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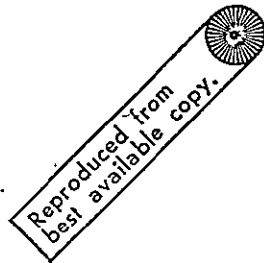
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CR-128703
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TEST REPORT
ELECTRON-PROTON SPECTROMETER
QUALIFICATION TEST UNIT
QUALIFICATION TEST

LEC Document Number EPS-695

(NASA-CR-128703) TEST REPORT:
ELECTRON-PROTON SPECTROMETER QUALIFICATION
TEST UNIT, QUALIFICATION TEST (Lockheed
Electronics Co.) 619 p HC \$33.00



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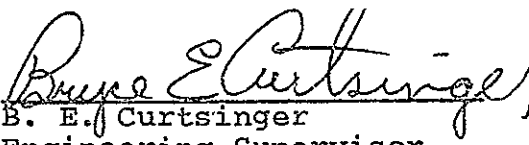
National Aeronautics and Space Administration
Manned Spacecraft Center
Houston, Texas
March 1972

CSCL 14B G3/14
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TEST REPORT
ELECTRON-PROTON SPECTROMETER
QUALIFICATION TEST UNIT,
QUALIFICATION TEST

Prepared by: 
D. L. Vincent
Mech. Engineer

Approved by: 
B. E. Curtsinger
Engineering Supervisor


B. C. Hall
Program Manager

Lockheed Electronics Company, Inc.
Houston Aerospace Systems Division
Houston, Texas

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PURPOSE

The purpose of the EPS Qualification Test Unit testing was to qualify the EPS for use in the 'Skylab' program and to demonstrate that the instrument would operate satisfactorily during, and subsequent to, exposure to the environmental requirements of the end item specification.

PROCEDURE

The tests described in this report were conducted in accordance with LEC document EPS-503, Qualification Test for Electron-Proton Spectrometer, P/N SEC39106425-301, S/N 1001. All testing was conducted with NASA QA and an LEC engineering representative as witnesses.

To maintain the test schedule and utilize available test facilities, the tests did not follow the sequence called for in EPS-530. The tests are reported in the sequence in which they were run, which is also shown in the test summary sheets, pages 30 and 31 of this report.

ACCEPTANCE TEST

Prior to the start of the qualification testing, the EPS Qualification Test Unit was subjected to acceptance testing in accordance with LEC document EPS-489. Data from this testing is shown in the data sheets that form Appendix A of this report.

QUALIFICATION TEST

Functional Test

As the final functional test of the acceptance testing was completed less than one week prior to the start of the qualification testing, the functional test of EPS-530, para. 2.1 did not need to be performed.

Thermal/Vacuum Test

On the 21st January 1972, the EPS Qualification Test Unit and its associated Bench Test Equipment (BTE) were taken to Building 33, NASA/MSC. The test article was installed in the test fixture in chamber 'N' and the BTE connected as required by para. 2.2 of EPS-503. A functional test was performed and the chamber door closed and sealed.

At 1:58 a.m. on 24 January, pump down of chamber 'N' was started. At 3:18 a.m. the BTE was activated, and the EPS electronics package and detector temperatures were monitored every 30 minutes, as called for in the test procedures, using the instruments built-in sensors for temperature measurement. Test mode 1 - cold, operating - and its accompanying functional test was completed by 5:50 p.m. on 24 January, and the test article was switched into test mode 2 - cold, standby. Test mode 2 was completed at 7:45 a.m. on 25 January and functional test data was then taken. A loss of electrical power in Building 33 between 7:56 a.m. and 8:25 a.m. delayed the taking of the functional test data, but did not continue long enough to cause drastic change in the test items internal temperature, and the functional test data taken is considered valid.

At 9:15 a.m. on 25 January the chamber and test article were placed into test mode 3 - hot, operating. At 6:00 p.m. on 25 January, this test case and its accompanying functional test were completed.

The chamber conditions were then changed to test mode 4 - hot, survival - and the 'electronics' power and detector bias supply to the test article were turned off at the BTE. At 7:45 a.m. on 26 January this final test mode was completed and the return of the test chamber to ambient conditions was started, and by 9:30 a.m. the post thermal/vacuum functional test data had been taken.

The test article was then returned to LEC's Radiation Instrumentation Department. Visual examination of the EPS revealed no damage that would prevent the instrument from meeting the operational requirements. No discrepancy reports were generated during the period of the Thermal/Vacuum test. Data from this test is included in the data sheets forming Appendix B of this report. Temperature and power profiles for each test mode are given on pages 33 through 36.

EMI Test

On 28 January 1972, the EPS Qualification Test Unit was taken to Building 14, NASA/MSC and accepted for electromagnetic compatibility testing to EPS-503, para. 2.8. Storage in Building 14 over the weekend permitted immediate commencement of testing on 31 January.

Radiated interference from the test instrument was evaluated on 31 January, and all levels of irradiance were shown to be within specification.

The instrument's electromagnetic susceptibility was evaluated on the 1st and 2nd of February. Although susceptibility was noted between 200 - 450 MHz, the levels were 6 to 10 dB above the specification levels, hence the instrument's performance was considered to be within specification.

The test unit was then returned to LEC's Radiation Instrumentation Department for functional test to EPS-503, para. 2.9.

Acoustic Test

On 8 February 1972, the EPS Qualification Test Unit was taken to Building 49, NASA/MSC and accepted for acoustic qualification testing to EPS-503, para. 2.10. The test article was then taken to Building 262, NASA/MSC and installed on the test fixture. The test article and fixture was then suspended inside the reverberant chamber and the door closed.

The test article was then exposed to 80 seconds of acoustic noise to the spectrum given in EPS-503, figure 6, followed immediately by 10 seconds at an overall level 4 dB higher to simulate transonic buffetting. It was then removed from the test chamber.

Visual examination of the unit showed no visible evidence of damage or failure caused by this test, and the test unit was then returned to Building 49. On the morning of 9 February the test article was returned to LEC's Radiation Instrumentation Department, where it was subjected to a functional test as per EPS-503, para. 2.11.

No discrepancy reports were generated during the period of the acoustic test or the subsequent functional test. Acoustic test data is shown on pages 37 through 40 of this report, and data from the functional test is included in Appendix B.

Shock Test

On 9 February 1972, the test article was transported to Building 49, NASA/MSD and accepted for shock testing to EPS-503, para. 2.6. The unit was instrumented with accelerometers in accordance with TPS EPS-1204.

The test article was then mounted to the test fixture V6-1-116 attached to the 310 slideplate. This shaker system had been set up to produce the shock response spectrum of EPS-503, figure 4. After subjecting the test article to shock pulses in the +X and -X direction, it was removed from the test fixture and the fixture rotated 90° to orient it for the 'T' axis. The test article was then reinstalled on the fixture and subjected to the same shock pulse in the +T and -T directions.

The unit was again removed from the test fixture and the fixture was removed from the slideplate and mounted on the 249 shaker. The test item was reinstalled on the fixture and subjected to shock excitation in the +R and -R directions. It was then removed from the fixture and replaced on its servicing stand and returned to LEC's Radiation Instrumentation Department.

Upon receipt of the test article at LEC, it was subjected to the bench shock test called for in EPS-503, 2.6.19 through 2.6.21. Upon completion of this portion of the shock testing, the unit received a functional check-out as per EPS-503, para. 2.7.

No discrepancy reports were generated during the period of the shock test or the subsequent functional check. Shock test data is shown on pages 41 through 70, and data from the functional test is included in Appendix B.

Vibration Test

On 10 February 1972, the Qualification Test Unit was taken to Building 49, NASA/MSD and accepted for vibration testing.

The test article was exposed to the 'X' and 'T' axis random and sinusoidal vibration of EPS-503, para. 2.4. At the end of this time it was returned to LEC's Radiation Instrumentation Department for functional testing to EPS-503, para. 2.5. The test article completed this functional test satisfactorily.

A discrepancy report (DR EPS-0087) was generated regarding the 'O-ring' seal on the underside of the mounting flange of the EPS. Sections of this had become unbonded during the constant removal from servicing stand to test fixture and back. It was determined that this discrepancy was due to handling damage, caused primarily by the large amount of handling required to do the testing and attempts to align the hold-down holes with those on the fixture with the full weight of the package bearing down on the 'O-ring' seal. The seal was rebonded to the flange.

On 15 February, the test article was returned to Building 49 to be subjected to 'R' axis vibration. Due to the inability of the 249 shaker system to attain the levels required when the spectrum was run as a single segment, the test spectrum was broken down into 6 segments as shown in Figure 54, page 71.

Each segment was run for 80 seconds at the nominal level plus 10 seconds at the high energy level. Each segment of the spectrum is shown in Figures 75 through 154.

Upon completion of the 'R' axis vibration testing (random and sinusoidal), the test article was returned to LEC's Radiation Instrumentation Department for functional testing. The unit satisfactorily completed the functional test with no discrepancies in the data, and visual inspection of the unit revealed no damage that would prevent it from meeting the operational requirements.

Data from the functional tests associated with the vibration testing is included in Appendix B.

Humidity Test

On 18 February 1972 the Qualification Test Unit was transported to Building 15, NASA/MSD and accepted for humidity testing.

The test article was placed in the humidity chamber and the door closed and sealed. It was then exposed to the humidity cycling described in EPS-503, para. 7.0. On 23 February the unit was removed from the humidity chamber.

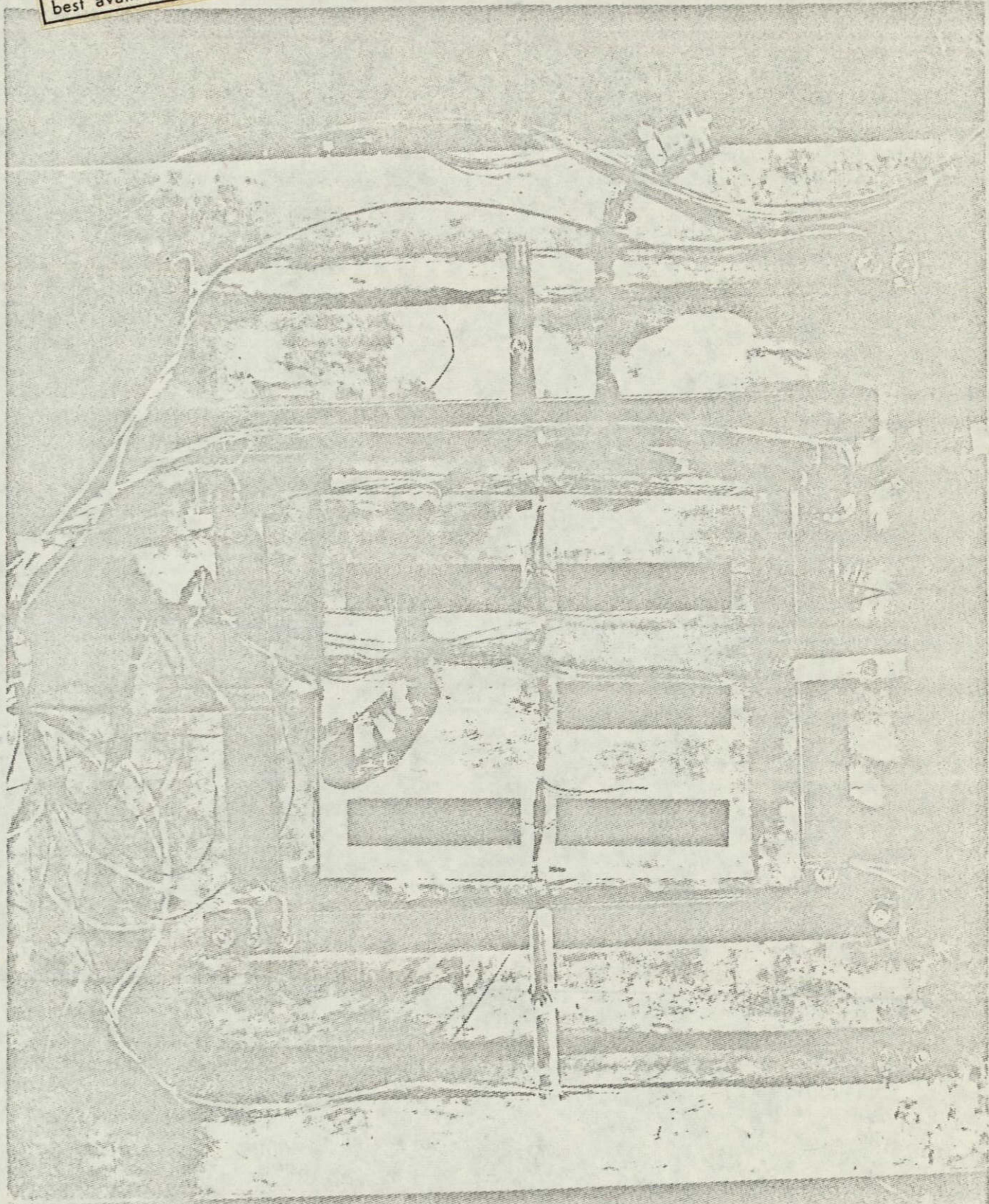
Visual inspection disclosed some staining of a screw and washer, also of the test stand, and some 'bubbling' of paint where moisture had penetrated under the paint surface.

DR EPS-0089 was generated at this time.

The unit was then returned to LEC's Radiation Instrumentation Department. The outside surfaces of the instrument were wiped dry and it was allowed to dry out at room ambient conditions for 8 hours. It was then subjected to the functional check called for in EPS-503, para. 2.13. During this functional test, some data was not within the specified limits and DR EPS-0090 was generated.

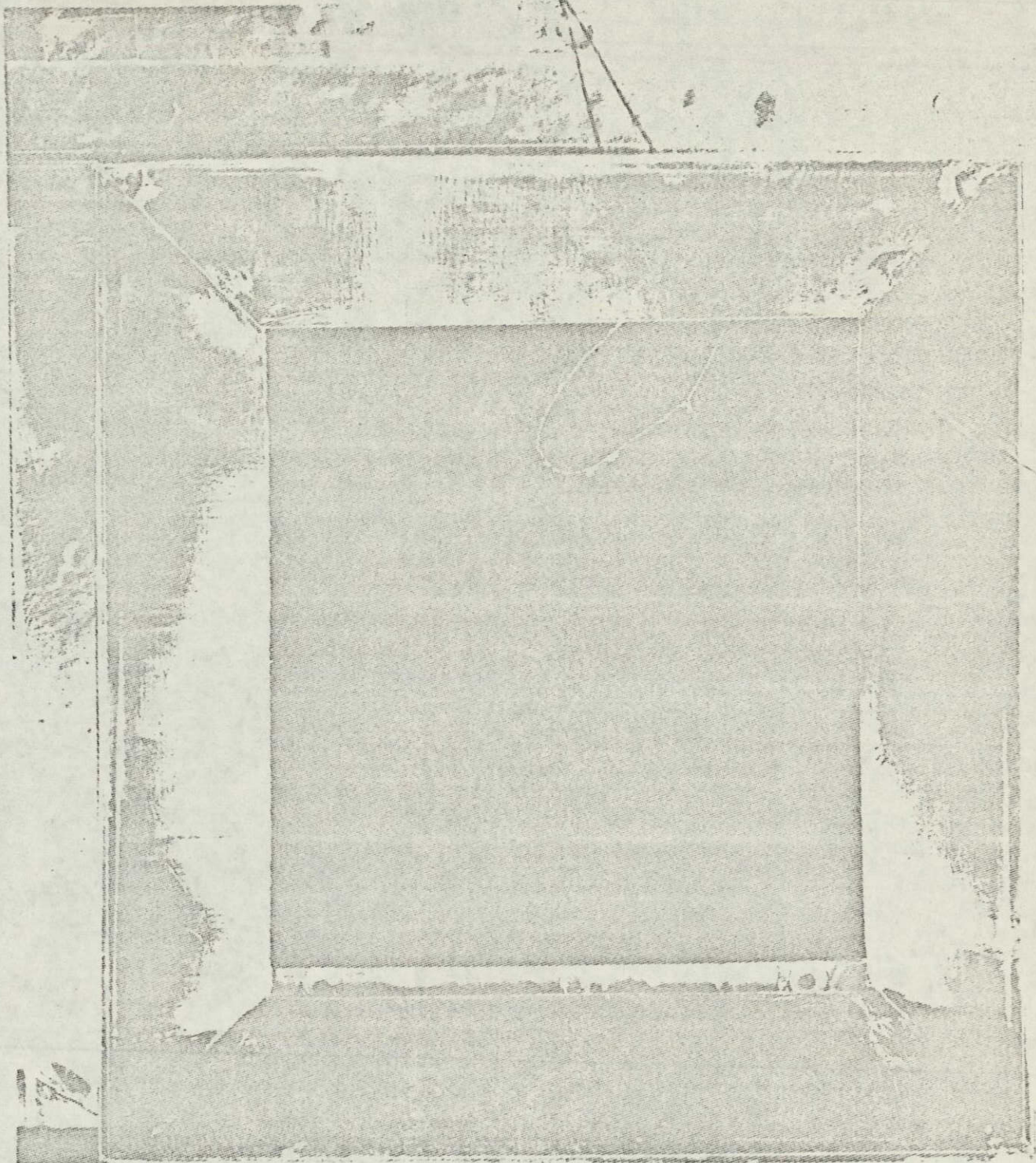
The test article was then placed in a vacuum chamber overnight, and the functional check repeated. The instrument satisfactorily completed this functional check. Data from the two functional checks is included in Appendix B.

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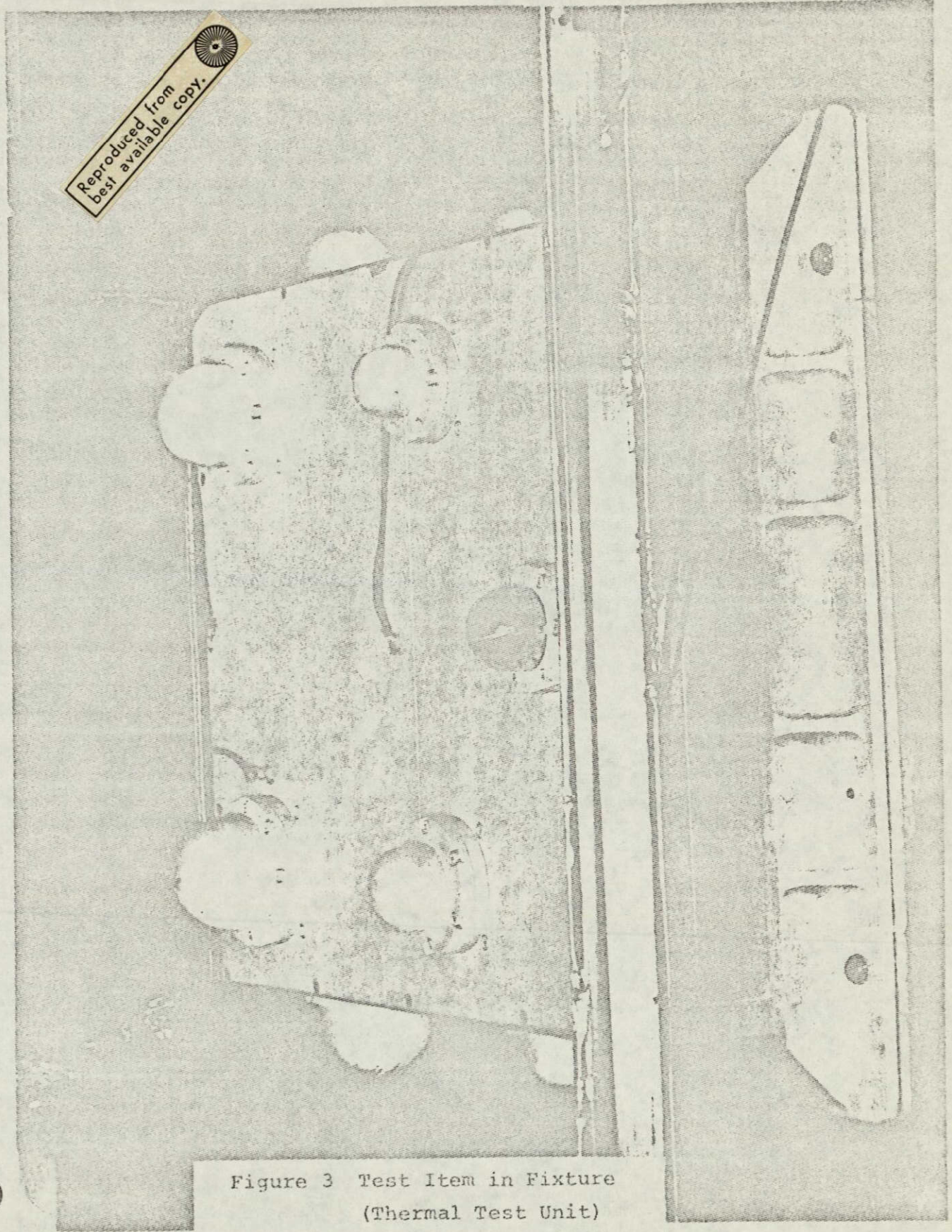
Figure 1 Underside of Test Fixture



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Figure 2 Top of Test Fixture

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Figure 3 Test Item in Fixture
(Thermal Test Unit)

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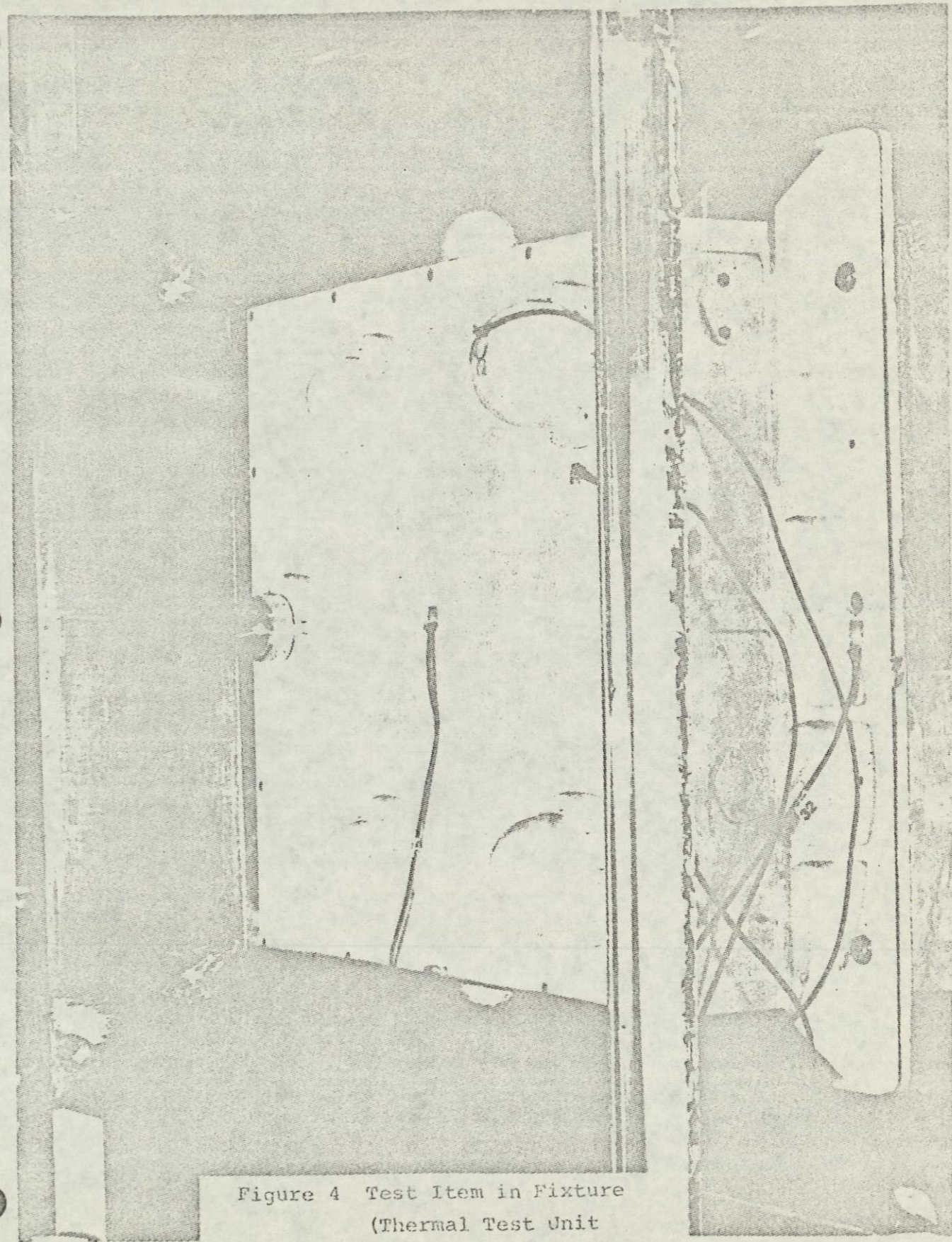


Figure 4 Test Item in Fixture
(Thermal Test Unit)

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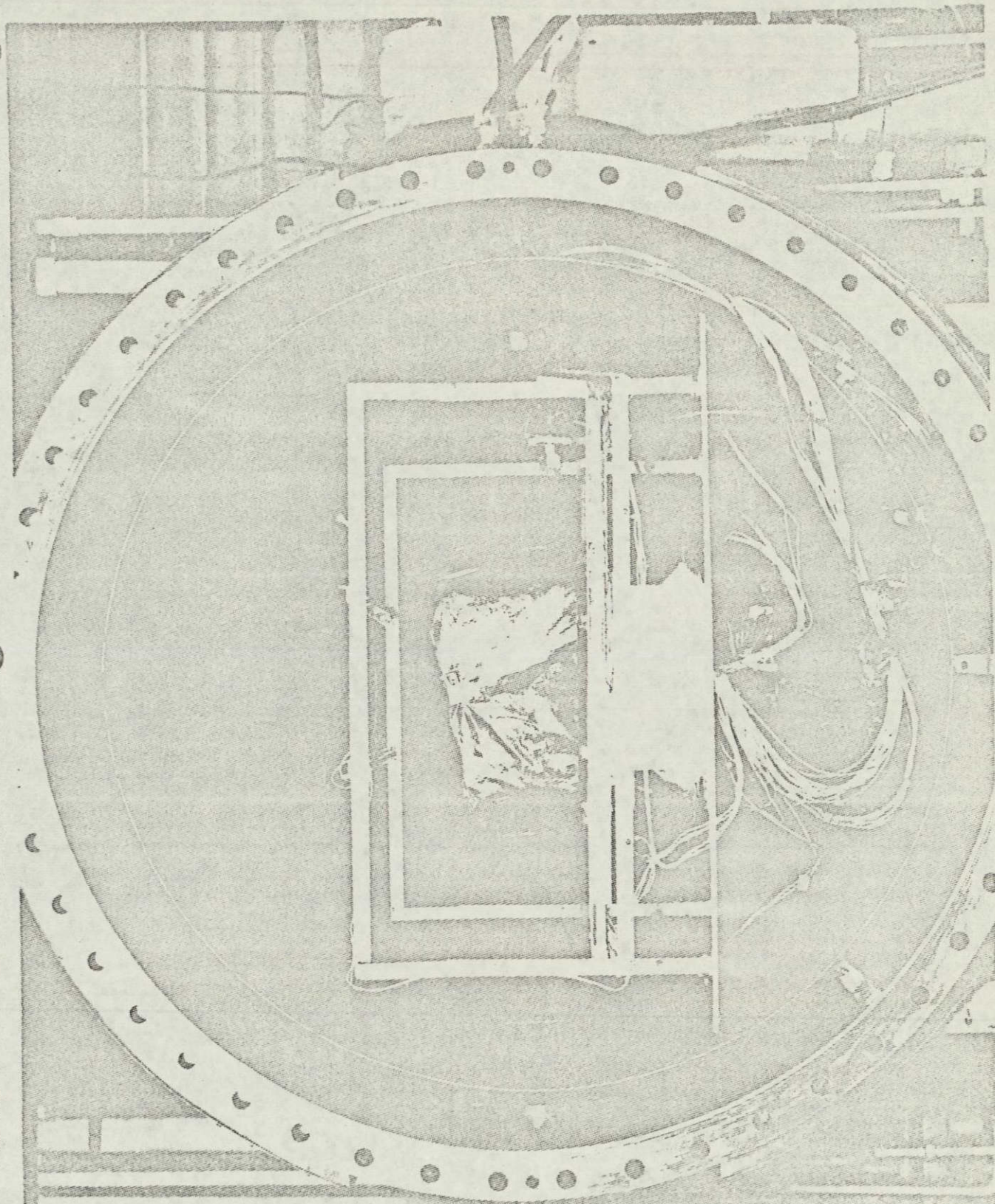
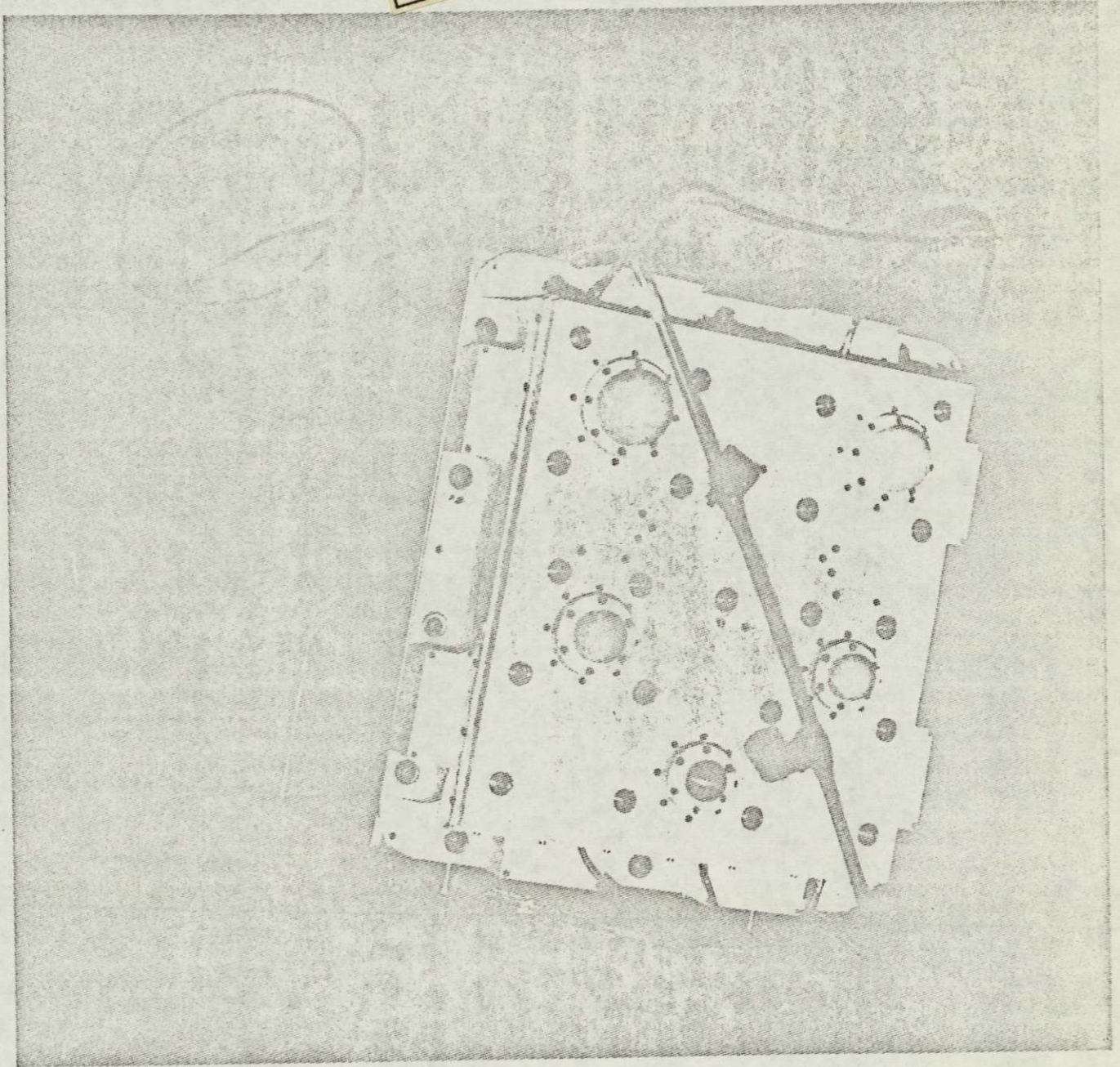


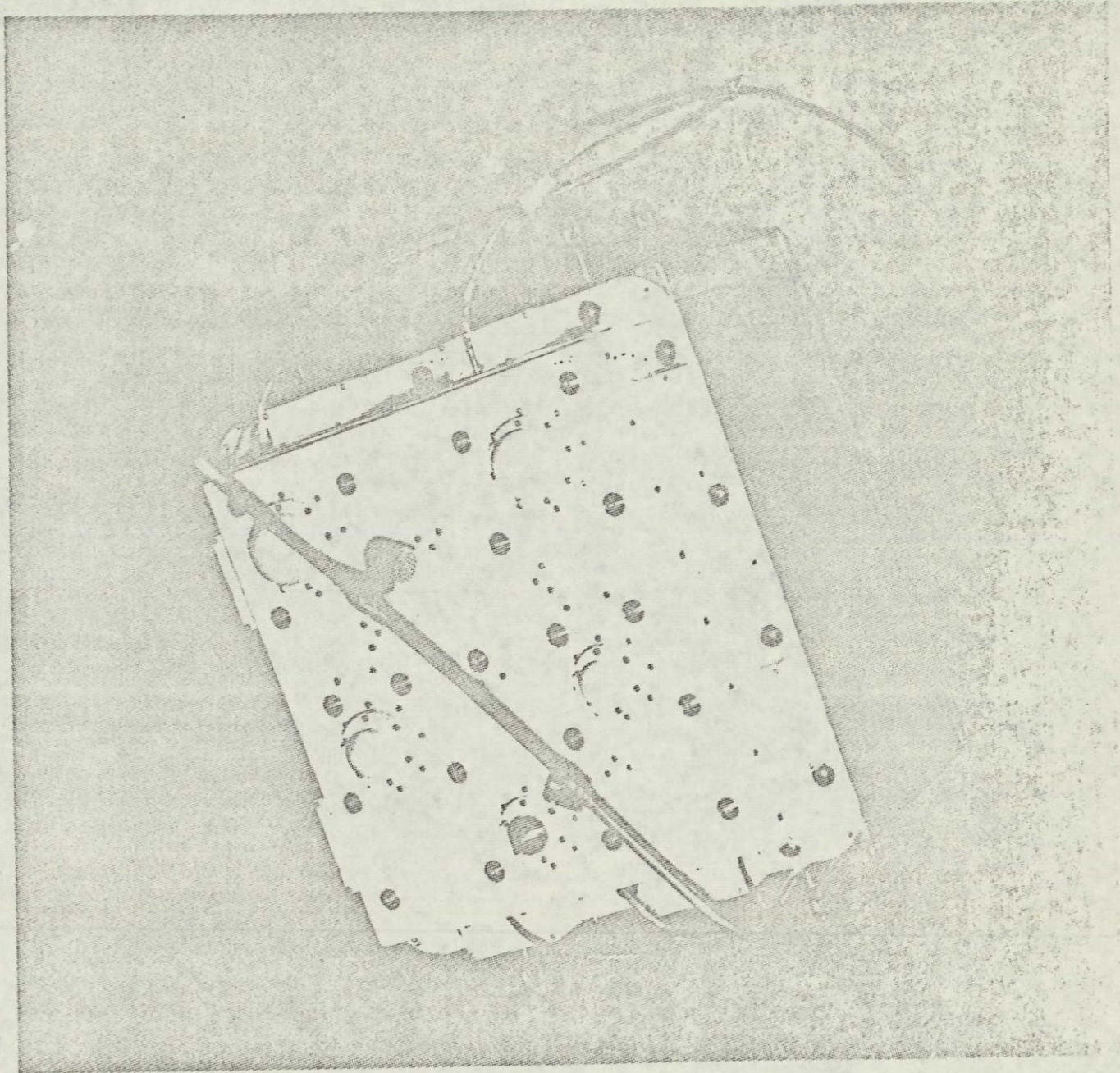
Figure 5 View of Test Article and Fixture
in Chamber 'N' (Thermal Test Unit)

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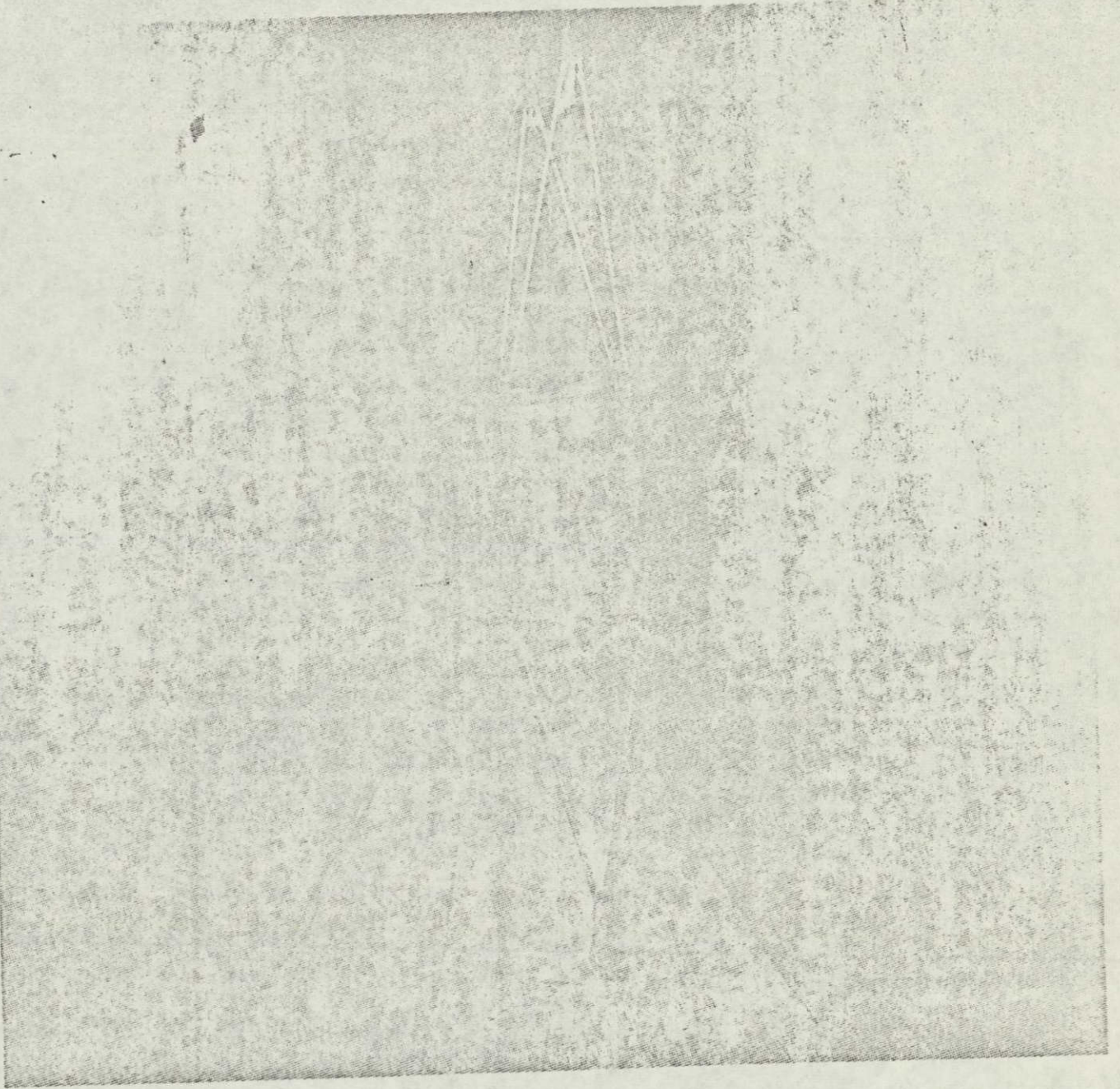
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Figure 6 Test Item Prepared for
Acoustic Testing



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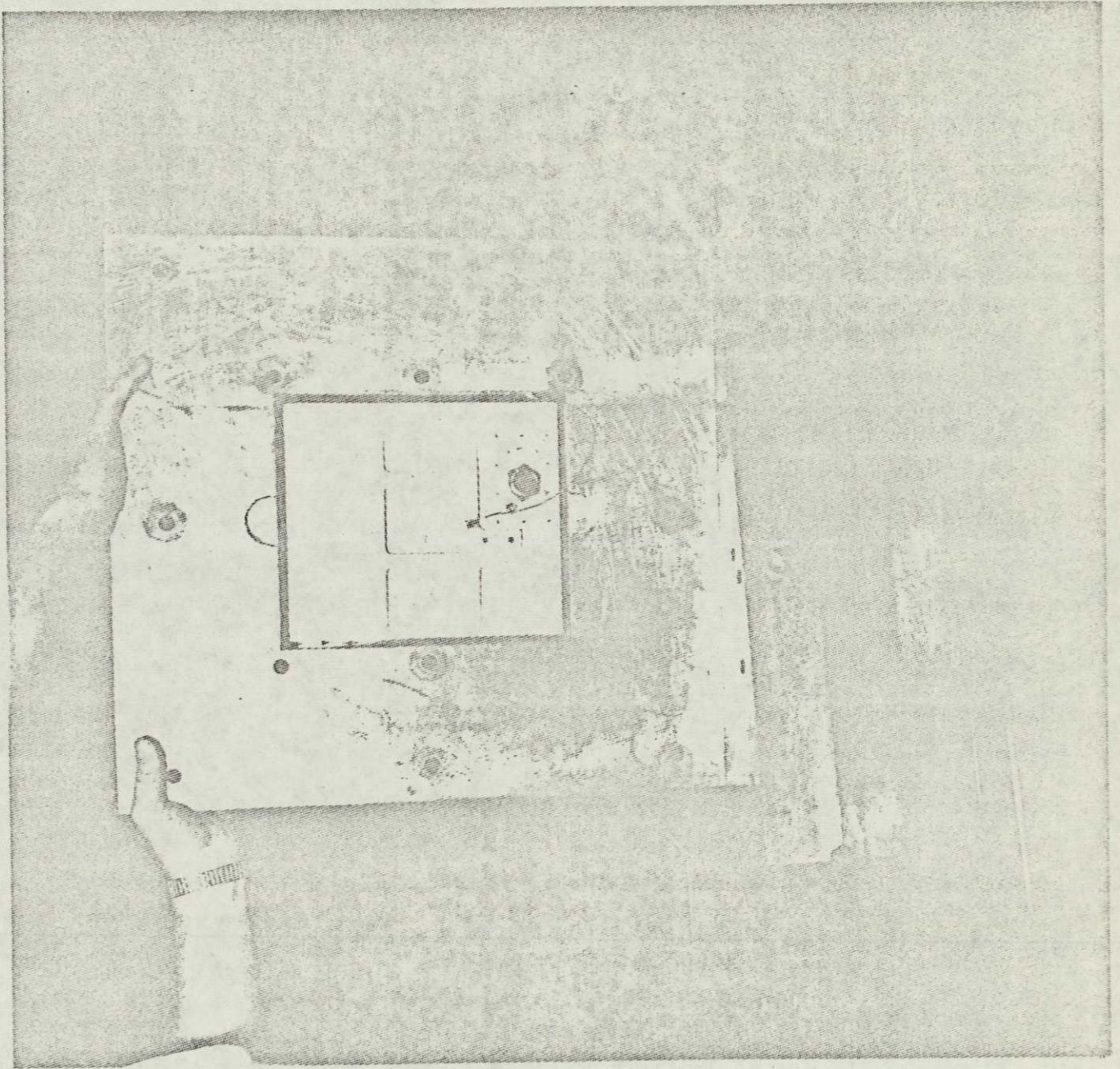
Figure 7 Test Item Prepared for
Acoustic Testing



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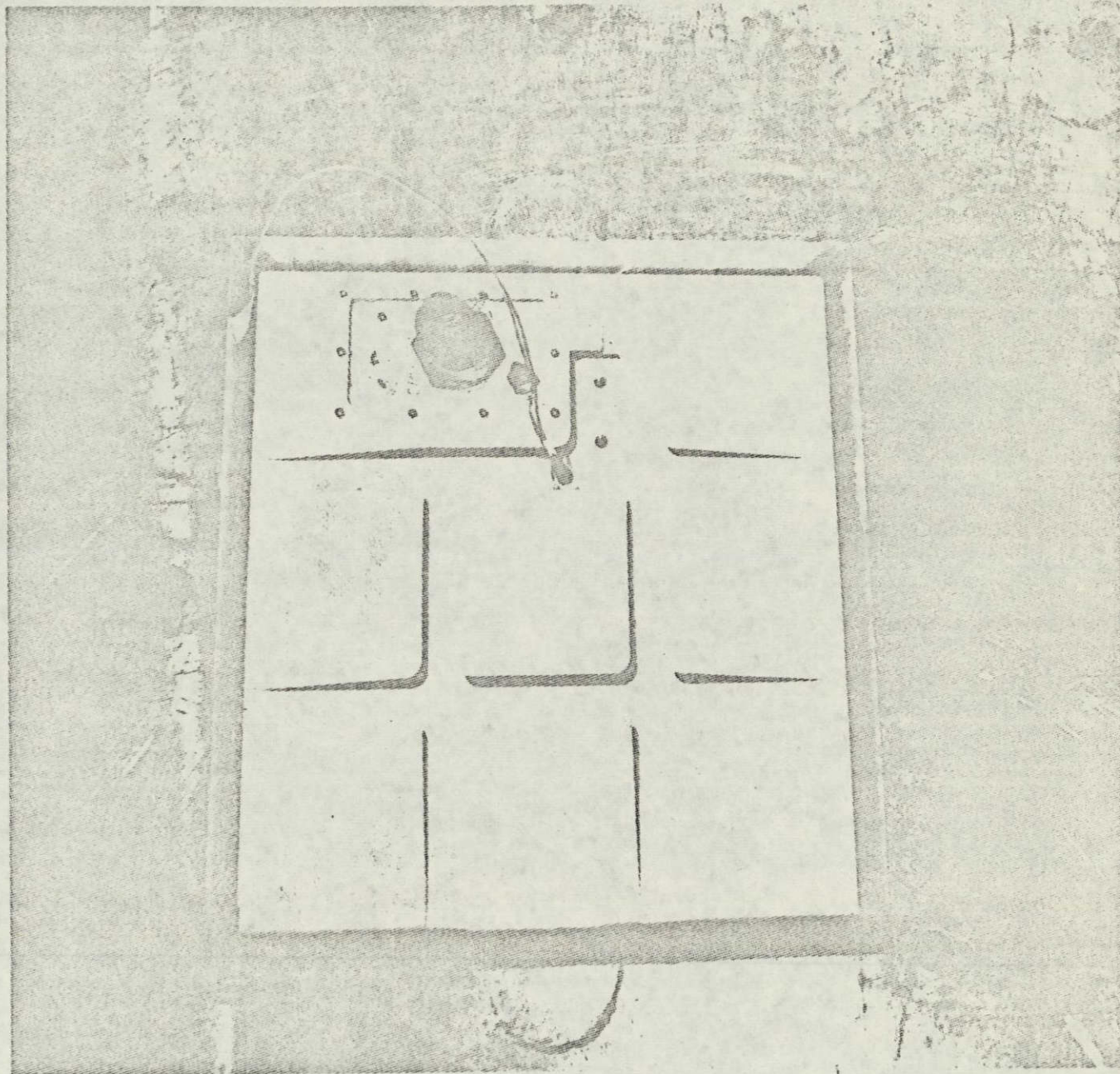
Figure 8 Test Article Suspended in Acoustic
Test Chamber Horn

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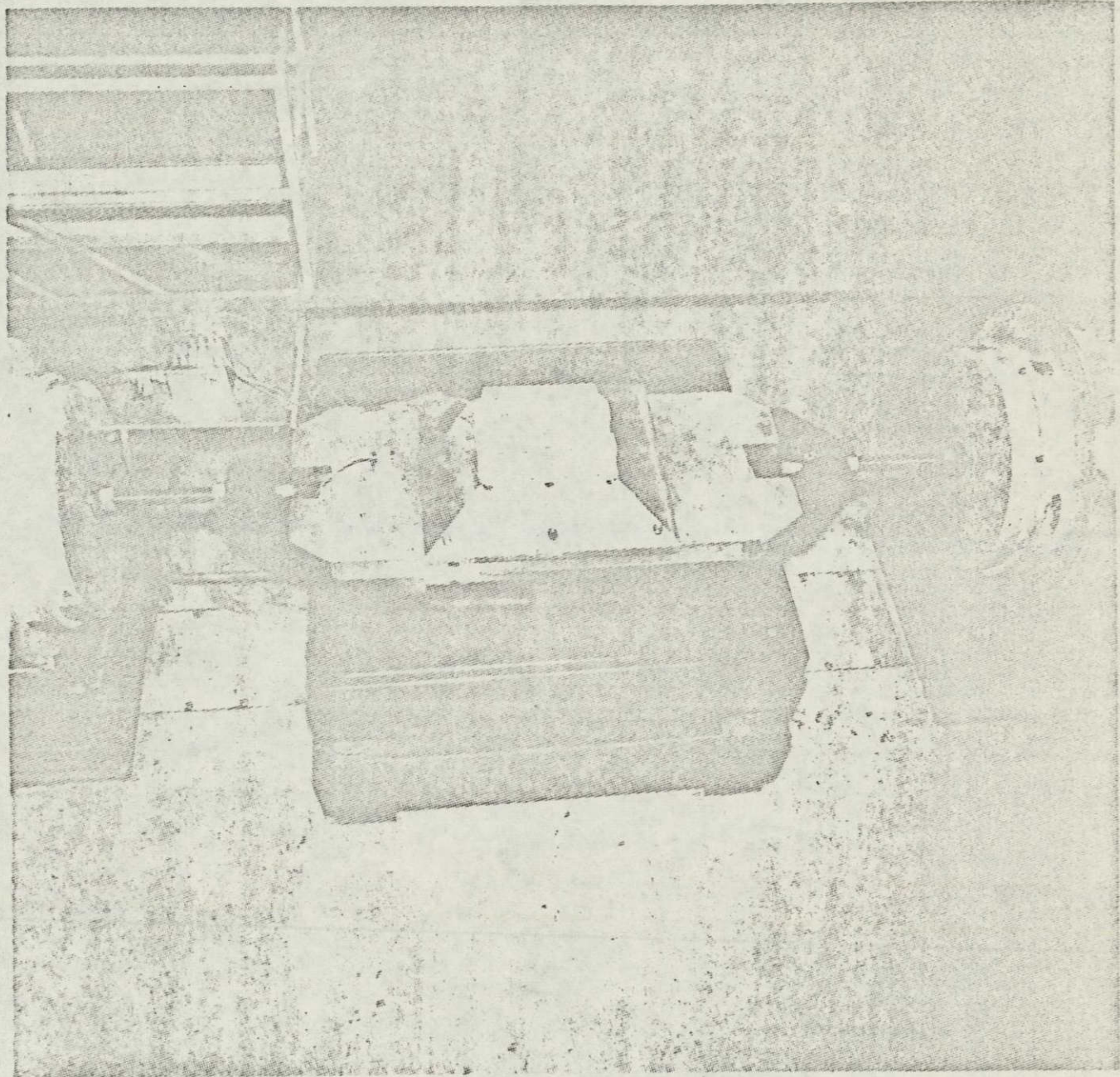
Figure 9 Underside of EPS in Vibration
Test Fixture



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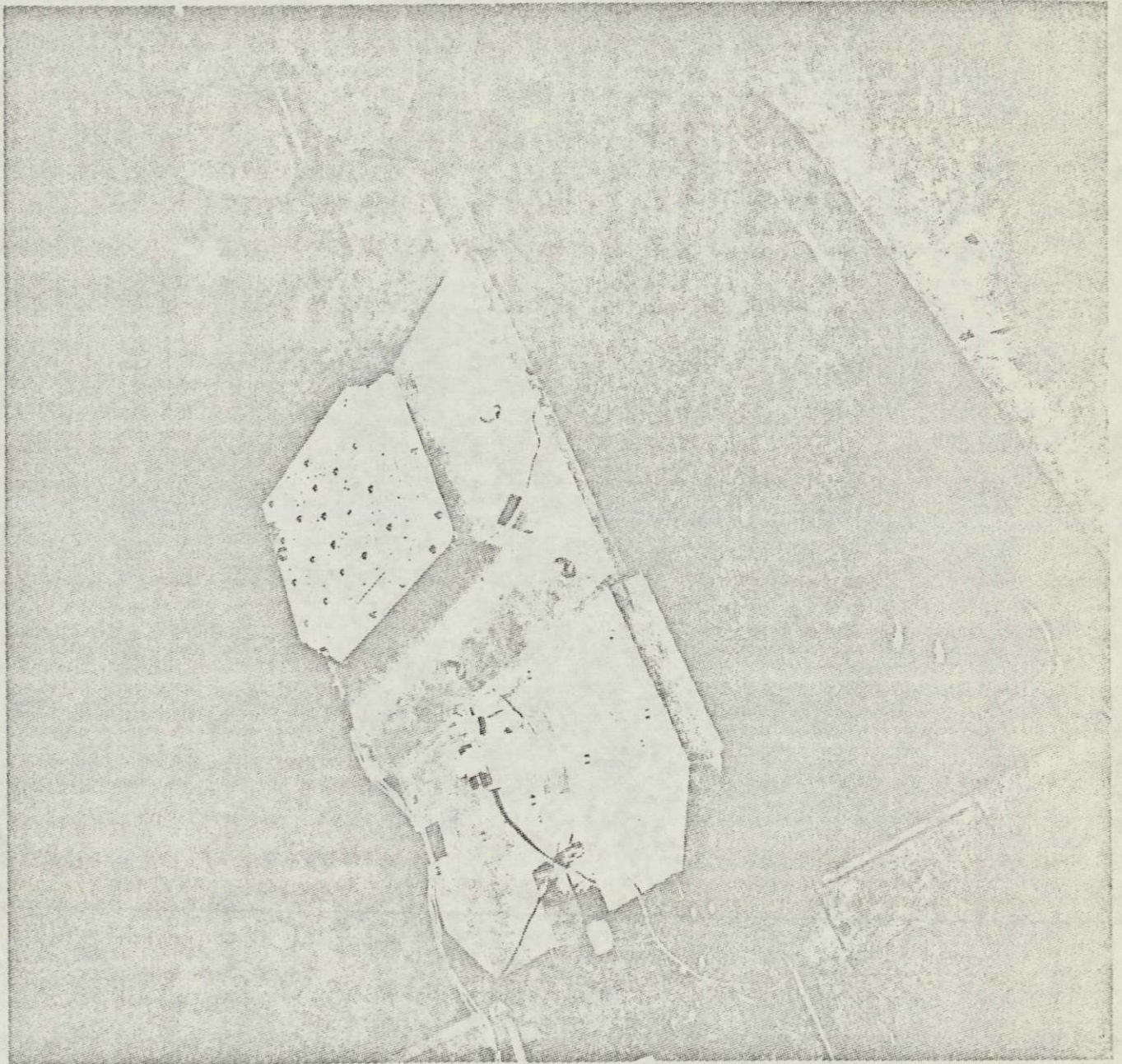
Figure 10 Closeup of Underside of EPS
in Vibration Test Fixture

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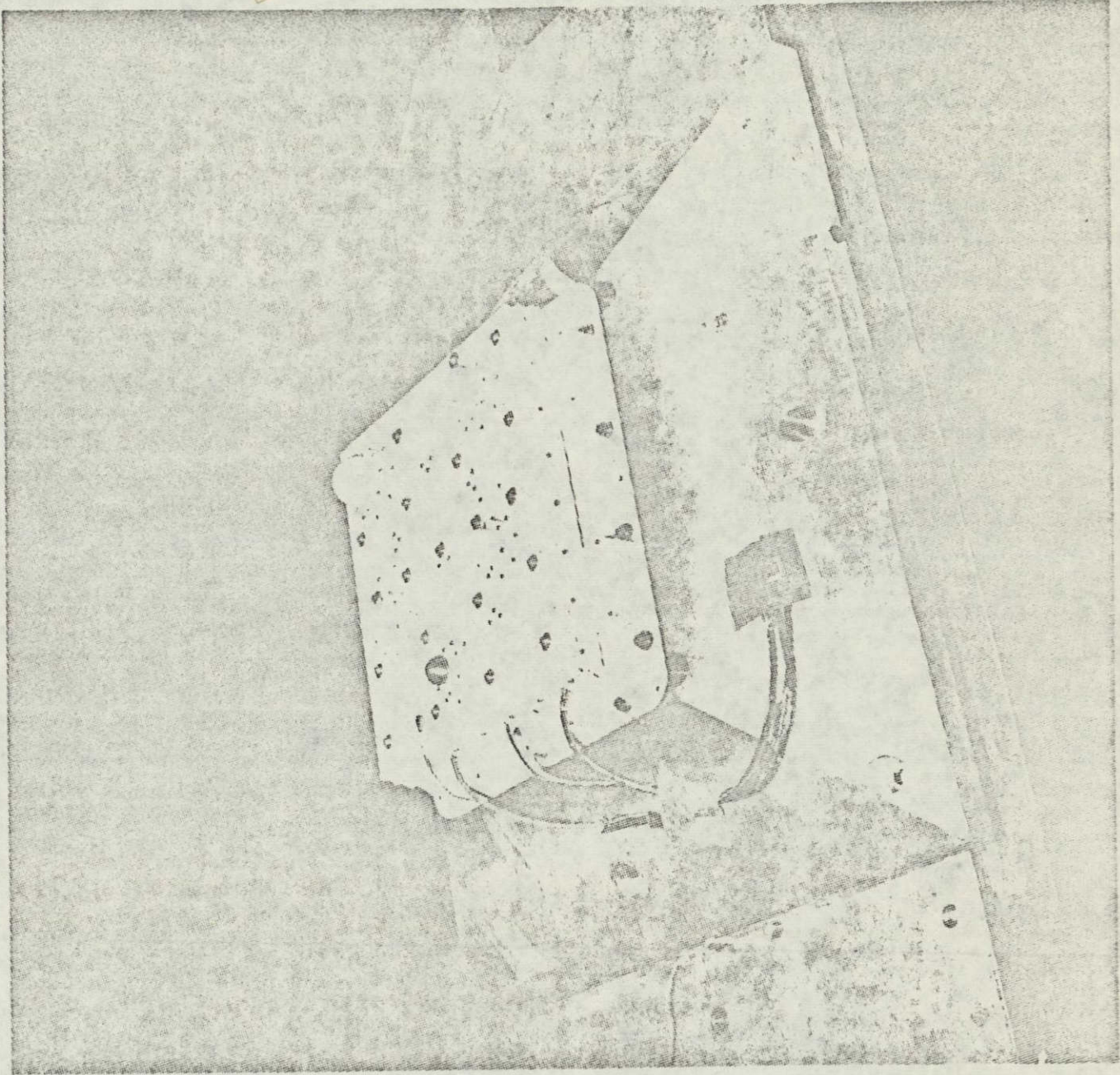
Figure 11 Vibration and Shock Setup
'X' Axis



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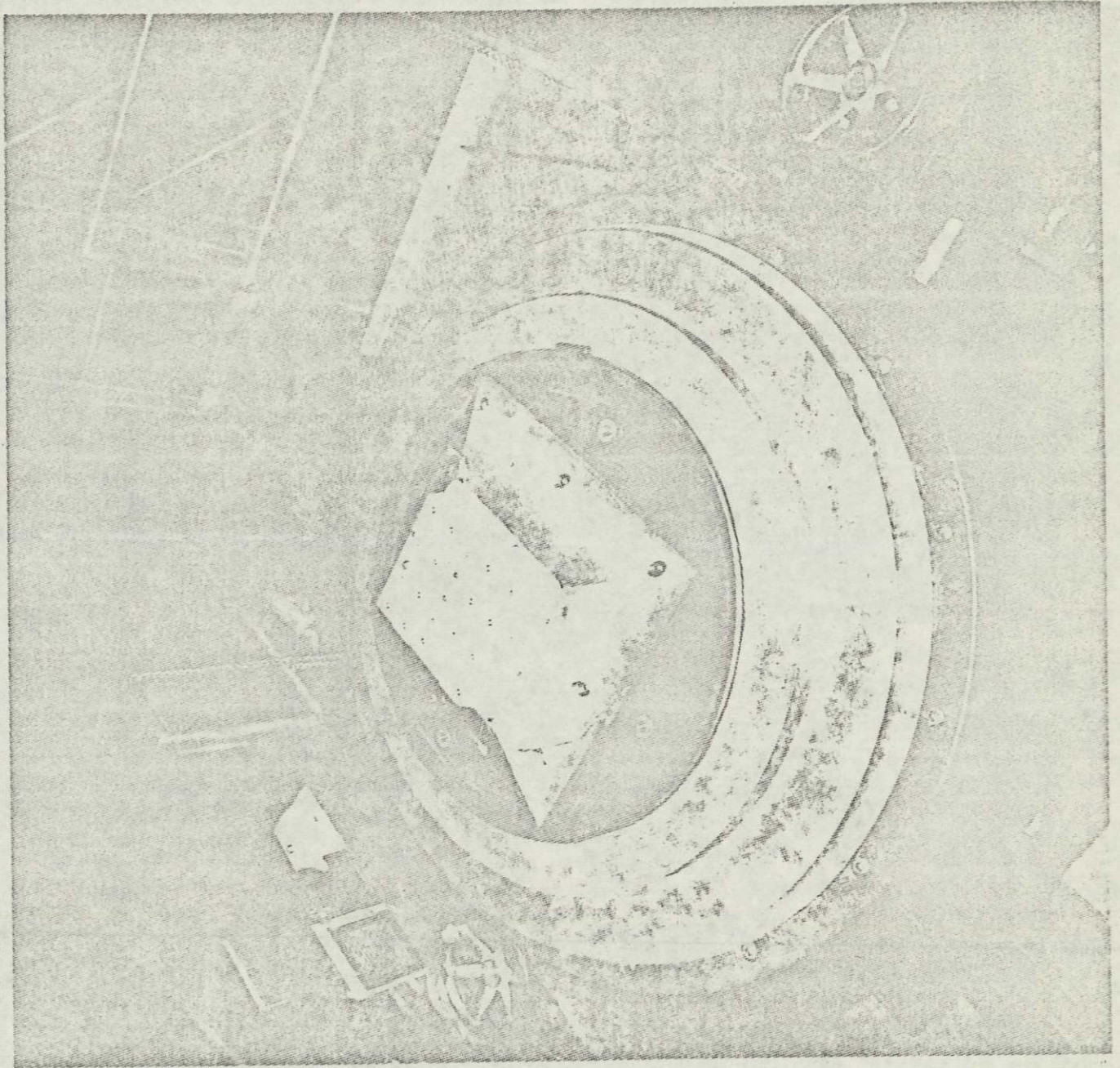
Figure 12 Vibration and Shock Setup
'T' Axis

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Figure 13 Closeup of EPS on Vibration
Test Fixture, 'X' Axis



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Figure 14 EPS Mounted for 'R' Axis
Vibration and Shock

The temperature results from the qualification test agree closely with those from the Engineering Test Unit test, and show that the operating temperatures for hot or cold orbits are satisfactory and do not exceed the predicted values. For test case 4, 'survival in 'hot' orbit, which is not considered an operational requirement, the test results are acceptably below the survival limits placed on the instrument.

The results of the functional tests (Appendix B) show no change in the test unit's operating characteristics either during or after thermal/vacuum testing, and the test is considered to verify the ability of the EPS to satisfactorily meet its performance requirements in the thermal/vacuum environment.

EMI Test

The test article was tested to NASA EMC-P-EB8-003. A report on this testing was generated (EMC-R-EB8-003) and is included as Appendix D of this report. The instrument is considered to have satisfactorily demonstrated its ability to meet the specification requirements placed upon it.

Acoustic Test

Photographs of the test setup are shown in Figures 6 to 8. Figures 20 and 21 show the spectrum shaped for the 'maximum aerodynamic pressure' run. Figure 22 shows the spectrum shaped for the transonic buffeting. Figure 23 shows the data taken during the actual 'maximum aerodynamic pressure' test run.

Subsequent to the acoustic exposure, visual examination of the instrument revealed no surface or structural damage of any kind attributable to the test environment. The post acoustic functional test results show no change in the instrument's operating characteristics, and the test verifies the ability of the EPS to satisfactorily meet its operational and performance requirements after exposure to the acoustic environment.

Shock Test

Accelerometers were mounted to the test article prior to the commencement of the shock testing, and Figure 13 shows the location of these accelerometers. Their purpose was primarily to monitor the response of the instrument to the increased 'R' axis random vibration levels, however, by placing them on the instrument at this point in time allowed the monitoring of the shock responses of the unit also.

These responses were recorded and included in this report as follows:

Figure	Direction
24 to 28	+X Axis
29 to 33	-X Axis
34 to 38	-T Axis
39 to 43	+T Axis
44 to 48	+R Axis
49 to 53	-R Axis

Examination of the input shock response spectra shows that they are all outside of the test specification in a number of areas. All of the input spectra are above the test specification up to 100 - 120 Hz frequency, with the +R axis being also over in the ranges of 1500 - 2000 Hz and 3000 - 3700 Hz. The -R axis is above the test criteria in the range 3100 - 3700 Hz.

The test inputs are below the test criteria in the following areas:

+X axis	430 - 750 Hz, 850 - 1900 Hz, 4000 - 6000 Hz
-X axis	430 - 2100 Hz, 4000 - 5500 Hz
-T axis	850 - 2700 Hz, 3400 - 6200 Hz
+T axis	430 - 750 Hz, 900 - 2700 Hz, 3300 - 6800 Hz
+R axis	400 - 1200 Hz
-R axis	450 - 1400 Hz

However, it is felt that these input response spectra represent as good a test input as could be achieved with the equipment available to perform this test in Building 49.

Studying the responses of the vibration isolated electronics package to the input shocks shows a considerable amount of isolation of the input, particularly when compared with the response measured on the baseplate accelerometer, which is not isolated from the input.

Visual examination of the test article indicated no damage or failure that would prevent the unit from meeting its performance or operational requirements. The unit was again visually examined after the bench drop test, with the same result.

The post shock functional check disclosed no changes in the instrument's operating characteristics, and the test is considered to verify the ability of the EPS to satisfactorily meet its operational and performance requirements after exposure to the shock environment.

Vibration Test

The accelerometers attached to the instrument prior to the shock test were used to monitor the responses of the instrument to random vibration inputs. Responses to sinusoidal vibration input were not recorded. Though required primarily to monitor responses to increased 'R' axis vibration levels, the accelerometers were also used to record the 'X' and 'T' axis responses.

As noted under QUALIFICATION TEST, Vibration Test, the 'X' and 'T' axes were run first, followed by a functional check. The input and response data for the 'X' axis is given in Figures 55 to 64, and for the 'T' axis in Figures 65 to 74. Data from the functional test is included in Appendix B.

Visual inspection of the test article after the vibration led to the generation of DR EPS-0087 regarding the 'O-ring' seal. It was considered that the cause of the seal coming loose was due to heavy handling rather than the testing, and the seal was rebonded to the mounting flange of the instrument. No other evidence of damage that would affect performance or operation was found. The functional check showed no change in the data or the instrument's operating characteristics.

As mentioned earlier, the 'R' axis random vibration was run in 6 segments (Figure 54). The input spectra and response data from the instrument are shown in Figures 75 through 134.

Visual examination of the instrument after the 'R' axis vibration revealed no evidence of damage that would affect performance or operation of the instrument. The functional test disclosed no change in data or operating characteristics of the EPS. Data from this functional test appears in Appendix B.

Humidity Test

Visual examination of the test article after completion of the humidity cycling disclosed some 'staining' of a screw and washer used to mount the top plate of the instrument to the top slice of the electronics package, and some small areas of thermal control paint were 'bubbled' where moisture had penetrated under the paint skin. These flaws are mentioned in DR EPS-0089 which was generated at this time.

During the functional test, certain data was out of specification.

- ⊙ Medium voltage ADC, 1.0, 2.0, 3.0, 4.0 and 4.9 Vdc input voltage: output voltage checked low.
- ⊙ Discriminator reference monitor checked 2.965 Vdc should be $3.0 \pm .02$ Vdc.

DR EPS-0090 was generated to cover these discrepancies. The test unit was placed in a vacuum of 70 microns or lower and allowed to remain overnight. The functional check was then repeated and all data was found to be within specification. Data from the initial functional check is included in Appendix B, and from the final checkout is included on the DR (see Appendix E of this report).

The 'staining' of the screw and washer and the bubbling of the paint were not considered to be problems that would affect the operational or performance characteristics of the instrument. The out of tolerance condition noted during the functional test was demonstrated to return to an in-tolerance condition as the instrument dried out. It is therefore considered that the test verified the ability of the EPS to satisfactorily operate in a space environment after being subjected to humidity.

TEST SUMMARY SHEET

SHEET 2 OF 2

ITEM: EPS QUALIFICATION TEST UNIT
 PART NO. : SEC39106425-301 SER. NO. 1001

QUAL TEST PROCEDURE LEC DOCUMENT EPS-503		REF. PAGES IN THIS REPORT		TEST RESULTS	PASS	FAIL	DATE 1972	REMARKS
TEST	PARA.	DATA	SETUP					
Functional Test	2.9			See Data Sheets	X		2-2	Data recorded on Data Sht 6 by error
Acoustic Test	2.10			See Test Data	X		2-7 to 2-8	
Functional Test	2.11			See Data Sheets	X		2-9	Recorded on Data Sht 10
Shock Test	2.6			See Test Data	X		2-9	
Functional Test	2.7			See Data Sheets	X		2-10	
Vibration Test: 'X' & 'T' Axis Vibration	2.4 2.4.11 to 2.4.23			See Test Data	X		2-10	Recorded on Data Sht. 8
Functional Test	2.5			See Data Sheets	X		2-11	
'R' Axis Vibra- tion	2.4.1 to 2.4.9			See Test Data	X		2-14	
Functional Test	2.4.10			See Data Sheets	X		2-15	Recorded on Data Sht. 4
Humidity Test	2.12				X		2-18 to 2-23	
Functional Test	2.13			See Data Sheets & DR EPS-0090	X		2-23 to 2-24	Recorded on Data Sht. 13 & DR EPS-0090

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EPS-0090

TEST SUMMARY SHEET

SHEET 1 of 2

ITEM: EPS QUALIFICATION TEST UNIT				SHEET 1 of 2				
PT. NO.: SEC39106425				SER. NO.: 1001				
QUAL TEST PROCEDURE		REF. PAGES		TEST RESULTS	PASS	FAIL	DATE	REMARKS
LEC DOCUMENT EPS-503		IN THIS REPORT						
TEST	PARA.	DATA	SETUP				1972	
Acceptance Test (LEC Document EPS-489	1.1				X		1-19 to 1-21	Completed prior to Qual. Testing
Functional Test	2.1							Not run-Accept Test less than 1 week previous.
Thermal/Vacuum Test:	2.2							
Functional Test	2.2.5			See Data Sheets	X		1-21	
Test Case 1	2.2.7			See Temp Curve	X		1-24	
Functional Test	2.2.15			See Data Sheets	X		1-24	
Test Case 2	2.2.18			See Temp Curve	X		1-25	
Functional Test	2.2.21			See Data Sheet	X		1-25	Power loss 0756 to 0825 in Bldg 33-Did not af- fect test or data
Test Case 3	2.2.23			See Temp Curve	X		1-25	
Functional Test	2.2.27			See Data Sheets	X		1-25	
Test Case 4	2 2 28			See Temp Curves	X		1-26	
Functional Test	2.3			See Data Sheets	X		1-26	
EMC Test (Per NASA Doc. EMC- P-EB8-003	2.8							
Functional Test	2.8.1			See Data Sheets	X		1-28	Data recorded on Data Sht 5 by error
EMC Test	2.8.2				X		2-1	

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EPS-695

Test Case	Predicted Temperature		Measured Temperature	
	Electronics	Detectors	Electronics	Detectors
1. Cold Orbit-Operating	+2.2°C (+36°F)	-17.8°C (0°F)	+5.57°C	-16.5°C
2. Cold Orbit-Standby (Heater Power Only)	-41.1°C (-42°F)	-50°C (-58°F)	-27.08°C	-38.32°C
3. Hot Orbit-Operating	+22.2°C (+72°F)	+7.8 to -7.8°C (+46 to +18°F) 0°C (32°F) Mean	+11.92°C	-6.48°C
4. Hot Orbit-Survival	+40.6°C (+105°F)	+35.6°C (+96°F)	+46.52°C	+40.27°C

Figure 15 - Predicted and Measured Temperatures -
Thermal/Vac. Test.

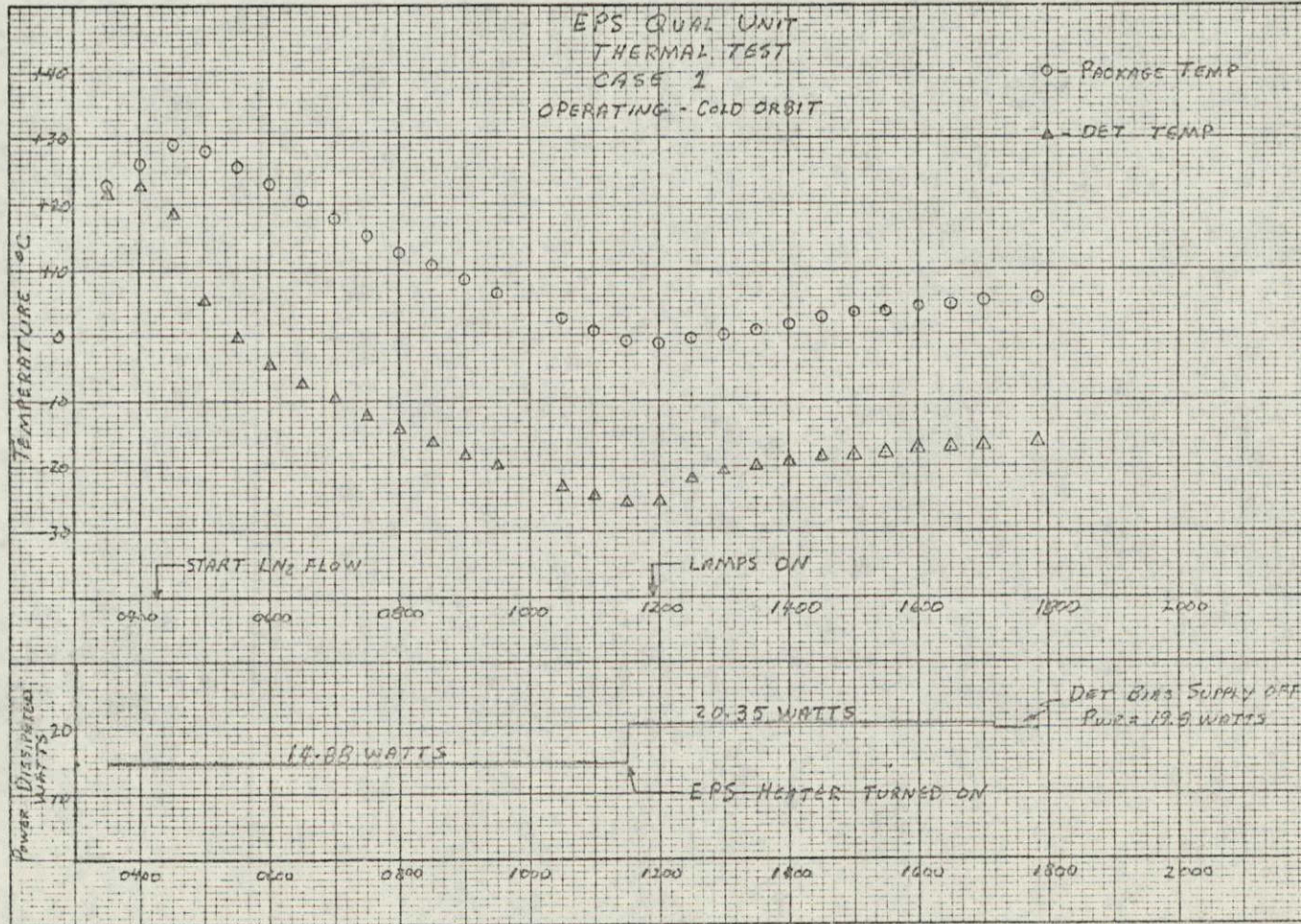


Figure 16 EPS Qual Unit, Thermal Test
 Case 1 - Operating, Cold Orbit

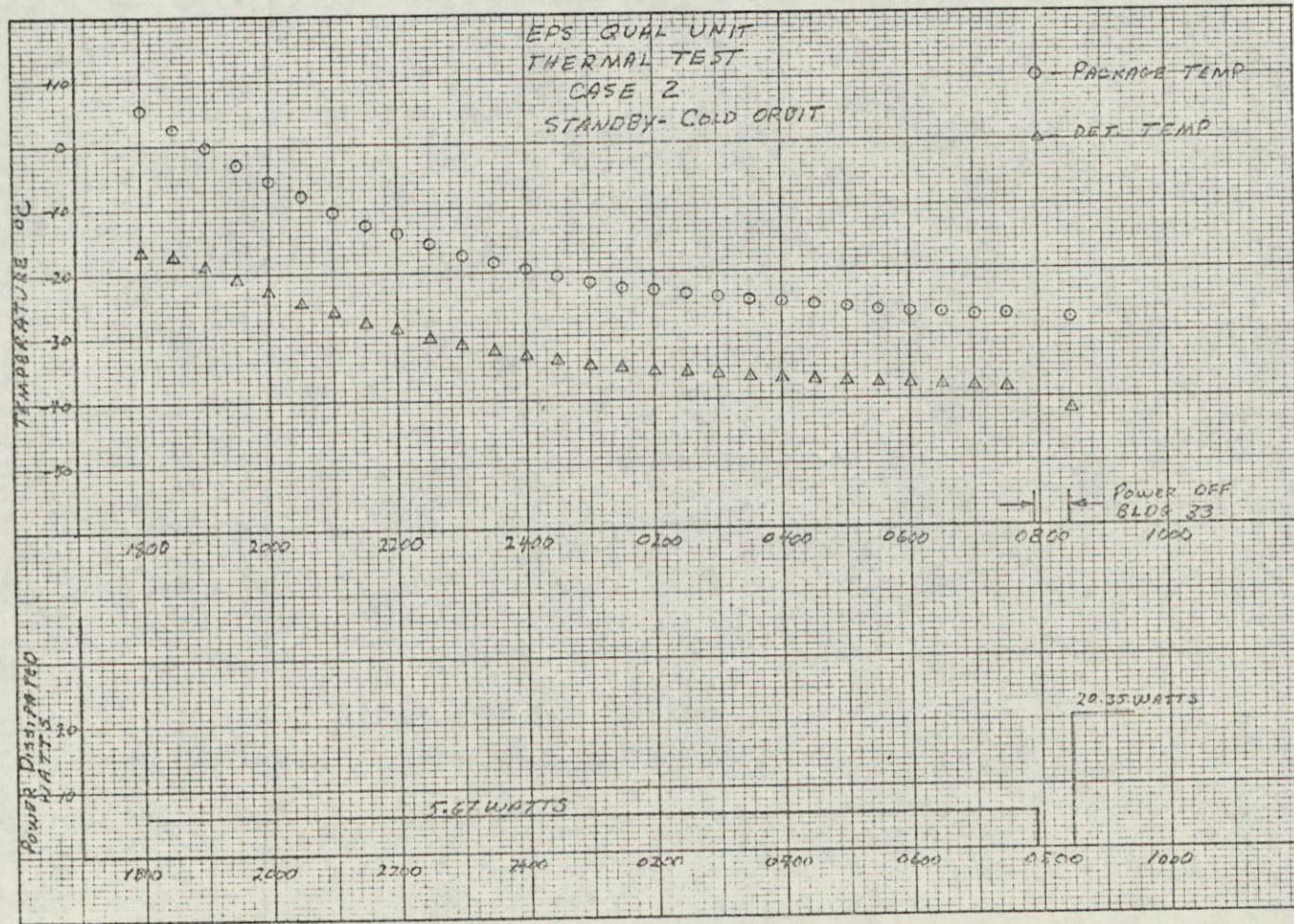


Figure 17 EPS Qual Unit, Thermal Test
 Case 2 - Standby, Cold Orbit

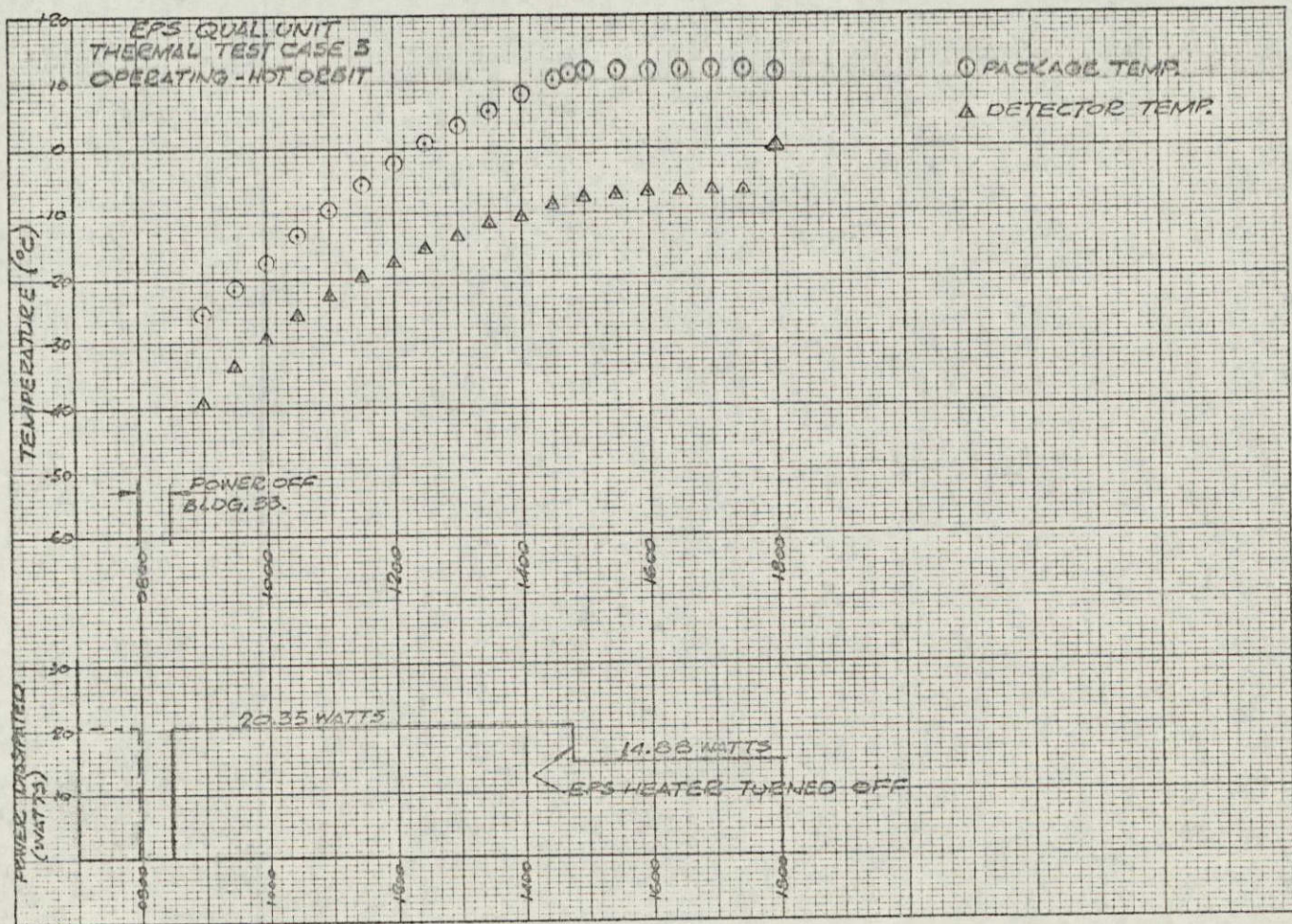


Figure 18 EPS Qual Unit, Thermal Test Case 3 - Operating, Hot Orbit

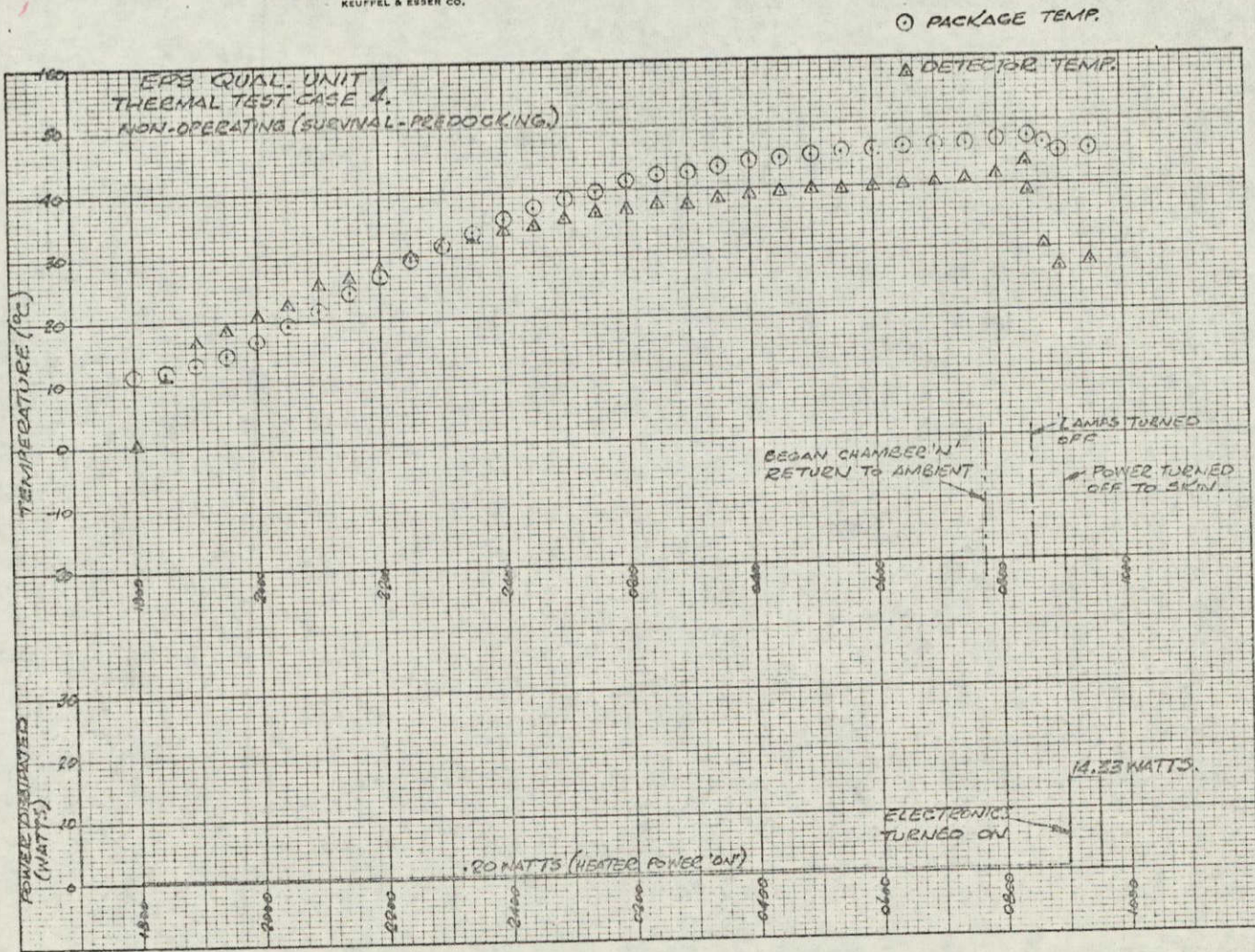


Figure 19 EPS Qual Unit, Thermal Test Case 4 -
 Nonoperating, Survival Predocking

SPECTRUM SHAPED FOR
AERODYNAMIC RUN

Reproduced from
best available copy.

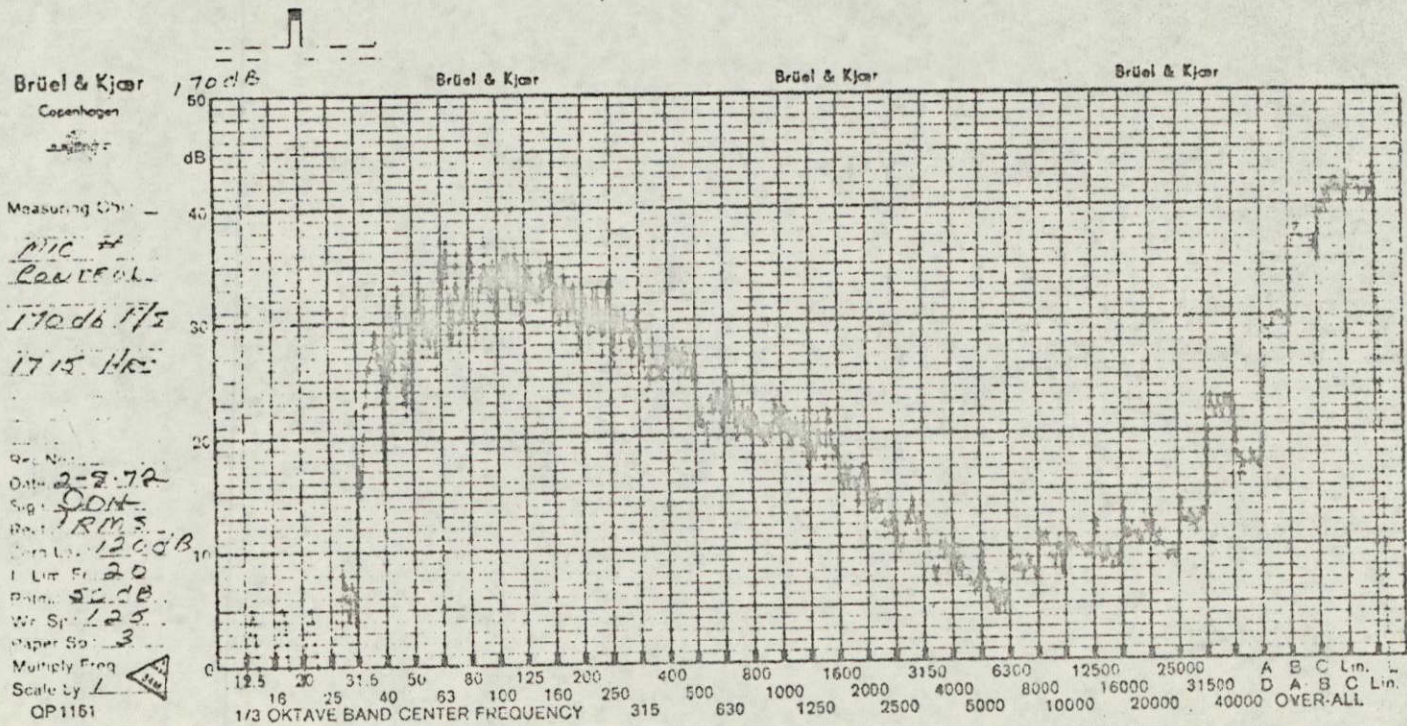


Figure 20 Spectrum Shaped for
Aerodynamic Run Mike 1

SPECTRUM SHAPED FOR
AERODYNAMIC RUN

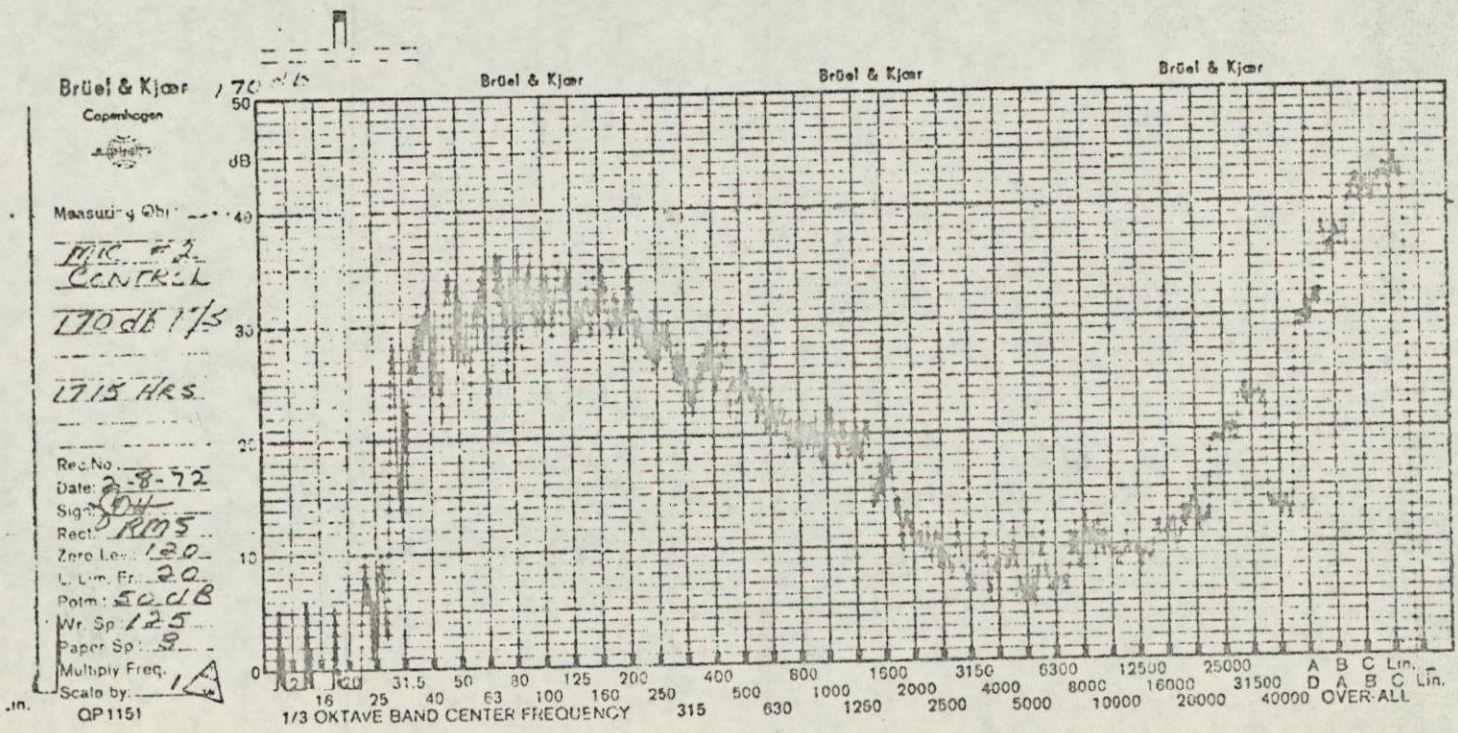


Figure 21 Spectrum Shaped for
Aerodynamic Run Mike 2

SPECTRUM SHAPED FOR 165 dB
TRANSONIC BUFFETING SPECTRUM

Reproduced from
best available copy.

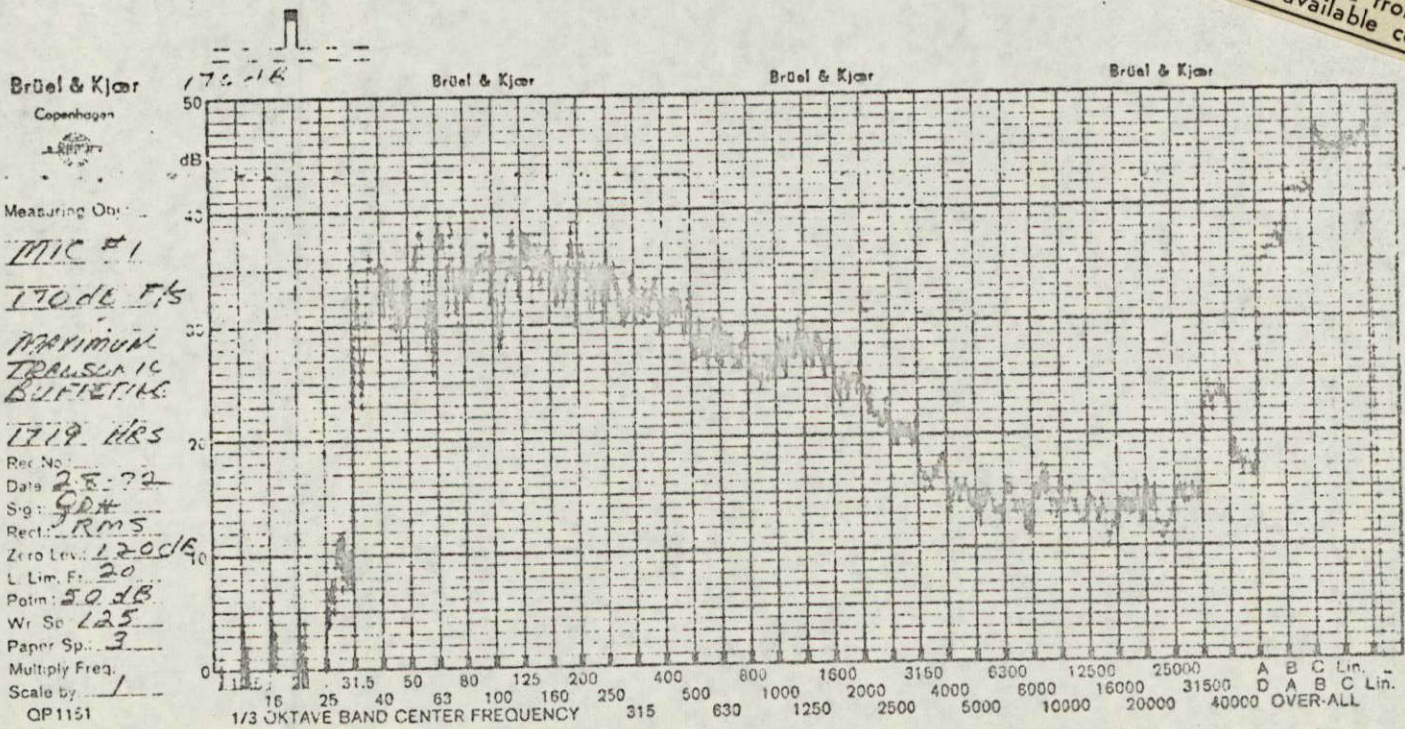
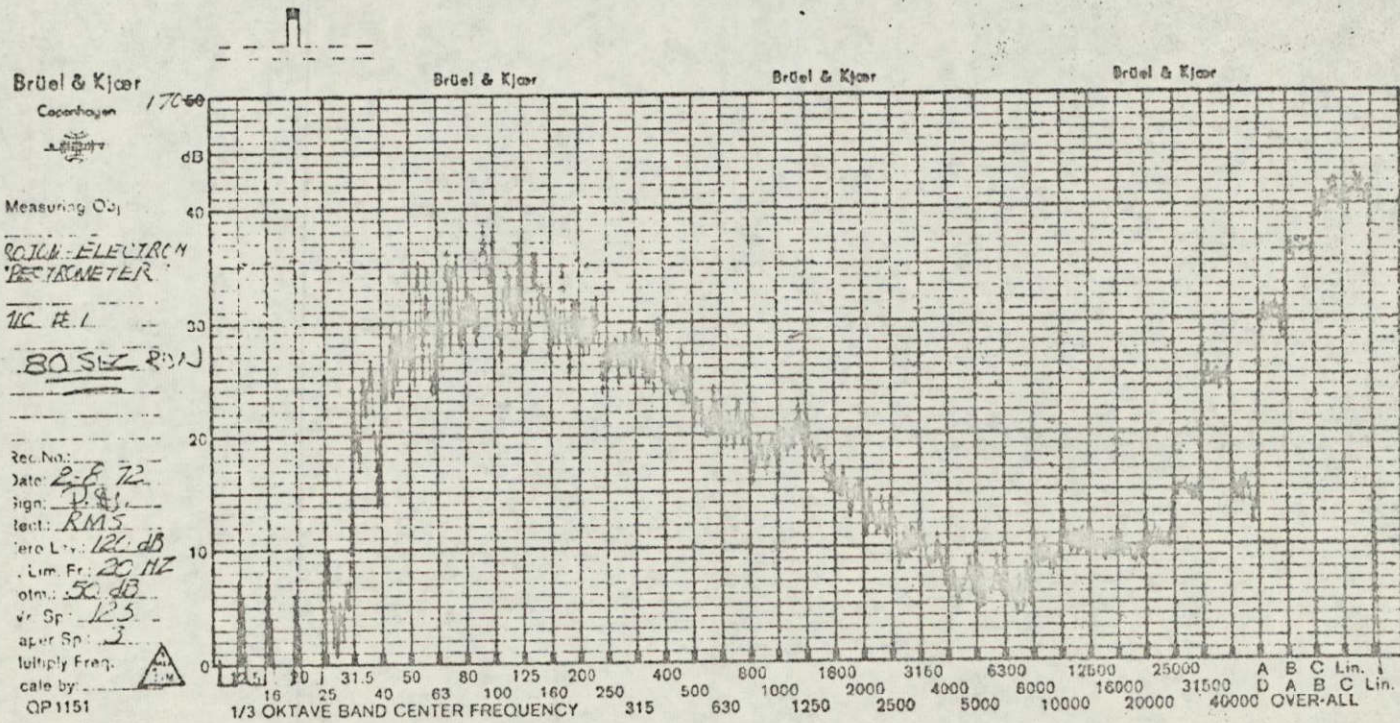


Figure 22 Spectrum Shaped for 165 db
Transonic Buffeting

DATA TAKEN DURING MAXIMUM
AERODYNAMIC RUN



Reproduced from
best available copy.

Figure 23 Data Taken During Maximum
Aerodynamic Run.

ELECTRON/PHOTON SPECTROMETER SKEW TEST DATA
 *X ON BECK ELECTROMETER DATA DATE PROCESSED 02/10/71
 TIME SLICE 19/36/19 TO 19/36/41 F.S CAL=1000.
 DATA RATE = 40000 S/S
 FREQ. INTERVAL 1/6 3RD OCTAVE
 Q VALUE = 10

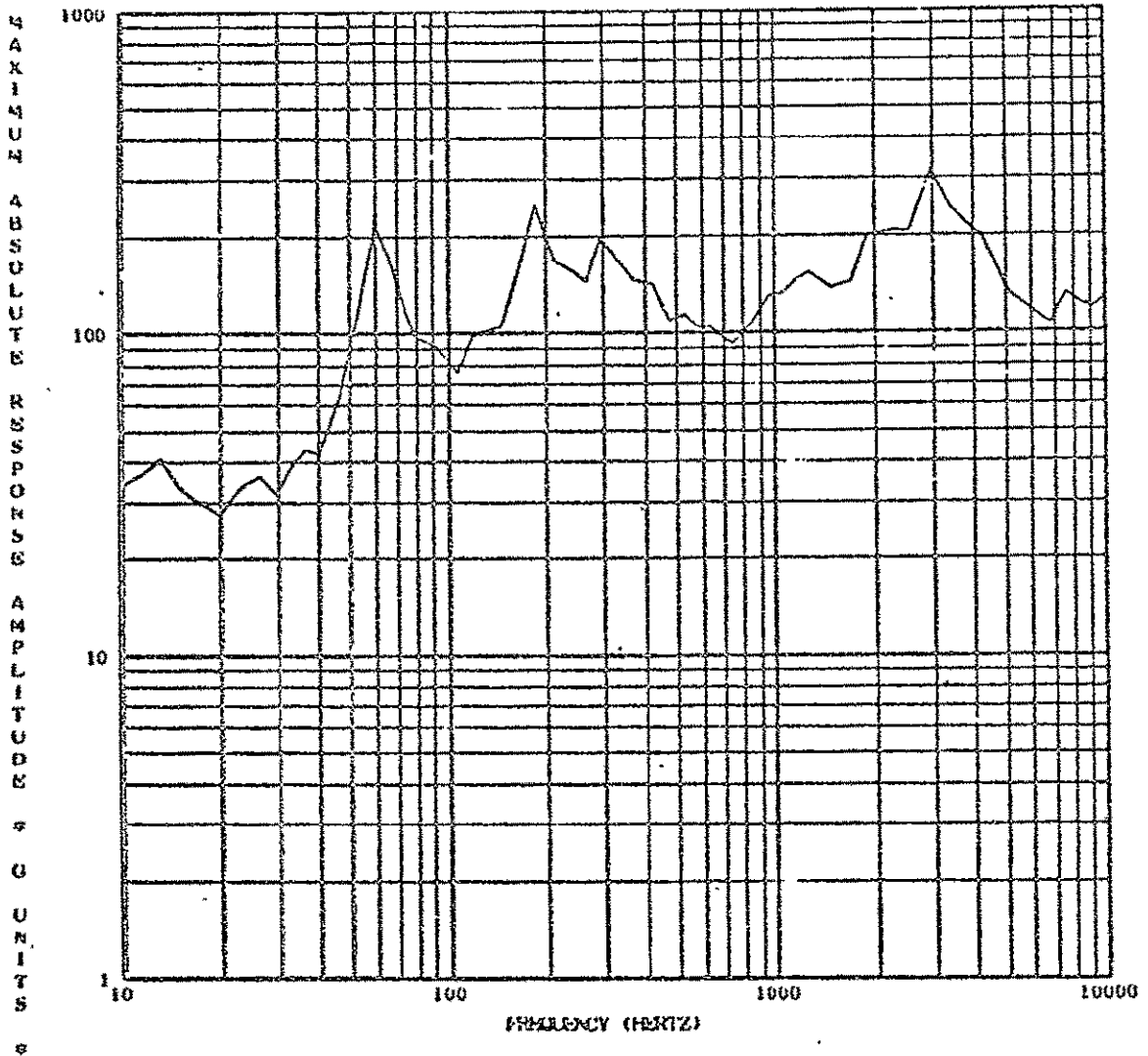


Figure 25 Shock Response Spectrum
 + 'X' Direction, 'X' Axis,
 Electronics Package

ELECTRON/PROTON SPECTROMETER NEAR TEST RUN 04
 -T ON BLACK ACCELEROMETER (ON4 DATE PRESENT) 02/10/71
 TIME SLICE 19/16/19 TO 19/16/41 F. M. = 1000.
 DATA RATE = 40000 S/S
 PROB. INTERV. 1/6 OF CURVE
 G VALUE = 10

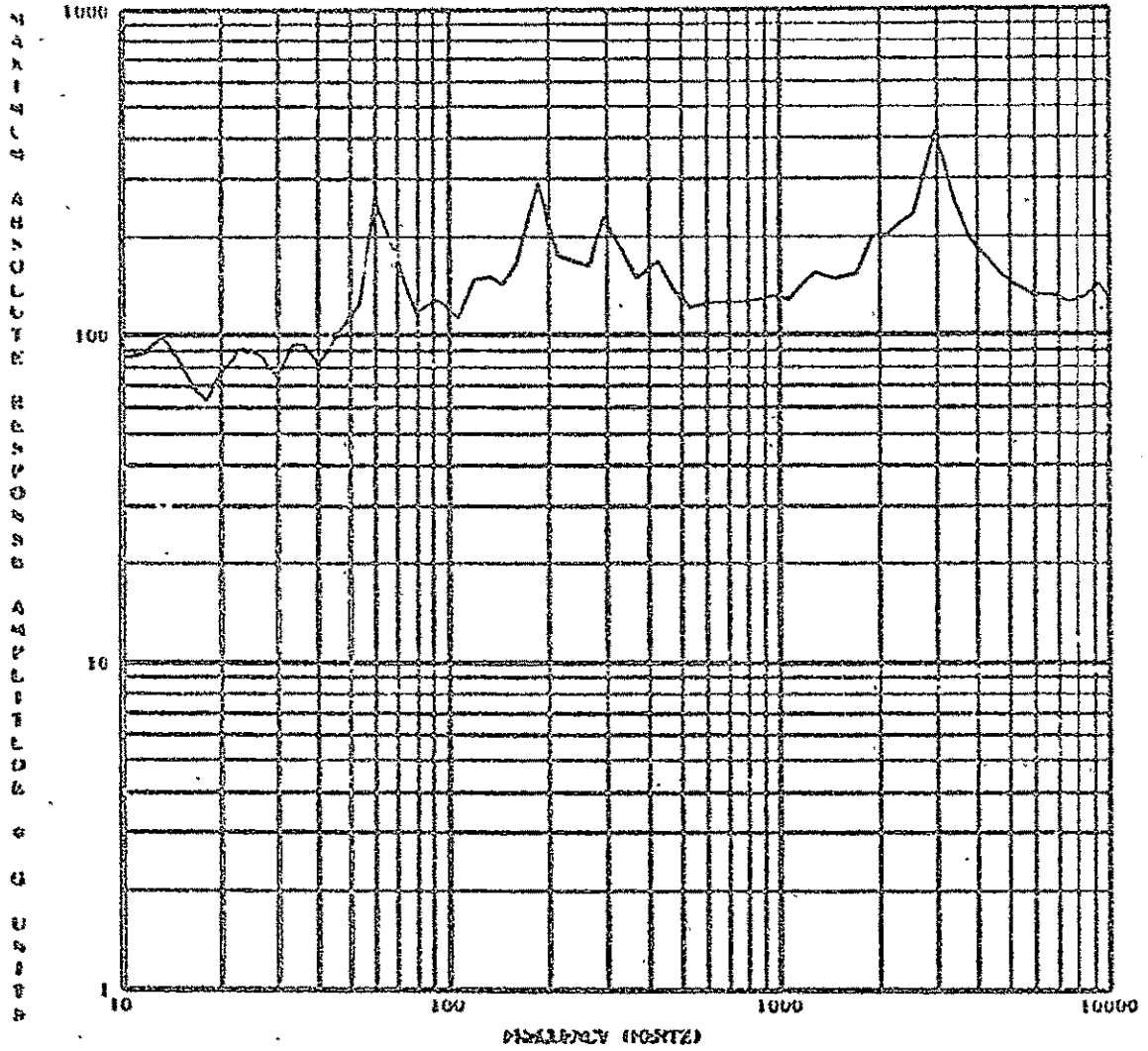


Figure 26 Shock Response Spectrum
 +'X' Direction, 'T' Axis,
 Electronics Package

ELECTRON/PROTON SPECTROMETER SHOCK TEST R/A 54
 *R ON BLOCK ACCELEROMETER TRKS DATE PROCESSED 02/10/71
 TIME SLICE 19/36/39 TO 19/36/41 * F.S. CAL=100.
 DATA RATE = 40000 S/S
 FREQ. INTERVAL: 1/6 TH OCTAVE
 D VALUE = 10

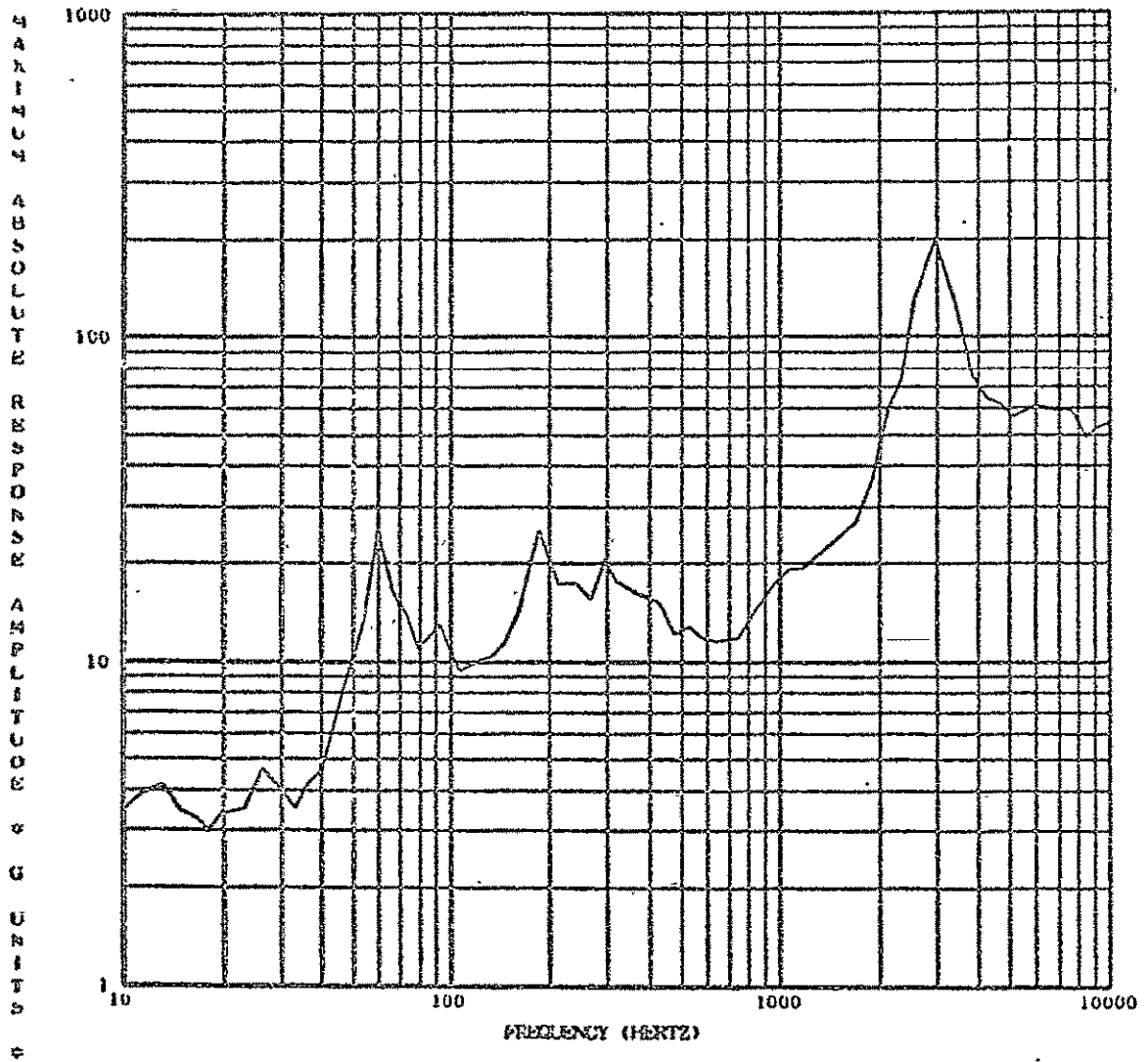


Figure 27 Shock Response Spectrum
 + 'X' Direction, 'R' Axis,
 Electronics Package

ELECTRON/PROTON SPECTROMETER SHOCK TEST RUN 56
 BOTTOM -R ACCELEROMETER 10KZ DATA PROCESSED 02/10/71
 TIME SLICE 19/36/39 TO 19/36/41 F.S.C.S.=1000.
 DATA RATE = 40000 S/S
 PROJ. INTERVAL, 1/6 TH OCTAVE
 G SCALE = 10

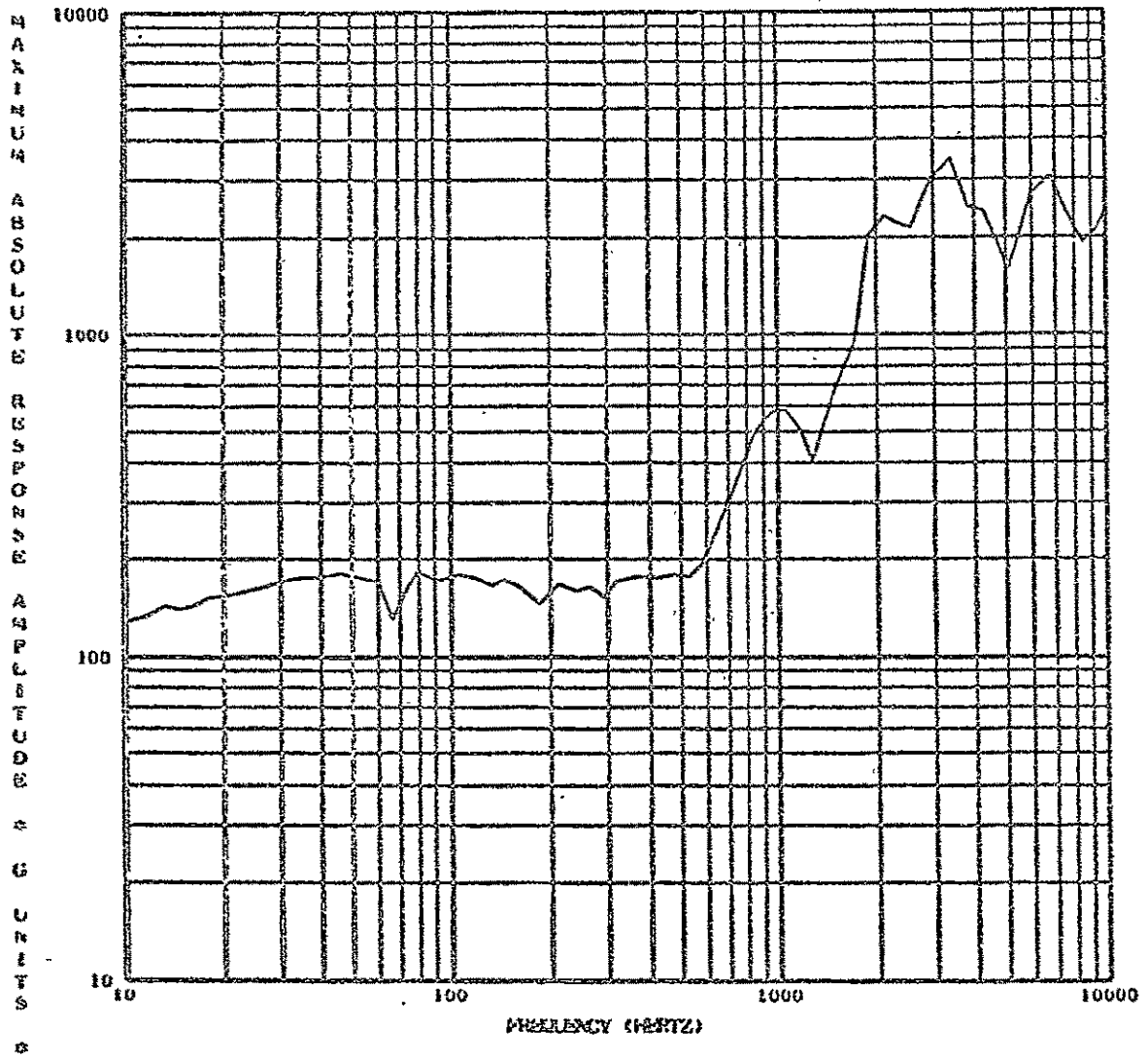


Figure 28 Shock Response Spectrum
 + 'X' Direction, 'R' Axis,
 Baseplate

ELECTRON/PHOTON SPECTROMETER SEARCH TEST RUN 55
 CONTROL ACCELEROMETER TRAIL DATA PROCESSED 02/10/71
 TIME SLICE 20/22/04 TO 20/22/06 F.S.C.M.=1000.
 DATA RATE = 40000 S/S
 FREQ. INTERVAL 1/8 TH OCTAVE.
 Q VALUE = 10

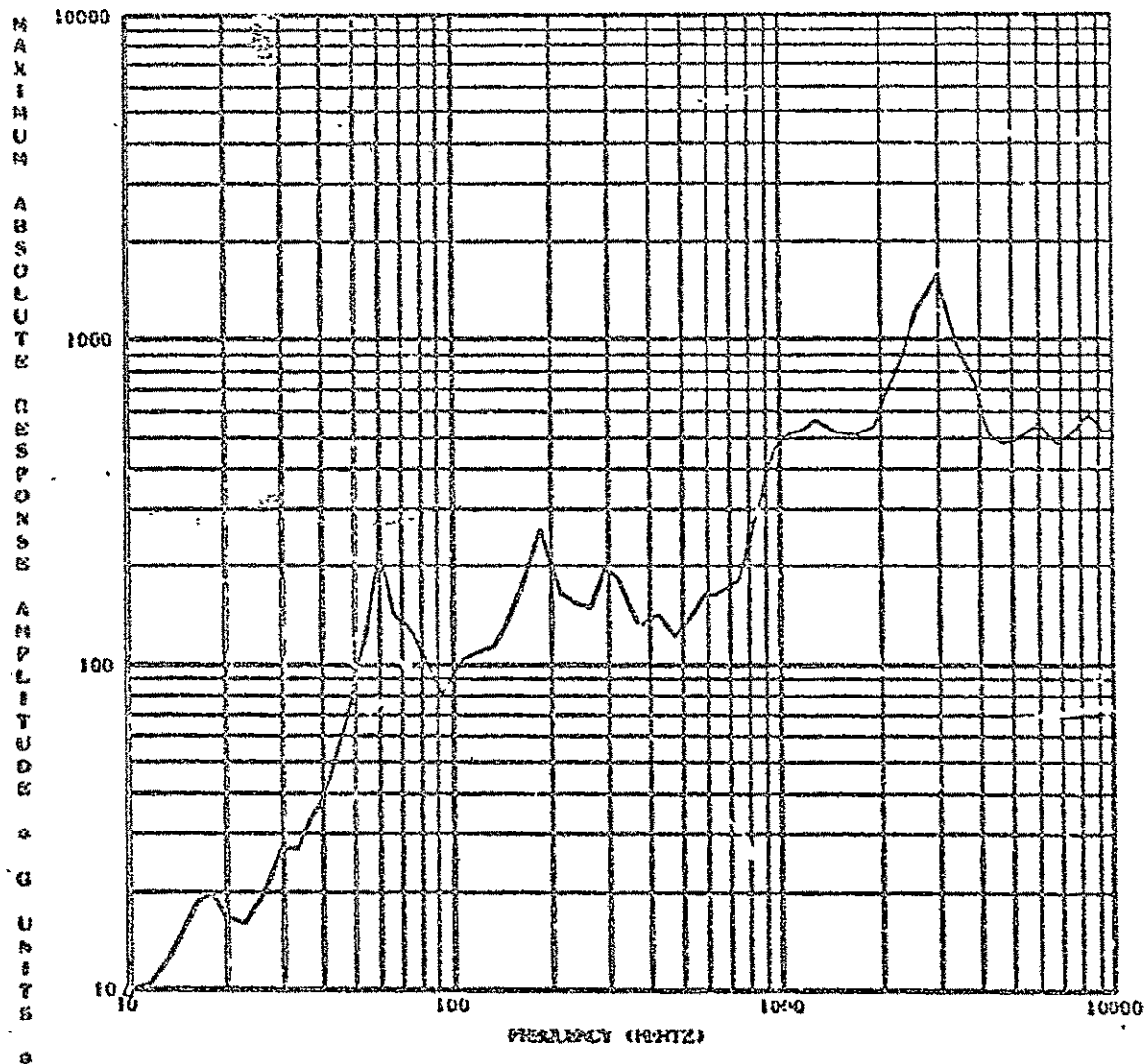


Figure 29 Shock Response Spectrum,
 Input, -X Direction

ELECTRON/PROTON SPECTROMETER SHOCK TEST RUN 55
 *X ON BLACK ACCELEROMETER TRIAS DATA PROCESSED 02/10/71
 TIME SLICE 20/22/01 TO 20/22/06 F.S.GAIN=100.0
 DATA RATE = 40000 S/S
 FREQ. INTERVAL 1/6 TH OCTAVE
 Q VALUE = 10

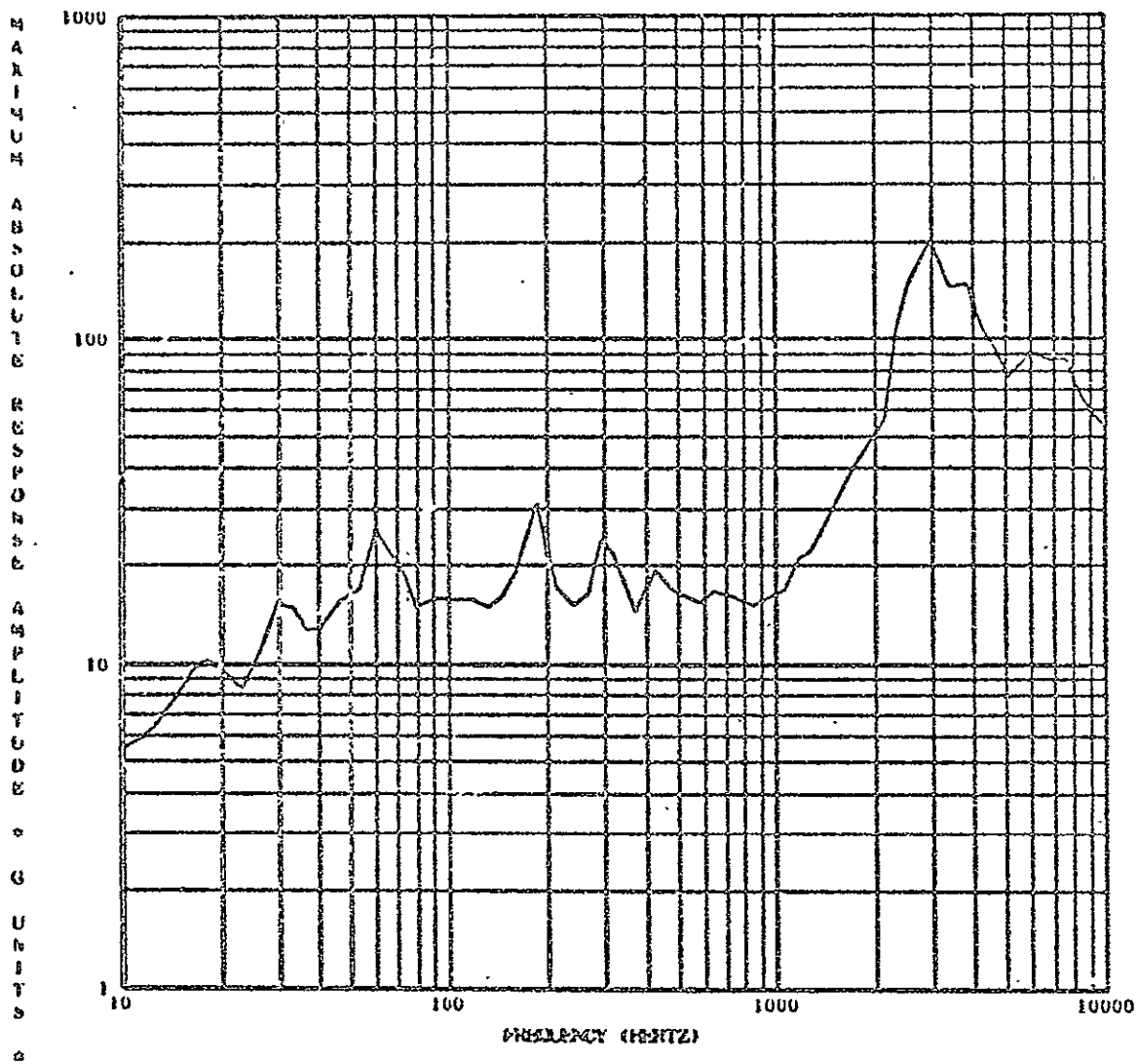


Figure 30 Shock Response Spectrum
 -'X' Direction, 'X' Axis,
 Electronics Package

ELECTRON/PHOTON SPECTROMETER NOISE TEST RUN 55
 -T ON BLACK RECTIFIER/SEMICONDUCTOR DATE PREPARED 02/11/71
 TIME SLICE 20/22/03 TO 20/22/06 F.S.C.R.=100.0
 DATA RATE = 40000 S/S
 FREQ. INTERVAL 1/6 IN OCTAVE
 Q-VALUE = 10

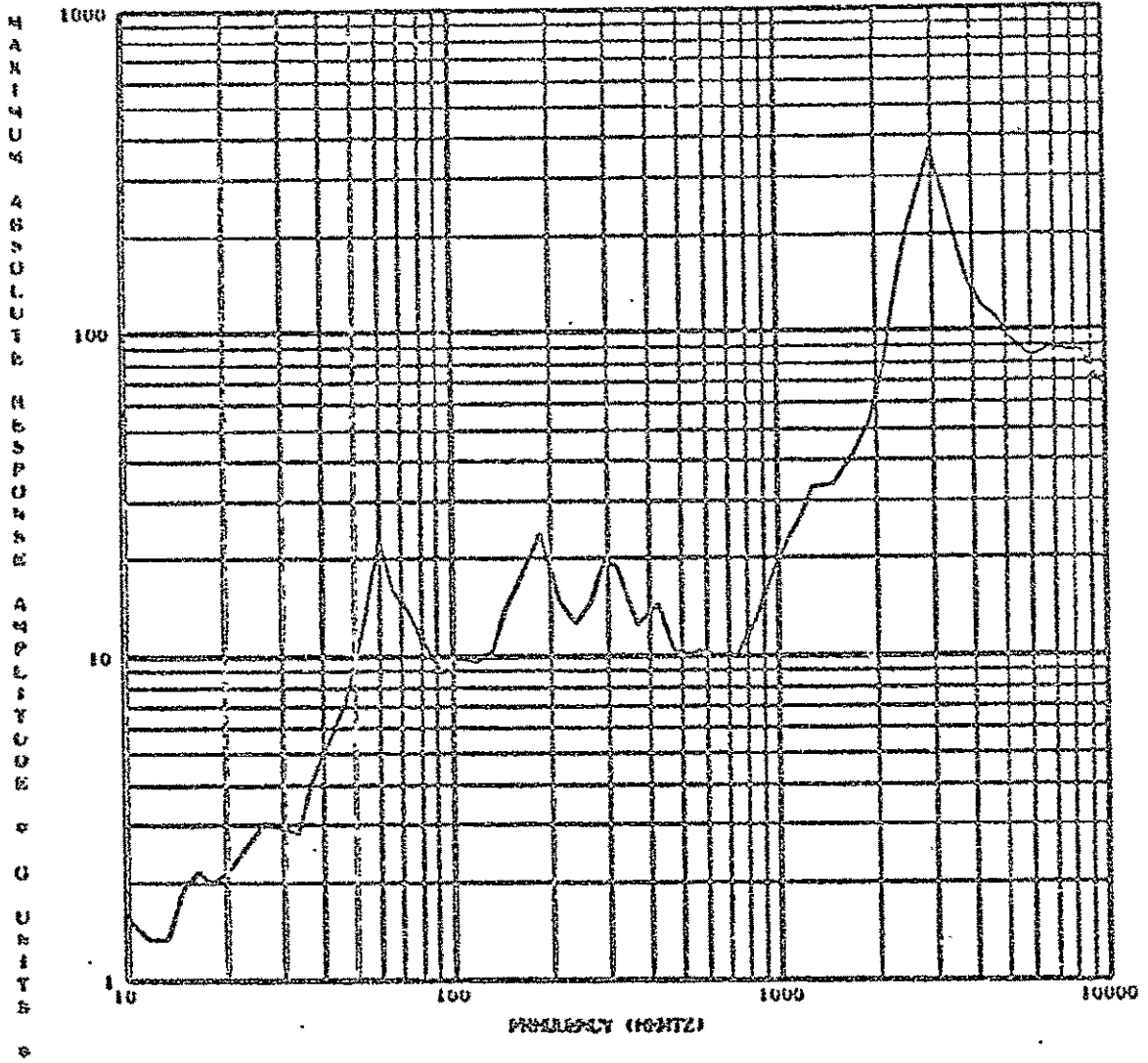


Figure 31 Shock Response Spectrum
 -'X' Direction, 'T' Axis,
 Electronics Package

ELECTRON/PROTON SPECTROMETER NELA TEST RA 55
 4R ON BLACK ACCELEROMETER TEST DATE PROCESSED 02/10/71
 TIME SLICE 20/22/03 TO 20/22/06 F.S.CAL=100.0
 DATA RATE = 40000 S/S
 FREQ. INTERVAL 1/6 TH OCTAVE
 Q VALUE = 10

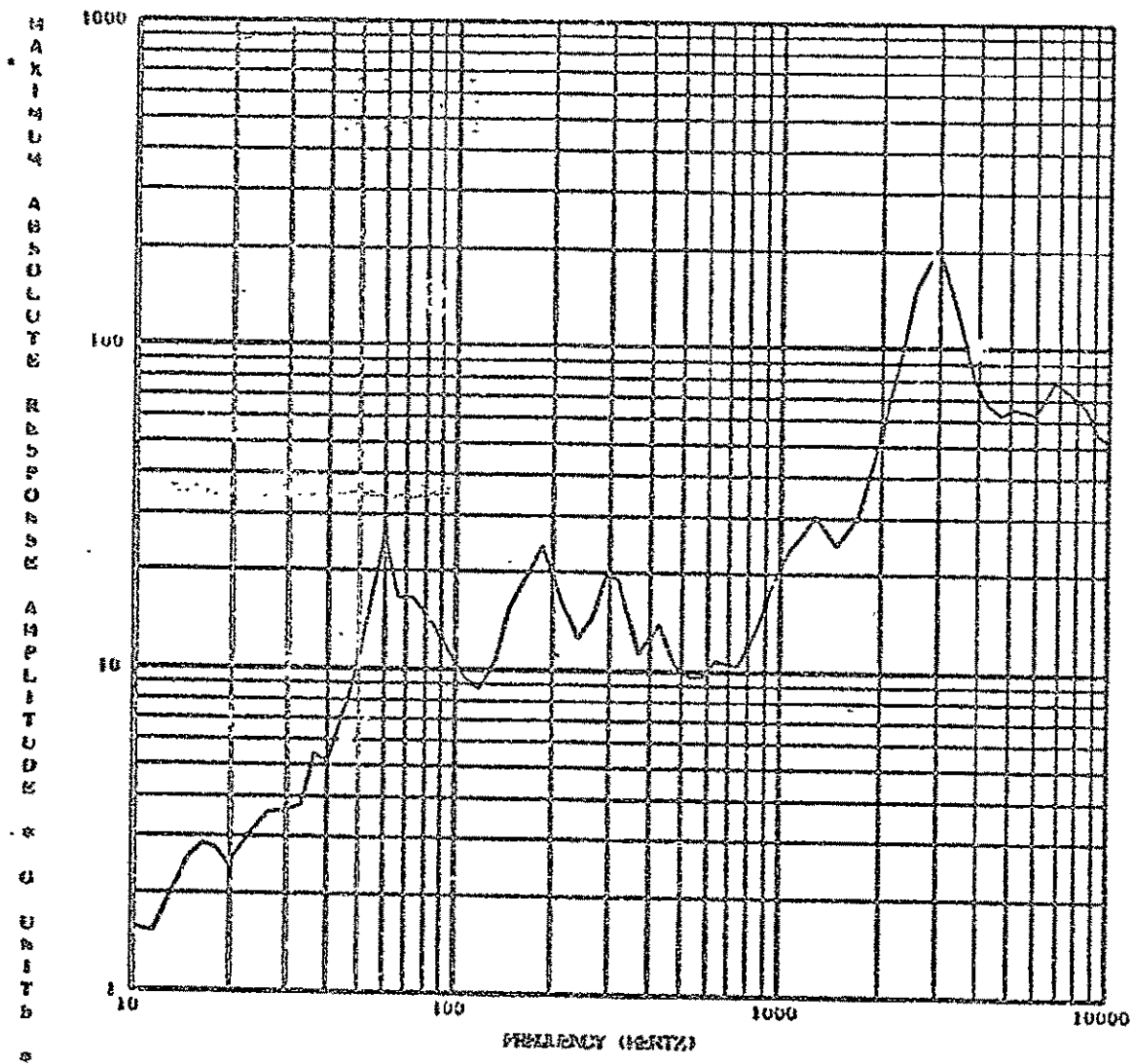


Figure 32 Shock Response Spectrum
 -'X' Direction, 'R' Axis,
 Electronics Package

ELECTRON/PHOTON SPECTROMETER MODEL TEST RA 55
EXHIBIT -R ACCELEROMETER TEST DATA, PROCESSED 02/10/71
TIME SLICE 20/22/01 TO 20/22/06 F.S.CAL.=1000;
DATA RATE = 40000 S/S
FREQ. INTERVAL: 1/6 TH OCTAVE
Q VALUE = 10

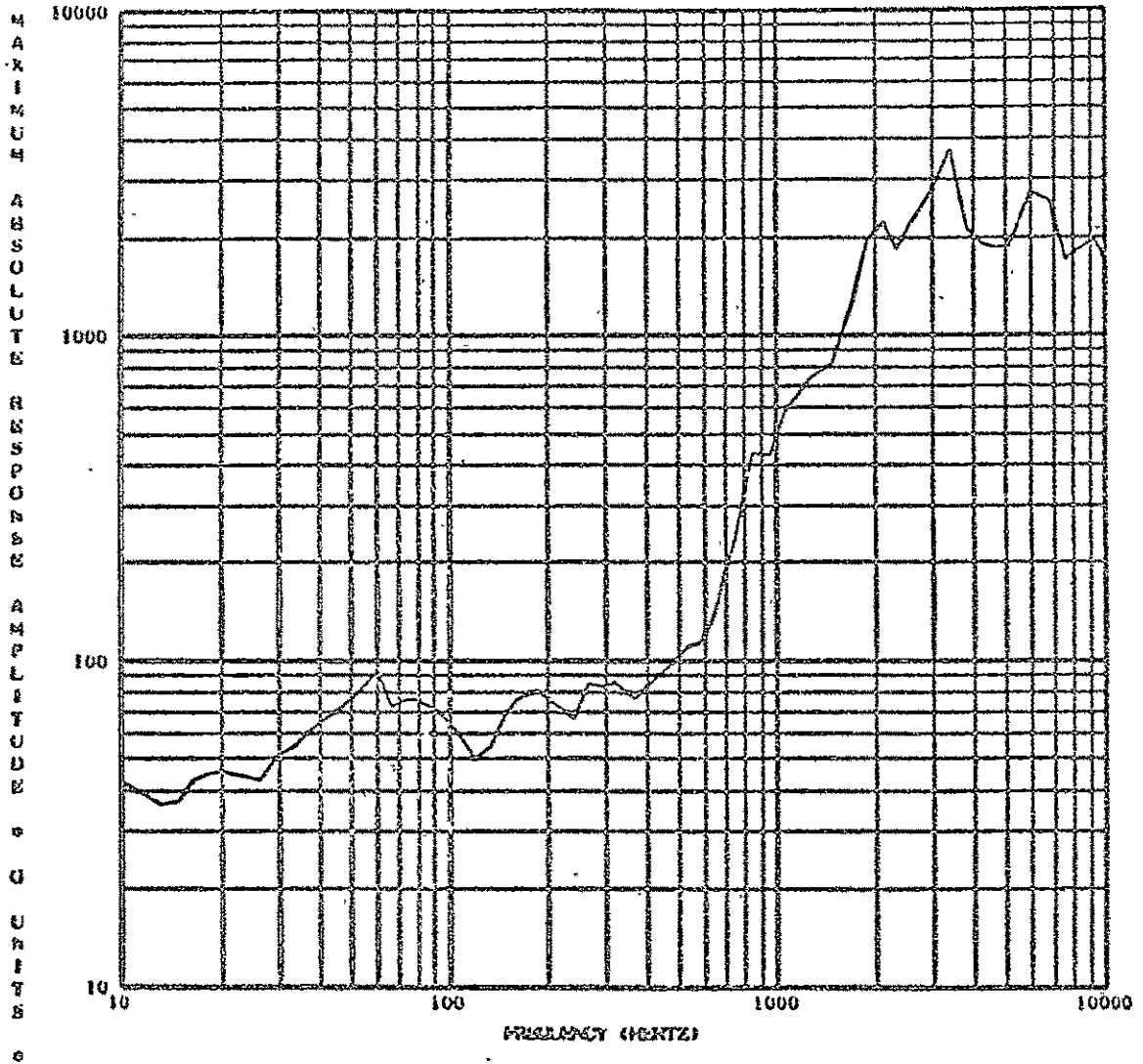


Figure 33 Shock Response Spectrum
-'X' Direction, 'R' Axis,
Baseplate

ELECTRON/HIGH SPEED SPECTROMETER SHOCK TEST RUN 56
 SHOCK OUTPUT TEST DATA PROCESSED 02/10/72
 TIME RANGE 20/56/49 TO 20/56/52 F.S.CAL=1000.
 DATA RATE = 40000 S/S
 FREQ. INTERVAL 1/6 TH OCTAVE
 G SCALE = 10

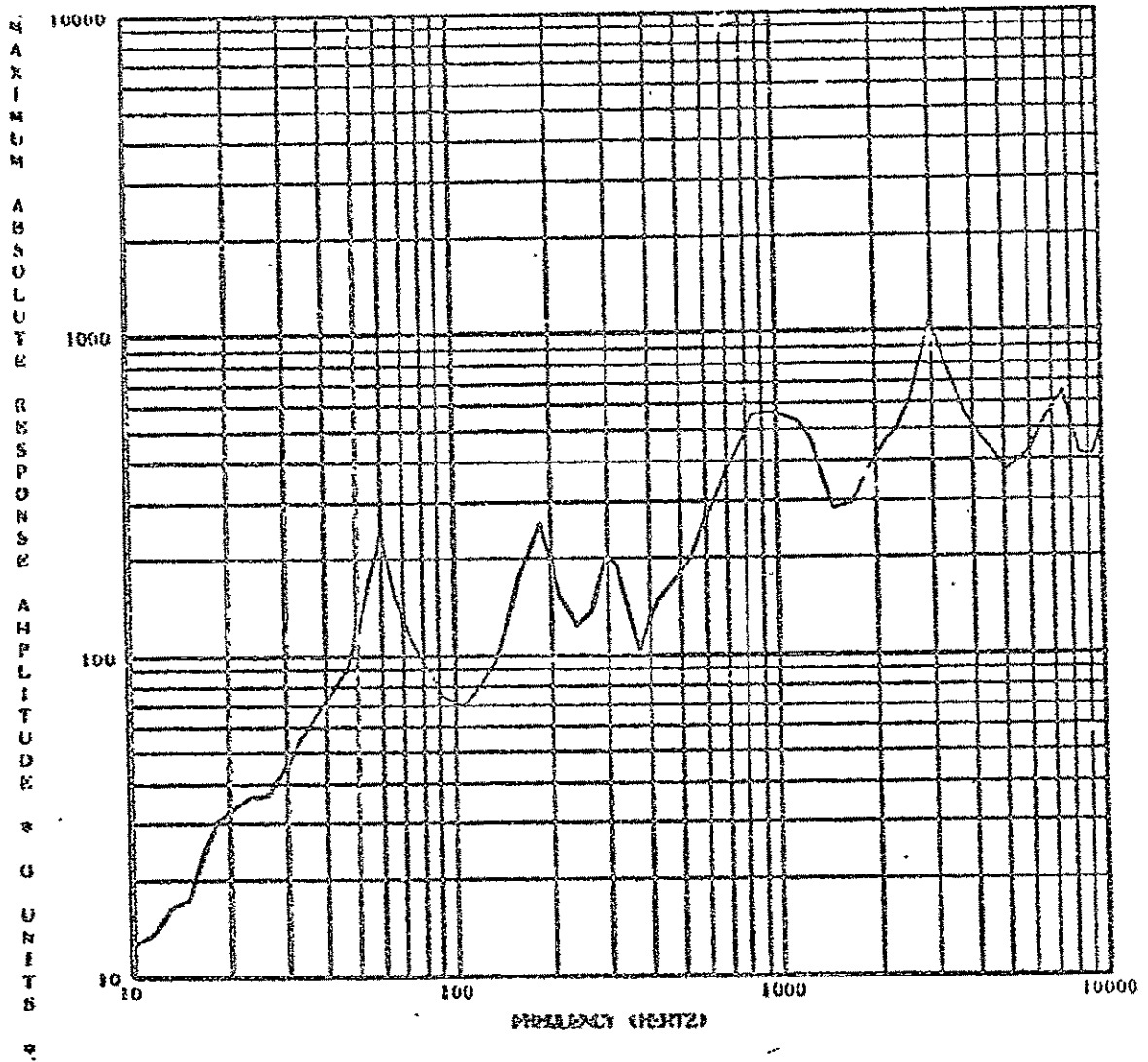


Figure 34 Shock Response Spectrum,
 Input, -T Direction

ELECTRON/PROTON SPECTROMETER SHOCK TEST RUN 56
 -T ACCEL TRK4 DATE PROCESSED 02/11/72
 TIME SLICE 20/56/49 TO 20/56/52 F.S.CAL=100.
 DATA RATE = 40000 S/S
 FREQ. INTERVAL 1/6 TH OCTAVE
 Q VALUE = 10

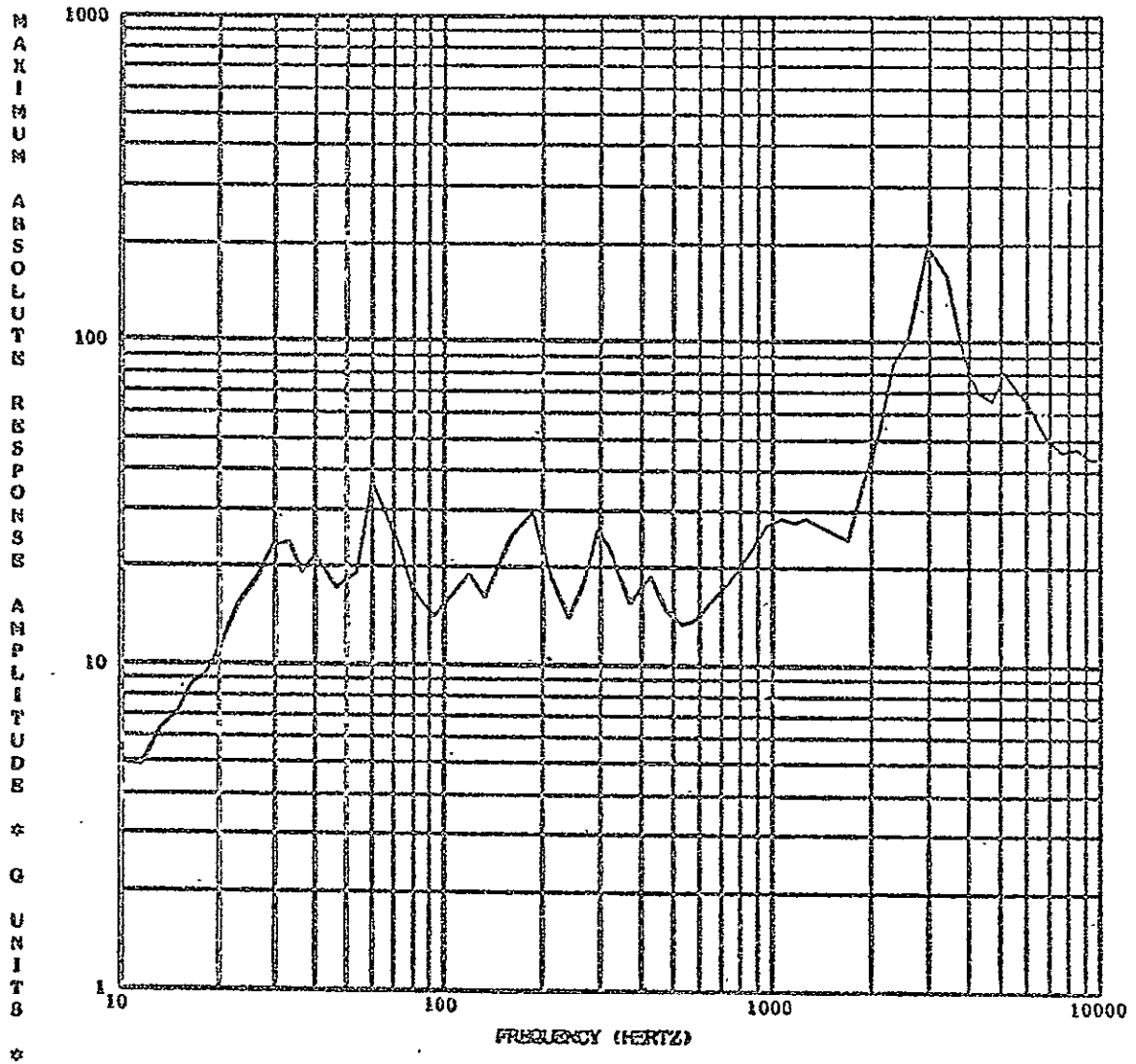


Figure 35 Shock Response Spectrum
 -'T' Direction, 'T' Axis,
 Electronics Package

ELECTRON/PROTON SPECTROMETER SHOCK TEST RUN 56
 OR ACCEL TRK3 DATE PROCESSED 02/11/72
 TIME SLICE 20/56/49 TO 20/56/52 F.S.CAL=100.
 DATA RATE = 40000 S/S
 FREQ. INTERVAL 1/6 TH OCTAVE
 Q VALUE = 10

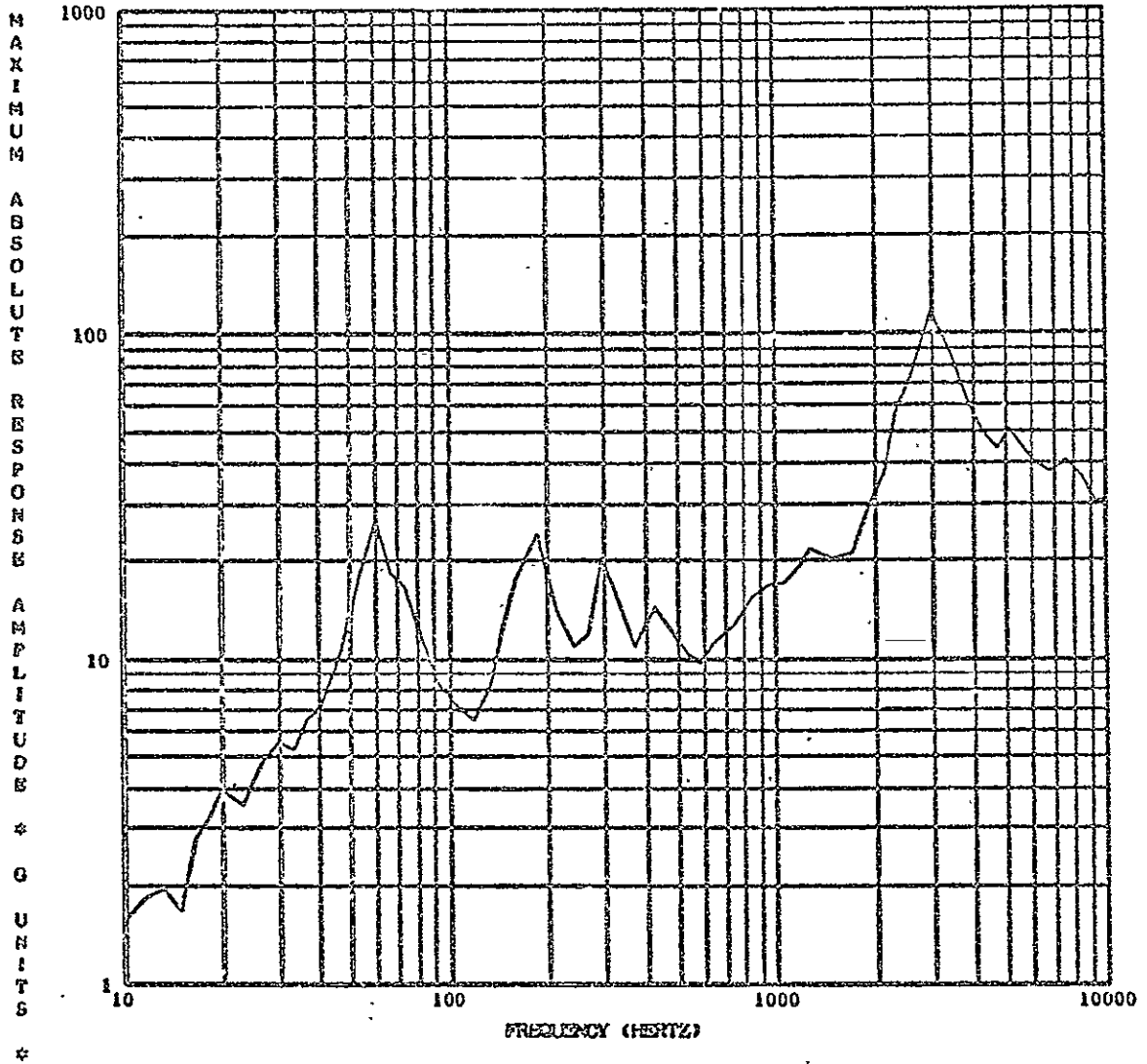


Figure 36 Shock Response Spectrum
 -'T' Direction, 'R' Axis,
 Electronics Package

ELECTRON/PROTON SPECTROMETER SHOCK TEST RUN 56
 *K ACCEL TRKS DATE PROCESSED 02/11/72
 TIME SLICES 20/56/49 TO 20/56/52 F.S.CAL=100.
 DATA RATE = 40000 S/S
 PRDZ. INTERVAL 1/6 TH OCTAVE
 Q VALUES = 10

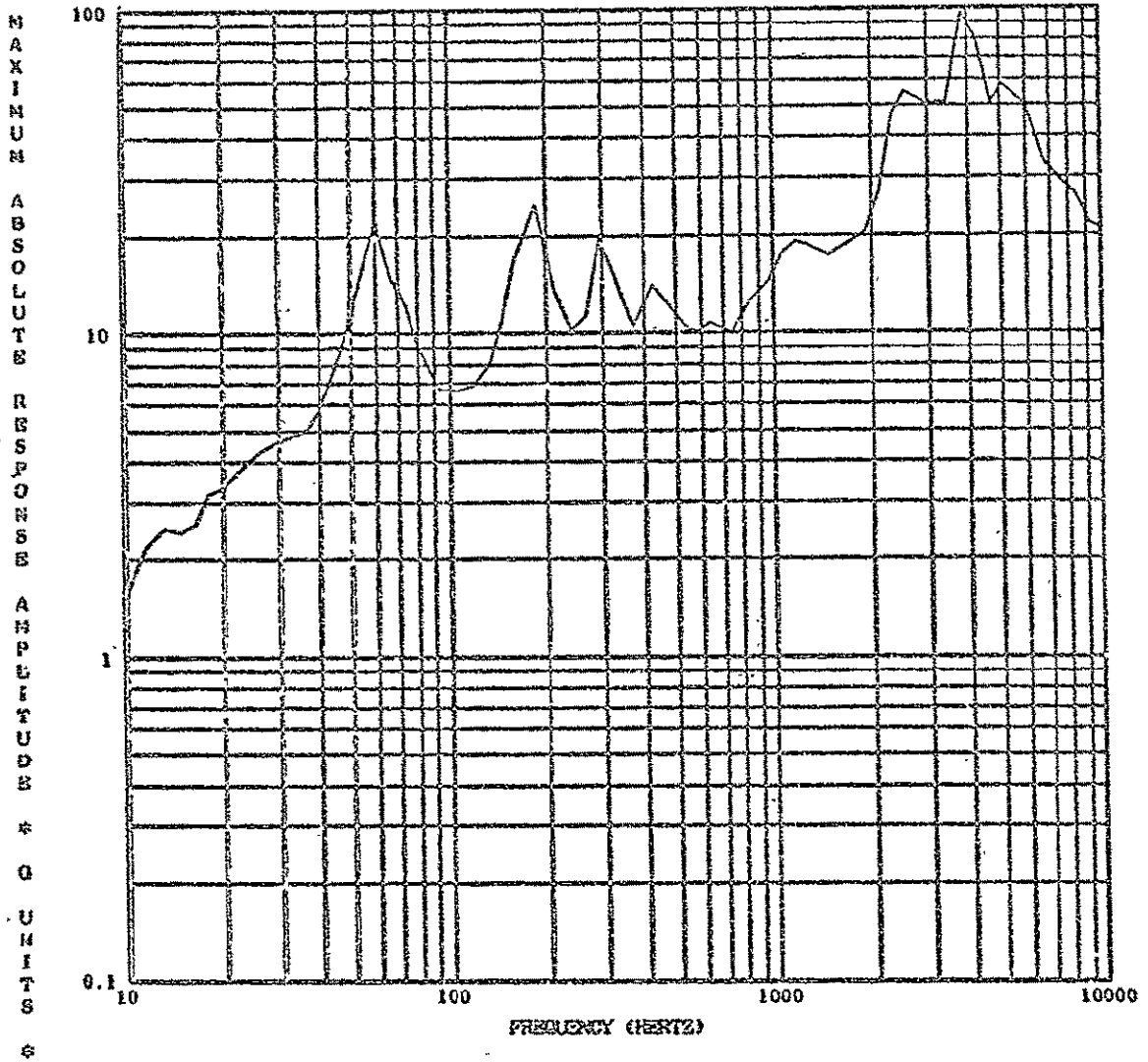


Figure 37 Shock Response Spectrum
 -T Direction, 'X' Axis,
 Electronics Package

ELECTRON/PROTON SPECTROMETER SHOCK TEST RUN 56
 -N ACCEL TRK2 DATA PROCESSED 02/11/72
 TIME SLICE 20/56/49 TO 20/56/52 F.S.CAL=1000.
 DATA RATE = 40000 S/S
 FREQ. INTERVAL 1/6 TH OCTAVE
 Q VALUE = 10

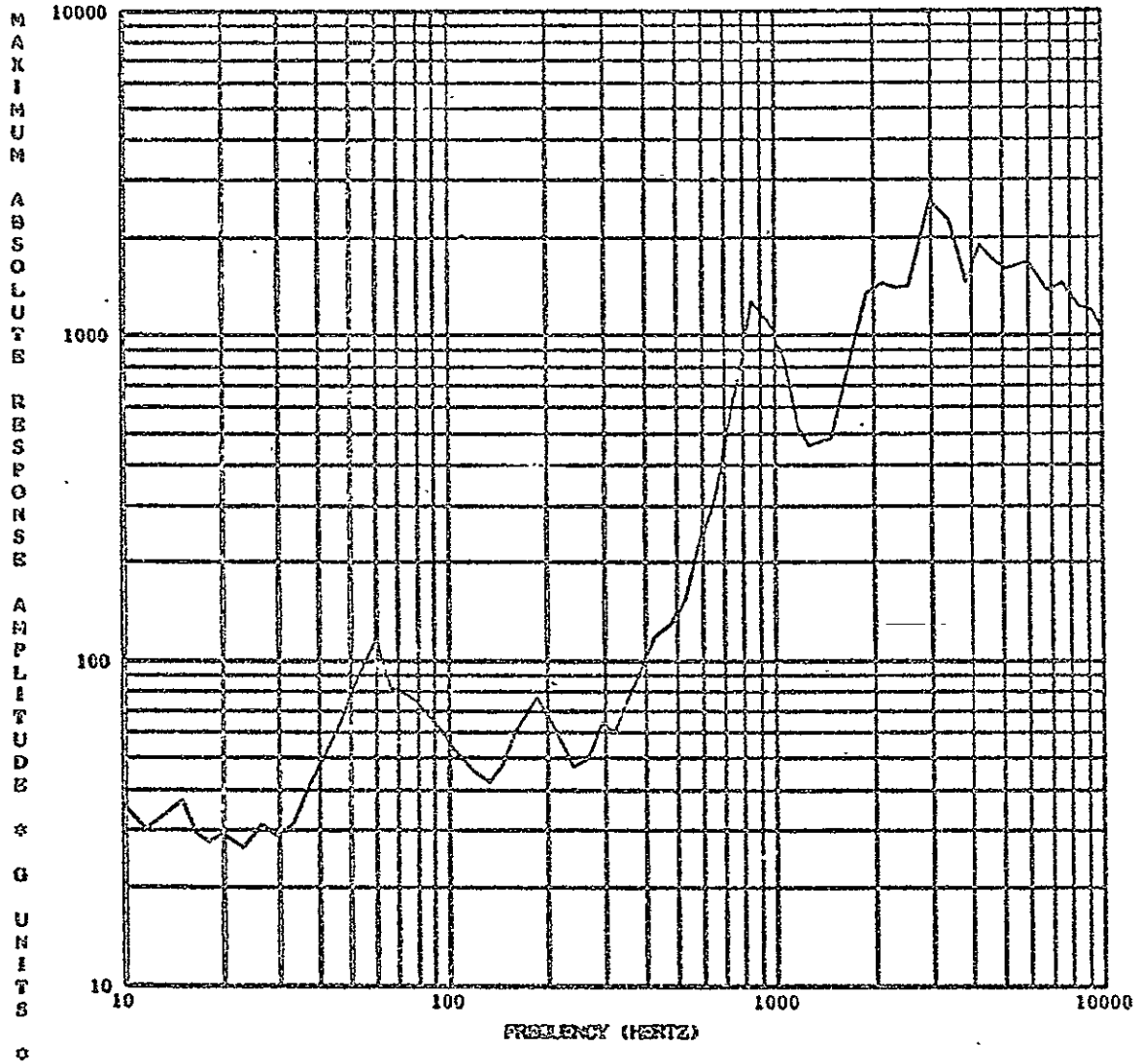


Figure 38 Shock Response Spectrum
 -T Direction, 'R' Axis,
 Baseplate

ELECTRON/PHOTON SPECTROMETER NCKA TEST IRN 57
NCKA OUTPUT DATA DATE PROCESSED 02/10/72
TIME SLICE 21/06/68 TO 21/06/67 F.S.C.M.=1000.
DATA RATE = 40000 S/S
PRDZ. INTERVAL 1/6 TH OCTAVE
Q VALUE = 10

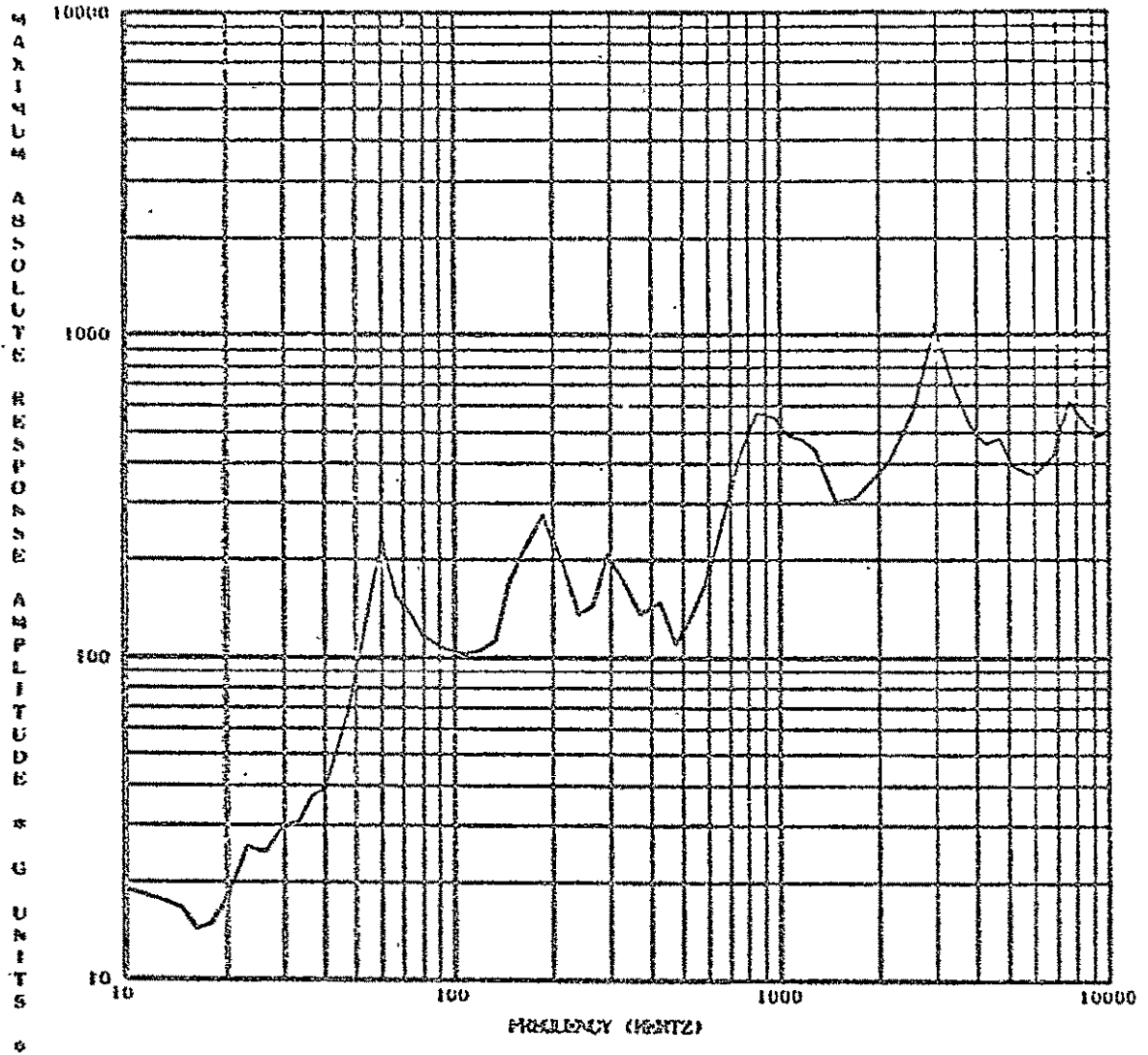


Figure 39 Shock Response Spectrum
Input, +T Direction

ELECTRON/PROTON SPECTROMETER SHOCK TEST RUA 57
 -T AXCEL TRKA DATE PROCESSED 02/11/72
 TIME SLICE 21/06/04 TO 21/06/07 F.S.CAL=100.
 DATA RATE = 40000 S/S
 FREQ. INTERVAL 1/6 TH OCTAVE
 G VALS = 10

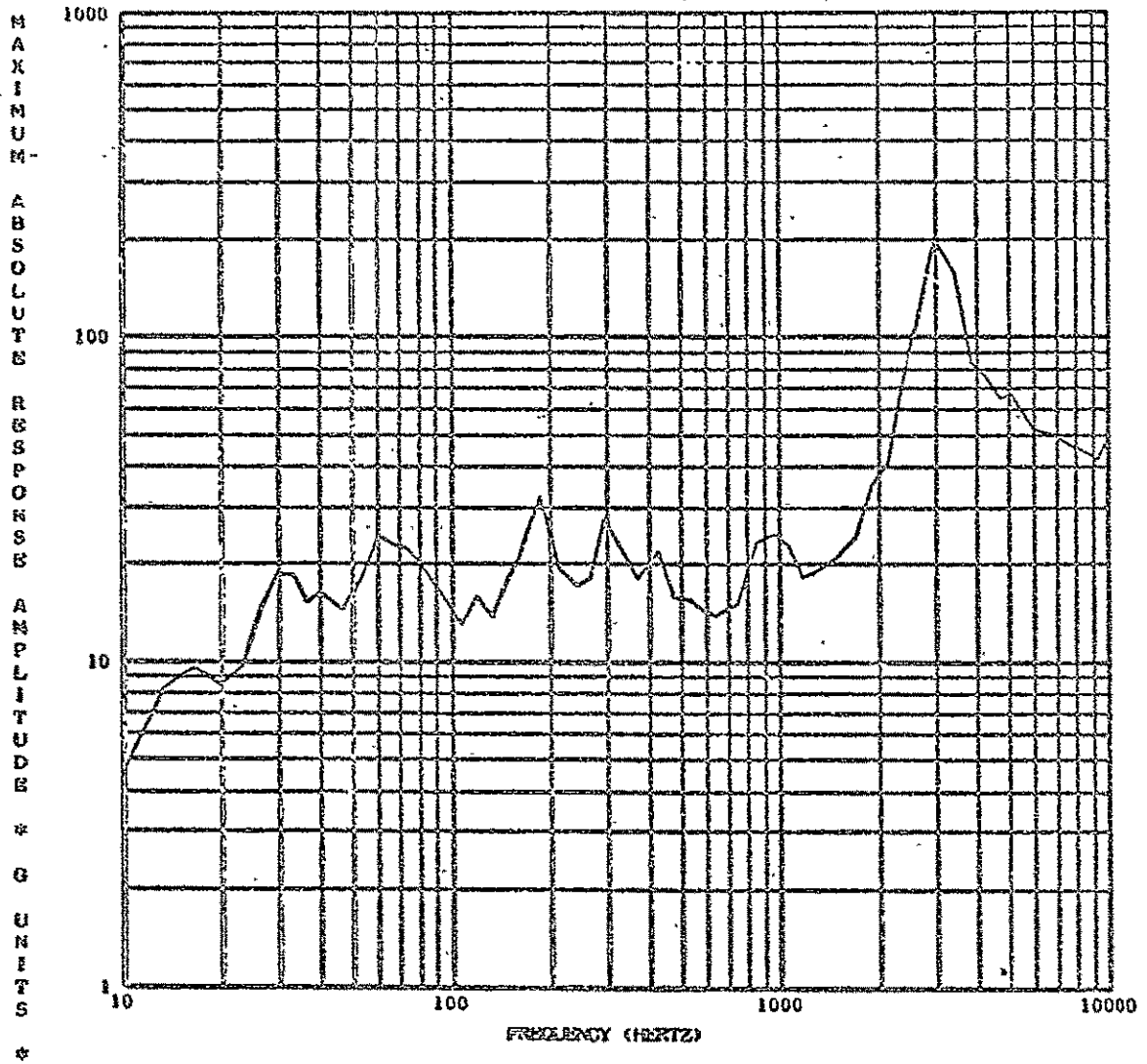


Figure 40 Shock Response Spectrum
 + 'T' Direction, 'T' Axis,
 Electronics Package



ELECTRON/PROTON SPECTROMETER SHOCK TEST RUN 57
 *X ACCEL TRKS DATE PROCESSED 02/11/72
 TIME SLICE 21/06/04 TO 21/06/07 F.S.CAL=100.
 DATA RATE = 40000 S/S
 FREQ. INTERVAL 1/6 TH OCTAVE
 Q VALUE = 10

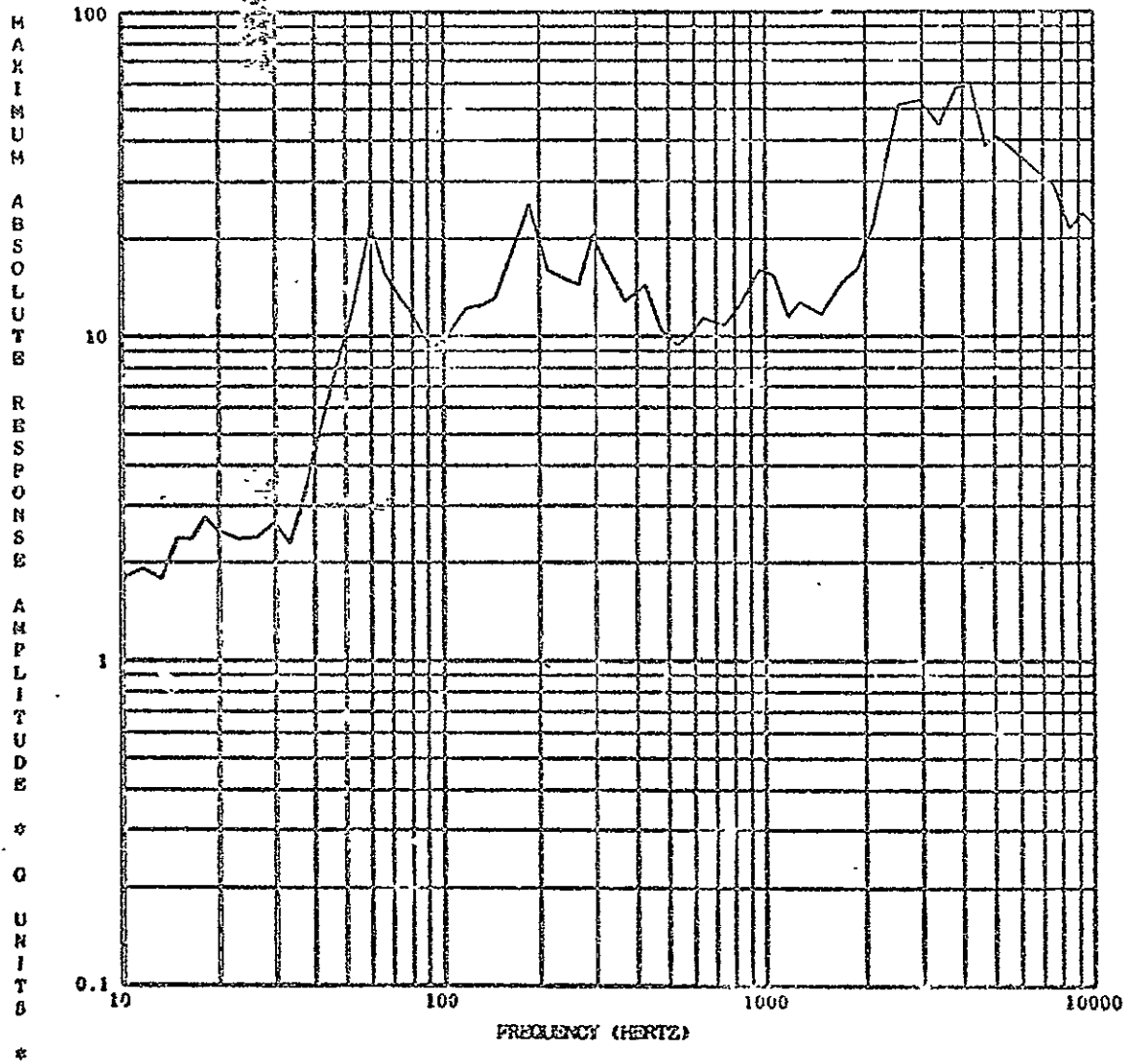


Figure 41 Shock Response Spectrum
 +T Direction, X Axis,
 Electronics Package



ELECTRON/PROTON SPECTROMETER SHOCK TEST RUN 57
4R ACCEL TRK3 DATE PROCESSED 02/11/72
TIME SLICS 21/06/04 TO 21/06/07 P.S.CAL=100.
DATA RATE = 40000 S/S
FREQ. INTERVAL 1/6 TH OCTAVE
Q VALUE = 10

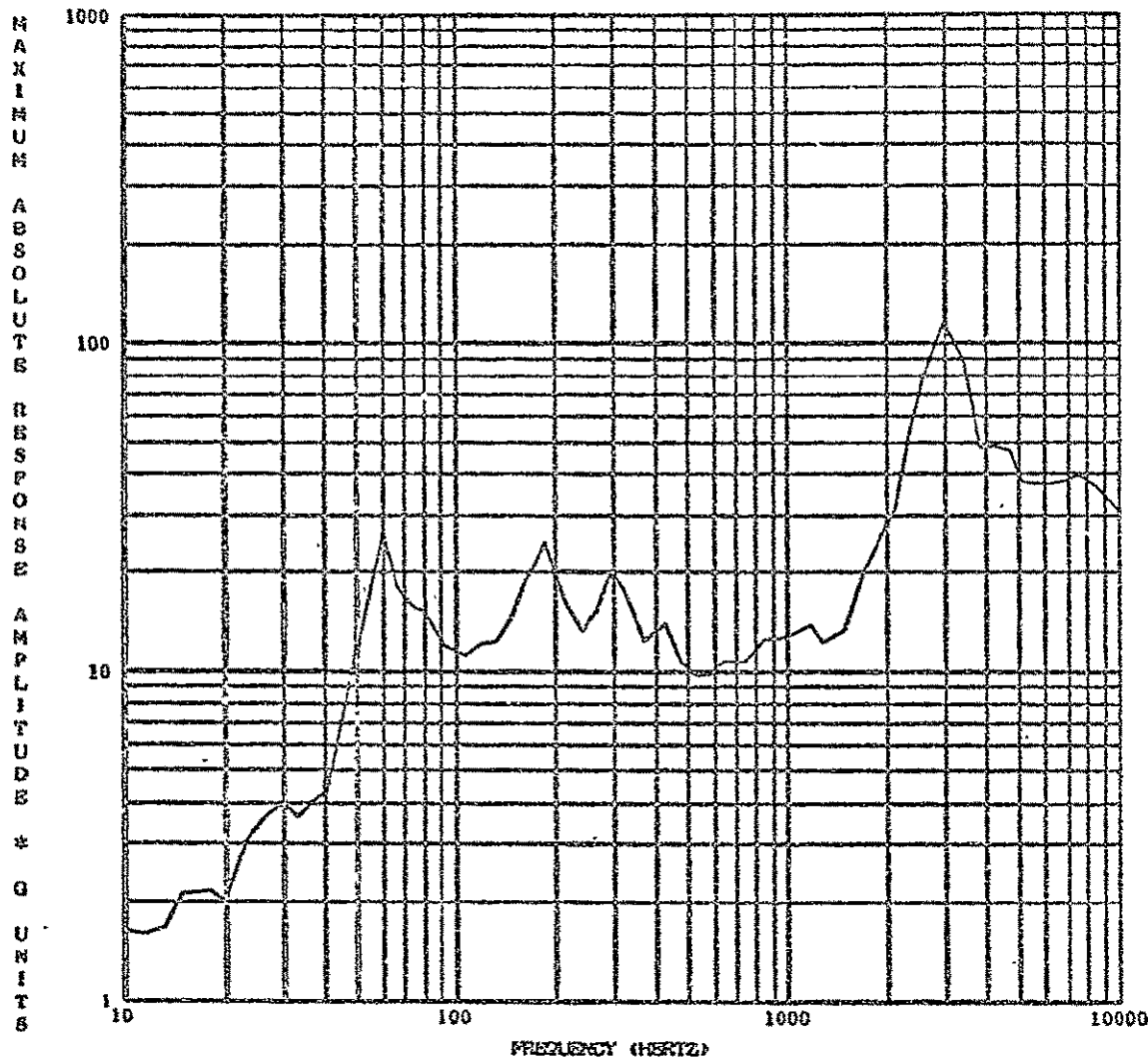


Figure 42 Shock Response Spectrum
+T Direction, 'R' Axis,
Electronics Package



ELECTRON/PROTON SPECTROMETER MECK TEST RUN 57
 -N ADCEL. TRK2 DATE PROCESSED 02/11/72
 TIME SLICE 21/06/04 TO 21/06/07 F.S.CAL=1000.
 DATA RATE = 40000 S/S
 FREQ. INTERVAL, 1/6 TH OCTAVE
 Q VALUE = 10

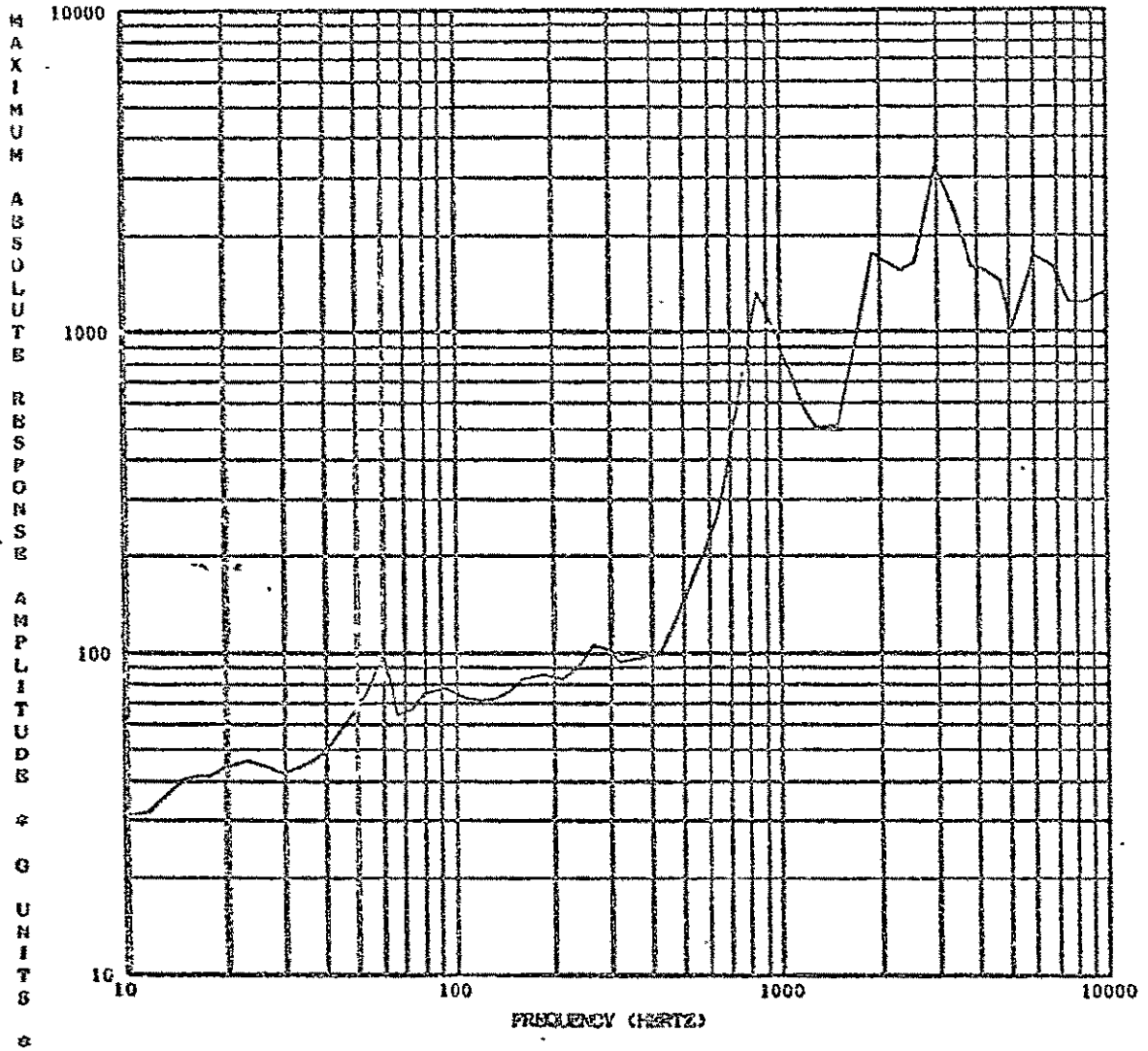


Figure 43 Shock Response Spectrum
 +T Direction, 'R' Axis,
 Baseplate



ELECTRON/PROTON SPECTROMETER SHOCK TEST RUN 5*
 SHOCK OUTPUT TEST DATE PROCESSED 02/10/72
 TIME SLICE 22/11/31 TO 22/11/34 F.S.CAL=1000
 DATA RATE = 40000 S/S
 FREQ. INTERVAL 1/6 TH OCTAVE
 Q VALUE = 10

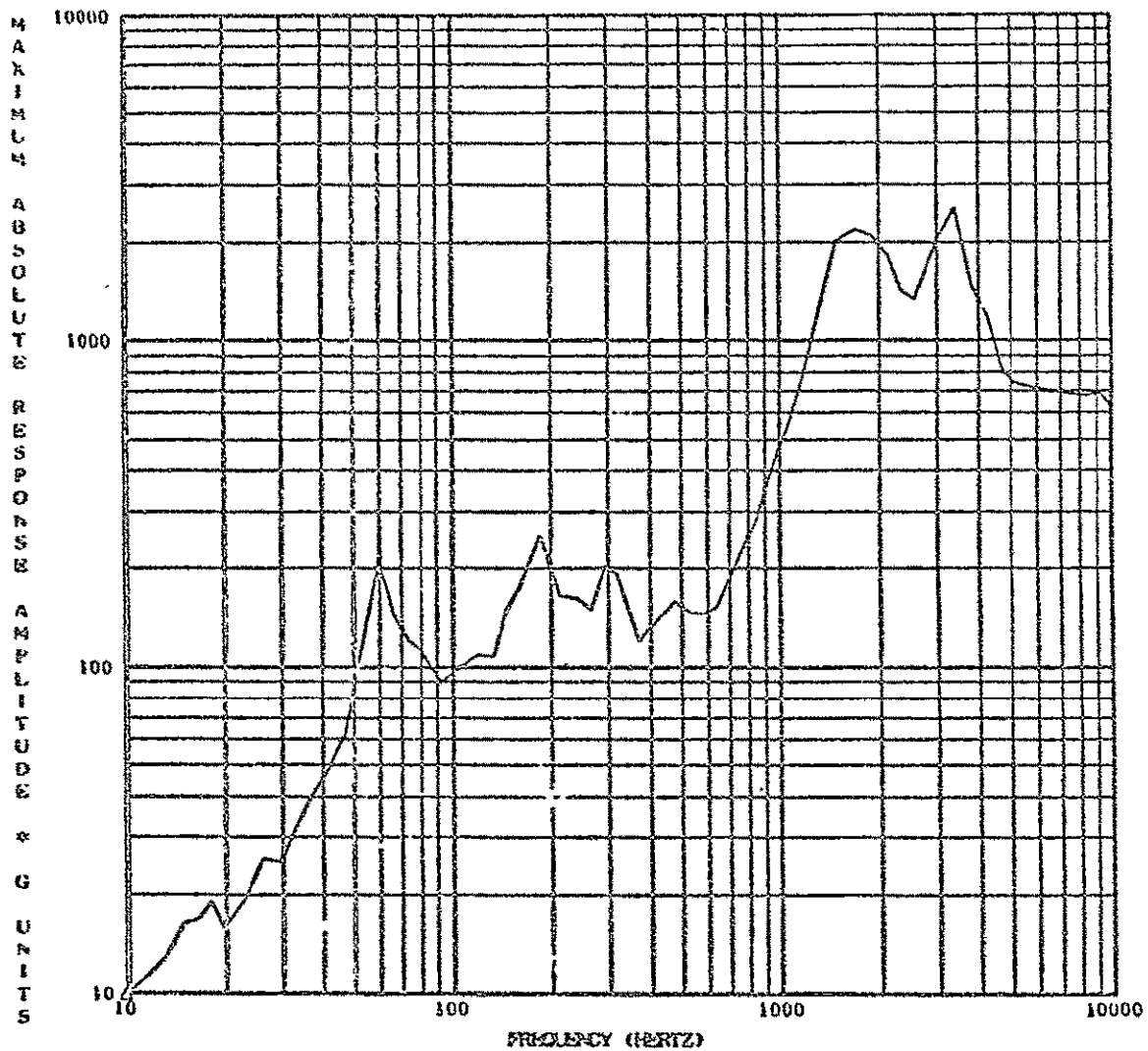


Figure 44 Shock Response Spectrum
 Input, +R Direction

ELECTRON/PROTON SPECTROMETER SHOCK TEST RUN 58
*R ACCEL TRK3 DATE PROCESSED 02/11/72
TIME SLICE 22/11/31 TO 22/11/34 F.S.CAL=100.
DATA RATE = 40000 S/S
PRSQ. INTERVAL 1/6 TH OCTAVE
Q VALUES = 10

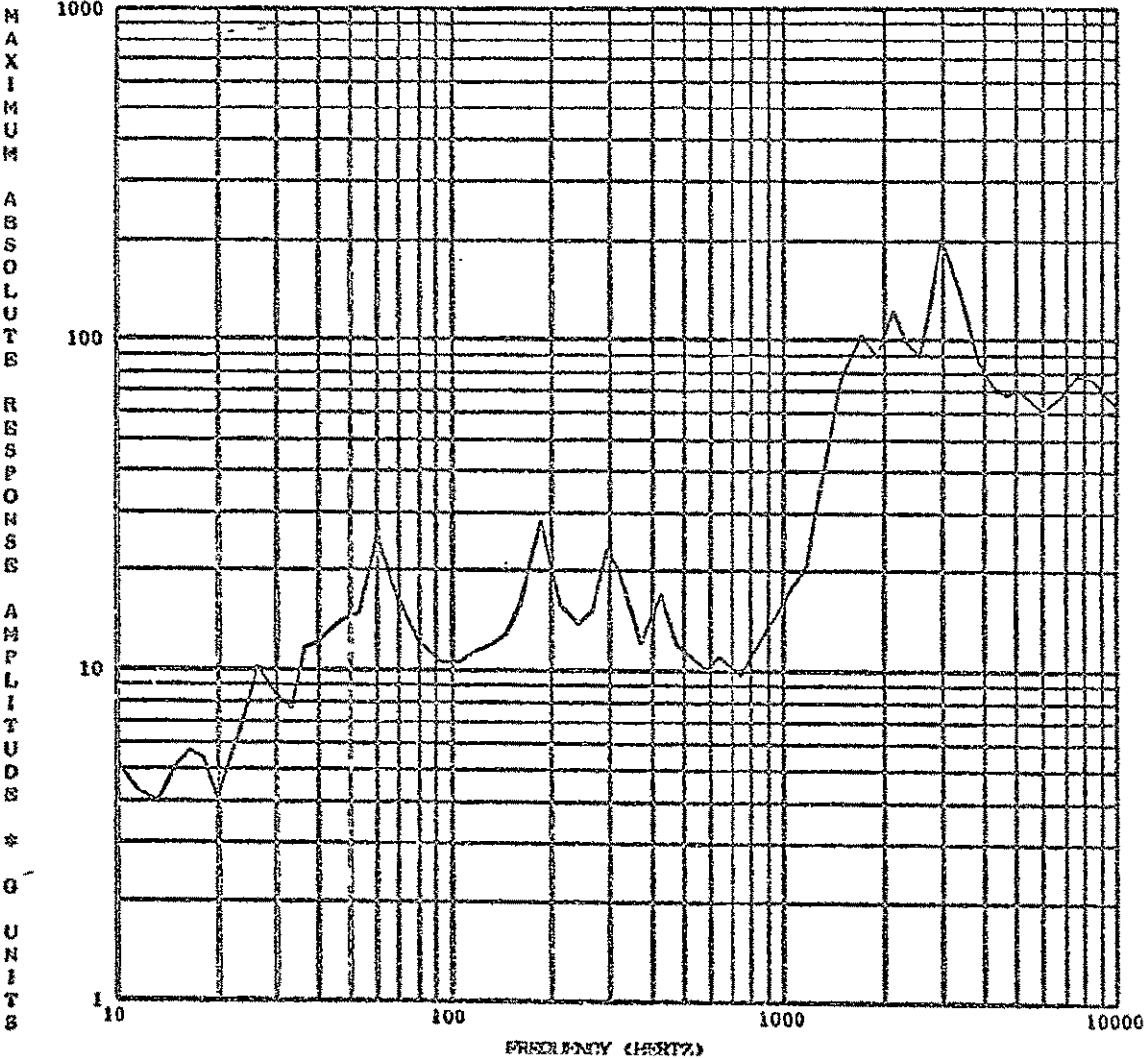


Figure 45 Shock Response Spectrum
+R Direction, 'R' Axis,
Electronics Package

ELECTRON/PROTON SPECTROMETER SHOCK TEST RUN 58
-R ACCEL THAZ DATE PROCESSED 02/11/72
THIS SLICE 22/11/31 TO 22/11/34 P.S.CAL=1000.
DATA RATE = 40000 S/S
FREQ. INTERVAL 1/6 TH OCTAVE
Q VALUE = 10

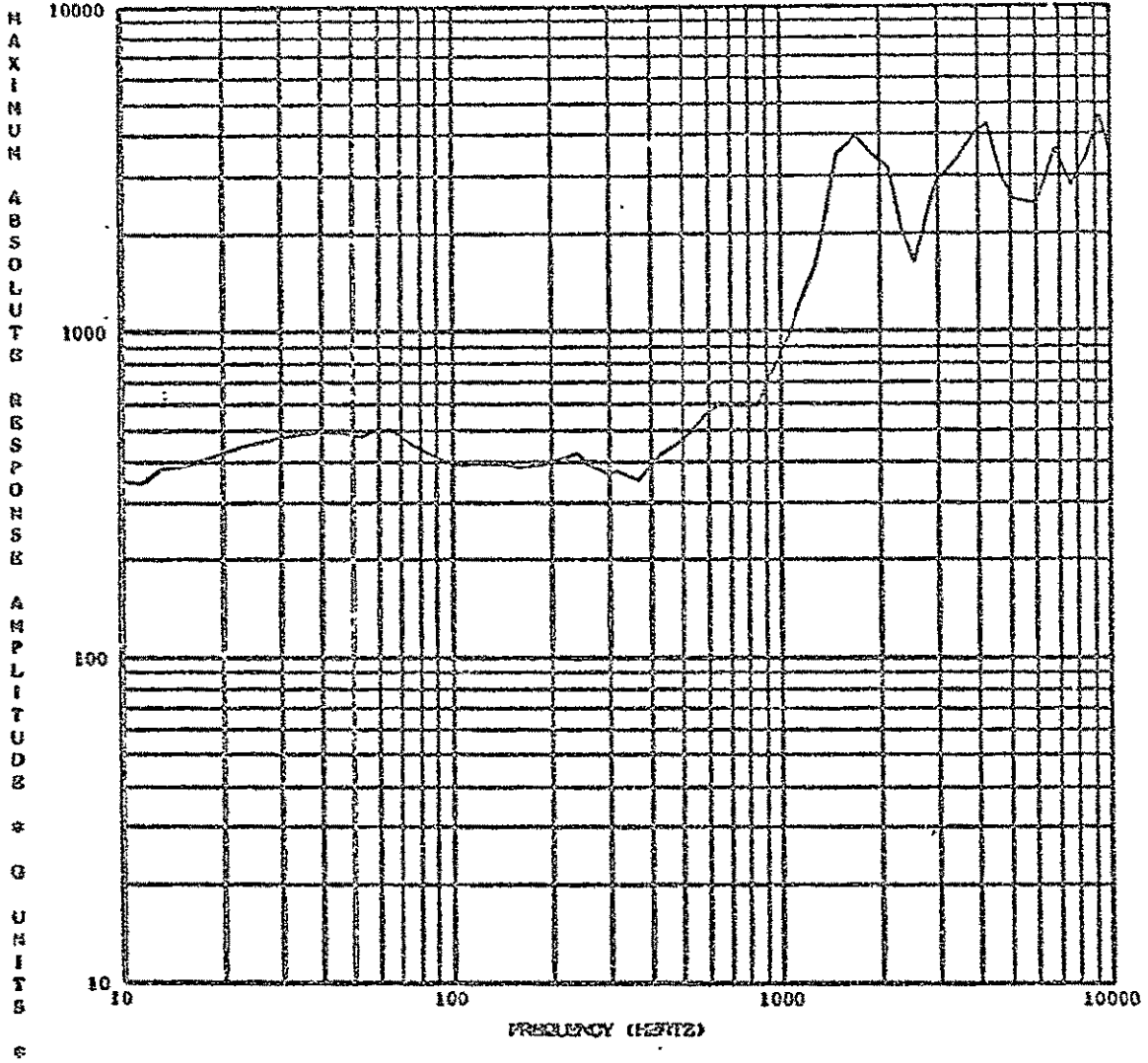


Figure 46 Shock Response Spectrum
+R Direction, 'R' Axis,
Baseplate

ELECTRON/IONOSPHERE SPECTROMETER SHOCK TEST R/A 5K
 *K ACCEL. TRKS DATE PROCESSED 02/11/72
 TIME SLICE 22/11/61 TO 22/11/66 F.S.CAL=100.
 DATA RATE = 40000 S/S
 FREQ. INTERVAL 1/6 TH OCTAVE
 Q VALUE = 10

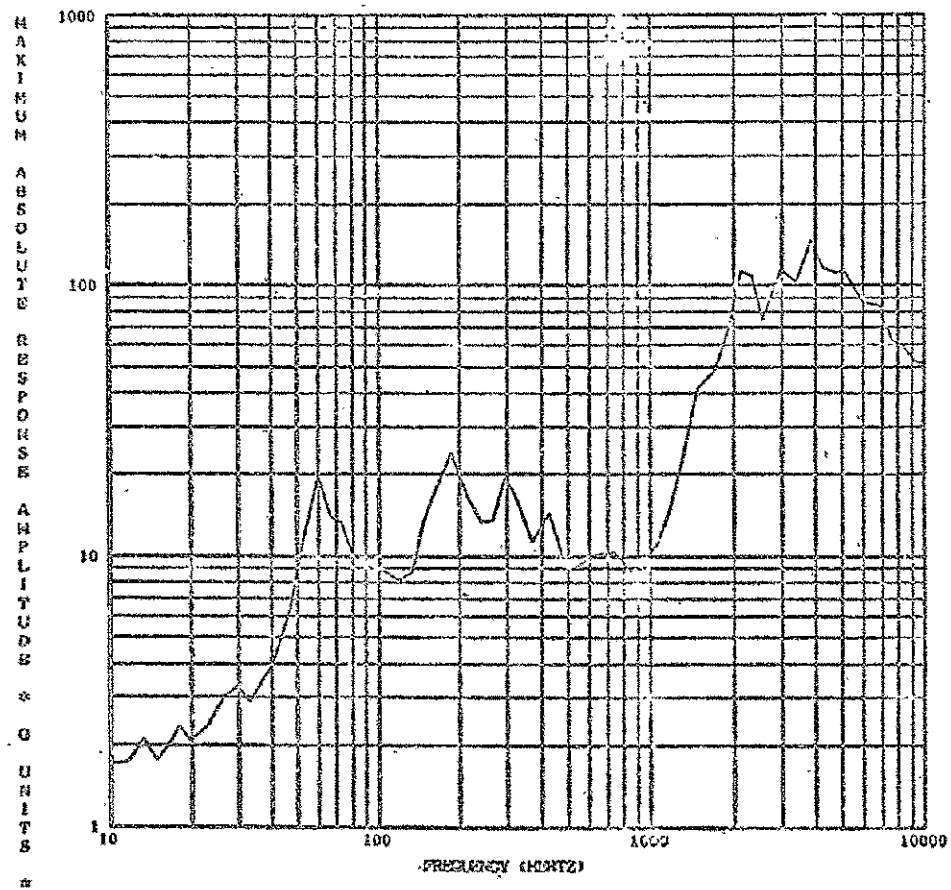


Figure 47 Shock Response Spectrum
 + 'R' Direction, 'X' Axis,
 Electronics Package

ELECTRON/PROTON SPECTROMETER SHOCK TEST RUN 58
 -T ACCEL TRK4 DATE PROCESSED 02/11/72
 TIME SLICE 22/11/31 TO 22/11/34 F.S.CAL=100.
 DATA RATE = 40000 S/S
 FREQ. INTERVAL 1/6 TH OCTAVE
 Q VALUE = 10

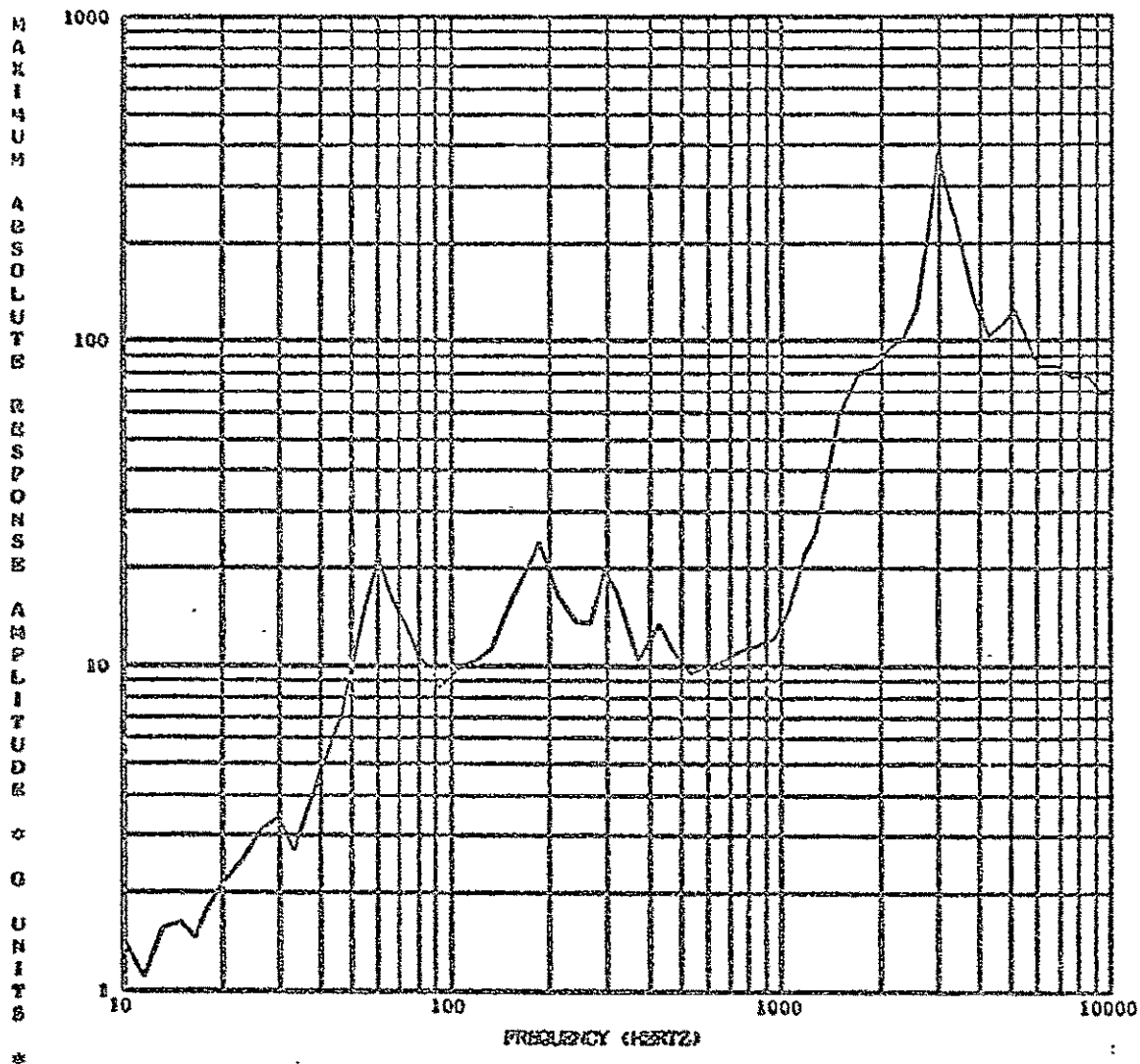


Figure 48 Shock Response Spectrum
 +'R' Direction, 'T' Axis,
 Electronics Package

ELECTRON/PROTON SPECTROMETER MEKX TEST RUN 59
 MEKX OUTPUT TRK1 DATE PROCESSED 02/10/72
 TIME SLICE 22/18/23 TO 22/19/24 F.S.CAL=1000
 DATA RATE = 40000 S/S
 FREQ. INTERVAL 1/6 TH OCTAVE
 Q VALUE = 10

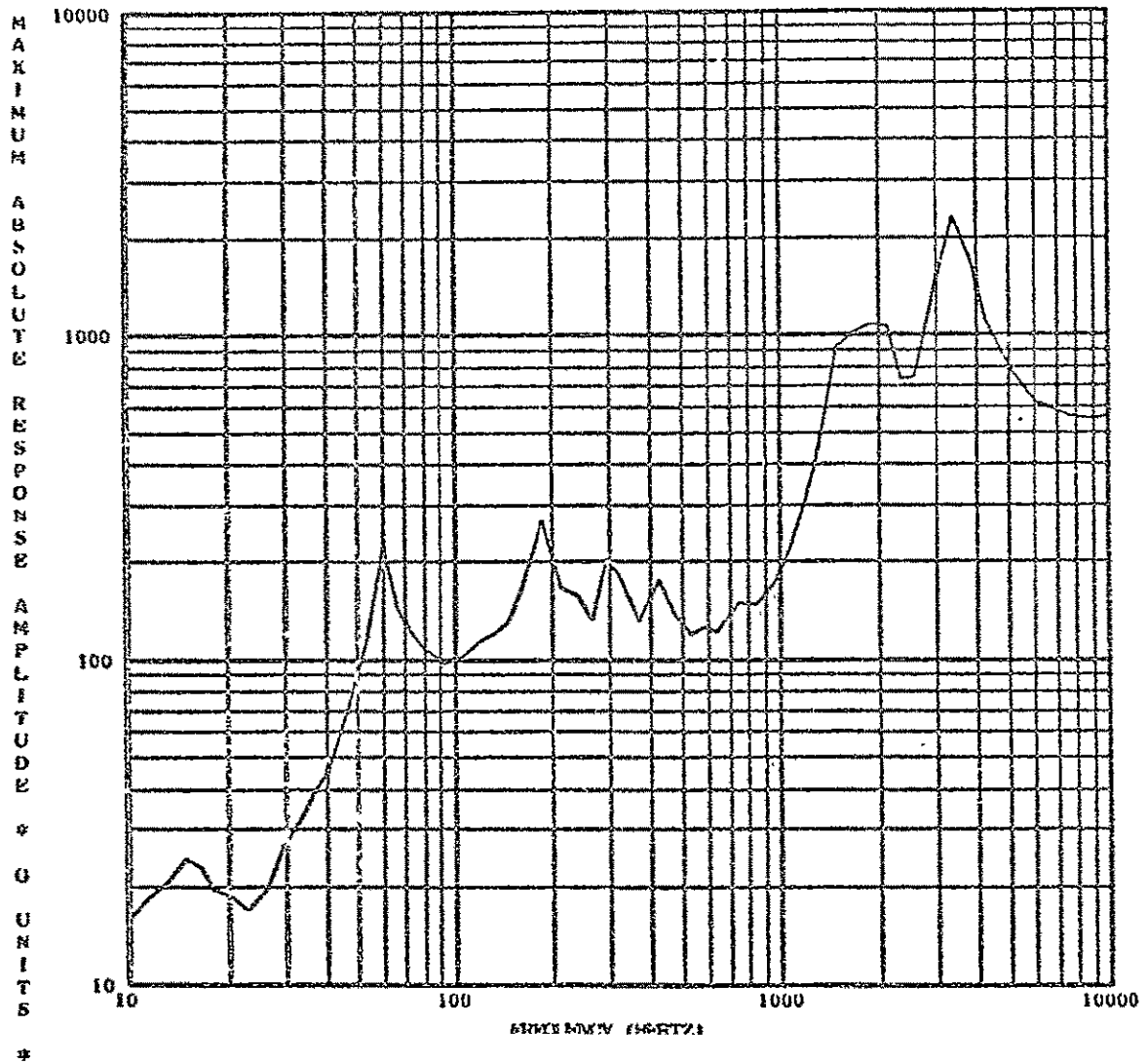


Figure 49 Shock Response Spectrum
 Input, -R Direction

ELECTRON/PHOTON SPECTROMETER SHOCK TEST RUN 59
 *R ACCEL TRK3 DATE PROCESSED 02/11/72
 TIME SLICE 22/18/21 TO 22/18/24 F.S.CAL=100.
 DATA RATE = 40000 S/S
 FREQ. INTERVAL 1/6 TH OCTAVE
 Q VALUE = 10

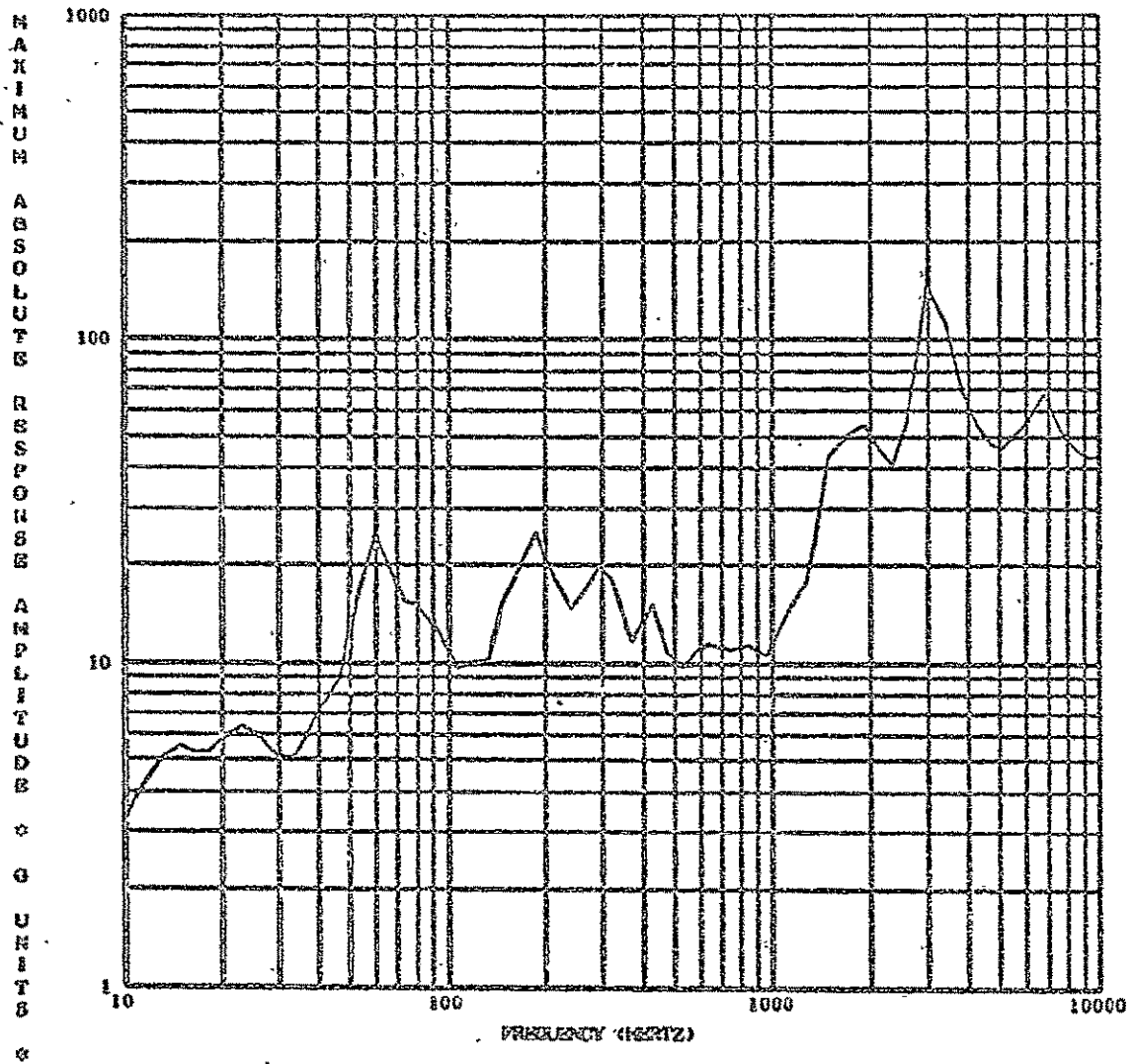


Figure 50 Shock Response Spectrum
 -R Direction, 'R' Axis,
 Electronics Package

ELECTRON/PROTON SPECTROMETER SHOCK TEST RUN 59
 -R ACCEL TRKZ DATE PROCESSED 02/11/72
 TIME SLICE 22/18/21 TO 22/18/24 F.S.CAL=1000.
 DATA RATE = 40000 S/S
 FREQ. INTERVAL, 1/6 TH OCTAVE
 Q VALUE = 10

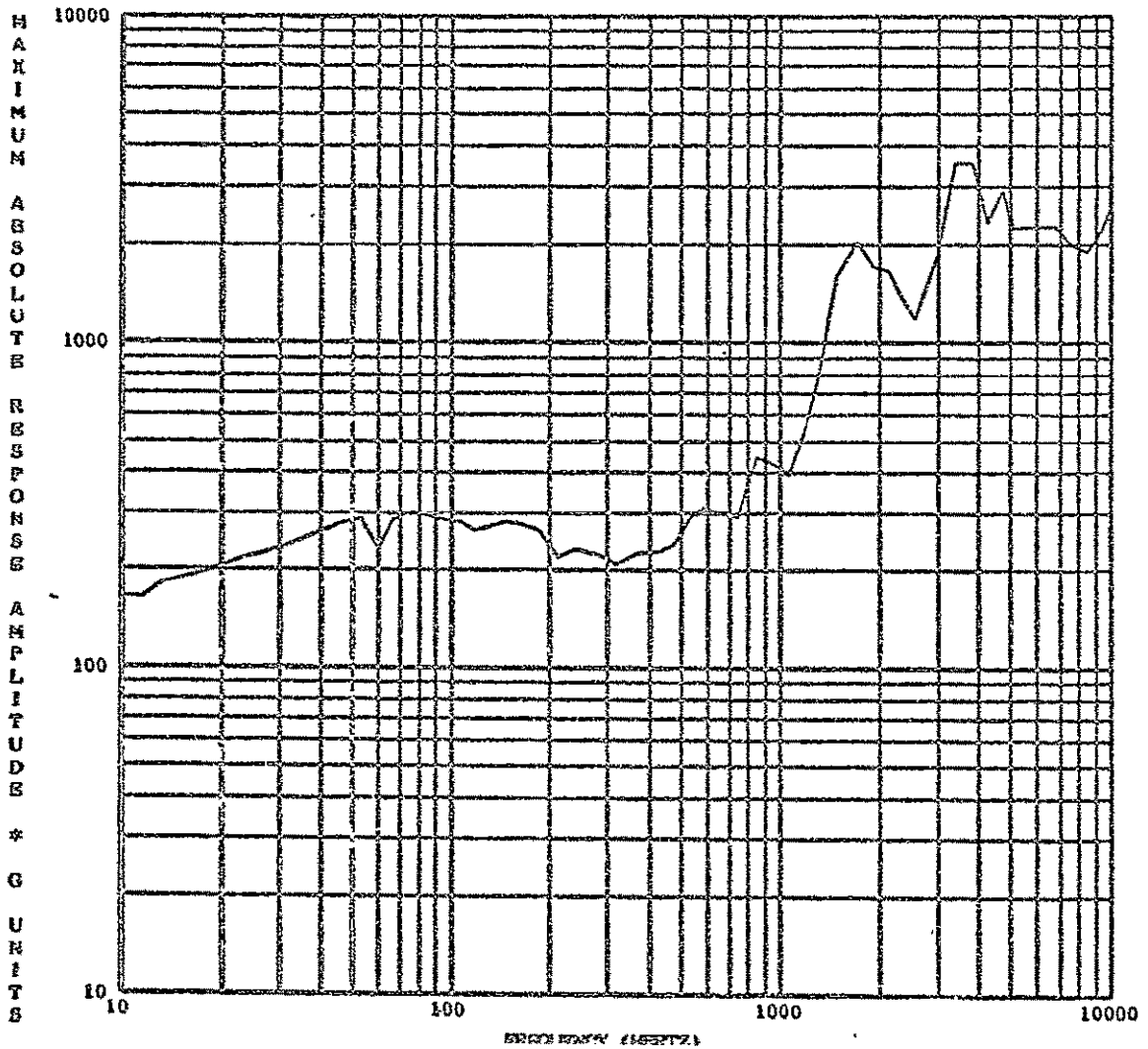


Figure 51 Shock Response Spectrum
 -R Direction, 'R' Axis,
 Baseplate

ELECTRON/PHOTON SPECTROMETER SHOCK TEST RUN 59
 OK ACCEL TRKS DATE PROCESSED 02/11/72
 TIME SLICE 22/18/21 TO 22/18/24 F.S.CAL=100.
 DATA RATE = 40000 S/S
 FREQ. INTERVAL 1/6 TH OCTAVE
 Q VALUE = 10

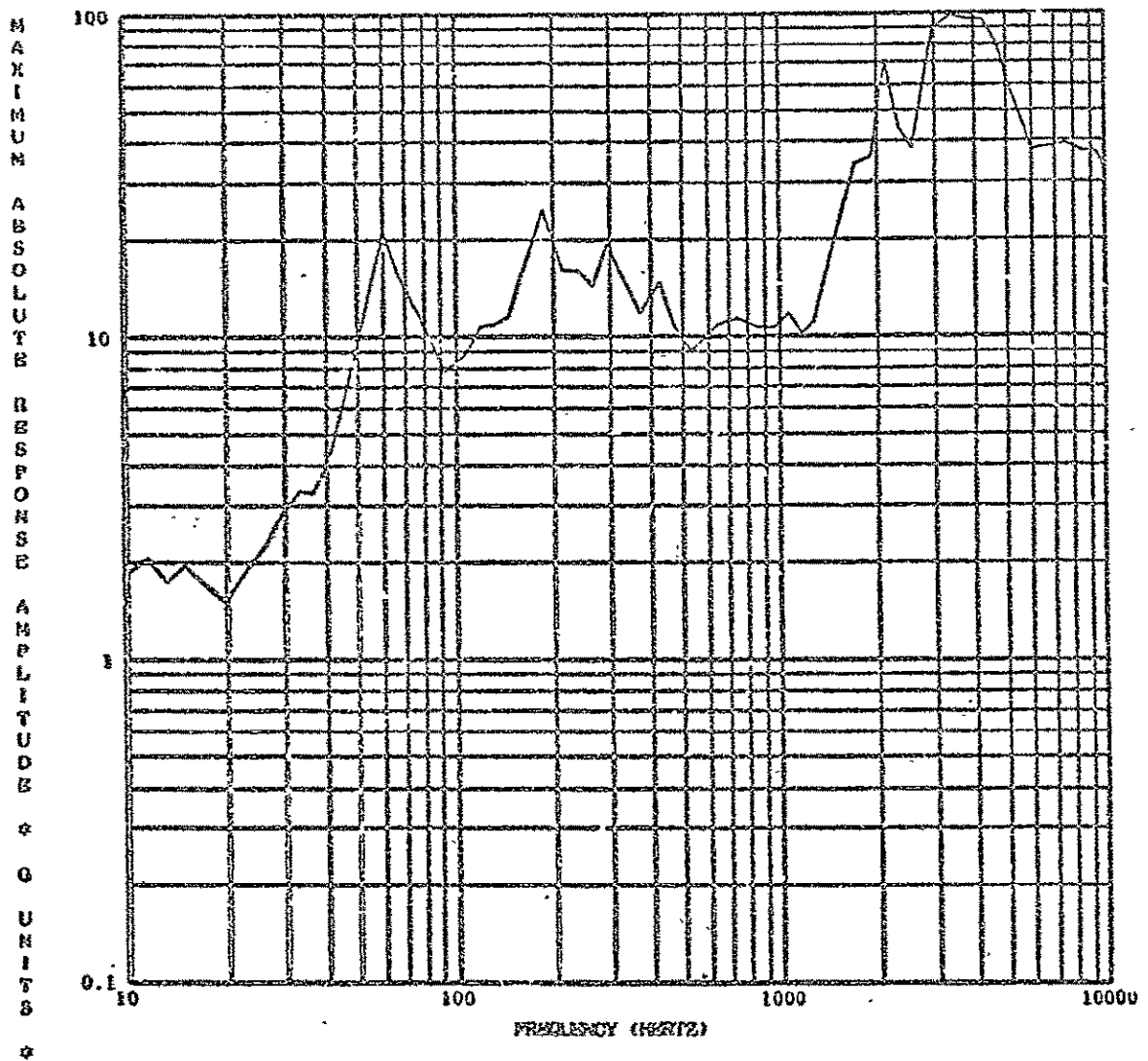


Figure 52 Shock Response Spectrum
 -R Direction, 'X' Axis,
 Electronics Package

ELECTRON/PROTON SPECTROMETER SHOCK TEST RUN 59
 -T ACCEL TRK4 DATA PROCESSED 02/11/72
 TIME SLICE 22/18/21 TO 22/18/24 F.S.CAL=100.
 DATA RATE = 40000 S/S
 FREQ. INTERVAL 1/6 TH OCTAVE
 G VALUE = 10

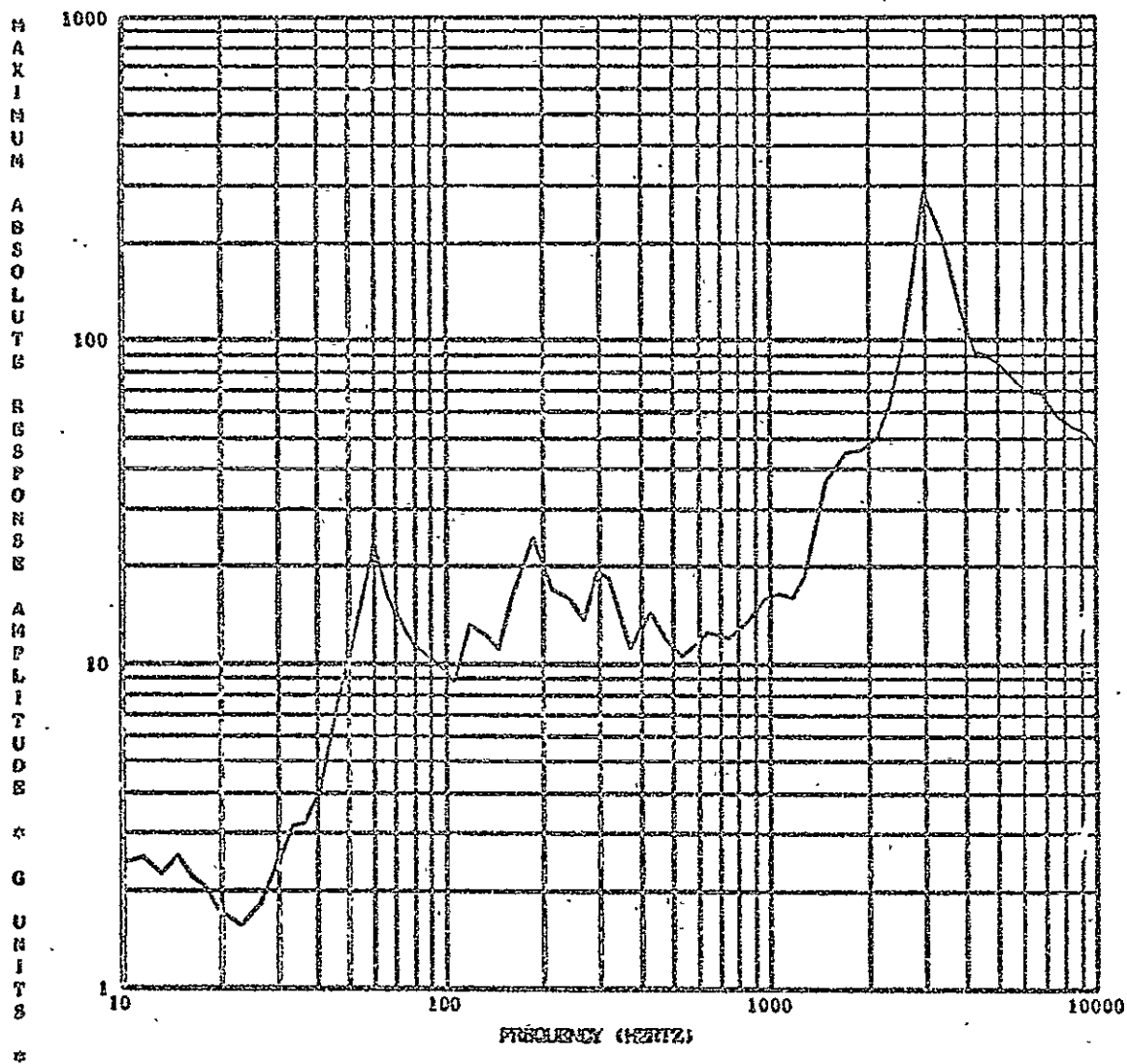
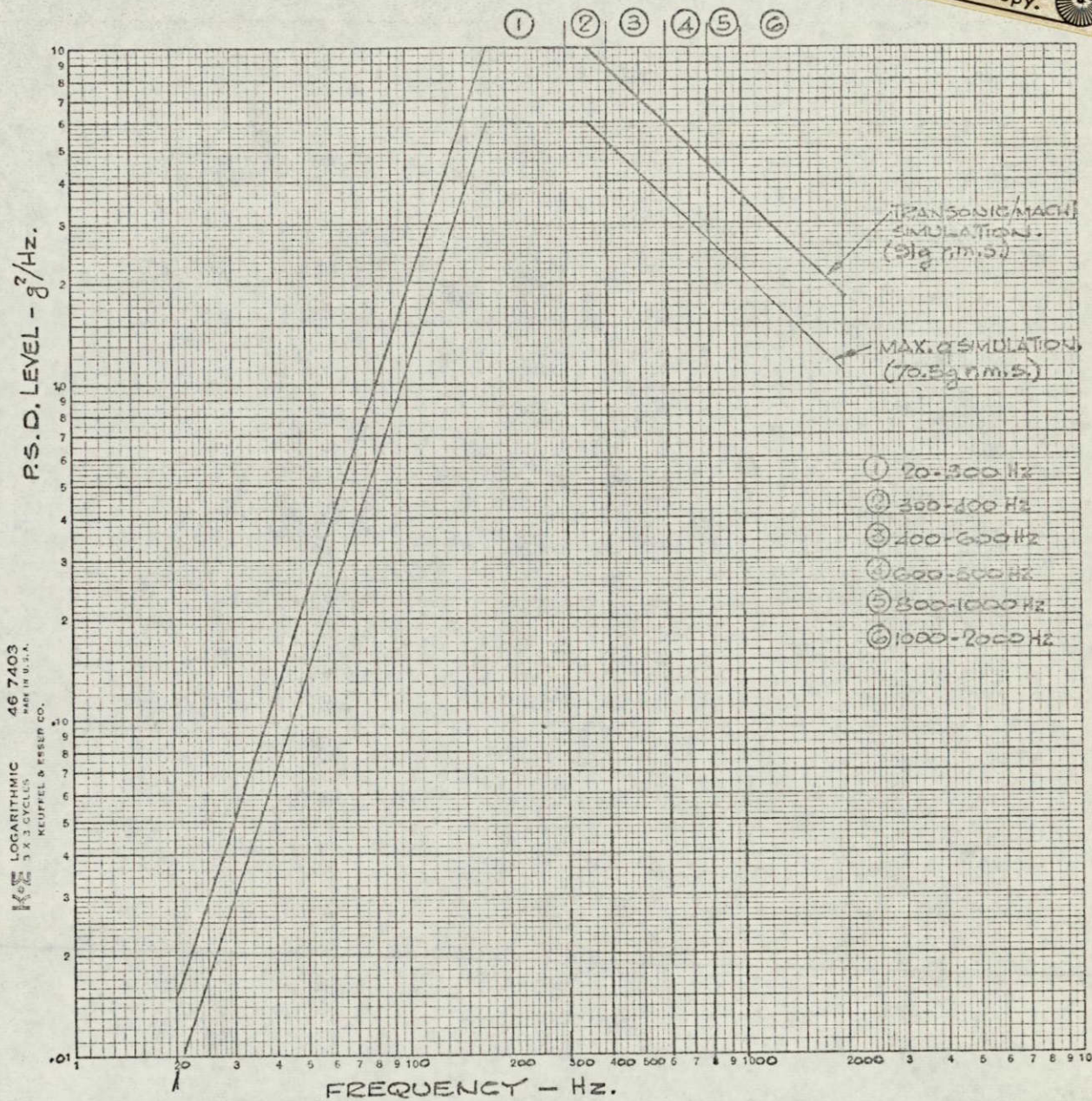


Figure 53 Shock Response Spectrum
 -R Direction, 'T' Axis,
 Electronics Package

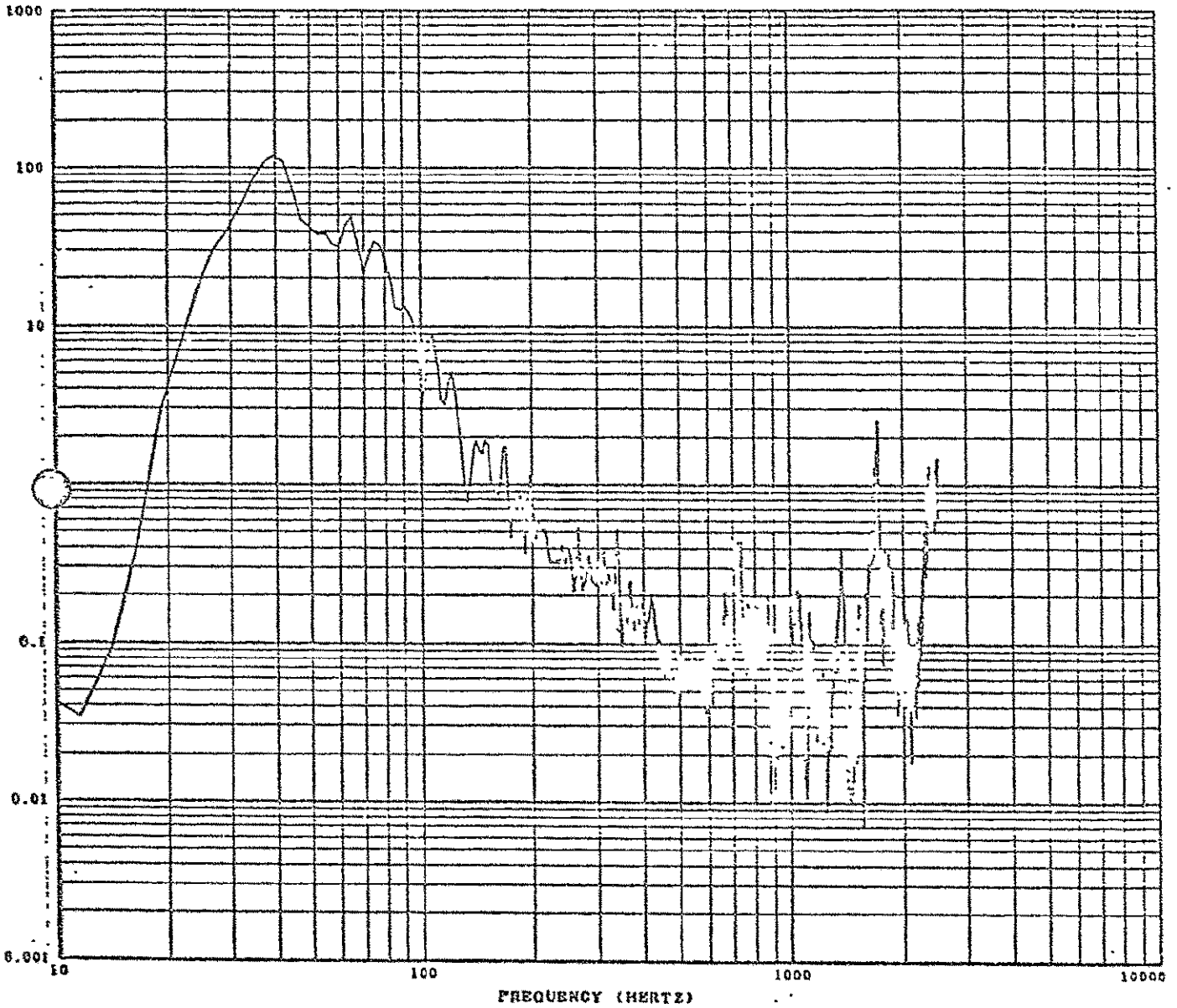
Reproduced from best available copy.



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 MADE IN U.S.A.

Figure 54 'R' Axis Vibration Spectrum Showing Segments

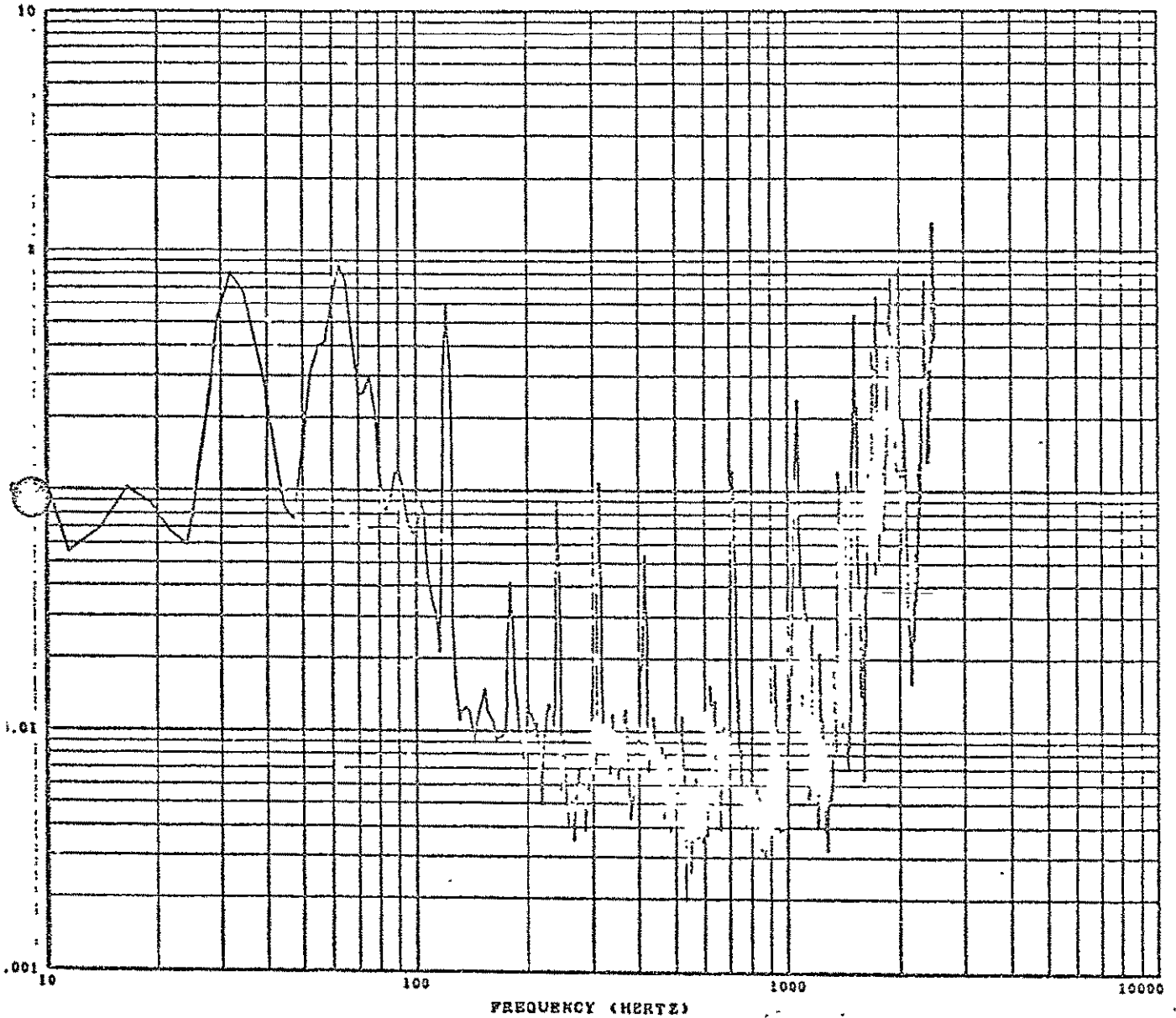
SENSOR - EPS-2H ELECTRON/PHOTON SPECT 1ST CAL=31.6 TIME SLICE (HR-MIN-SEC) 15 3 36.000 TO 15 3 36.000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION 2.1275 DATE PROCESSED..... 23FEB77
 NORM. STD. ERROR22124 VIBRATION TEST RUN. 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1071
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X .001000



g rms = 2.13 PAGE 2.

Figure 56 Electronic Package -
'X' Axis Response to Input
of Figure 55

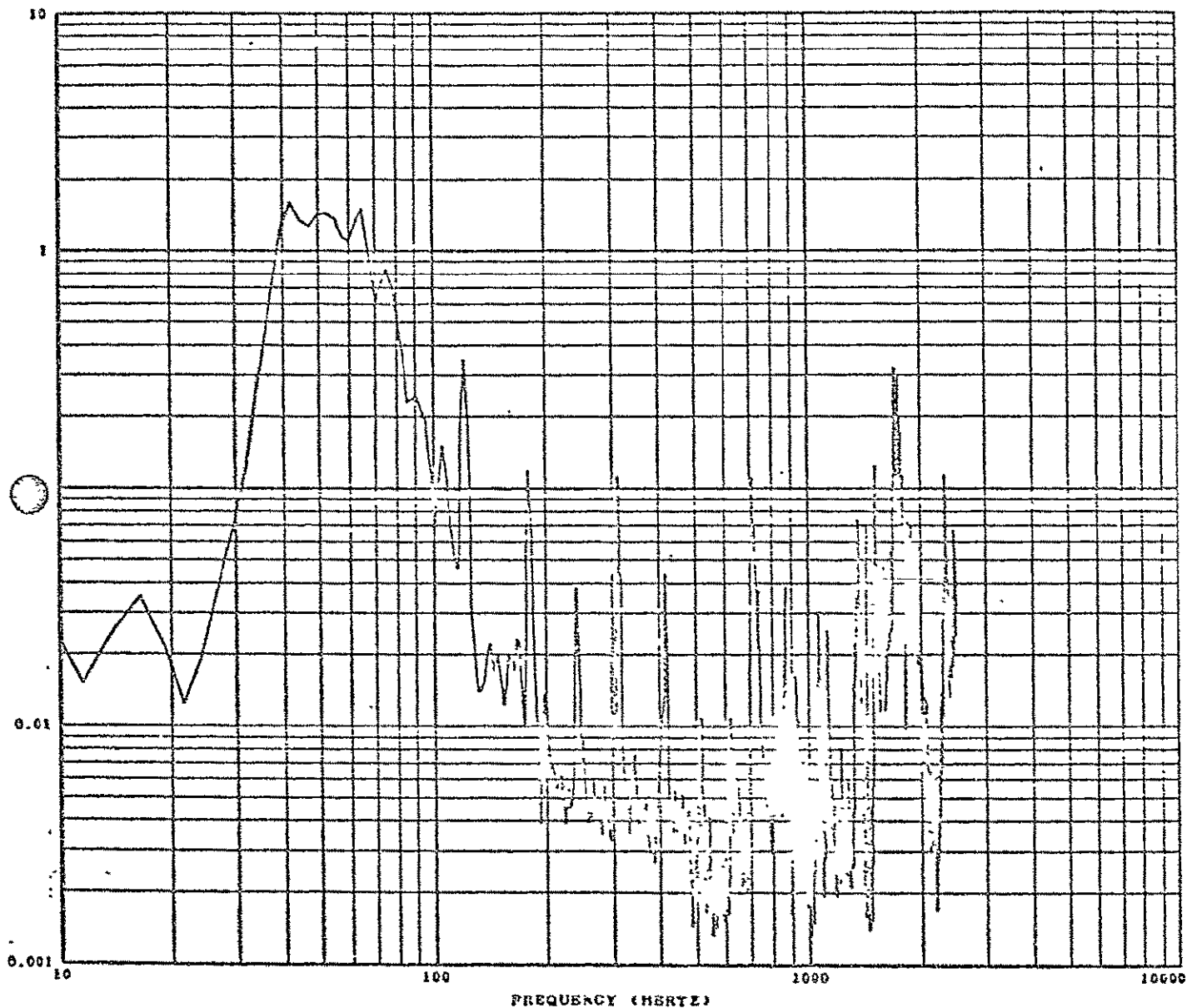
SENSOR - EPS-3T ELECTRON/PROTON SPECT. TEST CAL=31.6 TIME SLICE (HR-MIN-SEC) 15 3 36 0000 TO 15 3 42.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION .9984 DATE PROCESSED . . . 23FEB77
 NORM. STD. ERROR... .22124 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1077
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. THIS VALUE = VALUE SHOWN X .001000



g rms = 1.00 PAGE 4.

Figure 57 Electronics Package
 'T' Axis Response to
 Input of Figure 55

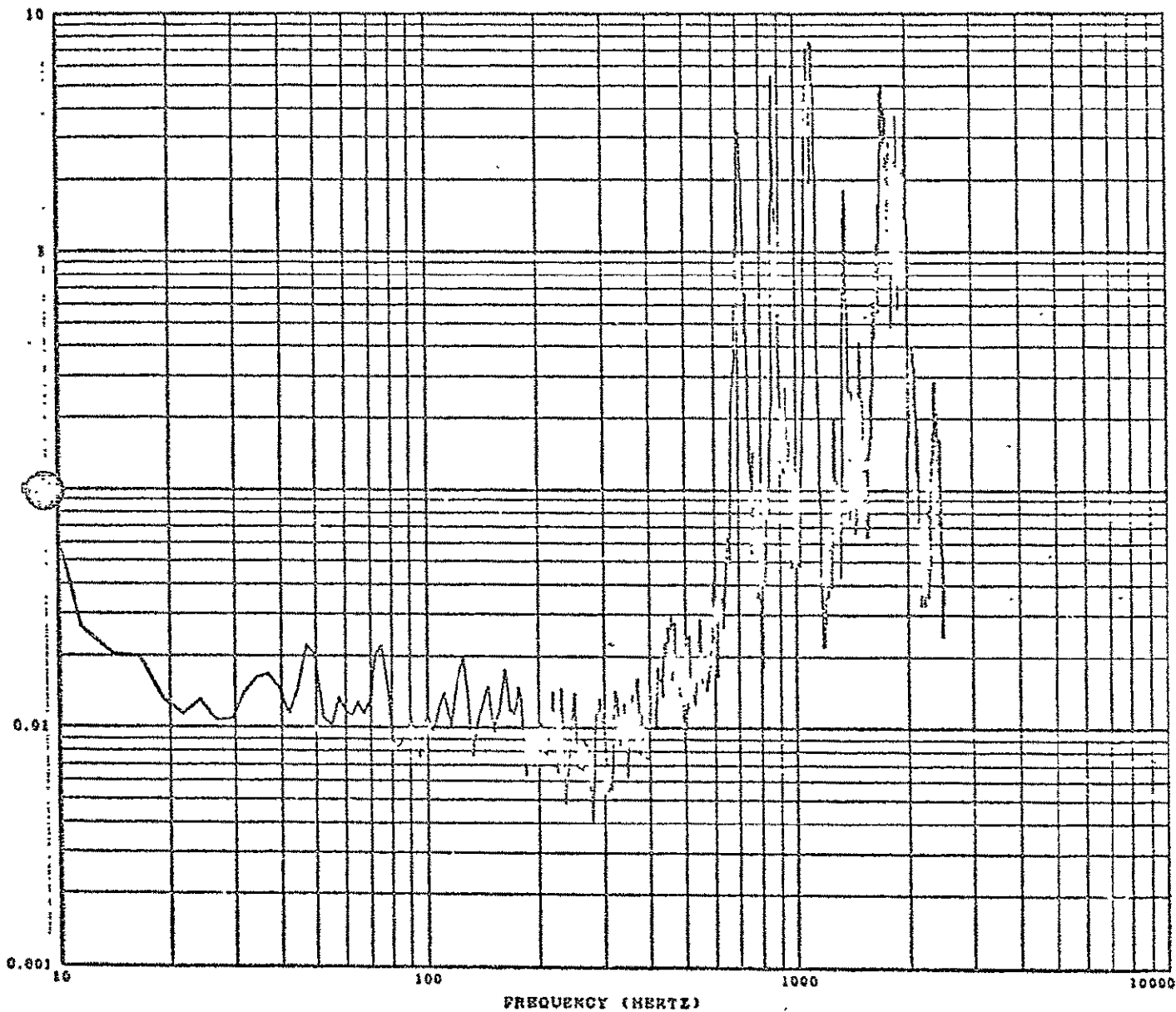
SENSOR - EPS-IR ELECTRON/PHOTON SPECT. TEST CAL=100 TIME SLICE (HR-MIN-SEC) 15 3 38 0000 TO 15 3 42 0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 1.2290 DATE PROCESSED.. ... 23FEB77
 NORM. STD. ERROR... .22124 VIBRATION TEST RUN 60X INPUT TAPE NUMBER..
 FILTER BANDWIDTHS... 5.1077
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN * X .010000



g rms = 1.23 PAGE 6.

Figure 58 Electronics Package, 'R' Axis
Response to Input of Figure 55

SENSOR - EPS-4R ELECTRON/PROTON SPECT. TEST CAL=100 TIME SLICE (HR-MIN-SEC) 15 3 38.0000 TO 15 3 42.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION... 39.9486 DATE PROCESSED. 23FEB77
 NORM STD. ERROR... .22124 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1077
 FILTER START POINTS. .0000



g rms = 39.95

PAGE 6.

Figure 59 Baseplate Response, 'R' Axis,
to Input of Figure 55

SENSOR - CONTROL ELECTRON/PROTON SPECT. TEST CAL=100 TIME SLICE (HR-MIN-SEC) 15 4 27.0000 TO 15 4 31.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION 31.3871 DATE PROCESSED 23FEB77
 NORM. STD. ERROR.... .22121 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1050
 FILTER START POINTS. .0000

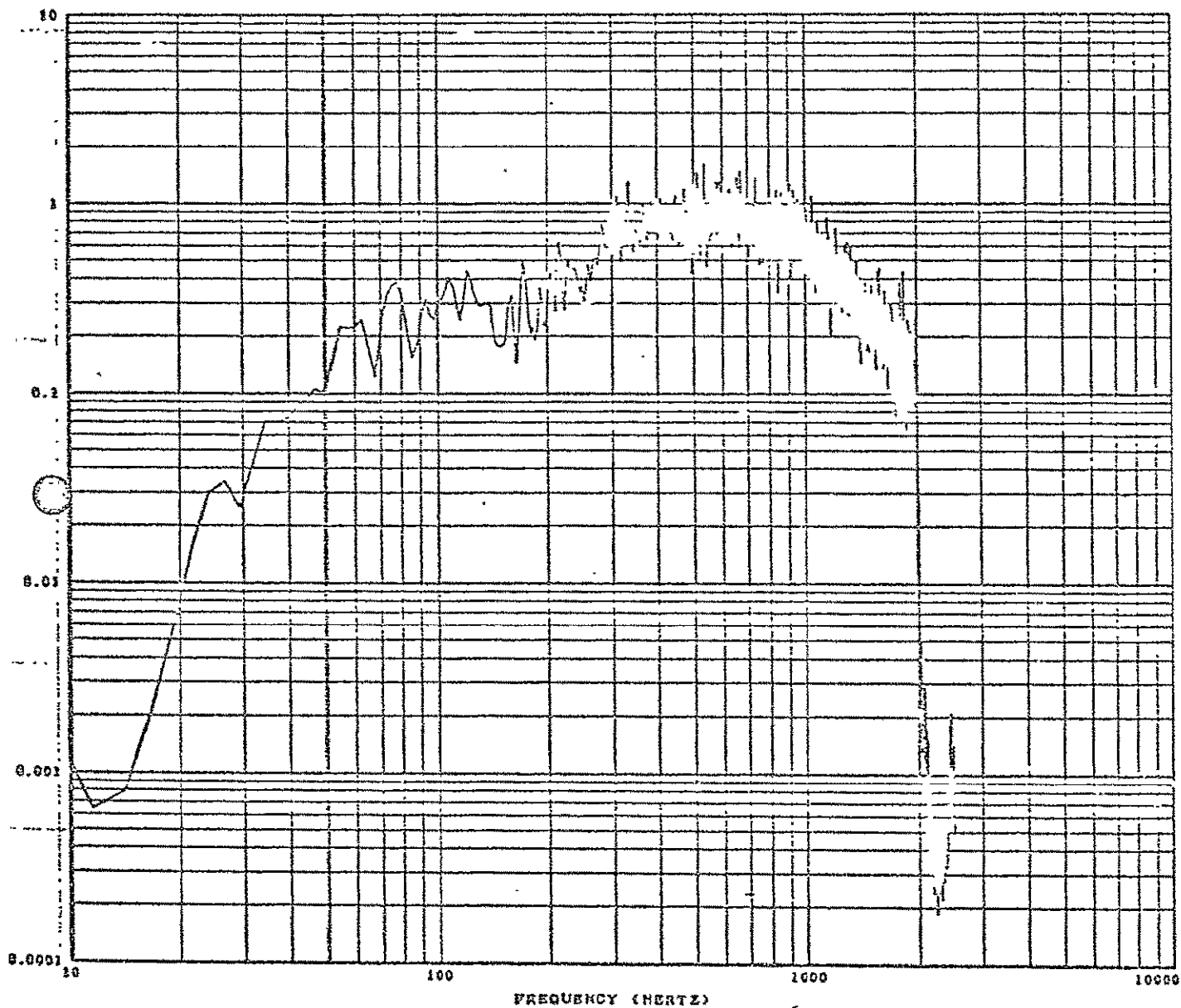
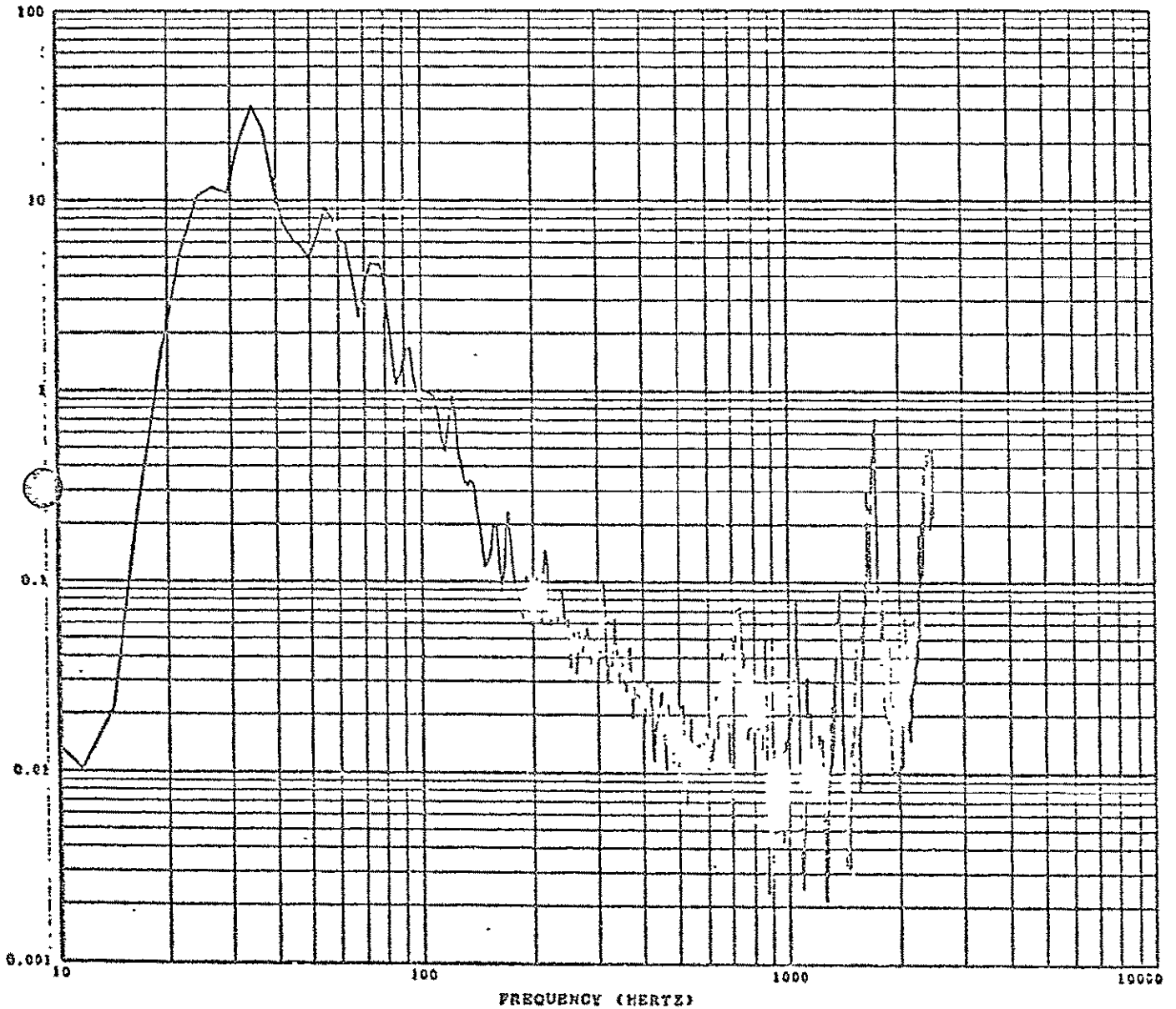


Figure 60 'X' Axis Input, Transonic/MACH 1 Simulation

SENSOR * EPS-2R ELECTRON/PROTON SPECT. TEST CAL=11.6 TIME SLICE (HR-MIN-SEC) 15 4 27.0000 TO 15 4 31 0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION... 3.1080 DATE PROCESSED 2JFEB77
 NORM. STD. ERROR.... .22121 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTH... 5.1099
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X .010000



$g_{rms} = 3.11$

Figure 61 Electronics Package, 'X' Axis
Response to Input of Figure 60

SENSOR = EPS-3T ELECTRON/PROTON SPECT. TEST CAL=31.6 TIME SLICE (HI-MIN-SEC) 15 4 27.0000 TO 15 4 31.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 1.6688 DATE PROCESSED..... 23FEB77
 NORM. STD. ERROR.... .22121 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS .. 5.1090
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE * VALUE SHOWN * .001000

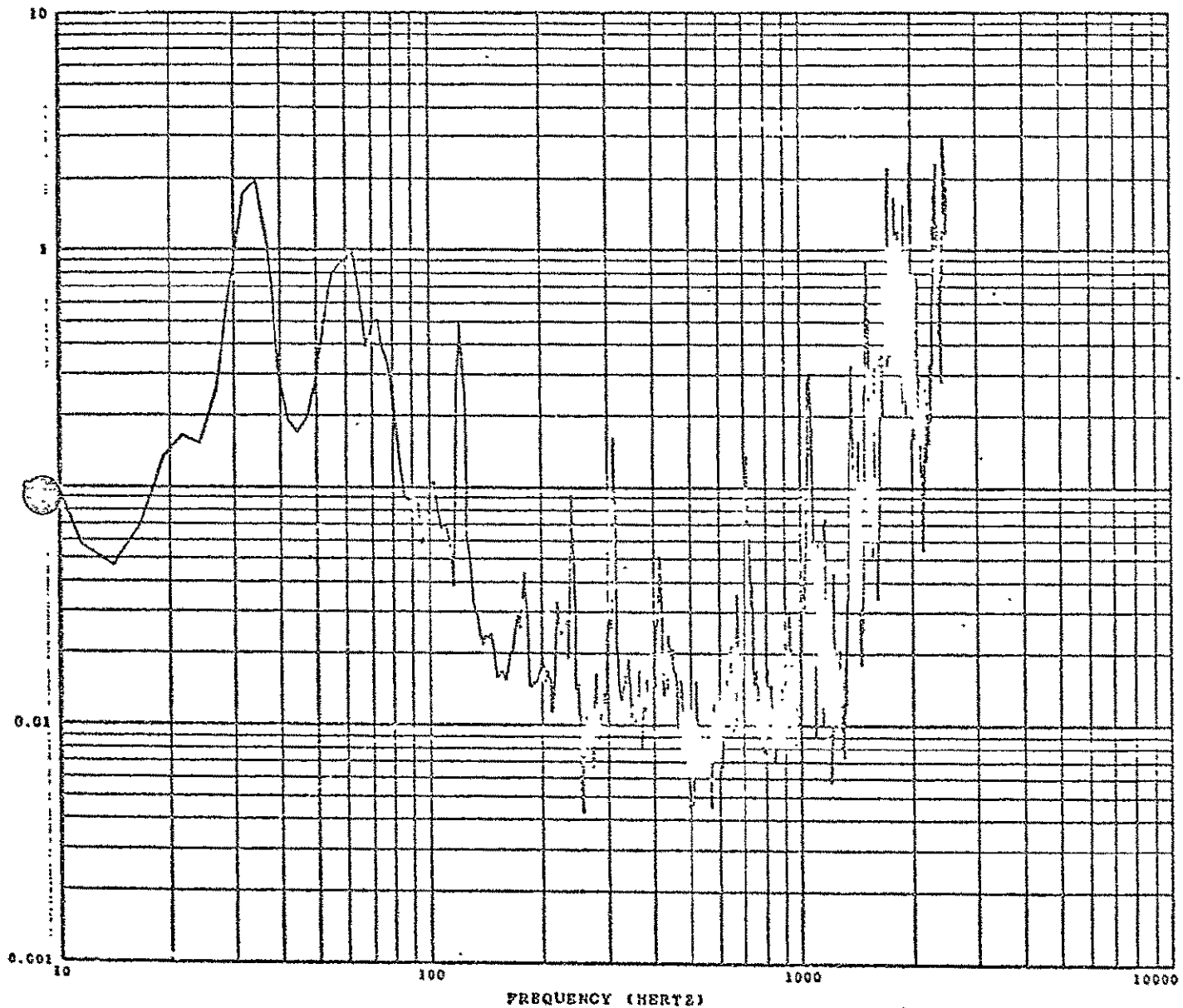
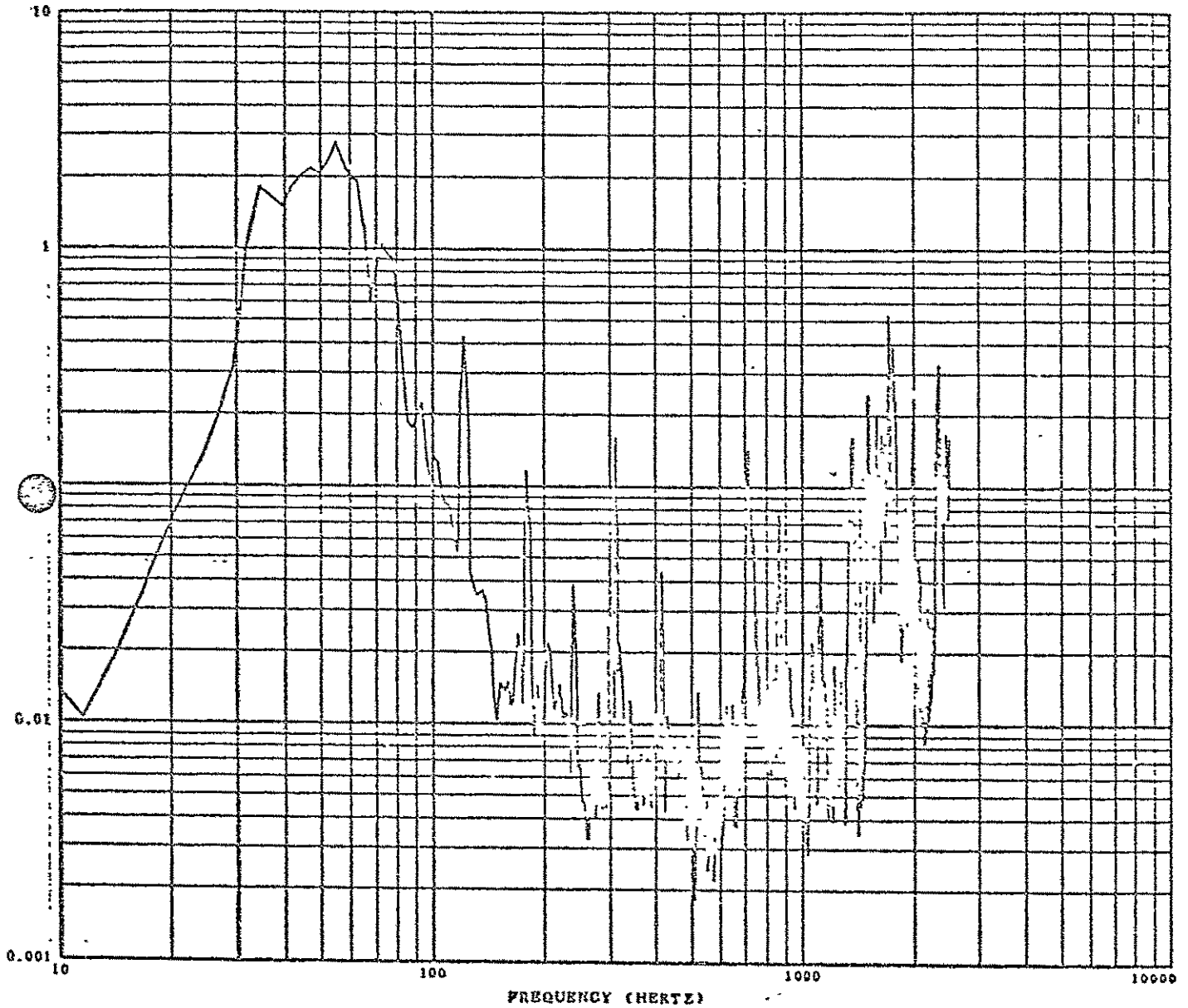


Figure 62 Electronics Package, 'T' Axis
Response to Input of Figure 60

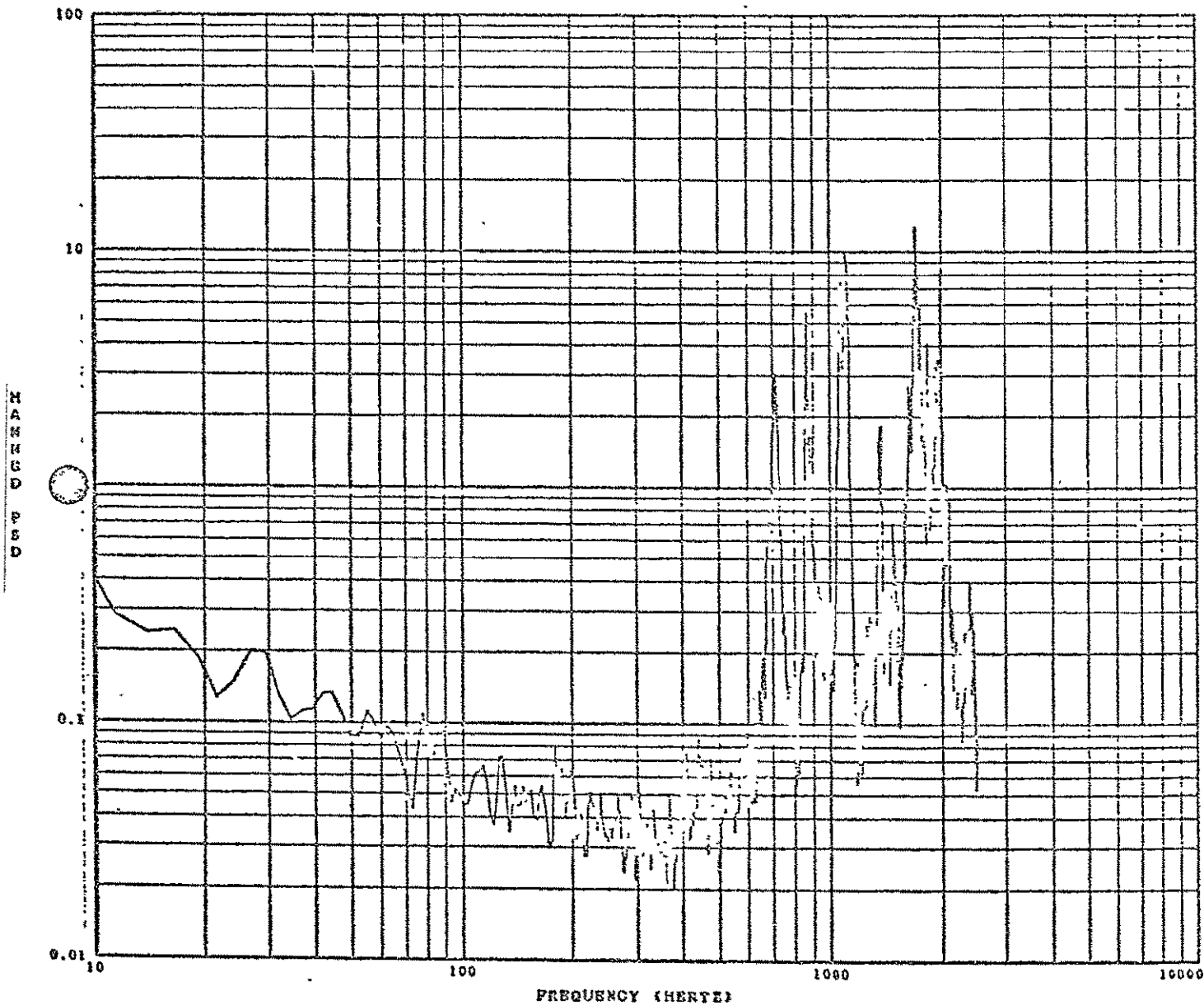
SENSOR - EPS-IR ELECTRON/PROTON SPECT. TEST CAL=100 TIME SLICE (HR-MIN-SEC) 15 4 27 0000 TO 15 4 31 0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 1.7992 DATE PROCESSED..... 23FEB77
 NORM. STD. ERROR.... .22121 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTH... 5.1090
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X .010000



g rms = 1.80 PAGE 1.

Figure 63 Electronics Package, 'R' Axis
Response to Input of Figure 60

SENSOR - EPS-4R ELECTRON/PROTON SPECT. TEST CAL=1.00 TIME SLICE (HH-MIN-SEC) 15 4 27.0000 TO 15 4 31.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 49.7187 DATE PROCESSED..... 23FEB77
 NORM. STD. EROR.... .22121 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...

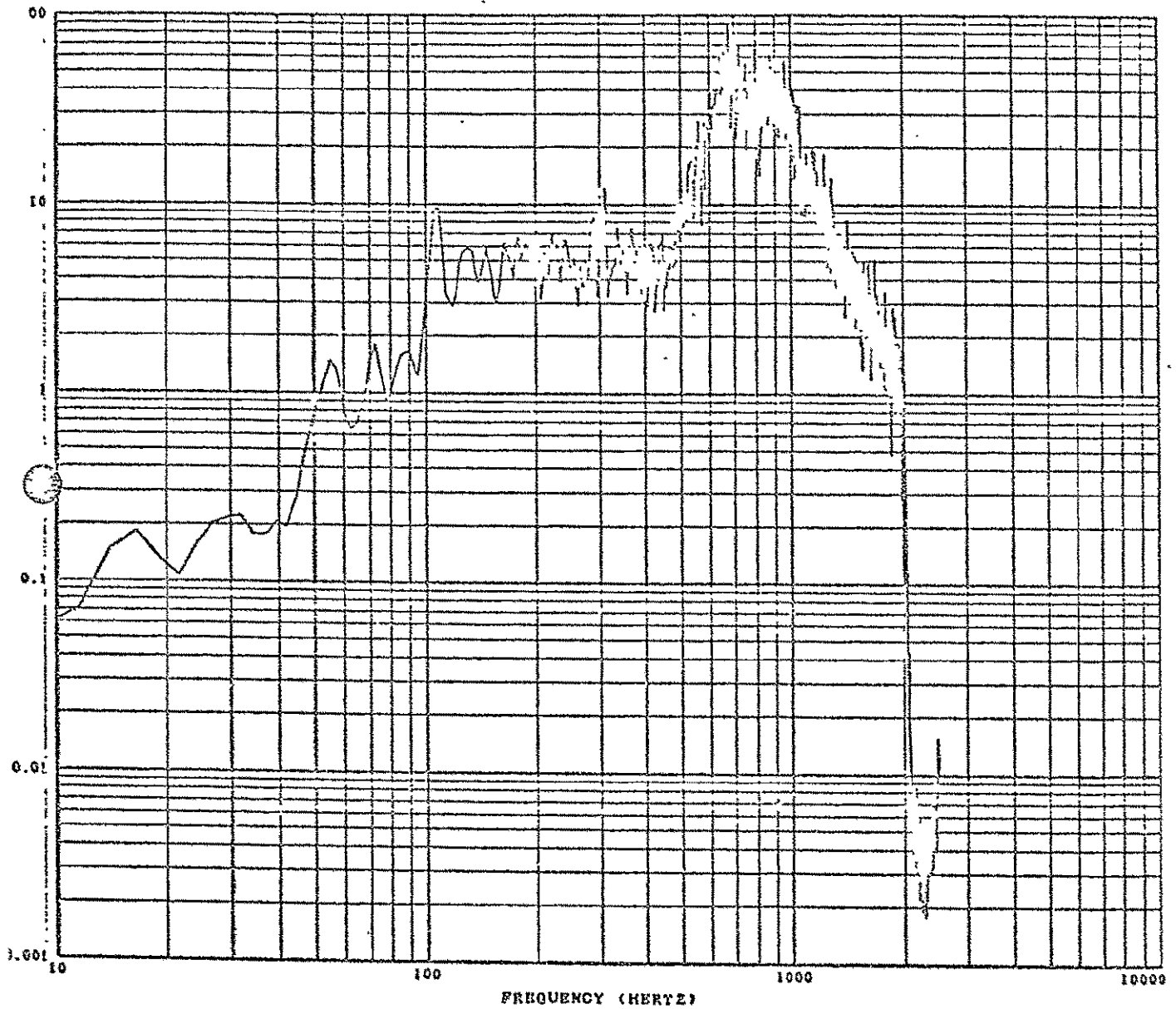


\dot{g} rms = 49.72

PAGE 1.

Figure 64 Baseplate, 'R' Axis Response
 to Input of Figure 60

SENSOR - CONTRL ELECTRON/PHOTON SPECT. TEST CAL=100. TIME SLICK (HR-MIN-SEC) 18 35 15.0000 TO 18 35 19.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 15.9526 DATE PROCESSED..... 2JNE871
 NORM. STD. ERROR.... .22115 VIBRATION TEST RUN BOX INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1116
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X .010000

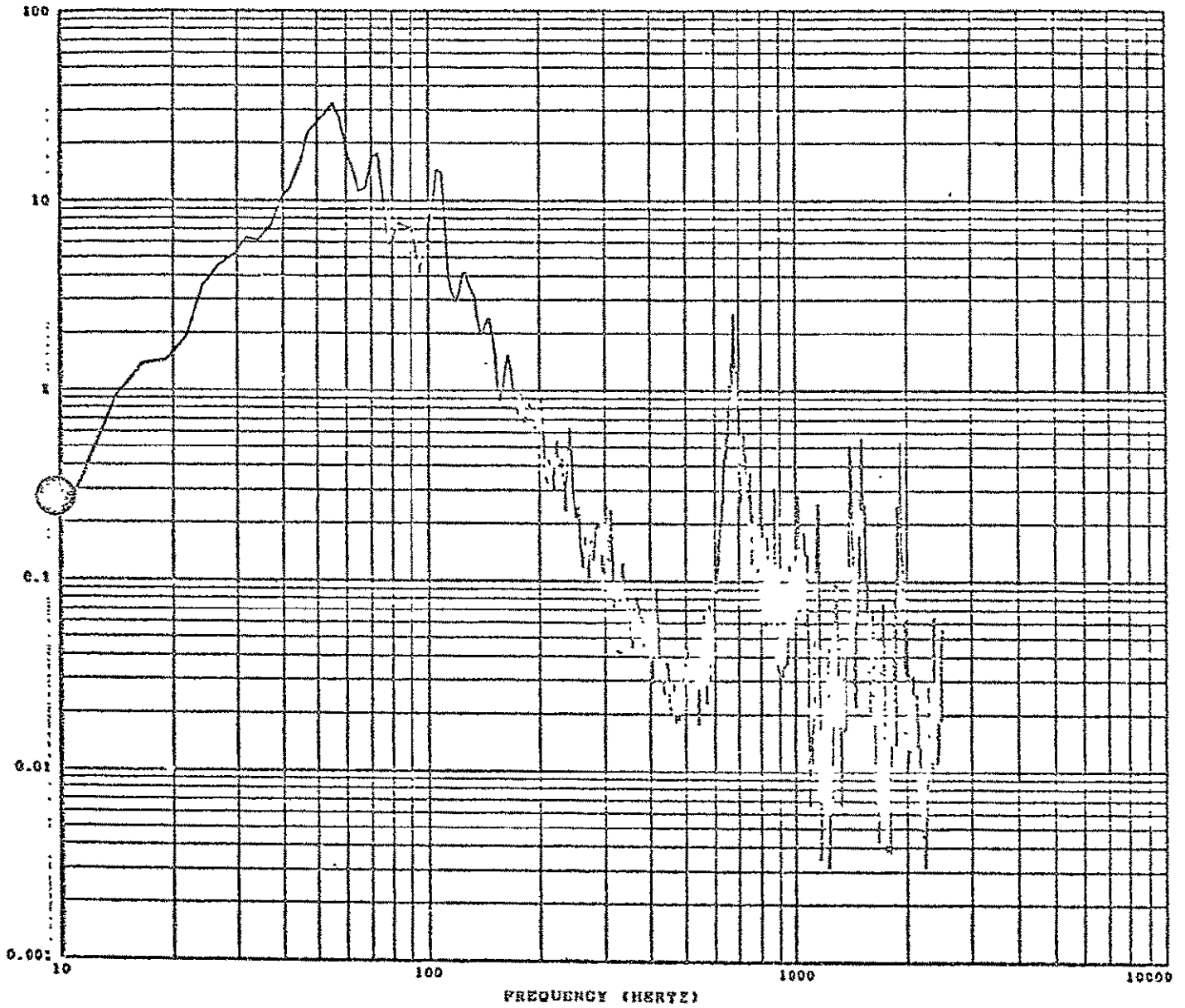


g rms = 15.95

PAGE 6.

Figure 65 'T' Axis Input, Max. g
Simulation

SENSOR - EPS-31 ELECTRON/PROTON SPECT. TEST CAL=31.6 TIME SLICE (H1-MIN-SEC) 16 35 15.0000 TO 16 35 19 0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 1.2513 DATE PROCESSED..... 2JFEB77
 NORM. STD. ERROR.... .22115 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1116
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X .001000

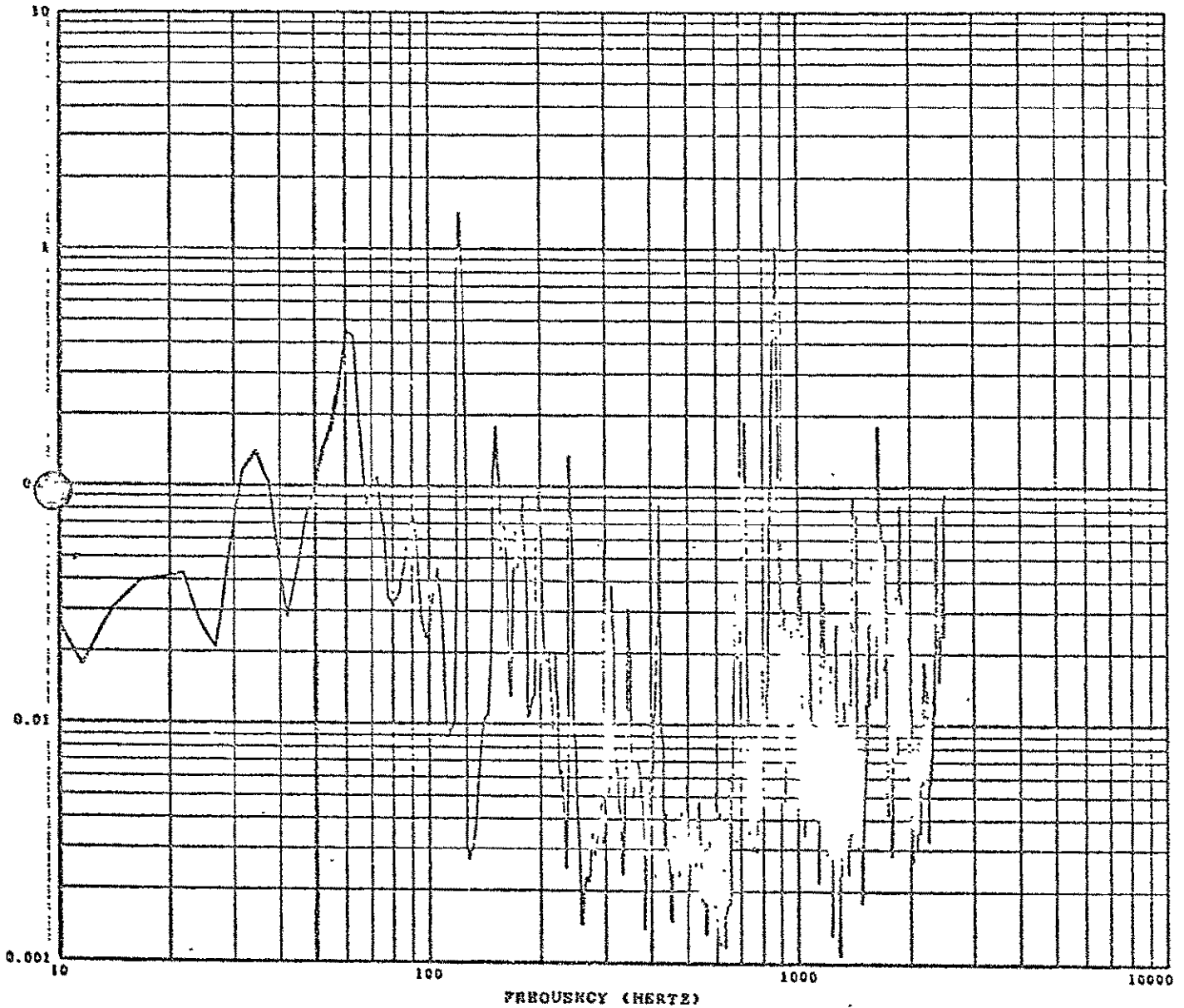


g rms = 1.25

PAGE 4.

Figure 66 Electronics Package, 'T' Axis
Response to Input of Figure 65

SENSOR - EPS-2R ELECTRON/PROTON SPECT. TEST CAL=J1 6 TIME SLICE (HR-MIN-SEC) 16 35 15.0000 TO 16 35 19.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. .3440 DATE PROCESSED..... 23FEB77
 NORM. STD. ERROR... .22115 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1116
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN * .001000

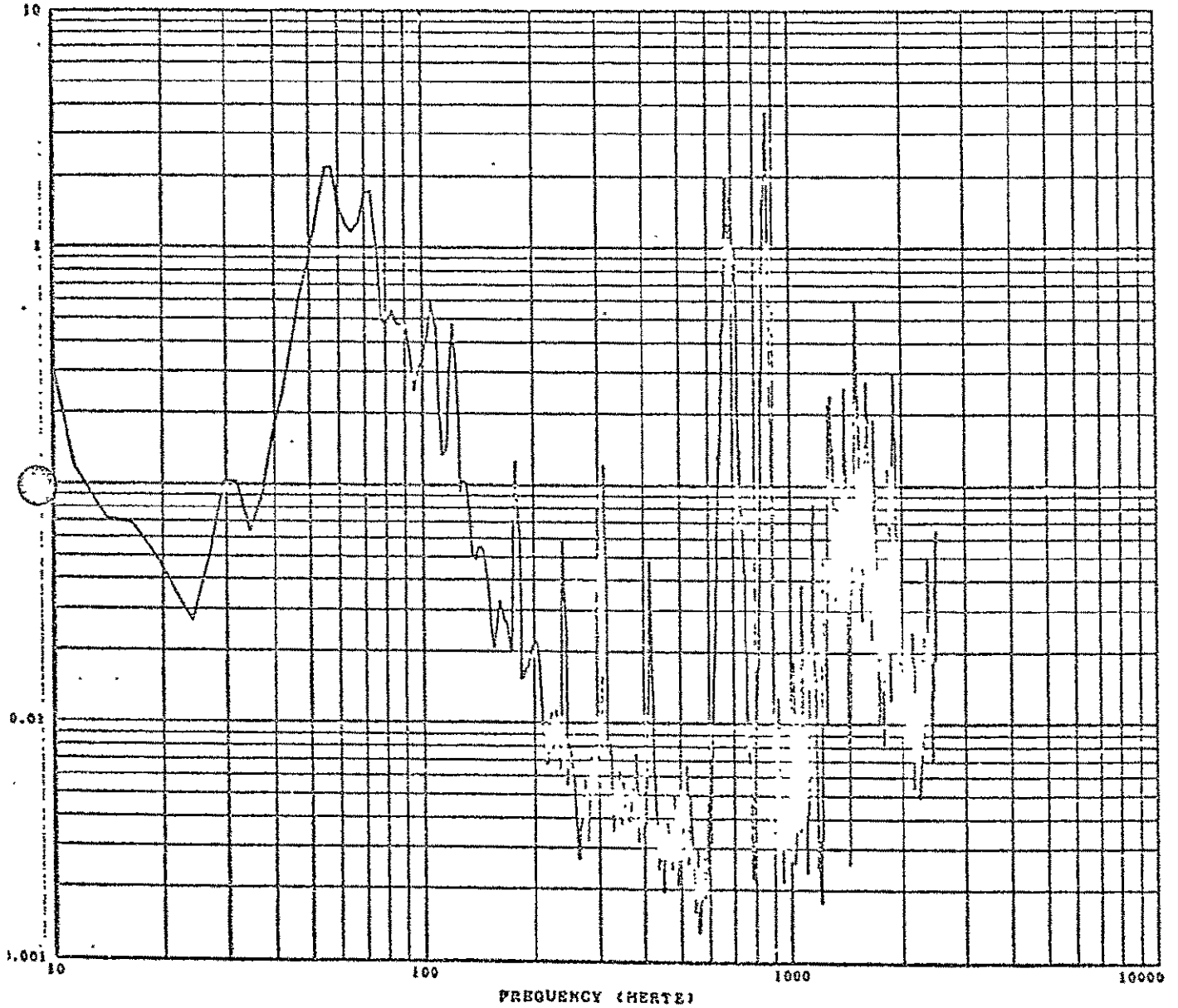


g rms = .34

PAGE 2.

Figure 67 Electronics Package, 'X' Axis
Response to Input of Figure 65

SENSOR - EPS-1R ELECTRON/PROTON SPECT. TEST CAL=11.6 TIME SLICE (HR-MIN-SEC) 16 35 15 0000 TO 16 35 19.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. .5899 DATE PROCESSED..... 23FEB77
 NORM. STD. ERROR... .22115 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS .. 5.1116
 FILTER START POINTS. .0000,
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN' X .001000



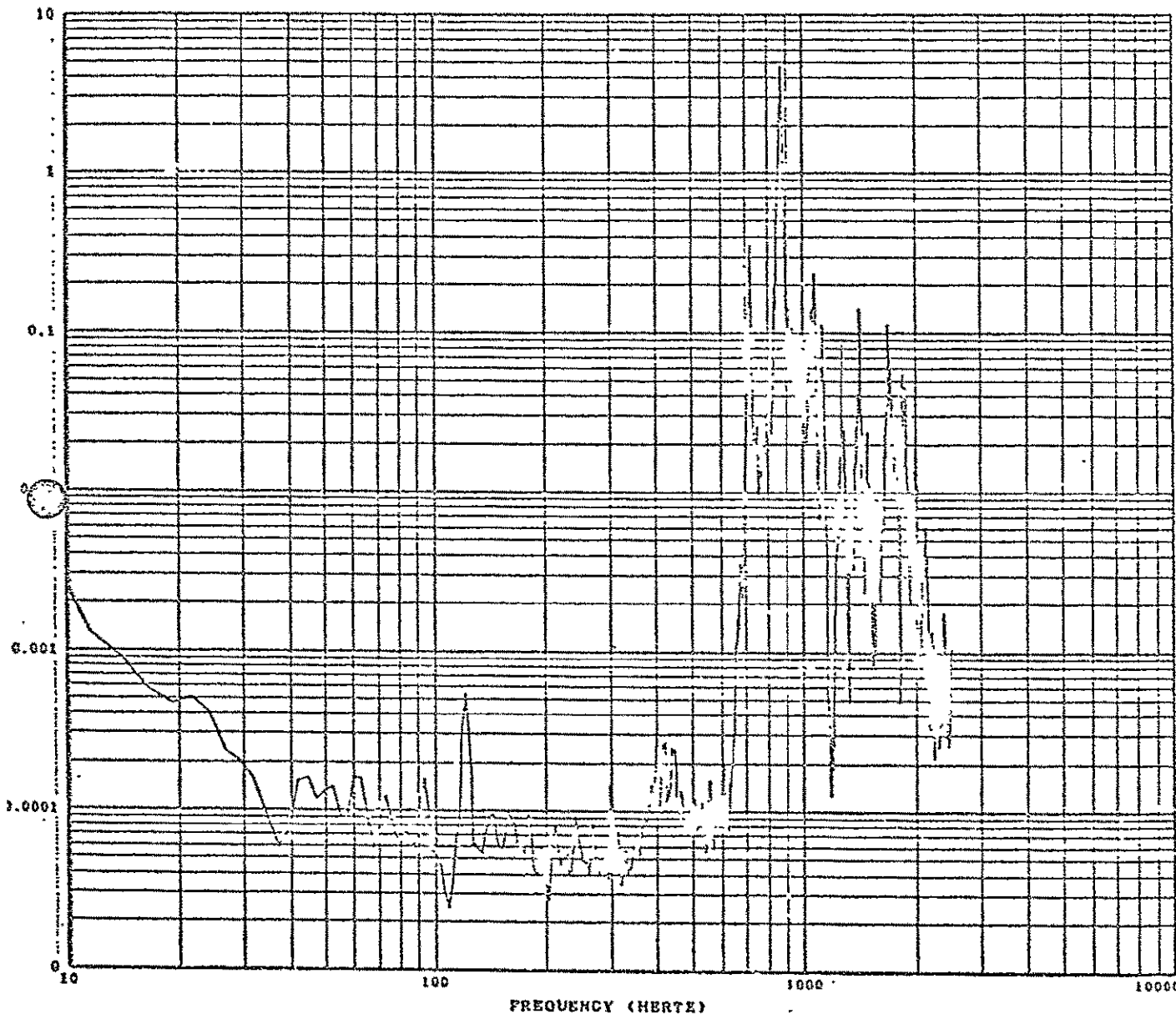
g rms = .59

PAGE 2.

Figure 68 Electronics Package, 'R' Axis
 Response to Input of Figure 65

C-2

SENSOR - EPS-4R ELECTRON/PHOTON SPECT. TEST CAL=31 6 TIME SLICE (HR-MIN-SEC) 16 35 15.0000 TO 16 35 19.0000
LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION. 11.4754 DATE PROCESSED 23FEB77
NORM. STD. ERROR.... .22115 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
FILTER BANDWIDTHS... 5.1116
FILTER START POINTS. .0000

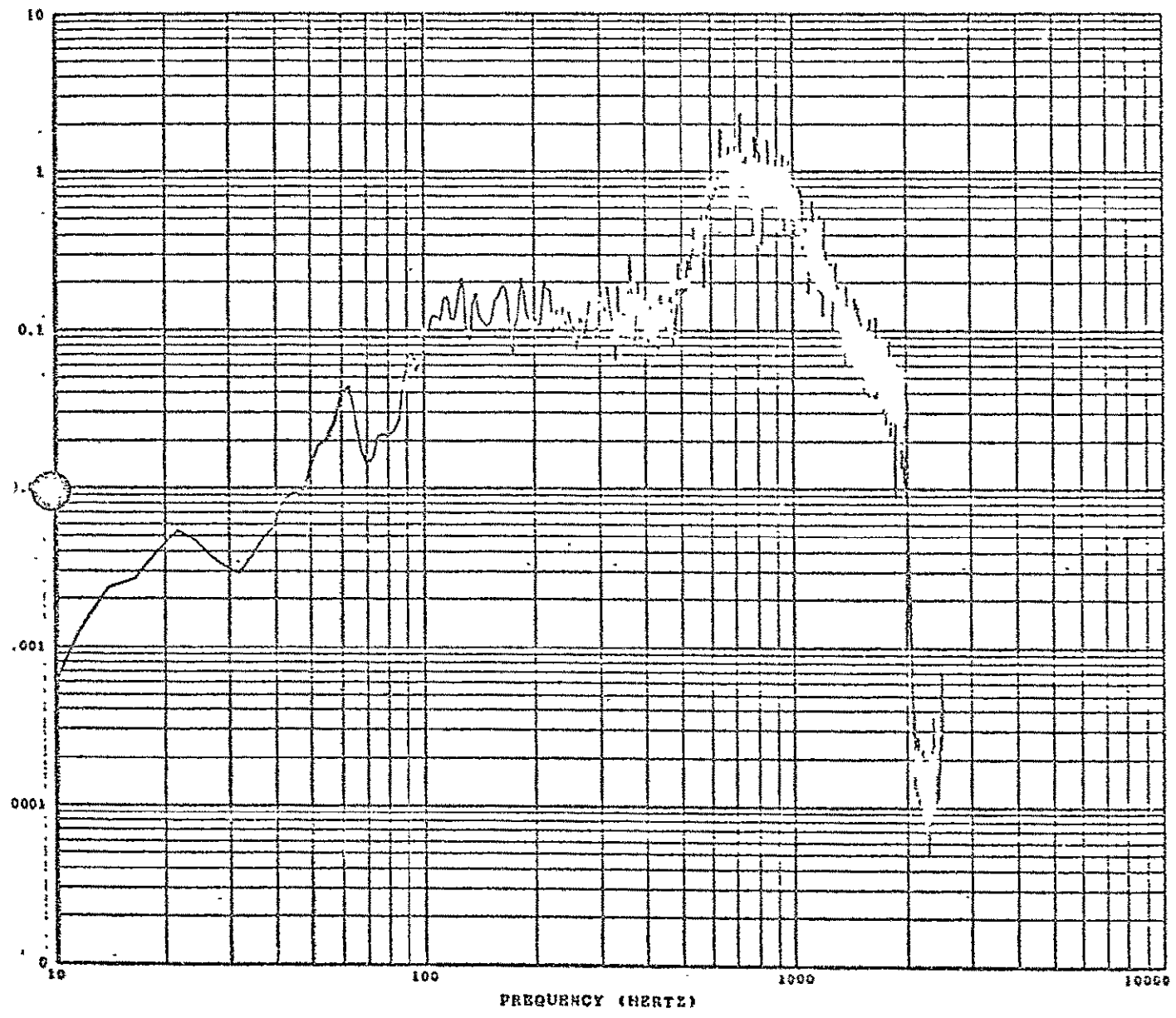


g rms = 11.48

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Figure 69 Baseplate, 'R' Axis Response to Input of Figure 65

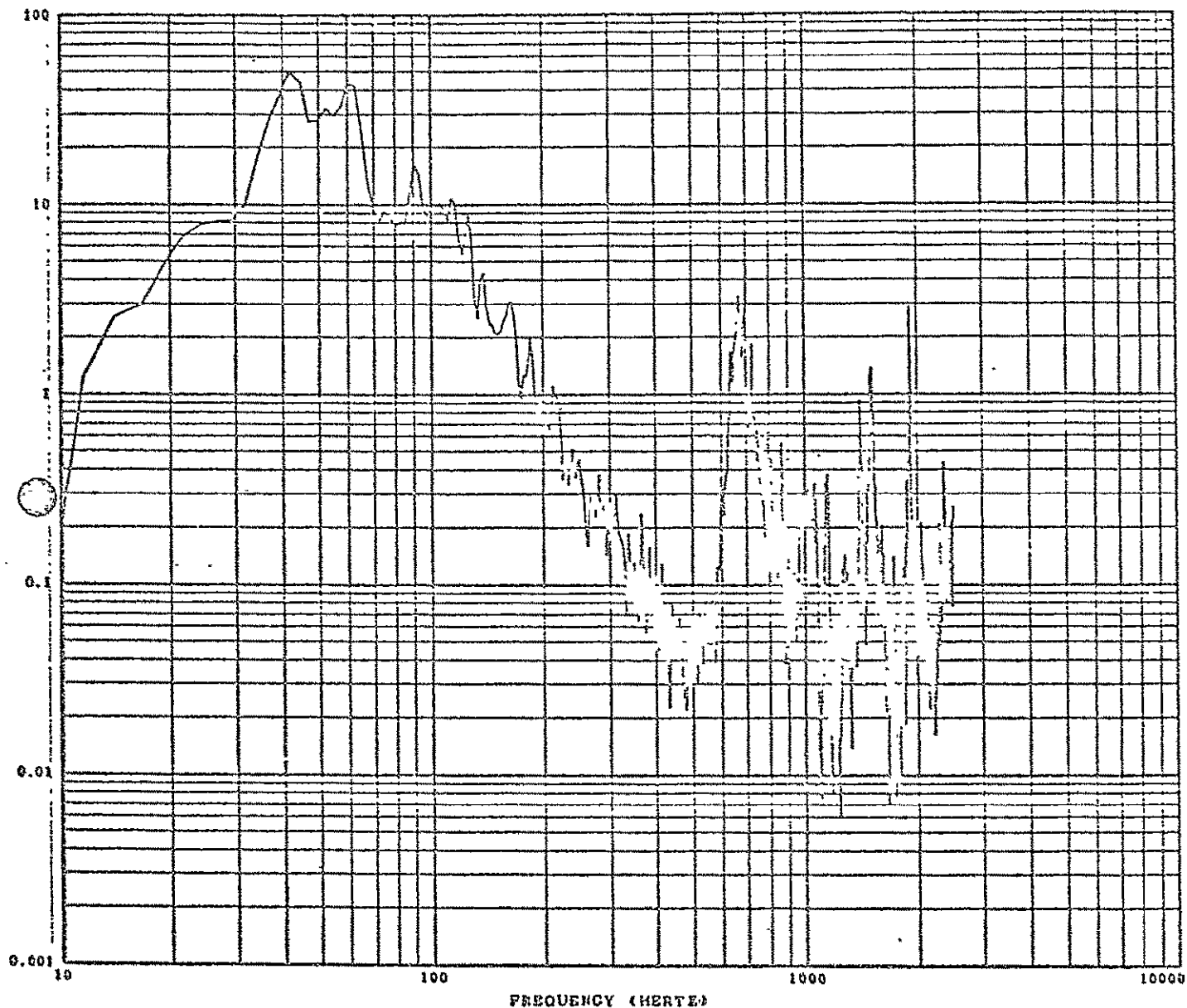
SENSOR - CONTROL ELECTRON/PROTON SPECT. TEST CAL=100. TIME SLICE (HR-MIN-SEC) 10 37 58 0000 10 10 30 0000
LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 25.1593 DATE PROCESSED..... 23FEB77
NORM. STD. ERROR.... .22115 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
FILTER BANDWIDTHS... 5.1116
FILTER START POINTS. .0000



g rms = 25.16 2403 6.

Figure 70 'T' Axis Input, Transonic/MACH 1 Simulation

SENSOR - EPS-37 ELECTRON/PHOTON SPECT. TEST CAL=31.6 TIME SLICE (HR-MIN-SEC) 16 35 56.0000 TO 16 36 .0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION . 1.6722 DATE PROCESSED..... 23F7877
 NORM. STD. ERROR.... .22115 VIBRATION TEST RUN 60X INPUT TAPE NUMBER....
 FILTER BANDWIDTH... 5.1116
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X .001000

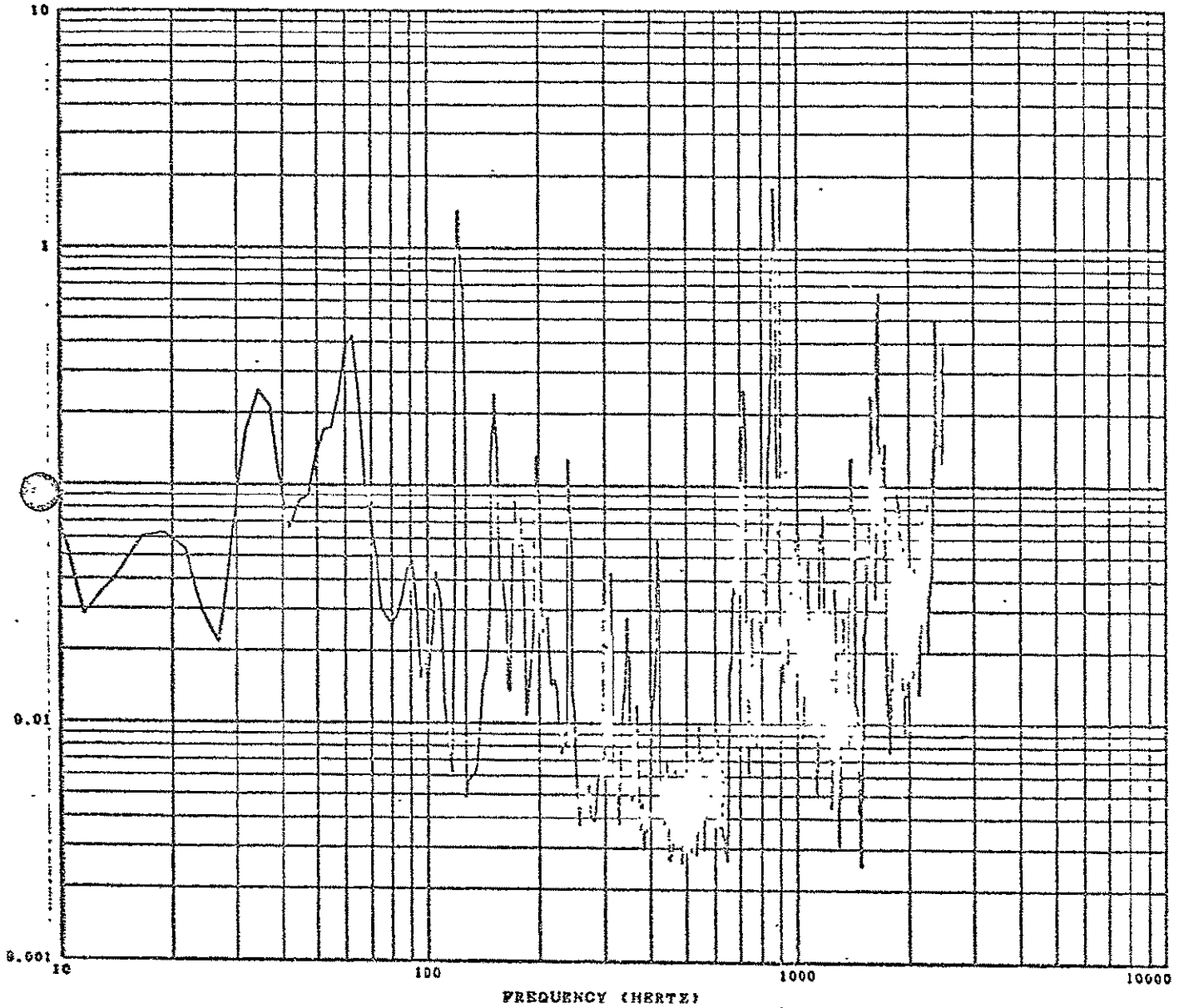


g rms = 1.67

PAGE 5.

Figure 71 Electronics Package, 'T' Axis
Response to Input of Figure 70

SENSOR - EPS-2R ELECTRON/PROTON SPECT. TEST CAL=31.6 TIME SLICE (HR-MIN-SEC) 16 35 56.0000 TO 16 36 .6000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION... .5986 DATE PROCESSED..... 23FEB77
 NORM. STD. ERROR.... .22115 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1116
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X .001000

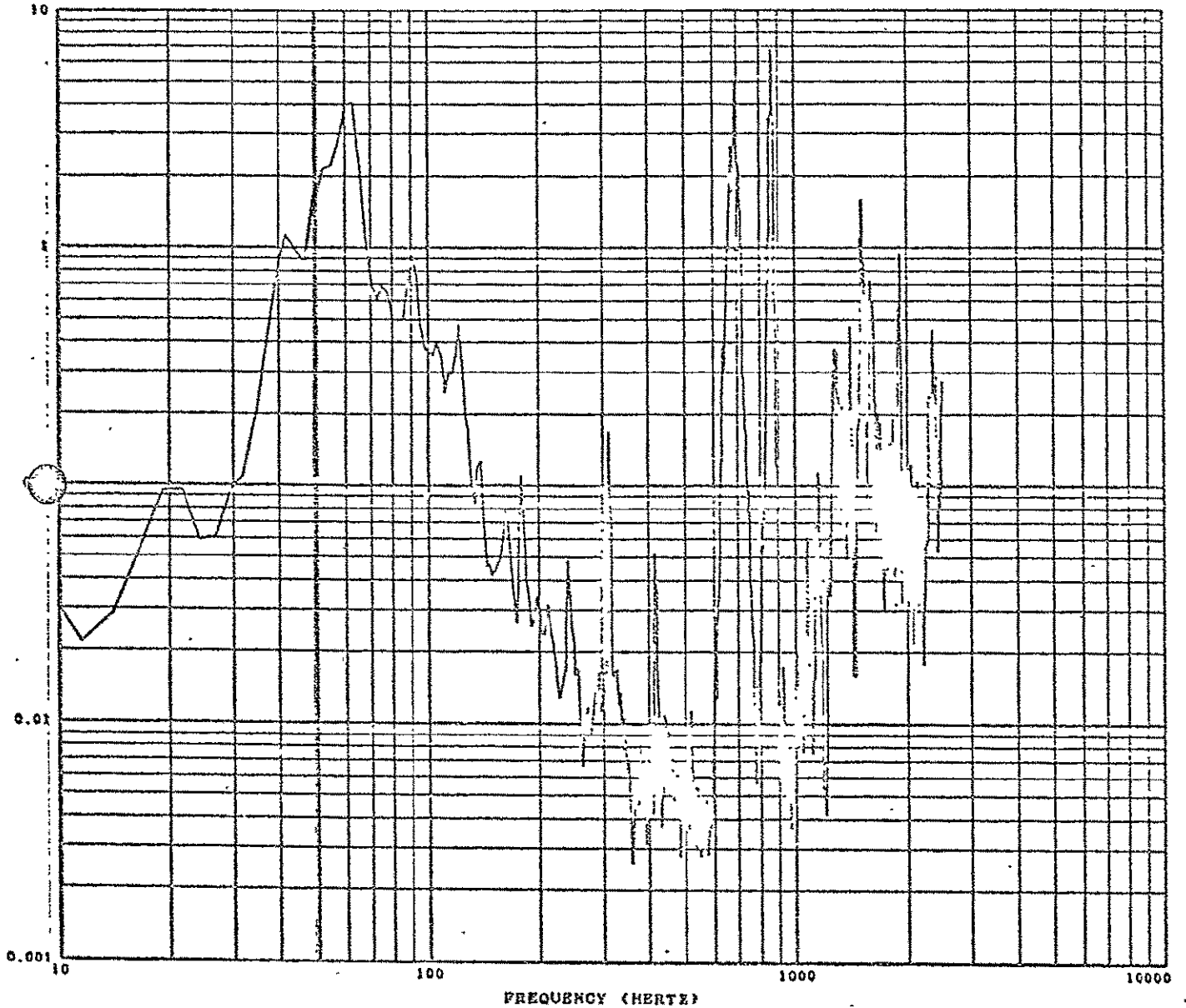


g rms = .60

PAGE 3.

Figure 72 Electronics Package, 'X' Axis
Response to Input of Figure 70

SENSOR - EPS-1R ELECTRON/PROTON SPECT. TEST CAL=31 6 TIME SLICE (HR-MIN-SEC) 16 35 56 0000 TO 16 36 0000
 LOS-PASS FILTER USED 3000.0 STANDARD DEVIATION.. .8702 DATE PROCESSED..... 23FEB77
 NOISE STD. ERROR.... .22115 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTH... 5.1115
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X .001000

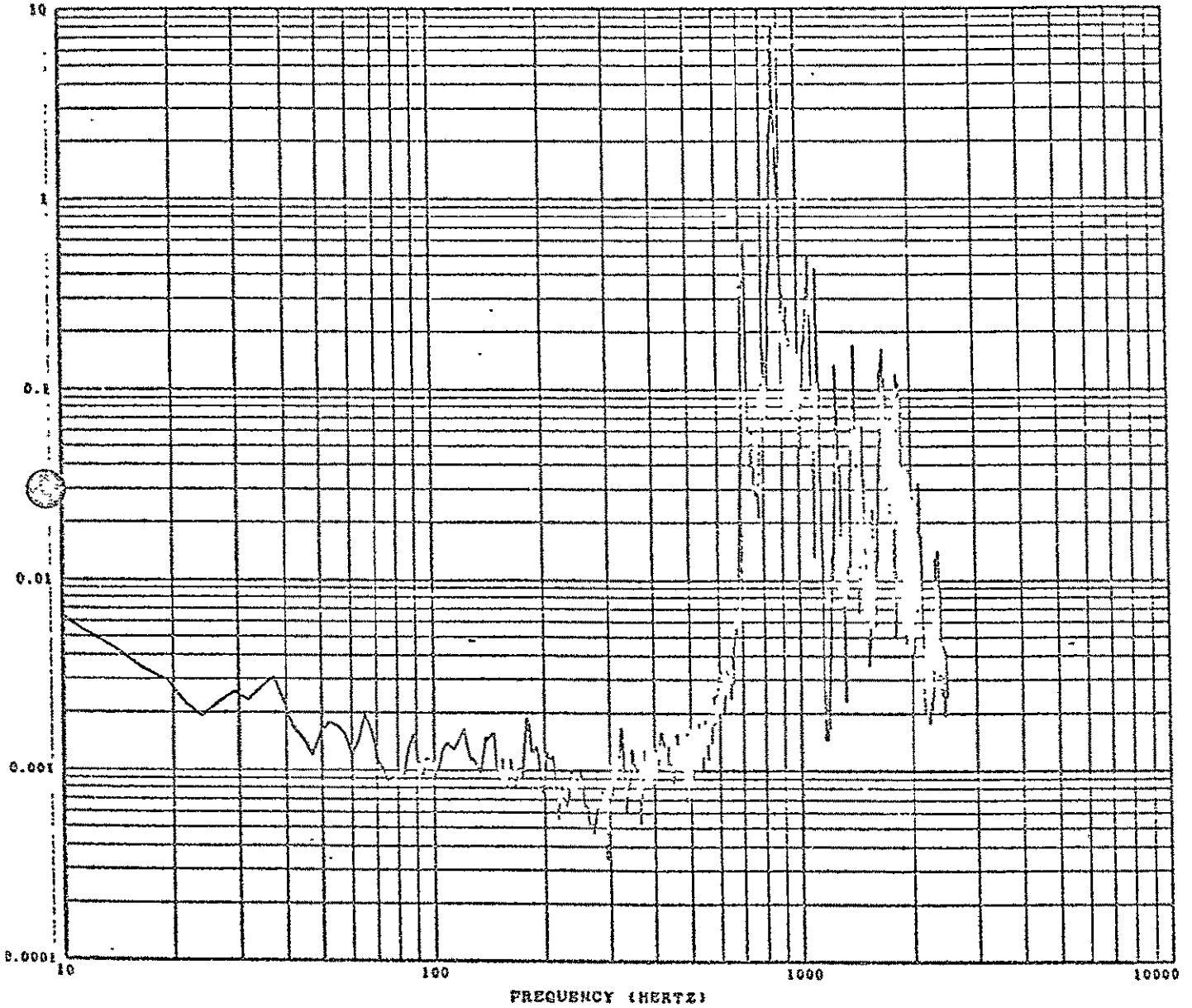


g rms = .87

PAGE 1.

Figure 73 Electronics Package, 'R' Axis
Response to Input of Figure 70

SENSOR - EPS-4R ELECTRON/PROTON SPECT. TEST CAL=31.6 TIME SLICE (HR-MIN-SEC) 16 35 56.0000 TO 16 36 .0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION 16.4033 DATE PROCESSED..... 23FEB77
 NOM. STD. ERROR..... .22115 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1118
 FILTER START POINTS. .0000

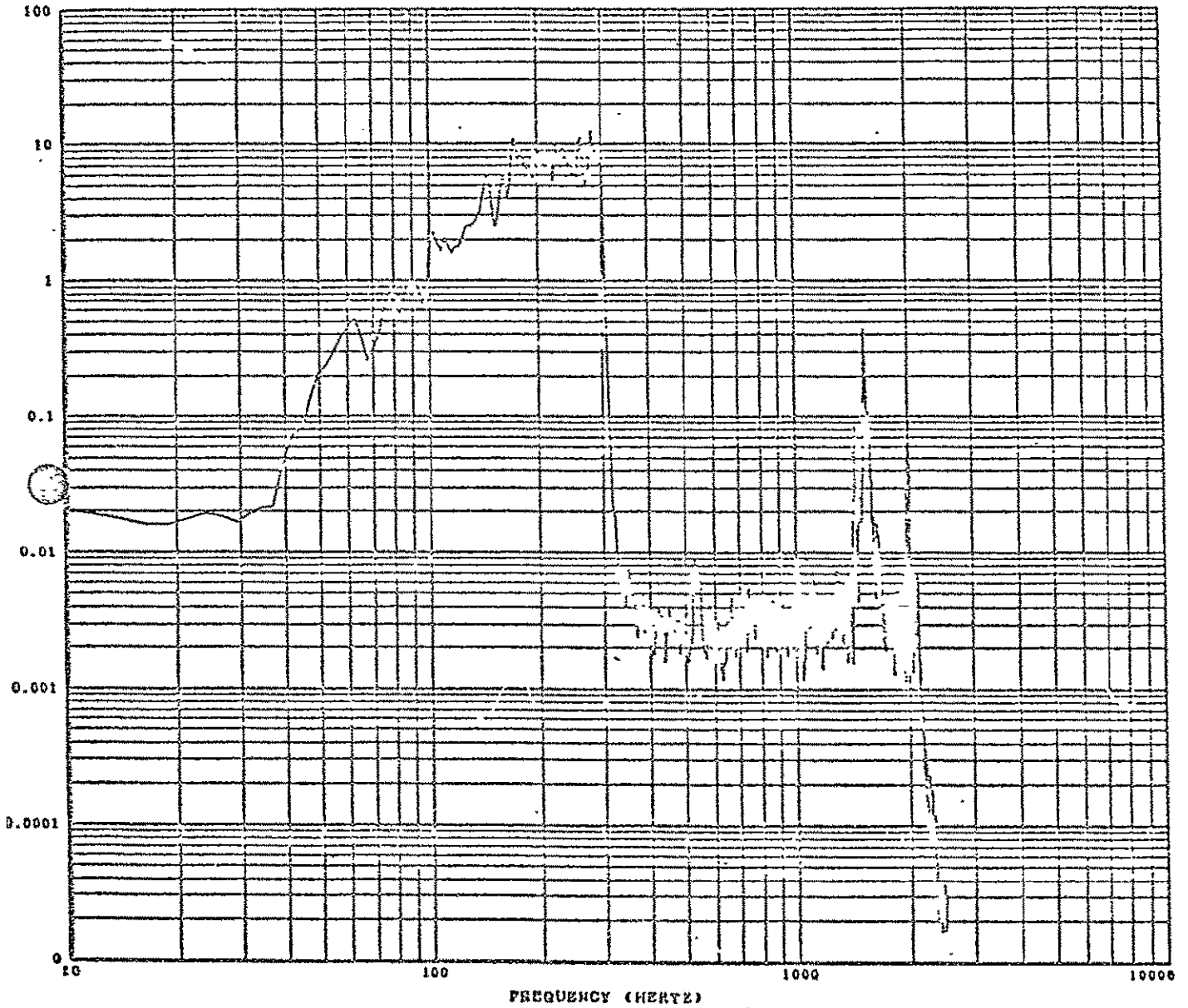


g rms = 16.40

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Figure 74 Baseplate, 'R' Axis Response to Input of Figure 70

SENSOR - COMVAL ELECTRON/PROTON SPECT. TEST CAL-100. TIME SLICE (HR-MIN-SEC) 15 29 29.0000 TO 15 29 33.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 36.5886 DATE PROCESSED... .. 25-FEB-77
 NORM. STD. ERROR.... .22115 VIBRATION TEST RUN 80X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1116
 FILTER START POINTS. .0000

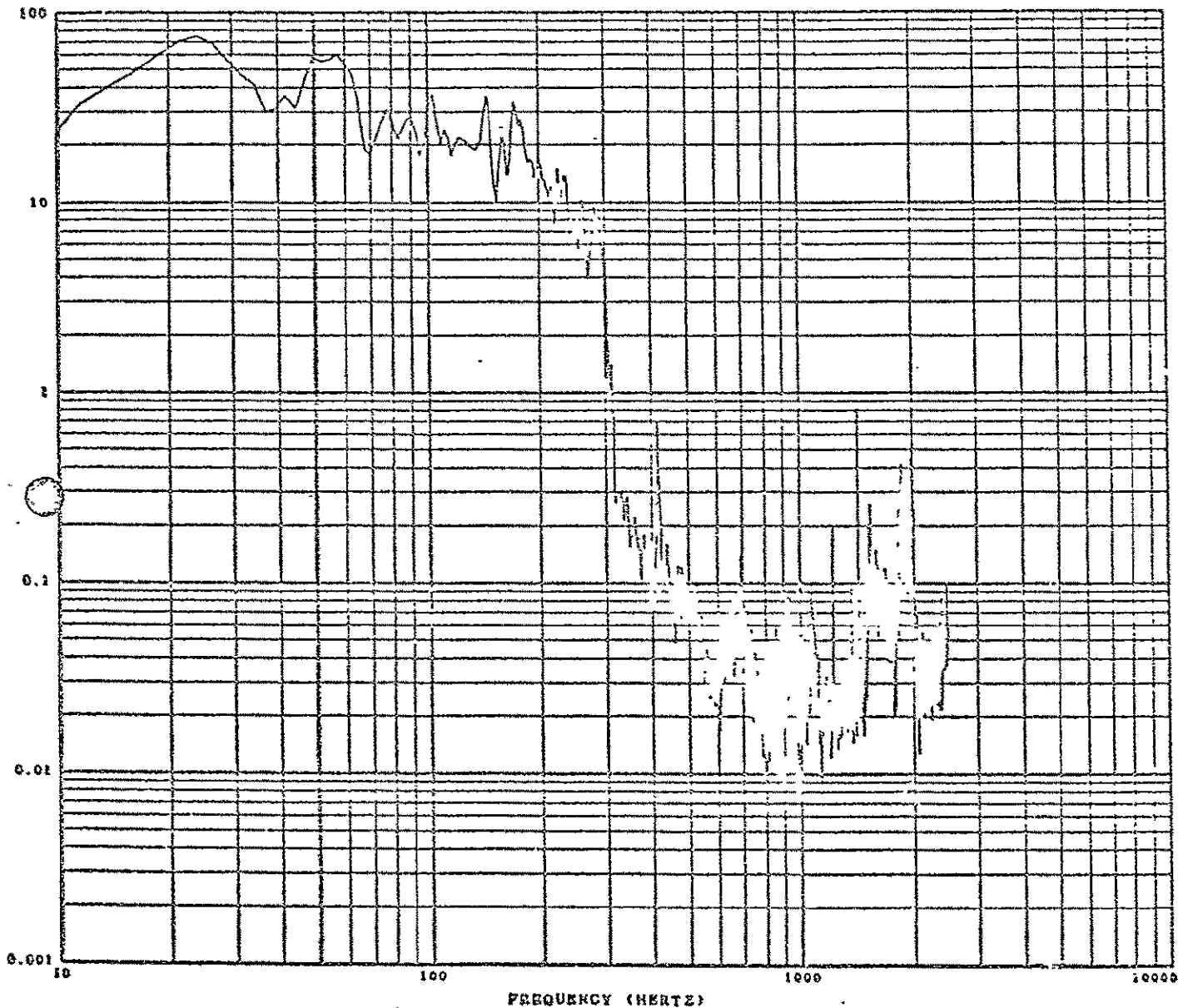


g rms = 36.58

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Figure 75 'R' Axis Input, Max. g
Simulation (20 - 300 Hz)

SENSOR - EPS-1R ELECTRON/PROTON SPECT. TEST CAL=100 TIME SLICE (HR-MIN-SEC) 15 29 29.0000 TO 15 29 33.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION 2.6475 DATE PROCESSED..... 25FEB77
 NORM. STD. ERROR..... .32115 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1116
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN' X .001000

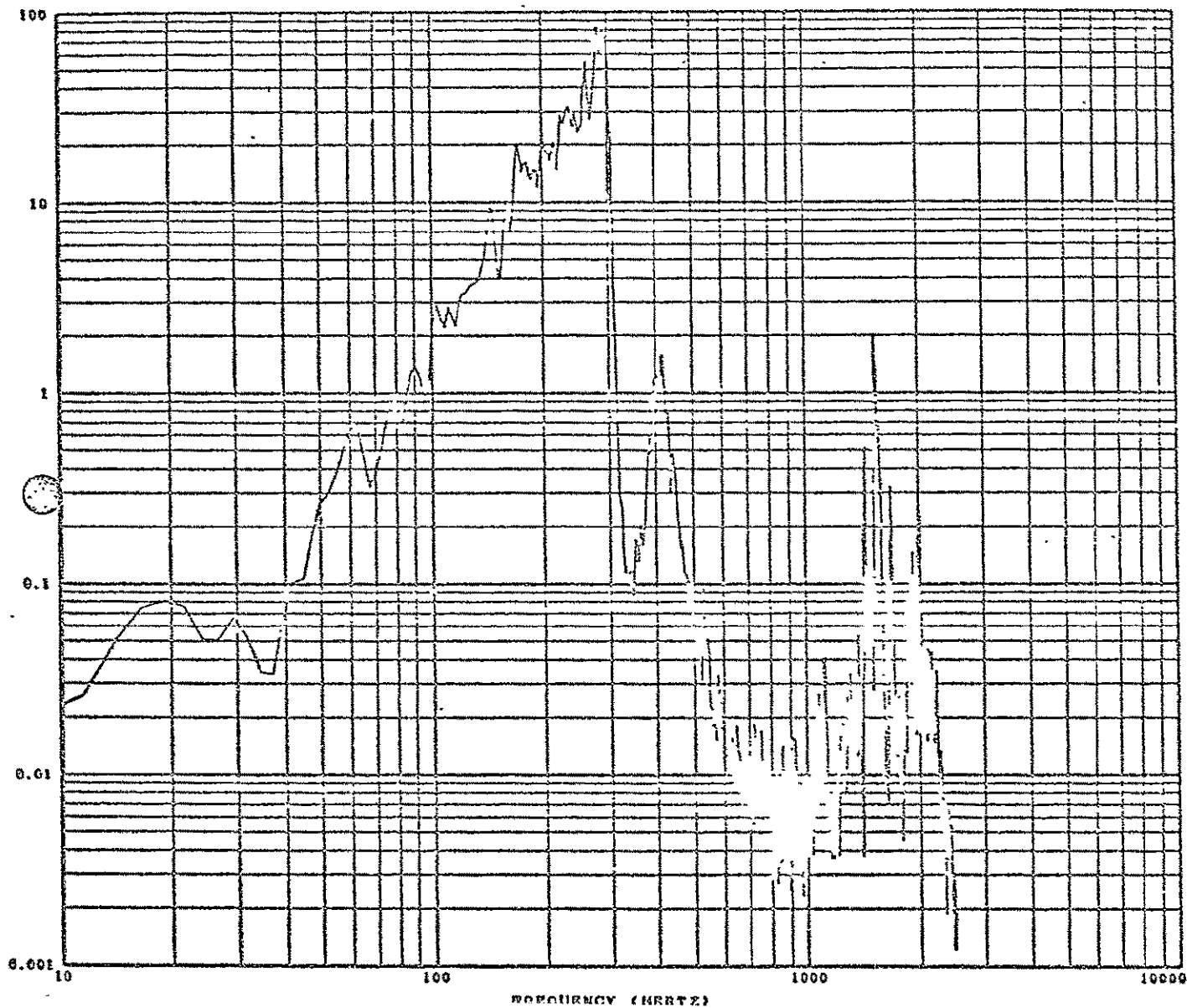


g rms = 2.65

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Figure 76 Electronics Package, 'R' Axis
Response to Input of Figure 75

SENSOR - EPS-4R ELECTRON/PROTON SPECT. TEST CAL=1000. TIME SLICE (HR-MIN-SEC) 15 29 29.0000 TO 15 29 31.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION. 71.5610 DATE PROCESSED 25/2317
 NORM. STD. ERROR.... .22115 VIBRATION TEST RUN 50X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1116
 FILTER START POINTS. 0000

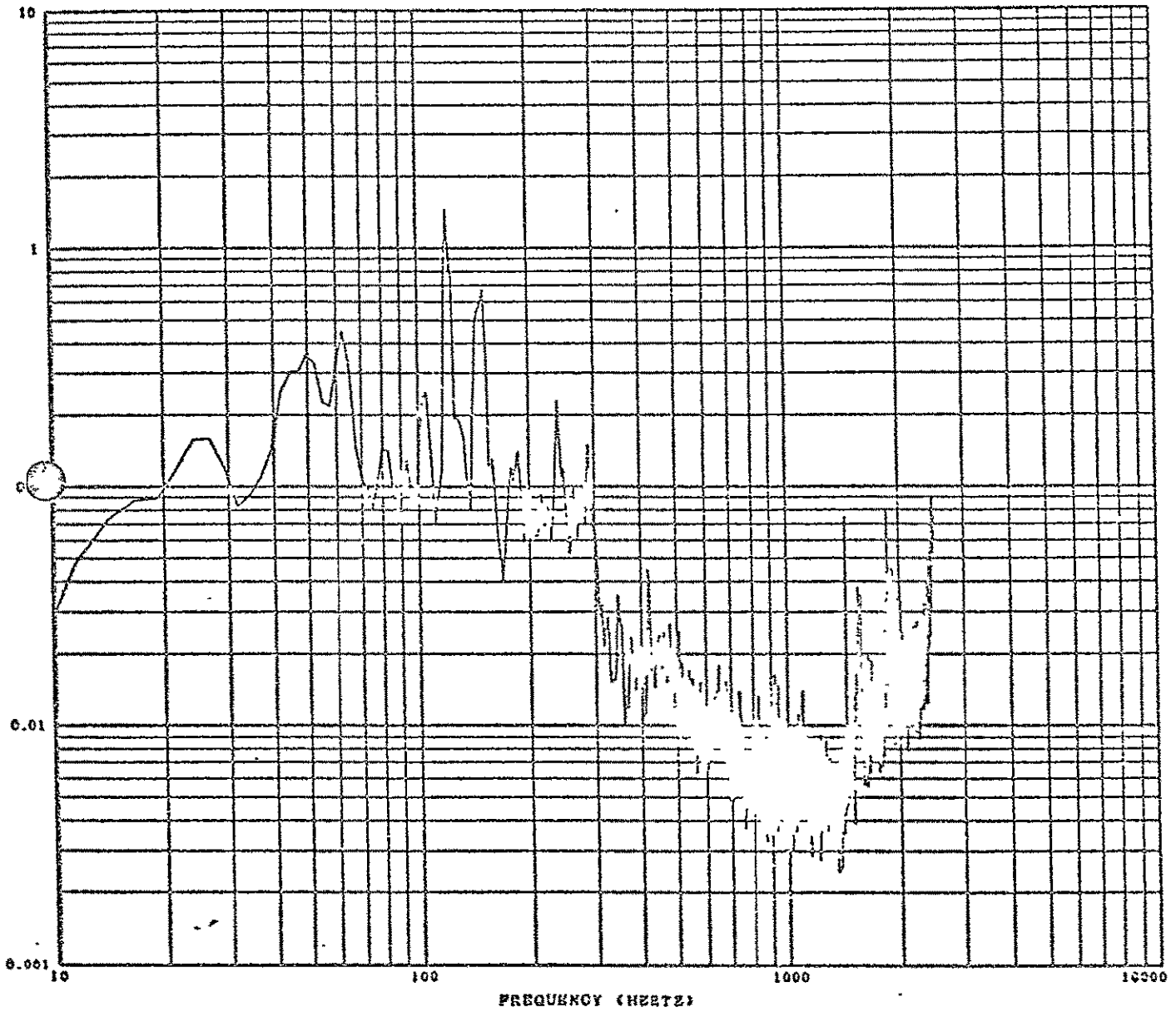


g rms = 71.56

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Figure 77 Baseplate, 'R' Axis Response to Input of Figure 75

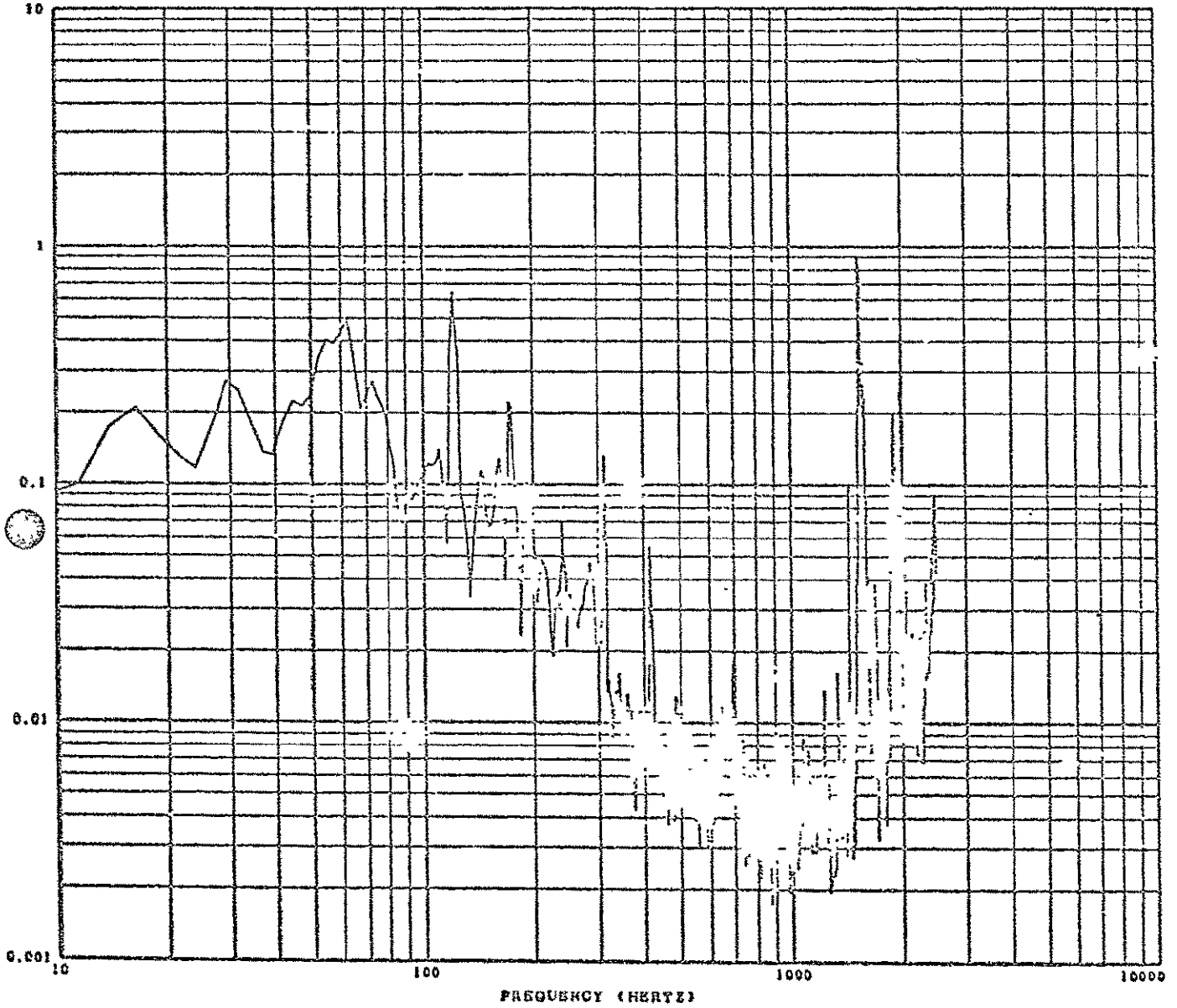
SENSOR - EPS-2R ELECTRON/PROTON SPECT. TEST CAL-31.0 TIME SLICE (HR-MIN-SEC) 15 29 29.0000 TO 15 29 33 0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION .389% DATE PROCESSED..... 25FEB77
 NORM. STD. ERROR... .22115 VIBRATION TEST RUN BOX INPUT TAPE NUMBER...
 FILTER BANDWIDTH... 5.1116
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE * VALUE SHOWN * X .001000



g rms = .39

Figure 78 Electronics Package, 'X' Axis
Response to Input of Figure 75

SENSOR - EP6-JT ELECTRON/PROTON SPECT. TEST CAL=31.6 TIME SLICE (MIN-MIN-SEC) 15 29 29.0000 TO 15 29 33 0000
LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION .3912 DATE PROCESSED..... 25FEB77
NORM. STD. ERROR22115 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
FILTER BANDWIDTHS... 5.1116
FILTER START POINTS. .0000
VERTICAL SCALE FACTOR USED. TRUE VALUE * VALUE SHOWN * X .001000

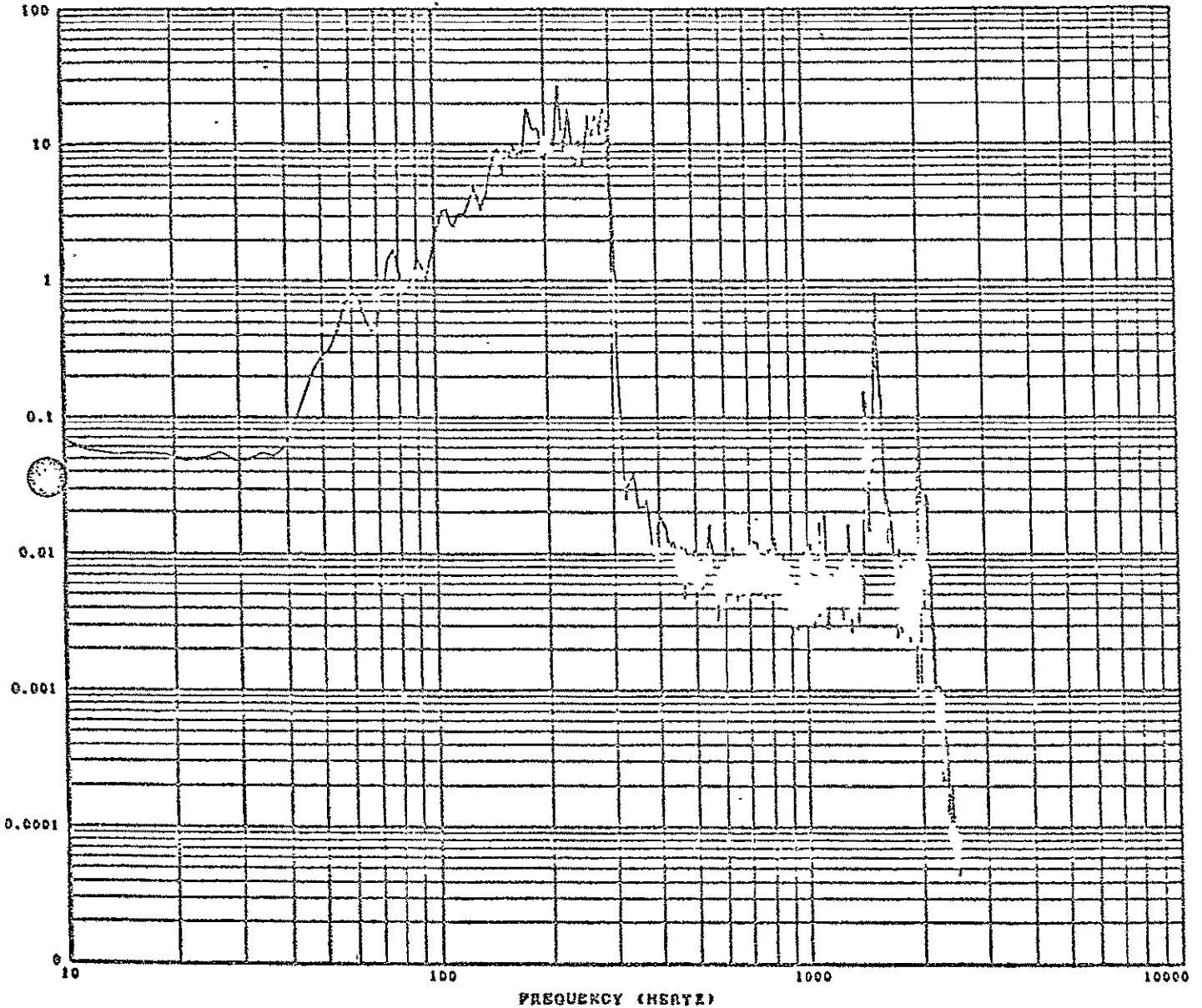


g rms = .39

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Figure 79 Electronics Package, 'T' Axis Response to Input of Figure 75

SENSOR - CONTROL ELECTRON/PROTON SPECT. TEST CAL-100. TIME SLICE (PRE-MIN-SEC) 15 30 45.0000 TO 15 30 49.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 46.0644 DATE PROCESSED..... 25-SEP-77
 NORM. STD. ERROR... .22113 VIBRATION TEST RUN 00X INPUT TAPE NUMBER...
 FILTER BANDWIDTH... 5.1129
 FILTER START POINTS. .0000

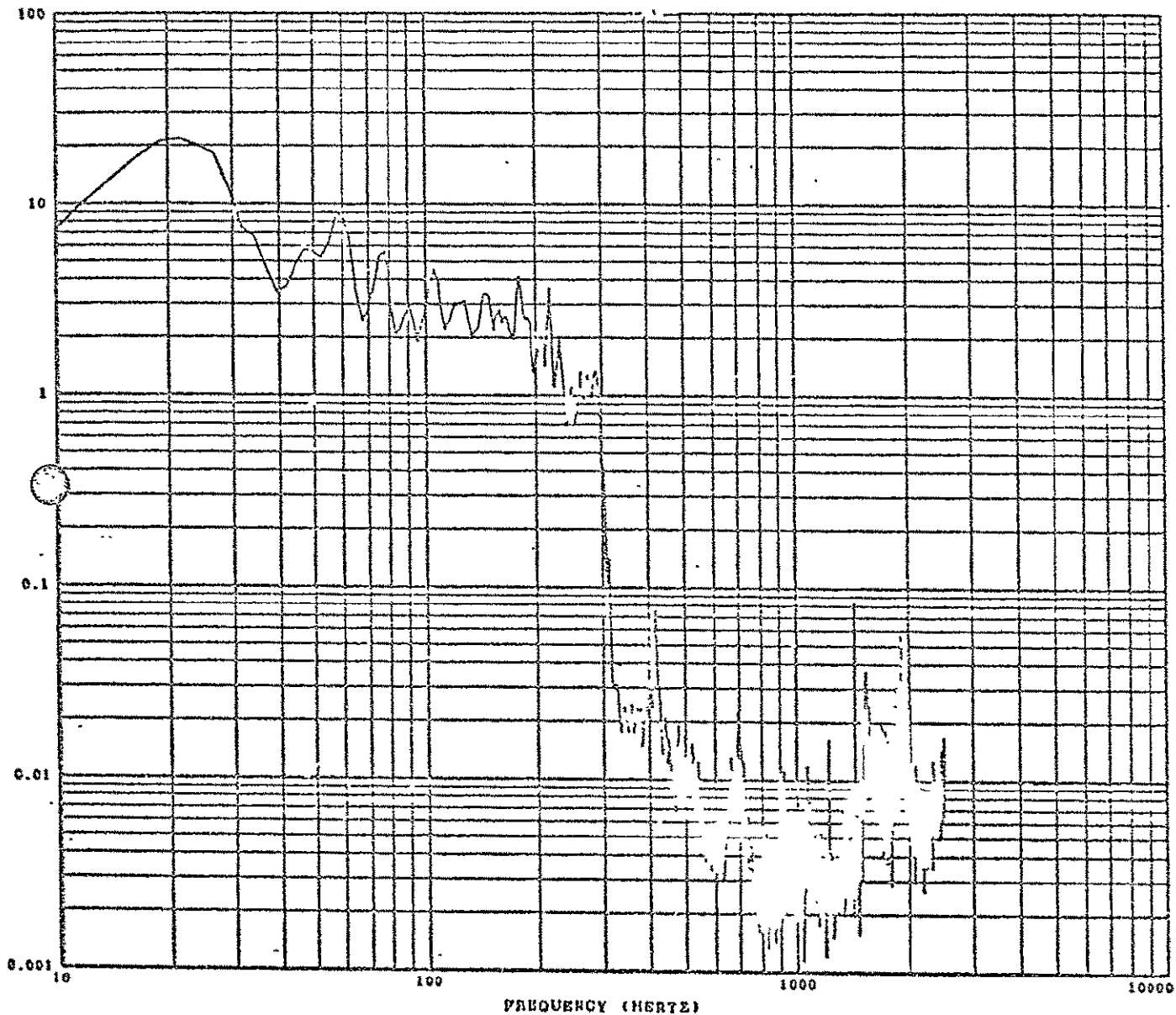


g rms = 46.06

PAGE 0.

Figure 80 'R' Axis Input, Transonic/MAC" ' Simulation, (20 - 300 Hz)

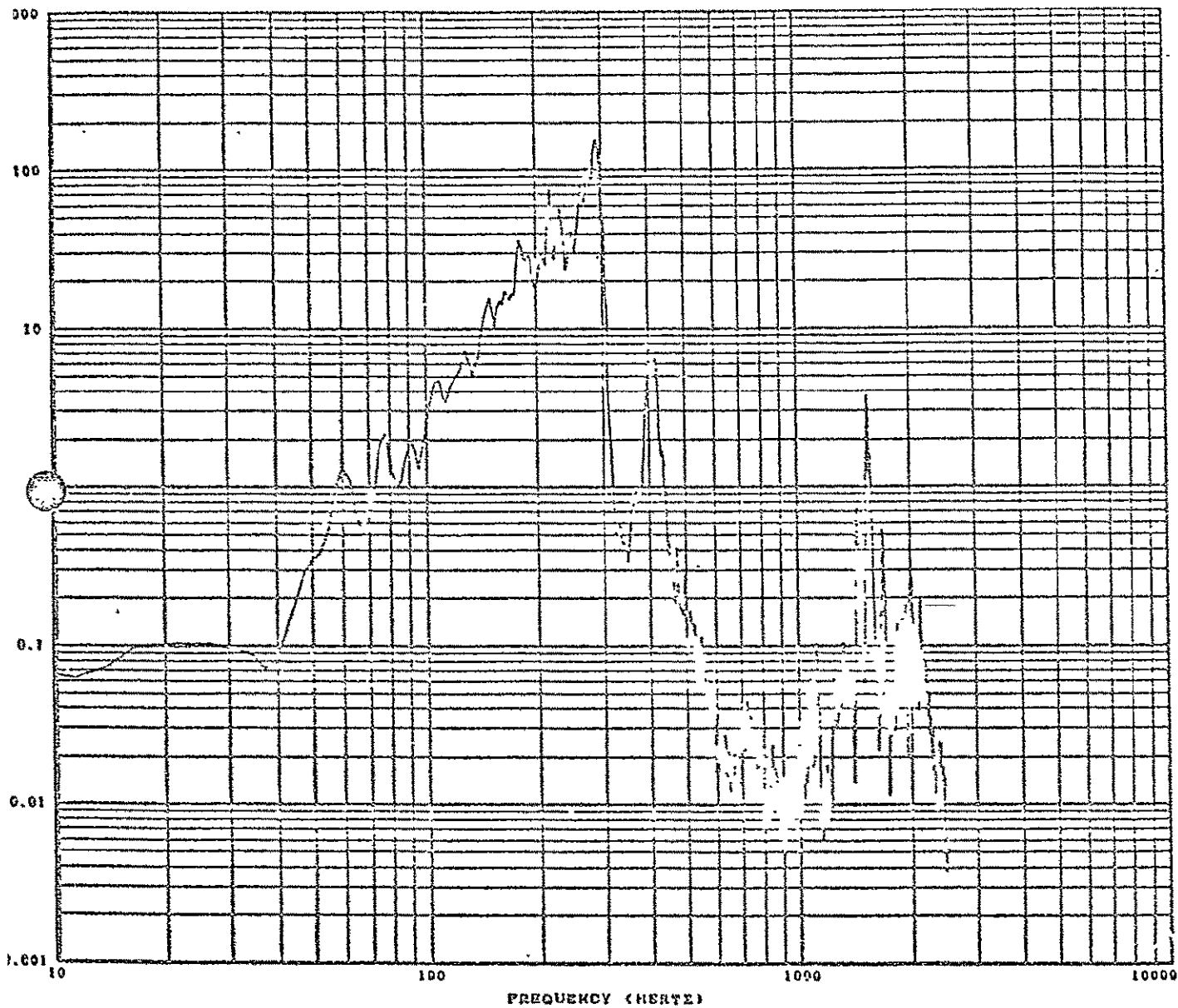
SENSOR - EPS-1R ELECTRON/PROTON SPECT. TEST CAL=100. TIME ALICE (HR-MIN-SEC) 15 30 45.0000 TO 15 30 49.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 3.3641 DATE PROCESSED..... 25FEB77
 NORM. STD ERROR... .22113 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1129
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X .010000



g rms = 3.36 PAGE 1.

Figure 81 Electronics Package, 'R' Axis
Response to Input of Figure 80

SENSOR - EPS-4H ELECTRON/PROTON SPECT. TEST CAL=1000. TIME SLICE (HR-MIN-SEC) 15 30 45.0000 TO 15 30 49.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 91.5681 DATE PROCESSED..... 25FEB77
 NORM. STD. ERROR... .22113 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1128
 FILTER START POINTS. .0000

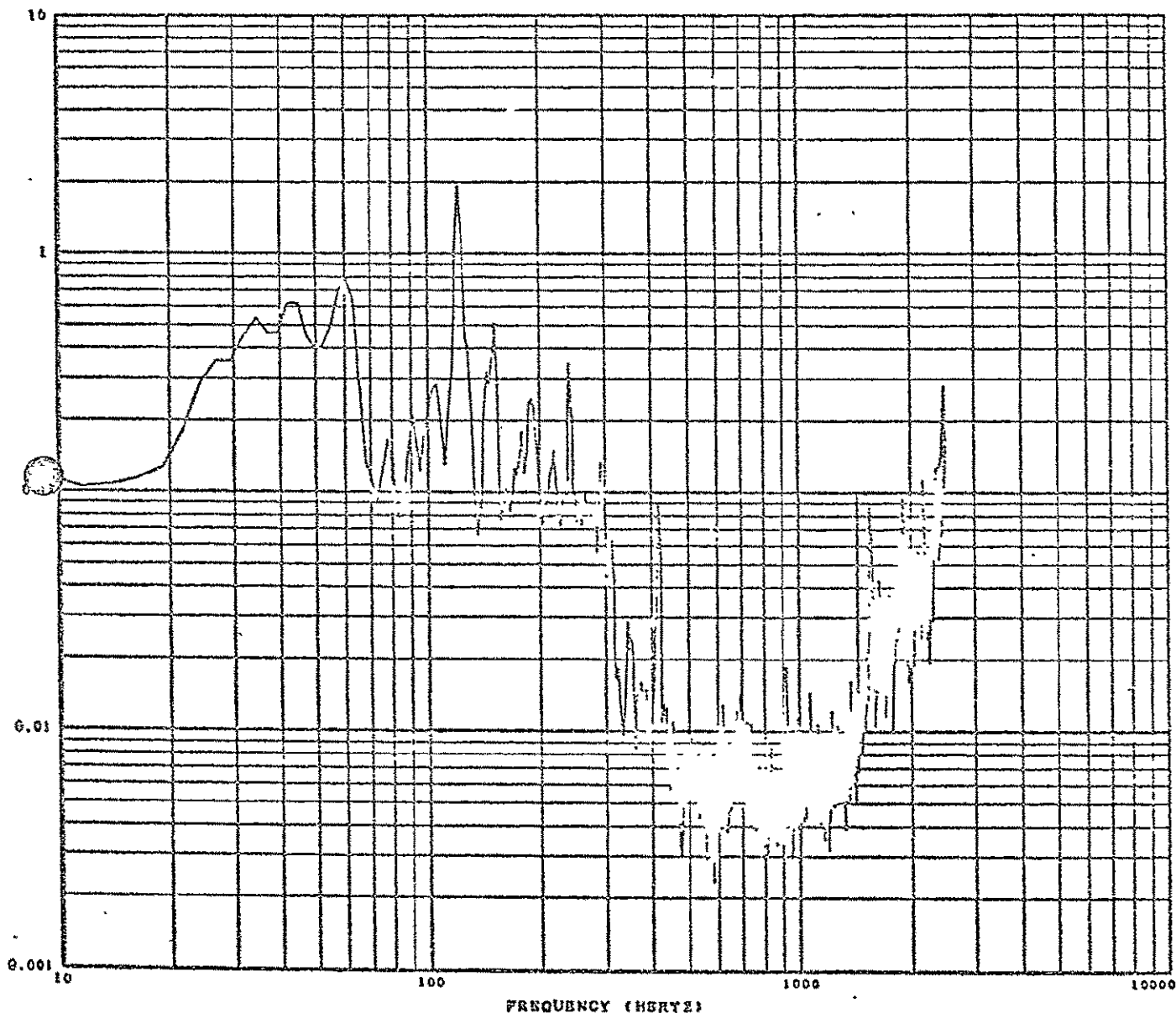


g rms = 91.57

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Figure 82 Baseplate, 'R' Axis Response
to Input of Figure 80

SENSOR = E15-2R ELECTRON/PROTON SPECT. TEST CAL=31.6 TIME SLICE (HR-MIN-SEC) 15 30 45.0000 TO 15 30 49 0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION... .5253 DATE PROCESSED..... 45FEB77
 NORM. STD. ERROR... .22113 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 6.1129
 FILTER START POINTS .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X 001000

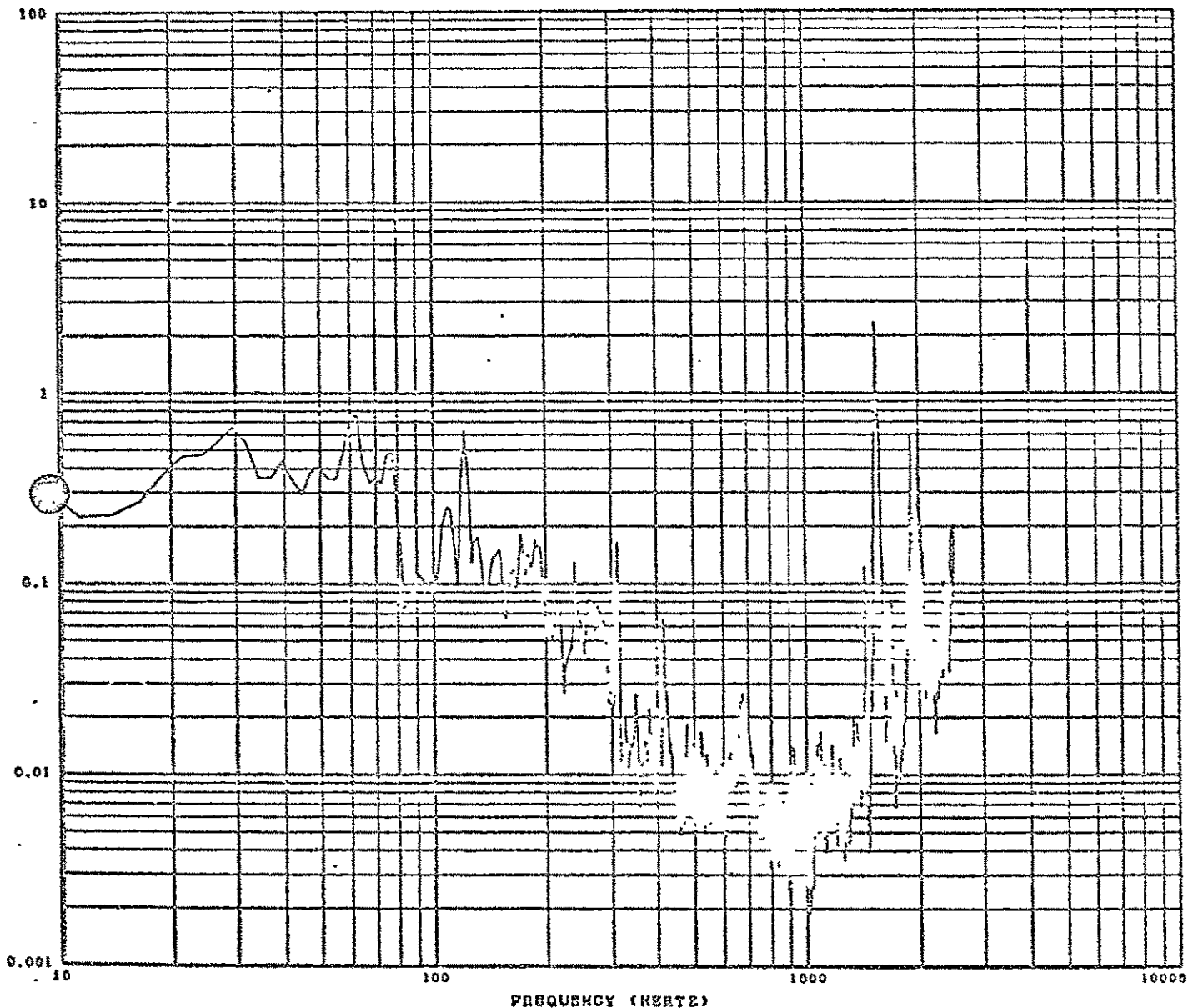


g rms = .53

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Figure 83 Electronics Package, 'X' Axis Response to Input of Figure 80

SENSOR - EPS-3T ELECTRON/PROTON SPECT. TEST CAL=31.6 TIME SLICE (HR-MIN-SEC) 15 30 45.0000 TO 15 30 49.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION... .6264 DATE PROCESSED..... 25-FEB-71
 NORM. STD. ERROR.... .22113 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1129
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN * X .001000

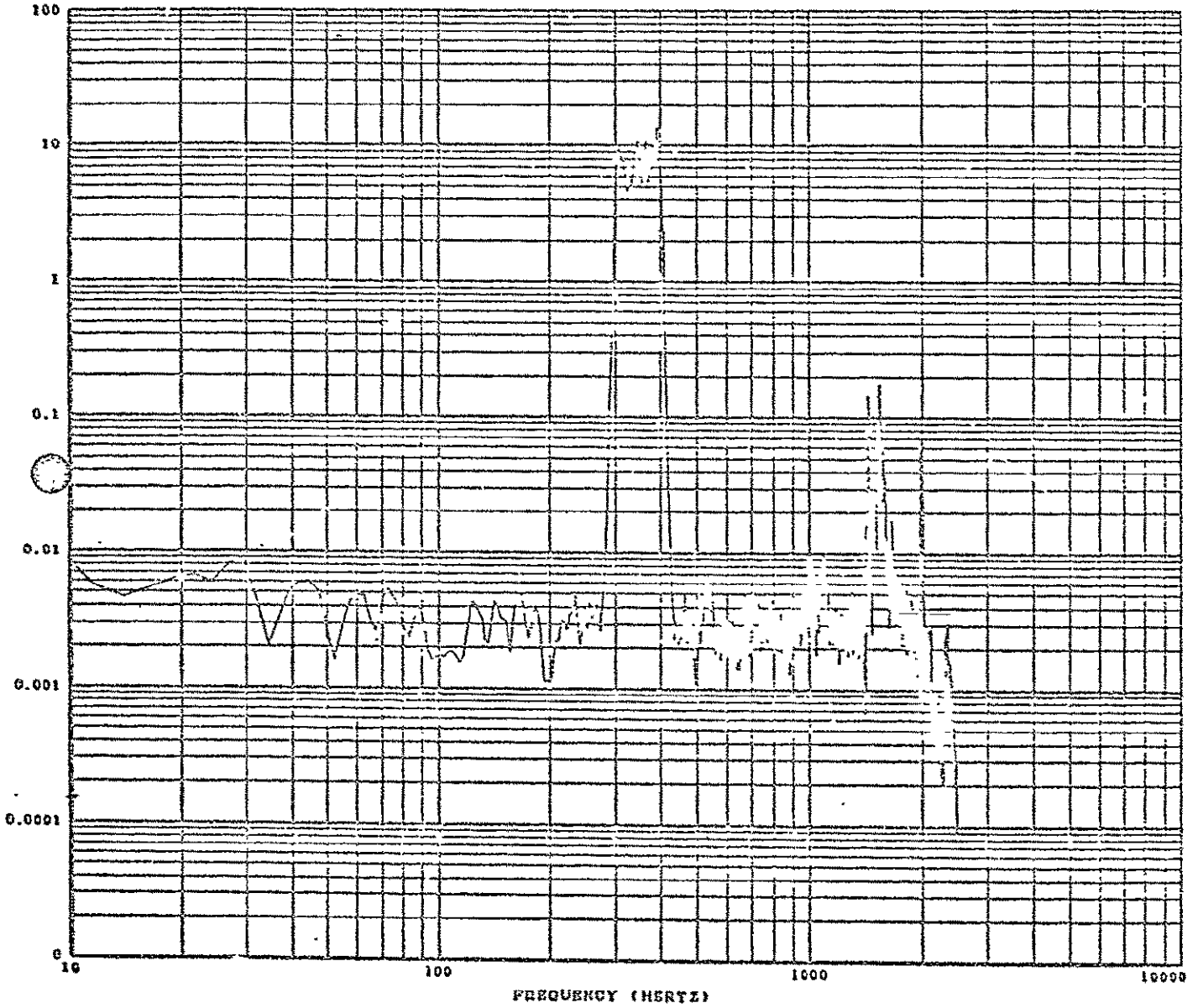


g rms = .63

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Figure 84 Electronics Package, 'T' Axis
Response to Input of Figure 80

SENSOR - CONTRL ELECTRON/PROTON SPECT. TEST CAL+100. TIME SLICE (HR-MIN-SEC) 15 51 .0000 TO 15 51 4.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION. 29 0160 DATE PROCESSED..... 25FEB77
 NORM. STD. ERROR.... .22126 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1064
 FILTER START POINTS. .0000



g rms = 29.02 PK78 B.

Figure 85 'R' Axis Input, Max. q
Simulation (300 - 400 Hz)

SENSOR - EPS-1R ELECTRON/PROTON SPECT. TEST CAL-100. TIME SLICE (HR-MIN-SEC) 15 51 .0000 TO 15 51 4 0000
 LOW-PASS FILTER USED 3000.0 % STANDARD DEVIATION.. 1 1281 DATE PROCESSED..... 25FEB77
 NORM. STD. ENDR.... .22126 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTH ... 5.1064
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN' X .001000

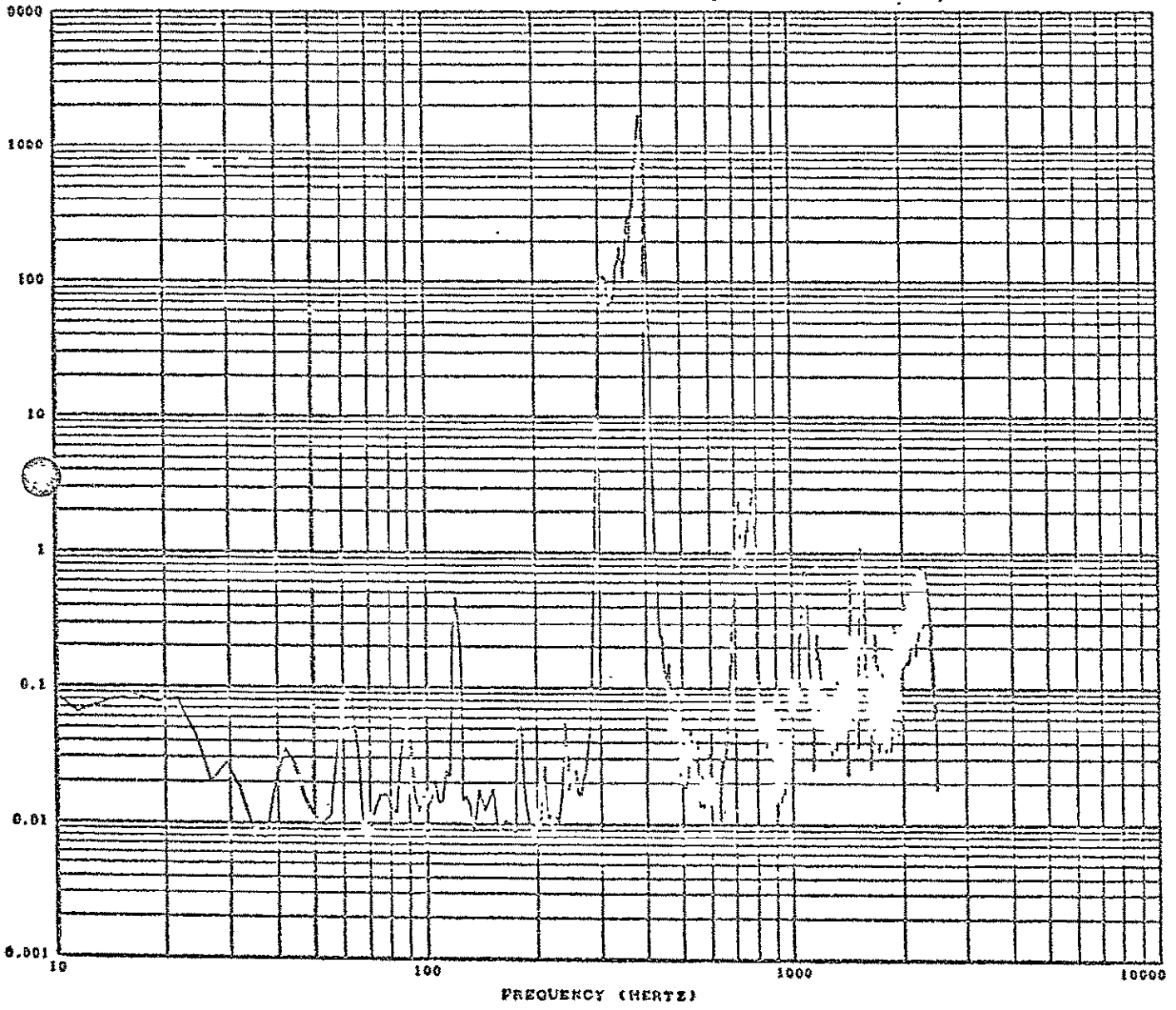


g rms = 1.83

PAGE 0.

Figure 86 Electronics Package, 'R' Axis
Response to Input of Figure 85

SENSOR - EPS-4R ELECTRON/PROTON SPECT. TEST CAL=1000 TIME ALICE (HH-MIN-SEC) 15 51 .0000 TO 15 51 4.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 213.1949 DATE PROCESSED..... 25FEB77
 MAX. STD. ERROR.... .22126 VIBRATION TEST RUN 00X INPUT TAPE NUMBER...
 FILTER BANDWIDTH... 5.1084
 FILTER START POINTS. .0000

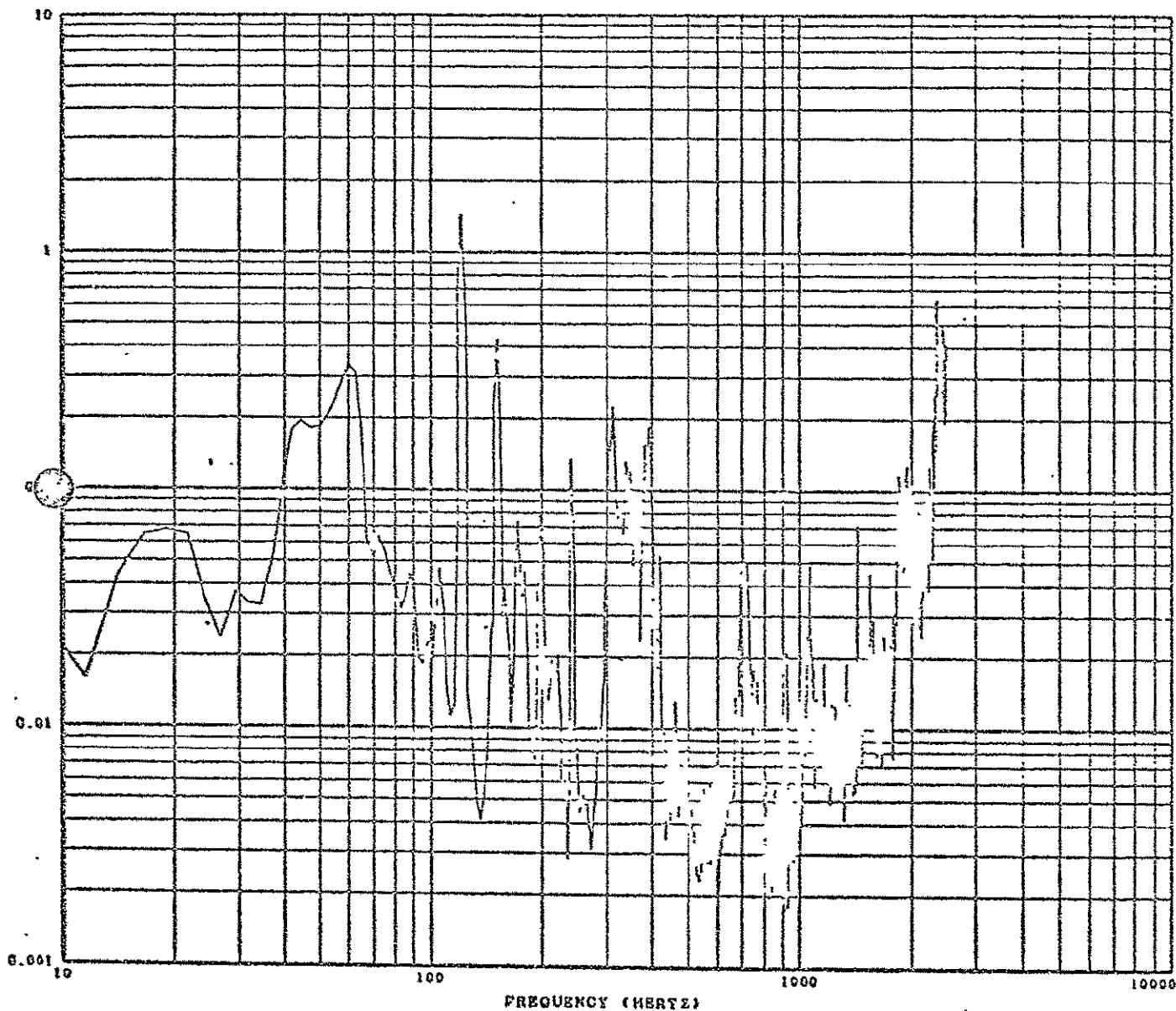


g rms = 213.19

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Figure 87 Baseplate, 'R' Axis Response
 to Input of Figure 85

SENSOR - EPS-2R ELECTRON/PHOTON SPECT. TEST CAL=31.6 TIME SLICE (HR-MIN-SEC) 15 51 .0000 TO 15 51 4.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION... .7543 DATE PROCESSED. 25-FEB77
 NORM. STD. ERROR.... .22126 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1064
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X .001000

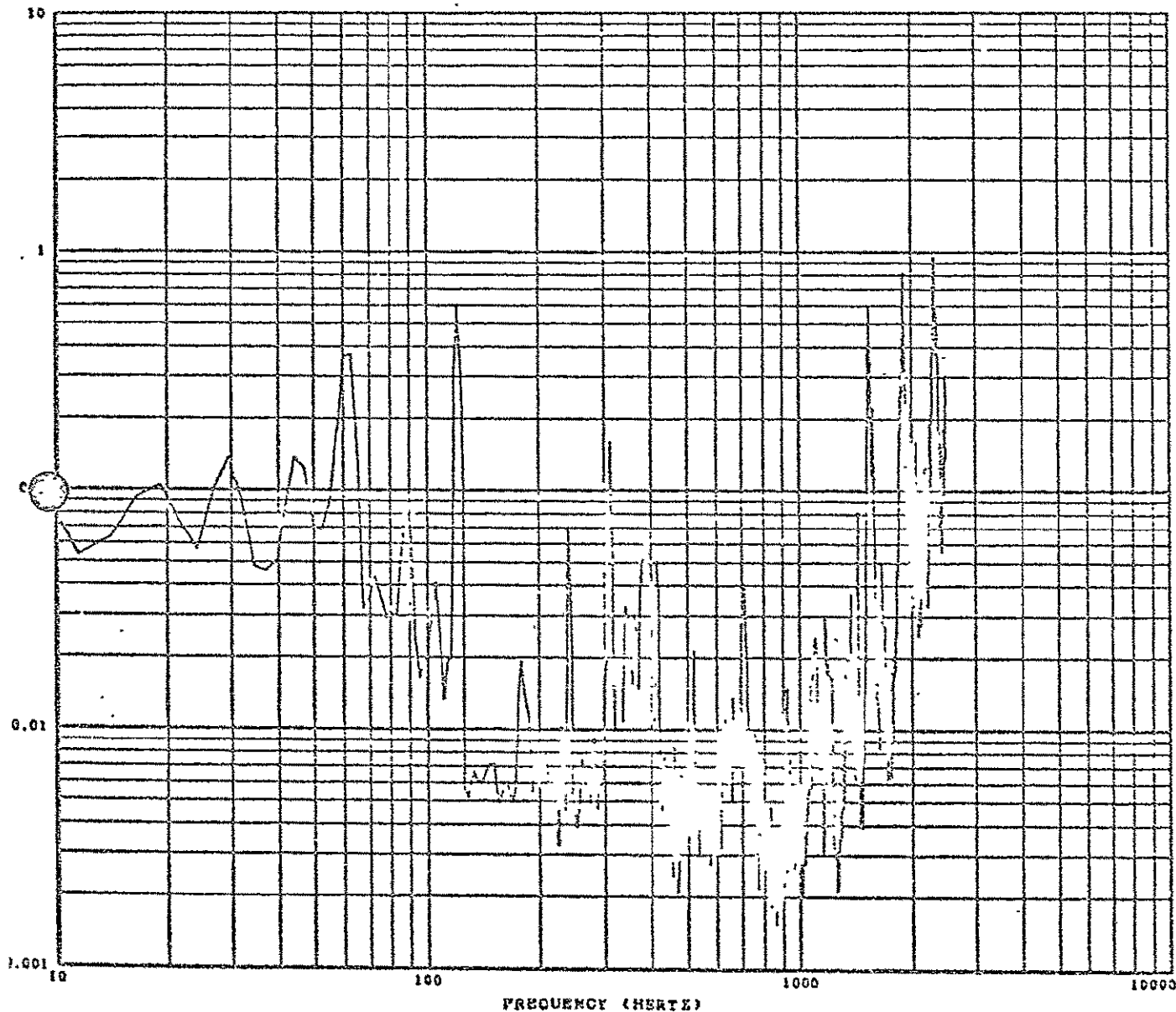


g rms = .75

PAGE 2.

Figure 88 Electronics Package, 'X' Axis
Response to Input of Figure 85

SENSOR - EPS-3T ELECTRON/PROTON SPECT. TEST CAL=31.6 TIME SLICE (H0-MIN-SEC) 15 51 .0000 TO 15 51 4.0000
 LOW-PASS FILTER USED 1000.0 STANDARD DEVIATION.. .6831 DATE PROCESSED..... 25FEB77
 FORM. STD. ERROR.... .22126 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1064
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X .001000



g rms = .68

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Figure 89 Electronics Package, 'T' Axis Response to Input of Figure 85

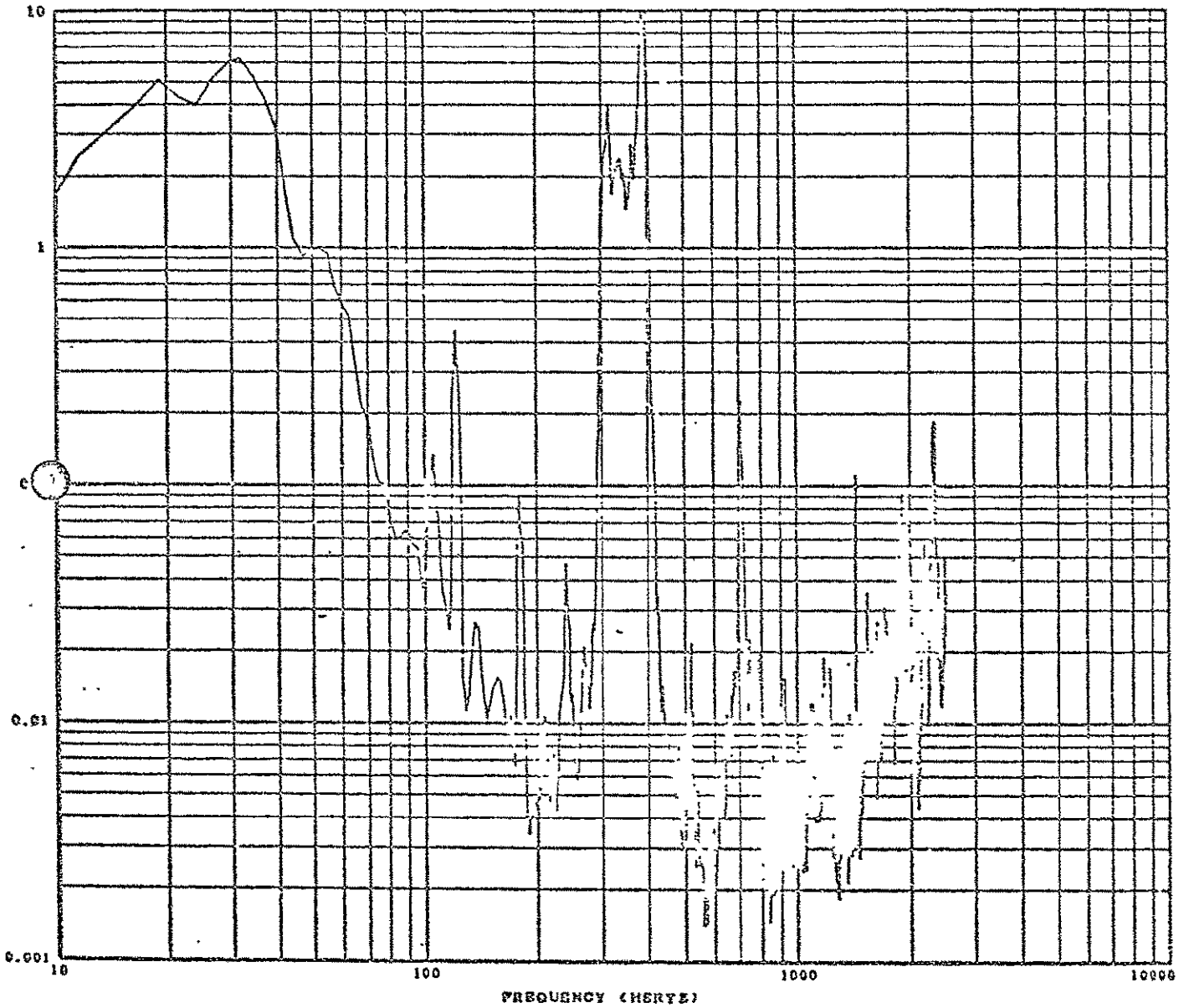
SENSOR - CONTRL ELECTRON/PROTON SPECT. TEST CAL=100. TIME SLICE (HR-MIN-SEC) 15 52 19 0000 TO 15 52 23 0000
LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 36.5010 DATE PROCESSED..... 25-FEB-77
NORM. STD. ERROR.... .22126 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
FILTER BANDWIDTHS... 5.1664
FILTER START POINTS. .0000



g rms = 36.50 PAGE 9.

Figure 90 'R' Axis Input, Transonic/MACH 1 Simulation (300 - 400 Hz)

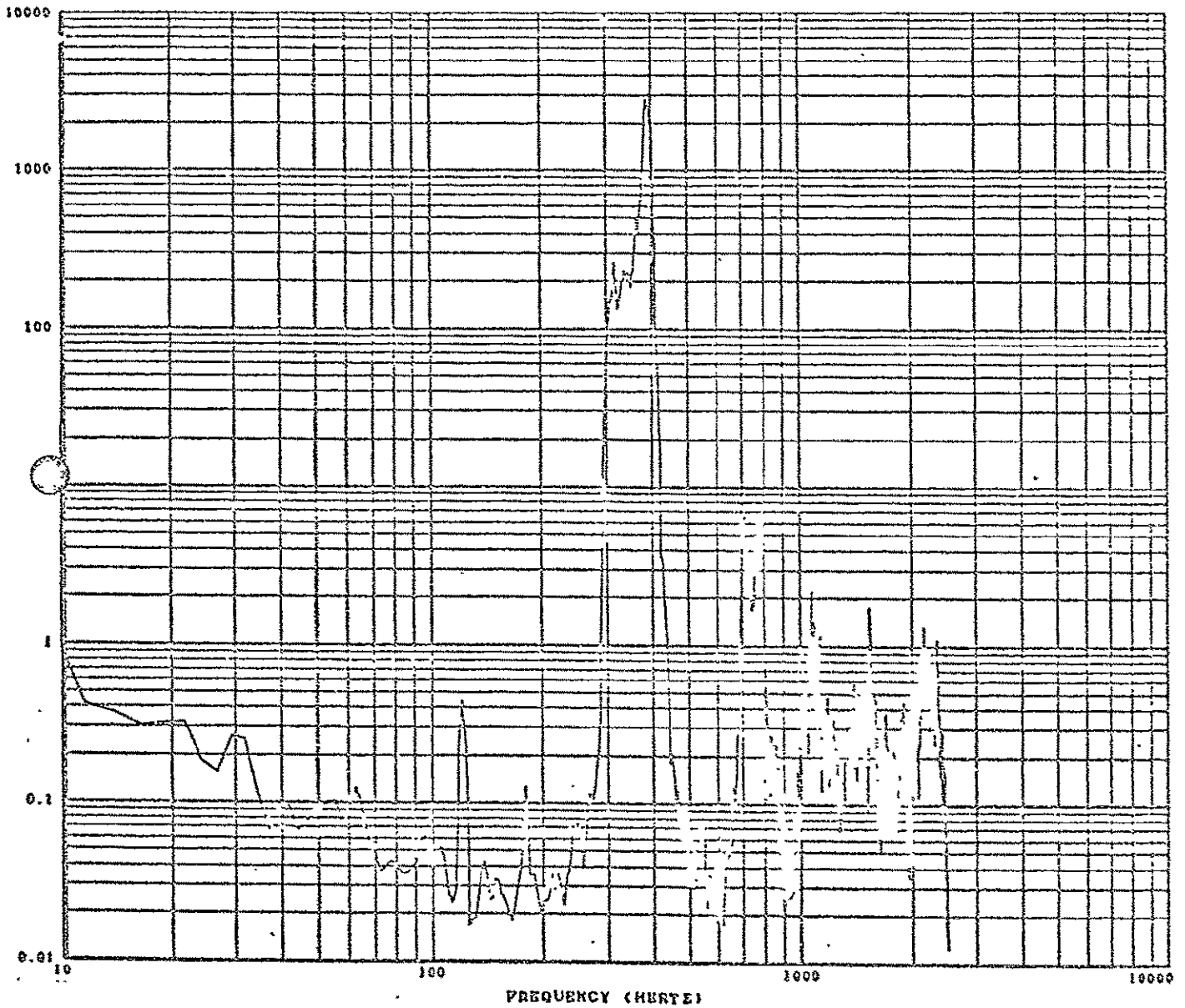
SENSOR - EPS-1R ELECTRON/PROTON SPECT. TEST CAL.=100 TIME SLICE (HR-MIN-SEC) 15 52 19 0000 TO 15 52 23.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 2.5157 DATE PROCESSED 25FEB77
 NORM. STD. ERROR.22126 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1064
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED, TRUE VALUE = VALUE SHOWN X .010000



g rms = 2.52 PAGE 1.

Figure 91 Electronics Package, 'R' Axis
Response to Input of Figure 90

SENSOR * EPS-4R ELECTRON/PRYTON SPECT. TEST CAL=1000 TIME SLICE (HR-MIN-SEC) 15 52 19 0000 TO 15 52 23.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION... 272.7499 DATE PROCESSED..... 25-EB77
 NORM. STD. ERROR.... .22126 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1064
 FILTER START POINTS. .0000

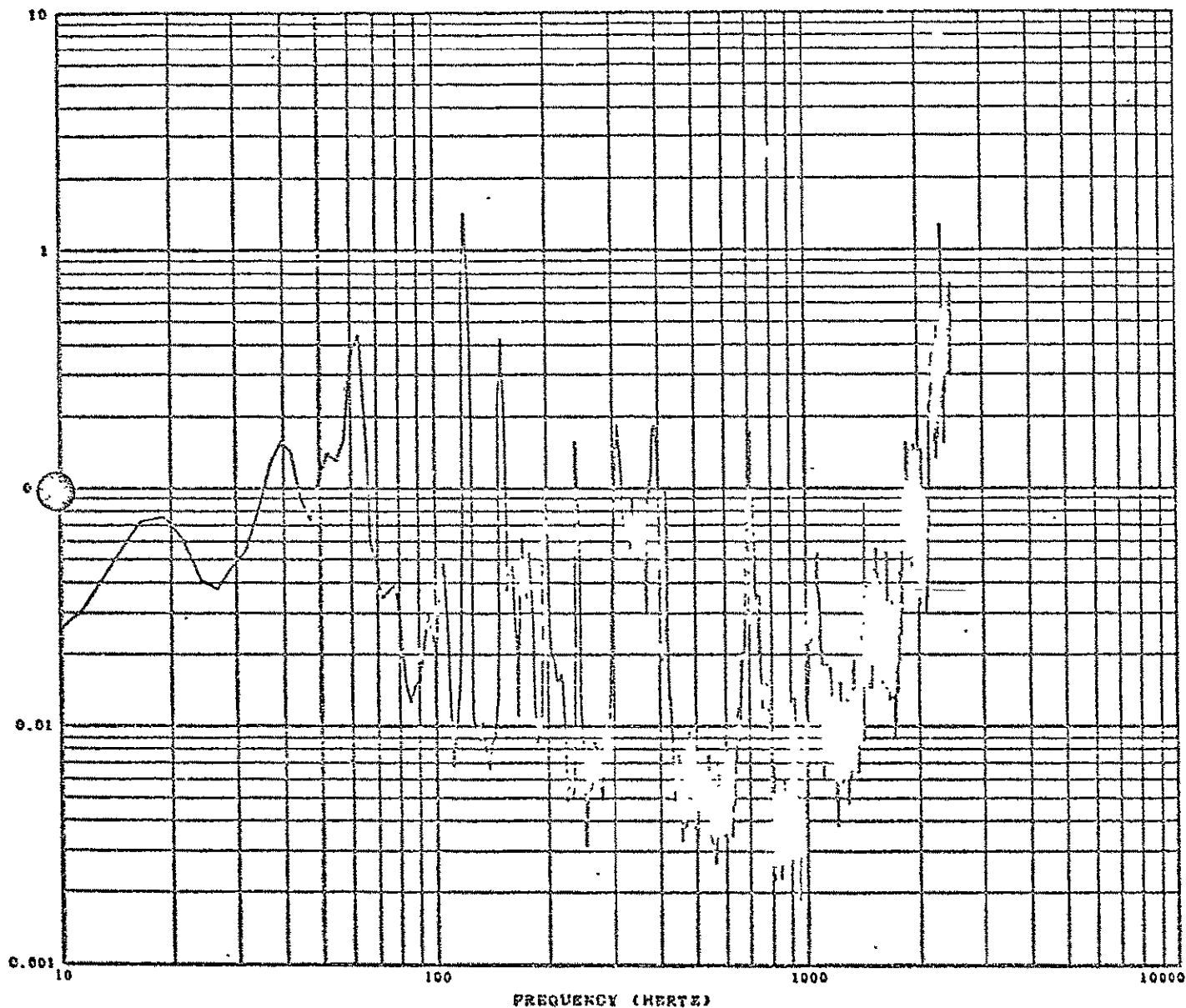


g rms = 272.75

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Figure 92 Baseplate, 'R' Axis Response to Input of Figure 90

SENSOR - EPS-2R ELECTRON/PHOTON SPECT. TEST CAL=31.6 TIME SLICE (HR-MIN-SEC) 15 52 19.0000 TO 15 52 23.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. .0059 DATE PROCESSED..... 25 FEB 77
 ROOT. STD. ERROR.... .22126 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTH... 5.1064
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. THIS VALUE = VALUE SHOWN X .001000

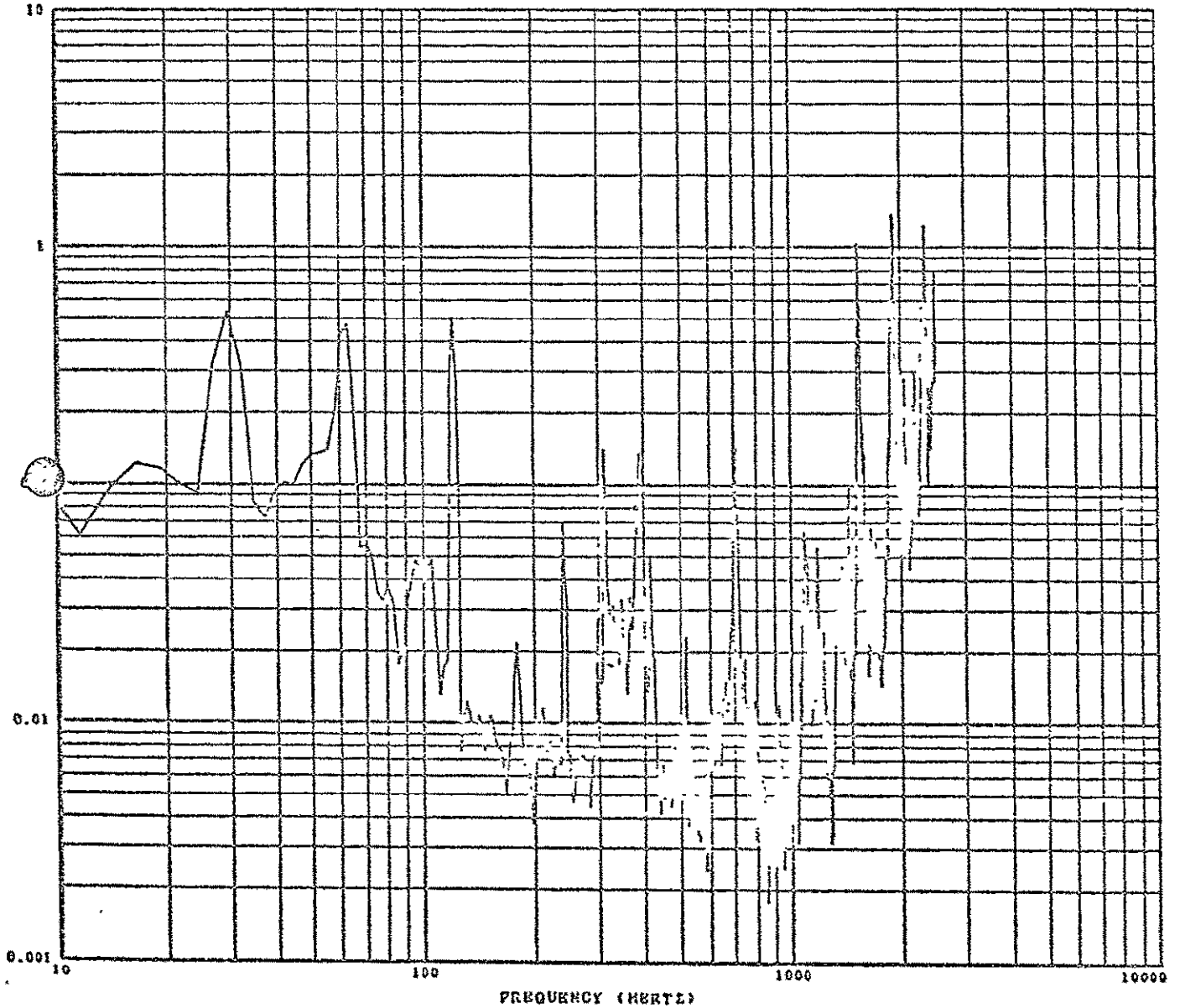


$g_{rms} = .91$

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Figure 93 Electronics Package, 'X' Axis Response to Input of Figure 90

SENSOR = EPS-3T ELECTRON/PROTON SPECT. TEST CAL=31.6 TIME SLICE (HR-MIN-SEC) 15 52 19.0000 TO 15 52 23.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. .9042 DATE PROCESSED..... 25FEB77
 NORM. STD. ERROR... .22126 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1064
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X .001000

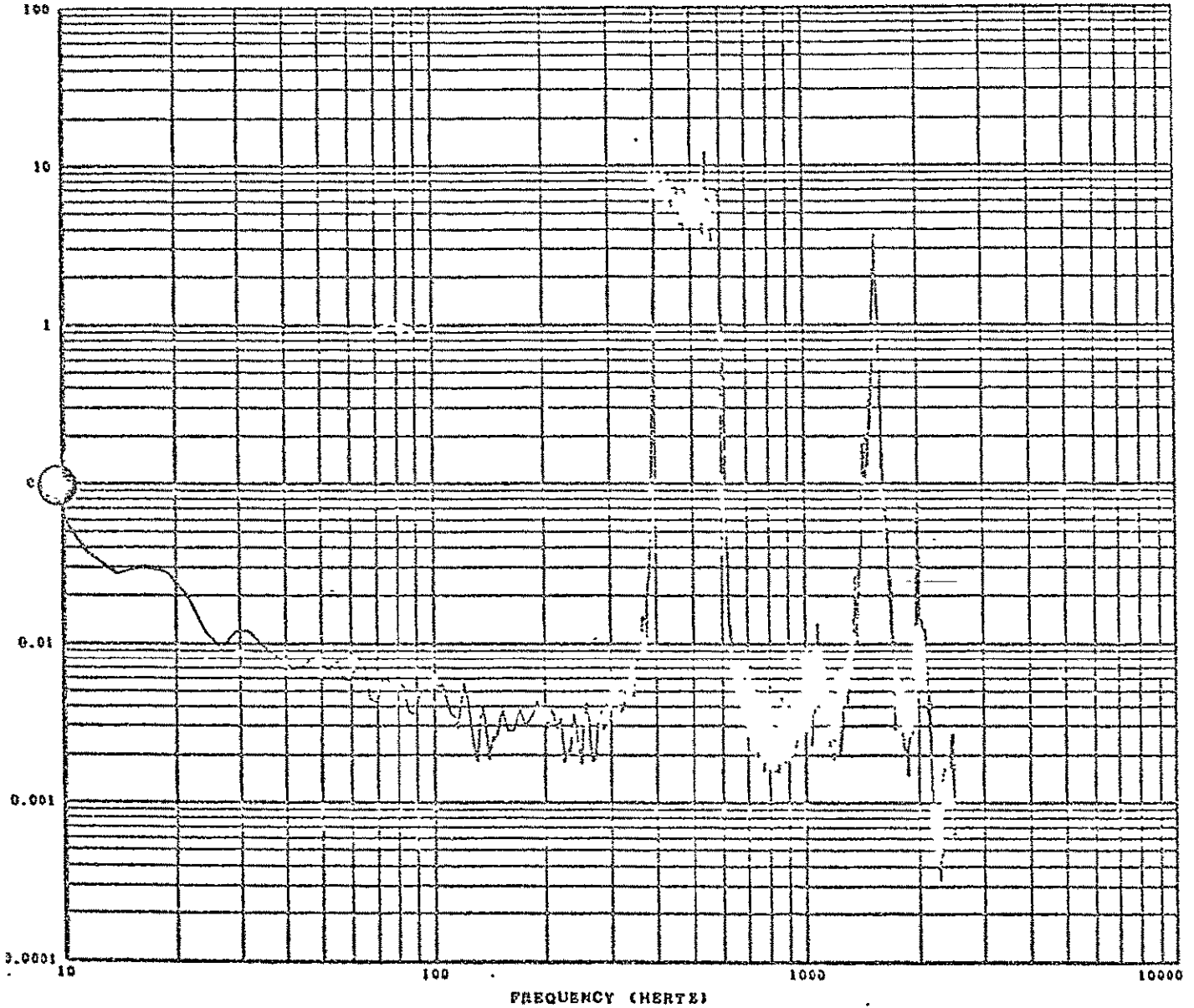


g RMS = .90

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Figure 94 Electronics Package, 'T' Axis
 Response to Input of Figure 90

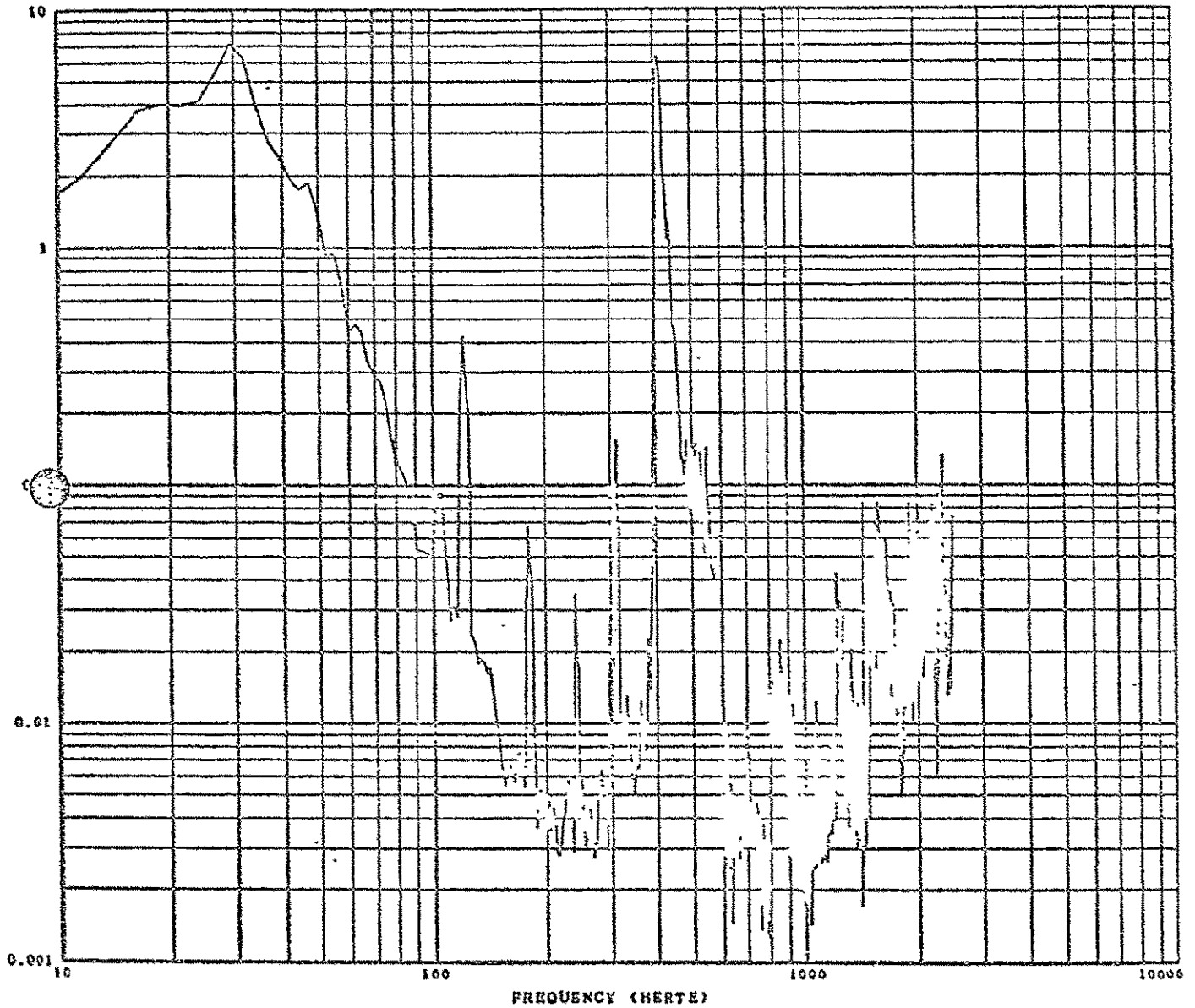
SENSOR - CONTRL ELECTRON/PROTON SPECT. TEST CAL=100. TIME SLICE (HR-MIN-SEC) 16 6 50.0000 TO 16 6 54.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION. 37.7699 DATE PROCESSED..... 25FEB77
 NOM. STD. ERROR.... .22124 VIBRATION TEST RUN BOX INPUT TAPE NUMBER...
 FILTER BANDWIDTH... 5.1077
 FILTER START POINTS. .0000



g rms = 37.77 PAGES 6.

Figure 95 'R' Axis Input, Max. g
Simulation (400 - 600 Hz)

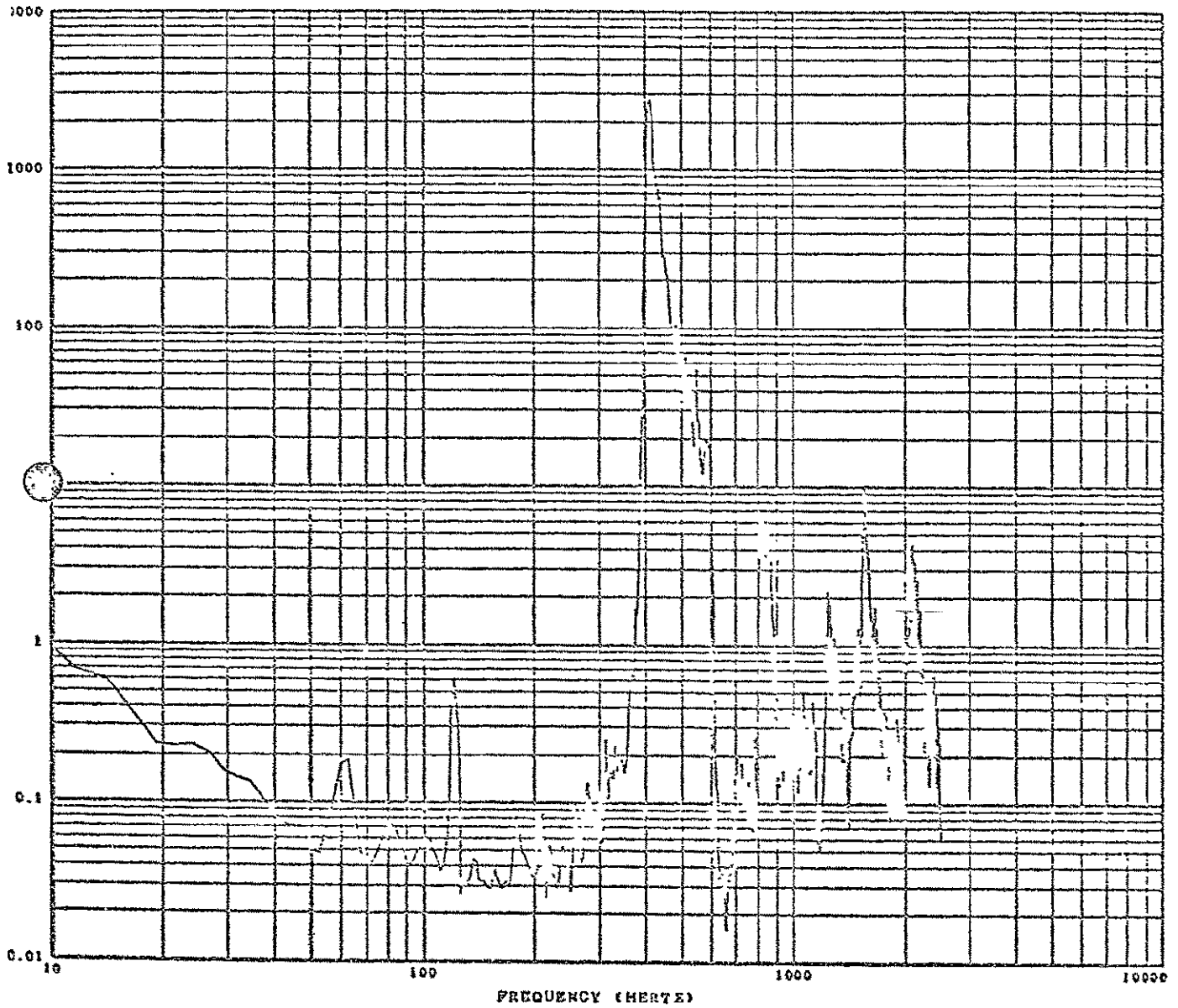
SENSOR - EPS-IR ELECTRON/PROTON SPECT. TEST CAL=100. TIME SLICE (IR-MIN-SEC) 16 @ 50.0000 TO 18 @ 54.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION 2.0286 DATE PROCESSED..... 25-FEB77
 NORM. STD. ERROR.... .22124 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1077
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X .010000



$g_{RMS} = 2.03$

Figure 96 Electronics Package, 'R' Axis
Response to Input of Figure 95

SENSOR - EPS-AR ELECTRON/PROTON SPECT. TEST CAL=1000. TIME SLICE (HR-MIN-SEC) 16 0 50.0000 TO 16 6 54.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION... 273.5802 DATE PROCESSED..... 25-FEB-77
 NORM. STD. ERROR.... .22124 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1077
 FILTER START POINTS. .0000

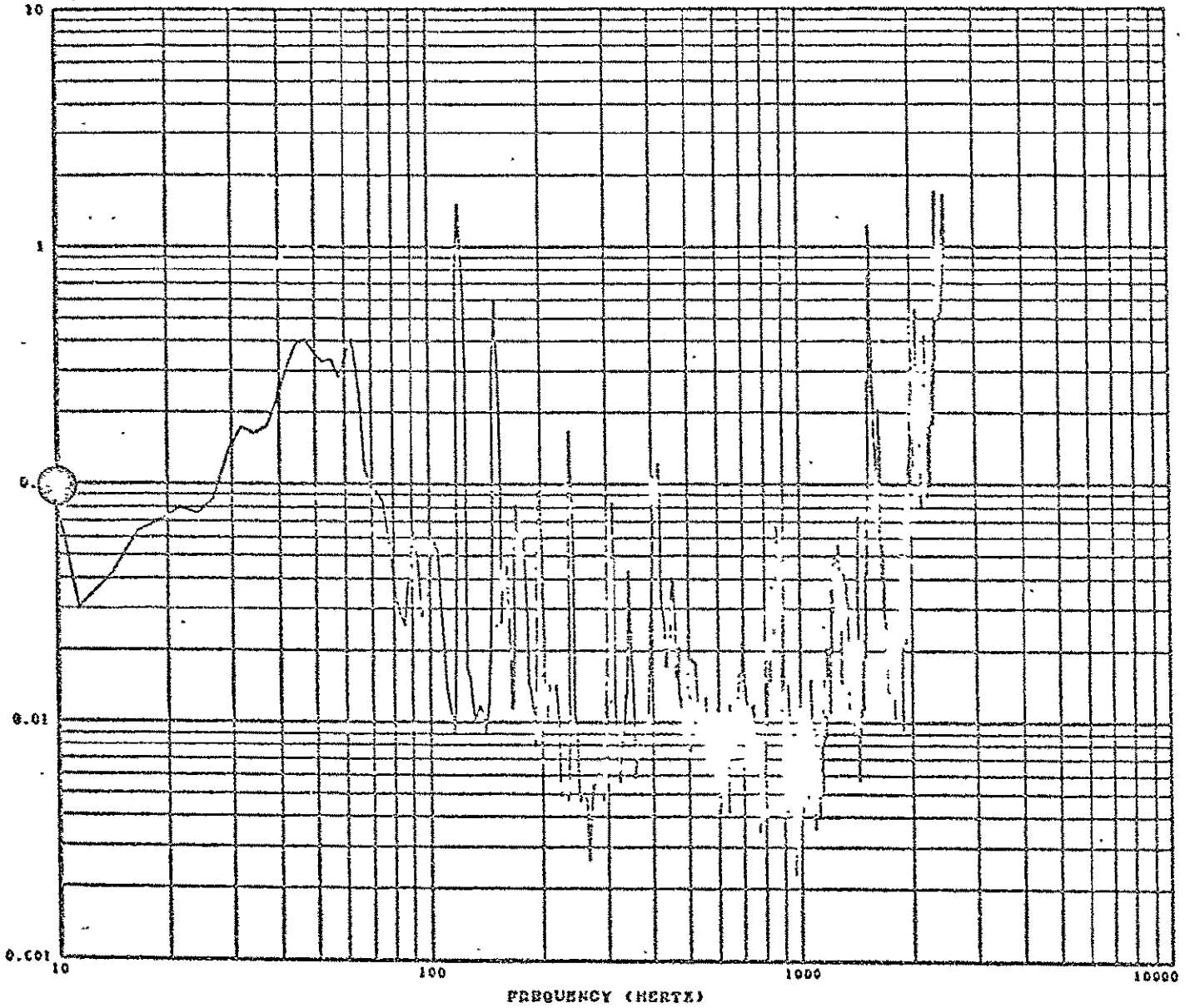


g rms = 273.58

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Figure 97 Baseplate, 'R' Axis Response to Input of Figure 95

SENSOR - EPS-2R ELECTRON/PROTON SPECT. TEST CAL=31 6 TIME SLICE (HR-MIN-SEC) 15 6 50.0000 TO 16 0 54 0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 1.0837 DATE PROCESSED... 25FEB77
 NORM. STD. ERROR... .22124 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTH... 5.1077
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE * VALUE SHOWN * X .001000

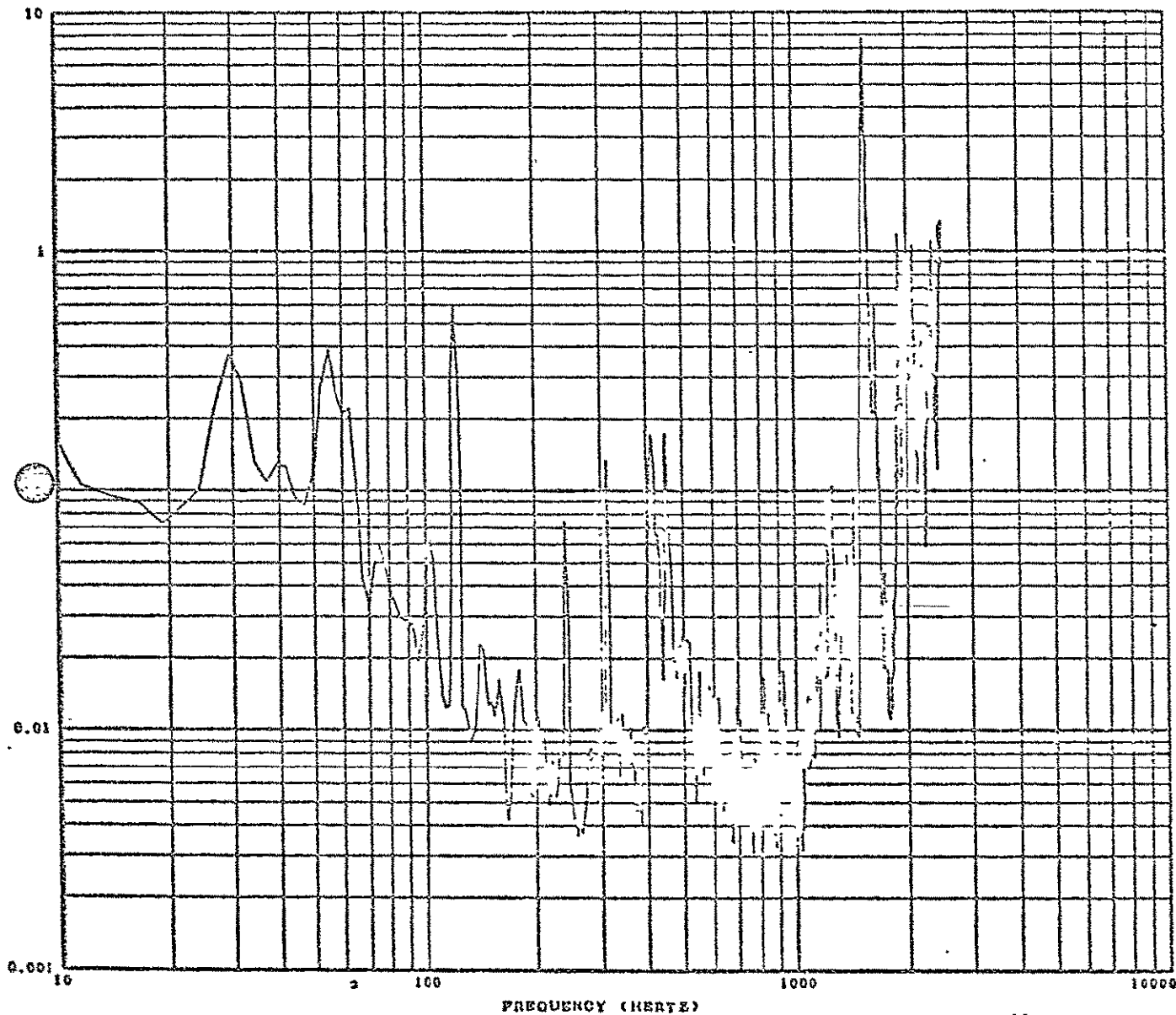


g rms = 1.08

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Figure 98 Electronics Package, 'X' Axis
Response to Input of Figure 95

SENSOR * EPS-3T ELECTRON/PROTON SPECT. TEST CAL=31.6 TIME SLICE (MIN-MIN-SEC) 16 6 50.0000 TO 16 6 54.0000
LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 1.1623 DATE PROCESSED..... 25FEB77
NORM. STD. ERROR.... .22124 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
FILTER BANDWIDTHS... 5 1017
FILTER START POINTS. .0000
VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X .001000

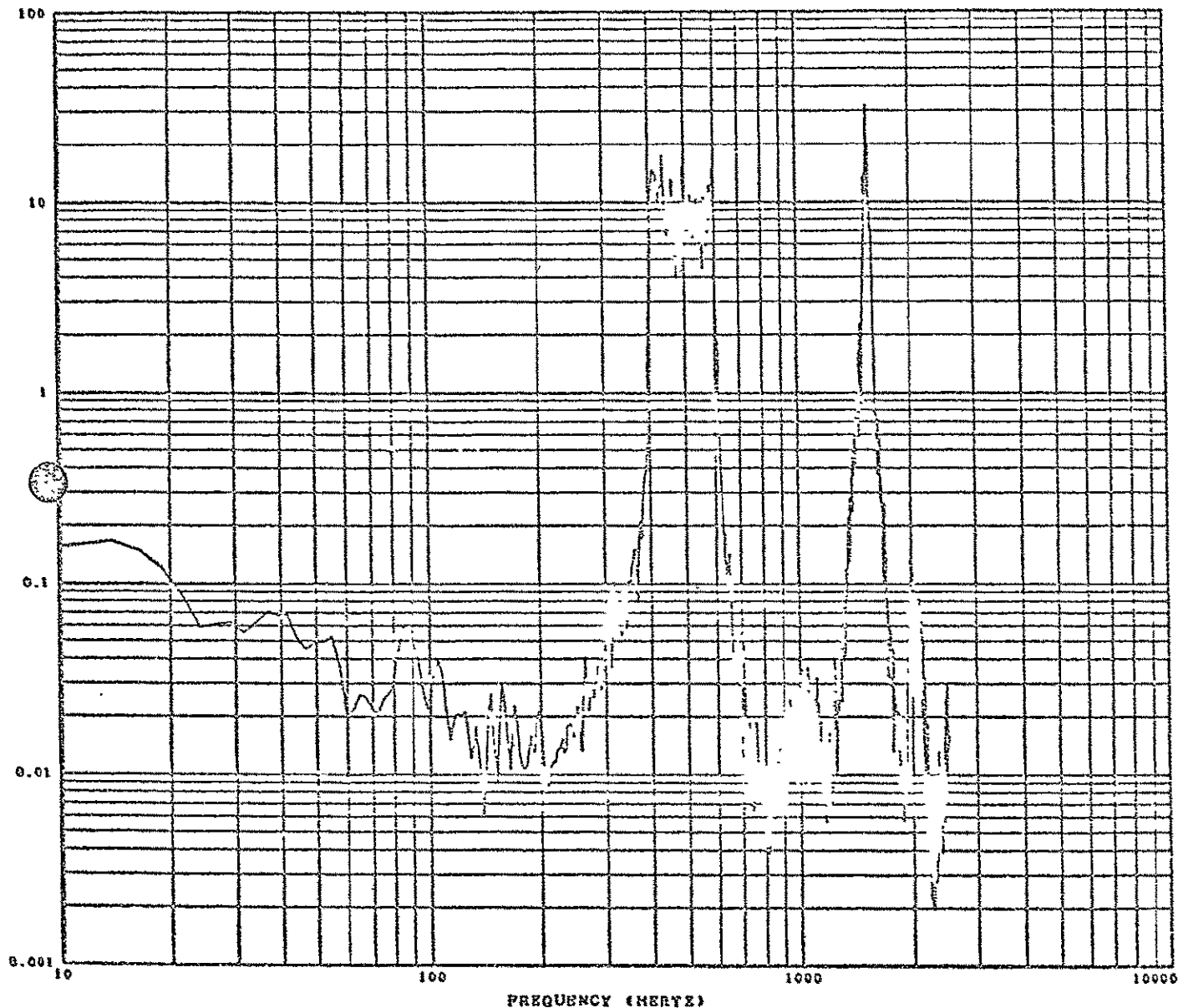


g rms = 1.16

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Figure 99 Electronics Package, 'T' Axis
Response to Input of Figure 95

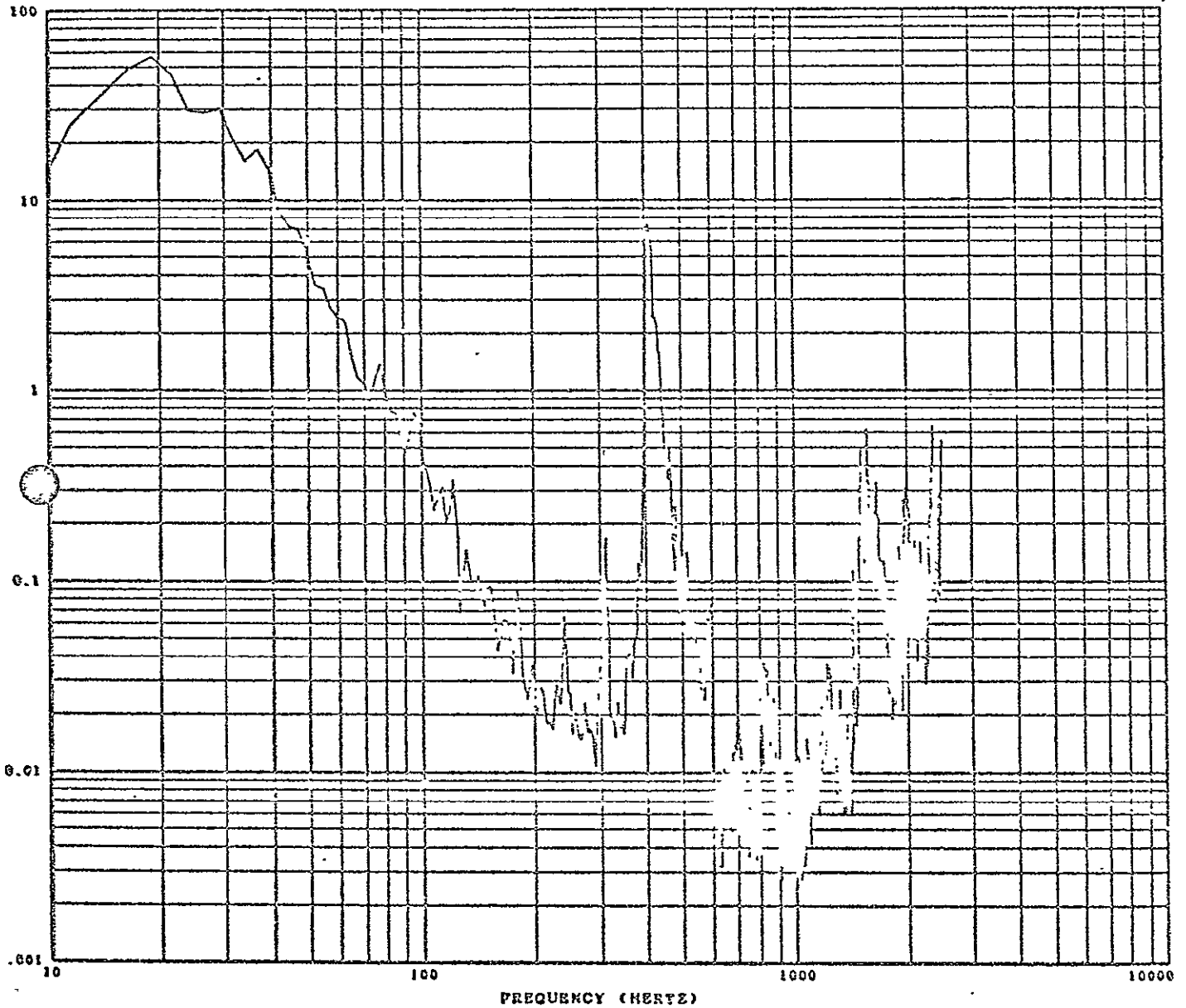
SENSOR - CONTRL ELECTRON/PROTON SPECT. TEST CAL=100. TIME SLICE (HR-MIN-SEC) 16 13 41.0000 TO 16 13 45.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION... 57.4523 DATE PROCESSED..... 25FEB77
 NORM. STD. ERROR22124 VIBRATION TEST RUN BOX INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1077
 FILTER START POINTS. .0000



g rms = 57.45 PAGE 6.

Figure 100 'R' Axis Input, Transonic/MACH 1 Simulation (400 - 600 Hz)

SENSOR - EPS-1R ELECTRON/PROTON SPECT. TEST CAL=100. TIME SLICE (HR-MIN-SEC) 16 13 41 0000 TO 16 13 45.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 4.1273 DATE PROCESSED. 25FEB77
 NORM. STD. ERROR.... .22124 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1077
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X .010000

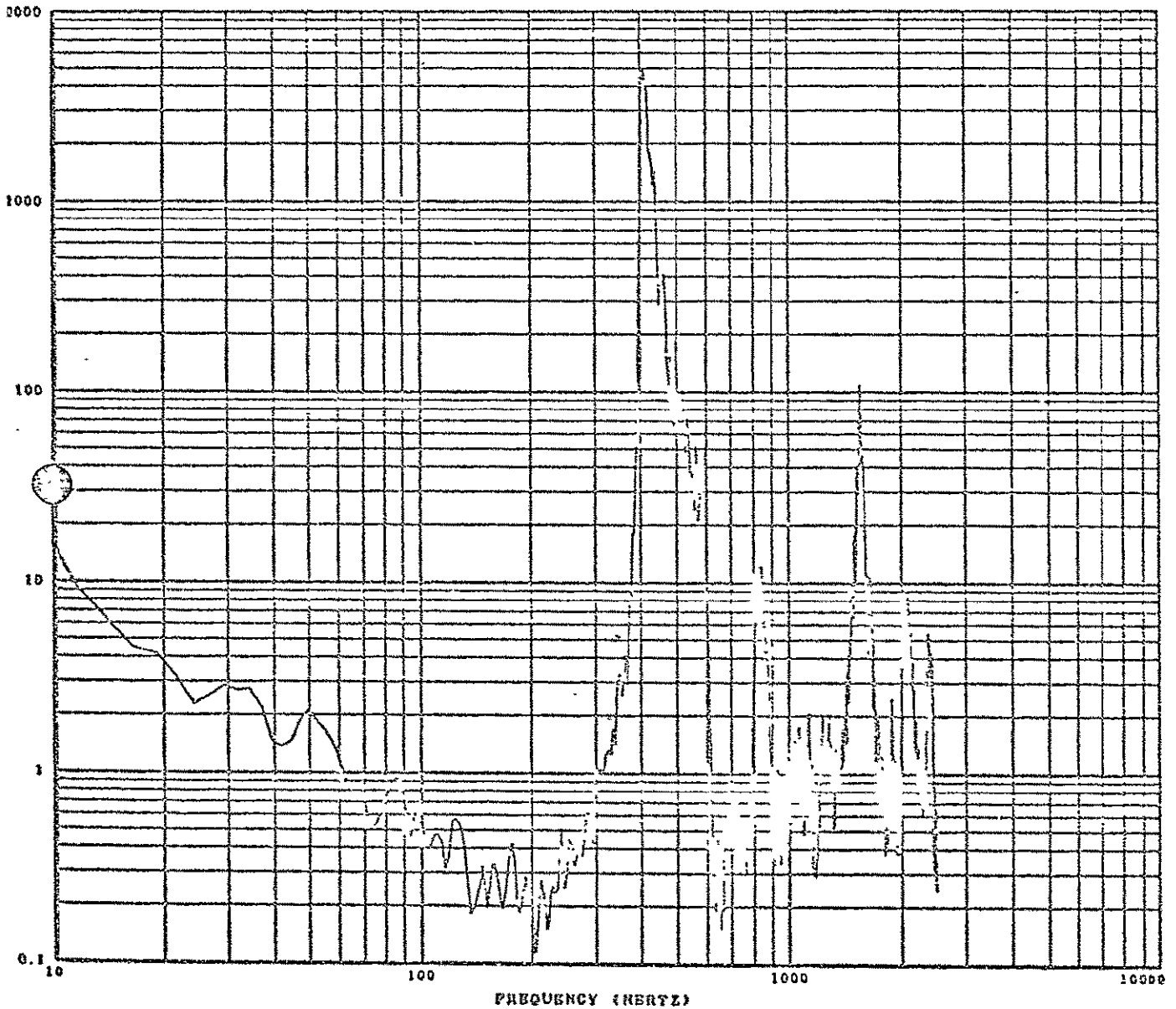


g rms = 4.13

PAGE 1.

Figure 101 Electronics Package, 'R' Axis Response to Input of Figure 100

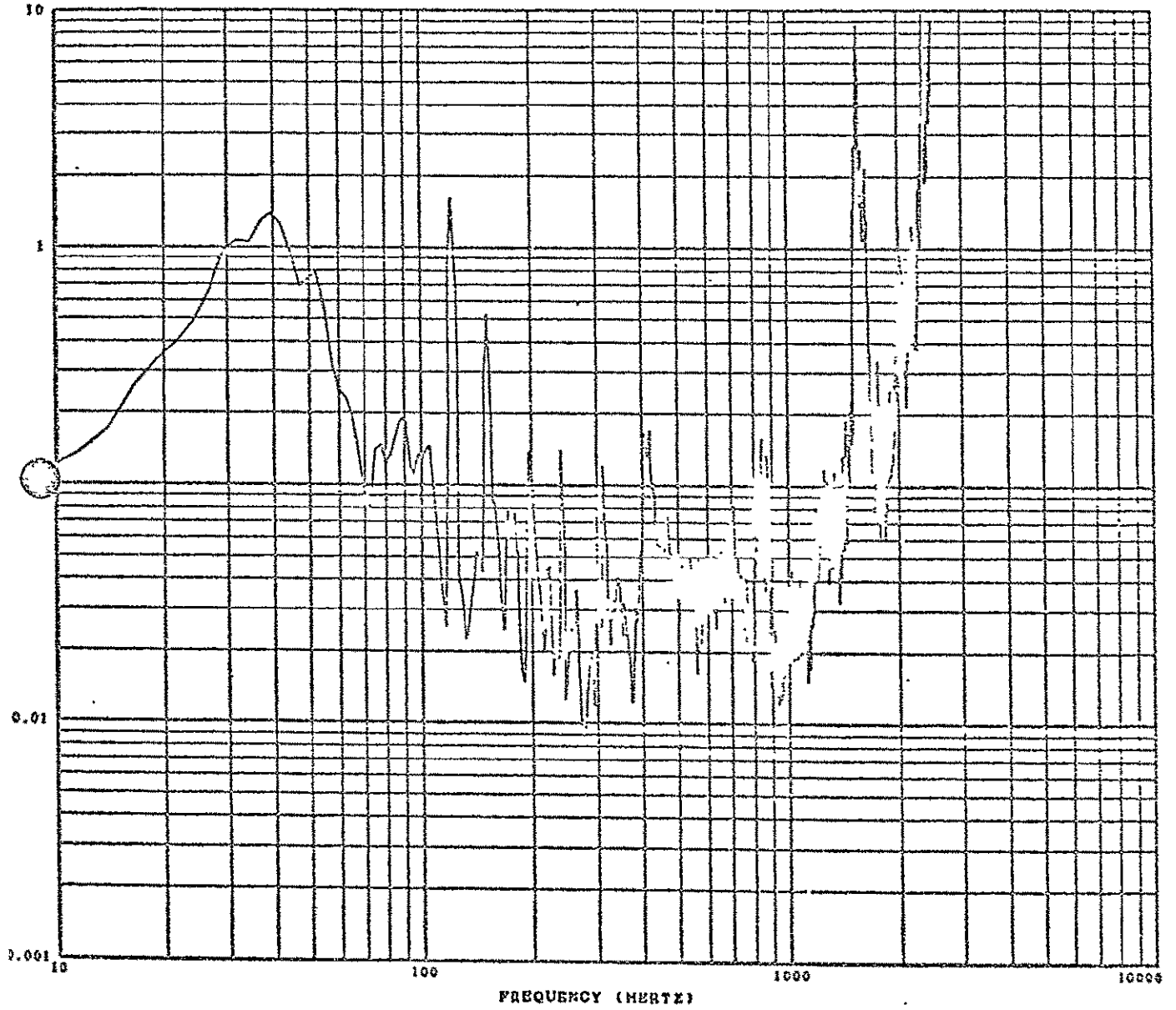
SENSOR - EPS-4R ELECTRON/PROTON SPECT. TEST CAL=1000. TIME SLICE (G-MIN-SEC) 16 13 41.0000 TO 16 13 45.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 377.5562 DATE PROCESSED..... 25FEB77
 NORM. LTD. ERROR.... .22124 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTH... 5.1077
 FILTER START POINTS. .0000



g rms = 377.56 PAGE 1.

Figure 102 Baseplate, 'R' Axis Response to Input of Figure 100

SENSOR - EPS-2R ELECTRON/PROTON SPECT. TEST CAL=31.6 TIME SLICE (HR-MIN-SEC) 16 13 41.0000 TO 16 13 45 0000
 LOW-PASS FILTER ENED 3000.0 STANDARD DEVIATION.. 2.4224 DATE PROCESSED..... 25FEB77
 NORM. STD. ERROR... .22124 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1077
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE * VALUE KNOWN * .001000

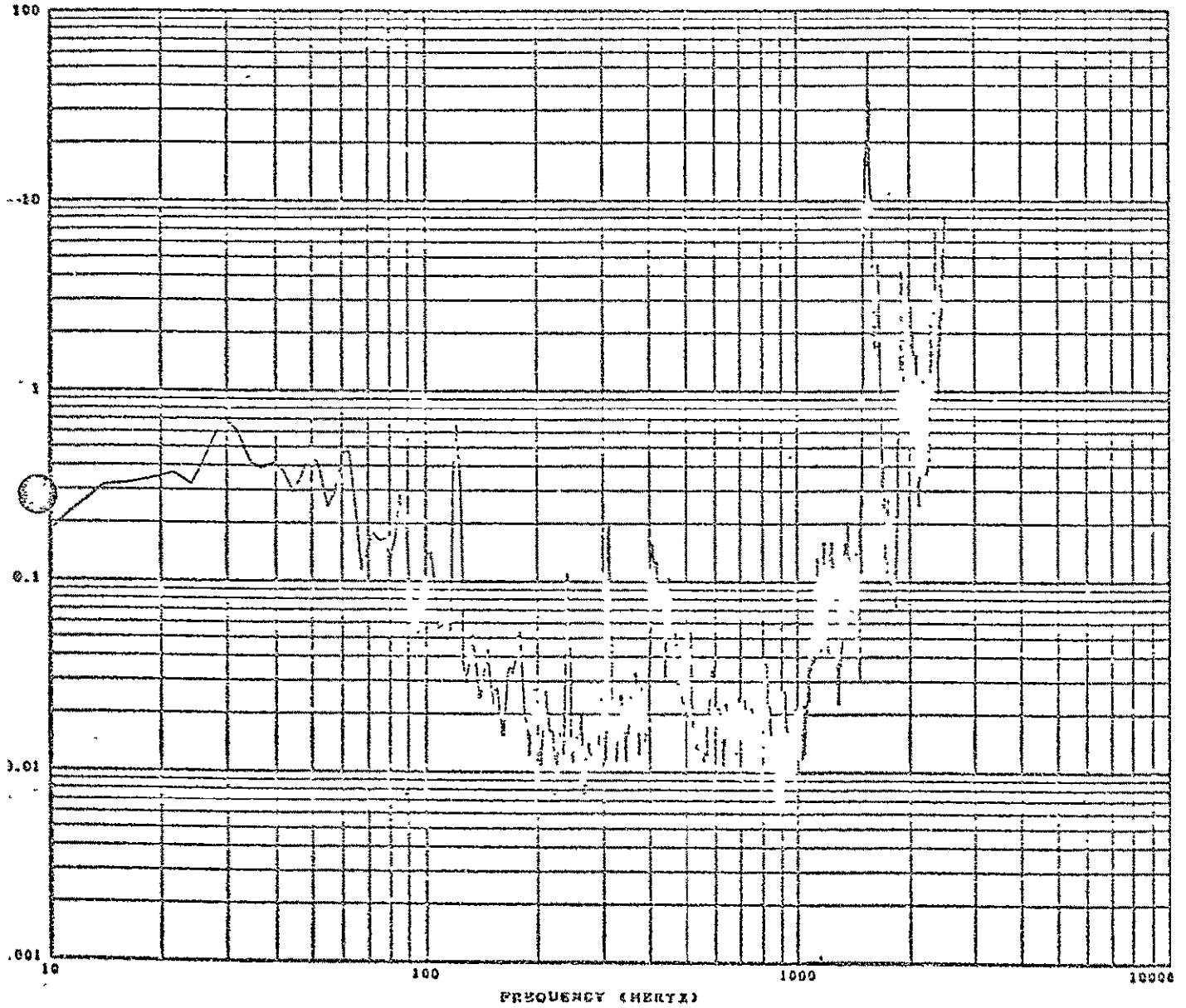


$g_{rms} = 2.42$

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Figure 103 Electronics Package, 'X' Axis
 Response to Input of Figure 100

SENSOR - EPS-3T ELECTRON/PROTON SPECT. TEST CAL=31.8 TIME SLICE (HR-MIN-SEC) 16 13 41.0000 TO 16 13 45.0000
 LOW-PASS FILTER USED 1000.0 STANDARD DEVIATION.. 2.7646 DATE PROCESSED..... 25FEB77
 NORM. STD. ERROR.... .22124 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1077
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X .001000

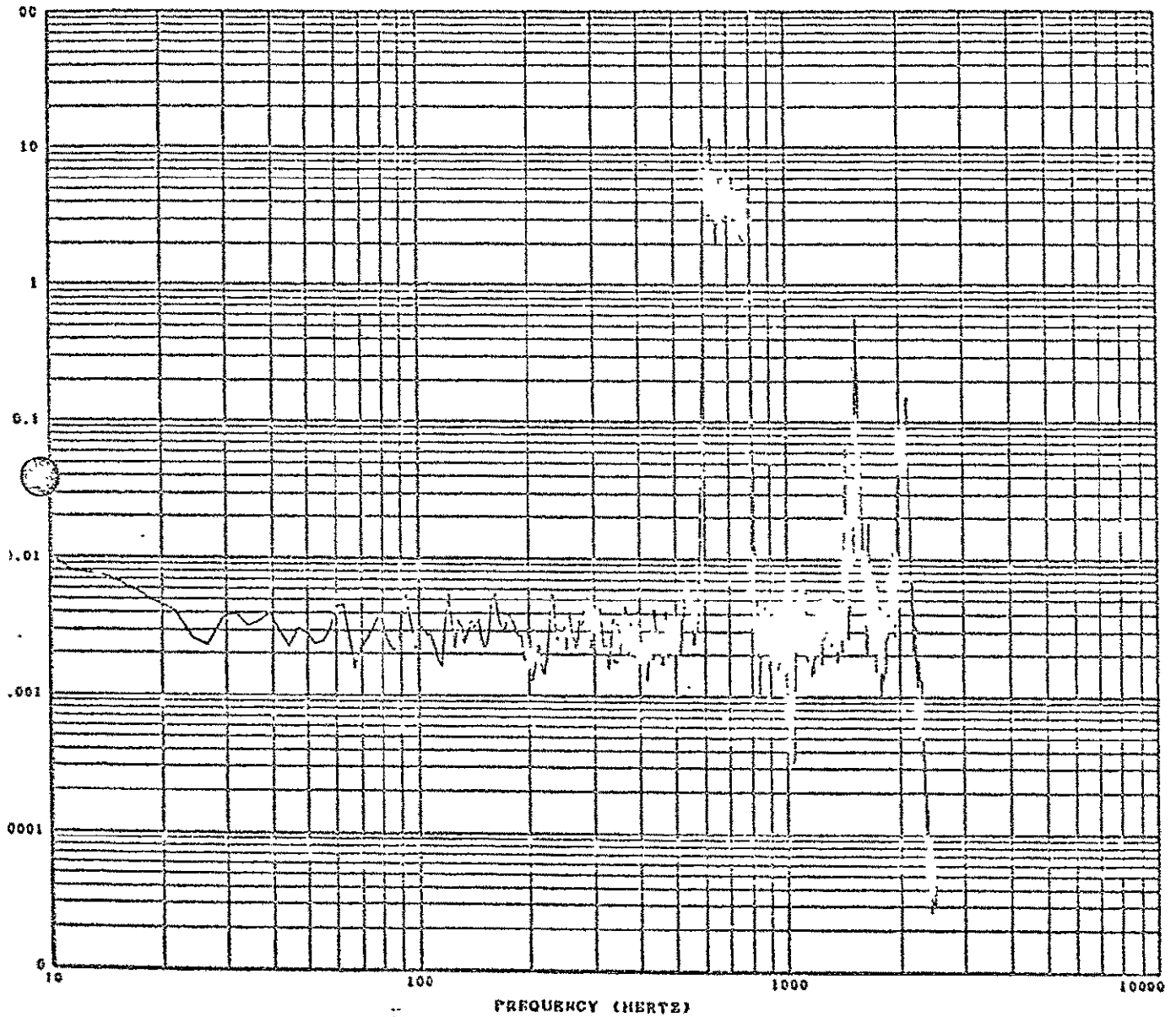


g rms = 2.76

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Figure 104 Electronics Package, 'T' Axis
Response to Input of Figure 100

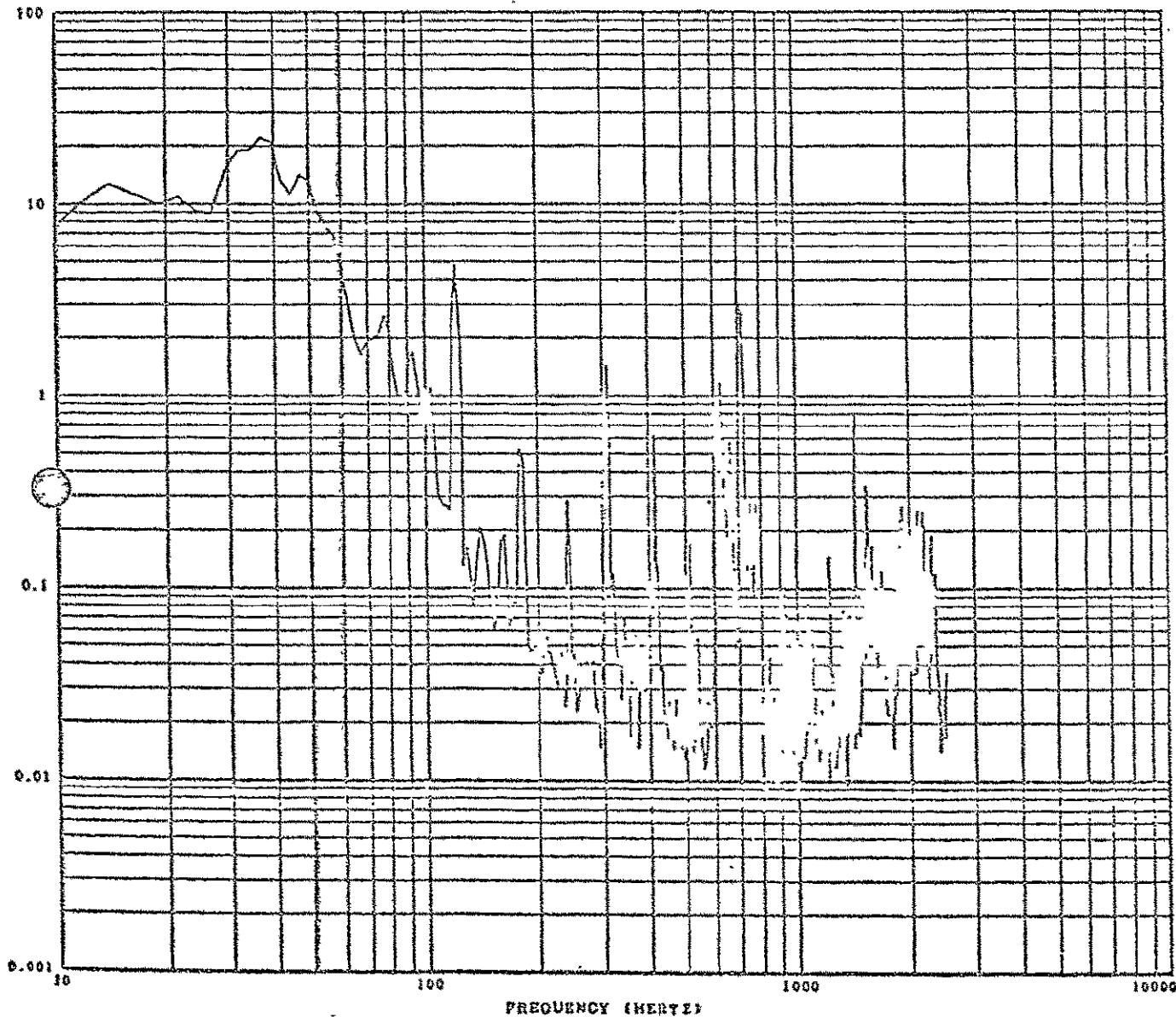
SENSOR - CONTROL ELECTRON/PROTON SPECT. TEST CAL. 100. TIME SLICE (HR-MIN-SEC) 16 32 10 0000 TO 16 32 14.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION... 30.0951 DATE PROCESSED..... 25FEB77
 NORM. STD. ERROR... .22120 VIBRATION TEST RUN 00X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1052
 FILTER START POINTS. .0000



g rms = 30.1

Figure 105 'R' Axis Input, Max. q simulation (600 - 800 Hz)

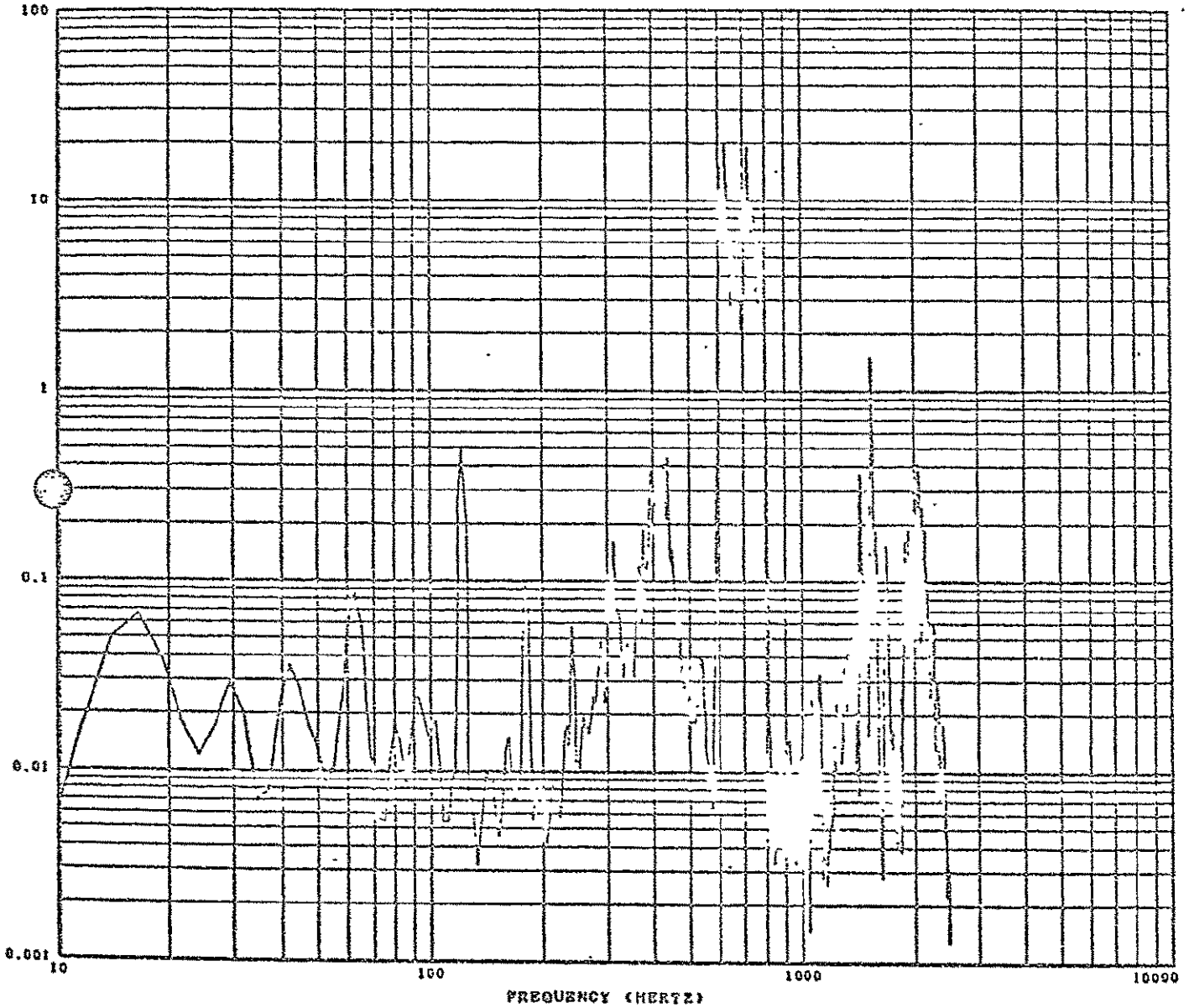
SENSOR - EPS-IR ELECTRON/PROTON SPECT. TEST CAL#100 TIME SLICE (HR-MIN-SEC) 16 32 10.0000 TO 16 32 14.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 1.0408 DATE PROCESSED 25FEB77
 NORM. STD. ERROR.... .22129 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTH... 6.1052
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN * .001000



g rms = 1.04 PAGE 0.

Figure 106 Electronics Package, 'R' Axis Response to Input of Figure 105

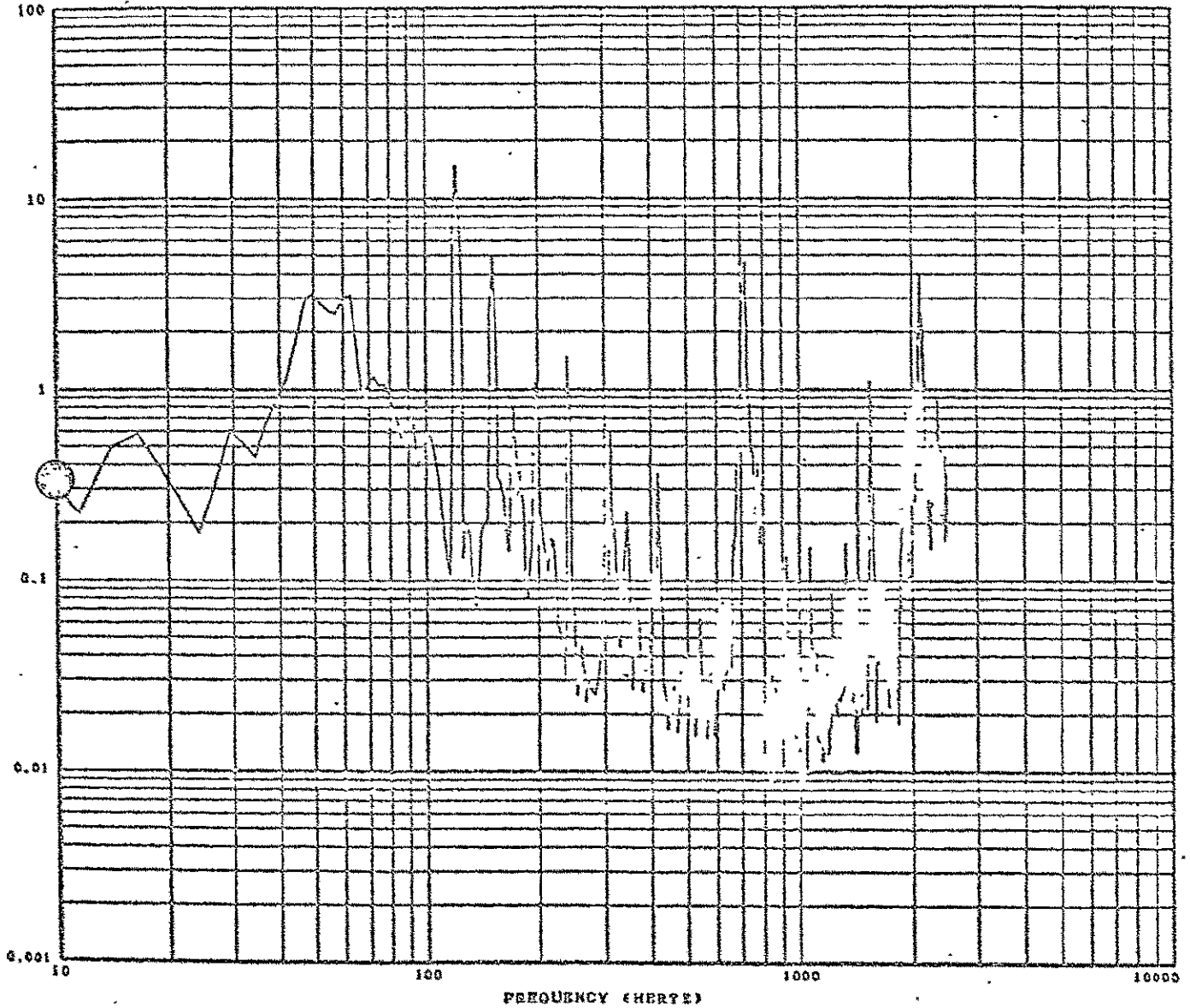
SENSOR - EPS-4R ELECTRON/PROTON SPECT. TEST CALF1000. TIME SLICE (HR-MIN-SEC) 16 32 10.0000 TO 16 32 14.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION... 39.4558 DATE PROCESSED..... 25FEB77
 NORM. STD. ERROR.... .22129 VIBRATION TEST RUN 00A INPUT TAPE NUMBER...
 FILTER BANDWIDTH... 5.1052
 FILTER START POINTS. .0000



g rms = 39.46 PAGE 6.

Figure 107 Baseplate, 'R' Axis Response to Input of Figure 105

SENSOR - EPS-2R ELECTRON/PROTON SPECT. TEST CAL=31.6 TIME SLICE (HR-MIN-SEC) 16 32 10.0000 TO 16 32 14 0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION... .3787 .. DATE PROCESSED..... 25-EB77
 NORM. STD. ERROR22129 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1652
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X .000100

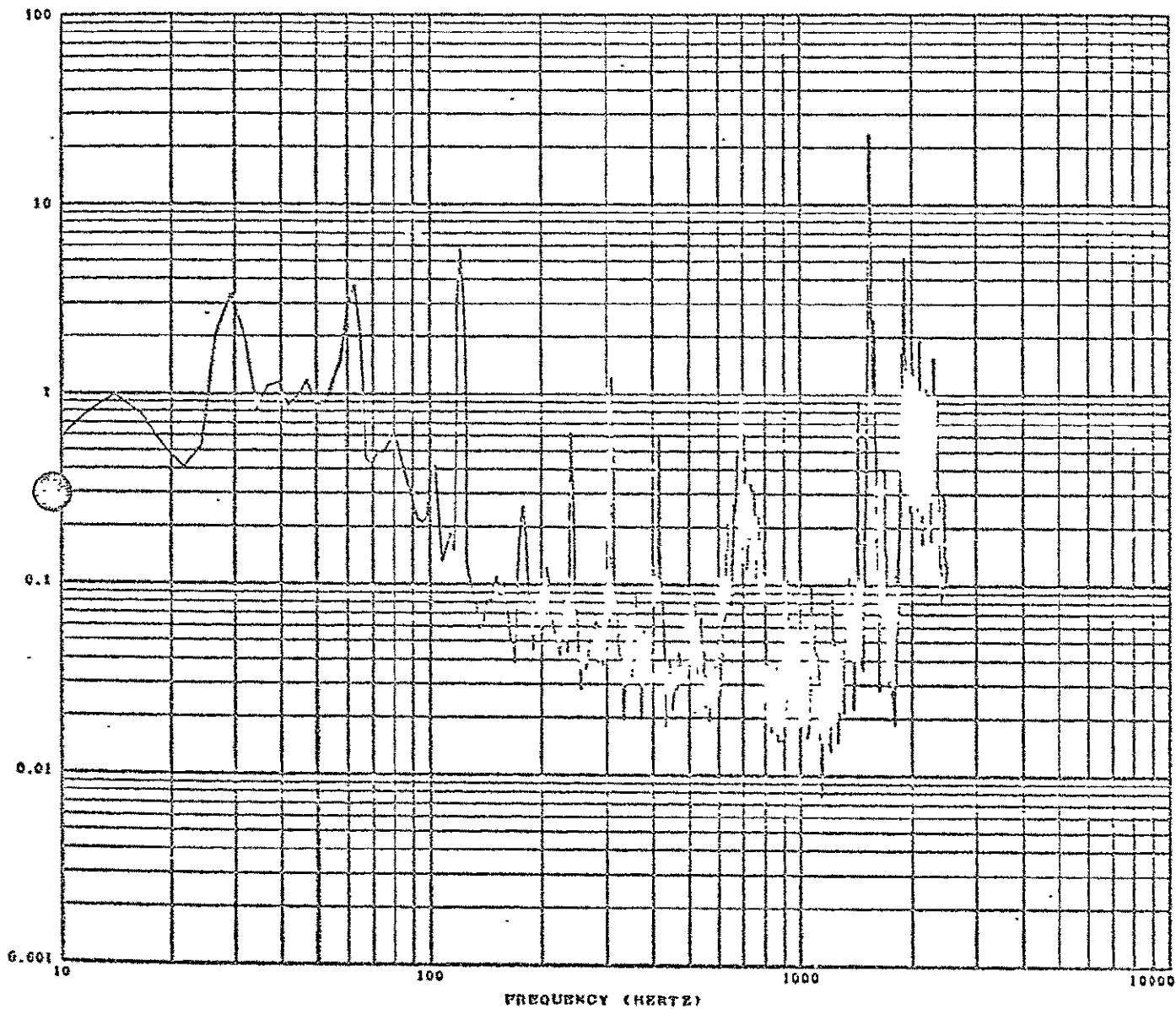


$g_{rms} = .38$

PAGE 2.

Figure 108 Electronics Package, 'X' Axis
Response to Input of Figure 105

SENSOR - EPS-3T ELECTRON/PROTON SPECT. TEST CAL=31.0 TIME SLICE (HR-MIN-SEC) 16 32 10.0000 TO 16 32 14.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. .4228 DATE PROCESSED..... 25FEB77
 NORM. STD. ERROR... .22129 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1052
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN' X .000100

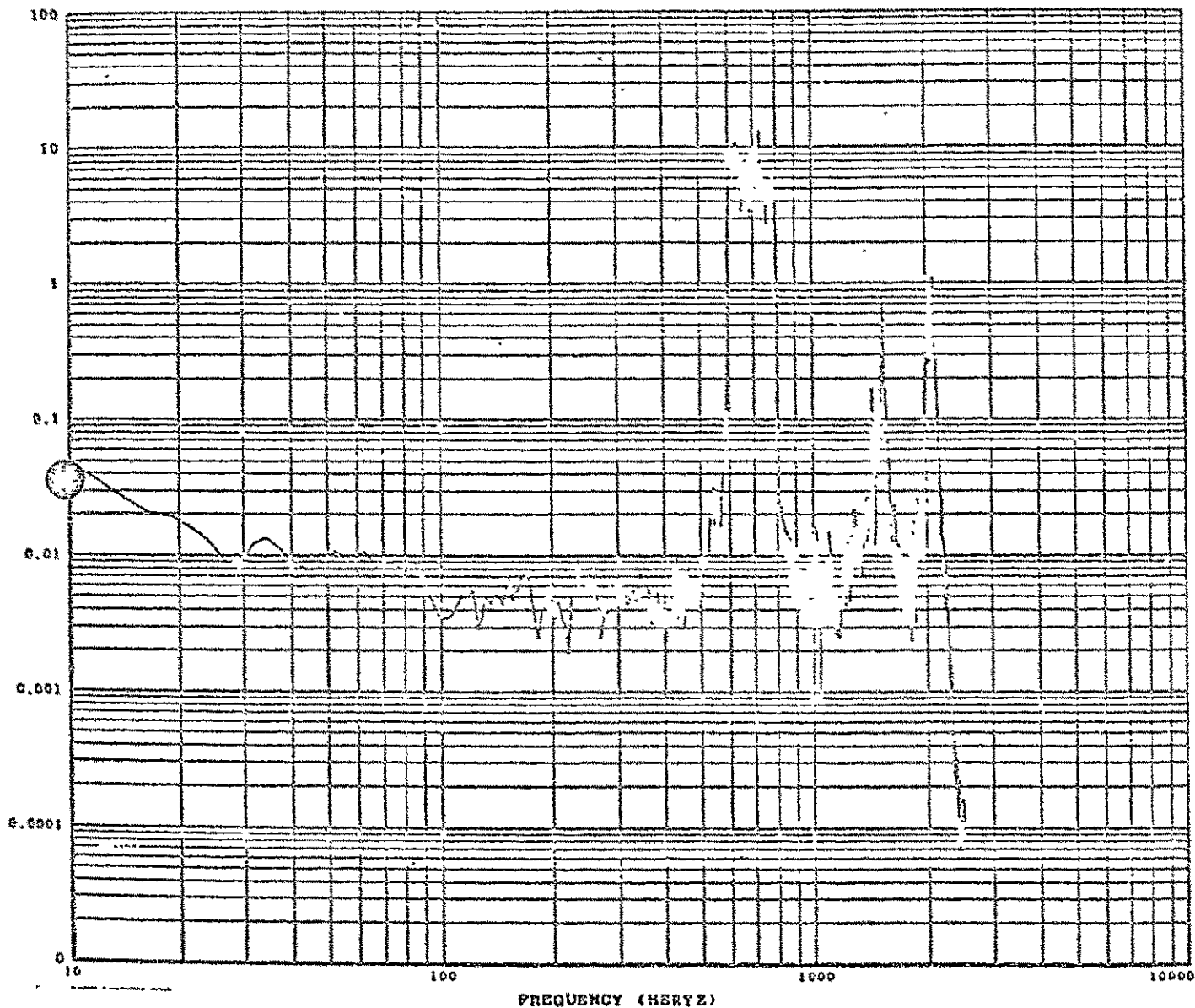


g RMS = .42

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Figure 109 Electronics Package, 'T' Axis
 Response to Input of Figure 105

SENSOR - CONTROL ELECTRON/PROTON SPECT. TEST CAL=100. TIME SLICE (HR-MIN-SEC) 16 32 57.0000 TO 16 32 56.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. JK 3723 DATE PROCESSED..... 25FEB77
 NORM. STD ERROR.... .22124 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1033
 FILTER START POINTS. .0000

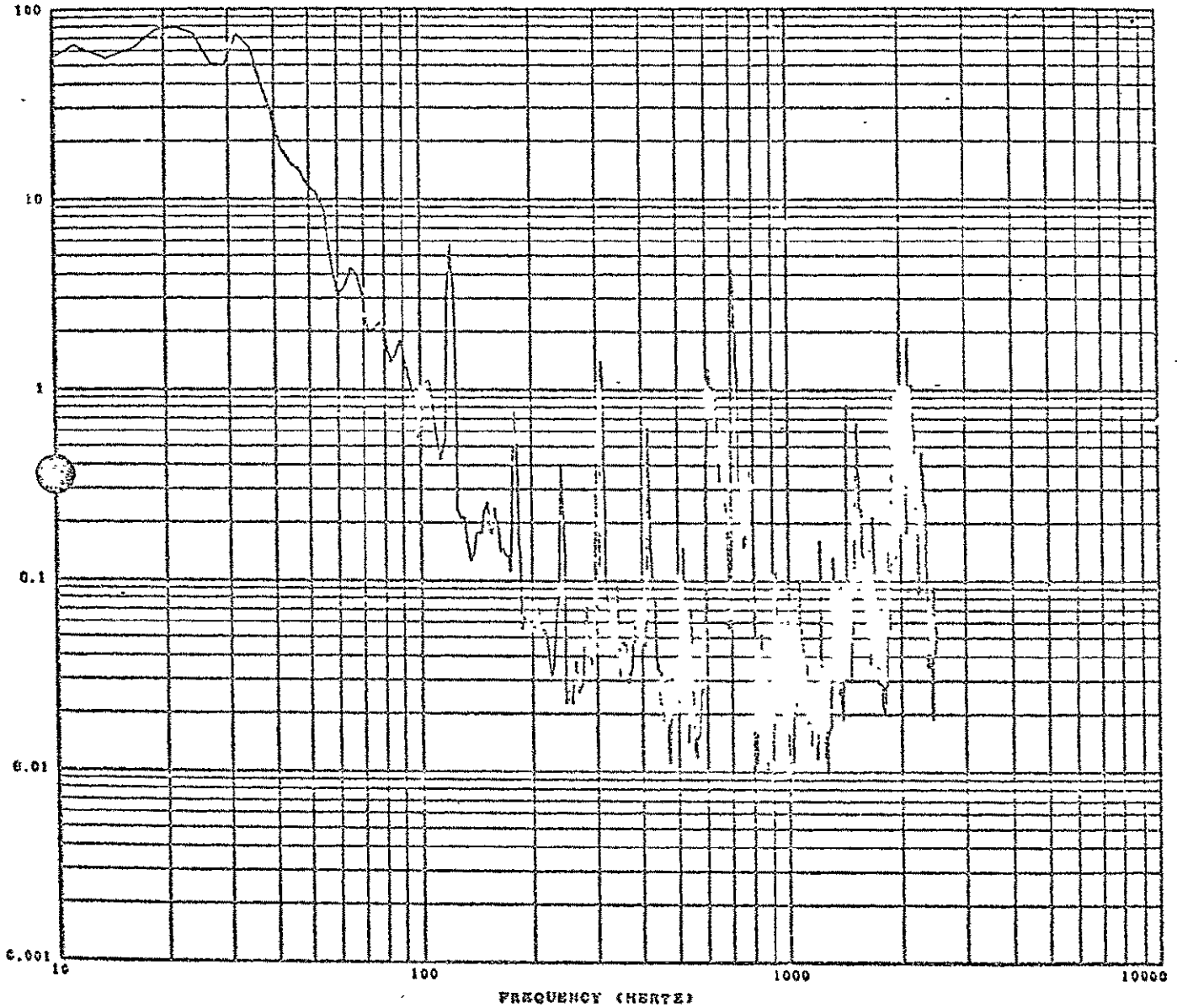


g rms = 38.37

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Figure 110 'F' Axis Input, Transonic/MACH 1
 Simulation (600 - 800 Hz)

SENSOR = EPS-IR ELECTRON/PROTON SPECT. TEST CAL=100. TIME SLICE (HR-MIN-SEC) 16 32 52 0000 TO 16 32 56.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 1.7750 DATE PROCESSED 25-FEB77
 NORM. STD. ERROR.... .22174 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1077
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE * VALUE SHOWN * X .001000

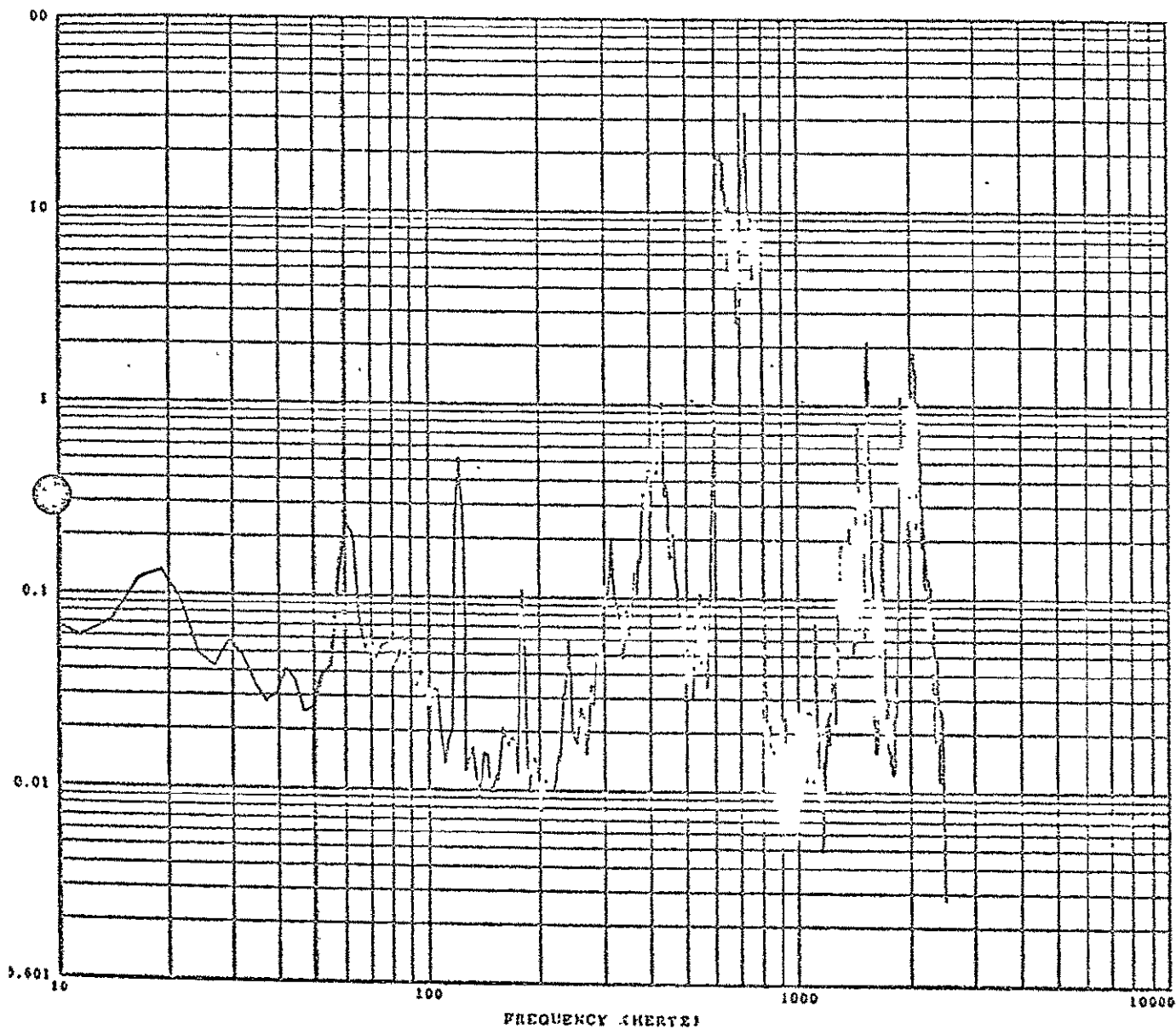


$g_{rms} = 1.78$

PAGE 1.

Figure 111 Electronics Package, 'R' Axis Response to Input of Figure 110

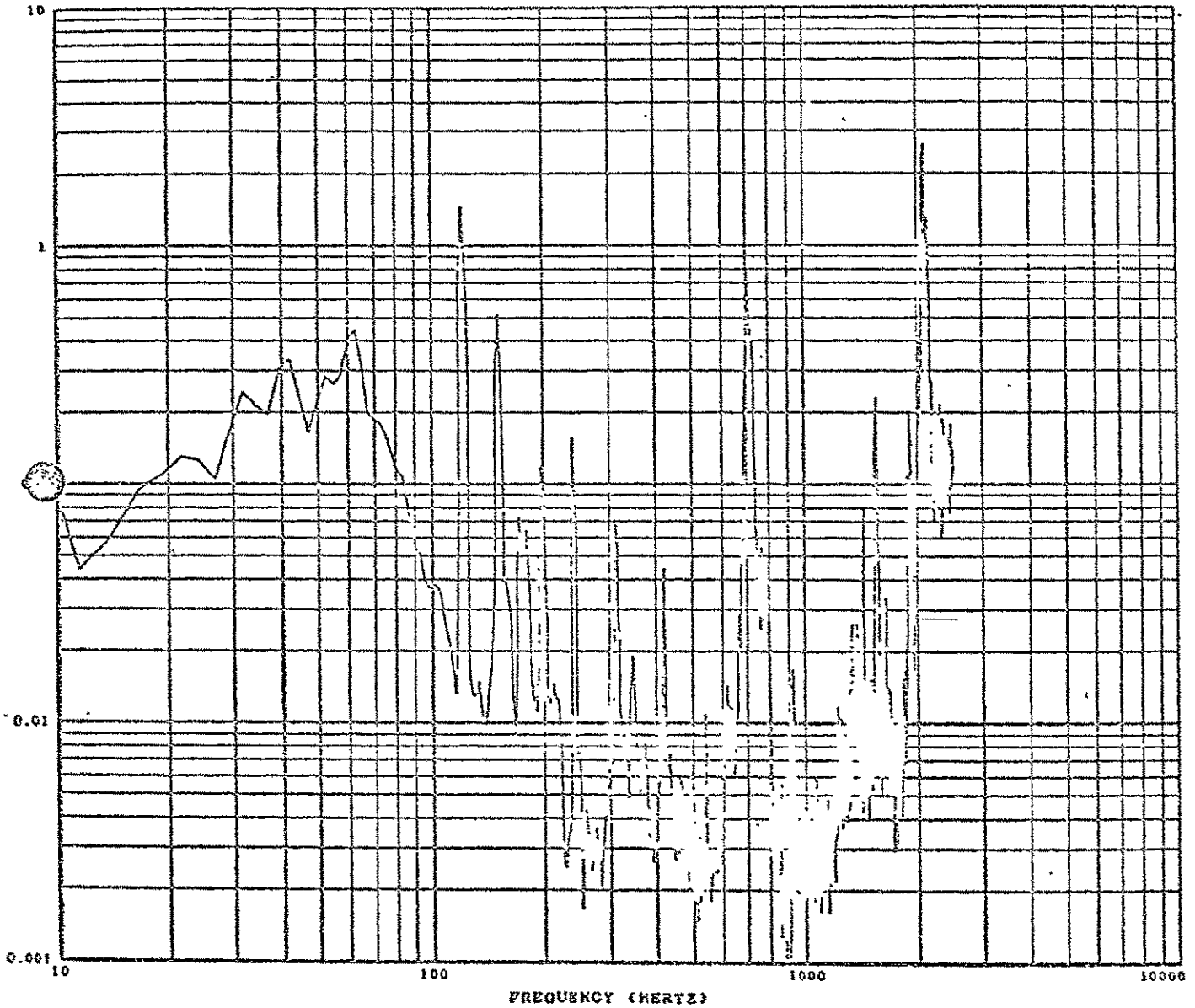
SENSOR - EPS-4R ELECTRON/PROTON SPECT. TEST CAL-1000. TIME SLICE (HR-MIN-SEC) 16 32 52.0000 TO 16 32 56.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION... 51.0891 DATE PROCESSED..... 25FEB77
 RRM. STD. ERROR... .22124 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 8.1071
 FILTER START POINTS. .0000



g rms = 51.09 PAGE 3.

Figure 112 Baseplate, 'R' Axis Response to Input of Figure 110

SENSOR - EPS-2H ELECTRON/PIKTON SPECT. TEST CAL=31.6 TIME SLICE (HR-MIN-SEC) 16 32 52.0000 TO 18 32 56.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. .7001 DATE PROCESSED..... 25SEP77
 NORM. STD. ERROR.... .22124 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1071
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN' X .001000

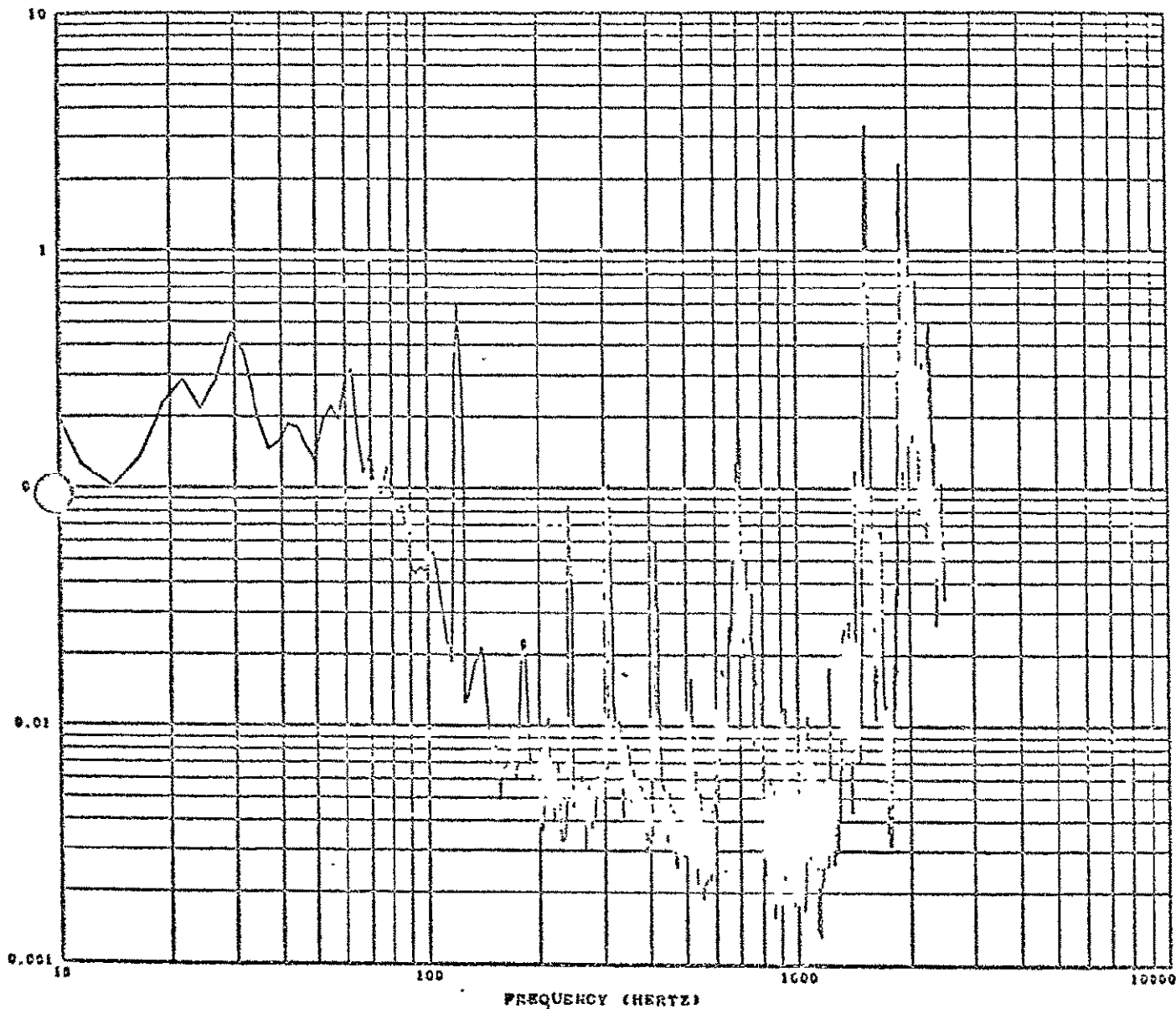


g rms = .70

PAGE 2.

Figure 113 Electronics Package, 'X' Axis Response to Input of Figure 110

SENSOR = EPS-3T ELECTRON/PROTON SPECT. TEST CAL=31.6 TIME SLICE (HS-MIN-SEC) 16 32 52.0000 TO 16 32 56.0000
 LOW-PASS FILTER USED 3000 0 STANDARD DEVIATION. .7376 DATE PROCESSED..... 25FEB77
 NOISE STD. FRAC..... 22124 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTH... 5.1077
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. THIS VALUE = VALUE SHOWN X .001000

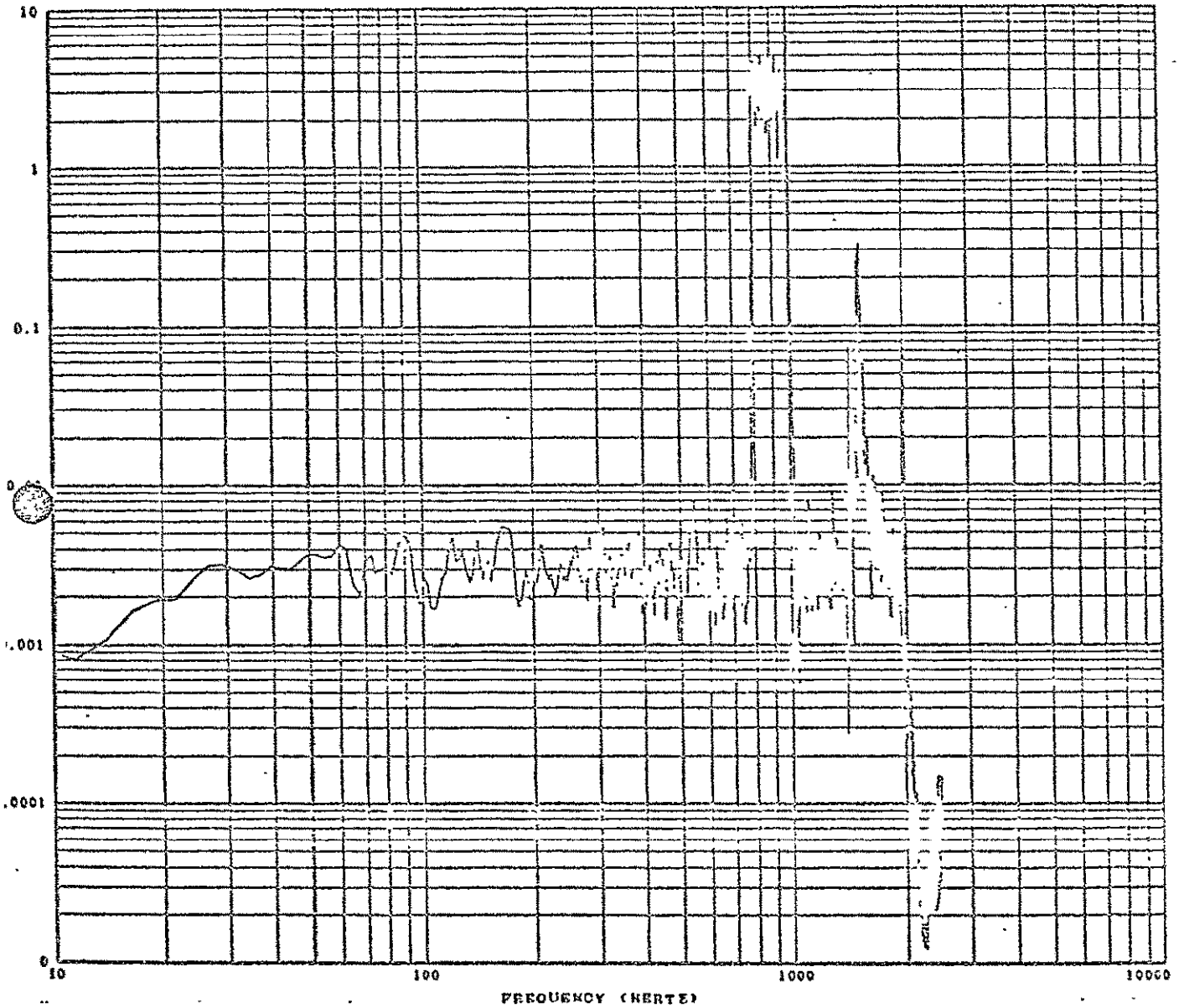


g rms = .74

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Figure 114 Electronics Package, 'T' Axis Response to Input of Figure 110

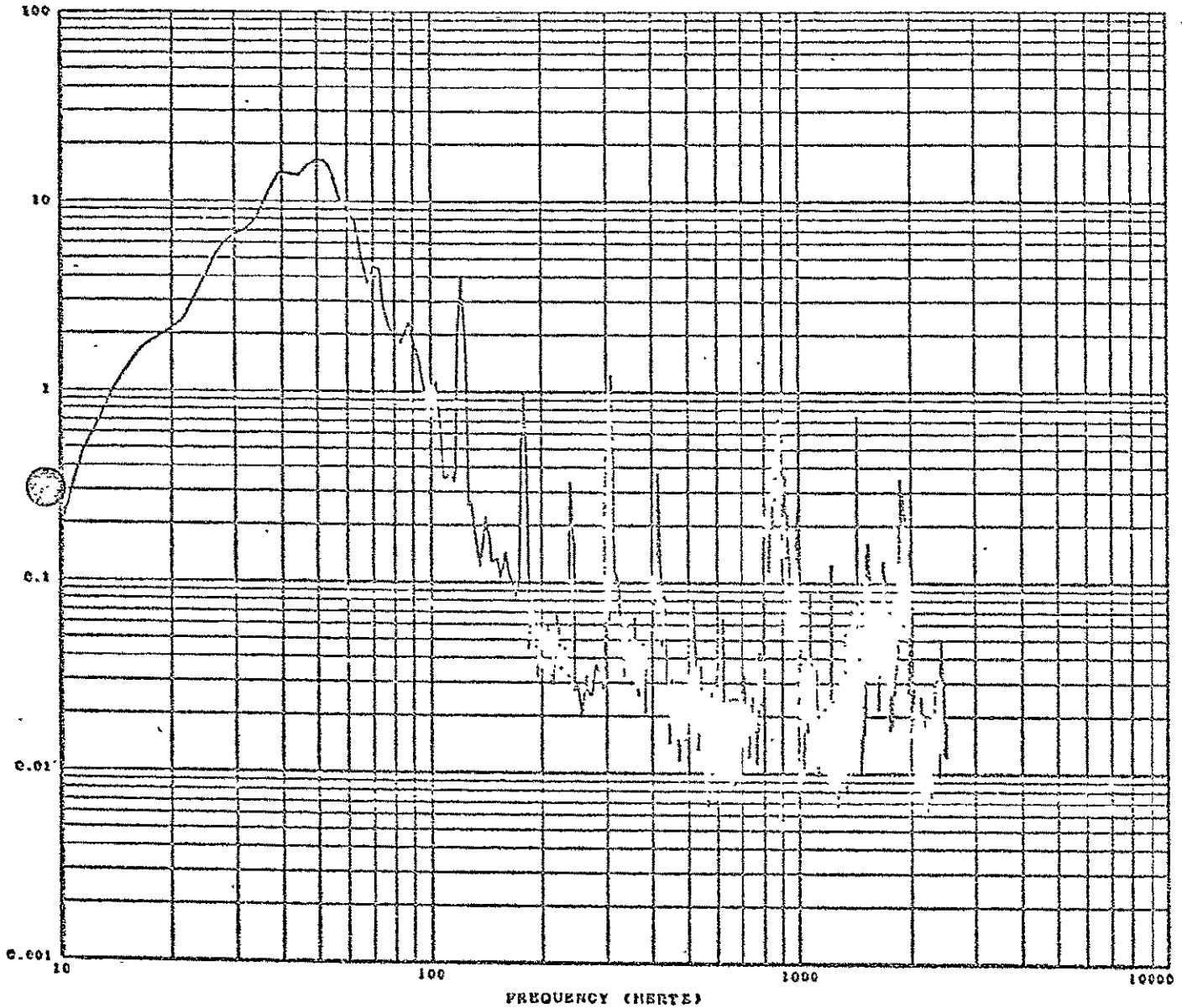
SENSOR - CONTROL ELECTRON/PROTON SPECT. TEST CAL:100. TIME SLICE (MINUTES) 10.000000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION 25.1061 DATE PROCESSED. 25FEB77
 NORM. STD. ERROR.... .22113 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1129
 FILTER START POINTS. .0000



g rms = 25.11 PAGE 8.

Figure 115 'R' Axis Input, Max. q
 Simulation (800 - 1000 Hz)

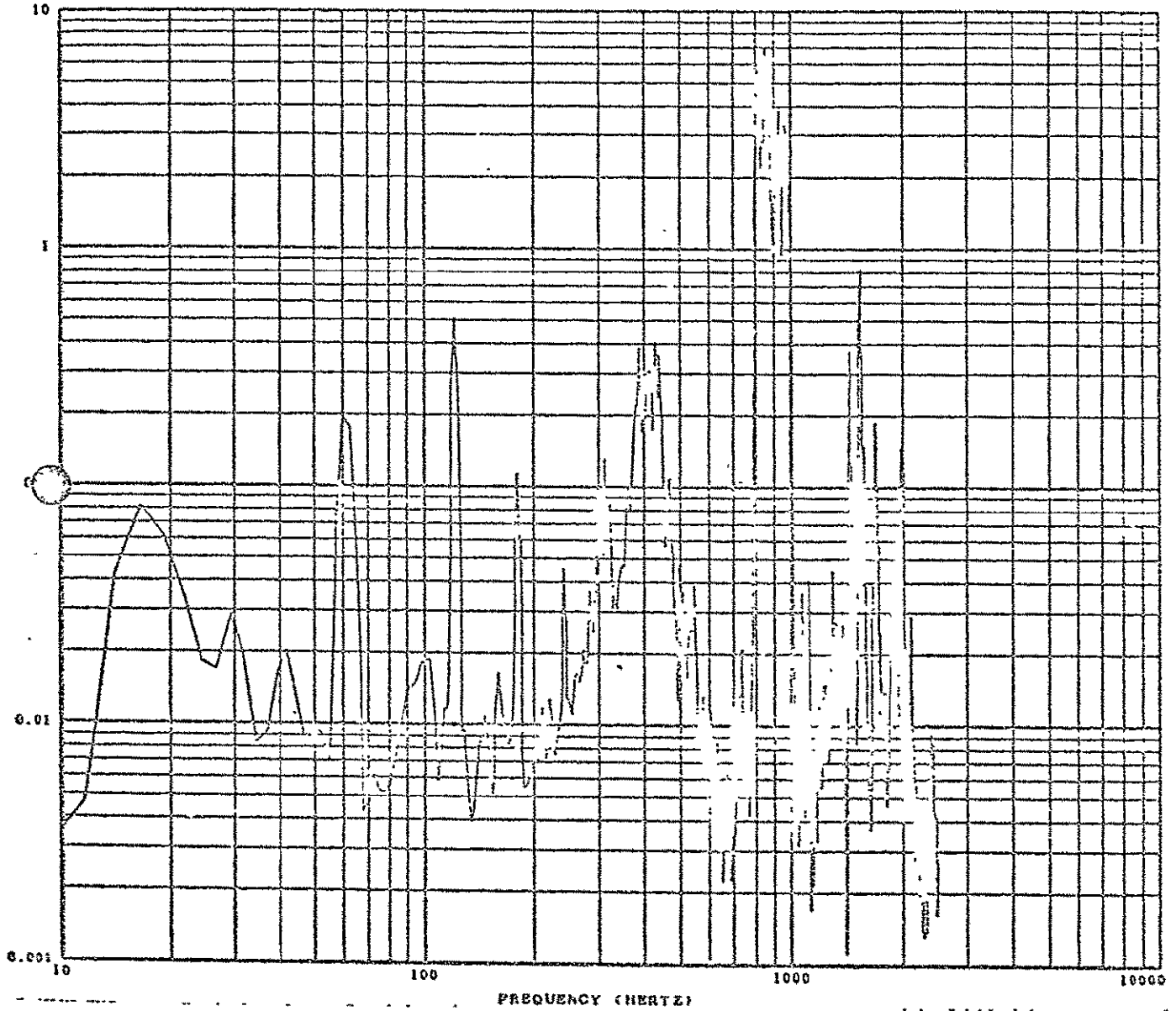
SENSOR - EPS-IR ELECTRON/PROTON SPECT. TEST CAL-100 TIME SLICE (HR-MIN-SEC) 16 54 19.0000 TO 16 54 21.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. .0674 DATE PROCESSED 2/21/77
 NOM. STD. ERROR.... .22113 VIBRATION TEST RUN 60X INPUT TAPE NUMBER ..
 FILTER BANDWIDTH. 5.1129
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR (GEO. TRUE VALUE = VALUE SHOWN) X .001000



g rms = .89

Figure 116 Electronics Package, 'R' Axis
Response to Input of Figure 115

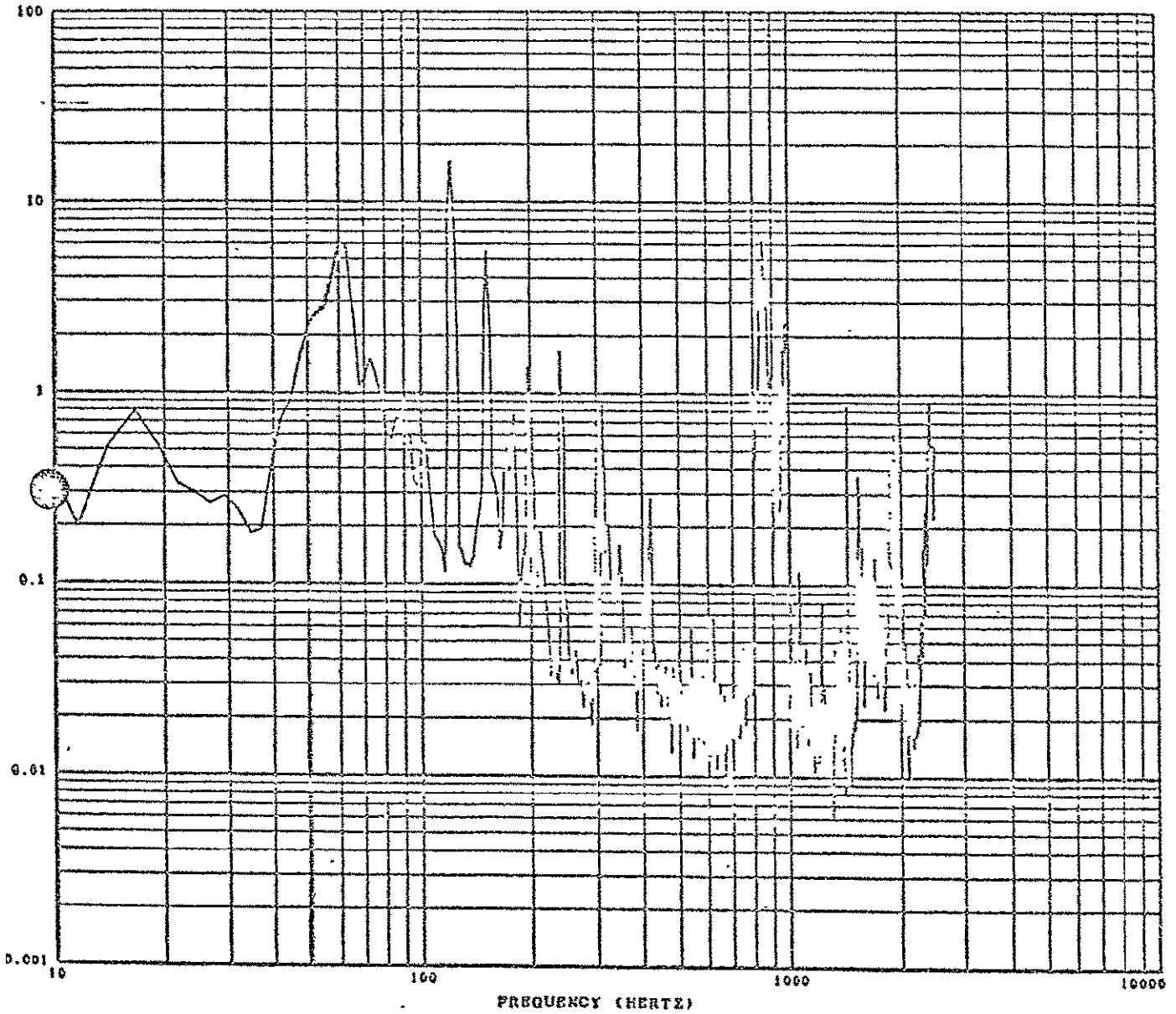
SENSOR * EPN-4R ELECTRON/PROTON SPECT. TEST CAL:1000. TIME SLICE (HR-MIN-SEC) 16 54 19.0000 TO 16 54 23.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 26.5542 DATE PROCESSED..... 25FEB77
 NORM. STD. ERROR.... .22113 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1129
 FILTER START POINTS. .0000



g rms = 26.55

Figure 117 Baseplate, 'R' Axis Response
 to Input of Figure 115

SENSOR - EPS-2R ELECTRON/PROTON SPECT. TEST CAL#31 6 TIME SLICE (HR-MIN-SEC) 16 54 19.0000 TO 16 54 23.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION... .3470 DATE PROCESSED..... 25-APR-71
 NORM. STD. ERROR..... .22117 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1129
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X .000100

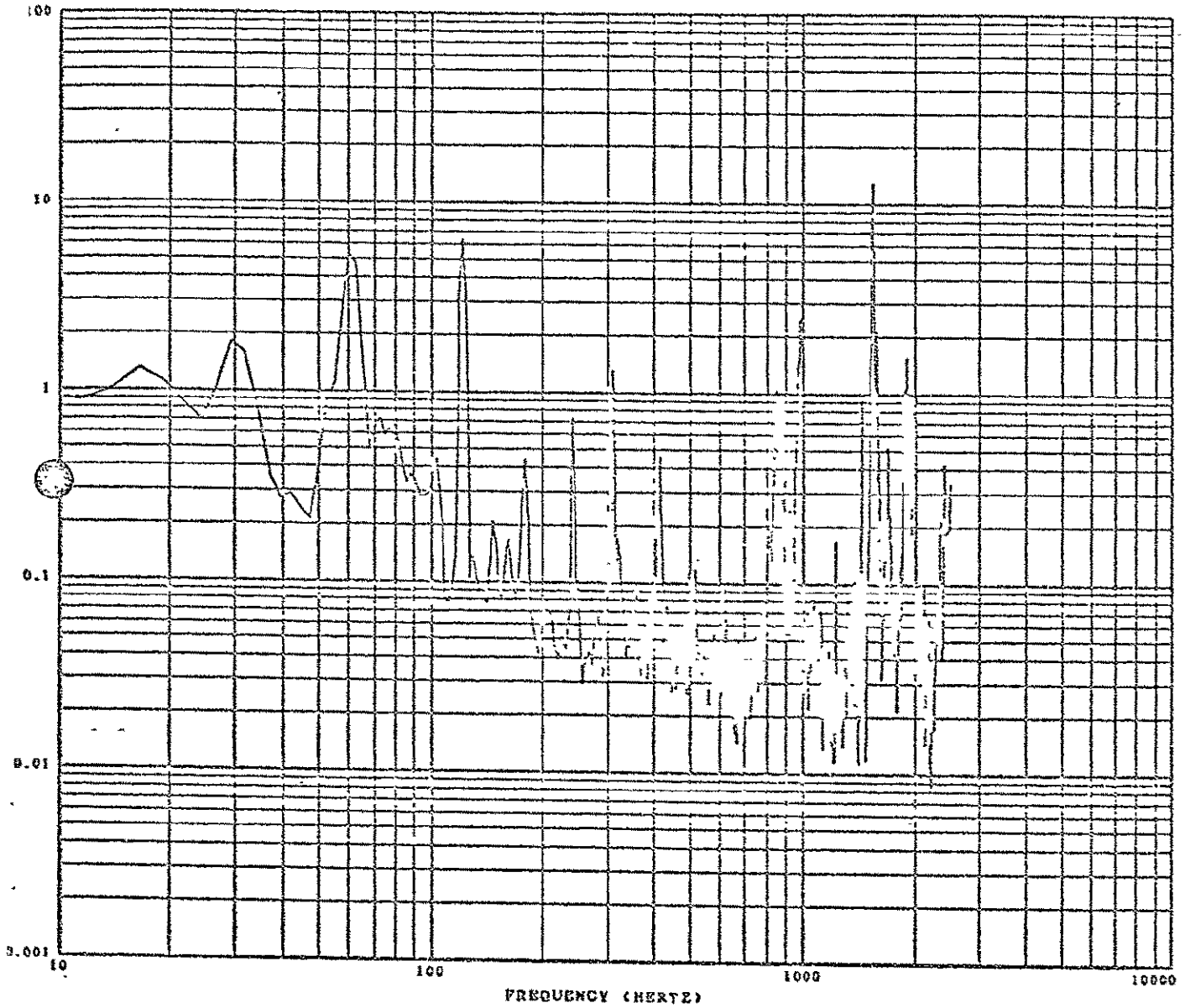


$g_{rms} = .35$

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Figure 118 Electronics Package, 'X' Axis
Response to Input of Figure 115

SENSOR * EPS-3T ELECTRON/PROTON SPECT. TEST CAL=31.6 TIME SLICE (HR-MIN-SEC) 16 54 19.0000 TO 16 54 23.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION... .3702 DATE PROCESSED..... 25FEB77
 NORM. STD. ERROR.... .22113 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1120
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X .000100

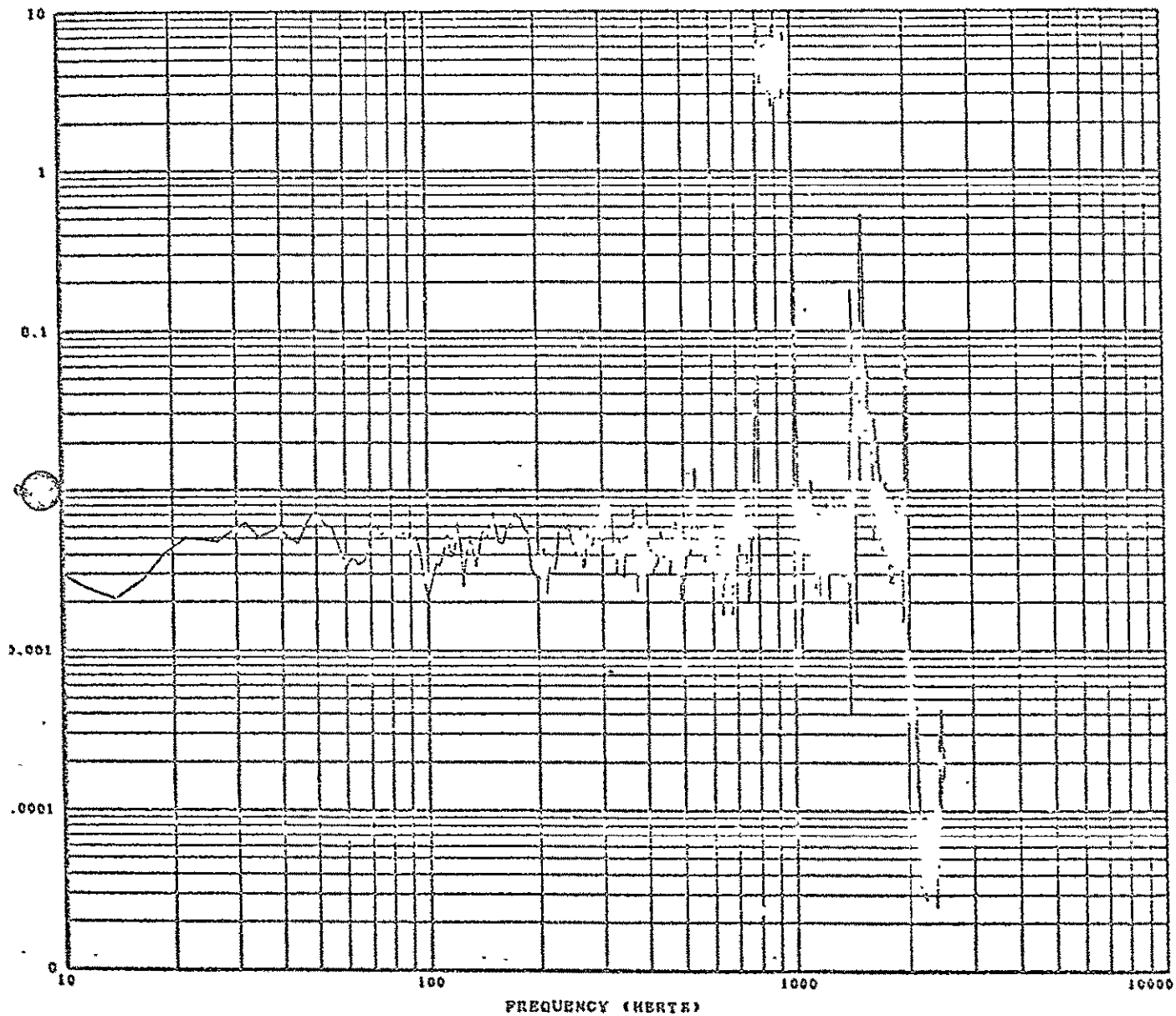


g rms = .37

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Figure 119 Electronics Package, 'T' Axis Response to Input of Figure 115

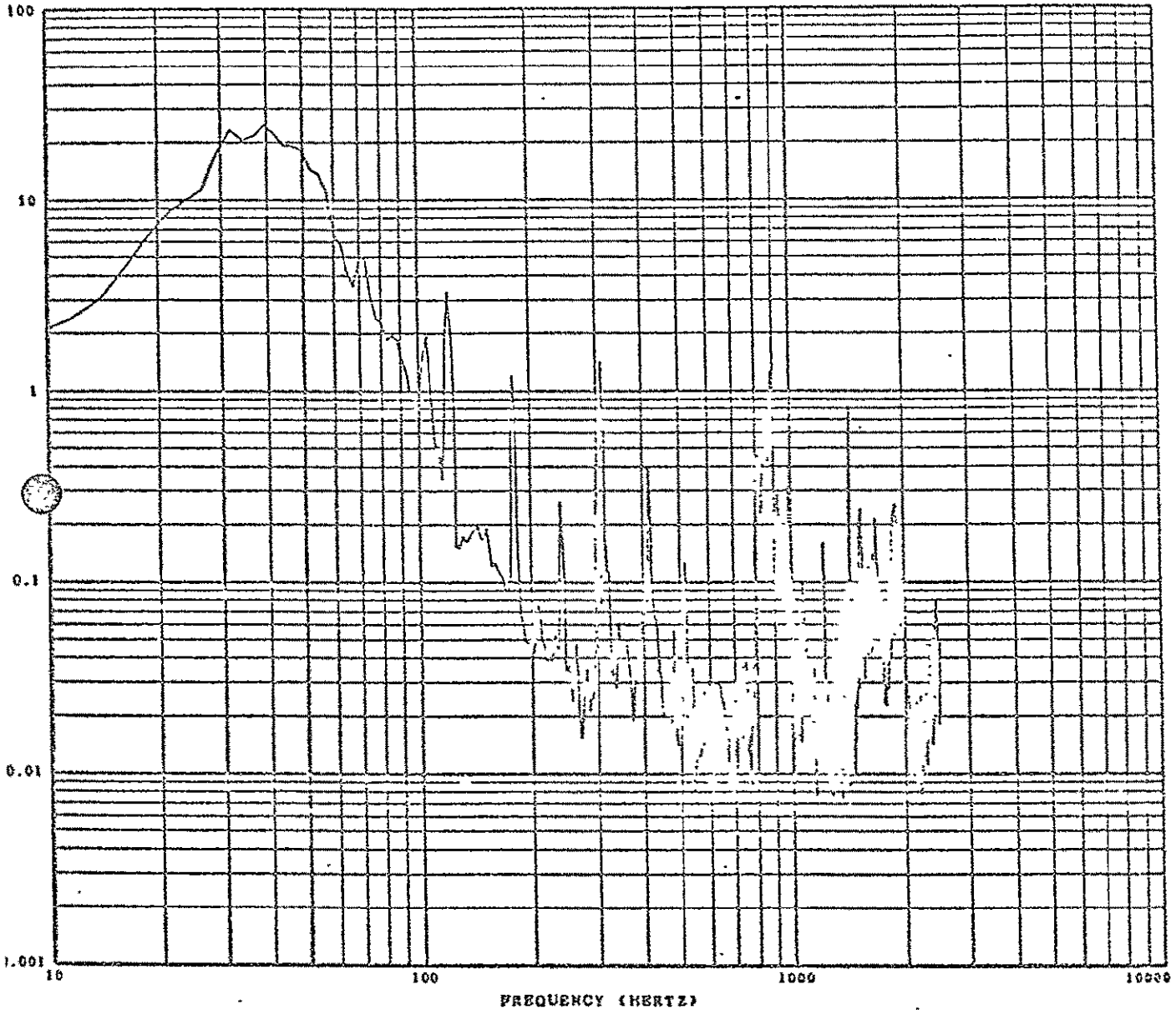
SENSOR - CONTRU ELECTRON/PROTON SPECT. TEST CAL=100. TIME SLICE (MIN-MIN-SEC) 16 55 35.0000 TO 16 55 39.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 31.7825 DATE PROCESSED..... 25FEB77
 NORM. STD. ERROR.... .22121 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1090
 FILTER START POINTS. .0000



g rms = 31.78 PAGES 0.

Figure 120 'R' Axis Input, Transonic/MACH 1 Simulation (800 - 1000 Hz)

SENSOR = EPS-IR ELECTRON/PHOTON SPECT. TEST CAL=100. TIME SLICE (HR-MIN-SEC) 16 55 33.0000 TO 16 59 33.0000
 LOW-PASS FILTER USED 3000 0 STANDARD DEVIATION 1.0664 DATE PROCESSED..... 25FEB77
 NORM. STD. ERROR... .22121 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTH... 5.1090
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X .001000

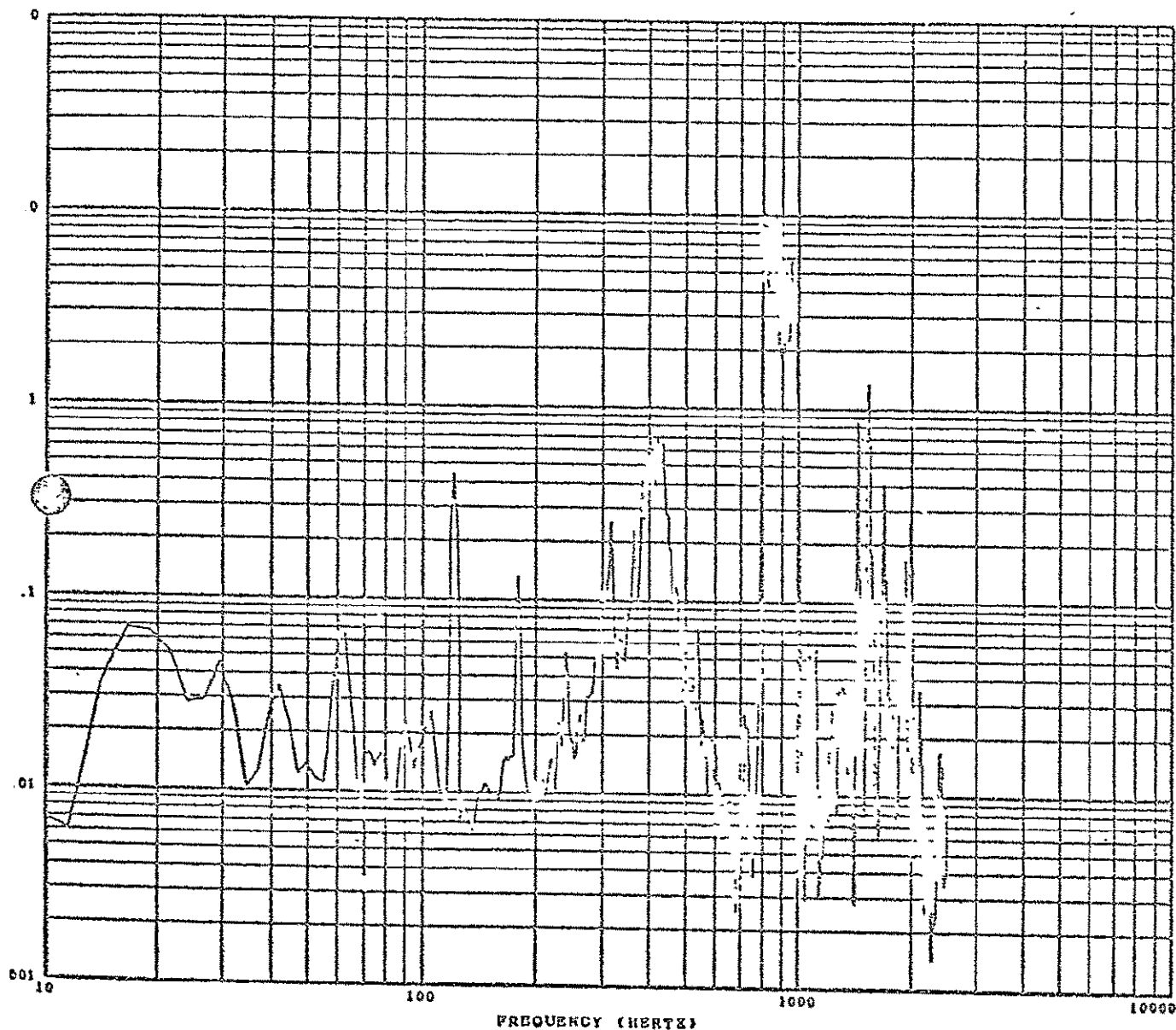


g rms = 1.07

PAGE 1.

Figure 121 Electronics Package, 'R' Axis Response to Input of Figure 120

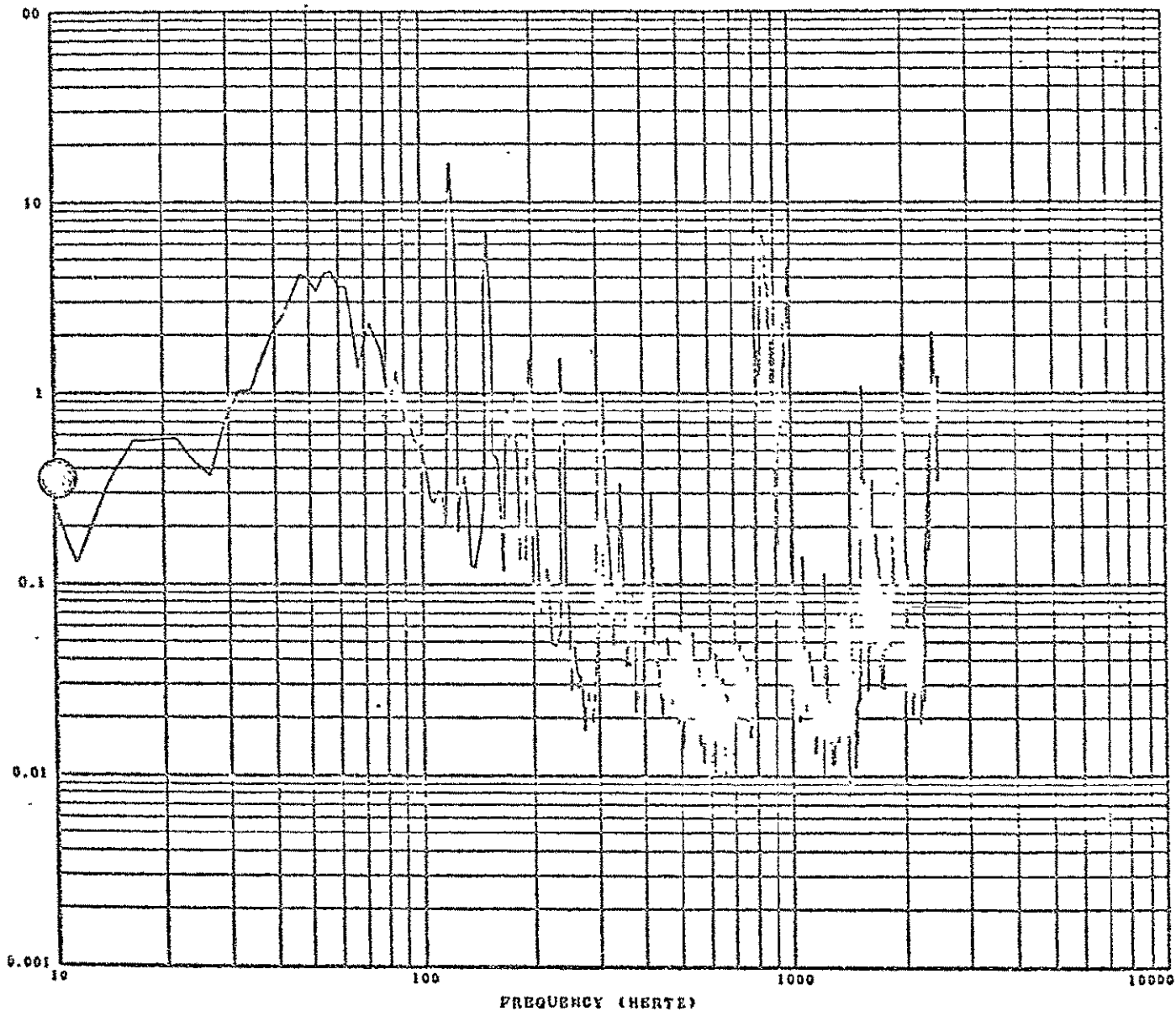
SENSOR - EPS-40 ELECTRON/PHOTON SPECT. TEST CAL=1000. TIME SLICE (HR-MIN-SEC) 16 55 35.0000 TO 16 55 39 0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 33.4494 DATE PROCESSED..... 25 FEB 77
 FORM. STD. ERROR.... .22121 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1090
 FILTER START POINTS. .0000



g RMS = 33.45 0/02 7.

Figure 122 Baseplate, 'R' Axis Response to Input of Figure 120

SENSOR - EPS-ZR ELECTRON/PROTON SPECT. TEST CAL=31 6 TIME SLICE (HR-MIN-SEC) 16 55 35 0000 TO 16 55 39.0000
 LOW-PASS FILTER USED 3000 0 STANDARD DEVIATION .4324 DATE PROCESSED..... 25FEB77
 NORM. STD. ERROR.... .22121 VIBRATION TEST RUN 60X INPUT TAPE NUMBER ..
 FILTER BANDWIDTHS... 5.1000
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X .000100

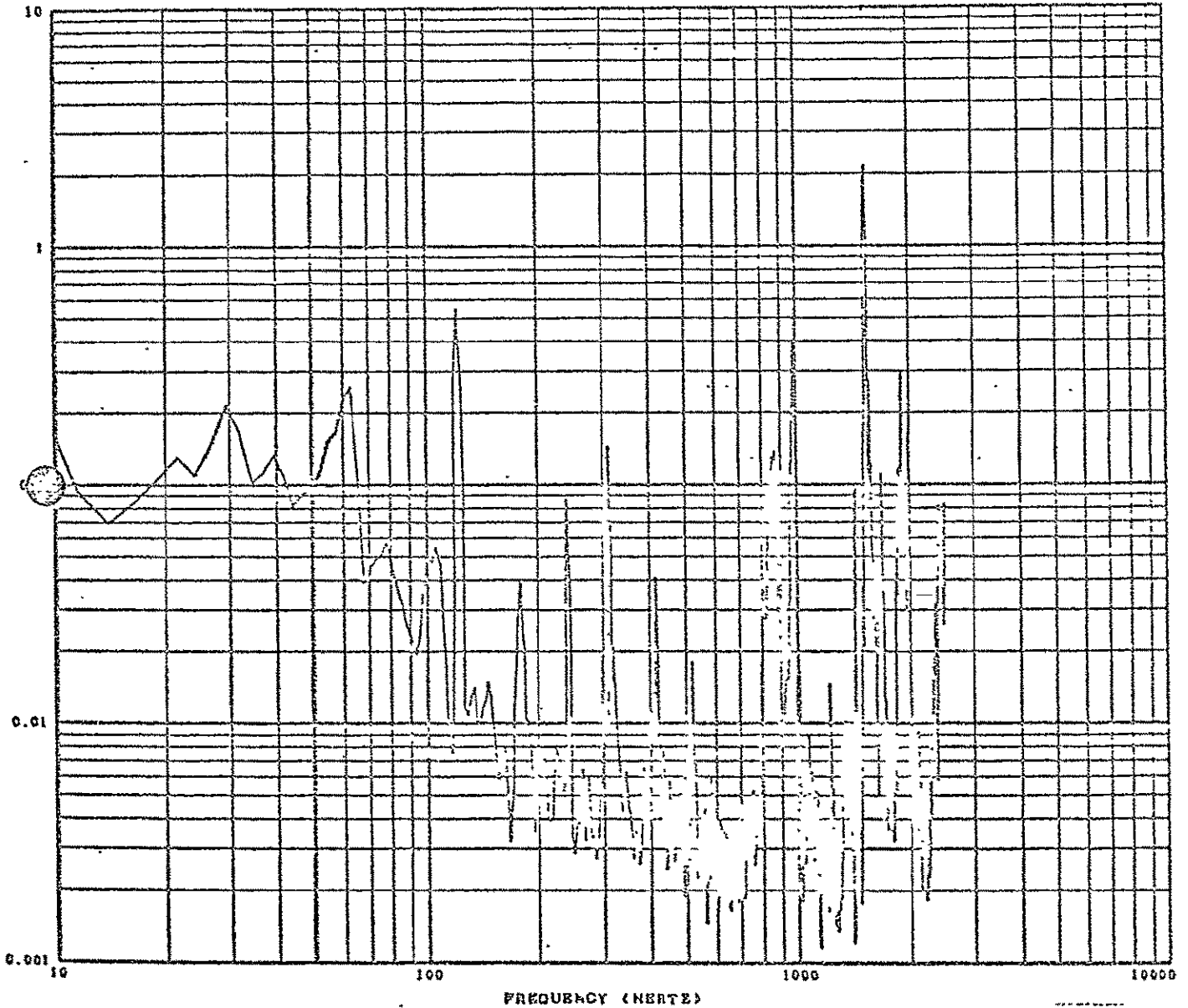


g rms = .43

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Figure 123 Electronics Package, 'X' Axis
Response to Input of Figure 120

SENSOR - EPS-3T ELECTRON/PROTON SPECT. TEST CAL=31.6 TIME SLICE (HR-MIN-SEC) 16 55 35.0000 TO 16 55 39.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION... .4637 DATE PROCESSED ... 25FEB77
 NORM. STD. ERROR... .22121 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1090
 FILTER START POINTS... .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE * VALUE SHOWN' X .001000

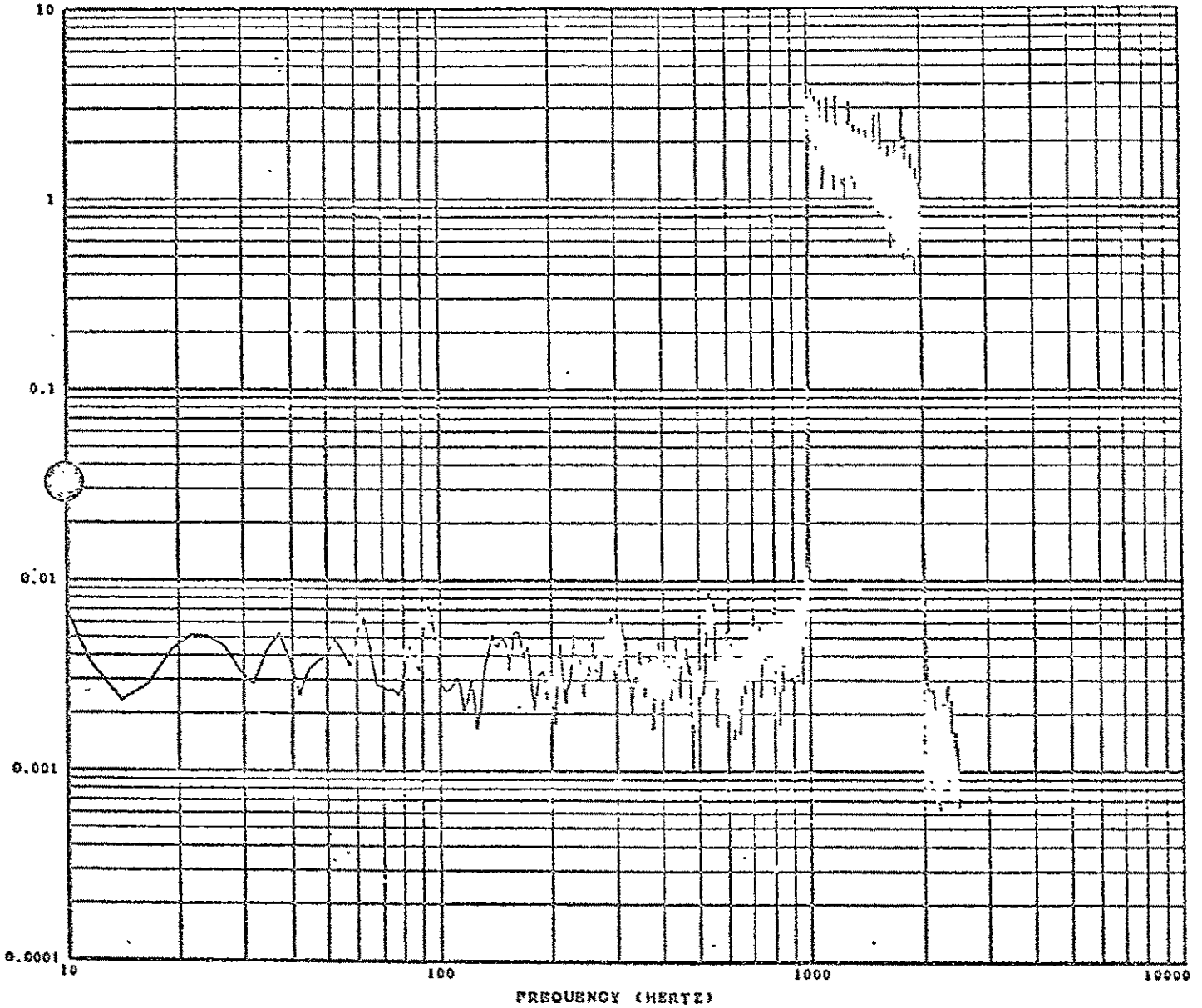


g rms = .46

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Figure 124 Electronics Package, 'T' Axis
Response to Input of Figure 120

SENSOR - CONTR. ELECTRON/PROTON SPECT. TEST CAL-100 TIME SLICE (HR-MIN-SEC) 17 21 10.0000 TO 17 21 14.0000
LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION 39 9.149 DATE PROCESSED 25FEB77
NORM. STD. FRIOR.... .22124 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
FILTER BANDWIDTHS... 5.1077
FILTER START POINTS. .0000

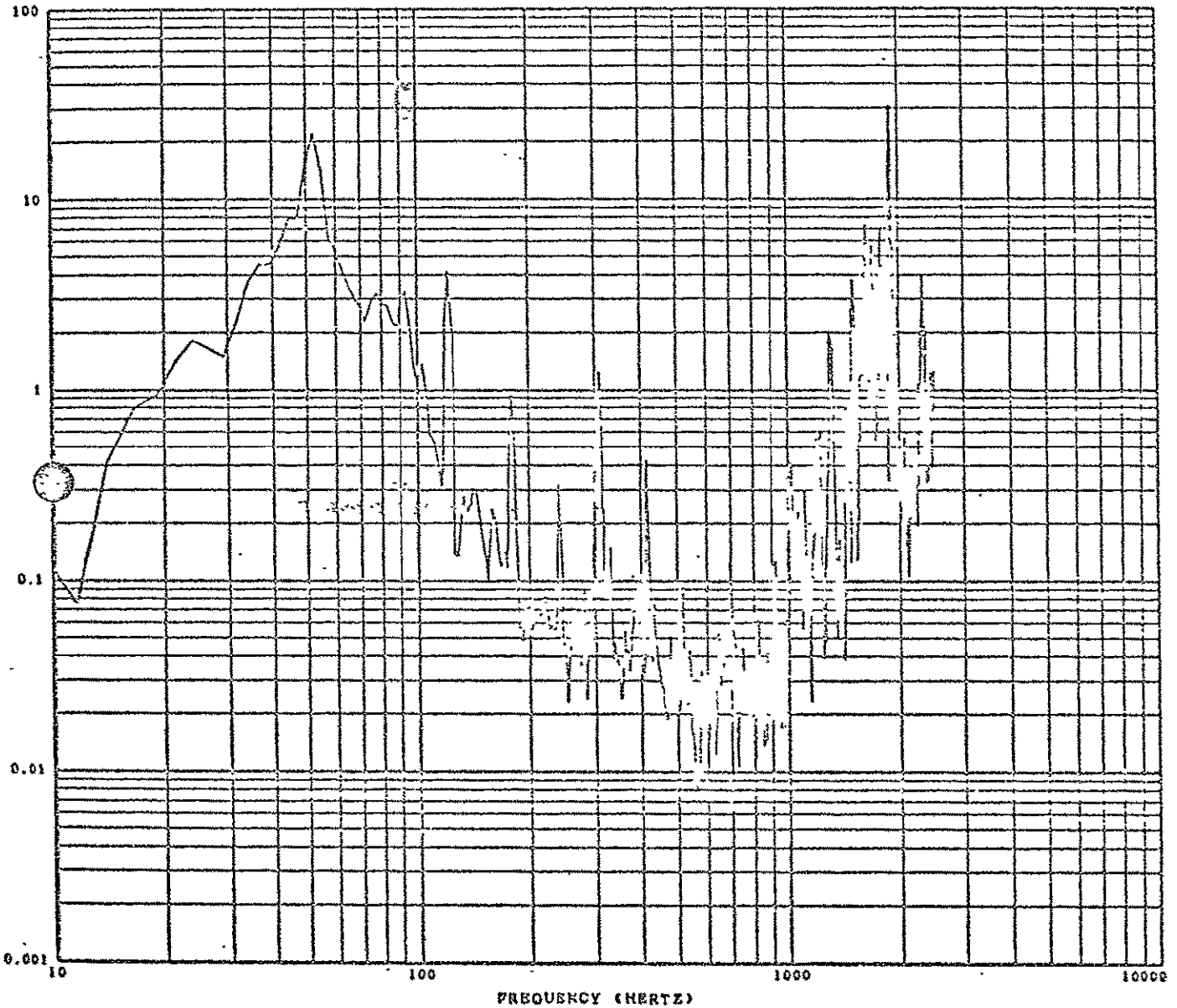


g rms = 39.93

PAGE 0.

Figure 125 'R' Axis Input, Max. g
Simulation (1000 - 2000 Hz)

SENSOR - EPS-IR ELECTRON/PROTON SPECT. TEST CAL=100. TIME SLICE (HR-MIN-SEC) 17 21 10.0000 TO 17 21 14.0000
LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 2.1210 --- DATE PROCESSED..... 25FB77
NORM. STD. ERROR.... .22124 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
FILTER BANDWIDTH... 5.1077
FILTER START POINTS. .0000
VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN * X .001000

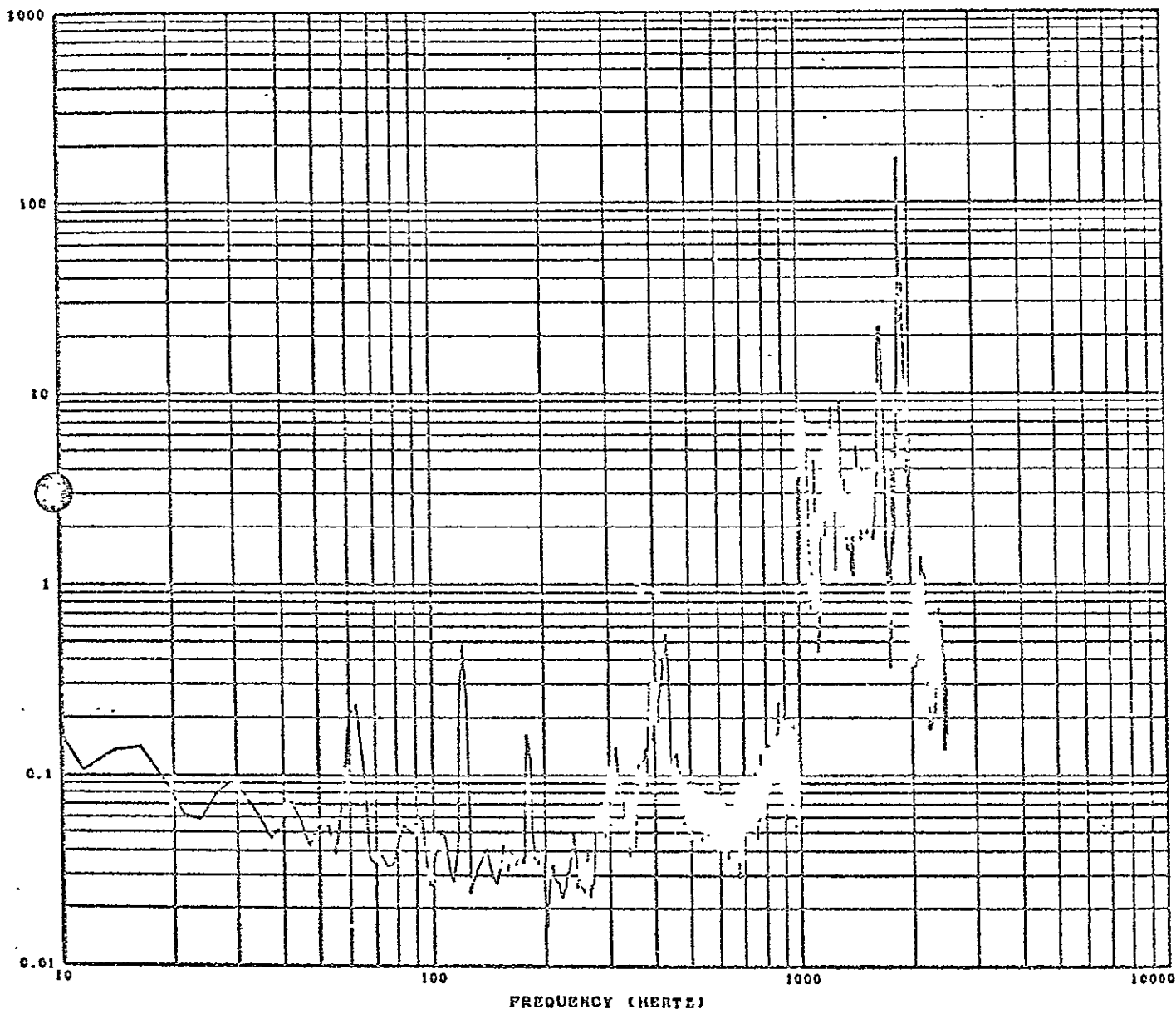


g rms = 2.12

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Figure 126 Electronics Package, 'R' Axis
Response to Input of Figure 125

SENSOR - EPS-4R ELECTRON/PROTON SPECT TEST CAL=1000 TIME SLICE (PRE-MIN-SEC) 17 21 10 0000 TO 17 21 14.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 95.7515 DATE PROCESSED 25FEB77
 NORM. STD. ERROR.... .22124 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 6.1077
 FILTER START POINTS. .0000

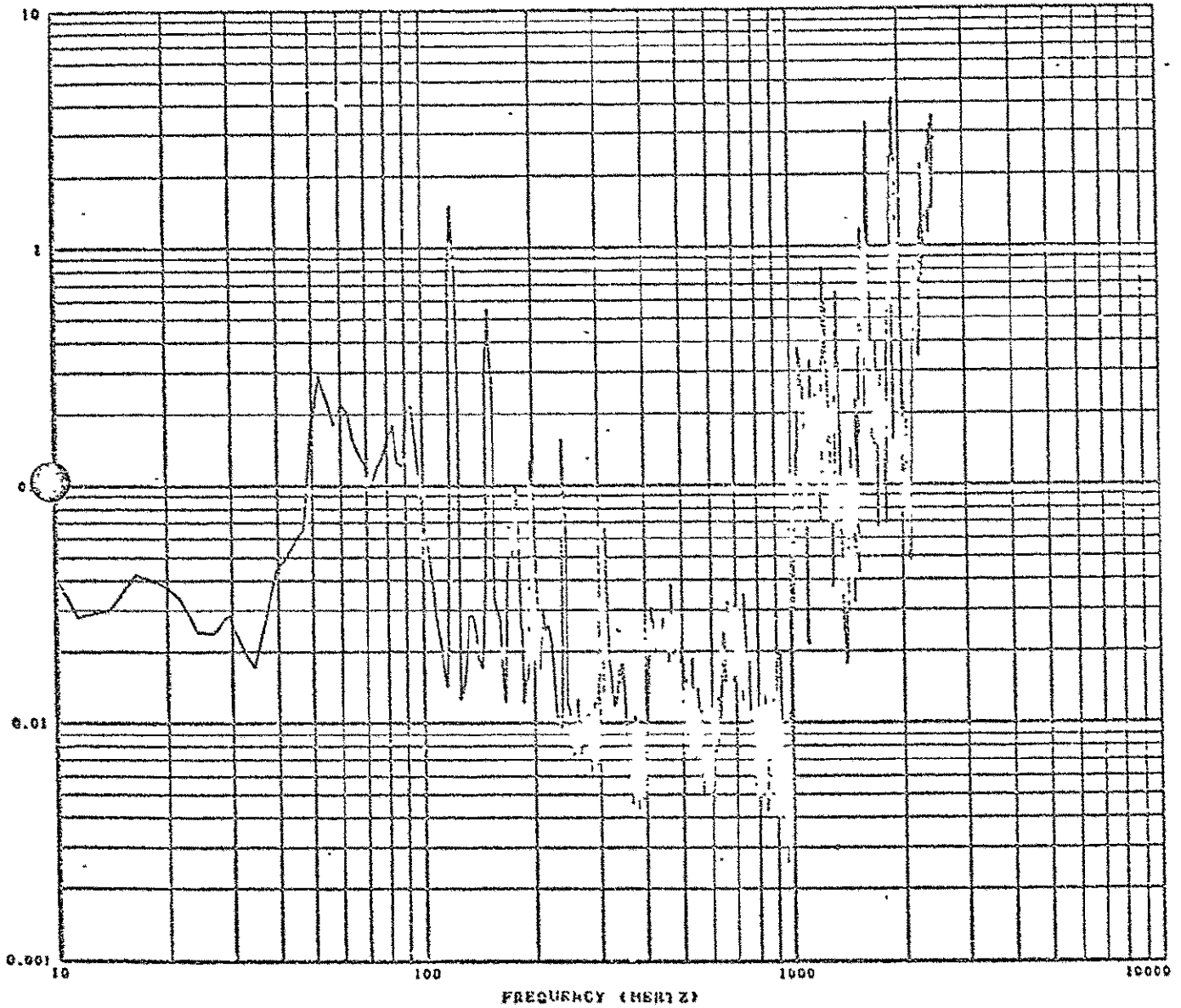


g rms = 95.75

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Figure 127 Baseplate, 'R' Axis Response to Input of Figure 125

SENSOR - EPS-2R ELECTRON/PROTON SPECT. TEST CAL=J1.6 TIME SLICE (HR-MIN-SEC) 17 21 10 0000 TO 17 21 14 0000
LOF-PASS FILTER USED 3000.0 STANDARD DEVIATION 2 1203 DATE PROCESSED..... 25FEB77
NORM. STD. FRISK.... .22124 VIBRATION TEST RUN 60A INPUT TAPE NUMBER...
FILTER BANDWIDTHS... 5.1077
FILTER START POINTS. .0000
VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X .001000

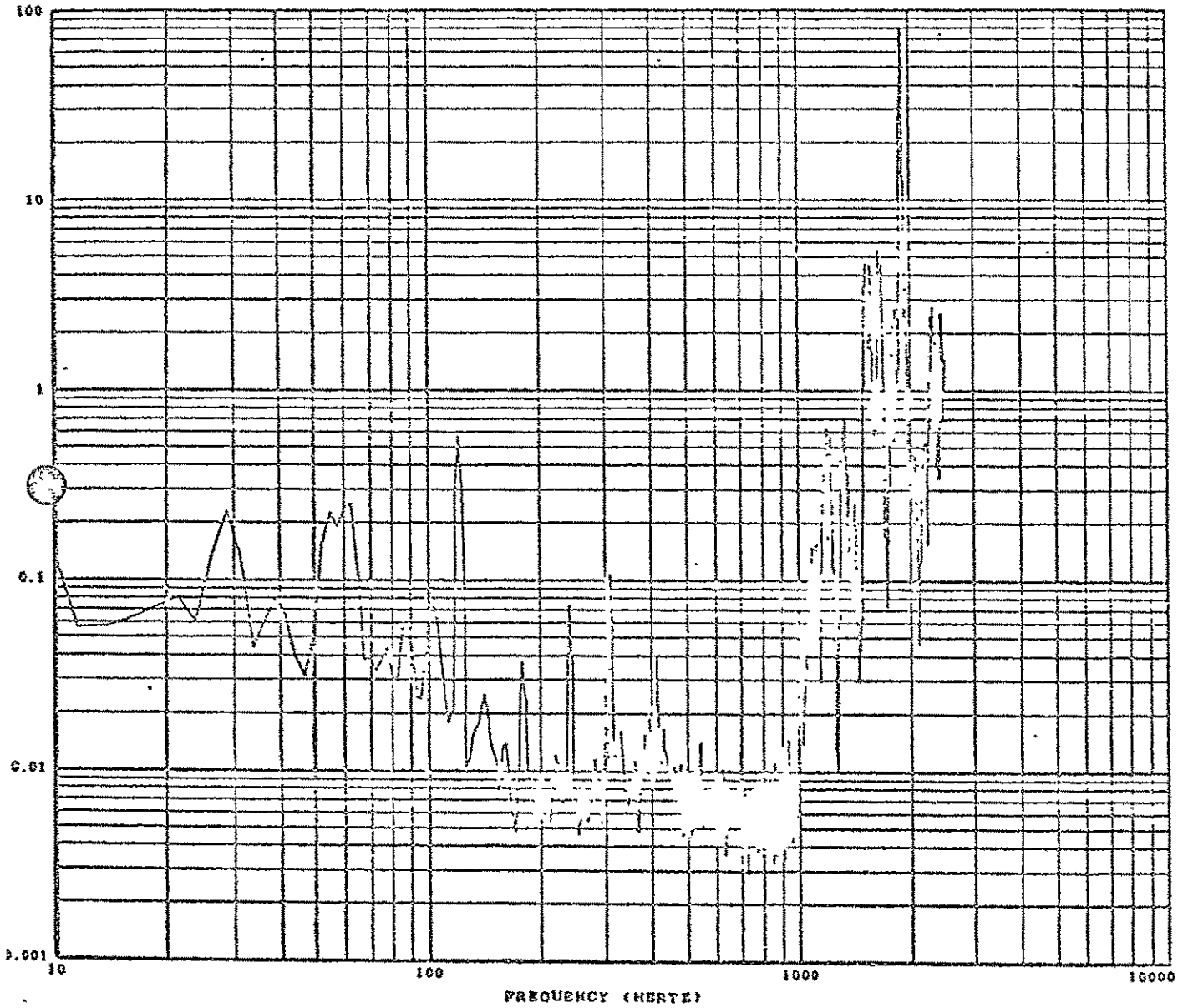


g rms = 2.12

PAGE 2.

Figure 128 Electronics Package, 'X' Axis
Response to Input of Figure 125

SENSOR - EPS-3T ELECTRON/PROTON SPECT. TEST CAL=31.6 TIME SLICE (180-MIN-SEC) 17 21 10.0000 TO 17 21 14.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION 2.5409 DATE PROCESSED, 25FEB77
 NORM. STD. ERROR.... .22124 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1077
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X .001000

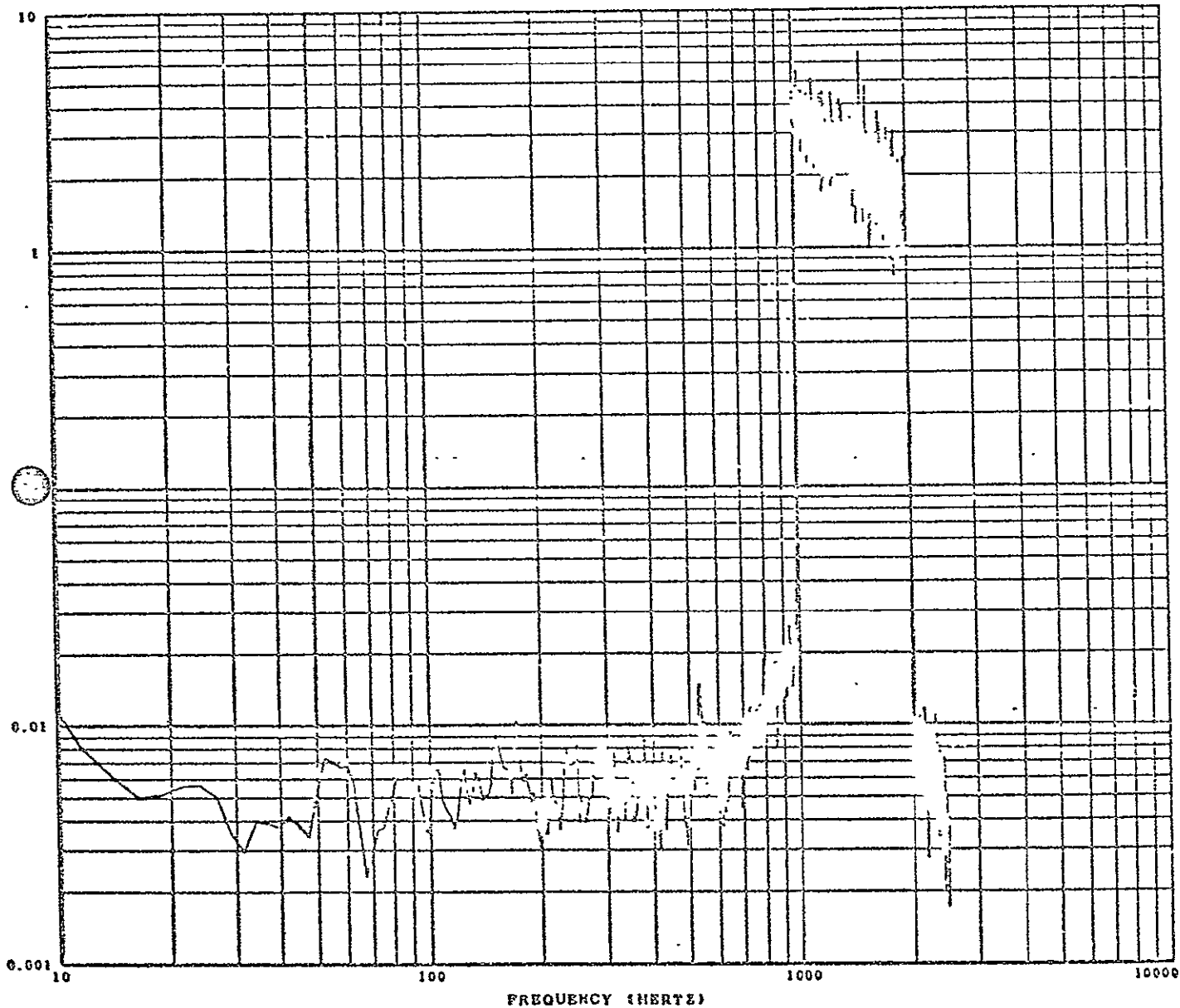


g rms = 2.54.

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Figure 129 Electronics Package, 'T' Axis Response to Input of Figure 125

SENSOR - CONTRL ELECTRON/PROTON SPECT TEST CAL=100. TIME SLICE (10-MIN-SEC) 17 22 20 0000 TO 17 22 32.0000
LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 50.2095 : DATE PROCESSED..... 25-FEB77
NORM. STD. ERR..... .27124 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
FILTER BANDWIDTHS... 5.1077
FILTER START POINTS. .0000

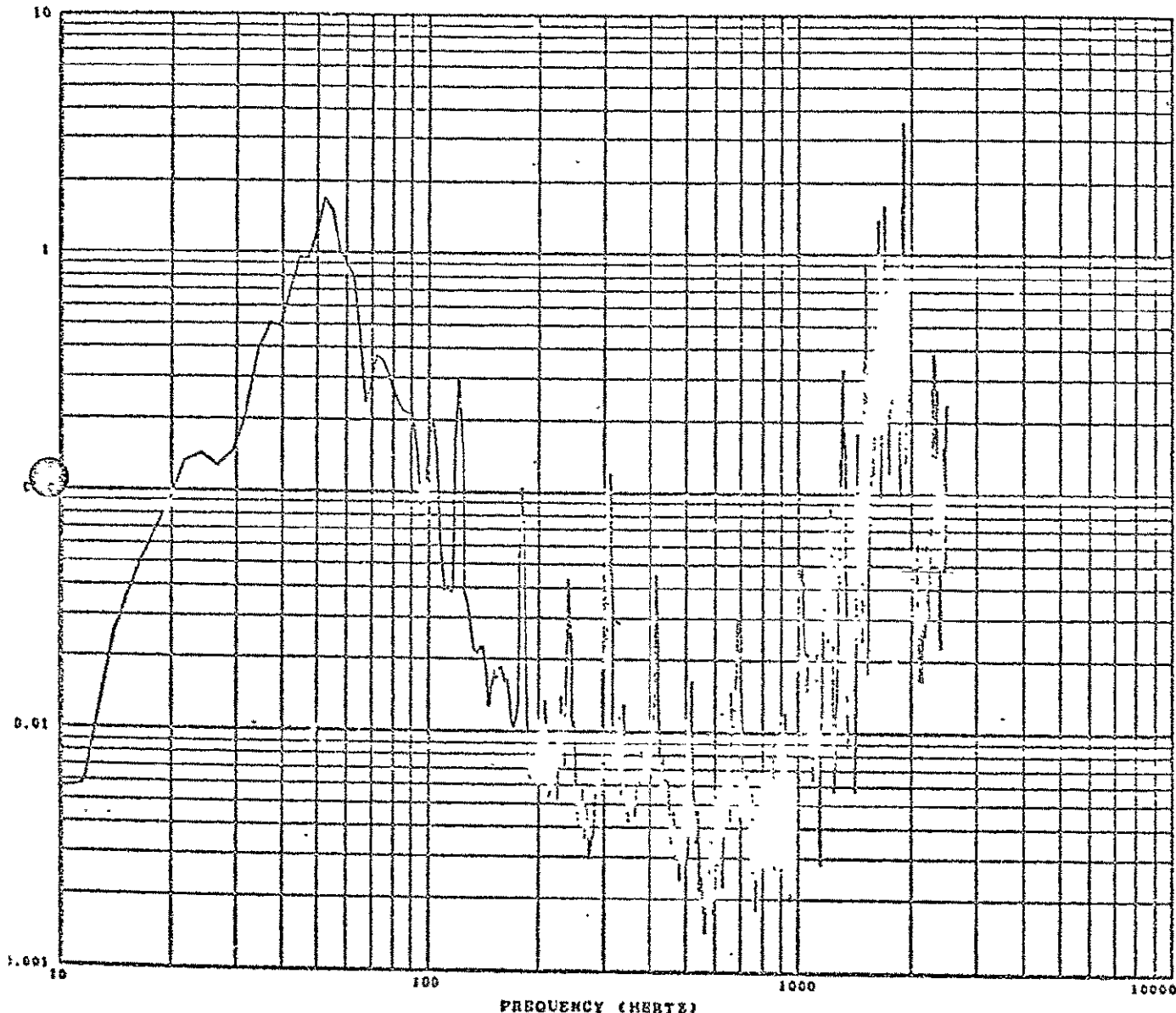


g rms = 50.21

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Figure 130 'R' Axis Input, Transonic/MACH 1
Simulation (1000 - 2000 Hz)

SENSOR - EPS-1R ELECTRON/PROTON SPECT. TEST CAL=100. TIME SLICE (HR-MIN-SEC) 17 22 28.0000 TO 17 22 32.0000
 LOW-PASS FILTER USED 3000 0 STANDARD DEVIATION 2.5687 DATE PROCESSED 25FEB77
 NORM. STD. ERROR... .22124 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTH... 5.1077
 FILTER START POINTS. 0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN * X .010000

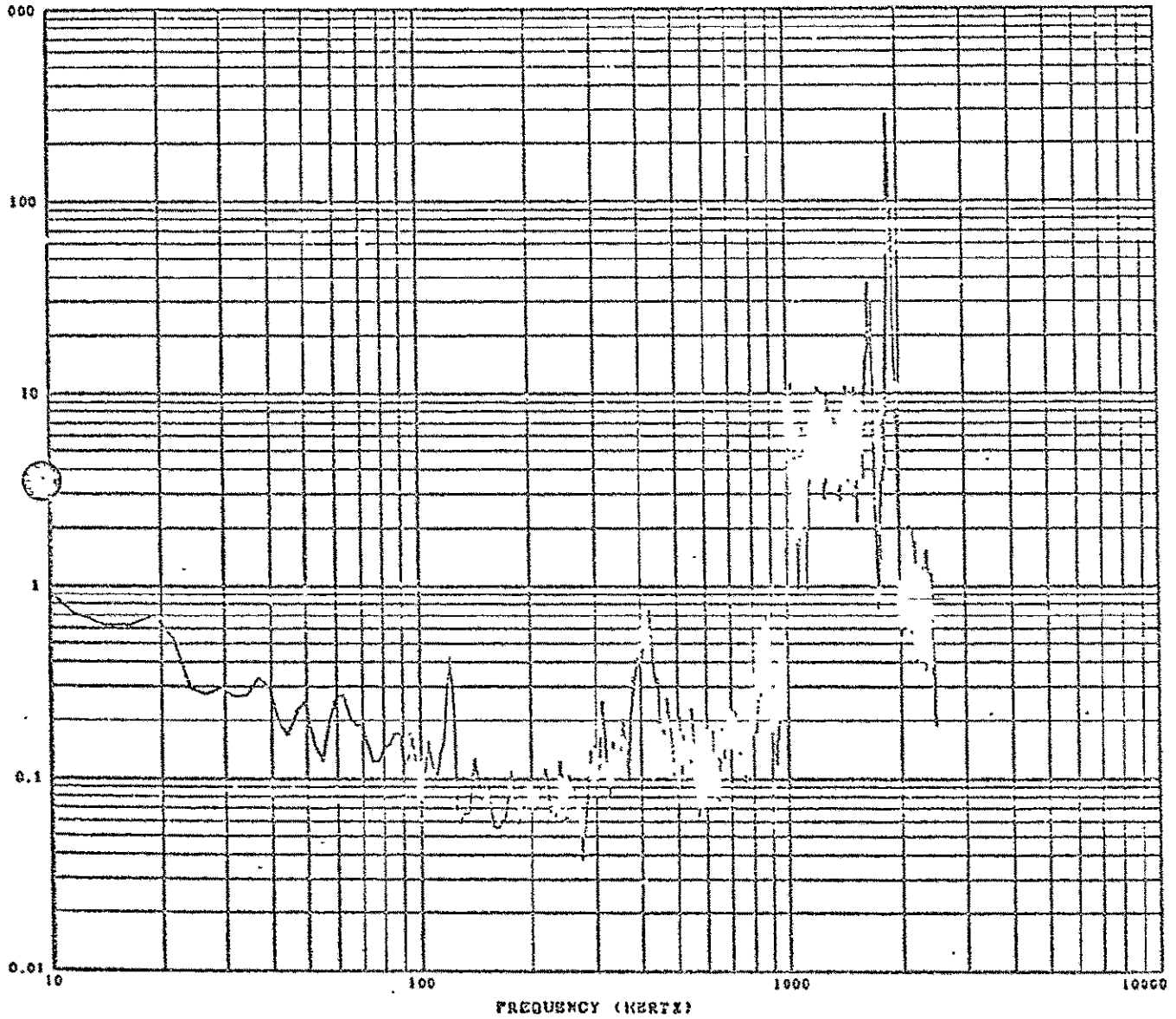


g rms = 2.57

PAGE 1.

Figure 131 Electronics Package, 'R' Axis
 Response to Input of Figure 130

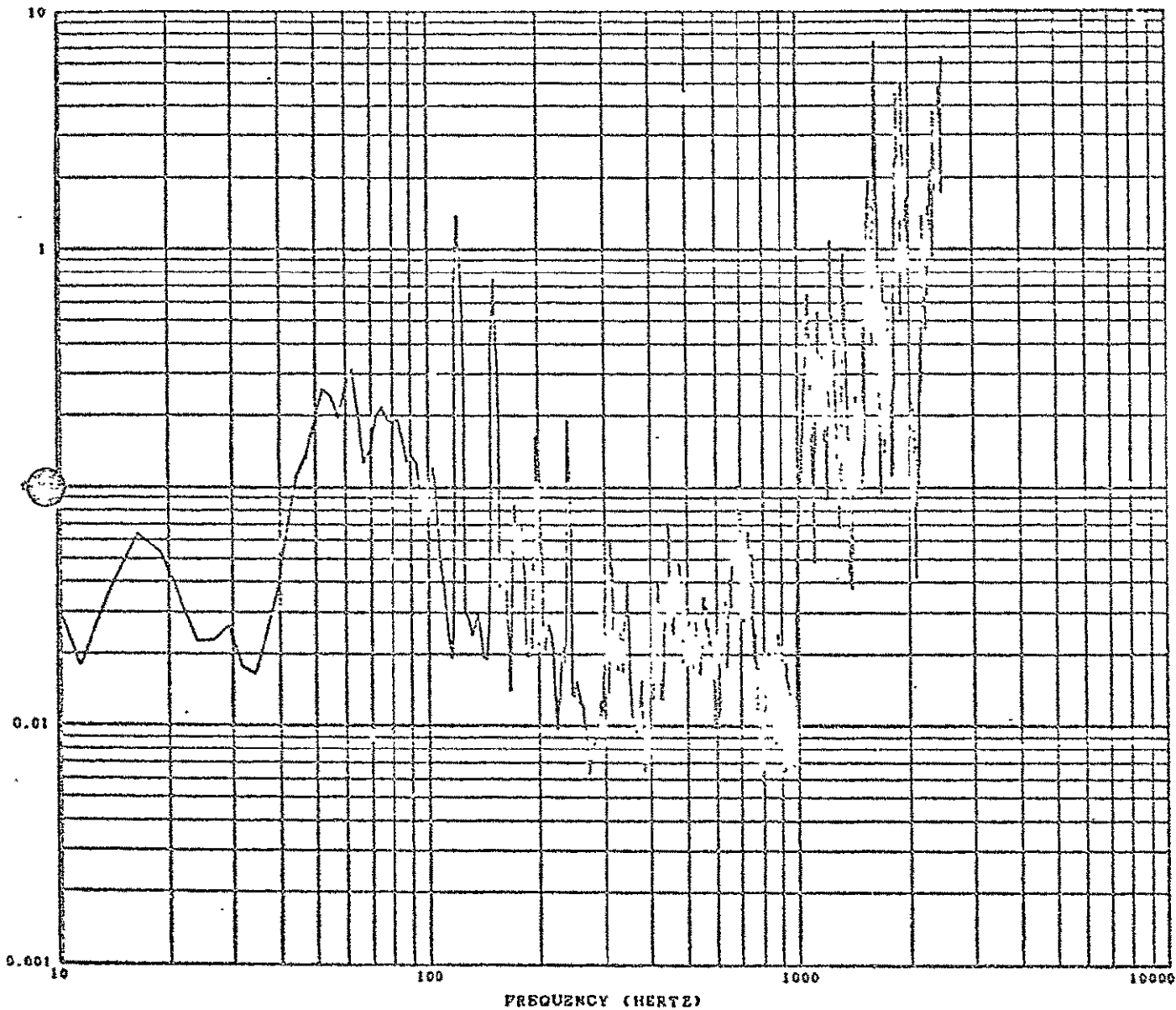
SENSOR = EPS-69 ELECTRON/PROTON SPECT. TEST CAL-1000. TIME SLICE (HR-MIN-SEC) 17 22 28 0000 TO 17 22 32.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION... 130.3424 DATE PROCESSED... 15FEB77.
 NOMI. STD. ERROR... .22124 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTH... 5.1077
 FILTER START POINTS. .0000



g rms = 130.34 PAGE 1.

Figure 132 Baseplate, 'R' Axis Response to Input of Figure 130

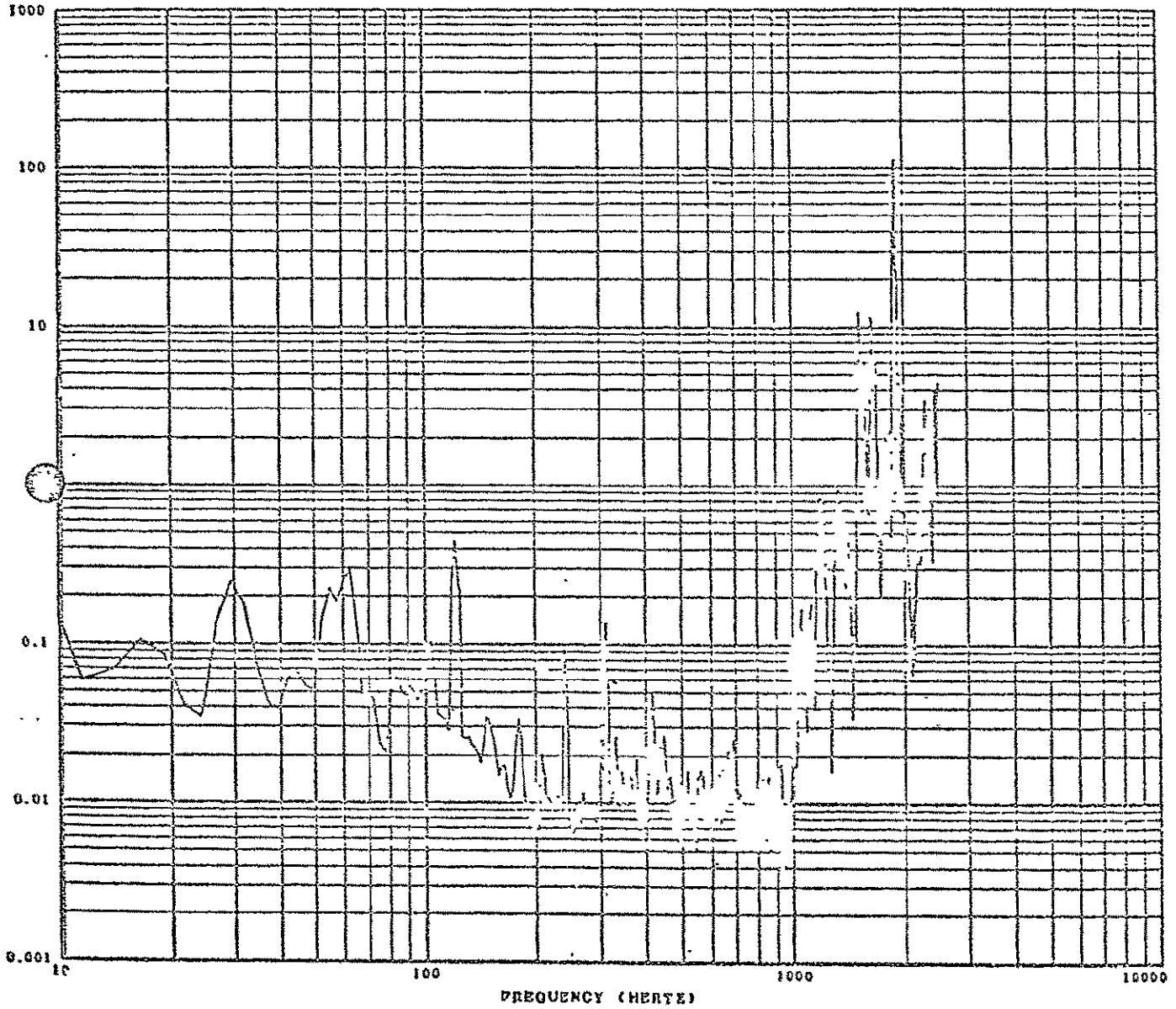
SENSOR - EPS-2R ELECTRON/PROTON SPECT. TEST CAL31.6 TIME SLICE (MIN-MIN-SEC) 17 22 28.0000 TO 17 22 32.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 2.5632 DATE PROCESSED..... 25FEB77
 NORM. STD. ERROR.... .22124 VIBRATION TEST RUN 60A INPUT TAPE NUMBER...
 FILTER BANDWIDTHS... 5.1017
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED. TRUE VALUE = VALUE SHOWN X .001000



g rms = 2.56 P/US 3.

Figure 133 Electronics Package, 'X' Axis
Response to Input of Figure 130

SENSOR - EPS-3T ELECTRON/PROTON SPECT. TEST CAL:31.6 TIME SLICE (HR-MIN-SEC) 17 22 28:0000 TO 17 22 32.0000
 LOW-PASS FILTER USED 3000.0 STANDARD DEVIATION.. 3.1908 DATE PROCESSED..... 25 FEB 77
 NORM. STD. ERROR... .22124 VIBRATION TEST RUN 60X INPUT TAPE NUMBER...
 FILTER BANDWIDTHS .. 5.1077
 FILTER START POINTS. .0000
 VERTICAL SCALE FACTOR USED TRUE VALUE = VALUE SHOWN' X .001000



g rms = 3.19

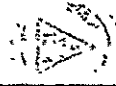
PAGE 6.

Figure 134 Electronics Package, 'T' Axis
Response to Input of Figure 130

Appendix A
Acceptance Test Data Sheets


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 DATA SHEET 1
 FUNCTIONAL TEST

(1) Visual inspection

 1/19/71
 Insp. Date

(5) Detector Plate Temperature

Rosemount Temperature Value	Package Temperature Monitor Value	Detector Plate Temperature Monitor Value	Elapsed Time	
<u>27.95 °C</u>	<u>25.3 °C</u>	<u>23.8 °C</u>	<u>0</u> Min.	<u>17:15</u>
<u>19.5 °C</u>	<u>22.9</u>	<u>20.5</u>	<u>1:55</u>	<u>19:10</u>
<u>16.6 °C</u>	<u>23.6</u>	<u>20.8</u>	<u>1:36</u>	<u>19:46</u>
<u>19.6</u>	<u>23.7</u>	<u>20.8</u>	<u>1:34</u>	<u>20:20</u>

 1/19/72
 Insp. Date

(6) Heater Power

Measured Value
27.54 VDC

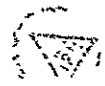
Acceptable Value
 +27.5 ± 0.5 Vdc

 1-19-72
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(7) Medium Voltage Heater Current

Measured Value
7 ma

Acceptable Value
 .10 ± 5 mA

 1-19-72

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DATA SHEET 1 (Cont.)

(8) Electronic Power

Measured Value

27.45 VDC

Acceptable Value

$+27.5 \pm 0.5$ Vdc

Insp.

Date



1-19-72

(9) Medium Voltage Electronics Current

Measured Value

514 ma

Maximum Value

560 mA

Insp.

Date



1-19-72

(10) Detector Bias

Measured Value

27.58 VDC

Acceptable Value

$+27.5 \pm 0.5$ Vdc

Insp.

Date



1-19-72

(11) Medium Voltage Detector Bias Current

Measured Value

21 ma

Maximum Value

30 mA

Insp.

Date



1-19-72

DATA SHEET 1 (Cont.)

(13) Medium Voltage ADC Checkout

Reference Input Voltage	Measured Electrical Unit Output Voltage	Acceptable Electrical Output Unit Voltage
+0.025±0.001 Vdc	<u>0.019</u> Vdc	+0.025±0.010 Vdc
+0.050±0.001	<u>.044</u>	0.050±0.010
+0.100±0.001	<u>.093</u>	0.100±0.010
+1.000±0.001	<u>.992</u>	1.000±0.010
+2.000±0.001	<u>1.994</u>	2.000±0.010
+3.000±0.001	<u>2.996</u>	+3.000±0.010
+4.000±0.001	<u>3.993</u>	+4.000±0.015
+4.900±0.001	<u>4.897</u>	+4.900±0.020



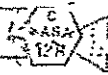
Insp.

Date

1/19/72

DATA SHEET 1 (Cont.)

(15) Medium Voltage Housekeeping Parameter Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Engineering Unit Value
+5V Monitor	A	<u>5.111</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.135</u>	+8.10±0.15
-8V Monitor	A	<u>-8.181</u>	-8.15±0.15
+25V Monitor	A	<u>25.688</u>	+25.50±0.75
+350V Monitor	A	<u>346.33</u>	+350.±15.
-15V Monitor	A	<u>-16.016</u> 	-15.0±1.0 ✓
-5V Monitor	A	<u>-5.401</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.111</u>	+5.00±0.25
+8V Monitor	B	<u>8.135</u>	+8.10±0.15
-8V Monitor	B	<u>-8.166</u>	-8.15±0.15
+25V Monitor	B	<u>25.642</u>	+25.50±0.75
+350V Monitor	B	<u>346.33</u>	+350.±15.
-15V Monitor	B	<u>-15.993</u>	-15.0±1.0
-5V Monitor	B	<u>-5.401</u>	-5.25±0.25
Disc Ref Mon.	B	<u>3.000</u>	+3.000±0.02


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(16)

	Actual Value	Acceptable Value
Heater	<u>25.37</u>	+25.0 ± 0.5 Vdc
Electronics	<u>25.00</u>	+25.0 ± 0.5 Vdc
Detector Bias	<u>25.02</u>	+25.0 ± 0.5 Vdc


 Insp. _____

Date 1/19/72

DATA SHEET 1 (Cont.)


(17) Low Voltage Current Consumption

Current Sink	Measured Current	Acceptable Value
Heater	<u>7 MA</u> ma	10 ± 5 mA
Electronics	<u>543 MA</u> ma	< 560
Detector Bias	<u>21 MA</u> ma	< 50



 Insp. _____ Date 1/19/72

(18) Low Voltage Housekeeping Checkout


Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.111</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.126</u>	+8.10±0.15
-8V Monitor	A	<u>-8.160</u>	-8.15±0.15
+25V Monitor	A	<u>25.588</u>	+25.50±0.75
+350 V Monitor	A	<u>346.33</u>	+350.±15.
-15V Monitor	A	<u>-15.980</u>	-15.0±1.0
-5V Monitor	A	<u>-5.398</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.111</u>	+5.00±0.25
+8V Monitor	B	<u>8.126</u>	+8.10±0.15
-8V Monitor	B	<u>-8.160</u>	-8.15±0.15
+25V Monitor	B	<u>25.588</u>	+25.50±0.75
+350V Monitor	B	<u>346.33</u>	+350.±15.
-15V Monitor	B	<u>-15.957</u>	-15.0±1.0
-5V Monitor	B	<u>-5.398</u>	-5.25±0.25
Disc Ref Mon.	B	<u>3.000</u>	+3.00±0.02


 Insp. _____ Date 1/19/72

DATA SHEET 1 (Cont.)

(19)	Actual Value	Acceptable Value
Heater	<u>29.98</u>	+30.0 ± 0.5 Vdc
Electronics	<u>29.97</u>	+30.0 ± 0.5 Vdc
Detector Bias	<u>30.11</u>	+30.0 ± 0.5 Vdc
		
	Insp.	Date <u>1/19/72</u>

(20) High Voltage Current Consumption

Current Sink	Measured Current	Acceptable Current
Heater	<u>7</u> ma	10 ± 5 mA
Electronics	<u>495</u> mA	≤ 560
Detector Bias	<u>21</u> mA	≤ 30
		
	Insp.	Date <u>1/19/72</u>

DATA SHEET 1 (Cont.)

(21) High Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.111</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.135</u>	+8.10±0.15
-8V Monitor	A	<u>-8.187</u>	-8.15±0.15
+25V Monitor	A	<u>25.588</u>	+25.50±0.75
+350V Monitor	A	<u>346.33</u>	+350.±15.
-15V Monitor	A	<u>-16.029</u>	-15.0±1.0
-5V Monitor	A	<u>-5.417</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.121</u>	+5.00±0.25
+8V Monitor	B	<u>8.145</u>	+8.10±0.15
-8V Monitor	B	<u>-8.187</u>	-8.15±0.15
+25V Monitor	B	<u>25.642</u>	+25.50±0.75
+350V Monitor	B	<u>346.33</u>	+350.±15.
-15V Monitor	B	<u>-16.029</u>	-15.0±1.0
-5V Monitor	B	<u>-5.417</u>	-5.25±0.25
Disc Ref Mon.	B	<u>2.995</u>	+3.00±0.02

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DATA SHEET 1 (Cont.),

(22) Temperature Measurement

Parameter	Prime Frame	Measured Value	Acceptable Limits
Package Temperature Monitor	A	<u>23.36</u> °C	
Package Temperature Monitor	B	<u>23.45</u>	
Detector Plate Temperature Monitor	A	<u>20.72</u>	61°F to 75°F = 16°C to 24°C ↓
Detector Plate Temperature Monitor	B	<u>20.72</u>	



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(23) Detector Leakage Current Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>.184</u> μA	1.0 μA
B	<u>.397</u>	2.0 μA
C	<u>1.968</u>	2.0 μA
D	<u>1.545</u>	2.0 μA
E	<u>1.516</u>	2.0 μA




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DATA SHEET 1 (Cont.)


(24) Detector Resolution Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>7</u> keV	50. keV
B	<u>6</u>	50. keV
C	<u>7.5</u>	50. keV
D	<u>12.5</u>	50. keV
E	<u>6.5</u>	50. keV


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(27) Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 14 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>14</u>	14 or 16
B	E2	<u>16</u>	14 or 16
C	E3	<u>14</u>	14 or 16
D	E4	<u>14</u>	14 or 16
E	P6	<u>14</u>	14 or 16


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DATA SHEET 1 (Cont.)

(28) Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>14</u>	14 or 16
B	P2	<u>14</u>	14 or 16
C	P3	<u>14</u>	14 or 16
D	P4	<u>14</u>	14 or 16
E	P5	<u>14</u>	14 or 16



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(30) Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>2032</u>	2032 or 2048
A	E2	<u>2048</u>	2032 or 2048
C	E3	<u>2032</u>	2032 or 2048
D	E4	<u>2032</u>	2032 or 2048
E	P6	<u>2032</u>	2032 or 2048




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DATA SHEET 1 (Cont.)


(31) Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>2032</u>	2032 or 2048
B	P2	<u>2032</u>	2032 or 2048
C	P3	<u>2032</u>	2032 or 2048
D	P4	<u>2032</u>	2032 or 2048
E	P5	<u>2032</u>	2032 or 2048

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(33) Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 262,142 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>260,096</u>	260,096 or 262,144
B	E2	<u>262,144</u>	260,096 or 262,144
C	E3	<u>260,096</u>	260,096 or 262,144
D	E4	<u>260,096</u>	260,096 or 262,144
E	P6	<u>260,096</u>	260,096 or 262,144

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DATA SHEET 1 (Cont.)

(34) Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>260,096</u>	260,096 or 262,144
B	P2	<u>260,096</u>	260,096 or 262,144
C	P3	<u>260,096</u>	260,096 or 262,144
D	P4	<u>260,096</u>	260,096 or 262,144
E	P6	<u>260,096</u>	260,096 or 262,144


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(36) Electron 1, Electron 2, Electron 3, Electron 4 and
Proton 6 33,554,430 pulse data accumulation test.

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>33,292,288</u>	33,292,288 or 0
B	E2	<u>0</u>	33,292,288 or 0
C	E3	<u>33,292,288</u>	33,292,288 or 0
D	E4	<u>38 -</u>	33,292,288 or 0
E	P6	<u>33,292,288</u>	33,292,288 or 0

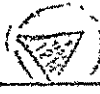

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DATA SHEET 1 (Cont.)

(37) Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
33,554,430 pulse data accumulation test .

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>33,292,288</u>	33,292,288 or 0
B	P2	<u>33,292,288</u>	33,292,288 or 0
C	P3	<u>33,292,288</u>	33,292,288 or 0
D	P4	<u>0</u>	33,292,288 or 0
E	P5	<u>33,292,288</u>	33,292,288 or 0


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DATA SHEET 2
THERMAL CYCLE TEST

(40) Temperature Transition to $+102^{\circ}\text{F} = +38.9^{\circ}\text{C}$ 33.3
44.5

Rosemount Temperature Value	Package Temperature Monitor Value	Detector Plate Temperature Monitor Value	Elapsed Time	
<u>19.9°C °C</u>	<u>23.5°C °C</u>	<u>20.7 °C</u>	<u>0</u> Min.	2200
<u>37</u>	<u>33.2 33.2</u>	<u>35.7</u>	<u>30</u>	2230
<u>35</u>	<u>37.7</u>	<u>35.6</u>	<u>60</u>	2308
<u>32.7</u>	<u>33.2 42.4</u>	<u>38.0</u>		0912

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(42) Repeat steps 6 through 37 at $+102 \pm 10^{\circ}\text{F}$.


(6) Heater Power

Measured Value

27.54

Acceptable Value

$+27.5 \pm 0.5 \text{ Vdc}$

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(7) Medium Voltage Heater Current

Measured Value

7 ma ma

Acceptable Value

$10 \pm 5 \text{ mA}$


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DATA SHEET 2 (Cont.)

(8) Electronic Power

Measured Value
27.44

Acceptable Value
 $+27.5 \pm 0.5$ Vdc

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(9) Medium Voltage Electronics Current

Measured Value
5.14 ma

Maximum Value
560 mA

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(10) Detector Bias

Measured Value

Acceptable Value
 $+27.5 \pm 0.5$ Vdc

~~Det Plate Temp. $> 25^{\circ}C$ Insp. _____ Date _____~~

(11) Medium Voltage Detector Bias Current

Measured Value
_____ ma

Maximum Value
30 mA

Insp. _____ Date _____

~~Bias Supply off.
Ref page 5 caution~~

DATA SHEET 2 (Cont.)

(13) Medium Voltage ADC Checkout

Reference Input Voltage	Measured Electrical Unit Output Voltage	Acceptable Electrical Output Unit Voltage
+0.025±0.001 Vdc	<u>.019</u> Vdc	+0.025±0.010 Vdc
+0.050±0.001	<u>.044</u>	0.050±0.010
+0.100±0.001	<u>.093</u>	0.100±0.010
+1.000±0.001	<u>.997</u>	1.000±0.010
+2.000±0.001	<u>1.999</u>	2.000±0.010
+3.000±0.001	<u>2.996</u>	+3.000±0.010
+4.000±0.001	<u>3.998</u>	+4.000±0.015
+4.900±0.001	<u>4.897</u>	+4.900±0.020



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DATA SHEET 2 (Cont.)

(15) Medium Voltage Housekeeping Parameter Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Engineering Unit Value
+5V Monitor	A	<u>5.151</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.165</u>	+8.10±0.15
-8V Monitor	A	<u>8.215</u>	-8.15±0.15
+25V Monitor	A	<u>25.694</u>	+25.50±0.75
+350V Monitor	A	<u>24.243</u>	+350.±15. ✓ <i>BUS OFF</i>
-15V Monitor	A	<u>-15.964</u>	-15.0±1.0 <i>PLATE TEMP > 25°C</i>
-5V Monitor	A	<u>-5.449</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.151</u>	+5.00±0.25
+8V Monitor	B	<u>8.165</u>	+8.10±0.15
-8V Monitor	B	<u>8.199</u>	-8.15±0.15
+25V Monitor	B	<u>25.750</u>	+25.50±0.75
+350V Monitor	B	<u>24.243</u>	+350.±15. ✓
-15V Monitor	B	<u>-15.964</u>	-15.0±1.0
-5V Monitor	B	<u>5.436</u>	-5.25±0.25
Disc Ref Mon.	B	<u>3.000</u>	+3.000±0.02

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(16)	Actual Value	Acceptable Value
Heater	<u>25.37</u>	+25.0 ± 0.5 Vdc
Electronics	<u>25.01</u>	+25.0 ± 0.5 Vdc
Detector Bias	<u>OFF</u>	+25.0 ± 0.5 Vdc

ReS: Page 5 Caution  1/20/72
Insp. Date

DATA SHEET 2 (Cont.)

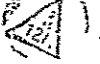
(17) Low Voltage Current Consumption

Current Sink	Measured Current	Acceptable Value
Heater	<u>7 ma</u> ma	10 ± 5 mA
Electronics	<u>547</u> ma	≤ 560
Detector Bias	<u>OFF</u> ma	≤ 50


Ref Page 5 Caution  Insp. 1/20/72 Date

(18) Low Voltage Housekeeping Checkout


Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.141</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.155</u>	+8.10±0.15
-8V Monitor	A	<u>-8.209</u>	-8.15±0.15 <i>Ref Page 5 Caution</i>
+25V Monitor	A	<u>25.696</u>	+25.50±0.75
+350 V Monitor	A	<u>24.243</u>	+350.±15. <i>OFF - DET. MAX T = 25°C</i>
-15V Monitor	A	<u>-15.951</u>	-15.0±1.0 —
-5V Monitor	A	<u>-5.433</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.141</u>	+5.00±0.25
+8V Monitor	B	<u>8.155</u>	+8.10±0.15
-8V Monitor	B	<u>-8.193</u>	-8.15±0.15
+25V Monitor	B	<u>25.696</u>	+25.50±0.75
+350V Monitor	B	<u>24.243</u>	+350.±15.
-15V Monitor	B	<u>-15.951</u>	-15.0±1.0 —
-5V Monitor	B	<u>-5.433</u>	-5.25±0.25
Disc Ref Mon.	B	<u>3.000</u>	+3.00±0.02

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DATA SHEET 2 (Cont.)

(19)	Actual Value	Acceptable Value
Heater	<u>29.98</u>	+30.0 ± 0.5 Vdc
Electronics	<u>29.97</u>	+30.0 ± 0.5 Vdc
Detector Bias	<u>OFF</u>	+30.0 ± 0.5 Vdc
<i>Ref Page 5 Caution</i> 		
	Insp.	Date <u>1/20/72</u>


(20) High Voltage Current Consumption

Current Sink	Measured Current	Acceptable Current
Heater	<u>7</u> ma	10 ± 5 mA
Electronics	<u>490</u> ma	≤ 560
Detector Bias	<u>OFF</u>	≤ 30
<i>Ref Page 5 Caution</i> 		
	Insp.	Date <u>1/20/72</u>

DATA SHEET 2 (Cont.)

(21) High Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.151</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.165</u>	+8.10±0.15
-8V Monitor	A	<u>-8.221</u>	-8.15±0.15
+25V Monitor	A	<u>25.750</u>	+25.50±0.75
+350V Monitor	A	<u>24.243</u>	+350.±15. DEF RAZ TEMP 72.5°C
-15V Monitor	A	<u>-16.023</u>	-15.0±1.0
-5V Monitor	A	<u>-5.452</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.151</u>	+5.00±0.25
+8V Monitor	B	<u>8.174</u>	+8.10±0.15
-8V Monitor	B	<u>-8.221</u>	-8.15±0.15
+25V Monitor	B	<u>25.750</u>	+25.50±0.75
+350V Monitor	B	<u>24.243</u>	+350.±15.
-15V Monitor	B	<u>-16.000</u>	-15.0±1.0
-5V Monitor	B	<u>-5.452</u>	-5.25±0.25
Disc Ref Mon.	B	<u>3.000</u>	+3.00±0.02


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DATA SHEET 2 (Cont.)

(22) Temperature Measurement

Parameter	Prime Frame	Measured Value	Acceptable Limits
Package Temperature Monitor	A	<u>41.7</u> °C	92°F to 112°F = 33.3°C to 44.4°C
Package Temperature Monitor	B	<u>41.7</u>	↓
Detector Plate Temperature Monitor	A	<u>35.6</u>	_____
Detector Plate Temperature Monitor	B	<u>35.6</u>	_____




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NOTE: DET BIAS OFF ∴ READINGS ARE FOR 25 VOLTS APPLIED TO DETECTOR

(23) Detector Leakage Current Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>.194</u> μA	1.0 μA
B	<u>.433</u>	2.0 μA
C	<u>.985</u>	2.0 μA
D	<u>.138</u>	2.0 μA
E	<u>.432</u>	2.0 μA

Ref Page 5 Caution



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DATA SHEET 2 (Cont.)

DET PLATE TEMP > 25°C DET BIAS OFF

(24) Detector Resolution Test 25 UNITS APPLICABLE TO DET.


EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>10</u> keV	50. keV
B	<u>10</u>	50. keV
C	<u>7.5</u>	50. keV
D	<u>9</u>	50. keV
E	<u>8</u>	50. keV

Ref Page 5 Caution


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(27) Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 14 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>14</u>	14 or 16
B	E2	<u>16</u>	14 or 16
C	E3	<u>14</u>	14 or 16
D	E4	<u>14</u>	14 or 16
E	P6	<u>14</u>	14 or 16


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DATA SHEET 2 (Cont.)


(28) Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>14</u>	14 or 16
B	P2	<u>14</u>	14 or 16
C	P3	<u>14</u>	14 or 16
D	P4	<u>14</u>	14 or 16
E	P5	<u>14</u>	14 or 16


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(30) Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6
2046 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>2032</u>	2032 or 2048
A	E2	<u>2048</u>	2032 or 2048
C	E3	<u>2032</u>	2032 or 2048
D	E4	<u>2032</u>	2032 or 2048
E	P6	<u>2032</u>	2032 or 2048


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DATA SHEET 2 (Cont.)

(31) Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>2032</u>	2032 or 2048
B	P2	<u>2032</u>	2032 or 2048
C	P3	<u>2032</u>	2032 or 2048
D	P4	<u>2032</u>	2032 or 2048
E	P5	<u>2032</u>	2032 or 2048


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(33) Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 262,142 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>260 096</u>	260,096 or 262,144
B	E2	<u>260 096</u>	260,096 or 262,144
C	E3	<u>260 096</u>	260,096 or 262,144
D	E4	<u>260 096</u>	260,096 or 262,144
E	P6	<u>260 096</u>	260,096 or 262,144


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DATA SHEET 2 (Cont.)


(34) Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>260 096</u>	260,096 or 262,144
B	P2	<u>260 096</u>	260,096 or 262,144
C	P3	<u>260 096</u>	260,096 or 262,144
D	P4	<u>260 096</u>	260,096 or 262,144
E	P6	<u>260 096</u>	260,096 or 262,144

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(36) Electron 1, Electron 2, Electron 3, Electron 4 and
Proton 6 33,554,430 pulse data accumulation test.

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>0</u>	33,292,288 or 0
B	E2	<u>118</u>	33,292,288 or 0
C	E3	<u>0</u>	33,292,288 or 0
D	E4	<u>33,292,288</u>	33,292,288 or 0
E	P6	<u>33,292,288</u>	33,292,288 or 0


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DATA SHEET 2 (Cont.)

(37) Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
33,554,430 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>33,292,288</u>	33,292,288 or 0
B	P2	<u>33,292,288</u>	33,292,288 or 0
C	P3	<u>33,292,288</u>	33,292,288 or 0
D	P4	<u>0</u>	33,292,288 or 0
E	P5	<u>33,292,288</u>	33,292,288 or 0


Insp.


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Date

DATA SHEET 2 (Cont.)

-11.1
-22.3

(43) Temperature Transition to +2°F = -16.7°C

Rosemount Temperature Value	Package Temperature Monitor Value	Detector Plate Temperature Monitor Value	Elapsed Time	
<u>32</u>	<u>34.4 34.4°C</u>	<u>22 °C</u>	<u>0</u> Min.	0430
<u>-22.3</u>	<u>-11.2</u>	<u>-19.4</u>	<u>90 min</u>	11:00
<u>-20.7</u>	<u>-15.8</u>	<u>-19.6</u>	<u>150 min</u>	12:00
<u>-20.6</u>	<u>-15.2</u>	<u>-19.6</u>	<u>180 min</u>	12:30
<u>-20.6</u>	<u>-15.7</u>	<u>-19.6</u>	<u>210 min</u>	1300
<u>-20.6</u>	<u>-15.6</u>	<u>-19.7</u>	<u>240 min</u>	13:30

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(45) Repeat of steps 6 through 37 at +2 ± 10°F.


(6) Heater Power

Measured Value

27.52

Acceptable Value —

+27.5 ± 0.5 Vdc

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Date

(7) Medium Voltage Heater Current

Measured Value

206 ma ma

Acceptable Value

200 ± 25 mA


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DATA SHEET 2 (Cont.)

(8) Electronic Power

Measured Value
27.44


Acceptable Value
 $+27.5 \pm 0.5$ Vdc

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(9) Medium Voltage Electronics Current

Measured Value
509 ma


Maximum Value
560 mA

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Insp. Date

(10) Detector Bias

Measured Value
27.55

Acceptable Value
 $+27.5 \pm 0.5$ Vdc

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(11) Medium Voltage Detector Bias Current

Measured Value
20 ma


Maximum Value
30 mA

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Insp. Date

DATA SHEET 2 (Cont.)

(13) Medium Voltage ADC Checkout


Reference Input Voltage	Measured Electrical Unit Output Voltage	Acceptable Electrical Output Unit Voltage
+0.025±0.001 Vdc	<u>.024</u> Vdc	+0.025±0.010 Vdc
+0.050±0.001	<u>.048</u>	0.050±0.010
+0.100±0.001	<u>.097</u>	0.100±0.010
+1.000±0.001	<u>.992</u>	1.000±0.010
+2.000±0.001	<u>1.994</u>	2.000±0.010
+3.000±0.001	<u>2.991</u>	+3.000±0.010
+4.000±0.001	<u>3.988</u>	+4.000±0.015
+4.900±0.001	<u>4.887</u>	+4.900±0.020


 Insp. _____ Date 11/20/12

DATA SHEET 2 (Cont.)

(15) Medium Voltage Housekeeping Parameter Checkout


Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Engineering Unit Value
+5V Monitor	A	<u>5.063</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.077</u>	+8.10±0.15
-8V Monitor	A	<u>-8.099</u>	-8.15±0.15
+25V Monitor	A	<u>25.427</u>	+25.50±0.75
+350V Monitor	A	<u>345.84</u>	+350.±15.
-15V Monitor	A	<u>-16.029</u>	-15.0±1.0
-5V Monitor	A	<u>-5.332</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.989</u>	+3.00±0.02
+5V Monitor	B	<u>5.072</u>	+5.00±0.25
+8V Monitor	B	<u>8.077</u>	+8.10±0.15
-8V Monitor	B	<u>-8.083</u>	-8.15±0.15
+25V Monitor	B	<u>25.427</u>	+25.50±0.75
+350V Monitor	B	<u>345.84</u>	+350.±15.
-15V Monitor	B	<u>-16.029</u>	-15.0±1.0
-5V Monitor	B	<u>-5.319</u>	-5.25±0.25
Disc Ref Mon.	B	<u>2.989</u>	+3.000±0.02

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DR # EPS-0021


(16)

	Actual Value	Acceptable Value
Heater	<u>25.36</u>	+25.0 ± 0.5 Vdc
Electronics	<u>25.01</u>	+25.0 ± 0.5 Vdc
Detector Bias	<u>25.02</u>	+25.0 ± 0.5 Vdc


Insp.  Date 1-20-72

DATA SHEET 2 (Cont.)

(17) Low Voltage Current Consumption

Current Sink	Measured Current	Acceptable Value
Heater	<u>190</u> ma	180 ± 25 mA
Electronics	<u>549</u> ma	≤ 560
Detector Bias	<u>20</u> ma	≤ 50
Insp.		Date <u>1-20-72</u>

(18) Low Voltage Housekeeping Checkout


Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.053</u> vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.067</u>	+8.10±0.15
-8V Monitor	A	<u>-8.093</u>	-8.15±0.15
+25V Monitor	A	<u>25.373</u>	+25.50±0.75
+350 V Monitor	A	<u>345.84</u>	+350.±15.
-15V Monitor	A	<u>-16.016</u>	-15.0±1.0 
-5V Monitor	A	<u>-5.329</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.989</u>	+3.00±0.02
+5V Monitor	B	<u>5.063</u>	+5.00±0.25
+8V Monitor	B	<u>8.067</u>	+8.10±0.15
-8V Monitor	B	<u>-8.093</u>	-8.15±0.15
+25V Monitor	B	<u>25.373</u>	+25.50±0.75
+350V Monitor	B	<u>345.84</u>	+350.±15.
-15V Monitor	B	<u>-15.993</u>	-15.0±1.0
-5V Monitor	B	<u>-5.316</u>	-5.25±0.25
Disc Ref Mon.	B	<u>2.989</u>	+3.00±0.02

DR # F-105-0071

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DATA SHEET 2 (Cont.)

(19)	Actual Value	Acceptable Value
Heater	<u>29.96</u>	+30.0 ± 0.5 Vdc
Electronics	<u>29.97</u>	+30.0 ± 0.5 Vdc
Detector Bias	<u>30.11</u>	+30.0 ± 0.5 Vdc


 Insp. _____ Date 1-20-72

(20) High Voltage Current Consumption

Current Sink	Measured Current	Acceptable Current
Heater	<u>225</u> ma	225 ± 25 mA.
Electronics	<u>490</u>	≤ 560
Detector Bias	<u>20</u>	≤ 30


 Insp. _____ Date 1-20-72

DATA SHEET 2 (Cont.)

(21) High Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.053</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.077</u>	+8.10±0.15
-8V Monitor	A	<u>-8.120</u>	-8.15±0.15
+25V Monitor	A	<u>25.427</u>	+25.50±0.75
+350V Monitor	A	<u>345.84</u>	+350.±15.
-15V Monitor	A	<u>-16.065</u>	-15.0±1.0
-5V Monitor	A	<u>-5.348</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.983</u>	+3.00±0.02
+5V Monitor	B	<u>5.063</u>	+5.00±0.25
+8V Monitor	B	<u>8.086</u>	+8.10±0.15
-8V Monitor	B	<u>-8.105</u>	-8.15±0.15
+25V Monitor	B	<u>25.427</u>	+25.50±0.75
+350V Monitor	B	<u>345.84</u>	+350.±15.
-15V Monitor	B	<u>-16.042</u>	-15.0±1.0
-5V Monitor	B	<u>-5.335</u>	-5.25±0.25
Disc Ref Mon.	B	<u>2.989</u>	+3.00±0.02



Insp.


1-20-72
Date

DOR # EPS-0071

DATA SHEET 2 (Cont.)


(22) Temperature Measurement

Parameter	Prime Frame	Measured Value	Acceptable Limits
Package Temperature Monitor	A	<u>-15.642 °C</u>	-8°F to +12°F = -22.2°C to -11.1°C
Package Temperature Monitor	B	<u>-15.642</u>	↓
Detector Plate Temperature Monitor	A	<u>-19.649</u>	XXXXXXXXXX
Detector Plate Temperature Monitor	B	<u>-19.552</u>	XXXXXXXXXX


 Insp. _____ Date 1/20/72

(23) Detector Leakage Current Test


EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>.006</u> μA	1.0 μA
B	<u>.011</u>	2.0 μA
C	.011 <u>.092</u>	2.0 μA
D	<u>.025</u>	2.0 μA
E	<u>.013</u>	2.0 μA


 Insp. _____ Date 1/20/72

DATA SHEET 2 (Cont.)


(24) Detector Resolution Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>6</u> keV	50. keV
B	<u>4</u>	50. keV
C	<u>5</u>	50. keV
D	<u>7</u>	50. keV
E	<u>6.5</u>	50. keV


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(27) Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>14</u>	14 or 16
B	E2	<u>16</u>	14 or 16
C	E3	<u>14</u>	14 or 16
D	E4	<u>16</u>	14 or 16
E	P6	<u>14</u>	14 or 16


 Insp. _____ Date 4/20/72

DATA SHEET 2 (Cont.)

(28) Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>14</u>	14 or 16
B	P2	<u>14</u>	14 or 16
C	P3	<u>14</u>	14 or 16
D	P4	<u>14</u>	14 or 16
E	P5	<u>14</u>	14 or 16

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(30) Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable
A	E1	<u>2032</u>	2032 or 2048
A	E2	<u>2048</u>	2032 or 2048
C	E3	<u>2032</u>	2032 or 2048
D	E4	<u>2032</u>	2032 or 2048
E	P6	<u>2032</u>	2032 or 2048

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DATA SHEET 2 (Cont.)

(31) Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>2032</u>	2032 or 2048
B	P2	<u>2032</u>	2032 or 2048
C	P3	<u>2032</u>	2032 or 2048
D	P4	<u>2032</u>	2032 or 2048
E	P5	<u>2032</u>	2032 or 2048



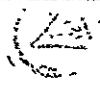
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(33) Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>260 096</u>	260,096 or 262,144
B	E2	<u>262 144</u>	260,096 or 262,144
C	E3	<u>260 096</u>	260,096 or 262,144
D	E4	<u>262 144</u>	260,096 or 262,144
E	P6	<u>260 096</u>	260,096 or 262,144



Insp.


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DATA SHEET 2 (Cont.)

(34) Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
262,142 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>260 096</u>	260,096 or 262,144
B	P2	<u>260 096</u>	260,096 or 262,144
C	P3	<u>260 096</u>	260,096 or 262,144
D	P4	<u>260 096</u>	260,096 or 262,144
E	P6	<u>262 144</u>	260,096 or 262,144


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(36) Electron 1, Electron 2, Electron 3, Electron 4 and
Proton 6 33,554,430 pulse data accumulation test.

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>33,292,288</u>	33,292,288 or 0
B	E2	<u>0</u>	33,292,288 or 0
C	E3	<u>0</u>	33,292,288 or 0
D	E4	<u>33,292,288</u>	33,292,288 or 0
E	P6	<u>33,292,288</u>	33,292,288 or 0


START 2:08


 Insp. _____ Date 1/20/72

DATA SHEET 2 (Cont.)

(37) Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
 33,554,430 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>33,292,288</u>	33,292,288 or 0
B	P2	<u>33,292,288</u>	33,292,288 or 0
C	P3	<u>33,292,288</u>	33,292,288 or 0
D	P4	<u>33,292,288</u>	33,292,288 or 0
E	P5	<u>33,292,288</u>	33,292,288 or 0


 _____ 1/20/72
 Insn Date

DATA SHEET 2 (Cont.)

(46) Temperature Transition to +102°F = +38.9°C 33.3
44.5

Rosemount Temperature Value	Package Temperature Monitor Value	Detector Plate Temperature Monitor Value	Elapsed Time	START
<u>39.8</u>	<u>33.5</u> °C	<u>37.8</u> °C	<u>0</u>	1620
<u>40.7</u>	<u>42.3</u>	<u>41.7</u>	<u>45</u>	1705
<u>35.7</u>	<u>37.6</u>	<u>40.9</u>	<u>108</u>	1808


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(48) Repeat of steps 6 through 37 at +102 ± 10°F.


(6) Heater Power

Measured Value

27.54

Acceptable Value

+27.5 ± 0.5 Vdc


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(7) Medium Voltage Heater Current

Measured Value

7 ma

Acceptable Value

10 ± 5 mA


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. DATA SHEET 2 (Cont.)


(8) Electronic Power

Measured Value

27.44

Acceptable Value

+27.5 ± 0.5 Vdc

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(9) Medium Voltage Electronics Current

Measured Value

515 ma

Maximum Value

560 mA

Insp. 

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~~(10) Detector Bias~~

~~Measured Value~~

~~_____~~

~~Acceptable Value~~

~~+27.5 ± 0.5 Vdc~~

~~Insp.~~

~~Date~~

~~(11) Medium Voltage Detector Bias Current~~

~~Measured Value~~

~~ma~~

~~Maximum Value~~

~~30 mA~~

~~Insp.~~

~~Date~~

Det Bias OFF
Ref Page 5 Caution

DATA SHEET 2 (Cont.)

(13) Medium Voltage ADC Checkout

Reference Input Voltage	Measured Electrical Unit Output Voltage	Acceptable Electrical Output Unit Voltage
+0.025±0.001 Vdc	<u>.019</u> Vdc	+0.025±0.010 Vdc
+0.050±0.001	<u>.044</u>	0.050±0.010
+0.100±0.001	<u>.097</u>	0.100±0.010
+1.000±0.001	<u>.997</u>	1.000±0.010
+2.000±0.001	<u>1.999</u>	2.000±0.010
+3.000±0.001	<u>3.000</u>	+3.000±0.010
+4.000±0.001	<u>3.998</u>	+4.000±0.015
+4.900±0.001	<u>4.897</u>	+4.900±0.020


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DATA SHEET 2 (Cont.)

(15) Medium Voltage Housekeeping Parameter Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Engineering Unit Value
+5V Monitor	A	<u>5.141</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.165</u>	+8.10±0.15
-8V Monitor	A	<u>-8.215</u>	-8.15±0.15
+25V Monitor	A	<u>25.696</u>	+25.50±0.75
+350V Monitor	A	<u>24.24</u>	+350.±15.
-15V Monitor	A	<u>-15.989</u>	-15.0±1.0
-5V Monitor	A	<u>-5.449</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.141</u>	+5.00±0.25
+8V Monitor	B	<u>8.165</u>	+8.10±0.15
-8V Monitor	B	<u>-8.215</u>	-8.15±0.15
+25V Monitor	B	<u>25.696</u>	+25.50±0.75
+350V Monitor	B	<u>24.24</u>	+350.±15.
-15V Monitor	B	<u>-15.987</u>	-15.0±1.0
-5V Monitor	B	<u>-5.436</u>	-5.25±0.25
Disc Ref Mon.	B	<u>3.000</u>	+3.000±0.02


*Det Bias off
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(16)


	Actual Value	Acceptable Value
Heater	<u>25.37</u>	+25.0 ± 0.5 Vdc
Electronics	<u>25.00</u>	+25.0 ± 0.5 Vdc
Detector Bias	<u>OFF</u>	+25.0 ± 0.5 Vdc

*Ref Page 5
Caution*

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DATA SHEET 2 (Cont.)

(17) Low Voltage Current Consumption


Current Sink	Measured Current	Acceptable Value
Heater	<u>7</u> ma	10 ± 5 mA
Electronics	<u>544</u> ma	≤ 560
Detector Bias	<u>OFF</u> ma	≤ 50
 Insp.		<u>1-20-72</u> Date

*Ref Page 5
Caution*

(18) Low Voltage Housekeeping Checkout


Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.131</u> vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.155</u>	+8.10±0.15
-8V Monitor	A	<u>-8.209</u>	-8.15±0.15
+25V Monitor	A	<u>25.696</u>	+25.50±0.75
+350 V Monitor	A	<u>24.24</u>	+350.±15.
-15V Monitor	A	<u>-15.974</u>	-15.0±1.0
-5V Monitor	A	<u>-5.433</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.141</u>	+5.00±0.25
+8V Monitor	B	<u>8.155</u>	+8.10±0.15
-8V Monitor	B	<u>-8.193</u>	-8.15±0.15
+25V Monitor	B	<u>25.696</u>	+25.50±0.75
+350V Monitor	B	<u>24.24</u>	+350.±15.
-15V Monitor	B	<u>-15.951</u>	-15.0±1.0
-5V Monitor	B	<u>-5.433</u>	-5.25±0.25
Disc Ref Mon.	B	<u>3.000</u>	+3.00±0.02

*Ref Page 5
Caution*


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DATA SHEET 2 (Cont.)

(19)	Actual Value	Acceptable Value
Heater	<u>29.98</u>	+30.0 ± 0.5 Vdc
Electronics	<u>29.97</u>	+30.0 ± 0.5 Vdc
Detector Bias	<u>OFF</u>	+30.0 ± 0.5 Vdc

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(20) High Voltage Current Consumption

Current Sink	Measured Current	Acceptable Current
Heater	<u>7</u> ma	10 ± 5 mA
Electronics	<u>490</u>	≤ 560
Detector Bias	<u>OFF</u>	≤ 30

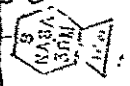
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DATA SHEET 2 (Cont.)

(21) High Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.141</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.165</u>	+8.10±0.15
-8V Monitor	A	<u>-8.236</u>	-8.15±0.15
+25V Monitor	A	<u>25.696</u>	+25.50±0.75
+350V Monitor	A	<u>24.24</u>	+350.±15.
-15V Monitor	A	<u>-16.023</u>	-15.0±1.0
-5V Monitor	A	<u>-5.452</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.151</u>	+5.00±0.25
+8V Monitor	B	<u>8.174</u>	+8.10±0.15
-8V Monitor	B	<u>-8.221</u>	-8.15±0.15
+25V Monitor	B	<u>25.750</u>	+25.50±0.75
+350V Monitor	B	<u>24.29</u>	+350.±15.
-15V Monitor	B	<u>-16.023</u>	-15.0±1.0
-5V Monitor	B	<u>-5.452</u>	-5.25±0.25
Disc Ref Mon.	B	<u>3.000</u>	+3.00±0.02

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
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DATA SHEET 2 (Cont.)


(22) Temperature Measurement

Parameter	Prime Frame	Measured Value	Acceptable Limits
Package Temperature Monitor	A	<u>40.66°C</u>	92°F to 112°F = 33.3°C to 44.4°C
Package Temperature Monitor	B	<u>40.66</u>	↓
Detector Plate Temperature Monitor	A	<u>37.53</u>	
Detector Plate Temperature Monitor	B	<u>37.53</u>	

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(23) *Ref Bias OFF - Bias Applied = 25V*
Detector Leakage Current Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>.216</u> μA	1.0 μA
B	<u>.459</u>	2.0 μA
C	<u>1.100</u>	2.0 μA
D	<u>.738</u>	2.0 μA
E	<u>.504</u>	2.0 μA

Ref Page 5 Caution
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DATA SHEET 2 (Cont.)

(24) Detector Resolution Test


Def Bias Ref off Page 5 Caution

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>7</u> keV	50. keV
B	<u>5</u>	50. keV
C	<u>5</u>	50. keV
D	<u>9</u>	50. keV
E	<u>7</u>	50. keV

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(27) Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>14</u>	14 or 16
B	E2	<u>16</u>	14 or 16
C	E3	<u>14</u>	14 or 16
D	E4	<u>22,784</u>	14 or 16
E	P6	<u>14</u>	14 or 16

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DATA SHEET 2 (Cont.)

(28) Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>14</u>	14 or 16
B	P2	<u>14</u>	14 or 16
C	P3	<u>14</u>	14 or 16
D	P4	<u>172</u>	14 or 16
E	P5	<u>14</u>	14 or 16


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(30) Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 2046 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable
A	E1	<u>2032</u>	2032 or 2048
A	E2	<u>2032</u>	2032 or 2048
C	E3	<u>2032</u>	2032 or 2048
D	E4	<u>18688</u>	2032 or 2048
E	P6	<u>2032</u>	2032 or 2048


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DATA SHEET 2 (Cont.)

(31) Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
2046 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>2032</u>	2032 or 2048
B	P2	<u>2032</u>	2032 or 2048
C	P3	<u>2032</u>	2032 or 2048
D	P4	<u>2048</u>	2032 or 2048
E	P5	<u>2032</u>	2032 or 2048



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(33) Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>260096</u>	260,096 or 262,144
B	E2	<u>262144</u>	260,096 or 262,144
C	E3	<u>260096</u>	260,096 or 262,144
D	E4	<u>260096</u>	260,096 or 262,144
E	P6	<u>260096</u>	260,096 or 262,144




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DATA SHEET 2 (Cont.)


(34) Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>260 096</u>	260,096 or 262,144
B	P2	<u>260 096</u>	260,096 or 262,144
C	P3	<u>260 096</u>	260,096 or 262,144
D	P4	<u>260 096</u>	260,096 or 262,144
E	P6	<u>260 096</u>	260,096 or 262,144

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(36) Electron 1, Electron 2, Electron 3, Electron 4 and
Proton 6 33,554,430 pulse data accumulation test.

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>33,292,288</u>	33,292,288 or 0
B	E2	<u>0</u>	33,292,288 or 0
C	E3	<u>33,292,288</u>	33,292,288 or 0
D	E4	<u>880</u>	33,292,288 or 0
E	P6	<u>0</u>	33,292,288 or 0

 1-20-72
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DATA SHEET 2 (Cont.)

(37) Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
33,554,430 pulse data accumulation test.

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>33,292,288</u>	33,292,288 or 0
B	P2	<u>33,292,288</u>	33,292,288 or 0
C	P3	<u>33,292,288</u>	33,292,288 or 0
D	P4	<u>0</u>	33,292,288 or 0
E	P5	<u>33,292,288</u>	33,292,288 or 0



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DATA SHEET 2 (Cont.)

(49) Temperature Transition to +70°F = +21.1°C ^{11.5} 26.7

Rosemount Temperature Value	Package Temperature Monitor Value	Detector Plate Temperature Monitor Value	Elapsed Time
<u>30.6</u> °C	<u>40.4</u> °C	<u>35.4</u> °C	<u>5</u> Min. 20:05
<u>16.8</u>	<u>30.1</u>	<u>21.0</u>	<u>30</u> 20:30
<u>16.5</u>	<u>26.5</u>	<u>19.5</u>	<u>45</u> 20:45
<u>16.9</u>	<u>21.3</u>	<u>18.2</u>	07:45


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(51) Repeat of steps 6 through 37 at +70 ± 10°F

(6) Heater Power

Measured Value
27.53


Acceptable Value
+27.5 ± 0.5 Vdc

 Insp. 1-21-72 Date

(7) Medium Voltage Heater Current

Measured Value
7 ma

Acceptable Value
10 ± 5 mA

 Insp. 1-21-72 Date

DATA SHEET 2 (Cont.)

(8) Electronic Power

Measured Value

27.44

Acceptable Value

 $+27.5 \pm 0.5$ Vdc

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Date

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(9) Medium Voltage Electronics Current

Measured Value

510 ma

Maximum Value

560 mA

Insp.

Date

1-21-72

(10) Detector Bias

Measured Value

27.55

Acceptable Value

 $+27.5 \pm 0.5$ Vdc

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Date

1-21-72

(11) Medium Voltage Detector Bias Current

Measured Value

20 ma

Maximum Value

30 mA

Insp.

Date

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DATA SHEET 2 (Cont.)

(13) Medium Voltage ADC Checkout

Reference Input Voltage	Measured Electrical Unit Output Voltage	Acceptable Electrical Output Unit Voltage
+0.025±0.001 Vdc	<u>.024</u> Vdc	+0.025±0.010 Vdc
+0.050±0.001	<u>.048</u>	0.050±0.010
+0.100±0.001	<u>.097</u>	0.100±0.010
+1.000±0.001	<u>0.997</u>	1.000±0.010
+2.000±0.001	<u>1.994</u>	2.000±0.010
+3.000±0.001	<u>2.996</u>	+3.000±0.010
+4.000±0.001	<u>3.998</u>	+4.000±0.015
+4.900±0.001	<u>4.897</u>	+4.900±0.020



Insp.

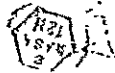
Date

1-21-72

DATA SHEET 2 (Cont.)

(15) Medium Voltage Housekeeping Parameter Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Engineering Unit Value
+5V Monitor	A	<u>5.111</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.135</u>	+8.10±0.15
-8V Monitor	A	<u>-8.181</u>	-8.15±0.15
+25V Monitor	A	<u>25.588</u>	+25.50±0.75
+350V Monitor	A	<u>346.33</u>	+350.±15.
-15V Monitor	A	<u>-16.039</u>	-15.0±1.0
-5V Monitor	A	<u>-5.401</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.111</u>	+5.00±0.25
+8V Monitor	B	<u>8.135</u>	+8.10±0.15
-8V Monitor	B	<u>-8.166</u>	-8.15±0.15
+25V Monitor	B	<u>25.642</u>	+25.50±0.75
+350V Monitor	B	<u>346.33</u>	+350.±15.
-15V Monitor	B	<u>-16.016</u>	-15.0±1.0
-5V Monitor	B	<u>-5.401</u>	-5.25±0.25
Disc Ref Mon.	B	<u>2.995</u>	+3.000±0.02



 Insp. _____ Date 1-21-72

(16)	Actual Value	Acceptable Value
Heater	<u>25.36</u>	+25.0 ± 0.5 Vdc
Electronics	<u>25.00</u>	+25.0 ± 0.5 Vdc
Detector Bias	<u>25.02</u>	+25.0 ± 0.5 Vdc



 Insp. _____ Date 1-21-72

DATA SHEET 2 (Cont.)

(17) Low Voltage Current Consumption


Current Sink	Measured Current	Acceptable Value
Heater	<u>7</u> ma	10 ± 5 mA
Electronics	<u>540</u> ma	< 560
Detector Bias	<u>20</u> ma	< 50
Insp.		<u>1-21-72</u> Date

(18) Low Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.102</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.126</u>	+8.10±0.15
-8V Monitor	A	<u>-8.160</u>	-8.15±0.15
+25V Monitor	A	<u>25.588</u>	+25.50±0.75
+350 V Monitor	A	<u>346.33</u>	+350.±15.
-15V Monitor	A	<u>-15.98</u>	-15.0±1.0 ✓
-5V Monitor	A	<u>-5.398</u>	-5.25±0.25
Disc Ref Mon.	A	<u>+2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.111</u>	+5.00±0.25
+8V Monitor	B	<u>8.126</u>	+8.10±0.15
-8V Monitor	B	<u>-8.160</u>	-8.15±0.15
+25V Monitor	B	<u>25.588</u>	+25.50±0.75
+350V Monitor	B	<u>346.33</u>	+350.±15.
-15V Monitor	B	<u>-15.98</u>	-15.0±1.0 ✓
-5V Monitor	B	<u>-5.398</u>	-5.25±0.25
Disc Ref Mon.	B	<u>+2.995</u>	+3.00±0.02
Insp.		<u>1-21-72</u> Date	


DATA SHEET 2 (Cont.)

(19)	Actual Value	Acceptable Value
Heater	<u>29.98</u>	+30.0 ± 0.5 Vdc
Electronics	<u>29.97</u>	+30.0 ± 0.5 Vdc
Detector Bias	<u>30.11</u>	+30.0 ± 0.5 Vdc


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(20) High Voltage Current Consumption


Current Sink	Measured Current	Acceptable Current
Heater	<u>7</u> ma	10 ± 5 mA
Electronics	<u>490</u>	≤ 560
Detector Bias	<u>20</u>	≤ 30


Insp. 1-21-72
 Date

DATA SHEET '2 (Cont.)

(21) High Voltage Housekeeping Checkout

Parameter.	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.111</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.135</u>	+8.10±0.15
-8V Monitor	A	<u>-8.166</u>	-8.15±0.15
+25V Monitor	A	<u>25.588</u>	+25.50±0.75
+350V Monitor	A	<u>346.33</u>	+350.±15.
-15V Monitor	A	<u>-16.016</u>	-15.0±1.0
-5V Monitor	A	<u>-5.400</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.111</u>	+5.00±0.25
+8V Monitor	B	<u>8.135</u>	+8.10±0.15
-8V Monitor	B	<u>-8.166</u>	-8.15±0.15
+25V Monitor	B	<u>25.642</u>	+25.50±0.75
+350V Monitor	B	<u>346.33</u>	+350.±15.
-15V Monitor	B	<u>-15.993</u>	-15.0±1.0
-5V Monitor	B	<u>-5.401</u>	-5.25±0.25
Disc Ref Mon.	B	<u>2.995</u>	+3.00±0.02


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DATA SHEET 2 (Cont.)

(22) Temperature Measurement

Parameter	Prime Frame	Measured Value	Acceptable Limits
Package Temperature Monitor	A	<u>21.3</u> °C	60°F-80°F = 15.5°C-26.7°C
Package Temperature Monitor	B	<u>21.3</u>	↓
Detector Plate Temperature Monitor	A	<u>18.2</u>	XXXX
Detector Plate Temperature Monitor	B	<u>18.2</u>	XXXX



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(23) Detector Leakage Current Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>201</u> μA	1.0 μA
B	<u>328</u>	2.0 μA
C	<u>1.871</u>	2.0 μA
D	<u>476</u>	2.0 μA
E	<u>467</u>	2.0 μA




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DATA SHEET 2 (Cont.)

(24) Detector Resolution Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>6.5</u> keV	50. keV
B	<u>6</u>	50. keV
C	<u>5.5</u>	50. keV
D	<u>10.5</u>	50. keV
E	<u>7</u>	50. keV

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(27) Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 14 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>14</u>	14 or 16
B	E2	<u>14</u>	14 or 16
C	E3	<u>14</u>	14 or 16
D	E4	<u>14</u>	14 or 16
E	P6	<u>14</u>	14 or 16

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DATA SHEET 2 (Cont.)


(28) Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>14</u>	14 or 16
B	P2	<u>14</u>	14 or 16
C	P3	<u>14</u>	14 or 16
D	P4	<u>14</u>	14 or 16
E	P5	<u>14</u>	14 or 16


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(30) Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 2046 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>2032</u>	2032 or 2048
A	E2	<u>2048</u>	2032 or 2048
C	E3	<u>2032</u>	2032 or 2048
D	E4	<u>2048</u>	2032 or 2048
E	P6	<u>2032</u>	2032 or 2048


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DATA SHEET 2 (Cont.)

(31) Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>2032</u>	2032 or 2048
B	P2	<u>2032</u>	2032 or 2048
C	P3	<u>2032</u>	2032 or 2048
D	P4	<u>2032</u>	2032 or 2048
E	P5	<u>2032</u>	2032 or 2048



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(33) Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>260 096</u>	260,096 or 262,144
B	E2	<u>260 096</u>	260,096 or 262,144
C	E3	<u>260 096</u>	260,096 or 262,144
D	E4	<u>260 096</u>	260,096 or 262,144
E	P6	<u>260 096</u>	260,096 or 262,144




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DATA SHEET 2 (Cont.)


(34) Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>260 096</u>	260,096 or 262,144
B	P2	<u>260 096</u>	260,096 or 262,144
C	P3	<u>260 096</u>	260,096 or 262,144
D	P4	<u>260 096</u>	260,096 or 262,144
E	P6	<u>260 096</u>	260,096 or 262,144


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(36) Electron 1, Electron 2, Electron 3, Electron 4 and
Proton 6 33,554,430 pulse data accumulation test.


EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>33,292,288</u>	33,292,288 or 0
B	E2	<u>33,292,288</u>	33,292,288 or 0
C	E3	<u>33,292,288</u>	33,292,288 or 0
D	E4	<u>344</u>	33,292,288 or 0
E	P6	<u>33,292,288</u>	33,292,288 or 0


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DATA SHEET 2 (Cont.)


(37) Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
 33,554,430 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>33 292 288</u>	33,292,288 or 0
B	P2	<u>0</u>	33,292,288 or 0
C	P3	<u>0</u>	33,292,288 or 0
D	P4	<u>33 292,288</u>	33,292,288 or 0
E	P5	<u>0</u>	33,292,288 or 0



Insp. _____ Date 1/21/72

(54) Visual Inspection.



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Appendix B

Qualification Test Procedure with Data Sheets EPS-530

QUALIFICATION TEST
FOR
ELECTRON-PROTON SPECTROMETER
P/N 39106425-_____
S/N _____

LEC Document EPS-503

Prepared by
Lockheed Electronics Company, Inc.
Houston Aerospace Systems Division
Houston, Texas

Under Contract NAS 9-11373

For
National Aeronautics and Space Administration
Manned Spacecraft Center
Houston, Texas
November 1971

QUALIFICATION TEST
FOR
ELECTRON-PROTON SPECTROMETER
P/N 39106425-301
S/N 1001

LEC Document EPS--503

*Revised
2-8-72*

Prepared by

Lockheed Electronics Company, Inc.
Houston Aerospace Systems Division
Houston, Texas

Under Contract NAS 9-11373

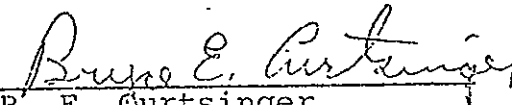
For


National Aeronautics and Space Administration
Manned Spacecraft Center
Houston, Texas

November 1971

QUALIFICATION TEST
FOR
ELECTRON-PROTON SPECTROMETER

Prepared by: 
D. L. Vincent
Mechanical Engineer

Approved by: 
B. E. Curtsinger
Engineering Supervisor


B. C. Hall
Program Manager

Electron-Proton Spectrometer Program
Radiation Instrumentation Department
Lockheed Electronics Company, Inc.
Houston Aerospace Systems Division
Houston, Texas

QUALIFICATION TEST

FOR

ELECTRON-PROTON SPECTROMETER

P/N 39106425- 301

S/N 1001

Approved by: *Carlton S. White* 1/14/72

Approved by: *[Signature]* 1-17-72

Approved by: *Andrew J. Fisher* 1/17/72

National Aeronautics and Space Administration
Manned Spacecraft Center
Houston, Texas

REVISION RECORD

Revision of

2-8-72

Page 4 - Rearranged

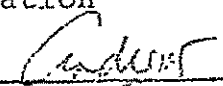
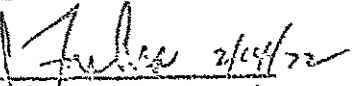
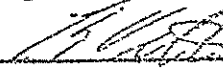
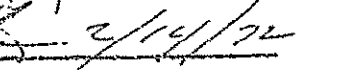
Page 5 - Changed R Axis levels

Page 6 - Changed R Axis duration

Page 21 - Changed step 2.4.8

Page 36 - New illustration

Approved

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QUALIFICATION TEST PROCEDURE
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QUALIFICATION TEST PROCEDURE
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QUALIFICATION TEST PROCEDURE

1. OBJECTIVES AND REQUIREMENTS

1.1 OBJECTIVE

The objective of this test is to verify the operational integrity of the Electron-Proton Spectrometer (EPS). The test will be conducted on the completed EPS, therefore, the acceptance tests, (EPS Acceptance Test Procedure, LEC Document # EPS-489) will be conducted on the EPS prior to the start of this test.

1.2 ENVIRONMENTAL TEST REQUIREMENTS

The following environmental tests required by the End Item Specification and the Interface Control Documents will be conducted at the various NASA/MSFC test facilities in accordance with the EPS Contract NAS 9-11373. The tests will be conducted in the sequence below, however, this is subject to change should scheduling problems be encountered at MSFC test facilities. When specified, visual inspection will be performed between the following tests.

<u>Test Sequence</u>	<u>Test Type</u>
1	Functional
2	Thermal Vacuum
3	Vibration
4	Shock
5	EMC
6	Acoustic
7	Humidity

Tests to determine that the EPS is operating within specification tolerances will be conducted during the Thermal Vacuum and EMC tests and before and after for all other tests.

The EPS electronics will be calibrated prior to conducting this test and no adjustments or tuning of the EPS will be permitted during the testing.

Each of the EPS systems including the scientific analog system, power system, temperature control system, housekeeping system, and the data processor system will be thoroughly exercised during the test.

The Bench Test Equipment (BTE) will be utilized during the test to provide power, timing signals, and test input signals, and to process data from the EPS by providing data storage, data decompression, engineering unit conversion visual display, and hard copy print out of all data. The BTE provides an interface to the EPS equivalent to that provided by the spacecraft/telemetry system in that it provides the same timing, voltage and impedance levels, signal rise times and power as does the spacecraft interface/telemetry system.

1.3 EQUIPMENT REQUIRED

1. Functional:

BTE (including test cables) (39106424)

Power Design 2005 Power Supply S/N 703138

2. Thermal Vacuum

Thermal/Vacuum Chamber (Chamber 'N')
 Test Fixture.

T/V Facility
 Bldg. 33,
 NASA/MSC

3. Vibration

GVL Control System
 249 Shaker
 Dual 310 Slideplate
 Fixture V6-1-116

Vibration Facility
 Bldg. 49, NASA/MSC

4. Shock

GVL Control System
 Fixture V6-1-116
 Stand SEC39107541

Vibration Facility
 Bldg. 49, NASA/MSC

5. EMC

Stand SEC39107541

Test Facility
 Bldg. 14, NASA/MSC

6. Acoustic

Reverberent Chambers

Test Facility
 Bldg. 262, NASA/MSC

7. Humidity

Humidity-Temperature Chamber
 and associated equipment

Test Facility
 Bldg. 15, NASA/MSC

Humidity Test Connector

SEC39107561-301

Stand SEC39107541.

1.4 TEST ENVIRONMENT AND SPECIFICATION

1. Functional

Prior to any environmental test, and subsequent to the test articles exposure to that environment, a functional test shall be run to ascertain that the test article is operational.

If less than one week has elapsed since the last functional test was conducted after an environmental exposure, that test may serve as verification of proper performance before succeeding environmental exposure.

2. Thermal Vacuum

The following test cases will be conducted: *

- | | |
|---|--|
| (a) Operating - Cold | B angle = $\pm 73 \frac{1}{2}^{\circ}$ |
| (b) Standby - Cold (heater
power only) | B angle = $\pm 73 \frac{1}{2}^{\circ}$ |
| (c) Operating - Hot | B angle = 0° |
| (d) Predocking, power off | Direct sun exposure |

*Sequence is not mandatory, but is most efficient for test facility use.

Boundary conditions for the above test cases are shown in Figure 1. Temperature and limits of the detectors and electronics package for test case are given in Figure 3.

The test shall be conducted in a vacuum chamber, with the EPS mounted to the test fixture (provided by NASA). The lamp banks (Figure 2) shall have been calibrated to provide the heat flux requirements called for in Figure 1.

3. Vibration

Sinusoidal: Sweep from 5 to 35 to 5 Hz at .25 g peak.

Sweep rate: 3 octaves/min.

(Applicable to all 3 axes of the instrument.)

Random:

R Axis

Max g and liftoff simulation

20 to 175 Hz + 9 dB/octave increase
175 to 350 Hz 6.0 g²/Hz
350 to 2000 Hz - 3 dB/octave decrease

Transonic/Mach 1 simulation

20 to 175 Hz + 9 dB/octave increase
175 to 350 Hz 10.0 g²/Hz
350 to 2000 Hz - 3 dB/octave decrease

X Axis

20 - 75 Hz @ 6 dB/oct increasing
75 - 175 Hz - .085 g²/Hz
175 - 300 Hz - 6 dB/oct increasing
300 - 1000 Hz - .25 g²/Hz
1000 - 2000 Hz - 6 dB/oct

T Axis

20 - 100 Hz @ 6 dB/oct increasing
100 - 440 Hz - .04 g²/Hz
440 - 600 Hz - 19 dB/oct increasing
600 - 900 Hz - .30 g²/Hz
900 - 2000 Hz - -12 dB/oct

Duration:

For R axis; 80 seconds at liftoff simulation plus 10 seconds at Mach 1 simulation. For X and T axes; 80 seconds at nominal level plus 10 seconds at 4 dB above nominal.

All tests shall be performed under the prevailing laboratory conditions.

The tolerances on the test conditions shall be:

- (a) The test tolerances for equalization bursts at any level are 2 dB above full levels from 20 to 1000 Hz and 4 dB above full levels from 1000 to 2000 Hz. There are no minimum tolerance requirements.
- (b) The test tolerances for full level test runs are ± 2 dB from 20 to 1000 Hz and ± 4 dB from 1000 to 2000 Hz.
- (c) The overall g rms tolerance is +15% and -10%, applicable both to bursts and test runs. (Note: g rms values are to be read out of the control console meter).
- (d) Compliance with the tolerance shall be verified by analysis of the input spectrum.
- (e) Three separate exceedances whose bandwidth is less than that of the shaping filter (up to 25 Hz) or less than 5% of the center frequency, whichever is larger, are acceptable.
- (f) Reductions below tolerance, whose bandwidth is less than that of the shaping filter (up to 25 Hz) are acceptable, provided the maximum capability of the shaker system has been used.

4. Shock

The shock test consists of two parts:

- (a) Verifying the integrity of the EPS to the pyrotechnic shock given in the I.C.D. (NR Document MH04-02120-434).
- (b) MIL-STD-810B, Method 516.1, Procedure V.

Test (a) consists of subjecting the test article to a pulse that produces the shock spectrum shown in Figure 4. The test article shall be subjected to this pulse once in each direction for the three mutually perpendicular axes (total of 6 shocks).

Test (b) consists of placing the test article, in its assembly and servicing stand, on a wooden bench top at least 1 5/8" thick and performing the following:

With the stand resting on its base lift one edge of the base four inches and allow the unit to drop back freely to the horizontal bench top. Repeat using the other three edges as pivot points for a total of four drops. Functionally test unit and compare with previous test results. Figure 5 shows test arrangement for Procedure V.

5. EMC

The EMC test will be conducted in accordance with Qualification Procedure for Electromagnetic Interference and Susceptibility Tests, Skylab Electron-Proton Spectrometer, EMC-P-EB8-003, and North American Rockwell ICD MH04-02057-234.

6. Acoustic

The acoustic test shall be run in accordance with MIL-STD-810B, Method 515, Procedure I with the following exceptions:

- (a) The sound pressure levels shall be as shown in Figure 6
- (b) The test time shall be 80 seconds of nominal exposure + 10 seconds of exposure to the 'transonic buffeting levels.

These test levels shall apply to the top (detector) face of the instrument. The sides of the instrument will be exposed to a level approximately 6 dB lower, when mounted on the test fixture. At the conclusion the unit shall be functionally tested and the results compared with previous functional test results.

7. Humidity

The humidity test will be run to MIL-STD-810B. Method 507, Procedure I, except that the minimum temperature shall be 68°F and the maximum temperature shall be 120°F. This test shall be repeated for five cycles only.

In general Procedure I consists of exposing the unit under test to the following conditions.

- (a) Raise temperature from ambient to 120°F and humidity to 95% over a two hour period. Maintain this condition for six hours.

(b) Over a period of 16 hours reduce temperature to 68°F and 85° or greater relative humidity.

(c) Repeat steps (a) and (b) for 5 cycles (120 hours).

(d) Allow the EPS to remain at room ambient conditions with no power applied for 8 hours.

(e) Functionally operate test unit at ambient conditions and compare with previous results.

1.5 FAILURE REPORTS

All failures will be reported in compliance with paragraph 4.4.4.1 of MSC-KA-D-69-44.

2. TEST PROCEDURE

2.1 FUNCTIONAL TEST

2.1.1 Turn OFF all EPS power at the BTE.

2.1.2 Connect the EPS to BTE as shown in Figure 7.

2.1.3 Place the BTE output power voltage level selection switch in the medium position.

2.1.4 Turn the Heater Power Switch to ON and verify that the output voltage is $+27.5 \pm 0.5$ Vdc. Record actual voltage.

2.1.5 Record the EPS Heater input current on the data sheet. Verify that this current is within the acceptance limits given on the data sheet.

2.1.6 Turn the Electronics Power Switch to ON and verify that the output voltage is 27.5 ± 0.5 Vdc. Record actual voltage.

2.1.7 Record the EPS Electronics input current on the data sheet. Verify that this current is within the acceptance limits given on the data sheet.

CAUTION

Do not apply Detector Bias when Detector Plate Temperature Monitor indicates 25°C or higher. If Detector Plate Temperature reaches 25°C, remove Detector Bias if applied. Detector Bias applied above 25°C may damage detectors. CAUTION does not apply when diodes are installed in place of detectors.

- 2.1.8 Turn the Detector Bias Switch to ON and verify that the input voltage is $+27.5 \pm 0.5$ Vdc. Record actual voltage.
- 2.1.9 Record the EPS Detector Bias Current on the data sheet. Verify that this current is within the acceptance limits given on the data sheet.
- 2.1.10 Activate the BTE controller and display. Select the Housekeeping Format.
- 2.1.11 Sequentially apply external reference voltage values given in the data sheet using the ADC External Reference Supply. Record on the data sheet the electrical unit value of the +350 V monitor as displayed by the BTE for each reference voltage. Verify that all EPS output values are within acceptance limits given in the data sheet.
- 2.1.12 Disconnect the External ADC Reference Supply from the BTE.
- 2.1.13 Record the values of those housekeeping parameters listed in the data sheet displayed on the BTE in engineering units. Verify that these EPS output values are within the acceptance limits given in the data sheet.
- 2.1.14 Place the BTE output power voltage level selection switch in the low position. Verify the Heater, Electronics and Detector Bias output voltages are $+25.0 \pm 0.5$ Vdc. Record actual values.

2.1.15 Record the values of the EPS input currents and verify that these values are within the acceptance limits given in the data sheet.

2.1.16 Record the values of those housekeeping parameters listed in the data sheet displayed on the BTE in engineering units. Verify that these EPS output values are within the acceptance limits given in the data sheet.

2.1.17 Place the BTE output voltage switch in the high position. Verify that the Heater, Electronics, and the Detector Bias output voltages are $+30.0 \pm 0.5$ Vdc.

2.1.18 Record the values of the EPS input currents and verify that these values are within the acceptance limits given in the data sheet.

2.1.19 Record the values of those housekeeping parameters listed in the data sheet displayed on the BTE in engineering units. Verify that these EPS output values are within the acceptance limits given in the data sheet.

2.1.20 Place the BTE output voltage switch in the Medium position. Record the values of the Package Temperature Monitor and the Detector Plate Temperature Monitor as displayed on the BTE in engineering units. Verify that the recorded values are within the acceptance limits given in the data sheet. During Thermal Vacuum Tests, this step for information only.

2.1.21 If the engineering unit value of the Detector Plate Temperature Monitor measured in step 2.1.20 is within the limits -50°C to $+25^{\circ}\text{C}$ record the values of each of the Detector Leakage Current Monitors as displayed on the BTE in engineering units. Verify that the recorded values are within the acceptance limits given in the data sheet.

2.1.22 If the engineering unit value of the Detector Plate Temperature Monitor measured in step 2.1.20 is within the limits -50°C to $+25^{\circ}\text{C}$ record the values of each of the Detector Resolution Monitors as displayed on the BTE in engineering units. Verify that the recorded values are within the acceptance limits given in the data sheet.

2.1.23 Place the Detector Bias Voltage switch of the BTE to OFF.

2.1.24 Place the BTE in the Data Format with a Burst Generator burst length of 14 pulses and a Sync Pulse Rate of 1 pulse/second.

2.1.25 Place the Burst Generator amplitude selection switch in the E1, E2, E3, E4, P6 position. For a complete burst cycle record the value of the information accumulated by the EPS Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 channels on the data sheet. Verify that these values are within acceptance limits given on the data sheet.

2.1.26 Place the Burst Generator amplitude selection switch in the P1, P2, P3, P4, P5 position. For a complete burst cycle record the value of the information accumulated by the EPS Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5 channels on the data sheet. Verify that these values are within acceptance limits given on the data sheet.

2.1.27 Change the BTE Burst Length to 2046 pulses.

2.1.28 Place the Burst Generator amplitude selection switch in the E1, E2, E3, E4, P6 position. For a complete burst cycle record the value of the information accumulated by the EPS Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 channels on the data sheet. Verify that these values are within acceptance limits given on the data sheet.

2.1.29 Place the Burst Generator amplitude selection switch in the P1, P2, P3, P4, P5 position. For a complete burst cycle record the value of the information accumulated by the EPS Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5 channels on the data sheet. Verify that these values are within acceptance limits given on the data sheet.

2.1.30 Change the BTE Burst Length to 262,142 pulses and the Svc Pulse Rate to 1 pulse/4 seconds.

2.1.31 Place the Burst Generator amplitude selection switch in the E1, E2, E3, E4, P6 position. For a complete burst cycle record the value of the information accumulated by the EPS Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 channels on the data sheet. Verify that these values are within acceptance limits given on the data sheet.

2.1.32 Place the Burst Generator amplitude selection switch in the P1, P2, P3, P4, P5 position. For a complete burst cycle record the value of the information accumulated by the EPS Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5 channels on the data sheet. Verify that these values are within acceptance limits given on the data sheet.

2.1.33 Change the BTE Burst Length to 33,554,430 pulses and the Sync Pulse Rate to 1 pulse/16 seconds.

2.1.34 Place the Burst Generator amplitude selection switch in the E1, E2, E3, E4, P6 position. For a complete burst cycle record the value of the information accumulated by the EPS Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 channels on the data sheet. Verify that these values are within acceptance limits given on the data sheet.

2.1.35 Place the Burst Generator amplitude selection switch in the P1, P2, P3, P4, P5 position. For a complete burst cycle record the value of the information accumulated by the EPS Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5 channels on the data sheet. Verify that these values are within acceptance limits given on the data sheet.

2.1.36 Perform a visual inspection for obvious damage such as dents, cracks, scratches, chipped paint, and loose screws.

2.2 THERMAL/VACUUM TEST

- ✓ 2.2.1 Upon completion of steps 2.1.1 through 2.1.36, move the the test article and BTE to vacuum chamber facility of Building 33, NASA/MSC.
- ✓ 2.2.2 Prepare vacuum chamber and test fixture for thermal/vacuum testing of the EPS.
- ✓ 2.2.3 Verify that all environmental chamber power is off and install test article on test fixture and connect to feed-through connector.
- ✓ 2.2.4 Turn off all power to test fixture (environmental simulation power) by unplugging at wall socket. Connect BTE to feed-through connector.
- ✓ 2.2.5 Perform a functional test steps 2.1.3 thru 2.1.35.
- ✓ 2.2.6 Close chamber door and pump down. (Vacuum to be better than 1×10^{-6} Torr).
- ✓ 2.2.7 Provide suitable power to the test fixture lamps, skin and cavity to give boundary conditions for test case 1 (operating - cold orbit. See Figure 1).

- ✓ 2.2.8 Place the BTE output power voltage level selection switch in the 'Medium' position.
- ✓ 2.2.9 Turn the Electronics Power Switch of the BTE to 'ON'.
- ✓ 2.2.10 Turn the Heater Power Switch of the BTE to 'ON'.
- ✓ 2.2.11 Turn the Detector Bias Switch of the BTE to 'ON'.
- ✓ 2.2.12 Activate the BTE controller and display. Select the housekeeping format.
- ✓ 2.2.13 Record the values of the Package Temperature Monitor and the Detector Plate Temperature Monitor, as displayed on the BTE Prime Frame A in engineering units, every 1/2 hour until the package temperature stabilizes. (Stabilization is reached when this temperature does not change more than 1.5°C (3°F) per hour.)
- ✓ 2.2.14 When stabilization is reached, allow the test article to 'soak' at this condition for 2 hours. (Package and detector temperatures will still be changing slowly; continue to record these temperatures every 1/2 hour.)
- ✓ 2.2.15 Repeat steps 2.1.4 through 2.1.35.
- ✓ 2.2.16 Return BTE to housekeeping mode.
- ✓ 2.2.17 Turn the Electronics Power Switch of BTE to 'OFF'.

- ✓ 2.2.18 Turn the Detector Bias Switch of the BTE to 'OFF'.

Test article is now in test case 2 (Heater power only - cold orbit, see Figure 1). Monitoring of Package Temperature and Detector Plate Temperature is achieved by turning Electronics Power Switch of the BTE to 'ON', allowing housekeeping data to stabilize (2 cycles is sufficient) and then returning the Electronics Power Switch to the 'OFF' position. BTE console will continue to display housekeeping data from the period of operation.

- ✓ 2.2.19 Repeat step 2.2.13.

- ✓ 2.2.20 Repeat step 2.2.14.

- ✓ 2.2.21 Repeat steps 2.1.4 through 2.1.35.

- ✓ 2.2.22 Return BTE to housekeeping mode.

- ✓ 2.2.23 Set fixture lamps, skin and cavity to give boundary conditions for test case 3 (operating - hot orbit, See Figure 1).

- ✓ 2.2.24 Place BTE:

- (a) Electronics Power Switch - 'ON'
- (b) Detector Bias Switch - 'ON'
- (c) Heater Power Switch - 'ON'

- ✓ 2.2.25 Repeat step 2.2.13.
- ✓ 2.2.26 Repeat step 2.2.14.
- ✓ 2.2.27 Repeat steps 2.1.4 through 2.1.35.
- ✓ 2.2.28 Set fixture lamps, skin and cavity to give boundary conditions for test case 4. (See Figure 1.)
- ✓ 2.2.29 Turn BTE:
 - (a) Electronics Power Switch to 'OFF'
 - (b) Heater Power Switch to 'ON'
 - (c) Detector Bias Switch to 'OFF'

Test article is now in test case 4 (No power - pre-docking see Figure 1). Monitoring of Package Temperature and Detector Plate Temperature is achieved by turning Electronics Power Switch of the BTE to 'ON', allowing housekeeping data to stabilize (2 cycles is sufficient) and then returning the Electronics Power Switch to the 'OFF' position. BTE console will continue to display housekeeping data from the period of operation.

- ✓ 2.2.30 Repeat step 2.2.13.
- ✓ 2.2.31 Repeat step 2.2.14.

2.2.32 Return vacuum chamber to ambient temperature and pressure.

2.3 FUNCTIONAL TEST

Repeat steps 2.1.1 through 2.1.36.

2.4 VIBRATION

2.4.1 Repeat steps 2.1.1 through 2.1.36. (Note: If less than one week has passed since Functional Test 2.3, this test may be omitted.)

2.4.2 Take test article to vibration facility, Building 49, NASA/MSC.

2.4.3 Prepare the GVL control system for sinusoidal and random excitation, utilizing the 249 shaker and dual 310 slideplate.

2.4.4 Mount the vibration fixture V6-1-116 on the 249 shaker.

2.4.5 Shape 'R' axis random vibration spectrum (see Figure 8 for spectrum).

2.4.6 . Install test article on vibration fixture, using P/N SDC39107458-001, SDC39107458-002, and 10-32UNF x 3/4 long skt. hd. cap screw (as shown in Figure 9). Screws to be installed to a torque of 56 ± 1 lbs-ins.

2.4.7 Expose the test article to the sinusoidal sweep (5-35-5 Hz at .25g peak, sweep at 3 octave/min.).

2.4.8 Expose the test article to the max q and liftoff random vibration spectrum for 80 seconds plus 10 seconds of Mach 1 random vibration spectrum (total exposure = 90 seconds).

2.4.9 Remove test article from fixture.

2.4.10 Repeat steps 2.1.1 through 2.1.35.

2.4.11 Remove fixture from 249 shaker, move to dual 310 slideplate, mount and orient for 'X' axis excitation (see Figure 10).

2.4.12 Shape the 'X' axis spectrum (see Figure 11 for spectrum).

2.4.13 Repeat step 2.4.6.

2.4.14 Repeat step 2.4.7.

2.4.15 Repeat step 2.4.8 for 'X' axis excitation.

2.4.16 Repeat step 2.4.9.

2.4.17 Re-orient test fixture for 'T' Axis excitation.
(See Figure 10)

2.4.18 Shape the 'T' Axis spectrum (see Figure 12 for spectrum).

2.4.19 Repeat step 2.4.6.

2.4.20 Repeat step 2.4.7.

2.4.21 Repeat step 2.4.8 for 'T' Axis excitation.

2.4.22 Repeat step 2.4.9.

2.4.23 Return test article to Beta Building.

2.5 FUNCTIONAL TEST

Repeat steps 2.1.1 through 2.1.36.

2.6 SHOCK

2.6.1 Repeat steps 2.1.1 through 2.1.36. (Note: If less than one week has passed since Functional Test 2.5, this test may be omitted.)

2.6.2 Take test article to vibration facility, Building 49, NASA/MSC.

2.6.3 Prepare shaker system, utilizing 249 shaker and dual 310 slide plate, for shock excitation.

2.6.4 Mount the vibration fixture V6-1-116 on the 249 shaker.

2.6.5 Shape shock pulse to produce the response spectrum of Figure 4.

2.6.6 Repeat step 2.4.6.

2.6.7 Expose the test article to the shock pulse in the +R and -R axis.

2.6.8 Repeat step 2.4.9.

2.6.9 Orient fixture and test item for 'X' Axis excitation, on 310 slideplate.

2.6.10 Repeat step 2.6.5.

2.6.11 Repeat step 2.4.6.

2.6.12 Repeat step 2.6.7 for +X and -X axis.

2.6.13 Repeat step 2.4.9.

2.6.14 Repeat step 2.4.17.

2.6.15 Repeat step 2.4.6.

2.6.16 Repeat step 2.6.7 for +T and -T axis.

2.6.17 Remove test article from test fixture.

2.6.18 Perform visual inspection of the end item for obvious damage such as dents, cracks, scratches, chipped paint, and loose screws.

2.6.19 Place EPS in servicing stand as shown in Figure 5. Secure to the stand in eight places with hardware shown in Figure 9.

2.6.20 Place EPS on wooden bench top at least 1 5/8" thick.

2.6.21 With stand resting on its base, lift one edge of the base 4 inches and allow the unit to drop freely to the bench top. Repeat using the other three edges as pivot points for a total of four drops.

2.7 FUNCTIONAL TEST

Repeat 2.1.1 to 2.1.36

2.8 EMC

2.8.1 After the EPS has been transferred to MSC Building 14, EMC Test Area, a demonstration of proper instrument operation is required prior to EMC Testing. Repeat steps 2.1.1 through 2.1.36.

2.8.2 Perform EMC testing as per NASA Document EMC-P-EB8-003, Qualification Procedure for Electromagnetic Interference and Susceptibility Tests, Skylab Electron/Proton Spectrometer.

Note: Since the Operating Temperature requirements for the EPS cannot be met during EMC testing (i.e., when the Detector Plate Temperature is greater than 25°C, all detector power is removed from the EPS), then the definition of susceptibility as given in Paragraph 5.0 of EMC-P-EB8-003 may not be valid. During EMC testing, if greater than 10 counts is obtained in any electron or proton channel, the RF stimulus shall be removed and another reading taken. If the counts are still present the EPS is not susceptible to the RF stimulus.

2.9 FUNCTIONAL TEST

After completion of all EMI testing, a demonstration of proper instrument operation is required.

Repeat steps 2.1.1 through 2.1.36.

2.10 ACOUSTIC

2.10.1 Repeat steps 2.1.1 through 2.1.36. (If less than one week has passed since Functional Test 2.9, this test may be omitted.)

2.10.2 Take test article to Acoustic Test Facility.

2.10.3 Prepare anechoic chamber to provide sound pressure levels of Figure 6.

2.10.4 Install test article in test chamber.

2.10.5 Subject the EPS to a sweep of from 25 to 8000 cps at the sound pressure levels specified in Figure 6. Subject the instrument to the specified sweep for a period of 80 + 10 seconds for each of the orthogonal axes of the instrument. If the test facility permits exposure of all sides simultaneously, the total test time may be limited to 80 seconds plus 10 seconds of transonic buffeting.

2.10.6 Remove test article from chamber.

2.10.7 Return to Beta Building

2.11 FUNCTIONAL TEST

Repeat steps 2.1.1 through 2.1.36.

2.12 HUMIDITY

2.12.1 Repeat steps 2.1.1 through 2.1.36. (If less than one week has passed since Functional Test 2.11, this test may be omitted.)

2.12.2 Install potted dummy plug (SEC39107561-301) in connector. Mount EPS in stand SEC39107541.

2.12.3 Take test article to Test Facility.

2.12.4 Place test article in test chamber. Prior to starting cycling, the internal chamber temperature shall be at standard ambient with uncontrolled humidity.

2.12.5 Gradually raise internal chamber temperature to 48.9°C (120°F) and the relative humidity to 95% over a period of 2 hours.

2.12.6 Maintain conditions of step 2.12.5 for not less than 6 hours.

2.12.7 Maintain 85%, or greater, relative humidity and reduce internal chamber temperature in 16 hours to 20°C ± 10°C (68°F).

2.12.8 Repeat steps 2.12.5 thru 2.12.7 for 5 cycles (not less than 120 hours). Figure 13 is an outline of the humidity cycle for this procedure.

2.12.9 Remove the test article from the chamber and allow the test article to return to 20°C ± 10°C.

2.12.10 Within one hour of test completion, perform a visual inspection for obvious damage such as dents, cracks, scratches, chipped paint, and loose screws.

2.12.11 Return test article to Beta Building.

2.13 FUNCTIONAL TEST

Repeat steps 2.1.1 to 2.1.35 eight hours after completion of the humidity test.

Test Case	Instrument Mode	Power	Simulated β Angle	Hot or Cold	Absorbed Heat Flux (BTU/Hr-Ft ²)		Boundary Temp. (°F)	
					Top	Sides	Skin	Cavity
1	Operating	Electronics and Heaters	$\pm 73 \frac{1}{2}^\circ$	Cold	18.2	13.9	-75	0
2	Standby	Heater Only	$\pm 73 \frac{1}{2}^\circ$	Cold	18.2	13.9	-75	0
3	Operating	Electronics Only	0	Hot	33.8	16.0	-23	75
4	Pre-Docking	None	$\pm 73 \frac{1}{2}^\circ$	Hot	128	13.9	250	75

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Figure 1 Thermal/Vac. Test Parameters

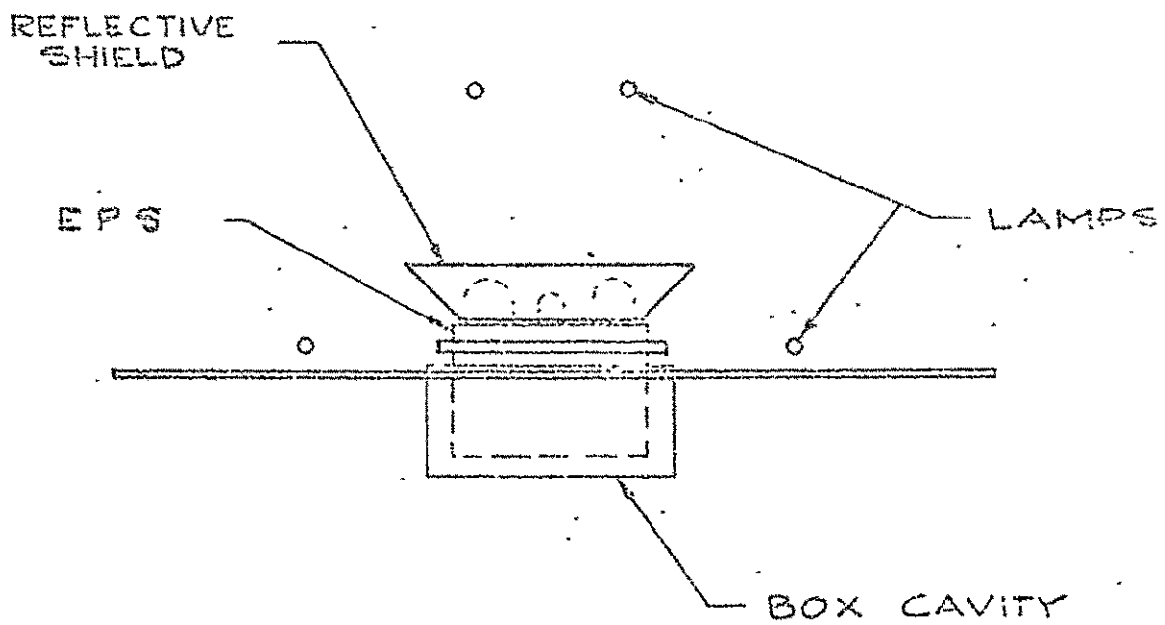
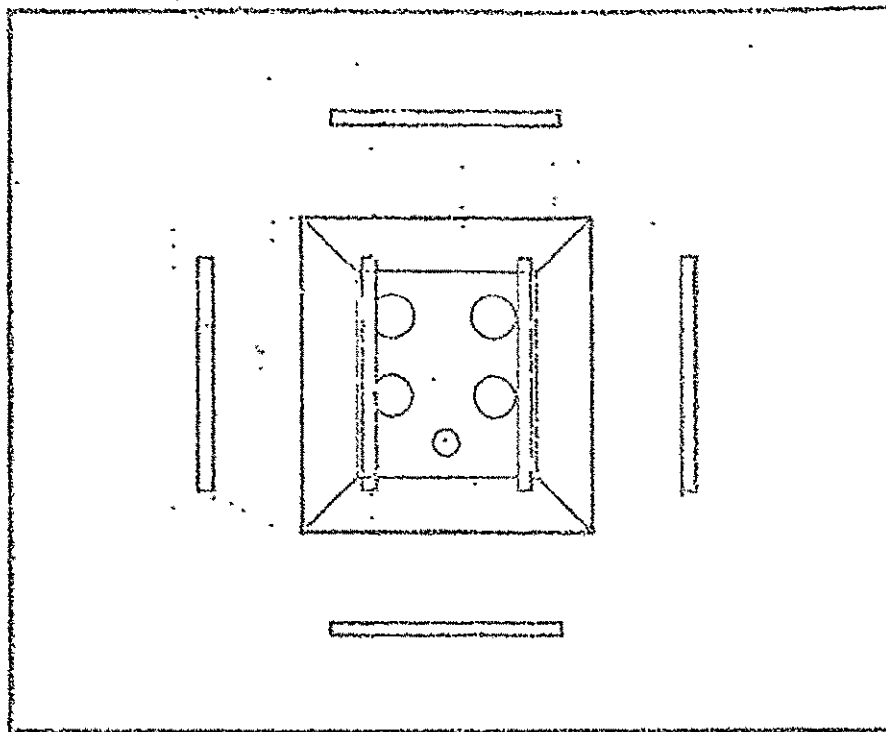


Figure 2 EPS Thermal Test Unit
Diagram of Test Fixture

EPS THERMAL VACUUM TEST LIMITS AND ANALYTICAL PREDICTIONS

Case No.		Electronics Temp. (°F)		Detector Temp. (°F)	
		Limit	Predicted	Limit	Predicted
1	Operating Mode 15 Watts, $\beta = \pm 73^\circ$	-13 Lower	20	-58 Lower	-12
2	Heater Only 6 Watts, $\beta = \pm 73^\circ$	-58 Lower	-34	-58 Lower	-52
3	Operating Mode 15 Watts, $\beta = 0^\circ$	122 Upper	79	50 Upper	28
4	Survival - Predock No Power, Sun on EPS Cavity at 117°F	150 Upper	75	122 Upper	75

Figure 3

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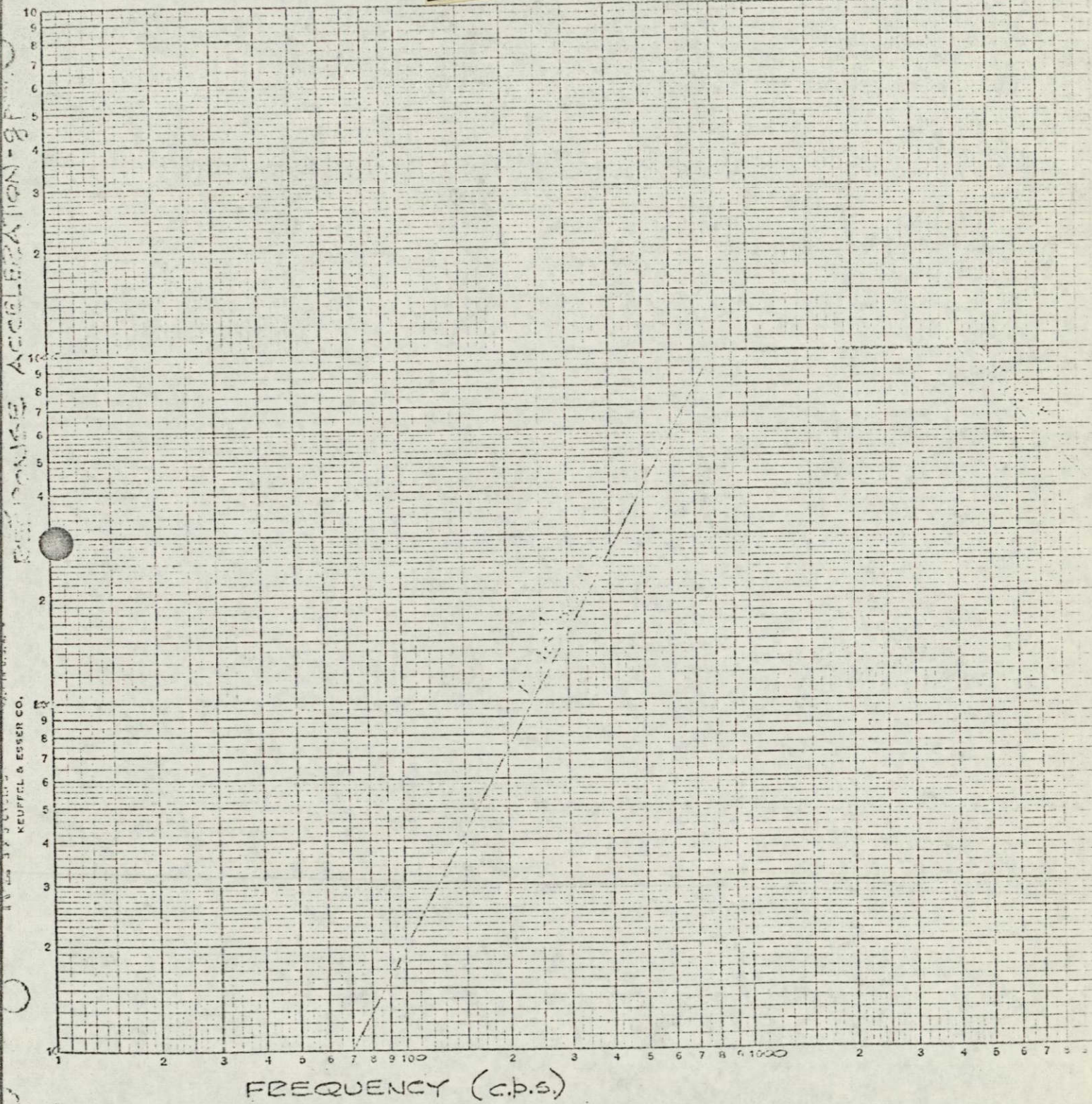
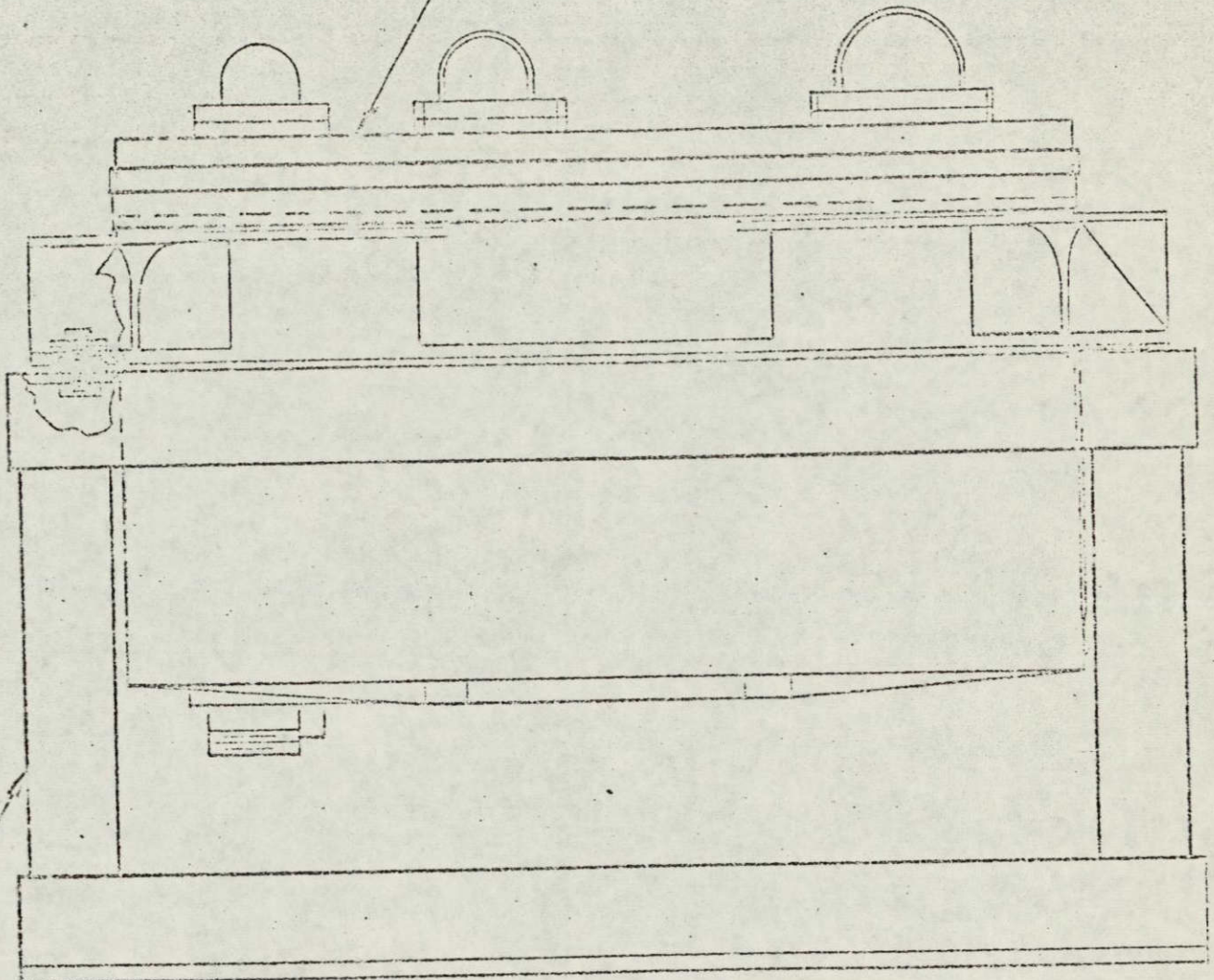


FIG. # - SHOCK RESPONSE SPECTRUM.

(TAKEN FROM ICD, NAE 20-1000-1000-1000)

TEST ARTICLE



SERVICING STAND

5 EPS BENCH DROP TEST ARRANGEMENT

ACOUSTIC ENVIRONMENT

1/3 Octave Band Center Frequency (CPS)	1/3 Octave Band Sound Pressure Level - dBre 0.0002 uBar Maximum Aerodynamic Pressure	Transonic Buffeting
25	143	
31.5	145	
40	147	
50	148	
63	149	
80	150	Run to same
100	151	spectrum, but
125	150	overall level
160	149	4 dB higher.
200	148	
250	147	
315	146	
400	145	Test tolerances:
500	143	overall level, ± 1 dB.
630	141	below 40 cps ± 6 dB
800	139	40 - 1000 cps ± 1 dB
1000	137	above 1000 cps ± 20 dB.
1250	135	
1600	133	
2000	131	
2500	129	
3150	127	
4000	125	
5000	123	
6300	121	
8000	118	
OVERALL	161	

Duration: 80 seconds of Max.
Aerodynamic Pressure
+10 seconds of Transonic
Buffeting.

Figure 6 - Acoustic Noise

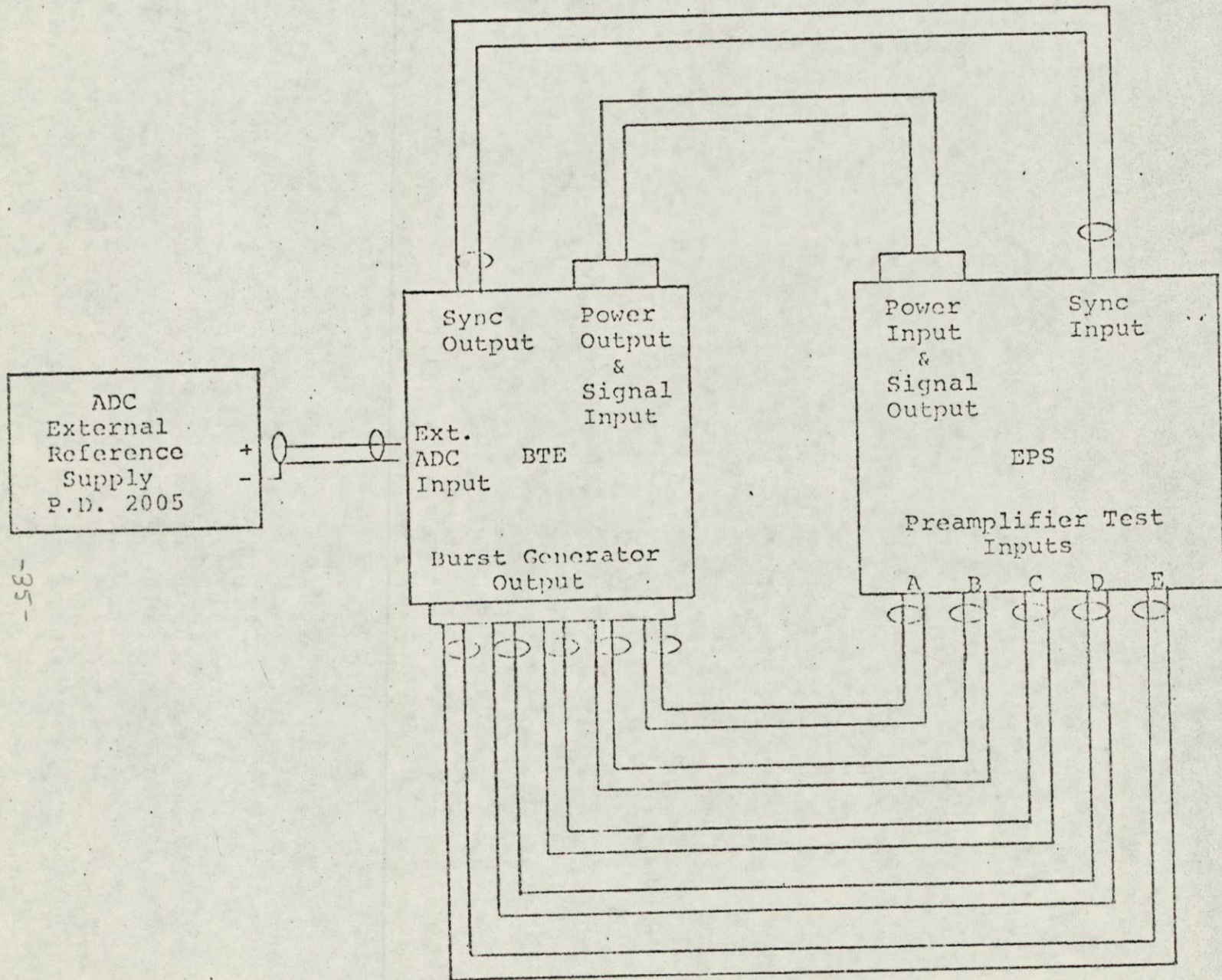


Figure 7 Test Setup

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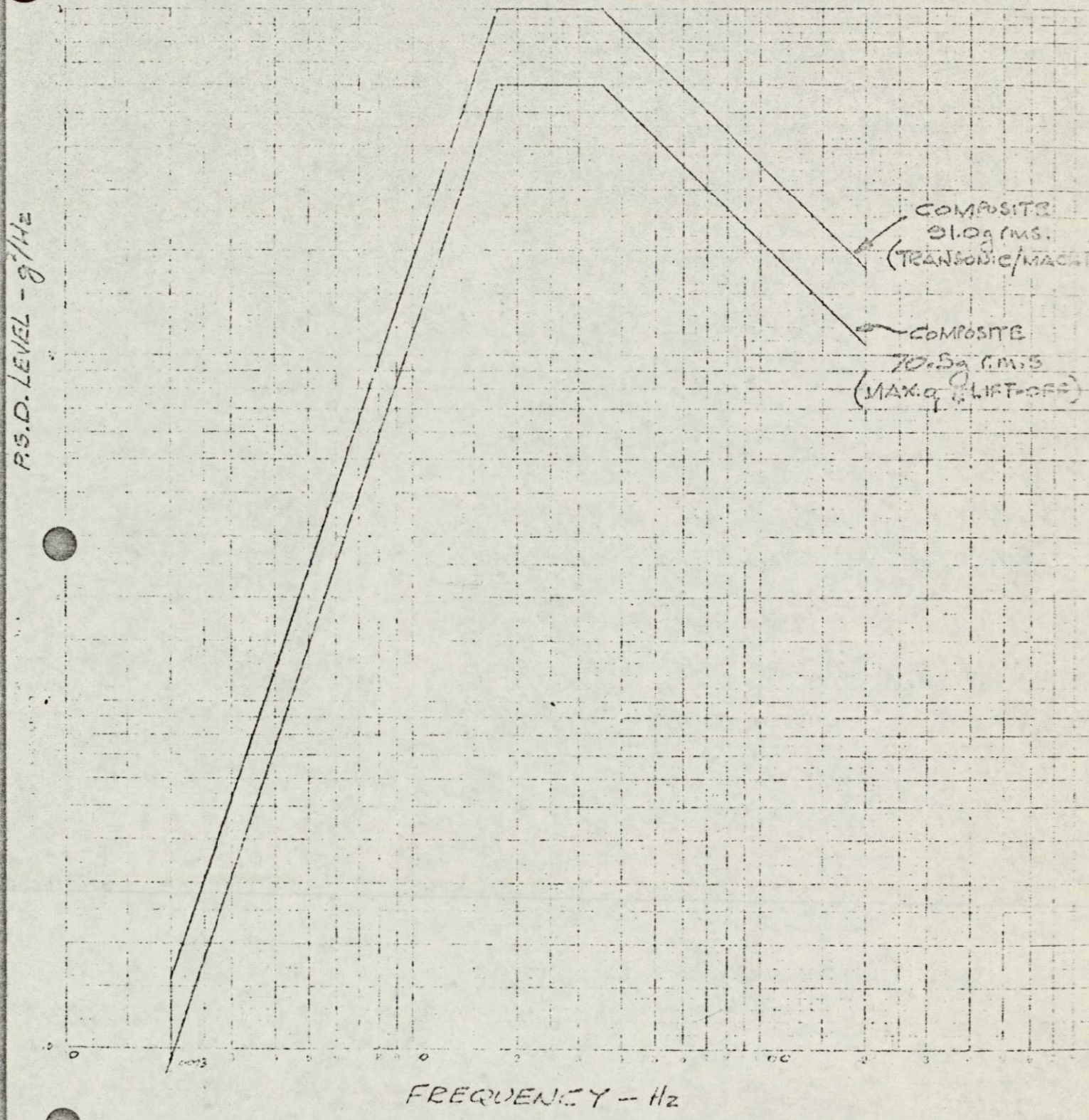


FIG. 8

'E' AXIS

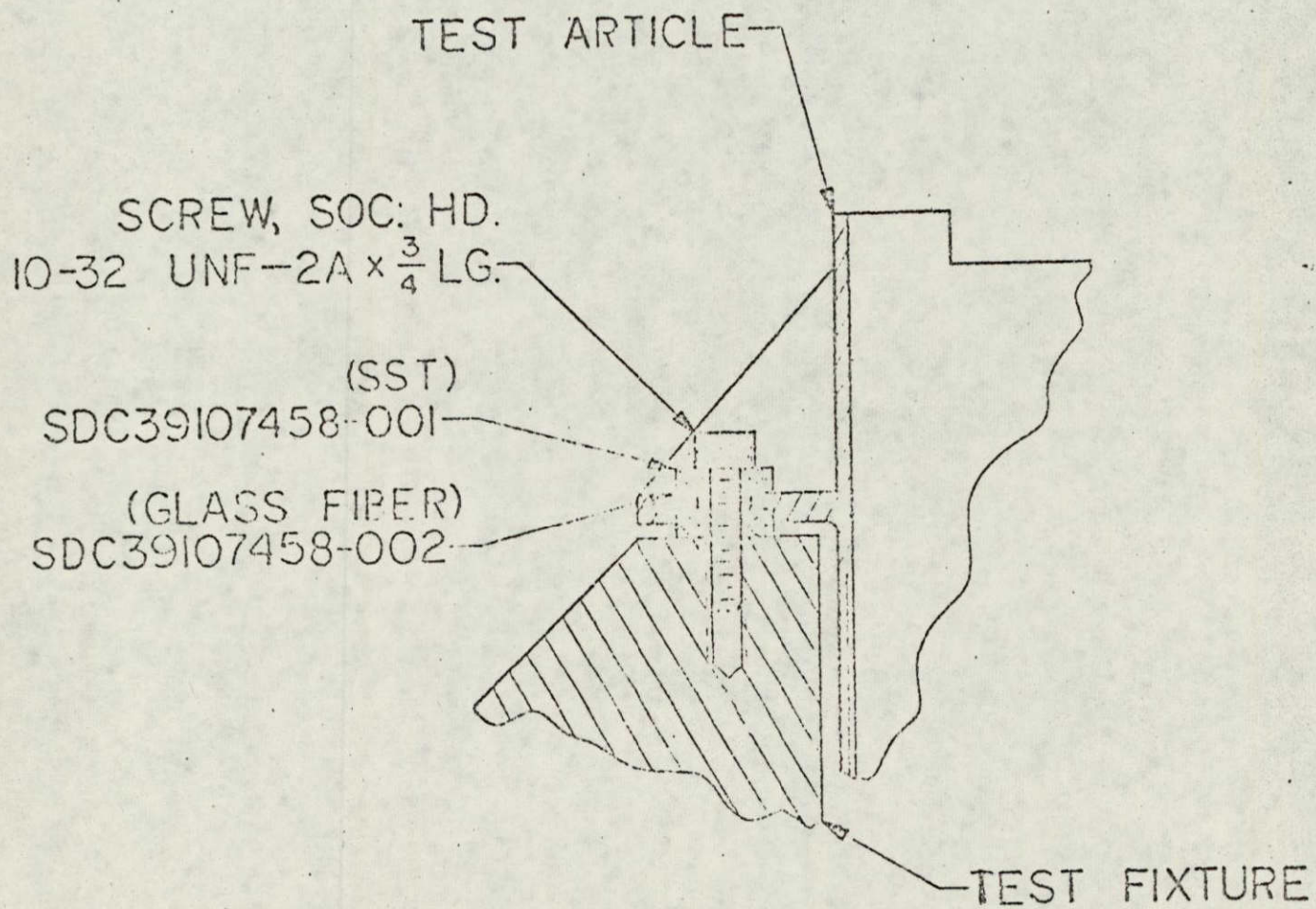


FIG. 9

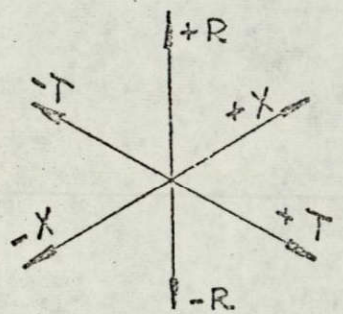
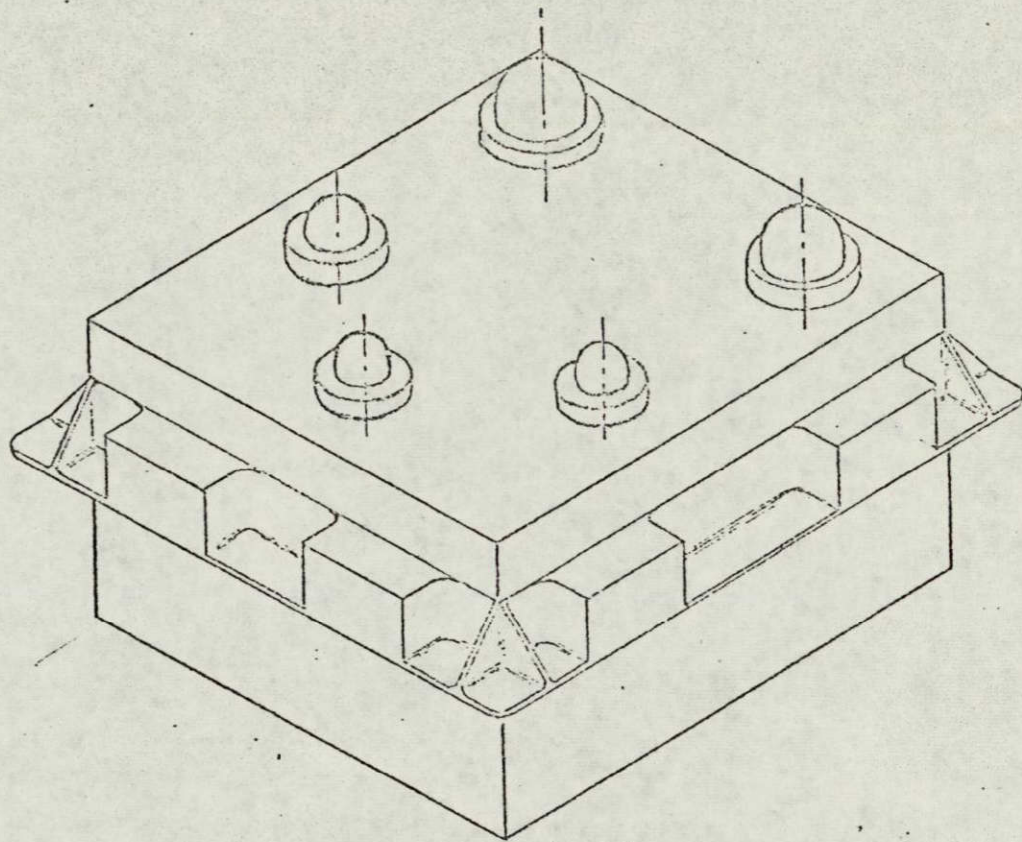


FIG.10 - INSTRUMENT AXES.

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0 dB ABOVE NOM.

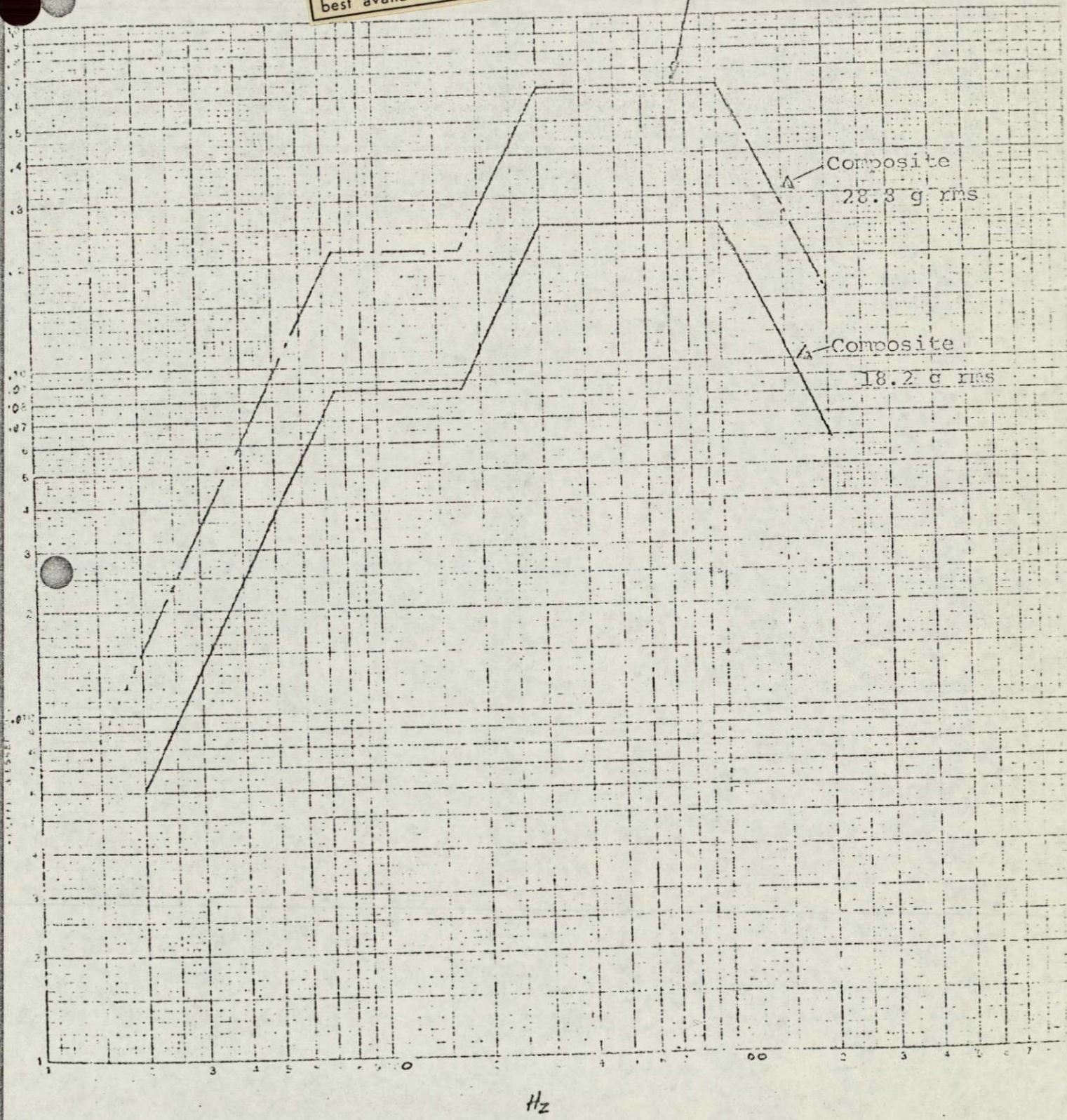


Figure 11 - X Axis

dv

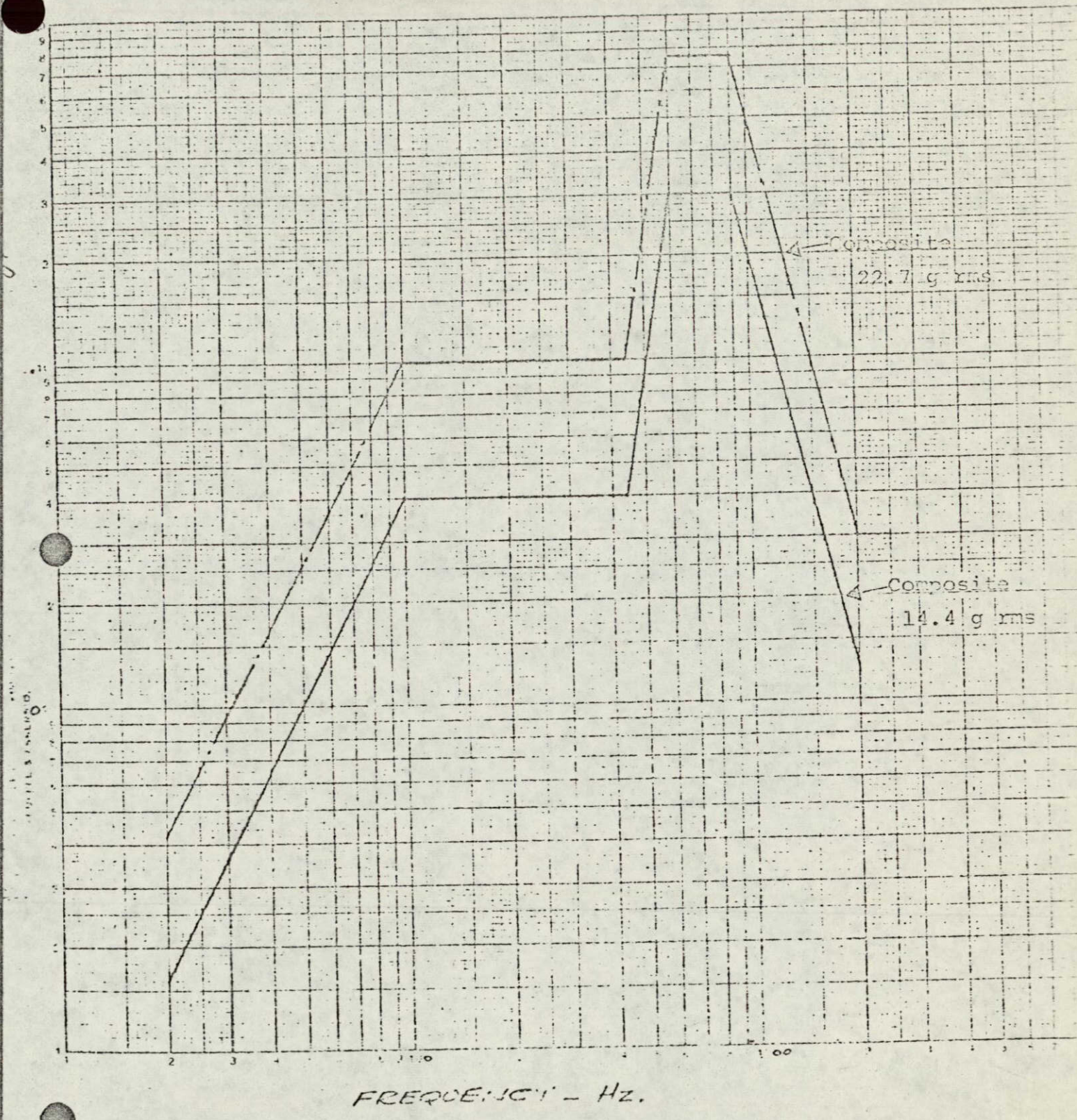
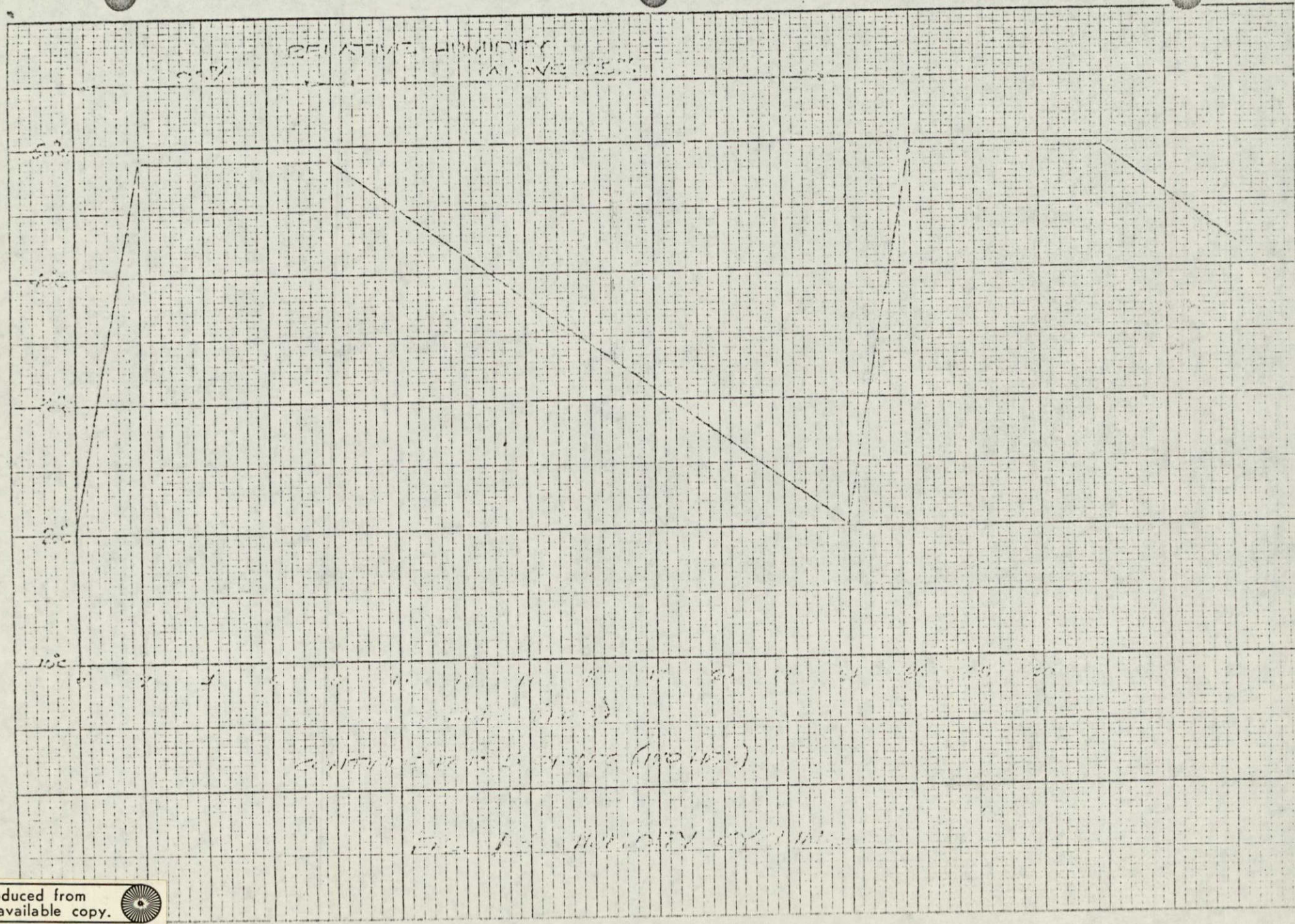


Figure 12 - 'T' AXIS.



COOLING AND DEHUMIDIFICATION PROCESS (100% RH)

FIG. 1 - HUMIDITY CONTROL



DATA SHEET 1 (Cont.)

2.1.6 Electronic Power

Measured Value

Acceptable Value

 $+27.5 \pm 0.5$ Vdc_____
Insp._____
Date

2.1.7 Medium Voltage Electronics Current

Measured Value

Maximum Value

560 mA

Insp._____
Date

2.1.8 Detector Bias

Measured Value

Acceptable Value

 $+27.5 \pm 0.5$ Vdc_____
Insp._____
Date

2.1.9 Medium Voltage Detector Bias Current

Measured Value

Maximum Value

30 mA

Insp._____
Date

DATA SHEET 1 (Cont.)

2.1.11 Medium Voltage ADC Checkout

Reference Input Voltage	Measured Electrical Unit Output Voltage	Acceptable Electrical Output Unit Voltage
+0.025±0.001 Vdc	_____ Vdc	+0.025±0.010 Vdc
+0.050±0.001	_____	0.050±0.010
+0.100±0.001	_____	0.100±0.010
+1.000±0.001	_____	1.000±0.010
+2.000±0.001	_____	2.000±0.010
+3.000±0.001	_____	+3.000±0.010
+4.000±0.001	_____	+4.000±0.015
+4.900±0.001	_____	+4.900±0.020

 Insp.

 Date

DATA SHEET 1 (Cont.)

2.1.13 Medium Voltage Housekeeping Parameter Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Engineering Unit Value
+5V Monitor	A	_____ Vdc	+5.00±0.25 Vdc
+8V Monitor	A	_____	+8.10±0.15
-8V Monitor	A	_____	-8.15±0.15
+25V Monitor	A	_____	+25.50±0.75
+350V Monitor	A	_____	+350.±15.
-15V Monitor	A	_____	-15.0±1.0
-5V Monitor	A	_____	-5.25±0.25
Disc Ref Mon.	A	_____	+3.00±0.02
+5V Monitor	B	_____	+5.00±0.25
+8V Monitor	B	_____	+8.10±0.15
-8V Monitor	B	_____	-8.15±0.15
+25V Monitor	B	_____	+25.50±0.75
+350V Monitor	B	_____	+350.±15.
-15V Monitor	B	_____	-15.0±1.0
-5V Monitor	B	_____	-5.25±0.25
Disc Ref Mon.	B	_____	+3.000±0.02

Insp. _____ Date _____

2.1.14

	Actual Value	Acceptable Value
Heater	_____	+25.0 ± 0.5 Vdc
Electronics	_____	+25.0 ± 0.5 Vdc
Detector Bias	_____	+25.0 ± 0.5 Vdc

Insp. _____ Date _____

DATA SHEET 1 (Cont.)

2.1.15 Low Voltage Current Consumption

Current Sink	Measured Current	Acceptable Value
Heater	_____ mA	10 ± 5 mA
Electronics	_____	< 560
Detector Bias	_____	< 30

_____ Insp. _____ Date

2.1.16 Low Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	_____ Vdc	+5.00±0.25 Vdc
+8V Monitor	A	_____	+8.10±0.15
-8V Monitor	A	_____	-8.15±0.15
+25V Monitor	A	_____	+25.50±0.75
+350 V Monitor	A	_____	+350.±15.
-15V Monitor	A	_____	-15.0±1.0
-5V Monitor	A	_____	-5.25±0.25
Disc Ref Mon.	A	_____	+3.00±0.02
+5V Monitor	B	_____	+5.00±0.25
+8V Monitor	B	_____	+8.10±0.15
-8V Monitor	B	_____	-8.15±0.15
+25V Monitor	B	_____	+25.50±0.75
+350V Monitor	B	_____	+350.±15.
-15V Monitor	B	_____	-15.0±1.0
-5V Monitor	B	_____	-5.25±0.25
Disc Ref Mon.	B	_____	+3.00±0.02

_____ Insp. _____ Date

DATA SHEET 1 (Cont.)

2.1.17	Actual Value	Acceptable Value
Heater	_____	+30.0 ± 0.5 Vdc
Electronics	_____	+30.0 ± 0.5 Vdc
Detector Bias	_____	+30.0 ± 0.5 Vdc

Insp. Date

2.1.18 High Voltage Current Consumption

Current Sink	Actual Value	Acceptable Value
Heater	_____ mA	10 ± 5 mA
Electronics	_____	≤ 560
Detector Bias	_____	≤ 30

Insp. Date

DATA SHEET 1 (Cont.)

2.1.19 High Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	_____ Vdc	+5.00±0.25 Vdc
+8V Monitor	A	_____	+8.10±0.15
-8V Monitor	A	_____	-8.15±0.15
+25V Monitor	A	_____	+25.50±0.75
+350V Monitor	A	_____	+350.±15.
-15V Monitor	A	_____	-15.0±1.0
-5V Monitor	A	_____	-5.25±0.25
Disc Ref Mon.	A	_____	+3.00±0.02
+5V Monitor	B	_____	+5.00±0.25
+8V Monitor	B	_____	+8.10±0.15
-8V Monitor	B	_____	-8.15±0.15
+25V Monitor	B	_____	+25.50±0.75
+350V Monitor	B	_____	+350.±15.
-15V Monitor	B	_____	-15.0±1.0
-5V Monitor	B	_____	-5.25±0.25
Disc Ref Mon.	B	_____	+3.00±0.02

 Insp. Date

DATA SHEET 1 (Cont.)

2.1.20 Temperature Measurement

Parameter	Prime Frame	Measured Value	Acceptable Limits
Package Temperature Monitor	A	_____ °C	50°F to 118°F = 10°C to 48°C
Package Temperature Monitor	B	_____	↓
Detector Plate Temperature Monitor	A	_____	_____
Detector Plate Temperature Monitor	B	_____	_____

Insp. Date

2.1.21 Detector Leakage Current Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	_____ μA	1.0 μA
B	_____	2.0 μA
C	_____	2.0 μA
D	_____	2.0 μA
E	_____	2.0 μA

Insp. Date

DATA SHEET 1 (Cont.)

2.1.22 Detector Resolution Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	_____ keV	50. keV
B	_____	50. keV
C	_____	50. keV
D	_____	50. keV
E	_____	50. keV

Insp. Date

2.1.25 Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	_____	14 or 16
B	E2	_____	14 or 16
C	E3	_____	14 or 16
D	E4	_____	14 or 16
E	P6	_____	14 or 16

Insp. Date

DATA SHEET 1 (Cont.)

2.1.26 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	_____	14 or 16
B	P2	_____	14 or 16
C	P3	_____	14 or 16
D	P4	_____	14 or 16
E	P5	_____	14 or 16

_____ Insp. _____ Date

2.1.28 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable
A	E1	_____	2032 or 2048
A	E2	_____	2032 or 2048
C	E3	_____	2032 or 2048
D	E4	_____	2032 or 2048
E	P6	_____	2032 or 2048

_____ Insp. _____ Date

DATA SHEET 1 (Cont.)

2.1.29 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	_____	2032 or 2048
B	P2	_____	2032 or 2048
C	P3	_____	2032 or 2048
D	P4	_____	2032 or 2048
E	P5	_____	2032 or 2048

Insp. Date

2.1.31 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	_____	260,096 or 262,144
B	E2	_____	260,096 or 262,144
C	E3	_____	260,096 or 262,144
D	E4	_____	260,096 or 262,144
E	P6	_____	260,096 or 262,144

Insp. Date

DATA SHEET 1 (Cont.)

2.1.32 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	_____	260,096 or 262,144
B	P2	_____	260,096 or 262,144
C	P3	_____	260,096 or 262,144
D	P4	_____	260,096 or 262,144
E	P6	_____	260,096 or 262,144

Insp. Date

2.1.34 Electron 1, Electron 2, Electron 3, Electron 4 and
Proton 6 33,554,430 pulse data accumulation test.

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	_____	33,292,288 or 0
B	E2	_____	33,292,288 or 0
C	E3	_____	33,292,288 or 0
D	E4	_____	33,292,288 or 0
E	P6	_____	33,292,288 or 0

Insp. Date

DATA SHEET 1 (Cont.)

2.1.35 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
33,554,430 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	_____	33,292,288 or 0
B	P2	_____	33,292,288 or 0
C	P3	_____	33,292,288 or 0
D	P4	_____	33,292,288 or 0
E	P5	_____	33,292,288 or 0

Insp. Date

2.1.36 Visual inspection


Insp. Date

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
DATA SHEET 2

2.2 THERMAL/VACUUM TEST

2.2.1 Test article and BTE to Building 33, NASA/MSC

Insp.  1-21-72 BEC
Date


2.2.2 Prepare chamber and test fixture

Insp.  1-21-72 BEC
Date

2.2.3 Install test article

Insp. 1-21-72 BEC
Date

2.2.4 Connect BTE


Insp.  1-21-72 BEC
Date

DATA SHEET 2 (Cont.)

2.1.4 Heater Power

Measured Value
27.54


Acceptable Value
 $+27.5 \pm 0.5$ Vdc


Insp. 1-21-72
Date

2.1.5 Medium Voltage Heater Current

Measured Value
7

Acceptable Value
 10 ± 5 mA


Insp. 1-21-72
Date

DATA SHEET 2 (Cont.)

2.1.6 Electronic Power

Measured Value

27.44

Acceptable Value

+27.5 ± 0.5 Vdc



Insp.

Date

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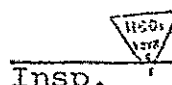
2.1.7 Medium Voltage Electronics Current

Measured Value

508

Maximum Value

560 mA



Insp.

Date

1-21-72

2.1.8 Detector Bias

Measured Value

OFF

Acceptable Value

+27.5 ± 0.5 Vdc

Ref Caution Page 10



Insp.

Date

1-21-72

2.1.9 Medium Voltage Detector Bias Current

Measured Value

OFF

Maximum Value

30 mA

Ref Caution Page 10.



Insp.

Date

1-21-72

DATA SHEET 2 (Cont.)

2.1.11 Medium Voltage ADC Checkout

Reference Input Voltage	Measured Electrical Unit Output Voltage	Acceptable Electrical Output Unit Voltage
+0.025±0.001 Vdc	<u>.024</u> Vdc	+0.025±0.010 Vdc
+0.050±0.001	<u>.048</u>	0.050±0.010
+0.100±0.001	<u>.097</u>	0.100±0.010
+1.000±0.001	<u>.997</u>	1.000±0.010
+2.000±0.001	<u>1.999</u>	2.000±0.010
+3.000±0.001	<u>2.996</u>	+3.000±0.010
+4.000±0.001	<u>3.998</u>	+4.000±0.015
+4.900±0.001	<u>4.897</u>	+4.900±0.020



Insp.

Date

1-21-72

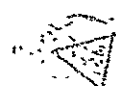
DATA SHEET 2 (Cont.)

2.1.13 Medium Voltage Housekeeping Parameter Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Engineering Unit Value
+5V Monitor	A	<u>5.121</u> vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.145</u>	+8.10±0.15
-8V Monitor	A	<u>-8.209</u>	-8.15±0.15
+25V Monitor	A	<u>25.642</u>	+25.50±0.75
+350V Monitor	A	<u>24.24</u>	+350.±15.0
-15V Monitor	A	<u>-16.042</u>	-15.0±1.0
-5V Monitor	A	<u>-5.433</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.131</u>	+5.00±0.25
+8V Monitor	B	<u>8.155</u>	+8.10±0.15
-8V Monitor	B	<u>-8.193</u>	-8.15±0.15
+25V Monitor	B	<u>25.642</u>	+25.50±0.75
+350V Monitor	B	<u>24.24</u>	+350.±15.0
-15V Monitor	B	<u>-16.042</u>	-15.0±1.0
-5V Monitor	B	<u>-5.433</u>	-5.25±0.25
Disc Ref Mon.	-	<u>3.000</u>	+3.000±0.02

Set Bias OFF
Ref Caution
Range R


DR EPS

Insp.  1-21-72
Date

2.1.14


	Actual Value	Acceptable Value
Heater	<u>25.37</u>	+25.0 ± 0.5 Vdc
Electronics	<u>24.49</u>	+25.0 ± 0.5 Vdc
Detector Bias	<u>OFF</u>	+25.0 ± 0.5 Vdc

Ref Caution
Percept 10


Insp.  1-21-71
Date

DATA SHEET 2 (Cont.)

2.1.15 Low Voltage Current Consumption

Current Sink	Measured Current	Acceptable Value
Heater	<u>7</u> mA	10 ± 5 mA
Electronics	<u>543</u>	≤ 560
Detector Bias	<u>OFF</u>	≤ 30.
Ref Caution Page 10		
Insp.		Date <u>1-21-72</u>

2.1.16 Low Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.121</u> vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.135</u>	+8.10±0.15
-8V Monitor	A	<u>-8.203</u>	-8.15±0.15
+25V Monitor	A	<u>25.642</u>	+25.50±0.75
+350 V Monitor	A	<u>24.24</u>	+350.±15.
-15V Monitor	A	<u>-16.006</u>	-15.0±1.0
-5V Monitor	A	<u>-5.430</u>	-5.25±0.25
Disc Ref Mon.	A	<u>3.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.121</u>	+5.00±0.25
+8V Monitor	B	<u>8.145</u>	+8.10±0.15
-8V Monitor	B	<u>-8.187</u>	-8.15±0.15
+25V Monitor	B	<u>25.642</u>	+25.50±0.75
+350V Monitor	B	<u>24.24</u>	+350.±15.
-15V Monitor	B	<u>-15.984</u>	-15.0±1.0
-5V Monitor	B	<u>-5.417</u>	-5.25±0.25
Disc Ref Mon.	B	<u>3.000</u>	+3.00±0.02
Ref Caution Page 10			
			Date <u>1-21-71</u>
		Insp.	

DR-EP5007

DATA SHEET 2 (Cont.)

2.1.17	Actual Value	Acceptable Value
Heater	<u>29.98</u>	+30.0 ± 0.5 Vdc
Electronics	<u>29.96</u>	+30.0 ± 0.5 Vdc
Detector Bias	<u>OFF</u>	+30.0 ± 0.5 Vdc

*Ref Caution
Page 10*

Insp.  Date 1-21-72

2.1.18 High Voltage Current Consumption

Current Sink	Actual Value	Acceptable Value
Heater	<u>7</u> mA	10 ± 5 mA
Electronics	<u>490</u>	≤ 560
Detector Bias	<u>OFF</u>	≤ 30

*Ref Caution
Page 10*

Insp.  Date 1-21-72

DATA SHEET 2 (Cont.)

2.1.19 High Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.131</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.155</u>	+8.10±0.15
-8V Monitor	A	<u>-8.193</u>	-8.15±0.15
+25V Monitor	A	<u>25.642</u>	+25.50±0.75
+350V Monitor	A	<u>24.24</u>	+350.±15.
-15V Monitor	A	<u>-16.019</u>	-15.0±1.0
-5V Monitor	A	<u>-5.420</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.131</u>	+5.00±0.25
+8V Monitor	B	<u>8.155</u>	+8.10±0.15
-8V Monitor	B	<u>-8.193</u>	-8.15±0.15
+25V Monitor	B	<u>25.696</u>	+25.50±0.75
+350V Monitor	B	<u>24.24</u>	+350.±15.
-15V Monitor	B	<u>-16.019</u>	-15.0±1.0
-5V Monitor	B	<u>-5.420</u>	-5.25±0.25
Disc Ref Mon.	B	<u>3.000</u>	+3.00±0.02

Ref Con -
Page 10
DR- EPS 503

Insp. _____ Date 1-26-72

DATA SHEET 2 (Cont.)


2.1.20 Temperature Measurement

Parameter	Prime Frame	Measured Value
Package Temperature Monitor	A	<u>31.18</u> °C
Package Temperature Monitor	B	<u>31.18</u>
Detector Plate Temperature Monitor	A	<u>27.17</u>
Detector Plate Temperature Monitor	B	<u>27.17</u>

Insp.  Date 1-21-72

2.1.21 Detector Leakage Current Test


EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>Not as per required</u> μA	1.0 μA
B	<u>Not as per required</u>	2.0 μA
C	<u>Not as per required</u>	2.0 μA
D	<u>Not as per required</u>	2.0 μA
E	<u>Not as per required</u>	2.0 μA

BE Outages  Date 1-21-72

DATA SHEET 2 (Cont.)

2.1.22 Detector Resolution Test


EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	Not Required	50. keV
B	Required ✓	50. keV
C	Per 2.1.22	50. keV
D	Per 2.1.22	50. keV
E	Per 2.1.22	50. keV



 Insp. _____ Date 1-21-72

2.1.25 Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>14</u>	14 or 16
B	E2	<u>16</u>	14 or 16
C	E3	<u>14</u>	14 or 16
D	E4	<u>14</u>	14 or 16
E	P6	<u>14</u>	14 or 16



 Insp. _____ Date 1-21-71

DATA SHEET 2 (Cont.)


2.1.26 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5.
14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>14</u>	14 or 16
B	P2	<u>14</u>	14 or 16
C	P3	<u>14</u>	14 or 16
D	P4	<u>14</u>	14 or 16
E	P5	<u>14</u>	14 or 16


 Insp. _____ Date 1-21-72

2.1.28 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 2046 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>2032</u>	2032 or 2048
A	E2	<u>2048</u>	2032 or 2048
C	E3	<u>2032</u>	2032 or 2048
D	E4	<u>2032</u>	2032 or 2048
E	P6	<u>2032</u>	2032 or 2048


 Insp. _____ Date 1-21-72

DATA SHEET 2 (Cont.)

2.1.29 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>2032</u>	2032 or 2048
B	P2	<u>2032</u>	2032 or 2048
C	P3	<u>2032</u>	2032 or 2048
D	P4	<u>2032</u>	2032 or 2048
E	P5	<u>2032</u>	2032 or 2048


 Insp. _____ Date 1-21-72

2.1.31 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>260,096</u>	260,096 or 262,144
B	E2	<u>260,096</u>	260,096 or 262,144
C	E3	<u>260,096</u>	260,096 or 262,144
D	E4	<u>260,096</u>	260,096 or 262,144
E	P6	<u>260,096</u>	260,096 or 262,144



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*DATA SHEET 2 (Cont.)

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2.1.32 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>260 096</u>	260,096 or 262,144
B	P2	<u>260 096</u>	260,096 or 262,144
C	P3	<u>260 096</u>	260,096 or 262,144
D	P4	<u>260 096</u>	260,096 or 262,144
E	P6	<u>260 096</u>	260,096 or 262,144




Date 1-21-72

Insp. _____

2.1.34 Electron 1, Electron 2, Electron 3, Electron 4 and
Proton 6 33,554,430 pulse data accumulation test.

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>33,292,288</u>	33,292,288 or 0
B	E2	<u>33,292,288</u>	33,292,288 or 0
C	E3	<u>33,292,288</u>	33,292,288 or 0
D	E4	<u>33,292,288</u>	33,292,288 or 0
E	P6	<u>33,292,288</u>	33,292,288 or 0




Date 1-21-72

Insp. _____

DATA SHEET 2 (Cont.)

2.1.35 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
 33,554,430 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>33,292,288</u>	33,292,288 or 0
B	P2	<u>33,292,288</u>	33,292,288 or 0
C	P3	<u>33,292,288</u>	33,292,288 or 0
D	P4	<u>33,292,288</u>	33,292,288 or 0
E	P5	<u>33,292,288</u>	33,292,288 or 0



Insp. _____ Date 1-21-71


DATA SHEET 2 (Cont.)

2.2.6 Pump down




Insp. 1-24-71
Date

2.2.7 Set test case 1



Insp. 1-24-71
Date

2.2.8 Output Power Voltage Switch to 'Medium'




Insp. 1-24-71
Date

2.2.9 Electronics Power Switch to 'ON'



Insp. 1-24-71
Date

2.2.10 Heater Power Switch to 'ON'




Insp. 1-24-71
Date

2.2.11 Detector Bias Switch to 'ON'



Insp. 1-24-71
Date


2.2.12 Activate BTE Controller and Display



Insp. 1-24-71
Date

2.2.13 Record temperatures Cont'd

<u>Elapsed Time</u>	<u>Package Temp</u>	<u>Det Temp</u>
<u>14:30/11</u>	<u>2.939</u>	<u>-18.770</u>
<u>15:00/11.5</u>	<u>3.124</u>	<u>-18.379</u>
<u>15:30/12</u>	<u>3.710</u>	<u>-17.988</u>
<u>16:00/12.5</u>	<u>4.199</u>	<u>-17.499</u>
<u>16:30/13</u>	<u>4.687</u>	<u>-17.108</u>
<u>17:00/13.5</u>	<u>5.18</u>	<u>-16.91</u>
<u>_____</u>	<u>_____</u>	<u>_____</u>
<u>_____</u>	<u>_____</u>	<u>_____</u>
<u>_____</u>	<u>_____</u>	<u>_____</u>
<u>_____</u>	<u>_____</u>	<u>_____</u>
<u>_____</u>	<u>_____</u>	<u>_____</u>
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<u>_____</u>	<u>_____</u>	<u>_____</u>
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<u>_____</u>	<u>_____</u>	<u>_____</u>


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Date


DATA SHEET 2 (Cont.)

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2.2.13 Record temperatures

<u>Elapsed Time</u>	<u>Package Monitor</u>	<u>Detector Monitor</u>	<u>Elapsed Time</u>	<u>Package Monitor</u>	<u>Detector Monitor</u>
0330/0 hrs	22.7	21.7	0900/5.5	8.40	-18.09
0400/0.5 hrs	26.0	22.9	0930/6	6.35	-19.75
0430/1	29.0	18.5	10:13/6.5	3.417	-22.194
0500/1.5	28.0	5.4	10:30/7.0	2.342	-23.168
0530/2	25.3	-0.2	11:00/7.5	.582	-24.537
0600/2.5	23.06	-4.21	11:20/8	-0.981	-25.807
0630/3	20.52	-7.14	1200/8.5	-1.0774	-25.416
0700/3.5	17.79	-9.73	12:30/9	-0.59	-22.093
0730/4	15.44	-12.03	13:00/9.5	+0.91	-20.822
0800/4.5	12.90	-14.27	13:30/10	+0.973	-20.040
0830/5	10.75	-16.13	14:00/10.5	1.755	-19.356

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2.2.14 Soak at stabilized temperature

<u>Elapsed Time</u>	<u>Package Monitor</u>	<u>Detector Monitor</u>
1500/11.5	3.12	-18.38
1530/12	3.71	-18.0
1600/12.5	4.20	-17.5
1630/13	4.69	-17.11
1700/13.5	5.18	-16.91



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SHEET 2 (Cont.)

2.1.4 Heater Power

Measured Value

27.52

Acceptable Value

+27.5 ± 0.5 Vdc

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2.1.5 Medium Voltage Heater Current

Measured Value

206 ma

Acceptable Value

200 ± 25 mA

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DATA SHEET 2 (Cont.)

2.1.6 Electronic Power

Measured Value

27.44

Acceptable Value

 $+27.5 \pm 0.5$ Vdc


 Insp. _____ Date 1-24-72

2.1.7 Medium Voltage Electronics Current

Measured Value

515 ma

Maximum Value

560 mA




 Insp. _____ Date 1-24-72

2.1.8 Detector Bias

Measured Value

27.55

Acceptable Value

 $+27.5 \pm 0.5$ Vdc


 Insp. _____ Date 1-24-72


2.1.9 Medium Voltage Detector Bias Current

Measured Value

20 ma

Maximum Value

30 mA




 Insp. _____ Date 1-24-72

DATA SHEET 2 (Cont.)

2.1.11 Medium Voltage ADC Checkout

Reference Input Voltage	Measured Electrical Unit Output Voltage	Acceptable Electrical Output Unit Voltage
+0.025±0.001 Vdc	<u>.024</u> Vdc	+0.025±0.010 Vdc
+0.050±0.001	<u>.048</u>	0.050±0.010
+0.100±0.001	<u>.097</u>	0.100±0.010
+1.000±0.001	<u>.997</u>	1.000±0.010
+2.000±0.001	<u>1.994</u>	2.000±0.010
+3.000±0.001	<u>2.996</u>	+3.000±0.010
+4.000±0.001	<u>3.993</u>	+4.000±0.015
+4.900±0.001	<u>4.892</u>	+4.900±0.020


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DATA SHEET 2 (Cont.)

2.1.13 Medium Voltage Housekeeping Parameter Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Engineering Unit Value
+5V Monitor	A	<u>5.102</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.126</u>	+8.10±0.15
-8V Monitor	A	<u>-8.160</u>	-8.15±0.15
+25V Monitor	A	<u>25.588</u>	+25.50±0.75
+350V Monitor	A	<u>346.33</u>	+350.±15.
-15V Monitor	A	<u>-16.049</u>	-15.0±1.0
-5V Monitor	A	<u>-5.386</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.989</u>	+3.00±0.02
+5V Monitor	B	<u>5.111</u>	+5.00±0.25
+8V Monitor	B	<u>8.126</u>	+8.10±0.15
-8V Monitor	B	<u>-8.160</u>	-8.15±0.15
+25V Monitor	B	<u>25.588</u>	+25.50±0.75
+350V Monitor	B	<u>346.33</u>	+350.±15.
-15V Monitor	B	<u>-16.049</u>	-15.0±1.0
-5V Monitor	B	<u>-5.386</u>	-5.25±0.25
Disc Ref Mon.	-	<u>2.995</u>	+3.000±0.02



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2.1.14

	Actual Value	Acceptable Value
Heater	<u>25.36</u>	+25.0 ± 0.5 Vdc
Electronics	<u>25.00</u>	+25.0 ± 0.5 Vdc
Detector Bias	<u>25.01</u>	+25.0 ± 0.5 Vdc



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DATA SHEET 2 (Cont.)

2.1.15 Low Voltage Current Consumption

Current Sink	Measured Current	Acceptable Value
Heater	<u>190</u> mA	180 ± 25 mA
Electronics	<u>545</u>	≤ 560
Detector Bias	<u>20</u>	≤ 30
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		Date

2.1.16 Low Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.102</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.116</u>	+8.10±0.15
-8V Monitor	A	<u>-8.154</u>	-8.15±0.15
+25V Monitor	A	<u>25.535</u>	+25.50±0.75
+350 V Monitor	A	<u>345.84</u>	+350.±15.
-15V Monitor	A	<u>-16.013</u>	 15.0±1.0
-5V Monitor	A	<u>-5.383</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.989</u>	+3.00±0.02
+5V Monitor	B	<u>5.102</u>	+5.00±0.25
+8V Monitor	B	<u>8.116</u>	+8.10±0.15
-8V Monitor	B	<u>-8.138</u>	-8.15±0.15
+25V Monitor	B	<u>25.588</u>	+25.50±0.75
+350V Monitor	B	<u>346.33</u>	+350.±15.
-15V Monitor	B	<u>-16.013</u>	 15.0±1.0
-5V Monitor	B	<u>-5.370</u>	-5.25±0.25
Disc Ref Mon.	B	<u>2.995</u>	+3.00±0.02

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DATA SHEET 2 (Cont.)

2.1.17	Actual Value	Acceptable Value
Heater	<u>29.96</u>	+30.0 ± 0.5 Vdc
Electronics	<u>29.97</u>	+30.0 ± 0.5 Vdc
Detector Bias	<u>30.07</u>	+30.0 ± 0.5 Vdc


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2.1.18 High Voltage Current Consumption

Current Sink	Actual Value	Acceptable Value
Heater	<u>224</u> mA	225 ± 25 mA
Electronics	<u>490</u>	≤ 560
Detector Bias	<u>20</u>	≤ 30


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DATA SHEET 2 (Cont.)

2.1.19 High Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.111</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.126</u>	+8.10±0.15
-8V Monitor	A	<u>-8.181</u>	-8.15±0.15
+25V Monitor	A	<u>25.583</u>	+25.50±0.75
+350V Monitor	A	<u>346.33</u>	+350.±15.
-15V Monitor	A	<u>-16.085</u>	-15.0±1.0
-5V Monitor	A	<u>-5.401</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.989</u>	+3.00±0.02
+5V Monitor	B	<u>5.111</u>	+5.00±0.25
+8V Monitor	B	<u>8.135</u>	+8.10±0.15
-8V Monitor	B	<u>-8.166</u>	-8.15±0.15
+25V Monitor	B	<u>25.588</u>	+25.50±0.75
+350V Monitor	B	<u>346.33</u>	+350.±15.
-15V Monitor	B	<u>-16.062</u>	-15.0±1.0
-5V Monitor	B	<u>-5.389</u>	-5.25±0.25
Disc Ref Mon.	B	<u>2.995</u>	+3.00±0.02

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DATA SHEET 2 (Cont.)

2.1.20 Temperature Measurement


Parameter	Prime Frame	Measured Value
Package Temperature Monitor	A	<u>5.274</u> °C
Package Temperature Monitor	B	<u>5.274</u>
Detector Plate Temperature Monitor	A	<u>-16.815</u>
Detector Plate Temperature Monitor	B	<u>-16.815</u>



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2.1.21 Detector Leakage Current Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>.067</u> μA	1.0 μA
B	<u>.021</u>	2.0 μA
C	<u>.117</u>	2.0 μA
D	<u>.030</u>	2.0 μA
E	<u>.021</u>	2.0 μA




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DATA SHEET 2 (Cont.)


2.1.22 Detector Resolution Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>6</u> keV	50. keV
B	<u>5</u>	50. keV
C	<u>5</u>	50. keV
D	<u>5</u>	50. keV
E	<u>6</u>	50. keV


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2.1.25 Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 14 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>14</u>	14 or 16
B	E2	<u>16</u>	14 or 16
C	E3	<u>14</u>	14 or 16
D	E4	<u>14</u>	14 or 16
E	P6	<u>14</u>	14 or 16


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DATA SHEET 2 (Cont.)


2.1.26 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5.
14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>14</u>	14 or 16
B	P2	<u>14</u>	14 or 16
C	P3	<u>14</u>	14 or 16
D	P4	<u>14</u>	14 or 16
E	P5	<u>14</u>	14 or 16


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2.1.28 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 2046 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>2032</u>	2032 or 2048
A	E2	<u>2032</u>	2032 or 2048
C	E3	<u>2032</u>	2032 or 2048
D	E4	<u>2032</u>	2032 or 2048
E	P6	<u>2032</u>	2032 or 2048


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DATA SHEET 2 (Cont.)

2.1.29 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
2046 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>2032</u>	2032 or 2048
B	P2	<u>2032</u>	2032 or 2048
C	P3	<u>2032</u>	2032 or 2048
D	P4	<u>2032</u>	2032 or 2048
E	P5	<u>2032</u>	2032 or 2048



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2.1.31 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>260 096</u>	260,096 or 262,144
B	E2	<u>260 144</u>	260,096 or 262,144
C	E3	<u>260 096</u>	260,096 or 262,144
D	E4	<u>260 144</u>	260,096 or 262,144
E	P6	<u>260 096</u>	260,096 or 262,144




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DATA SHEET 2 (Cont.)


2.1.32 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>260 096</u>	260,096 or 262,144
B	P2	<u>260 096</u>	260,096 or 262,144
C	P3	<u>260 096</u>	260,096 or 262,144
D	P4	<u>260 096</u>	260,096 or 262,144
E	P6	<u>260 096</u>	260,096 or 262,144


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2.1.34 Electron 1, Electron 2, Electron 3, Electron 4 and
Proton 6 33,554,430 pulse data accumulation test.


EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>0</u>	33,292,288 or 0
B	E2	<u>0</u>	33,292,288 or 0
C	E3	<u>33,292,288</u>	33,292,288 or 0
D	E4	<u>0</u>	33,292,288 or 0
E	P6	<u>33,292,288</u>	33,292,288 or 0


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DATA SHEET 2 (Cont.)


2.1.35 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
33,554,430 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>33,292,288</u>	33,292,288 or 0
B	P2	<u>33,292,288</u>	33,292,288 or 0
C	P3	<u>33,292,288</u>	33,292,288 or 0
D	P4	<u>33,292,288</u>	33,292,288 or 0
E	P5	<u>33,292,288</u>	33,292,288 or 0




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2.2.19 Record Temperatures

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Elapsed Time	Package Monitor	Detector Monitor	Elapsed Time	Package Monitor	Detector Monitor
<u>1800/0</u>	<u>5.47</u>	<u>-16.52</u>	<u>0300/9.0</u>	<u>-23.95</u>	<u>-36.07</u>
<u>1830/0.5</u>	<u>2.93</u>	<u>-17.11</u>	<u>0330/9.5</u>	<u>-24.41</u>	<u>-36.16</u>
<u>1900/1</u>	<u>-0.20</u>	<u>-18.87</u>	<u>0400/10.0</u>	<u>-24.93</u>	<u>-36.75</u>
<u>1930/1.5</u>	<u>-3.03</u>	<u>-20.72</u>	<u>0430/10.5</u>	<u>-25.32</u>	<u>-37.05</u>
<u>2000/2</u>	<u>-5.57</u>	<u>-22.58</u>	<u>0500/11.0</u>	<u>-25.71</u>	<u>-37.34</u>
<u>2030/2.5</u>	<u>-8.02</u>	<u>-24.34</u>	<u>0530/11.5</u>	<u>-26.10</u>	<u>-37.54</u>
<u>2100/3</u>	<u>-10.36</u>	<u>-26.00</u>	<u>0600/12.00</u>	<u>-26.39</u>	<u>-37.83</u>
<u>2130/3.5</u>	<u>-12.42</u>	<u>-27.57</u>	<u>0630/12.5</u>	<u>-26.59</u>	<u>-38.03</u>
<u>2200/4</u>	<u>-13.98</u>	<u>-28.84</u>	<u>0700/13.00</u>	<u>-26.88</u>	<u>-38.23</u>
<u>2030/4.5</u>	<u>-15.64</u>	<u>-30.01</u>	<u>0730/13.5</u>	<u>-27.08</u>	<u>-38.32</u>
<u>2300/5</u>	<u>-17.11</u>	<u>-31.08</u>	<u>0800/14.00</u>	_____	_____
<u>2330/5.5</u>	<u>-18.38</u>	<u>-32.06</u>	_____	_____	_____
<u>2400/6</u>	<u>-19.55</u>	<u>-32.94</u>	_____	_____	_____
<u>0030/6.5</u>	<u>-20.73</u>	<u>-33.72</u>	_____	_____	_____
<u>0100/7</u>	<u>-21.51</u>	<u>-34.31</u>	_____	_____	_____
<u>0130/7.5</u>	<u>-22.29</u>	<u>-34.90</u>	_____	_____	_____
<u>0200/8.0</u>	<u>-22.78</u>	<u>-35.39</u>	_____	_____	_____
<u>0230/8.5</u>	<u>-23.36</u>	<u>-35.68</u>	_____	_____	_____


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DATA SHEET 2 (Cont.)

2.2.16 BTE to Housekeeping mode




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2.2.17 Electronics Power Switch to 'OFF'




Insp. 1-24-72 Date

2.2.18 Detector Bias Switch to 'OFF'




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2.2.19 Repeat step 2.2.13



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2.2.20 Repeat step 2.2.14



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DATA SHEET 2 (Cont.)


2.1.4 Heater Power

Measured Value

27.53

Acceptable Value

$+27.5 \pm 0.5$ Vdc


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2.1.5 Medium Voltage Heater Current

Measured Value

206

Acceptable Value

200 ± 25 mA

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DATA SHEET 2 (Cont.)


2.1.6 Electronic Power

Measured Value

27.45

Acceptable Value

+27.5 ± 0.5 Vdc


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2.1.7 Medium Voltage Electronics Current

Measured Value

515

Maximum Value

560 mA


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2.1.8 Detector Bias

Measured Value

27.56

Acceptable Value

+27.5 ± 0.5 Vdc


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2.1.9 Medium Voltage Detector Bias Current

Measured Value

20

Maximum Value

30 mA


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DATA SHEET 2 (Cont.)

2.1.11 Medium Voltage ADC Checkout

Reference Input Voltage	Measured Electrical Unit Output Voltage	Acceptable Electrical Output Unit Voltage
+0.025±0.001 Vdc	<u>.024</u> Vdc	+0.025±0.010 Vdc
+0.050±0.001	<u>.048</u>	0.050±0.010
+0.100±0.001	<u>.097</u>	0.100±0.010
+1.000±0.001	<u>.997</u>	1.000±0.010
+2.000±0.001	<u>1.994</u>	2.000±0.010
+3.000±0.001	<u>2.991</u>	+3.000±0.010
+4.000±0.001	<u>3.993</u>	+4.000±0.015
+4.900±0.001	<u>4.887</u>	+4.900±0.020


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2.1.13 Medium Voltage Housekeeping Parameter Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Engineering Unit Value
+5V Monitor	A	<u>5.053</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.067</u>	+8.10±0.15
-8V Monitor	A	<u>-8.099</u>	-8.15±0.15
+25V Monitor	A	<u>25.373</u>	+25.50±0.75
+350V Monitor	A	<u>346.33</u>	+350.±15.
-15V Monitor	A	<u>-16.075</u>	-15.0±1.0
-5V Monitor	A	<u>-5.319</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.989</u>	+3.00±0.02
+5V Monitor	B	<u>5.063</u>	+5.00±0.25
+8V Monitor	B	<u>8.077</u>	+8.10±0.15
-8V Monitor	B	<u>-8.099</u>	-8.15±0.15
+25V Monitor	B	<u>25.427</u>	+25.50±0.75
+350V Monitor	B	<u>346.33</u>	+350.±15.
-15V Monitor	B	<u>-16.075</u>	-15.0±1.0
-5V Monitor	B	<u>-5.319</u>	-5.25±0.25
Disc Ref Mon.	B	<u>2.989</u>	+3.000±0.02

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2.1.14


	Actual Value	Acceptable Value
Heater	<u>25.36</u>	+25.0 ± 0.5 Vdc
Electronics	<u>25.01</u>	+25.0 ± 0.5 Vdc
Detector Bias	<u>25.01</u>	+25.0 ± 0.5 Vdc

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
8.25 Am Power Up in Bldg 33
 PCB Temp = -27.76 °C
 Det Plate Temp = -41.94 °C

DATA SHEET 2 (Cont.)

2.1.15 Low Voltage Current Consumption

Current Sink	Measured Current	Acceptable Value
Heater	<u>190</u> mA	180 ± 25 mA
* Electronics	<u>555</u>	≤ 560
* Detector Bias	<u>20</u>	≤ 30
Insp.		Date <u>1-25-72</u>

2.1.16 Low Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.043</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.047</u>	+8.10±0.15
-8V Monitor	A	<u>-8.087</u>	-8.15±0.15
+25V Monitor	A	<u>25.320</u>	+25.50±0.75
+350 V Monitor	A	<u>346.33</u>	+350.±15.
-15V Monitor	A	<u>-16.049</u>	-15.0±1.0
-5V Monitor	A	<u>-5.300</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.989</u>	+3.00±0.02
+5V Monitor	B	<u>5.043</u>	+5.00±0.25
+8V Monitor	B	<u>8.057</u>	+8.10±0.15
-8V Monitor	B	<u>-8.071</u>	-8.15±0.15
+25V Monitor	B	<u>25.320</u>	+25.50±0.75
+350V Monitor	B	<u>346.33</u>	+350.±15.
-15V Monitor	B	<u>-16.026</u>	-15.0±1.0
-5V Monitor	B	<u>-5.300</u>	-5.25±0.25
Disc Ref Mon.	B	<u>2.989</u>	+3.00±0.02
Insp.		Date <u>1-25-72</u>	

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DATA SHEET 2 (Cont.)


2.1.17

	Actual Value	Acceptable Value
Heater	<u>29.96</u>	+30.0 ± 0.5 Vdc
Electronics	<u>29.97</u>	+30.0 ± 0.5 Vdc
Detector Bias	<u>30.07</u>	+30.0 ± 0.5 Vdc

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2.1.18 High Voltage Current Consumption

Current Sink	Actual Value	Acceptable Value
Heater	<u>225</u> mA	225 ± 25 mA
Electronics	<u>491</u>	< 560
Detector Bias	<u>20</u>	< 30

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DATA SHEET 2 (Cont.)

2.1.19 High Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.053</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.067</u>	+8.10±0.15
-8V Monitor	A	<u>-8.099</u>	-8.15±0.15
+25V Monitor	A	<u>25.373</u>	+25.50±0.75
+350V Monitor	A	<u>346.33</u>	+350.±15.
-15V Monitor	A	<u>-16.075</u>	-15.0±1.0
-5V Monitor	A	<u>-5.319</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.989</u>	+3.00±0.02
+5V Monitor	B	<u>5.063</u>	+5.00±0.25
+8V Monitor	B	<u>8.077</u>	+8.10±0.15
-8V Monitor	B	<u>-8.083</u>	-8.15±0.15
+25V Monitor	B	<u>25.427</u>	+25.50±0.75
+350V Monitor	B	<u>346.33</u>	+350.±15.
-15V Monitor	B	<u>-16.052</u>	-15.0±1.0
-5V Monitor	B	<u>-5.306</u>	-5.25±0.25
Disc Ref Mon.	B	<u>2.989</u>	+3.00±0.02

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DATA SHEET 2 (Cont.)


2.1.20 Temperature Measurement

Parameter	Prime Frame	Measured Value
Package Temperature Monitor	A	<u>-27.86 °C</u>
Package Temperature Monitor	B	<u>-27.86</u>
Detector Plate Temperature Monitor	A	<u>-41.84</u>
Detector Plate Temperature Monitor	B	<u>-41.84</u>

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2.1.21 Detector Leakage Current Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>0</u> μA	1.0 μA
B	<u>.003</u>	2.0 μA
C	<u>.011</u>	2.0 μA
D	<u>.063</u>	2.0 μA
E	<u>0</u>	2.0 μA

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DATA SHEET 2 (Cont.)

2.1.22 Detector Resolution Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>4</u> keV	50. keV
B	<u>5</u>	50. keV
C	<u>4</u>	50. keV
D	<u>3.5</u>	50. keV
E	<u>5</u>	50. keV

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2.1.25 Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 14 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>14</u>	14 or 16
B	E2	<u>14</u>	14 or 16
C	E3	<u>14</u>	14 or 16
D	E4	<u>14</u>	14 or 16
E	P6	<u>14</u>	14 or 16

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DATA SHEET 2 (Cont.)

2.1.26 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5.
14 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>14</u>	14 or 16
B	P2	<u>14</u>	14 or 16
C	P3	<u>14</u>	14 or 16
D	P4	<u>14</u>	14 or 16
E	P5	<u>14</u>	14 or 16



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2.1.28 Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable
A	E1	<u>2032</u>	2032 or 2048
A	E2	<u>2032</u>	2032 or 2048
C	E3	<u>2032</u>	2032 or 2048
D	E4	<u>2032</u>	2032 or 2048
E	P6	<u>2032</u>	2032 or 2048



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DATA SHEET 2 (Cont.)

2.1.29 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>2032</u>	2032 or 2048
B	P2	<u>2032</u>	2032 or 2048
C	P3	<u>2032</u>	2032 or 2048
D	P4	<u>2032</u>	2032 or 2048
E	P5	<u>2032</u>	2032 or 2048

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2.1.31 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>260 096</u>	260,096 or 262,144
B	E2	<u>260 144</u>	260,096 or 262,144
C	E3	<u>260 096</u>	260,096 or 262,144
D	E4	<u>260 096</u>	260,096 or 262,144
E	P6	<u>260 096</u>	260,096 or 262,144

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DATA SHEET 2 (Cont.)


2.1.32 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>260 096</u>	260,096 or 262,144
B	P2	<u>260 096</u>	260,096 or 262,144
C	P3	<u>260 096</u>	260,096 or 262,144
D	P4	<u>260 096</u>	260,096 or 262,144
E	P6	<u>260 096</u>	260,096 or 262,144

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2.1.34 Electron 1, Electron 2, Electron 3, Electron 4 and
Proton 6 33,554,430 pulse data accumulation test.

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>33,292,288</u>	33,292,288 or 0
B	E2	<u>0</u>	33,292,288 or 0
C	E3	<u>33,292,288</u>	33,292,288 or 0
D	E4	<u>33,292,288</u>	33,292,288 or 0
E	P6	<u>33,292,288</u>	33,292,288 or 0

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2.1.35 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
33,554,430 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>33,292,288</u>	33,292,288 or 0
B	P2	<u>33,292,288</u>	33,292,288 or 0
C	P3	<u>33,292,288</u>	33,292,288 or 0
D	P4	<u>33,292,288</u>	33,292,288 or 0
E	P5	<u>33,292,288</u>	33,292,288 or 0

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Elapsed Time	Package Temp.	Detector Temp.	Elapsed Time	Package Temp.	Detector Temp.
09:00/0	-25.42	-39.2			
09:30/0.5	-21.702	-33.92			
10:00/1	-17.597	-29.424			
10:30/1.5	-13.296	-25.807			
11:00/2.0	-9.386	-22.777			
11:00/2.5	Pinpoint	found			
11:30/3.0	-5.477	-19.943			
12:00/3.5	-2.251	-17.695			
12:30/4.0	+0.680	-15.544			
13:00/4.5	3.417	-13.687			
13:30/5.0	5.958	-11.830			
14:00/5.5	8.108	-10.266			
14:30/6.0	10.161	-8.8			
15:00	11.627	-7.529			
15:30	11.725	-7.041			
16:00	11.823	-6.943			
16:30	11.823	-6.845			
17:00	11.92	-6.845			
17:30	11.92	-6.845			
18:00	11.43	+0.19			

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DATA SHEET 2 (Cont.)

2.2.22 BTE to Housekeeping mode


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2.2.23 Set test case 3


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2.2.24 BTE (a) Electronics Power Switch 'ON'
 (b) Detector Bias Switch 'ON'
 (c) Heater Power Switch '~~OFF~~' → '(ON) P2C'


Ref Para.
2.2.24

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2.2.25 Repeat step 2.2.13

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2.2.26 Repeat step 2.2.14

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DATA SHEET 2 (Cont.)

2.1.4 Heater Power

Measured Value

27.54

Acceptable Value

$+27.5 \pm 0.5$ Vdc

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2.1.5 Medium Voltage Heater Current

Measured Value

7 MA

Acceptable Value

10 ± 5 mA

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DATA SHEET 2 (Cont.)


2.1.6 Electronic Power

Measured Value

27.44

Acceptable Value

+27.5 ± 0.5 Vdc

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2.1.7 Medium Voltage Electronics Current

Measured Value

512
(512 mA)

Maximum Value

560 mA

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2.1.8 Detector Bias

Measured Value

27.55

Acceptable Value

+27.5 ± 0.5 Vdc

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2.1.9 Medium Voltage Detector Bias Current

Measured Value

20 MA

Maximum Value

30 mA

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DATA SHEET 2 (Cont.)

2.1.11 Medium Voltage ADC Checkout

Reference Input Voltage	Measured Electrical Unit Output Voltage	Acceptable Electrical Output Unit Voltage
+0.025±0.001 Vdc	<u>0.024</u> Vdc	+0.025±0.010 Vdc
+0.050±0.001	<u>0.048</u>	0.050±0.010
+0.100±0.001	<u>0.097</u>	0.100±0.010
+1.000±0.001	<u>0.997</u>	1.000±0.010
+2.000±0.001	<u>1.994</u>	2.000±0.010
+3.000±0.001	<u>2.996</u>	+3.000±0.010
+4.000±0.001	<u>3.993</u>	+4.000±0.015
+4.900±0.001	<u>4.892</u>	+4.900±0.020


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DATA SHEET 2 (Cont.)

2.1.13 Medium Voltage Housekeeping Parameter Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Engineering Unit Value
+5V Monitor	A	<u>+5.111</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>+8.135</u>	+8.10±0.15
-8V Monitor	A	<u>-8.166</u>	-8.15±0.15
+25V Monitor	A	<u>+25.588</u>	+25.50±0.75
+350V Monitor	A	<u>+346.330</u>	+350.±15.
-15V Monitor	A	<u>-16.062</u>	-15.0±1.0
-5V Monitor	A	<u>-5.401</u>	-5.25±0.25
Disc Ref Mon.	A	<u>+2.995</u>	+3.00±0.02
+5V Monitor	B	<u>+5.111</u>	+5.00±0.25
+8V Monitor	B	<u>+8.135</u>	+8.10±0.15
-8V Monitor	B	<u>-8.166</u>	-8.15±0.15
+25V Monitor	B	<u>+25.642</u>	+25.50±0.75
+350V Monitor	B	<u>+346.330</u>	+350.±15.
-15V Monitor	B	<u>-16.039</u>	-15.0±1.0
-5V Monitor	B	<u>-5.389</u>	-5.25±0.25
Disc Ref Mon.	B	<u>+2.995</u>	+3.00±0.02

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2.1.14

	Actual Value	Acceptable Value
Heater	<u>25.37</u>	+25.0 ± 0.5 Vdc
Electronics	<u>25.00</u>	+25.0 ± 0.5 Vdc
Detector Bias	<u>25.01</u>	+25.0 ± 0.5 Vdc

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DATA SHEET 2 (Cont.)

2.1.15 Low Voltage Current Consumption

Current Sink	Measured Current	Acceptable Value
Heater	<u>7 MA</u> mA	10 ± 5 mA
Electronics	<u>543 MA</u>	≤ 560
Detector Bias	<u>20 MA</u>	≤ 30

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2.1.16 Low Voltage Housekeeping Checkout


Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>+5.111</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>+8.126</u>	+8.10±0.15
-8V Monitor	A	<u>-8.160</u>	-8.15±0.15
+25V Monitor	A	<u>+25.588</u>	+25.50±0.75
+350 V Monitor	A	<u>+346.330</u>	+350.±15.
-15V Monitor	A	<u>-16.026</u>	-15.0±1.0
-5V Monitor	A	<u>-5.398</u>	-5.25±0.25
Disc Ref Mon.	A	<u>+2.995</u>	+3.00±0.02
+5V Monitor	B	<u>+5.111</u>	+5.00±0.25
+8V Monitor	B	<u>+8.126</u>	+8.10±0.15
-8V Monitor	B	<u>-8.160</u>	-8.15±0.15
+25V Monitor	B	<u>+25.588</u>	+25.50±0.75
+350V Monitor	B	<u>+346.330</u>	+350.±15.
-15V Monitor	B	<u>-16.003</u>	-15.0±1.0
-5V Monitor	B	<u>-5.386</u>	-5.25±0.25
Disc Ref Mon.	B	<u>+2.995</u>	+3.00±0.02

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DATA SHEET 2 (Cont.)

2.1.17	Actual Value	Acceptable Value
Heater	<u>29.99</u>	+30.0 ± 0.5 Vdc
Electronics	<u>29.96</u>	+30.0 ± 0.5 Vdc
Detector Bias	<u>30.14</u>	+30.0 ± 0.5 Vdc

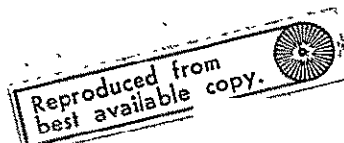

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2.1.18 High Voltage Current Consumption

Current Sink	Actual Value	Acceptable Value
Heater	<u>29.99 7</u> mA	10 ± 5 mA
Electronics	<u>490</u> mA	≤ 560
Detector Bias	<u>20</u> mA	≤ 30


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DATA SHEET 2 (Cont.)



2.1.19 High Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>+5.171</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>+8.135</u>	+8.10±0.15
-8V Monitor	A	<u>-8.187</u>	-8.15±0.15
+25V Monitor	A	<u>+25.588</u>	+25.50±0.75
+350V Monitor	A	<u>+346.330</u>	+350.±15.
-15V Monitor	A	<u>-16.075</u>	-15.0±1.0
-5V Monitor	A	<u>-5.404</u>	-5.25±0.25
Disc Ref Mon.	A	<u>+2.995</u>	+3.00±0.02
+5V Monitor	B	<u>+5.121</u>	+5.00±0.25
+8V Monitor	B	<u>+8.145</u>	+8.10±0.15
-8V Monitor	B	<u>-8.182</u>	-8.15±0.15
+25V Monitor	B	<u>+25.642</u>	+25.50±0.75
+350V Monitor	B	<u>+346.330</u>	+350.±15.
-15V Monitor	B	<u>-16.075</u>	-15.0±1.0
-5V Monitor	B	<u>-5.404</u>	-5.25±0.25
Disc Ref Mon.	B	<u>+2.995</u>	+3.00±0.02


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DATA SHEET 2 (Cont.)


2.1.20 Temperature Measurement

Parameter	Prime Frame	Measured Value
Package Temperature Monitor	A	<u>+11.925 °C</u>
Package Temperature Monitor	B	<u>+11.920</u>
Detector Plate Temperature Monitor	A	<u>-6.845</u>
Detector Plate Temperature Monitor	B	<u>-6.845</u>

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2.1.21 Detector Leakage Current Test


EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>+ .017</u> μA	1.0 μA
B	<u>+ .038</u>	2.0 μA
C	<u>+ .248</u>	2.0 μA
D	<u>.065</u>	2.0 μA
E	<u>.050</u>	2.0 μA

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DATA SHEET 2 (Cont.)


2.1.22 Detector Resolution Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>.361</u> keV	50. keV
B	<u>.312</u>	50. keV
C	<u>.308</u>	50. keV
D	<u>.337</u>	50. keV
E	<u>.347</u>	50. keV

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2.1.25 Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 14 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>14</u>	14 or 16
B	E2	<u>14</u>	14 or 16
C	E3	<u>14</u>	14 or 16
D	E4	<u>14</u>	14 or 16
E	P6	<u>14</u>	14 or 16

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2.1.26 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5.
14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>14</u>	14 or 16
B	P2	<u>14</u>	14 or 16
C	P3	<u>14</u>	14 or 16
D	P4	<u>14</u>	14 or 16
E	P5	<u>14</u>	14 or 16

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2.1.28 Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 2046 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>2032, 2048, 2048</u>	2032 or 2048
A	E2	<u>2048, 2032</u>	2032 or 2048
C	E3	<u>2048, 2032</u>	2032 or 2048
D	E4	<u>2032</u>	2032 or 2048
E	P6	<u>2048, 2032</u>	2032 or 2048

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DATA SHEET 2 (Cont.)


2.1.29 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>2032</u>	2032 or 2048
B	P2	<u>2032</u>	2032 or 2048
C	P3	<u>2032</u>	2032 or 2048
D	P4	<u>2032</u>	2032 or 2048
E	P5	<u>2032</u>	2032 or 2048.


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2.1.31 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>260096</u>	260,096 or 262,144
B	E2	<u>260096</u>	260,096 or 262,144
C	E3	<u>260096</u>	260,096 or 262,144
D	E4	<u>260096</u>	260,096 or 262,144
E	P6	<u>260096</u>	260,096 or 262,144


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2.1.32. Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>260,096</u>	260,096 or 262,144
B	P2	<u>260,096</u>	260,096 or 262,144
C	P3	<u>260,096</u>	260,096 or 262,144
D	P4	<u>260,096</u>	260,096 or 262,144
E	P6	<u>260,096</u>	260,096 or 262,144

1-25-72

Insp. _____ Date

2.1.34 Electron 1, Electron 2, Electron 3, Electron 4 and
Proton 6 33,554,430 pulse data accumulation test.

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>33,292,288</u>	33,292,288 or 0
B	E2	<u>33,292,288</u>	33,292,288 or 0
C	E3	<u>33,292,288</u>	33,292,288 or 0
D	E4	<u>33,292,288</u>	33,292,288 or 0
E	P6	<u>33,292,288</u>	33,292,288 or 0

1-25-72


Insp. _____ Date

DATA SHEET 2 (Cont.)



2.1.35 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
33,554,430 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>33,292,288</u>	33,292,288 or 0
B	P2	<u>33,292,288</u>	33,292,288 or 0
C	P3	<u>33,292,288</u>	33,292,288 or 0
D	P4	<u>33,292,288</u>	33,292,288 or 0
E	P5	<u>33,292,288</u>	33,292,288 or 0


Insp. 1-25-72
 Date

ELAPSED TIME	PACKAGE TEMP.	RECORD DETECTOR TEMP.	TEMPERATURE ELAPSED TIME	PACKAGE TEMP.	DETECTOR TEMP.
125/72 1800/0	+11.43	+0.19	0330/9.5	43.59	38.12
1830/0.5	11.82	11.43	0400/100	44.27	38.70
1900/1	13.00	16.42	0430/10.5	44.76	39.09
1930/1.5	14.56	18.76	0500/11.0	45.06	39.39.1
2000/2	16.81	20.81	0530/11.5	45.54	39.58
2030/2.5	19.15	22.67	0600/12.0	45.84	39.88
2100/3	21.69	24.53	0630/12.5	46.13	39.97
2130/3.5	24.24	26.39	0700/13.0	46.33	40.17
2200/4	26.97	28.24	0730/13.5	46.52	40.27
2230/4.5	29.32	29.81	Vented Chamber at 07:45 Turned lamps off at 0825		
2300/5	31.57	31.27	0800	47.11	41.15
2330/5.5	33.52	32.45	0825	47.50	43.2
2400/6	35.28	33.52	0830	47.60	38.82
126/72 0030/6.5	37.14	34.50	0900	45.25	26.88
0100/7	38.70	35.48	0930	45.45	27.56
0130/7.5	39.88	36.26	13:10	34.303	29.22
0200/8.0	41.15	36.94			
0230/8.5	42.12	37.53			
0300/9.0	42.91	37.53			


DATA SHEET 2 (Cont.)

2.2.28 Set test case 4


 1-25-72
 Insp. Date

2.2.29 BTE (a) Electronics Power Switch 'OFF'
 (b) Heater Power Switch ~~OFF~~ ON *BEC*
 (c) Detector Bias Switch 'OFF'


Ref Para. 2.2.29 in Proc.

 1-25-72
 Insp. Date


2.2.30 Repeat step 2.2.13

 1-26-72
 Insp. Date

2.2.31 Repeat step 2.2.14

 1-26-72
 Insp. Date

2.2.32 Vacuum chamber to ambient

 1/26/72
 Insp. Date

DATA SHEET 3
FUNCTIONAL TEST

2.3 FUNCTIONAL TEST DATA SHEET

2.1.4 Heater Power

Measured Value
27.54


Acceptable Value
 $+27.5 \pm 0.5$ Vdc

~~27.54~~ 1/26/72
Insp. _____ Date _____

2.1.5 Medium Voltage Heater Current

Measured Value
7 MA

Acceptable Value
 10 ± 5 mA

 1/26/72
Insp. _____ Date _____

DATA SHEET 3 (Cont.)

1.6 Electronic Power

Measured Value

27.45

Acceptable Value

+27.5 ± 0.5 Vdc

Insp.

Date

1/26/72

1.7 Medium Voltage Electronics Current

Measured Value

512 MA

Maximum Value

560 mA

Insp.

Date

1/26/72

2.1.8 Detector Bias

Measured Value

Acceptable Value

+27.5 ± 0.5 Vdc

Insp.

Date

1/26/72
DET PLATE
ABOVE 25°C
SEE CAUTION
2.1.7

2.1.9 Medium Voltage Detector Bias Current

Measured Value

Maximum Value

30 mA

Insp.


Date

1/26/72
SEE CAUTION 2.1.7

DATA SHEET 3 (Cont.)

2.1.11 Medium Voltage ADC Checkout

Reference Input Voltage	Measured Electrical Unit Output Voltage	Acceptable Electrical Output Unit Voltage
+0.025±0.001 Vdc	<u>0.023 .024</u> Vdc	+0.025±0.010 Vdc
+0.050±0.001	<u>.048</u>	0.050±0.010
+0.100±0.001	<u>.097</u>	0.100±0.010
+1.000±0.001	<u>.997</u>	1.000±0.010
+2.000±0.001	<u>1.994</u>	2.000±0.010
+3.000±0.001	<u>2.996</u>	+3.000±0.010
+4.000±0.001	<u>3.998</u>	+4.000±0.015
+4.900±0.001	<u>4.897</u>	+4.900±0.020



Insp. 1/26/72
 Date

DATA SHEET 3 (Cont.)


2.1.13 Medium Voltage Housekeeping Parameter Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Engineering Unit Value
+5V Monitor	A	<u>+5.131</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>+8.145</u>	+8.10±0.15
-8V Monitor	A	<u>-8.187</u>	-8.15±0.15
+25V Monitor	A	<u>25.642</u>	+25.50±0.75
+350V Monitor	* A	<u>+24.243</u>	+350.±15. "OFF"
-15V Monitor	A	<u>-15.984</u>	-15.0±1.0
-5V Monitor	A	<u>-5.417</u>	-5.25±0.25
Disc Ref Mon.	A	<u>+2.995</u>	+3.00±0.02
+5V Monitor	B	<u>+5.131</u>	+5.00±0.25
+8V Monitor	B	<u>+8.155</u>	+8.10±0.15
-8V Monitor	B	<u>-8.209</u>	-8.15±0.15
+25V Monitor	B	<u>+25.642</u>	+25.50±0.75
+350V Monitor	* B	<u>+24.243</u>	+350.±15. "OFF"
-15V Monitor	B	<u>-16.019</u>	-15.0±1.0
-5V Monitor	B	<u>-5.433</u>	-5.25±0.25
Disc Ref Mon.	B	<u>+3.000</u>	+3.000±0.02

DR
 MEASUREMENTS
 EPS 0071
 Insp. _____ Date 1/26/72

2.1.14

	Actual Value	Acceptable Value
Heater	<u>25.37</u>	+25.0 ± 0.5 Vdc
Electronics	<u>25.00</u>	+25.0 ± 0.5 Vdc
Detector Bias	<u>—</u>	+25.0 ± 0.5 Vdc

*  "OFF"
 SEE 201.7

*
 Insp. _____ Date _____

DATA SHEET 3 (Cont.)

2.1.15 Low Voltage Current Consumption

Current Sink	Measured Current	Acceptable Value
Heater	<u>7.0</u> mA	10 ± 5 mA
Electronics	<u>544 mA</u>	≤ 560
Detector Bias	<u>OFF</u>	≤ 30


SEE 2.1.7

Insp. X Date _____

2.1.16 Low Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>+5.121</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>+8.135</u>	+8.10±0.15
-8V Monitor	A	<u>-8.203</u>	-8.15±0.15
+25V Monitor	A	<u>+25.642</u>	+25.50±0.75
+350 V Monitor	X A	<u>+24.243</u>	+350.±15. "OFF"
-15V Monitor	A	<u>-15.984</u>	-15.0±1.0
-5V Monitor	A	<u>-5.430</u>	-5.25±0.25
Disc Ref Mon.	A	<u>+2.995</u>	+3.00±0.02
+5V Monitor	B	<u>+5.121</u>	+5.00±0.25
+8V Monitor	B	<u>+8.145</u>	+8.10±0.15
-8V Monitor	B	<u>-8.187</u>	-8.15±0.15
+25V Monitor	B	<u>+25.642</u>	+25.50±0.75
+350V Monitor	X B	<u>+24.243</u>	+350.±15. OFF
-15V Monitor	B	<u>-15.984</u>	-15.0±1.0
-5V Monitor	B	<u>-5.417</u>	-5.25±0.25
Disc Ref Mon.	B	<u>+3.000</u>	+3.00±0.02

* See Caution

 2.1.7

Insp. X Date _____

DATA SHEET 3 (Cont.)

2.1.17	Actual Value	Acceptable Value
Heater	<u>29.98</u>	+30.0 ± 0.5 Vdc
Electronics	<u>29.97</u>	+30.0 ± 0.5 Vdc
Detector Bias	<u>OFF</u>	+30.0 ± 0.5 Vdc

*
 Insp. _____ Date _____

2.1.18 High Voltage Current Consumption

Current Sink	Actual Value	Acceptable Value
Heater	<u>7 mA</u>	mA 10 ± 5 mA
Electronics	<u>489 mA</u>	≤ 560
Detector Bias	<u>OFF</u>	≤ 30


*
 Insp. _____ Date _____

* SEE
 CAUTION
 20107
 1/2V
 4V

DATA SHEET 3 (Cont.)

2.1.19 High Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>+50.131</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>+80.155</u>	+8.10±0.15
-8V Monitor	A	<u>-80.193</u>	-8.15±0.15
+25V Monitor	A	<u>+25.642</u>	+25.50±0.75
+350V Monitor	A *	<u>+24.243</u>	+350.±15. OFF
-15V Monitor	A	<u>-15.997</u>	-15.0±1.0
-5V Monitor	A	<u>-5.433</u>	-5.25±0.25
Disc Ref Mon.	A	<u>+2.995</u>	+3.00±0.02
+5V Monitor	B	<u>+50.141</u>	+5.00±0.25
+8V Monitor	B	<u>+80.155</u>	+8.10±0.15
-8V Monitor	B	<u>-8.193</u>	-8.15±0.15
+25V Monitor	B	<u>+25.696</u>	+25.50±0.75
+350V Monitor	B *	<u>+24.243</u>	+350.±15. OFF
-15V Monitor	B	<u>-15.997</u>	-15.0±1.0
-5V Monitor	B	<u>-5.420</u>	-5.25±0.25
Disc Ref Mon.	B	<u>+3.000</u>	+3.00±0.02



Insp.

 1/26/72
 Date

 * See caution
 2.1.7

DATA SHEET 3 (Cont.)

2.1.20 Temperature Measurement

Parameter	Prime Frame	Measured Value	Acceptable Limits
Package Temperature Monitor	A	<u>+35.085</u> °C	50°F to 118°F = 10°C to 48°C
Package Temperature Monitor	B	<u>+35.085</u>	↓
Detector Plate Temperature Monitor	A	<u>+29.416</u>	
Detector Plate Temperature Monitor	B	<u>+29.416</u>	

Insp. _____ Date 1/26/72

2.1.21 Detector Leakage Current Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value	DET PLATE TEMPERATURE
A	_____ μA	1.0 μA	+ 29.4 °C
B	_____ μA	2.0 μA	SEE CAUTION
C	_____ μA	2.0 μA	20107
D	_____ μA	2.0 μA	
E	_____ μA	2.0 μA	

NOT TAKEN

Insp. _____ Date _____

DATA SHEET 3 (Cont.)

2.1.22 Detector Resolution Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>.435</u> keV	50. keV
B	<u>.405</u>	50. keV
C	<u>.391</u>	50. keV
D	<u>.464</u>	50. keV
E	<u>.396</u>	50. keV

SEE CAUTION

20107..

1/26/72

↑
VOLTAGE
NOT
E.V.

Insp. _____ Date _____

2.1.25 Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>14</u>	14 or 16
B	E2	<u>14</u>	14 or 16
C	E3	<u>14</u>	14 or 16
D	E4	<u>14</u>	14 or 16
E	P6	<u>14</u>	14 or 16

102

1/26/72


Insp. _____ Date _____

DATA SHEET 3 (Cont.)

2.1.26 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>14</u>	14 or 16
B	P2	<u>14</u>	14 or 16
C	P3	<u>14</u>	14 or 16
D	P4	<u>14</u>	14 or 16
E	P5	<u>14</u>	14 or 16


1/26/72


 Insp. _____ Date _____

2.1.28 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable
A	E1	<u>2032</u>	2032 or 2048
A	E2	<u>2032</u>	2032 or 2048
C	E3	<u>2032</u>	2032 or 2048
D	E4	<u>2032</u>	2032 or 2048
E	P6	<u>2032</u>	2032 or 2048


1/26/72


 Insp. _____ Date _____

DATA SHEET 3 (Cont.)

2.1.29 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
2046 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>2032</u>	2032 or 2048
B	P2	<u>2032</u>	2032 or 2048
C	P3	<u>2032</u>	2032 or 2048
D	P4	<u>2032</u>	2032 or 2048
E	P5	<u>2032</u>	2032 or 2048


Insp.

1/26/72
Date

2.1.31 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>260,096</u>	260,096 or 262,144
B	E2	<u>262,144</u>	260,096 or 262,144
C	E3	<u>262,144</u>	260,096 or 262,144
D	E4	<u>262,144</u>	260,096 or 262,144
E	P6	<u>260,096</u>	260,096 or 262,144


Insp.

1/26/72
Date

DATA SHEET 3 (Cont.)

2.1.32 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>260,096</u>	260,096 or 262,144
B	P2	<u>260,096</u>	260,096 or 262,144
C	P3	<u>260,096</u>	260,096 or 262,144
D	P4	<u>260,096</u>	260,096 or 262,144
E	P6	<u>262,144</u>	260,096 or 262,144

Insp.

Date

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2.1.34 Electron 1, Electron 2, Electron 3, Electron 4 and
Proton 6 33,554,430 pulse data accumulation test.

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>33,292,288</u>	33,292,288 or 0
B	E2	<u>0</u>	33,292,288 or 0
C	E3	<u>33,292,288</u>	33,292,288 or 0
D	E4	<u>33,292,288</u>	33,292,288 or 0
E	P6	<u>33,292,288</u>	33,292,288 or 0

Insp.


Date

1/26/72


DATA SHEET 3 (Cont.)

2.1.35 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
33,554,430 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>33,292,288</u>	33,292,288 or 0
B	P2	<u>33,292,288</u>	33,292,288 or 0
C	P3	<u>33,292,288</u>	33,292,288 or 0
D	P4	<u>33,292,288</u>	33,292,288 or 0
E	P5	<u>33,292,288</u>	33,292,288 or 0


 Insp. _____ Date 1/26/72

2.1.36 Visual inspection


 Insp. _____ Date 1/26/72

DATA SHEET 4

2.4 VIBRATION

2.1.4 Heater Power

Measured Value

Acceptable Value
 $+27.5 \pm 0.5$ Vdc

Insp. Date

2.1.5 Medium Voltage Heater Current

Measured Value

Acceptable Value
 10 ± 5 mA

Insp. Date

DATA SHEET 4 (Cont.)

2.1.6 Electronic Power

Measured Value

Acceptable Value

 $+27.5 \pm 0.5 \text{ Vdc}$ _____
Insp._____
Date

2.1.7 Medium Voltage Electronics Current

Measured Value

Maximum Value

560 mA

Insp._____
Date

2.1.8 Detector Bias

Measured Value

Acceptable Value

 $+27.5 \pm 0.5 \text{ Vdc}$ _____
Insp._____
Date

2.1.9 Medium Voltage Detector Bias Current

Measured Value

Maximum Value

30 mA

Insp._____
Date

DATA SHEET 4 (Cont.)

2.1.11 Medium Voltage ADC Checkout

Reference Input Voltage	Measured Electrical Unit Output Voltage	Acceptable Electrical Output Unit Voltage
+0.025±0.001 Vdc	_____ Vdc	+0.025±0.010 Vdc
+0.050±0.001	_____	0.050±0.010
+0.100±0.001	_____	0.100±0.010
+1.000±0.001	_____	1.000±0.010
+2.000±0.001	_____	2.000±0.010
+3.000±0.001	_____	+3.000±0.010
+4.000±0.001	_____	+4.000±0.015
+4.900±0.001	_____	+4.900±0.020

Insp.

Date

DATA SHEET 4 (Cont.)

2.1.13 Medium Voltage Housekeeping Parameter Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Engineering Unit Value
+5V Monitor	A	_____ Vdc	+5.00±0.25 Vdc
+8V Monitor	A	_____	+8.10±0.15
-8V Monitor	A	_____	-8.15±0.15
+25V Monitor	A	_____	+25.50±0.75
+350V Monitor	A	_____	+350.±15.
-15V Monitor	A	_____	-15.0±1.0
-5V Monitor	A	_____	-5.25±0.25
Disc Ref Mon.	A	_____	+3.00±0.02
+5V Monitor	B	_____	+5.00±0.25
+8V Monitor	B	_____	+8.10±0.15
-8V Monitor	B	_____	-8.15±0.15
+25V Monitor	B	_____	+25.50±0.75
+350V Monitor	B	_____	+350.±15.
-15V Monitor	B	_____	-15.0±1.0
-5V Monitor	B	_____	-5.25±0.25
Disc Ref Mon.	B	_____	+3.000±0.02

Insp. Date

2.1.14

	Actual Value	Acceptable Value
Heater	_____	+25.0 ± 0.5 Vdc
Electronics	_____	+25.0 ± 0.5 Vdc
Detector Bias	_____	+25.0 ± 0.5 Vdc

Insp. Date

DATA SHEET 4 (Cont.)

2.1.15 Low Voltage Current Consumption

Current Sink	Measured Current	Acceptable Value
Heater	_____ mA	10 ± 5 mA
Electronics	_____	< 560
Detector Bias	_____	< 30

_____ Insp. _____ Date

2.1.16 Low Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	_____ Vdc	+5.00±0.25 Vdc
+8V Monitor	A	_____	+8.10±0.15
-8V Monitor	A	_____	-8.15±0.15
+25V Monitor	A	_____	+25.50±0.75
+350 V Monitor	A	_____	+350.±15.
-15V Monitor	A	_____	-15.0±1.0
-5V Monitor	A	_____	-5.25±0.25
Disc Ref Mon.	A	_____	+3.00±0.02
+5V Monitor	B	_____	+5.00±0.25
+8V Monitor	B	_____	+8.10±0.15
-8V Monitor	B	_____	-8.15±0.15
+25V Monitor	B	_____	+25.50±0.75
+350V Monitor	B	_____	+350.±15.
-15V Monitor	B	_____	-15.0±1.0
-5V Monitor	B	_____	-5.25±0.25
Disc Ref Mon.	B	_____	+3.00±0.02

_____ Insp. _____ Date

DATA SHEET 4 (Cont.)

2.1.17	Actual Value	Acceptable Value
Heater	_____	+30.0 ± 0.5 Vdc
Electronics	_____	+30.0 ± 0.5 Vdc
Detector Bias	_____	+30.0 ± 0.5 Vdc

Insp. Date

2.1.18 High Voltage Current Consumption

Current Sink	Actual Value	Acceptable Value
Heater	_____ mA	10 ± 5 mA
Electronics	_____	≤ 560
Detector Bias	_____	≤ 30

Insp. Date

DATA SHEET 4 (Cont.)

2.1.19 High Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	_____ Vdc	+5.00±0.25 Vdc
+8V Monitor	A	_____	+8.10±0.15
-8V Monitor	A	_____	-8.15±0.15
+25V Monitor	A	_____	+25.50±0.75
+350V Monitor	A	_____	+350.±15.
-15V Monitor	A	_____	-15.0±1.0
-5V Monitor	A	_____	-5.25±0.25
Disc Ref Mon.	A	_____	+3.00±0.02
+5V Monitor	B	_____	+5.00±0.25
+8V Monitor	B	_____	+8.10±0.15
-8V Monitor	B	_____	-8.15±0.15
+25V Monitor	B	_____	+25.50±0.75
+350V Monitor	B	_____	+350.±15.
-15V Monitor	B	_____	-15.0±1.0
-5V Monitor	B	_____	-5.25±0.25
Disc Ref Mon.	B	_____	+3.00±0.02

Insp. _____

Date _____

DATA SHEET 4 (Cont.)

2.1.20 Temperature Measurement

Parameter	Prime Frame	Measured Value	Acceptable Limits
Package Temperature Monitor	A	_____ °C	50°F to 118°F : 10°C to 48°C
Package Temperature Monitor	B	_____	↓
Detector Plate Temperature Monitor	A	_____	_____
Detector Plate Temperature Monitor	B	_____	_____

_____ Insp. _____ Date

2.1.21 Detector Leakage Current Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	_____ μA	1.0 μA
B	_____	2.0 μA
C	_____	2.0 μA
D	_____	2.0 μA
E	_____	2.0 μA

_____ Insp. _____ Date

DATA SHEET 4 (Cont.)

2.1.22 Detector Resolution Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	_____ keV	50. keV
B	_____	50. keV
C	_____	50. keV
D	_____	50. keV
E	_____	50. keV

Insp. _____ Date _____

2.1.25 Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	_____	14 or 16
B	E2	_____	14 or 16
C	E3	_____	14 or 16
D	E4	_____	14 or 16
E	P6	_____	14 or 16

Insp. _____ Date _____

DATA SHEET 4 (Cont.)

2.1.26 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5.
14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	_____	14 or 16
B	P2	_____	14 or 16
C	P3	_____	14 or 16
D	P4	_____	14 or 16
E	P5	_____	14 or 16

Insp. Date

2.1.28 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable
A	E1	_____	2032 or 2048
A	E2	_____	2032 or 2048
C	E3	_____	2032 or 2048
D	E4	_____	2032 or 2048
E	P6	_____	2032 or 2048

Insp. Date

DATA SHEET 4 (Cont.)

2.1.29 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	_____	2032 or 2048
B	P2	_____	2032 or 2048
C	P3	_____	2032 or 2048
D	P4	_____	2032 or 2048
E	P5	_____	2032 or 2048

Insp. Date

2.1.31 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	_____	260,096 or 262,144
B	E2	_____	260,096 or 262,144
C	E3	_____	260,096 or 262,144
D	E4	_____	260,096 or 262,144
E	P6	_____	260,096 or 262,144

Insp. Date

DATA SHEET 4 (Cont.)

2.1.32 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	_____	260,096 or 262,144
B	P2	_____	260,096 or 262,144
C	P3	_____	260,096 or 262,144
D	P4	_____	260,096 or 262,144
E	P6	_____	260,096 or 262,144

Insp. Date

2.1.34 Electron 1, Electron 2, Electron 3, Electron 4 and
Proton 6 33,554,430 pulse data accumulation test.

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	_____	33,292,288 or 0
B	E2	_____	33,292,288 or 0
C	E3	_____	33,292,288 or 0
D	E4	_____	33,292,288 or 0
E	P6	_____	33,292,288 or 0

Insp. Date

DATA SHEET 4 (Cont.)

2.1.35 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
33,554,430 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	_____	33,292,288 or 0
B	P2	_____	33,292,288 or 0
C	P3	_____	33,292,288 or 0
D	P4	_____	33,292,288 or 0
E	P5	_____	33,292,288 or 0


Insp. Date

2.1.36 Visual inspection


Insp. Date

DATA SHEET 4 (Cont.)


2.4.2 Test article to Building 49, NASA/MSC

	10 FEB 72
<u>Insp.</u>	<u>10 FEB 72</u>
	Date


2.4.3 Prepare control system

	10 FEB 72
<u>Insp.</u>	<u>10 FEB 72</u>
	Date


2.4.4 Mount fixture

	10 FEB 72
<u>Insp.</u>	<u>10 FEB 72</u>
	Date


2.4.5 Shape 'R' axis spectrum

	14 FEB 72
<u>Insp.</u>	<u>14 FEB 72</u>
	Date

2.4.6 Install test article


	14 FEB 72
<u>Insp.</u>	<u>14 FEB 72</u>
	Date

2.4.7 Sinusoidal Sweep


	14 FEB 72
<u>Insp.</u>	<u>14 FEB 72</u>
	Date







DATA SHEET 4 (Cont.)


2.4.8 Random exposure: (Attach spectrum plot)
 Nominal: Time _____ seconds
 g rms _____
 High Energy Time _____ seconds
 g rms _____

SEE BELOW  14 FEB. 72
 Insp. _____ Date

2.4.9 Remove test article

 14 FEB. 72
 Insp. _____ Date

2.4.8 HIGH
 SEG. 1  20-300 HZ. NOM. 33 GRMS, 42 FOR 10 SEC.
 SEG. 2  300-400 HZ. NOM. 26 GRMS, 32 " " "
 ① SEG. 3  400-600 HZ. NOM 36 GRMS ~~6~~/⁵ SEC 5 SEC
 SEG. 4  600-800 HZ. NOM 27 GRMS 38 GRMS 10 SEC
 SEG. 5  800-1 KC 24 GRMS 30 GRMS 10 SEC
 SEG. 6  1 KC - 2 KC 41 GRMS 52 GRMS 10 SEC.

① POWER AMPLIFIER OVER CURRENT DUMPED TEST AFTER 5 SECONDS OF HIGH LEVEL. RECYCLED AMPLIFIER AND RAN AN ADDITIONAL 5 SECONDS. TAT 


DATA SHEET 4 (Cont.)

POST R AXIS

2.1.4 Heater Power

Measured Value
27.54


Acceptable Value
 $+27.5 \pm 0.5$ Vdc


Insp. 2/15/72
Date

2.1.5 Medium Voltage Heater Current

Measured Value
100?

Acceptable Value
 10 ± 5 mA


Insp. 2/15/72
Date

DATA SHEET 4 (Cont.)

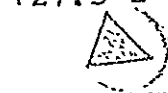
2.1.6 Electronic Power

Measured Value

27.45

Acceptable Value

+27.5 ± 0.5 Vdc



Insp.

Date

2/15/72

2.1.7 Medium Voltage Electronics Current

Measured Value

512 mA

Maximum Value

560 mA



Insp.

Date

2/15/72

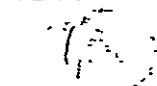
2.1.8 Detector Bias

Measured Value

27.56

Acceptable Value

+27.5 ± 0.5 Vdc



Insp.

Date

2/15/72

2.1.9 Medium Voltage Detector Bias Current

Measured Value

20 mA

Maximum Value

30 mA



Insp.

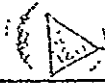
Date

2/15/72

DATA SHEET 4 (Cont.)

2.1.11 Medium Voltage ADC Checkout

Reference Input Voltage	Measured Electrical Unit Output Voltage	Acceptable Electrical Output Unit Voltage
+0.025±0.001 Vdc	<u>.024</u> Vdc	+0.025±0.010 Vd
+0.050±0.001	<u>.048</u>	0.050±0.010
+0.100±0.001	<u>.097</u>	0.100±0.010
+1.000±0.001	<u>.997</u>	1.000±0.010
+2.000±0.001	<u>1.994</u>	2.000±0.010
+3.000±0.001	<u>2.996</u>	+3.000±0.010
+4.000±0.001	<u>3.993</u>	+4.000±0.015
+4.900±0.001	<u>4.892</u>	+4.900±0.020



Insp. 2/15/77
Date

DATA SHEET 4 (Cont.)

2.1.13 Medium Voltage Housekeeping Parameter Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Engineering Unit Value
+5V Monitor	A	<u>5.111</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.135</u>	+8.10±0.15
-8V Monitor	A	<u>-8.181</u>	-8.15±0.15
+25V Monitor	A	<u>25.588</u>	+25.50±0.75
+350V Monitor	A	<u>346.330</u>	+350.±15.
-15V Monitor	A	<u>-16.016</u>	-15.0±1.0
-5V Monitor	A	<u>-5.401</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.111</u>	+5.00±0.25
+8V Monitor	B	<u>8.135</u>	+8.10±0.15
-8V Monitor	B	<u>-8.166</u>	-8.15±0.15
+25V Monitor	B	<u>25.588</u>	+25.50±0.75
+350V Monitor	B	<u>346.330</u>	+350.±15.
-15V Monitor	B	<u>-16.016</u>	-15.0±1.0
-5V Monitor	B	<u>-5.401</u>	-5.25±0.25
Disc Ref Mon.	B	<u>3.000</u>	+3.000±0.02


DATA EPS-0071



 Insp. _____ Date 2/15/72

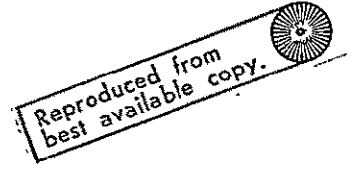
2.1.14

	Actual Value	Acceptable Value
Heater	<u>25.37</u>	+25.0 ± 0.5 Vdc
Electronics	<u>25.00</u>	+25.0 ± 0.5 Vdc
Detector Bias	<u>25.02</u>	+25.0 ± 0.5 Vdc




 Insp. _____ Date 2/15/72

DATA SHEET 4 (Cont.)




2.1.15 Low Voltage Current Consumption

Current Sink	Measured Current	Acceptable Value
Heater	<u>7</u> mA	10 ± 5 mA
Electronics	<u>530</u>	≤ 560
Detector Bias	<u>2.1</u>	≤ 30


 Insp. Date 2/15/72

2.1.16 Low Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.111</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.126</u>	+8.10±0.15
-8V Monitor	A	<u>-8.160</u>	-8.15±0.15
+25V Monitor	A	<u>25.588</u>	+25.50±0.75
+350 V Monitor	A	<u>346.330</u>	+350.±15.
-15V Monitor	A	<u>-15.980</u>	-15.0±1.0
-5V Monitor	A	<u>-5.398</u>	-5.25±0.25
Disc Ref Mon.	A	<u>3.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.111</u>	+5.00±0.25
+8V Monitor	B	<u>8.126</u>	+8.10±0.15
-8V Monitor	B	<u>-8.160</u>	-8.15±0.15
+25V Monitor	B	<u>25.588</u>	+25.50±0.75
+350V Monitor	B	<u>346.330</u>	+350.±15.
-15V Monitor	B	<u>-15.980</u>	-15.0±1.0
-5V Monitor	B	<u>-5.398</u>	-5.25±0.25
Disc Ref Mon.	B	<u>3.000</u>	+3.00±0.02


 Insp. Date 2/15/72

DATA SHEET 4 (Cont.)

2.1.17	Actual Value	Acceptable Value
Heater	<u>29.97</u>	+30.0 ± 0.5 Vdc
Electronics	<u>29.96</u>	+30.0 ± 0.5 Vdc
Detector Bias	<u>30.08</u>	+30.0 ± 0.5 Vdc



Insp.

Date

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2.1.18 High Voltage Current Consumption

Current Sink	Actual Value	Acceptable Value
Heater	<u>7</u> mA	10 ± 5 mA
Electronics	<u>492</u>	≤ 560
Detector Bias	<u>21</u>	≤ 30



Insp.

Date


2/15/72

DATA SHEET 4 (Cont.)

2.1.19 High Voltage Housekeeping Checkout.

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.121</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.135</u>	+8.10±0.15
-8V Monitor	A	<u>-8.187</u>	-8.15±0.15
+25V Monitor	A	<u>25.588</u>	+25.50±0.75
+350V Monitor	A	<u>346.330</u>	+350.±15.
-15V Monitor	A	<u>-16.052</u>	-15.0±1.0
-5V Monitor	A	<u>-5.417</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.121</u>	+5.00±0.25
+8V Monitor	B	<u>8.145</u>	+8.10±0.15
-8V Monitor	B	<u>-8.187</u>	-8.15±0.15
+25V Monitor	B	<u>25.642</u>	+25.50±0.75
+350V Monitor	B	<u>346.330</u>	+350.±15.
-15V Monitor	B	<u>-16.029</u>	-15.0±1.0
-5V Monitor	B	<u>-5.417</u>	-5.25±0.25
Disc Ref Mon.	B	<u>3.000</u>	+3.00±0.02

DRH EPS-0021




 Insp. _____ Date 2/15/72

C-15

DATA SHEET 4 (Cont.)

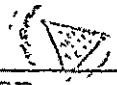
2.1.20 Temperature Measurement

Parameter	Prime Frame	Measured Value	Acceptable Limits
Package Temperature Monitor	A	<u>24.627</u> °C	50°F to 118°F 10°C to 48°C
Package Temperature Monitor	B	<u>24.725</u>	↓
Detector Plate Temperature Monitor	A	<u>23.552</u>	
Detector Plate Temperature Monitor	B	<u>23.552</u>	


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 Insp. _____ Date _____

2.1.21 Detector Leakage Current Test


EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>.194</u> uA	1.0 uA
B	<u>.566</u>	2.0 uA
C	<u>1.968</u>	2.0 uA
D	<u>.695</u>	2.0 uA
E	<u>.753</u>	2.0 uA


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 Insp. _____ Date _____

DATA SHEET 4 (Cont.)

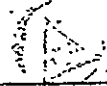
2.1.22 Detector Resolution Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>.391</u> <u>7.0</u> keV	50. keV
B	<u>.410</u> <u>7.0</u>	50. keV
C	<u>.405</u> <u>6.5</u>	50. keV
D	<u>.884</u> <u>18</u>	50. keV
E	<u>.366</u> <u>7.0</u>	50. keV


 Insp. _____ Date 2/15/72

2.1.25 Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 14 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>14</u>	14 or 16
B	E2	<u>14</u>	14 or 16
C	E3	<u>14</u>	14 or 16
D	E4	<u>14</u>	14 or 16
E	P6	<u>14</u>	14 or 16


 Insp. _____ Date 2/15/72

DATA SHEET 4 (Cont.)

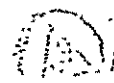
2.1.26 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>14</u>	14 or 16
B	P2	<u>14</u>	14 or 16
C	P3	<u>14</u>	14 or 16
D	P4	<u>14</u>	14 or 16
E	P5	<u>14</u>	14 or 16


 Insp. _____ Date 2/15/72

2.1.28 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 2046 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>2032</u>	2032 or 2048
A	E2	<u>2032</u>	2032 or 2048
C	E3	<u>2032</u>	2032 or 2048
D	E4	<u>2032</u>	2032 or 2048
E	P6	<u>2032</u>	2032 or 2048


 Insp. _____ Date 2/15/72

DATA SHEET 4 (Cont.)

2.1.29 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>2032</u>	2032 or 2048
B	P2	<u>2032</u>	2032 or 2048
C	P3	<u>2032</u>	2032 or 2048
D	P4	<u>2032</u>	2032 or 2048
E	P5	<u>2032</u>	2032 or 2048




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2.1.31 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>260 096</u>	260,096 or 262,144
B	E2	<u>260 096</u>	260,096 or 262,144
C	E3	<u>260 096</u>	260,096 or 262,144
D	E4	<u>262 144</u>	260,096 or 262,144
E	P6	<u>260 096</u>	260,096 or 262,144



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2/15/72
Date

DATA SHEET 4 (Cont.)


2.1.32 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>260,096</u>	260,096 or 262,144
B	P2	<u>260,096</u>	260,096 or 262,144
C	P3	<u>260,096</u>	260,096 or 262,144
D	P4	<u>260,096</u>	260,096 or 262,144
E	P6	<u>260,096</u>	260,096 or 262,144

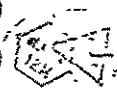

Insp. 2/15/72
Date

2.1.34 Electron 1, Electron 2, Electron 3, Electron 4 and
Proton 6 33,554,430 pulse data accumulation test.

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>33,292,288</u>	33,292,288 or 0
B	E2	<u>0</u>	33,292,288 or 0
C	E3	<u>33,292,288</u>	33,292,288 or 0
D	E4	<u>14</u>	33,292,288 or 0
E	P6	<u>33,292,288</u>	33,292,288 or 0


Insp. 2/15/72
Date

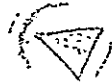
DR # EPS-0072



DATA SHEET 4 (Cont.)

2.1.35 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
33,554,430 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>33 292 288</u>	33,292,288 or 0
B	P2	<u>33 292 288</u>	33,292,288 or 0
C	P3	<u>33 292 288</u>	33,292,288 or 0
D	P4	<u>33 292 288</u>	33,292,288 or 0
E	P5	<u>33 292 288</u>	33,292,288 or 0



Insp.


Date

2/15/72


DATA SHEET 4 (Cont.)

2.4.10 Orient for 'X' axis


2.4.11
GRS.


 Insp. _____ Date 10 FEB 72


2.4.12 Shape 'X' axis spectrum


 Insp. _____ Date 10 FEB 72

2.4.13 Repeat step 2.4.6


 Insp. _____ Date 10 FEB 72

2.4.14 Repeat step 2.4.7


 Insp. _____ Date 10 FEB 72



2.4.15 Repeat step 2.4.8 for 'X' axis (attach spectrum plot)

Nominal Time 1 MIN 20 SEC seconds

g rms 19 G RMS

High Energy Time 10 SEC. seconds 28.9 

g rms NO READING SEE SPECTRUM 28.9 G RMS

 34 
 Insp. _____ Date 10 FEB 72

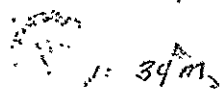
DATA SHEET 4 (Cont.)

2.4.16 Repeat step 2.4.9



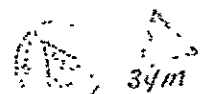
Insp.	Date
	10 FEB 72

2.4.17 Re-orient for 'T' axis



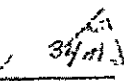
Insp.	Date
	10 FEB 72

2.4.18 Shape 'T' axis spectrum



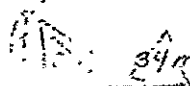
Insp.	Date
	10 FEB 72

2.4.19 Repeat step 2.4.6



Insp.	Date
	10 FEB 72


2.4.20 Repeat step 2.4.7



Insp.	Date
	10 FEB 72

DATA SHEET 4 (Cont.)


2.4.21 Repeat step 2.4.8 for 'T' axis (attach spectrum plot)

Nominal Time 1 MIN 20 SEC. secondsg rms 156 RMS -100High Energy Time 10 SEC secondsg rms ~~200 RMS. 1.00 METER, SEE PAGE RMS~~ 


↓

Insp.	Date
↓	<u>10 FEB. 72</u>

2.4.22 Repeat step 2.4.9

Insp.	Date
	<u>10 FEB. 72</u>

2.4.23 Return to Beta Building

Insp.	Date
	<u>11 FEB. 72</u>


DATA SHEET 5
FUNCTIONAL TEST

2.5 FUNCTIONAL TEST DATA SHEET

EMI FUNCTIONAL TEST.


2.1.4 Heater Power

Measured Value Acceptable Value
INDIA 27.53V +27.5 ± 0.5 Vdc

 1-28-72
Insp. Date

2.1.5 Medium Voltage Heater Current

Measured Value Acceptable Value
INDIA .006A 10 ± 5 mA
6 mA

 1-28-72
Insp. Date

DATA SHEET 5 (Cont.)

2.1.6 Electronic Power

Measured Value

27.46

Acceptable Value

 $+27.5 \pm 0.5$ Vdc

1-28-72

Insp.

Date

2.1.7 Medium Voltage Electronics Current

Measured Value

509 mA

Maximum Value

560 mA



1-28-72

Insp.

Date

2.1.8 Detector Bias

Measured Value

27.55

Acceptable Value

 $+27.5 \pm 0.5$ Vdc

1-28-72

Insp.

Date

2.1.9 Medium Voltage Detector Bias Current

Measured Value

20 mA

Maximum Value

30 mA



1-28-72


Insp.

Date

DATA SHEET 5 (Cont.)

2.1.11 Medium Voltage ADC Checkout



Reference Input Voltage	Measured Electrical Unit Output Voltage	Acceptable Electrical Output Unit Voltage
+0.025±0.001 Vdc	<u>0.024</u> Vdc	+0.025±0.010 Vdc
+0.050±0.001	<u>0.053</u>	0.050±0.010
+0.100±0.001	<u>0.097</u>	0.100±0.010
+1.000±0.001	<u>0.997</u>	1.000±0.010
+2.000±0.001	<u>1.994</u>	2.000±0.010
+3.000±0.001	<u>2.996</u>	+3.000±0.010
+4.000±0.001	<u>3.998</u>	+4.000±0.015
+4.900±0.001	<u>4.892</u>	+4.900±0.020


Insp. 1-28-22
Date

DATA SHEET 5 (Cont.)


2.1.13 Medium Voltage Housekeeping Parameter Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Engineering Unit Value
+5V Monitor	A	<u>5.111</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.135</u>	+8.10±0.15
-8V Monitor	A	<u>-8.181</u>	-8.15±0.15
+25V Monitor	A	<u>+25.588</u>	+25.50±0.75
+350V Monitor	A	<u>346.330</u>	+350.±15.
-15V Monitor	A	<u>-16.039</u> ^{DR- EPS- 0011}	-15.0±1.0 ~
-5V Monitor	A	<u>-5.401</u> ^{DR- EPS- 0011}	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.111</u>	+5.00±0.25
+8V Monitor	B	<u>8.135</u>	+8.10±0.15
-8V Monitor	B	<u>-8.166</u>	-8.15±0.15
+25V Monitor	B	<u>+25.588</u>	+25.50±0.75
+350V Monitor	B	<u>346.330</u>	+350.±15.
-15V Monitor	B	<u>-16.016</u> ^{DR- EPS- 0011}	-15.0±1.0 ~
-5V Monitor	B	<u>-5.401</u> ^{DR- EPS- 0011}	-5.25±0.25
Disc Ref Mon.	B	<u>+3.000</u>	+3.000±0.02



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 Insp. Date
 KEY UK-EPS-0011

2.1.14


	Actual Value	Acceptable Value
Heater	<u>25.31</u>	+25.0 ± 0.5 Vdc
Electronics	<u>25.00</u>	+25.0 ± 0.5 Vdc
Detector Bias	<u>25.01</u>	+25.0 ± 0.5 Vdc


1-28-72
 Insp. Date

DATA SHEET 5 (Cont.)

2.1.15 Low Voltage Current Consumption


Current Sink	Measured Current	Acceptable value
Heater	<u>7</u> mA	10 ± 5 mA
Electronics	<u>540 MA</u>	≤ 560
Detector Bias	<u>20</u>	≤ 30



 Insp. _____ Date 1-28-72

2.1.16 Low Voltage Housekeeping Checkout


Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>+5.102</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.126</u>	+8.10±0.15
-8V Monitor	A	<u>-8.160</u>	-8.15±0.15
+25V Monitor	A	<u>+25.535</u>	+25.50±0.75
+350 V Monitor	A	<u>+346.330</u>	+350.±15.
-15V Monitor	A	<u>-15.980</u>	-15.0±1.0
-5V Monitor	A	<u>-5.398</u>	-5.25±0.25
Disc Ref Mon.	A	<u>+2.995</u>	+3.00±0.02
+5V Monitor	B	<u>+5.111</u>	+5.00±0.25
+8V Monitor	B	<u>+8.126</u>	+8.10±0.15
-8V Monitor	B	<u>-8.160</u>	-8.15±0.15
+25V Monitor	B	<u>+25.588</u>	+25.50±0.75
+350V Monitor	B	<u>+346.330</u>	+350.±15.
-15V Monitor	B	<u>-15.980</u>	-15.0±1.0
-5V Monitor	B	<u>5.1000 -5.386</u>	-5.25±0.25
Disc Ref Mon.	B	<u>3.000</u>	+3.00±0.02



 Insp. _____ Date 1-28-72


DATA SHEET 5 (Cont.)

2.1.17	Actual Value	Acceptable Value
Heater	<u>29.97</u>	+30.0 ± 0.5 Vdc
Electronics	<u>29.96</u>	+30.0 ± 0.5 Vdc
Detector Bias	<u>30.15</u>	+30.0 ± 0.5 Vdc

Insp.  1-28-72
Date

2.1.18 High Voltage Current Consumption

Current Sink	Actual Value	Acceptable Value
Heater	<u>7</u> mA	10 ± 5 mA
Electronics	<u>490</u>	≤ 560
Detector Bias	<u>20</u>	≤ 30

Insp.  1-28-72
Date

DATA SHEET 5. (Cont.)

2.1.19 High Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.111</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.095</u>	+8.10±0.15
-8V Monitor	A	<u>-8.181</u>	-8.15±0.15
+25V Monitor	A	<u>+25.588</u>	+25.50±0.75
+350V Monitor	A	<u>+346.330</u>	+350.±15.
-15V Monitor	A	<u>-16.016</u> DR EPS 0071	-15.0±1.0
-5V Monitor	A	<u>-5.401</u> DR EPS 0071	-5.25±0.25
Disc Ref Mon.	A	<u>+2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.111</u>	+5.00±0.25
+8V Monitor	B	<u>8.135</u>	+8.10±0.15
-8V Monitor	B	<u>-8.166</u>	-8.15±0.15
+25V Monitor	B	<u>+25.612</u>	+25.50±0.75
+350V Monitor	B	<u>+346.330</u>	+350.±15.
-15V Monitor	B	<u>-16.016</u> DR EPS 0071	-15.0±1.0
-5V Monitor	B	<u>-5.401</u> DR EPS 0071	-5.25±0.25
Disc Ref Mon.	B	<u>+3.000</u>	+3.00±0.02



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DATA SHEET 5 (Cont.)

2.1.20 Temperature Measurement

Parameter	Prime Frame	Measured Value	Acceptable Limits
Package Temperature Monitor	A	<u>24.431</u> °C	50°F to 118°F = 10°C to 48°C
Package Temperature Monitor	B	<u>24.431</u>	↓
Detector Plate Temperature Monitor	A	<u>22.965</u>	
Detector Plate Temperature Monitor	B	<u>22.965</u>	



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2.1.21 Detector Leakage Current Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>0.197</u> μA	1.0 μA
B	<u>0.522</u>	2.0 μA
C	<u>1.968</u>	2.0 μA
D	<u>1.668</u>	2.0 μA
E	<u>1.662</u>	2.0 μA




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DATA SHEET 5 (Cont.)

2.1.22 Detector Resolution Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>391</u> keV	50. keV
B	<u>4</u>	50. keV
C	<u>410</u>	50. keV
D	<u>527</u>	50. keV
E	<u>374</u>	50. keV

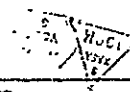


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2.1.25 Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>14</u>	14 or 16
B	E2	<u>14</u>	14 or 16
C	E3	<u>14</u>	14 or 16
D	E4	<u>16</u>	14 or 16
E	P6	<u>14</u>	14 or 16

DR-EPS-COS




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DATA SHEET 5 (Cont.)


2.1.26 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>14</u>	14 or 16
B	P2	<u>14</u>	14 or 16
C	P3	<u>14</u>	14 or 16
D	P4	<u>14</u>	14 or 16
E	P5	<u>16</u>	14 or 16


 Insp. _____ Date 1-28-72

2.1.28 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 2046 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>2032</u>	2032 or 2048
A	E2	<u>2032</u>	2032 or 2048
C	E3	<u>2032</u>	2032 or 2048
D	E4	<u>2032</u>	2032 or 2048
E	P6	<u>2032</u>	2032 or 2048


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DATA SHEET 5 (Cont.)


2.1.29 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>2032</u>	2032 or 2048
B	P2	<u>2032</u>	2032 or 2048
C	P3	<u>2032</u>	2032 or 2048
D	P4	<u>2032</u>	2032 or 2048
E	P5	<u>2032</u>	2032 or 2048


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Date

2.1.31 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 262,142 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>260096</u>	260,096 or 262,144
B	E2	<u>260096</u>	260,096 or 262,144
C	E3	<u>260096</u>	260,096 or 262,144
D	E4	<u>260096</u>	260,096 or 262,144
E	P6	<u>260096</u>	260,096 or 262,144


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Date

DATA SHEET 5 (Cont.)


2.1.32 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>260096</u>	260,096 or 262,144
B	P2	<u>260096</u>	260,096 or 262,144
C	P3	<u>262144</u>	260,096 or 262,144
D	P4	<u>260096</u>	260,096 or 262,144
E	P6	<u>260096</u>	260,096 or 262,144


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 Date

2.1.34 Electron 1, Electron 2, Electron 3, Electron 4 and
Proton 6 33,554,430 pulse data accumulation test.


EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>33,292,288</u>	33,292,288 or 0
B	E2	<u>33,292,288</u>	33,292,288 or 0
C	E3	<u>33,292,288</u>	33,292,288 or 0
D	E4	<u>0</u>	33,292,288 or 0
E	P6	<u>33,292,288</u>	33,292,288 or 0


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DATA SHEET 5, (Cont.)

2.1.35 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
33,554,430 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>33,292,288</u>	33,292,288 or 0
B	P2	<u>33,292,288</u>	33,292,288 or 0
C	P3	<u>0</u>	33,292,288 or 0
D	P4	<u>0</u>	33,292,288 or 0
E	P5	<u>0</u>	33,292,288 or 0



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2.1.36 Visual inspection



1-28-72

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09:10 - 20.326
10:05 - 23.063
11:30 - 21.6
14:30 - 20.033
15:30 - 20.717

PKG 26.386
PT 26.093
PT 26.582

20204 N
580 Ma

DATA SHEET 6

2.6 ~~SHOCK~~ EMI POST TEST DATA

2.1.4 Heater Power

Measured Value

27.54

Acceptable Value

$+27.5 \pm 0.5$ Vdc

Insp.

Date



2-2-72

2.1.5 Medium Voltage Heater Current

Measured Value

8 mA

Acceptable Value

10 ± 5 mA

Insp.

Date



2-2-72

DATA SHEET 6 (Cont.)

2.1.6 Electronic Power

Measured Value

27.45

Acceptable Value

+27.5 ± 0.5 Vdc



Insp.

Date

2-2-72

2.1.7 Medium Voltage Electronics Current

Measured Value

511

Maximum Value

560 mA



Insp.

Date

2-2-72

2.1.8 Detector Bias

Measured Value

27.97

Acceptable Value

+27.5 ± 0.5 Vdc



Insp.

Date

2-2-72

2.1.9 Medium Voltage Detector Bias Current

Measured Value

20

Maximum Value

30 mA



Insp.


Date

2-2-72

DATA SHEET 6 (Cont.)

2.1.11 Medium Voltage ADC Checkout

Reference Input Voltage	Measured Electrical Unit Output Voltage	Acceptable Electrical Output Unit Voltage
+0.025±0.001 Vdc	<u>0.019</u> Vdc	+0.025±0.010 Vdc
+0.050±0.001	<u>0.048 0.045</u>	0.050±0.010
+0.100±0.001	<u>0.093</u>	0.100±0.010
+1.000±0.001	<u>0.992 0.992</u>	1.000±0.010
+2.000±0.001	<u>1.994</u>	2.000±0.010
+3.000±0.001	<u>2.996</u>	+3.000±0.010
+4.000±0.001	<u>3.993</u>	+4.000±0.015
+4.900±0.001	<u>4.892</u>	+4.900±0.020



Insp.

 Date 2-2-72

DATA SHEET 6 (Cont.)

2.1.13 Medium Voltage Housekeeping Parameter Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Engineering Unit Value
+5V Monitor	A	<u>5.111</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.126</u>	+8.10±0.15
-8V Monitor	A	<u>-8.151</u>	-8.15±0.15
+25V Monitor	A	<u>25.588</u>	+25.50±0.75
+350V Monitor	A	<u>346.330</u>	+350.±15.
-15V Monitor	A	<u>-16.039</u>	-15.0±1.0
-5V Monitor	A	<u>-5.401</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>+5.111</u>	+5.00±0.25
+8V Monitor	B	<u>8.135</u>	+8.10±0.15
-8V Monitor	B	<u>-8.166</u>	-8.15±0.15
+25V Monitor	B	<u>25.687</u>	+25.50±0.75
+350V Monitor	B	<u>346.330</u>	+350.±15.
-15V Monitor	B	<u>-16.015</u>	-15.0±1.0
-5V Monitor	B	<u>-5.401</u>	-5.25±0.25
Disc Ref Mon.	B	<u>+2.995</u>	+3.000±0.02

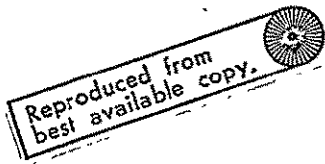
Insp. REP EPS-0011 Date 2-2-72
 DR

2.1.14

	Actual Value	Acceptable Value
Heater.	<u>25.37</u>	+25.0 ± 0.5 Vdc
Electronics	<u>25.00</u>	+25.0 ± 0.5 Vdc
Detector Bias	<u>25.02</u>	+25.0 ± 0.5 Vdc

Insp. AS 105X Date 2-2-72

DATA SHEET 6 (Cont.)



2.1.15 Low Voltage Current Consumption

Current Sink	Measured Current	Acceptable Value
Heater	<u>7</u> mA	10 ± 5 mA
Electronics	<u>541</u>	≤ 560
Detector Bias	<u>20</u>	≤ 30

Insp. [Signature] Date 2-2-72

2.1.16 Low Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.102</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.126</u>	+8.10±0.15
-8V Monitor	A	<u>-8.175</u>	-8.15±0.15
+25V Monitor	A	<u>25.535</u>	+25.50±0.75
+350 V Monitor	A	<u>346.330</u>	+350.±15.
-15V Monitor	A	<u>-16.003</u>	-15.0±1.0
-5V Monitor	A	<u>-5.398</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.495</u>	+3.00±0.02
+5V Monitor	B	<u>5.111</u>	+5.00±0.25
+8V Monitor	B	<u>8.126</u>	+8.10±0.15
-8V Monitor	B	<u>-8.160</u>	-8.15±0.15
+25V Monitor	B	<u>25.588</u>	+25.50±0.75
+350V Monitor	B	<u>346.332</u>	+350.±15.
-15V Monitor	B	<u>-15.980</u>	-15.0±1.0
-5V Monitor	B	<u>-5.373</u>	-5.25±0.25
Disc Ref Mon.	B	<u>3.000</u>	+3.00±0.02

Insp. [Signature] Date 2-2-72

174 DR EPS-0011

DATA SHEET 6 (Cont.)


2.1.17	Actual Value	Acceptable Value
Heater	<u>29.97</u>	+30.0 ± 0.5 Vdc
Electronics	<u>29.96</u>	+30.0 ± 0.5 Vdc
Detector Bias	<u>30.09</u>	+30.0 ± 0.5 Vdc



 Insp. _____ Date 2-2-72

2.1.18 High Voltage Current Consumption


Current Sink	Actual Value	Acceptable Value
Heater	<u>7</u> mA	10 ± 5 mA
Electronics	<u>492</u>	≤ 560
Detector Bias	<u>20</u>	≤ 30



 Insp. _____ Date 2-2-72

DATA SHEET 6 (Cont.)

2.1.19 High Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.111</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.135</u>	+8.10±0.15
-8V Monitor	A	<u>-8.166</u>	-8.15±0.15
+25V Monitor	A	<u>25.558</u>	+25.50±0.75
+350V Monitor	A	<u>346.330</u>	+350.±15.
-15V Monitor	A	<u>-16.616</u> EPS	-15.0±1.0
-5V Monitor	A	<u>-5.401</u> 0071	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u> 	+3.00±0.02
+5V Monitor	B	<u>5.111</u>	+5.00±0.25
+8V Monitor	B	<u>8.135</u>	+8.10±0.15
-8V Monitor	B	<u>-8.166</u>	-8.15±0.15
+25V Monitor	B	<u>25.142</u>	+25.50±0.75
+350V Monitor	B	<u>346.330</u>	+350.±15.
-15V Monitor	B	<u>-16.616</u> EPS 0071	-15.0±1.0
-5V Monitor	B	<u>-5.359</u>	-5.25±0.25
Disc Ref Mon.	B	<u>2.995</u>	+3.00±0.02

Insp.


Date


REF.
EPS-0071

2-2-72

DATA SHEET 6 (Cont.)


2.1.20 Temperature Measurement

Parameter	Prime Frame	Measured Value	Acceptable Limits
Package Temperature Monitor	A	+ <u>21.870</u> °C	50°F to 118°F = 10°C to 48°C
Package Temperature Monitor	B	+ <u>21.870</u>	↓ 
Detector Plate Temperature Monitor	A	+ <u>18.958</u>	XXXXXXXXXX
Detector Plate Temperature Monitor	B	+ <u>18.958</u>	XXXXXXXXXX


2-2-72
 Insp. _____ Date _____

2.1.21 Detector Leakage Current Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>0.167</u> μA	1.0 μA
B	<u>0.451</u>	2.0 μA
C	<u>1.968</u>	2.0 μA
D	<u>0.554</u>	2.0 μA
E	<u>0.576</u>	2.0 μA


2-2-72
 Insp. _____ Date _____

DATA SHEET 6 (Cont.)

2.1.22 Detector Resolution Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>.391</u> keV	50. keV
B	<u>.396</u>	50. keV
C	<u>.391</u>	50. keV
D	<u>.907</u>	50. keV
E	<u>.371</u>	50. keV

Insp. 2-2-72 Date

2.1.25 Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>14</u>	14 or 16
B	E2	<u>14</u>	14 or 16
C	E3	<u>14</u>	14 or 16
D	E4	<u>14</u>	14 or 16
E	P6	<u>14</u>	14 or 16

DT/EP5-0082
 ?

Insp. 2/2/72 Date

DATA SHEET 6 (Cont.)

2.1.26 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5.
14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>14</u>	14 or 16
B	P2	<u>14</u>	14 or 16
C	P3	<u>14</u>	14 or 16
D	P4	<u>14</u>	14 or 16
E	P5	<u>14</u>	14 or 16



Insp. _____ Date 2-2-72

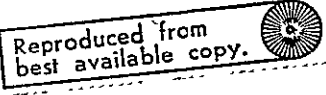
2.1.28 Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>2032</u>	2032 or 2048
A	E2	<u>2032</u>	2032 or 2048
C	E3	<u>2032</u>	2032 or 2048
D	E4	<u>2048</u>	2032 or 2048
E	P6	<u>2032</u>	2032 or 2048



Insp. _____ Date 2-2-72

DATA SHEET 6 (Cont.)




2.1.29 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>2032</u>	2032 or 2048
B	P2	<u>2032</u>	2032 or 2048
C	P3	<u>2032</u>	2032 or 2048
D	P4	<u>2032</u>	2032 or 2048
E	P5	<u>2032</u>	2032 or 2048

Insp.  Date 2-2-72

2.1.31 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 262,142 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>260096</u>	260,096 or 262,144
B	E2	<u>260096</u>	260,096 or 262,144
C	E3	<u>260096</u>	260,096 or 262,144
D	E4	<u>262144</u>	260,096 or 262,144
E	P6	<u>260096</u>	260,096 or 262,144

Insp.  Date 2-2-72

DATA SHEET 6 (Cont.)

2.1.32 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>260,096</u>	260,096 or 262,144
B	P2	<u>260,096</u>	260,096 or 262,144
C	P3	<u>260,096</u>	260,096 or 262,144
D	P4	<u>260,096</u>	260,096 or 262,144
E	P6	<u>262,144</u>	260,096 or 262,144



Insp. 2-2-72 / Date

2.1.34 Electron 1, Electron 2, Electron 3, Electron 4 and
Proton 6 33,554,430 pulse data accumulation test.

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>33,292,288</u>	33,292,288 or 0
B	E2	<u>0</u>	33,292,288 or 0
C	E3	<u>0</u>	33,292,288 or 0
D	E4	<u>244</u>	33,292,288 or 0
E	P6	<u>33,292,288</u>	33,292,288 or 0.




Insp. 2-2-72 / Date

REF PK =
EPS 0072

DATA SHEET 6 (Cont.)

2.1.35 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
33,554,430 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>33,292,288</u>	33,292,288 or 0
B	P2	<u>33,292,288</u>	33,292,288 or 0
C	P3	<u>33,292,288</u>	33,292,288 or 0
D	P4	<u>33,292,288</u>	33,292,288 or 0
E	P5	<u>33,292,288</u>	33,292,288 or 0

 Insp. 2-2-72
Date

2.1.36 Visual inspection


 Insp. 2-2-72
Date

DATA SHEET 6 (Cont.)


2.6.2 Test article to Building 49, NASA/MSC

	<u>9 FEB 72</u>
Insp.	Date


2.6.3 Prepare control system

	<u>9 FEB 72</u>
Insp.	Date


2.6.4 Mount fixture

	<u>9 FEB 72</u>
Insp.	Date

2.6.5 *R AXIS*
Shape shock pulse

	<u>9 FEB 72</u>
Insp.	Date


2.6.6 Repeat step 2.4.6

	<u>9 FEB 72</u>
Insp.	Date

2.6.7 Expose to shock pulse

	<u>9 FEB 72</u>
Insp.	Date

2.6.8 Repeat step 2.4.9

	<u>9 FEB 72</u>
Insp.	Date

DATA SHEET 6 (Cont.)

2.6.9 Setup for 'X' axis



Insp. _____ Date 9 FEB 72

2.6.10 Repeat step 2.6.5



Insp. _____ Date 9 FEB 72

2.6.11 Repeat step 2.4.6



Insp. _____ Date 9 FEB 72

2.6.12 Repeat step 2.6.7



Insp. _____ Date 9 FEB 72

2.6.13 Repeat step 2.4.9



Insp. _____ Date 9 FEB 72


2.6.14 Repeat step 2.4.17




Insp. _____ Date 9 FEB 72

DATA SHEET 6 (Cont.)

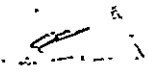
2.6.15 Repeat step 2.4.6


Insp. _____ Date 9 FEB 72


2.6.16 ^T AXIS Repeat step 2.6.7


Insp. _____ Date 9 FEB 72


2.6.17 Remove test article from fixture


Insp. _____ Date 9 FEB 72


2.6.18 Visual inspection


Insp. _____ Date 9 FEB 72

2.6.19 Install test article in stand


Insp. _____ Date 9 FEB 72

2.6.21 Drop test


Insp. _____ Date 2/10/72

DATA SHEET 7
FUNCTIONAL TEST

2.7 FUNCTIONAL TEST DATA SHEET

2.1.4 Heater Power

Measured Value

27.54

Acceptable Value

$+27.5 \pm 0.5$ Vdc



Insp.

2/10/24

Date

2.1.5 Medium Voltage Heater Current

Measured Value

7 mA

Acceptable Value

10 ± 5 mA



Insp.

2/10/24

Date

DATA SHEET 7 (Cont.)

2.1.6 Electronic Power

Measured Value

27.45

Acceptable Value

+27.5 \pm 0.5 Vdc

Insp.

Date

2/10/22

2.1.7 Medium Voltage Electronics Current

Measured Value

506 mA

Maximum Value

560 mA



FEB 10 '22

Insp.

Date

2.1.8 Detector Bias

Measured Value

27.58

Acceptable Value

+27.5 \pm 0.5 Vdc



FEB 10 '22

Insp.

Date

2.1.9 Medium Voltage Detector Bias Current

Measured Value

20 mA

Maximum Value

30 mA



FEB 10 '22

Insp.

Date

DATA SHEET 7 (Cont.)

2.1.11 Medium Voltage ADC Checkout

Reference Input Voltage	Measured Electrical Unit Output Voltage	Acceptable Electrical Output Unit Voltage
+0.025±0.001 Vdc	<u>.024</u> Vdc	+0.025±0.010 Vdc
+0.050±0.001	<u>.048</u>	0.050±0.010
+0.100±0.001	<u>.097</u>	0.100±0.010
+1.000±0.001	<u>0.997</u>	1.000±0.010
+2.000±0.001	<u>1.994</u>	2.000±0.010
+3.000±0.001	<u>2.996</u>	+3.000±0.010
+4.000±0.001	<u>3.993</u>	+4.000±0.015
+4.900±0.001	<u>4.892</u>	+4.900±0.020



FEB 10 '72

Insp.

Date

DATA SHEET 7 (Cont.)

2.1.13 Medium Voltage Housekeeping Parameter Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Engineering Unit Value
+5V Monitor	A	<u>5.111</u> 0.9786 Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.126</u>	+8.10±0.15
-8V Monitor	A	<u>-8.160</u>	-8.15±0.15
+25V Monitor	A	<u>25.588</u>	+25.50±0.75
+350V Monitor	A	<u>346.330</u>	+350.±15.
-15V Monitor	A	<u>-16.039</u>	-15.0±1.0
-5V Monitor	A	<u>-5.401</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.111</u>	+5.00±0.25
+8V Monitor	B	<u>8.135</u>	+8.10±0.15
-8V Monitor	B	<u>-8.181</u>	-8.15±0.15
+25V Monitor	B	<u>25.588</u>	+25.50±0.75
+350V Monitor	B	<u>346.330</u>	+350.±15.
-15V Monitor	B	<u>-16.039</u>	-15.0±1.0
-5V Monitor	B	<u>-5.401</u>	-5.25±0.25
Disc Ref Mon.	B	<u>2.995</u>	+3.000±0.02



DR #
EPS-0071



JEB 1072

Insp. _____ Date _____

2.1.14

	Actual Value	Acceptable Value
Heater	<u>25.37</u> 25.00	+25.0 ± 0.5 Vdc
Electronics	<u>25.00</u>	+25.0 ± 0.5 Vdc
Detector Bias	<u>25.02</u>	+25.0 ± 0.5 Vdc



JEB 1072

Insp. _____ Date _____

DATA SHEET 7 (Cont.)

2.1.15 Low Voltage Current Consumption

Current Sink	Measured Current	Acceptable Value
Heater	<u>7</u> mA	10 ± 5 mA
Electronics	<u>538</u>	< 560
Detector Bias	<u>21</u>	< 30

JUN 10 '72

Insp.

Date

2.1.16 Low Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.111</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.126</u>	+8.10±0.15
-8V Monitor	A	<u>-8.160</u>	-8.15±0.15
+25V Monitor	A	<u>25.588</u>	+25.50±0.75
+350 V Monitor	A	<u>346.330</u>	+350.±15.
-15V Monitor	A	<u>-15.980</u>	-15.0±1.0
-5V Monitor	A	<u>-5.398</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.111</u>	+5.00±0.25
+8V Monitor	B	<u>8.126</u>	+8.10±0.15
-8V Monitor	B	<u>-8.160</u>	-8.15±0.15
+25V Monitor	B	<u>25.588</u>	+25.50±0.75
+350V Monitor	B	<u>301 346.330</u>	+350.±15.
-15V Monitor	B	<u>-15.980</u>	-15.0±1.0
-5V Monitor	B	<u>-5.398</u>	-5.25±0.25
Disc Ref Mon.	B	<u>3.000</u>	+3.00±0.02

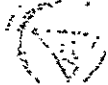
Insp.

Date

DATA SHEET 7 (Cont.)

2.1.17	Actual Value	Acceptable Value
Heater	<u>29.97</u>	+30.0 ± 0.5 Vdc
Electronics	<u>29.96</u>	+30.0 ± 0.5 Vdc
Detector Bias	<u>30.14</u>	+30.0 ± 0.5 Vdc


FEB 10 '72


 Insp. _____ Date _____

2.1.18 High Voltage Current Consumption

Current Sink	Actual Value	Acceptable Value
Heater	<u>7</u>	mA 10 ± 5 mA
Electronics	<u>490</u>	≤ 560
Detector Bias	<u>21</u>	≤ 30

FEB 10 '72


 Insp. _____ Date _____

DATA SHEET 7 (Cont.)

2.1.19 High Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.111</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.135</u>	+8.10±0.15
-8V Monitor	A	<u>-8.187</u>	-8.15±0.15
+25V Monitor	A	<u>25.588</u>	+25.50±0.75
+350V Monitor	A	<u>346.330</u>	+350.±15.
-15V Monitor	A	<u>-16.052</u>	-15.0±1.0
-5V Monitor	A	<u>-5.417</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.121</u>	+5.00±0.25
+8V Monitor	B	<u>8.145</u>	+8.10±0.15
-8V Monitor	B	<u>-8.187</u>	-8.15±0.15
+25V Monitor	B	<u>25.642</u>	+25.50±0.75
+350V Monitor	B	<u>346.330</u>	+350.±15.
-15V Monitor	B	<u>-16.029</u>	-15.0±1.0
-5V Monitor	B	<u>-5.417</u>	-5.25±0.25
Disc Ref Mon.	B	<u>3.000</u>	+3.00±0.02


DR#
EPS 0021

Insp. _____ Date _____

DATA SHEET 7 (Cont.)

2.1.20 Temperature Measurement


Parameter	Prime Frame	Measured Value	Acceptable Limits
Package Temperature Monitor	A	<u>23.258</u> °C	50°F to 118°F = 10°C to 48°C
Package Temperature Monitor	B	<u>23.356</u>	↓
Detector Plate Temperature Monitor	A	<u>23.161</u>	_____
Detector Plate Temperature Monitor	B	<u>23.161</u>	_____


FEB 10 72

Insp. _____ Date _____

2.1.21 Detector Leakage Current Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>.175</u> μA	1.0 μA
B	<u>.537</u>	2.0 μA
C	<u>1.968</u>	2.0 μA
D	<u>.682</u>	2.0 μA
E	<u>.711</u>	2.0 μA


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Insp. _____ Date _____

DATA SHEET 7 (Cont.)

2.1.22 Detector Resolution Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>.391</u> <u>7</u> keV	50. keV
B	<u>.405</u> <u>6.5</u>	50. keV
C	<u>.552</u> <u>13</u>	50. keV
D	<u>.627</u> <u>12</u>	50. keV
E	<u>.711</u> <u>14</u>	50. keV



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Insp. _____ Date _____

2.1.25 Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>14</u>	14 or 16
B	E2	<u>14</u>	14 or 16
C	E3	<u>14</u>	14 or 16
D	E4	<u>14</u>	14 or 16
E	P6	<u>14</u>	14 or 16



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Insp. _____ Date _____

DATA SHEET 7 (Cont.)

2.1.26 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5.
14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>14</u>	14 or 16
B	P2	<u>14</u>	14 or 16
C	P3	<u>14</u>	14 or 16
D	P4	<u>14</u>	14 or 16
E	P5	<u>14</u>	14 or 16

#B10-2

Insp. _____ Date _____

2.1.28 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable
A	E1	<u>2032</u>	2032 or 2048
A	E2	<u>2032</u>	2032 or 2048
C	E3	<u>2032</u>	2032 or 2048
D	E4	<u>2032</u>	2032 or 2048
E	P6	<u>2032</u>	2032 or 2048


#B10-2

Insp. _____ Date _____

DATA SHEET 7 (Cont.)

2.1.29 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
2046 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>2032</u>	2032 or 2048
B	P2	<u>2032</u>	2032 or 2048
C	P3	<u>2032</u>	2032 or 2048
D	P4	<u>2032</u>	2032 or 2048
E	P5	<u>2032</u>	2032 or 2048


2012

 Insp. _____ Date _____

2.1.31 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>260096</u>	260,096 or 262,144
B	E2	<u>260096</u>	260,096 or 262,144
C	E3	<u>260096</u>	260,096 or 262,144
D	E4	<u>262144</u>	260,096 or 262,144
E	P6	<u>260096</u>	260,096 or 262,144


2012

 Insp. _____ Date _____

DATA SHEET 7 (Cont.)

2.1.32 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>260096</u>	260,096 or 262,144
B	P2	<u>260096</u>	260,096 or 262,144
C	P3	<u>260096</u>	260,096 or 262,144
D	P4	<u>260096</u>	260,096 or 262,144
E	P6	<u>262144</u>	260,096 or 262,144

Insp.

Date

FEB 10 '22

2.1.34 Electron 1, Electron 2, Electron 3, Electron 4 and
Proton 6 33,554,430 pulse data accumulation test.

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>33,292,288</u>	33,292,288 or 0
B	E2	<u>33,292,288</u>	33,292,288 or 0
C	E3	<u>33,292,288</u>	33,292,288 or 0
D	E4	<u>33,292,288</u>	33,292,288 or 0
E	P6	<u>0</u>	33,292,288 or 0

Insp.

Date

FEB 10 '22

DATA SHEET 7 (Cont.)

2.1.35 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
33,554,430 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
P1		<u>33,292,288</u>	33,292,288 or 0
P2		<u>33,292,288</u>	33,292,288 or 0
P3		<u>33,292,288</u>	33,292,288 or 0
P4		<u>33,292,288</u>	33,292,288 or 0
P5		<u>33,292,288</u>	33,292,288 or 0

FEB 10 78

Insp. _____ Date _____

2.1.36 Visual inspection

DATA SHEET 8

2.8 EMC VIBRATION.

POST X & T AXIS FUNCTIONAL TEST

2.1.4 Heater Power

Measured Value

27.54

Acceptable Value _____

+27.5 ± 0.5 Vdc



3117

Insp. _____

Date _____

2.1.5 Medium Voltage Heater Current

Measured Value

1.007

Acceptable Value _____

10 ± 5 mA



3117

Insp. _____

Date _____

DATA SHEET 8 (Cont.)

2.1.6 Electronic Power

Measured Value

27.45

Acceptable Value

$+27.5 \pm 0.5$ Vdc

Insp.

Date

FB1172

2.1.7 Medium Voltage Electronics Current

Measured Value

509

Maximum Value

560 mA

Insp.

Date

FB1172

2.1.8 Detector Bias

Measured Value

27.56

Acceptable Value

$+27.5 \pm 0.5$ Vdc

Insp.

Date

FB1172

2.1.9 Medium Voltage Detector Bias Current

Measured Value

20

Maximum Value

30 mA

Insp.

Date

FB1172



2.1.11 Medium Voltage ADC Checkout

Reference Input Voltage	Measured Electrical Unit Voltage	Acceptable Electrical Output Unit Voltage
+0.025±0.002 Vdc	<u>0.029</u> Vdc	+0.025±0.010 Vdc
+0.050±0.002	<u>0.044</u>	0.050±0.010
+0.100±0.002	<u>0.093</u>	0.100±0.010
+1.000±0.002	<u>0.992</u>	1.000±0.010
+2.000±0.002	<u>1.994</u>	2.000±0.010
+3.000±0.002	<u>2.991</u>	+3.000±0.010
+4.000±0.002	<u>3.993</u>	+4.000±0.015
+4.900±0.002	<u>4.892</u>	+4.900±0.020



FEB 11 '72


Insp. _____ Date _____

DATA SHEET 8 (Cont.)

2.1.13 Medium Voltage Housekeeping Parameter Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Engineering Unit Value
+5V Monitor	A	<u>5.111</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.126</u>	+8.10±0.15
-8V Monitor	A	<u>-8.181</u>	-8.15±0.15
+25V Monitor	A	<u>25.588</u>	+25.50±0.75
+350V Monitor	A	<u>346.330</u>	+350.±15.
-15V Monitor	A	<u>-16.039</u>	-15.0±1.0
-5V Monitor	A	<u>-5.401</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.111</u>	+5.00±0.25
+8V Monitor	B	<u>8.135</u>	+8.10±0.15
-8V Monitor	B	<u>-8.166</u>	-8.15±0.15
+25V Monitor	B	<u>25.588</u>	+25.50±0.75
+350V Monitor	B	<u>346.330</u>	+350.±15.
-15V Monitor	B	<u>-16.016</u>	-15.0±1.0
-5V Monitor	B	<u>-5.401</u>	-5.25±0.25
Disc Ref Mon.	B	<u>2.995</u>	+3.000±0.02


DATA 15720-007



 Insp. _____ Date FB1178

2.1.14

	Actual Value	Acceptable Value
Heater	<u>25.37</u>	+25.0 ± 0.5 Vdc
Electronics	<u>25.00</u>	+25.0 ± 0.5 Vdc
Detector Bias	<u>25.02</u>	+25.0 ± 0.5 Vdc




 Insp. _____ Date FB1178

DATA SHEET 8 (Cont.)

2.1.15 Low Voltage Current Consumption


Current Sink	Measured Current	Acceptable Value
Heater	<u>7</u> mA	10 ± 5 mA
Electronics	<u>540</u>	≤ 560
Detector Bias	<u>20</u>	≤ 30



 Insp. _____ Date Feb 11 '72

2.1.16 Low Voltage Housekeeping Checkout


Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.102</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.126</u>	+8.10±0.15
-8V Monitor	A	<u>-8.175</u>	-8.15±0.15
+25V Monitor	A	<u>25.588</u>	+25.50±0.75
+350 V Monitor	A	<u>346.330</u>	+350.±15.
-15V Monitor	A	<u>-15.980</u>	-15.0±1.0
-5V Monitor	A	<u>-5.398</u>	-5.25±0.25
Disc Ref Mon.	A	<u>+3.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.102</u>	+5.00±0.25
+8V Monitor	B	<u>8.126</u>	+8.10±0.15
-8V Monitor	B	<u>-8.160</u>	-8.15±0.15
+25V Monitor	B	<u>25.588</u>	+25.50±0.75
+350V Monitor	B	<u>346.330</u>	+350.±15.
-15V Monitor	B	<u>-15.980</u>	-15.0±1.0
-5V Monitor	B	<u>-5.398</u>	-5.25±0.25
Disc Ref Mon.	B	<u>+3.000</u>	+3.00±0.02



 Insp. _____ Date Feb 11 '72


DATA SHEET 8 (Cont.)

2.1.17	Actual Value	Acceptable Value
Heater	<u>29.97</u>	+30.0 ± 0.5 Vdc
Electronics	<u>29.97</u>	+30.0 ± 0.5 Vdc
Detector Bias	<u>30.08</u>	+30.0 ± 0.5 Vdc


 Insp. _____ Date Feb 11 '72

2.1.18 High Voltage Current Consumption

Current Sink	Actual Value	Acceptable Value
Heater	<u>17</u> mA	10 ± 5 mA
Electronics	488 <u>493</u>	≤ 560
Detector Bias	<u>20</u>	≤ 30

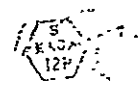

 Insp. _____ Date Feb 11 '72

DATA SHEET 8 (Cont.)

2.1.19 High Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.111</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.135</u>	+8.10±0.15
-8V Monitor	A	<u>-8.181</u>	-8.15±0.15
+25V Monitor	A	<u>25.588</u>	+25.50±0.75
+350V Monitor	A	<u>346.330</u>	+350.±15.
-15V Monitor	A	<u>-16.016</u>	-15.0±1.0
-5V Monitor	A	<u>-5.401</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.111</u>	+5.00±0.25
+8V Monitor	B	<u>8.13.5</u>	+8.10±0.15
-8V Monitor	B	<u>-8.166</u>	-8.15±0.15
+25V Monitor	B	<u>25.642</u>	+25.50±0.75
+350V Monitor	B	<u>346.330</u>	+350.±15.
-15V Monitor	B	<u>-15.943</u>	-15.0±1.0
-5V Monitor	B	<u>-5.401</u>	-5.25±0.25
Disc Ref Mon.	B	<u>3.000</u>	+3.00±0.02

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Insp. _____ Date _____

DATA SHEET 8 (Cont.)

2.1.20 Temperature Measurement

Parameter	Prime Frame	Measured Value	Acceptable Limits
Package Temperature Monitor	A	<u>23,747</u> °C	50°F to 118°F = 10°C to 48°C
Package Temperature Monitor	B	<u>23,747</u>	↓
Detector Plate Temperature Monitor	A	<u>23,258</u>	XXXXXXXXXX
Detector Plate Temperature Monitor	B	<u>23,258</u>	XXXXXXXXXX

FEB 11 '72

Insp. _____ Date _____

2.1.21 Detector Leakage Current Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>.185</u> μA	1.0 μA
B	<u>.533</u>	2.0 μA
C	<u>.392</u>	2.0 μA
D	<u>.674</u>	2.0 μA
E	<u>.175</u>	2.0 μA

FEB 11 '72

Insp. _____ Date _____

DATA SHEET 8 (Cont.)

2.1.22 Detector Resolution Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>.391</u> <u>7</u> keV	50. keV
B	<u>.4</u> <u>7</u>	50. keV
C	<u>.4</u> <u>6</u>	50. keV
D	<u>.6</u> <u>11</u>	50. keV
E	<u>.376</u> <u>7</u>	50. keV



FEB 11 '72

Insp. _____ Date _____

2.1.25 Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>14</u>	14 or 16
B	E2	<u>16</u>	14 or 16
C	E3	<u>14</u>	14 or 16
D	E4	<u>14</u>	14 or 16
E	P6	<u>14</u>	14 or 16



FEB 11 '72

Insp. _____ Date _____

DATA SHEET 8 (Cont.)

2.1.26 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5.
14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>14</u>	14 or 16
B	P2	<u>14</u>	14 or 16
C	P3	<u>14</u>	14 or 16
D	P4	<u>14</u>	14 or 16
E	P5	<u>14</u>	14 or 16



FBI 11 '72

Insp. _____ Date _____

2.1.28 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>2032</u>	2032 or 2048
A	E2	<u>2032</u>	2032 or 2048
C	E3	<u>2032</u>	2032 or 2048
D	E4	<u>2048</u>	2032 or 2048
E	P6	<u>2032</u>	2032 or 2048




FBI 11 '72

Insp. _____ Date _____

DATA SHEET 8 (Cont.)

2.1.29 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
2046 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>2032</u>	2032 or 2048
B	P2	<u>2032</u>	2032 or 2048
C	P3	<u>2032</u>	2032 or 2048
D	P4	<u>2032</u>	2032 or 2048
E	P5	<u>2032</u>	2032 or 2048


 JB 11 72

 Insp. Date

2.1.31 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>260096</u>	260,096 or 262,144
B	E2	<u>260096</u>	260,096 or 262,144
C	E3	<u>260096</u>	260,096 or 262,144
D	E4	<u>260096</u>	260,096 or 262,144
E	P6	<u>260096</u>	260,096 or 262,144


 JB 11 72

 Insp. Date

DATA SHEET 8 (Cont.)

2.1.32 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>260096</u>	260,096 or 262,144
B	P2	<u>260096</u>	260,096 or 262,144
C	P3	<u>260096</u>	260,096 or 262,144
D	P4	<u>260096</u>	260,096 or 262,144
E	P6	<u>262144</u>	260,096 or 262,144

FB 11 72

FB 11 72

Insp.

Date

2.1.34 Electron 1, Electron 2, Electron 3, Electron 4 and
Proton 6 33,554,430 pulse data accumulation test.

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>33,292,288</u>	33,292,288 or 0
B	E2	<u>0</u>	33,292,288 or 0
C	E3	<u>33,292,288</u>	33,292,288 or 0
D	E4	<u>33,292,288</u>	33,292,288 or 0
E	P6	<u>33,292,288</u>	33,292,288 or 0

FB 11 72


Insp.

Date


DATA SHEET 8 (Cont.)

2.1.35 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
33,554,430 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>33,292,288</u>	33,292,288 or 0
B	P2	<u>33,292,288</u>	33,292,288 or 0
C	P3	<u>33,292,288</u>	33,292,288 or 0
D	P4	<u>33,292,288</u>	33,292,288 or 0
E	P5	<u>33,292,288</u>	33,292,288 or 0


EB117
 Insp. _____ Date _____

2.1.36 Visual inspection


EB117
 Insp. _____ Date _____

~~2.8.2 Perform EMI Test per EMC P-EB8-003~~ N/A

Insp. _____ Date _____

DATA SHEET 9
FUNCTIONAL TEST

2.9 FUNCTIONAL TEST DATA SHEET

~~POST HEATABILITY~~

2.1.4 Heater Power

Measured Value

Acceptable Value

$+27.5 \pm 0.5$ Vdc

Insp.

Date

2.1.5 Medium Voltage Heater Current

Measured Value

Acceptable Value

10 ± 5 mA

Insp.

Date

DATA SHEET 9 (Cont.)

2.1.6 Electronic Power

Measured Value

Acceptable Value

+27.5 ± 0.5 Vdc

Insp. Date

2.1.7 Medium Voltage Electronics Current

Measured Value

Maximum Value

560 mA

Insp. Date

2.1.8 Detector Bias

Measured Value

Acceptable Value

+27.5 ± 0.5 Vdc

Insp. Date

2.1.9 Medium Voltage Detector Bias Current

Measured Value

Maximum Value

30 mA

Insp. Date

DATA SHEET 9 (Cont.)

2.1.11 Medium Voltage ADC Checkout

Reference Input Voltage	Measured Electrical Unit Output Voltage	Acceptable Electrical Output Unit Voltage
+0.025±0.001 Vdc	_____ Vdc	+0.025±0.010 Vdc
+0.050±0.001	_____	0.050±0.010
+0.100±0.001	_____	0.100±0.010
+1.000±0.001	_____	1.000±0.010
+2.000±0.001	_____	2.000±0.010
+3.000±0.001	_____	+3.000±0.010
+4.000±0.001	_____	+4.000±0.015
+4.900±0.001	_____	+4.900±0.020

Insp.

Date

DATA SHEET 9 (Cont.)

2.1.13 Medium Voltage Housekeeping Parameter Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Engineering Unit Value
+5V Monitor	A	_____ Vdc	+5.00±0.25 Vdc
+8V Monitor	A	_____	+8.10±0.15
-8V Monitor	A	_____	-8.15±0.15
+25V Monitor	A	_____	+25.50±0.75
+350V Monitor	A	_____	+350.±15.
-15V Monitor	A	_____	-15.0±1.0
-5V Monitor	A	_____	-5.25±0.25
Disc Ref Mon.	A	_____	+3.00±0.02
+5V Monitor	B	_____	+5.00±0.25
+8V Monitor	B	_____	+8.10±0.15
-8V Monitor	B	_____	-8.15±0.15
+25V Monitor	B	_____	+25.50±0.75
+350V Monitor	B	_____	+350.±15.
-15V Monitor	B	_____	-15.0±1.0
-5V Monitor	B	_____	-5.25±0.25
Disc Ref Mon.	B	_____	+3.000±0.02

Insp. _____ Date _____

2.1.14

	Actual Value	Acceptable Value
Heater	_____	+25.0 ± 0.5 Vdc
Electronics	_____	+25.0 ± 0.5 Vdc
Detector Bias	_____	+25.0 ± 0.5 Vdc

Insp. _____ Date _____

DATA SHEET 9 (Cont.)

2.1.15 Low Voltage Current Consumption

Current Sink	Measured Current	Acceptable Value
Heater	_____ mA	10 ± 5 mA
Electronics	_____	< 560
Detector Bias	_____	< 30

_____ Insp. _____ Date

2.1.16 Low Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	_____ Vdc	+5.00±0.25 Vdc
+8V Monitor	A	_____	+8.10±0.15
-8V Monitor	A	_____	-8.15±0.15
+25V Monitor	A	_____	+25.50±0.75
+350 V Monitor	A	_____	+350.±15.
-15V Monitor	A	_____	-15.0±1.0
-5V Monitor	A	_____	-5.25±0.25
Disc Ref Mon.	A	_____	+3.00±0.02
+5V Monitor	B	_____	+5.00±0.25
+8V Monitor	B	_____	+8.10±0.15
-8V Monitor	B	_____	-8.15±0.15
+25V Monitor	B	_____	+25.50±0.75
+350V Monitor	B	_____	+350.±15.
-15V Monitor	B	_____	-15.0±1.0
-5V Monitor	B	_____	-5.25±0.25
Disc Ref Mon.	B	_____	+3.00±0.02

_____ Insp. _____ Date

DATA SHEET 9 (Cont.)

2.1.17	Actual Value	Acceptable Value
Heater	_____	+30.0 ± 0.5 Vdc
Electronics	_____	+30.0 ± 0.5 Vdc
Detector Bias	_____	+30.0 ± 0.5 Vdc

Insp. Date

2.1.18 High Voltage Current Consumption

Current Sink	Actual Value	Acceptable Value
Heater	_____	mA 10 ± 5 mA
Electronics	_____	< 560
Detector Bias	_____	< 30

Insp. Date

DATA SHEET 9 (Cont.)

2.1.19 High Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	_____ Vdc	+5.00±0.25 Vdc
+8V Monitor	A	_____	+8.10±0.15
-8V Monitor	A	_____	-8.15±0.15
+25V Monitor	A	_____	+25.50±0.75
+350V Monitor	A	_____	+350.±15.
-15V Monitor	A	_____	-15.0±1.0
-5V Monitor	A	_____	-5.25±0.25
Disc Ref Mon.	A	_____	+3.00±0.02
+5V Monitor	B	_____	+5.00±0.25
+8V Monitor	B	_____	+8.10±0.15
-8V Monitor	B	_____	-8.15±0.15
+25V Monitor	B	_____	+25.50±0.75
+350V Monitor	B	_____	+350.±15.
-15V Monitor	B	_____	-15.0±1.0
-5V Monitor	B	_____	-5.25±0.25
Disc Ref Mon.	B	_____	+3.00±0.02

Insp. _____ Date _____

DATA SHEET 9 (Cont.)

2.1.20. Temperature Measurement

Parameter	Prime Frame	Measured Value	Acceptable Limits
Package Temperature Monitor	A	_____ °C	50°F to 118°F 10°C to 48°C
Package Temperature Monitor	B	_____	↓
Detector Plate Temperature Monitor	A	_____	_____
Detector Plate Temperature Monitor	B	_____	_____

Insp. Date

2.1.21 Detector Leakage Current Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	_____ μA	1.0 μA
B	_____	2.0 μA
C	_____	2.0 μA
D	_____	2.0 μA
E	_____	2.0 μA

Insp. Date

DATA SHEET 9 (Cont.)

2.1.22 Detector Resolution Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	_____ keV	50. keV
B	_____	50. keV
C	_____	50. keV
D	_____	50. keV
E	_____	50. keV

Insp. _____ Date _____

2.1.25 Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	_____	14 or 16
B	E2	_____	14 or 16
C	E3	_____	14 or 16
D	E4	_____	14 or 16
E	P6	_____	14 or 16

Insp. _____ Date _____

DATA SHEET 9 (Cont.)

2.1.26 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5.
14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	_____	14 or 16
B	P2	_____	14 or 16
C	P3	_____	14 or 16
D	P4	_____	14 or 16
E	P5	_____	14 or 16

Insp. Date

2.1.28 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable
A	E1	_____	2032 or 2048
A	E2	_____	2032 or 2048
C	E3	_____	2032 or 2048
D	E4	_____	2032 or 2048
E	P6	_____	2032 or 2048

Insp. Date

DATA SHEET 9 (Cont.)

2.1.29 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	_____	2032 or 2048
B	P2	_____	2032 or 2048
C	P3	_____	2032 or 2048
D	P4	_____	2032 or 2048
E	P5	_____	2032 or 2048

Insp. Date

2.1.31 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	_____	260,096 or 262,144
B	E2	_____	260,096 or 262,144
C	E3	_____	260,096 or 262,144
D	E4	_____	260,096 or 262,144
E	P6	_____	260,096 or 262,144

Insp. Date

DATA SHEET 9 (Cont.)

2.1.32 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	_____	260,096 or 262,144
B	P2	_____	260,096 or 262,144
C	P3	_____	260,096 or 262,144
D	P4	_____	260,096 or 262,144
E	P6	_____	260,096 or 262,144

Insp. Date

2.1.34 Electron 1, Electron 2, Electron 3, Electron 4 and
Proton 6 33,554,430 pulse data accumulation test.

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	_____	33,292,288 or 0
B	E2	_____	33,292,288 or 0
C	E3	_____	33,292,288 or 0
D	E4	_____	33,292,288 or 0
E	P6	_____	33,292,288 or 0

Insp. Date

DATA SHEET 9 (Cont.)

2.1.35 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
33,554,430 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	_____	33,292,288 or 0
B	P2	_____	33,292,288 or 0
C	P3	_____	33,292,288 or 0
D	P4	_____	33,292,288 or 0
E	P5	_____	33,292,288 or 0

Insp. Date

2.1.36 Visual inspection

Insp. Date

Post Acoustic Functional Test.

2.10 ACOUSTIC

2.1.4 Heater Power

Measured Value

27.54

Acceptable Value

$\pm 27.5 \pm 0.5$ Vdc

Insp.



Date

2/9/22

2.1.5 Medium Voltage Heater Current

Measured Value

7 mA

Acceptable Value

10 ± 5 mA

Insp.



Date

2/9/22

DATA SHEET 10 (Cont.)


2.1.6 Electronic Power

Measured Value

27.54

Acceptable Value

+27.5 ± 0.5 Vdc


Insp. 2/9/72
Date


2.1.7 Medium Voltage Electronics Current

Measured Value

510 mA

Maximum Value

560 mA


Insp. 2/9/72
Date


2.1.8 Detector Bias

Measured Value

27.56

Acceptable Value

+27.5 ± 0.5 Vdc


Insp. 2/9/72
Date


2.1.9 Medium Voltage Detector Bias Current

Measured Value

20 mA

Maximum Value

30 mA



Insp. 2/9/72
Date

DATA SHEET 10 (Cont.)

2.1.13 Medium Voltage Housekeeping Parameter Checkout


Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Engineering Unit Value
+5V Monitor	A	<u>5.111</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.135</u>	+8.10±0.15
-8V Monitor	A	<u>-8.181</u>	-8.15±0.15
+25V Monitor	A	<u>25.588</u>	+25.50±0.75
+350V Monitor	A	<u>346.33</u>	+350.±15.
-15V Monitor	A	<u>-16.016</u>	-15.0±1.0
-5V Monitor	A	<u>-5.401</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.111</u>	+5.00±0.25
+8V Monitor	B	<u>8.135</u>	+8.10±0.15
-8V Monitor	B	<u>-8.166</u>	-8.15±0.15
+25V Monitor	B	<u>25.642</u>	+25.50±0.75
+350V Monitor	B	<u>346.33</u>	+350.±15.
-15V Monitor	B	<u>-16.016</u>	-15.0±1.0
-5V Monitor	B	<u>-5.401</u>	-5.25±0.25
Disc Ref Mon.	B	<u>3.000</u>	+3.000±0.02

RFF: DR #FSC-0091


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2.1.14

	Actual Value	Acceptable Value
Heater	<u>25.37</u>	+25.0 ± 0.5 Vdc
Electronics	<u>25.0</u>	+25.0 ± 0.5 Vdc
Detector Bias	<u>25.03</u>	+25.0 ± 0.5 Vdc


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 Date

DATA SHEET 10 (Cont.)

2.1.15 Low Voltage Current Consumption


Current Sink	Measured Current	Acceptable Value
Heater	<u>7 mA</u> mA	10 ± 5 mA
Electronics	<u>540 mA</u>	≤ 560
Detector Bias	<u>20 mA</u>	≤ 30
	<u>(Signature)</u>	<u>2/9/72</u>
	Insp.	Date

2.1.16 Low Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.111</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.126</u>	+8.10±0.15
-8V Monitor	A	<u>-8.160</u>	-8.15±0.15
+25V Monitor	A	<u>25.588</u>	+25.50±0.75
+350 V Monitor	A	<u>346.33</u>	+350.±15.
-15V Monitor	A	<u>-15.98</u>	-15.0±1.0
-5V Monitor	A	<u>-5.398</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.111</u>	+5.00±0.25
+8V Monitor	B	<u>8.126</u>	+8.10±0.15
-8V Monitor	B	<u>-8.160</u>	-8.15±0.15
+25V Monitor	B	<u>25.588</u>	+25.50±0.75
+350V Monitor	B	<u>346.33</u>	+350.±15.
-15V Monitor	B	<u>-15.98</u>	-15.0±1.0
-5V Monitor	B	<u>-5.386</u>	-5.25±0.25
Disc Ref Mon.	B	<u>3.000</u>	+3.00±0.02
		<u>(Signature)</u>	<u>2/9/72</u>
		Insp.	Date

DATA SHEET 10 (Cont.)


2.1.17	Actual Value	Acceptable Value
Heater	<u>29.97</u>	+30.0 ± 0.5 Vdc
Electronics	<u>29.96</u>	+30.0 ± 0.5 Vdc
Detector Bias	<u>30.15</u>	+30.0 ± 0.5 Vdc



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2.1.18 High Voltage Current Consumption

Current Sink	Actual Value	Acceptable Value
Heater	<u>7 ma</u> mA	10 ± 5 mA
Electronics	<u>490 ma</u>	≤ 560
Detector Bias	<u>20 ma</u>	≤ 30

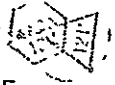


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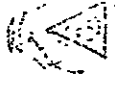
DATA SHEET 10 (Cont.)

2.1.19 High Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.121</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.135</u>	+8.10±0.15
-8V Monitor	A	<u>-8.187</u>	-8.15±0.15
+25V Monitor	A	<u>25.588</u>	+25.50±0.75
+350V Monitor	A	<u>346.330</u>	+350.±15.
-15V Monitor	A	<u>-16.029</u>	-15.0±1.0
-5V Monitor	A	<u>-5.417</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.995</u>	+3.00±0.02
+5V Monitor	B	<u>5.121</u>	+5.00±0.25
+8V Monitor	B	<u>8.145</u>	+8.10±0.15
-8V Monitor	B	<u>-8.187</u>	-8.15±0.15
+25V Monitor	B	<u>25.642</u>	+25.50±0.75
+350V Monitor	B	<u>346.330</u>	+350.±15.
-15V Monitor	B	<u>-16.029</u>	-15.0±1.0
-5V Monitor	B	<u>-5.392</u>	-5.25±0.25
Disc Ref Mon.	B	<u>3.000</u>	+3.00±0.02



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DATA SHEET 10 (Cont.)


2.1.20 Temperature Measurement

Parameter	Prime Frame	Measured Value	Acceptable Limits
Package Temperature Monitor	A	<u>25.604</u> °C	50°F to 118°F 10°C to 48°C
Package Temperature Monitor	B	<u>25.604</u>	↓ ▽
Detector Plate Temperature Monitor	A	<u>24.334</u>	_____
Detector Plate Temperature Monitor	B	<u>24.334</u>	_____


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2.1.21 Detector Leakage Current Test


EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>.211</u> μA	1.0 μA
B	<u>.589</u>	2.0 μA
C	<u>1.968</u>	2.0 μA
D	<u>.738</u>	2.0 μA
E	<u>.792</u>	2.0 μA


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DATA SHEET 10 (Cont.)


2.1.22 Detector Resolution Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>.405 7.5 keV</u>	50. keV
B	<u>.420 7.0</u>	50. keV
C	<u>.420 7.5</u>	50. keV
D	<u>.826 17.5</u>	50. keV
E	<u>.386 7.5</u>	50. keV

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2.1.25 Electron 1, Electron 2, Electron 3, Electron 4,
 and Proton 6 14 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>14</u>	14 or 16
B	E2	<u>16</u>	14 or 16
C	E3	<u>14</u>	14 or 16
D	E4	<u>14</u>	14 or 16
E	P6	<u>14</u>	14 or 16

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 Insp. Date

DATA SHEET 10 (Cont.)

2.1.26 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5.
14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>14</u>	14 or 16
B	P2	<u>14</u>	14 or 16
C	P3	<u>14</u>	14 or 16
D	P4	<u>14</u>	14 or 16
E	P5	<u>14</u>	14 or 16



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2.1.28 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>2032</u>	2032 or 2048
A	E2	<u>2032</u>	2032 or 2048
C	E3	<u>2032</u>	2032 or 2048
D	E4	<u>2048</u>	2032 or 2048
E	F6	<u>2032</u>	2032 or 2048




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Insp. _____ Date _____

DATA SHEET 10 (Cont.)


2.1.29 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>2032</u>	2032 or 2048
B	P2	<u>2032</u>	2032 or 2048
C	P3	<u>2032</u>	2032 or 2048
D	P4	<u>2032</u>	2032 or 2048
E	P5	<u>2032</u>	2032 or 2048


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2.1.31 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 262,142 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>260096</u> 144	260,096 or 262,144
B	E2	<u>260096</u> 262144	260,096 or 262,144
C	E3	<u>260096</u>	260,096 or 262,144
D	E4	<u>260096</u>	260,096 or 262,144
E	P6	<u>260096</u>	260,096 or 262,144


Insp. 2/9/72 Date

DATA SHEET 10 (Cont.)

2.1.32 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
262,142 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>260,096</u>	260,096 or 262,144
B	P2	<u>260,096</u>	260,096 or 262,144
C	P3	<u>260,096</u>	260,096 or 262,144
D	P4	<u>260,096</u>	260,096 or 262,144
E	P6	<u>260,096</u>	260,096 or 262,144


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2.1.34 Electron 1, Electron 2, Electron 3, Electron 4 and
Proton 6 33,554,430 pulse data accumulation test.

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>33,292,288</u>	33,292,288 or 0
B	E2	<u>0</u>	33,292,288 or 0
C	E3 8	<u>0 33,292,288</u>	33,292,288 or 0
D	E4 152	<u>0 33,292,288</u>	33,292,288 or 0
E	P6	<u>32,292,288</u>	33,292,288 or 0



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Insp. Date

DATA SHEET 10 (Cont.)

2.1.35 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
 33,554,430 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>33,292,288</u>	33,292,288 or 0
B	P2	<u>33,292,288</u>	33,292,288 or 0
C	P3	<u>33,292,288</u>	33,292,288 or 0
D	P4	<u>33,292,288</u>	33,292,288 or 0
E	P5	<u>33,292,288</u>	33,292,288 or 0

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Insp. _____ Date _____

2.1.36 Visual inspection

2/9/72


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DATA SHEET 10 (Cont.)


2.10.2 Test article to test facility

 8 FEB. 72
Insp. Date


2.10.3 Prepare chamber

 8 FEB. 72
Insp. Date

2.10.4 Install test article

 8 FEB. 72
Insp. Date


2.10.5 Test

 8 FEB. 72
Insp. Date

2.10.6 Remove test article

8 FEB. 72
Insp. Date

2.10.7 Return to Beta Building

 9 FEB 72
Insp. Date

DATA SHEET 11
FUNCTIONAL TEST

2.11 FUNCTIONAL TEST DATA SHEET

2.1.4 Heater Power

Measured Value

Acceptable Value

$+27.5 \pm 0.5$ Vdc

Insp. Date

2.1.5 Medium Voltage Heater Current

Measured Value

Acceptable Value

10 ± 5 mA

Insp. Date

DATA SHEET 11 (Cont.)

2.1.6 Electronic Power

Measured Value

Acceptable Value

+27.5 ± 0.5 Vdc

Insp.

Date

2.1.7 Medium Voltage Electronics Current

Measured Value

Maximum Value

560 mA

Insp.

Date

2.1.8 Detector Bias

Measured Value

Acceptable Value

+27.5 ± 0.5 Vdc

Insp.

Date

2.1.9 Medium Voltage Detector Bias Current

Measured Value

Maximum Value

30 mA

Insp.

Date

DATA SHEET 11 (Cont.)

2.1.11 Medium Voltage ADC Checkout

Reference Input Voltage	Measured Electrical Unit Output Voltage	Acceptable Electrical Output Unit Voltage
+0.025±0.001 Vdc	_____ Vdc	+0.025±0.010 Vdc
+0.050±0.001	_____	0.050±0.010
+0.100±0.001	_____	0.100±0.010
+1.000±0.001	_____	1.000±0.010
+2.000±0.001	_____	2.000±0.010
+3.000±0.001	_____	+3.000±0.010
+4.000±0.001	_____	+4.000±0.015
+4.900±0.001	_____	+4.900±0.020

Insp.

Date

DATA SHEET 11 (Cont.)

2.1.13 Medium Voltage Housekeeping Parameter Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Engineering Unit Value
+5V Monitor	A	_____ Vdc	+5.00±0.25 Vdc
+8V Monitor	A	_____	+8.10±0.15
-8V Monitor	A	_____	-8.15±0.15
+25V Monitor	A	_____	+25.50±0.75
+350V Monitor	A	_____	+350.±15.
-15V Monitor	A	_____	-15.0±1.0
-5V Monitor	A	_____	-5.25±0.25
Disc Ref Mon.	A	_____	+3.00±0.02
+5V Monitor	B	_____	+5.00±0.25
+8V Monitor	B	_____	+8.10±0.15
-8V Monitor	B	_____	-8.15±0.15
+25V Monitor	B	_____	+25.50±0.75
+350V Monitor	B	_____	+350.±15.
-15V Monitor	B	_____	-15.0±1.0
-5V Monitor	B	_____	-5.25±0.25
Disc Ref Mon.	B	_____	+3.000±0.02

Insp. _____ Date _____

2.1.14

	Actual Value	Acceptable Value
Heater	_____	+25.0 ± 0.5 Vdc
Electronics	_____	+25.0 ± 0.5 Vdc
Detector Bias	_____	+25.0 ± 0.5 Vdc

Insp. _____ Date _____

DATA SHEET 11 (Cont.)

2.1.15 Low Voltage Current Consumption

Current Sink	Measured Current	Acceptable Value
Heater	_____ mA	10 ± 5 mA
Electronics	_____	< 560
Detector Bias	_____	< 30

_____ Insp. _____ Date

2.1.16 Low Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	_____ Vdc	+5.00±0.25 Vdc
+8V Monitor	A	_____	+8.10±0.15
-8V Monitor	A	_____	-8.15±0.15
+25V Monitor	A	_____	+25.50±0.75
+350 V Monitor	A	_____	+350.±15.
-15V Monitor	A	_____	-15.0±1.0
-5V Monitor	A	_____	-5.25±0.25
Disc Ref Mon.	A	_____	+3.00±0.02
+5V Monitor	B	_____	+5.00±0.25
+8V Monitor	B	_____	+8.10±0.15
-8V Monitor	B	_____	-8.15±0.15
+25V Monitor	B	_____	+25.50±0.75
+350V Monitor	B	_____	+350.±15.
-15V Monitor	B	_____	-15.0±1.0
-5V Monitor	B	_____	-5.25±0.25
Disc Ref Mon.	B	_____	+3.00±0.02

_____ Insp. _____ Date

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DATA SHEET 11 (Cont.)

2.1.17	Actual Value	Acceptable Value
Heater	_____	+30.0 ± 0.5 Vdc
Electronics	_____	+30.0 ± 0.5 Vdc
Detector Bias	_____	+30.0 ± 0.5 Vdc

Insp. Date

2.1.18 High Voltage Current Consumption

Current Sink	Actual Value	Acceptable Value
Heater	_____ mA	10 ± 5 mA
Electronics	_____	≤ 560
Detector Bias	_____	≤ 30

Insp. Date

DATA SHEET 11 (Cont.)

2.1.19 High Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	_____ Vdc	+5.00±0.25 Vdc
+8V Monitor	A	_____	+8.10±0.15
-8V Monitor	A	_____	-8.15±0.15
+25V Monitor	A	_____	+25.50±0.75
+350V Monitor	A	_____	+350.±15.
-15V Monitor	A	_____	-15.0±1.0
-5V Monitor	A	_____	-5.25±0.25
Disc Ref Mon.	A	_____	+3.00±0.02
+5V Monitor	B	_____	+5.00±0.25
+8V Monitor	B	_____	+8.10±0.15
-8V Monitor	B	_____	-8.15±0.15
+25V Monitor	B	_____	+25.50±0.75
+350V Monitor	B	_____	+350.±15.
-15V Monitor	B	_____	-15.0±1.0
-5V Monitor	B	_____	-5.25±0.25
Disc Ref Mon.	B	_____	+3.00±0.02

Insp. _____ Date _____

DATA SHEET 11 (Cont.)

2.1.20 Temperature Measurement

Parameter	Prime Frame	Measured Value	Acceptable Limits
Package Temperature Monitor	A	_____ °C	50°F to 118°F 10°C to 48°C
Package Temperature Monitor	B	_____	↓
Detector Plate Temperature Monitor	A	_____	_____
Detector Plate Temperature Monitor	B	_____	_____

Insp. Date

2.1.21 Detector Leakage Current Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	_____ μA	1.0 μA
B	_____	2.0 μA
C	_____	2.0 μA
D	_____	2.0 μA
E	_____	2.0 μA

Insp. Date

DATA SHEET 11 (Cont.)

2.1.22 Detector Resolution Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	_____ keV	50. keV
B	_____	50. keV
C	_____	50. keV
D	_____	50. keV
E	_____	50. keV

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Date

2.1.25 Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	_____	14 or 16
B	E2	_____	14 or 16
C	E3	_____	14 or 16
D	E4	_____	14 or 16
E	P6	_____	14 or 16

Insp.

Date

DATA SHEET 11 (Cont.)

2.1.26 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5.
14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	_____	14 or 16
B	P2	_____	14 or 16
C	P3	_____	14 or 16
D	P4	_____	14 or 16
E	P5	_____	14 or 16

Insp. Date

2.1.28 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable
A	E1	_____	2032 or 2048
A	E2	_____	2032 or 2048
C	E3	_____	2032 or 2048
D	E4	_____	2032 or 2048
E	P6	_____	2032 or 2048

Insp. Date

DATA SHEET 11 (Cont.)

2.1.29 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	_____	2032 or 2048
B	P2	_____	2032 or 2048
C	P3	_____	2032 or 2048
D	P4	_____	2032 or 2048
E	P5	_____	2032 or 2048

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2.1.31 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	_____	260,096 or 262,144
B	E2	_____	260,096 or 262,144
C	E3	_____	260,096 or 262,144
D	E4	_____	260,096 or 262,144
E	P6	_____	260,096 or 262,144

Insp. Date

DATA SHEET 11 (Cont.)

2.1.32 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	_____	260,096 or 262,144
B	P2	_____	260,096 or 262,144
C	P3	_____	260,096 or 262,144
D	P4	_____	260,096 or 262,144
E	P6	_____	260,096 or 262,144

Insp. _____ Date _____

2.1.34 Electron 1, Electron 2, Electron 3, Electron 4 and
Proton 6 33,554,430 pulse data accumulation test.

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	_____	33,292,288 or 0
B	E2	_____	33,292,288 or 0
C	E3	_____	33,292,288 or 0
D	E4	_____	33,292,288 or 0
E	P6	_____	33,292,288 or 0

Insp. _____ Date _____

DATA SHEET 11 (Cont.)

2.1.35 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
 33,554,430 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	_____	33,292,288 or 0
B	P2	_____	33,292,288 or 0
C	P3	_____	33,292,288 or 0
D	P4	_____	33,292,288 or 0
E	P5	_____	33,292,288 or 0

 Insp. Date

2.1.36 Visual inspection

 Insp. Date

DATA SHEET 12

2.12 HUMIDITY

2.1.4 Heater Power

Measured Value

Acceptable Value
 $+27.5 \pm 0.5$ Vdc

_____ Insp.

_____ Date

2.1.5 Medium Voltage Heater Current.

Measured Value

Acceptable Value
 10 ± 5 mA

_____ Insp.

_____ Date

DATA SHEET 12 (Cont.)

2.1.6 Electronic Power

Measured Value _____ Acceptable Value
+27.5 ± 0.5 Vdc

Insp. Date

2.1.7 Medium Voltage Electronics Current

Measured Value _____ Maximum Value
560 mA

Insp. Date

2.1.8 Detector Bias

Measured Value _____ Acceptable Value
+27.5 ± 0.5 Vdc

Insp. Date

2.1.9 Medium Voltage Detector Bias Current

Measured Value _____ Maximum Value
30 mA

Insp. Date

DATA SHEET 12 (Cont.)

2.1.11 Medium Voltage ADC Checkout

Reference Input Voltage	Measured Electrical Unit Output Voltage	Acceptable Electrical Output Unit Voltage
+0.025±0.001 Vdc	_____ Vdc	+0.025±0.010 Vdc
+0.050±0.001	_____	0.050±0.010
+0.100±0.001	_____	0.100±0.010
+1.000±0.001	_____	1.000±0.010
+2.000±0.001	_____	2.000±0.010
+3.000±0.001	_____	+3.000±0.010
+4.000±0.001	_____	+4.000±0.015
+4.900±0.001	_____	+4.900±0.020

Insp.

Date

DATA SHEET 12 (Cont.)

2.1.13 Medium Voltage Housekeeping Parameter Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Engineering Unit Value
+5V Monitor	A	_____ Vdc	+5.00±0.25 Vdc
+8V Monitor	A	_____	+8.10±0.15
-8V Monitor	A	_____	-8.15±0.15
+25V Monitor	A	_____	+25.50±0.75
+350V Monitor	A	_____	+350.±15.
-15V Monitor	A	_____	-15.0±1.0
-5V Monitor	A	_____	-5.25±0.25
Disc Ref Mon.	A	_____	+3.00±0.02
+5V Monitor	B	_____	+5.00±0.25
+8V Monitor	B	_____	+8.10±0.15
-8V Monitor	B	_____	-8.15±0.15
+25V Monitor	B	_____	+25.50±0.75
+350V Monitor	B	_____	+350.±15.
-15V Monitor	B	_____	-15.0±1.0
-5V Monitor	B	_____	-5.25±0.25
Disc Ref Mon.	B	_____	+3.000±0.02

Insp. _____ Date _____

2.1.14

	Actual Value	Acceptable Value
Heater	_____	+25.0 ± 0.5 Vdc
Electronics	_____	+25.0 ± 0.5 Vdc
Detector Bias	_____	+25.0 ± 0.5 Vdc

Insp. _____ Date _____

DATA SHEET 12 (Cont.)

2.1.15 Low Voltage Current Consumption

Current Sink	Measured Current	Acceptable Value
Heater	_____ mA	10 ± 5 mA
Electronics	_____	≤ 560
Detector Bias	_____	≤ 30

_____ Insp. _____ Date

2.1.16 Low Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	_____ Vdc	+5.00±0.25 Vdc
+8V Monitor	A	_____	+8.10±0.15
-8V Monitor	A	_____	-8.15±0.15
+25V Monitor	A	_____	+25.50±0.75
+350 V Monitor	A	_____	+350.±15.
-15V Monitor	A	_____	-15.0±1.0
-5V Monitor	A	_____	-5.25±0.25
Disc Ref Mon.	A	_____	+3.00±0.02
+5V Monitor	B	_____	+5.00±0.25
+8V Monitor	B	_____	+8.10±0.15
-8V Monitor	B	_____	-8.15±0.15
+25V Monitor	B	_____	+25.50±0.75
+350V Monitor	B	_____	+350.±15.
-15V Monitor	B	_____	-15.0±1.0
-5V Monitor	B	_____	-5.25±0.25
Disc Ref Mon.	B	_____	+3.00±0.02

_____ Insp. _____ Date

DATA SHEET 12 (Cont.)

2.1.17	Actual Value	Acceptable Value
Heater	_____	+30.0 ± 0.5 Vdc
Electronics	_____	+30.0 ± 0.5 Vdc
Detector Bias	_____	+30.0 ± 0.5 Vdc

Insp. Date

2.1.18 High Voltage Current Consumption

Current Sink	Actual Value	Acceptable Value
Heater	_____ mA	10 ± 5 mA
Electronics	_____	< 560
Detector Bias	_____	< 30

Insp. Date

DATA SHEET 12 (Cont.)

2.1.19 High Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	_____ Vdc	+5.00±0.25 V
+8V Monitor	A	_____	+8.10±0.15
-8V Monitor	A	_____	-8.15±0.15
+25V Monitor	A	_____	+25.50±0.75
+350V Monitor	A	_____	+350.±15.
-15V Monitor	A	_____	-15.0±1.0
-5V Monitor	A	_____	-5.25±0.25
Disc Ref Mon.	A	_____	+3.00±0.02
+5V Monitor	B	_____	+5.00±0.25
+8V Monitor	B	_____	+8.10±0.15
-8V Monitor	B	_____	-8.15±0.15
+25V Monitor	B	_____	+25.50±0.75
+350V Monitor	B	_____	+350.±15.
-15V Monitor	B	_____	-15.0±1.0
-5V Monitor	B	_____	-5.25±0.25
Disc Ref Mon.	B	_____	+3.00±0.02

_____ Insp.

_____ Date

DATA SHEET 12 (Cont.)

2.1.20 Temperature Measurement

Parameter	Prime Frame	Measured Value	Acceptable Limits
Package Temperature Monitor	A	_____ °C	50°F to 118°F = 10°C to 48°C
Package Temperature Monitor	B	_____	↓
Detector Plate Temperature Monitor	A	_____	_____
Detector Plate Temperature Monitor	B	_____	_____

Insp. Date

2.1.21 Detector Leakage Current Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	_____ μA	1.0 μA
B	_____	2.0 μA
C	_____	2.0 μA
D	_____	2.0 μA
E	_____	2.0 μA

Insp. Date

DATA SHEET 12 (Cont.)

2.1.22 Detector Resolution Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	_____ keV	50. keV
B	_____	50. keV
C	_____	50. keV
D	_____	50. keV
E	_____	50. keV

Insp. Date

2.1.25 Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	_____	14 or 16
B	E2	_____	14 or 16
C	E3	_____	14 or 16
D	E4	_____	14 or 16
E	P6	_____	14 or 16

Insp. Date

DATA SHEET 12 (Cont.)

2.1.26 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	_____	14 or 16
B	P2	_____	14 or 16
C	P3	_____	14 or 16
D	P4	_____	14 or 16
E	P5	_____	14 or 16

Insp. Date

2.1.28 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	_____	2032 or 2048
A	E2	_____	2032 or 2048
C	E3	_____	2032 or 2048
D	E4	_____	2032 or 2048
E	P6	_____	2032 or 2048

Insp. Date

DATA SHEET 12 (Cont.)

2.1.29 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	_____	2032 or 2048
B	P2	_____	2032 or 2048
C	P3	_____	2032 or 2048
D	P4	_____	2032 or 2048
E	P5	_____	2032 or 2048

Insp. Date

2.1.31 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	_____	260,096 or 262,144
B	E2	_____	260,096 or 262,144
C	E3	_____	260,096 or 262,144
D	E4	_____	260,096 or 262,144
E	P6	_____	260,096 or 262,144

Insp. Date

DATA SHEET 12 (Cont.)

2.1.32 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	_____	260,096 or 262,144
B	P2	_____	260,096 or 262,144
C	P3	_____	260,096 or 262,144
D	P4	_____	260,096 or 262,144
E	P6	_____	260,096 or 262,144

Insp. Date

2.1.34 Electron 1, Electron 2, Electron 3, Electron 4 and
Proton 6 33,554,430 pulse data accumulation test.

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	_____	33,292,288 or 0
B	E2	_____	33,292,288 or 0
C	E3	_____	33,292,288 or 0
D	E4	_____	33,292,288 or 0
E	P6	_____	33,292,288 or 0

Insp. Date

DATA SHEET 12 (Cont.)

2.1.35 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
33,554,430 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	_____	33,292,288 or 0
B	P2	_____	33,292,288 or 0
C	P3	_____	33,292,288 or 0
D	P4	_____	33,292,288 or 0
E	P5	_____	33,292,288 or 0

Insp.

Date


2.1.36 Visual inspection

Insp.


Date

DATA SHEET 12 (Cont.)


2.12.2 Install dummy plug

2/18/72 
Insp. Date


2.12.3 Test article to facility

2/18/72 
Insp. Date

2.12.4 Test article in chamber

2/18/72 
Insp. Date

2.12.5 Raise temperature and humidity

2/18/72 
Insp. Date

2.12.6 Maintain test condition for six hours

2/18/72 
Insp. Date

2.12.7 Reduce temperature

2/18/72 
Insp. Date

DATA SHEET 12 (Cont.)

2.12.8 Repeat steps 2.12.5 through 2.12.7 for 5 cycles

2/23/72  _____
Insp. Date


2.12.9 Remove test article from chamber

2/23/72  _____
Insp. Date

2.12.10 Visual inspection

2/23/72  DR# EPS 0089
Insp. Date

2.12.11 Return to Beta Building

2/23/72  _____
Insp. Date

DATA SHEET 13
FUNCTIONAL TEST

2.13 FUNCTIONAL TEST DATA SHEET

POST Humidity

2.1.4 Heater Power

Measured Value

27.53

Acceptable Value

$+27.5 \pm 0.5$ Vdc



Insp.

Date

2/23/72

2.1.5 Medium Voltage Heater Current

Measured Value

1.007

Acceptable Value

10 ± 5 mA



Insp.

Date

2/23/72

DATA SHEET 13 (Cont.)


2.1.6 Electronic Power

Measured Value

27.45

Acceptable Value

+27.5 ± 0.5 Vdc

 2/23/22
Insp. Date


2.1.7 Medium Voltage Electronics Current

Measured Value

511

Maximum Value

560 mA

 2/23/22
Insp. Date


2.1.8 Detector Bias

Measured Value

27.57

Acceptable Value

+27.5 ± 0.5 Vdc.

 2/23/22
Insp. Date


2.1.9 Medium Voltage Detector Bias Current

Measured Value

20

Maximum Value


30 mA

 2/23/22
Insp. Date

DATA SHEET 13 (Cont.)

2.1.11 Medium Voltage ADC Checkout

Reference Input Voltage	Measured Electrical Unit Output Voltage	Acceptable Electrical Output Unit Voltage
+0.025±0.001 Vdc	<u>0.024</u> Vdc	+0.025±0.010 Vdc
+0.050±0.001	<u>0.044</u>	0.050±0.010
+0.100±0.001	<u>0.097</u>	0.100±0.010
+1.000±0.001	<u>0.988</u>	1.000±0.010
+2.000±0.001	<u>1.974</u>	2.000±0.010
+3.000±0.001	<u>2.961</u>	+3.000±0.010
+4.000±0.001	<u>3.949</u>	+4.000±0.015
+4.900±0.001	<u>4.843</u>	+4.900±0.020

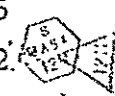
Insp.  Date 2/23/22

DR # 1795-0090

DATA SHEET 13 (Cont.)

2.1.13 Medium Voltage Housekeeping Parameter Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Engineering Unit Value
+5V Monitor	A	<u>5.063</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.057</u>	+8.10±0.15
-8V Monitor	A	<u>-8.057</u>	-8.15±0.15
+25V Monitor	A	<u>25.320</u>	+25.50±0.75
+350V Monitor	A	<u>359.195</u>	+350.±15.
-15V Monitor	A	<u>-15.944</u>	-15.0±1.0
-5V Monitor	A	<u>-5.387</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.965</u>	+3.00±0.02
+5V Monitor	B	<u>5.063</u>	+5.00±0.25
+8V Monitor	B	<u>8.057</u>	+8.10±0.15
-8V Monitor	B	<u>-8.057</u>	-8.15±0.15
+25V Monitor	B	<u>25.323</u>	+25.50±0.75
+350V Monitor	B	<u>359.195</u>	+350.±15.
-15V Monitor	B	<u>-15.921</u>	-15.0±1.0
-5V Monitor	B	<u>-5.374</u>	-5.25±0.25
Disc Ref Mon.	B	<u>2.965</u>	+3.000±0.02



DR # EPS-0090



Insp.

2.1.14

	Actual Value	Acceptable Value
Heater	<u>25.37</u>	+25.0 ± 0.5 Vdc
Electronics	<u>25.0</u>	+25.0 ± 0.5 Vdc
Detector Bias	<u>25.02</u>	+25.0 ± 0.5 Vdc



Insp.

Date

2/23/72

DATA SHEET 13 (Cont.)

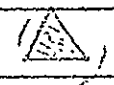
2.1.15 Low Voltage Current Consumption

Current Sink Measured Current Acceptable Value

Heater 7 mA 10 ± 5 mA

Electronics 542 ≤ 560

Detector Bias 21 ≤ 30



Insp. Date 2/23/72

2.1.16 Low Voltage Housekeeping Checkout

Parameter Prime Frame Measured Engineering Unit Output Acceptable Value

+5V Monitor A 5.053 Vdc +5.00±0.25 Vdc

+8V Monitor A 8.028 +8.10±0.15

-8V Monitor A -8.101 -8.15±0.15

+25V Monitor A 25.320 +25.50±0.75

+350 V Monitor A 357.215 +350.±15.

-15V Monitor A -15.804 -15.0±1.0

-5V Monitor A -5.342 -5.25±0.25

Disc Ref Mon. A 2.965 +3.00±0.02 

+5V Monitor B 5.063 +5.00±0.25

+8V Monitor B 8.028 +8.10±0.15


-8V Monitor B -8.101 -8.15±0.15


+25V Monitor B 25.320 +25.50±0.75

+350V Monitor B 357.215 +350.±15.

-15V Monitor B -15.804 -15.0±1.0

-5V Monitor B -5.342 -5.25±0.25

Disc Ref Mon. B 2.971 +3.00±0.02 




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DR# ERS-0090

DATA SHEET 13 (Cont.)

2.1.17	Actual Value	Acceptable Value
Heater	<u>29.97</u>	+30.0 ± 0.5 Vdc
Electronics	<u>29.96</u>	+30.0 ± 0.5 Vdc
Detector Bias	<u>30.13</u>	+30.0 ± 0.5 Vdc


Insp. Date 2/23/72

2.1.18 High Voltage Current Consumption

Current Sink	Actual Value	Acceptable Value
Heater	<u>2</u>	mA 10 ± 5 mA
Electronics	<u>493</u>	≤ 560
Detector Bias	<u>21</u>	≤ 30


Insp. Date 2/23/72

DATA SHEET 13 (Cont.)

2.1.19 High Voltage Housekeeping Checkout

Parameter	Prime Frame	Measured Engineering Unit Output	Acceptable Value
+5V Monitor	A	<u>5.072</u> Vdc	+5.00±0.25 Vdc
+8V Monitor	A	<u>8.057</u>	+8.10±0.15
-8V Monitor	A	<u>-8.150</u>	-8.15±0.15
+25V Monitor	A	<u>25.373</u>	+25.50±0.75
+350V Monitor	A	<u>357.215</u>	+350.±15.
-15V Monitor	A	<u>-15.934</u>	-15.0±1.0
-5V Monitor	A	<u>-5.326</u>	-5.25±0.25
Disc Ref Mon.	A	<u>2.971</u>	+3.00±0.02
+5V Monitor	B	<u>5.072</u>	+5.00±0.25
+8V Monitor	B	<u>8.057</u>	+8.10±0.15
-8V Monitor	B	<u>-8.134</u>	-8.15±0.15
+25V Monitor	B	<u>25.373</u>	+25.50±0.75
+350V Monitor	B	<u>357.215</u>	+350.±15.
-15V Monitor	B	<u>-15.889</u>	-15.0±1.0
-5V Monitor	B	<u>-5.326</u>	-5.25±0.25
Disc Ref Mon.	R	<u>2.971</u>	+3.00±0.02


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DATA SHEET 13 (Cont.)

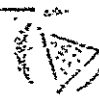
2.1.20 Temperature Measurement

Parameter	Prime Frame	Measured Value	Acceptable Limits
Package Temperature Monitor	A	<u>26.875</u> °C	50°F to 118°F = 10°C to 48°C
Package Temperature Monitor	B	<u>26.875</u>	↓
Detector Plate Temperature Monitor	A	<u>25.018</u>	_____
Detector Plate Temperature Monitor	B	<u>25.018</u>	_____


 Insp. _____ Date 2/23/72

2.1.21 Detector Leakage Current Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>.309</u> μA	1.0 μA
B	<u>.771</u>	2.0 μA
C	<u>1.968</u>	2.0 μA
D	<u>.759</u>	2.0 μA
E	<u>1.405</u>	2.0 μA


 Insp. _____ Date 2/23/72

DATA SHEET 13 (Cont.)


2.1.22 Detector Resolution Test

EPS Channel	Measured Engineering Unit Output	Maximum Acceptable Value
A	<u>1459</u> <u>8.5</u> keV	50. keV
B	<u>1102</u> <u>0</u>	50. keV
C	<u>1068</u> <u>0</u>	50. keV
D	<u>1073</u> <u>1.5</u>	50. keV
E	<u>1053</u> <u>2.5</u>	50. keV


 Insp. _____ Date 2/23/72

2.1.25 Electron 1, Electron 2, Electron 3, Electron 4, and Proton 6 . 14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>14</u>	14 or 16
B	E2	<u>16</u>	14 or 16
C	E3	<u>14</u>	14 or 16
D	E4	<u>14</u>	14 or 16
E	P6	<u>14</u>	14 or 16


 Insp. _____ Date 2/23/72

DATA SHEET 13 (Cont.)

2.1.26 Proton 1, Proton 2, Proton 3, Proton 4; and Proton 5.
14 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>14</u>	14 or 16
B	P2	<u>14</u>	14 or 16
C	P3	<u>14</u>	14 or 16
D	P4	<u>14</u>	14 or 16
E	P5	<u>14</u>	14 or 16


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2.1.28 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable
A	E1	<u>2032</u>	2032 or 2048
A	E2	<u>2032</u>	2032 or 2048
C	E3	<u>2032</u>	2032 or 2048
D	E4	<u>2032</u>	2032 or 2048
E	P6	<u>2032</u>	2032 or 2048


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DATA SHEET 13 (Cont.)


2.1.29 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
2046 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>2032</u>	2032 or 2048
B	P2	<u>2032</u>	2032 or 2048
C	P3	<u>2032</u>	2032 or 2048
D	P4	<u>2032</u>	2032 or 2048
E	P5	<u>2032</u>	2032 or 2048

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2.1.31 Electron 1, Electron 2, Electron 3, Electron 4, and
Proton 6 262,142 pulse data accumulation test


EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>260096</u>	260,096 or 262,144
B	E2	<u>260096</u>	260,096 or 262,144
C	E3	<u>260096</u>	260,096 or 262,144
D	E4	<u>260096</u>	260,096 or 262,144
E	P6	<u>260096</u>	260,096 or 262,144

 2/23/72
 Insp. Date

DATA SHEET 13 (Cont.)


2.1.32 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
262,142 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>260096</u>	260,096 or 262,144
B	P2	<u>260096</u>	260,096 or 262,144
C	P3	<u>260096</u>	260,096 or 262,144
D	P4	<u>260096</u>	260,096 or 262,144
E	P6	<u>260096</u>	260,096 or 262,144


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2.1.34 Electron 1, Electron 2, Electron 3, Electron 4 and
Proton 6 33,554,430 pulse data accumulation test.

EPS Channel	Threshold	Measured Count	Acceptable Count
A	E1	<u>33,292,288</u>	33,292,288 or 0
B	E2	<u>0</u>	33,292,288 or 0
C	E3	<u>33,292,288</u>	33,292,288 or 0
D	E4	<u>33,292,288</u>	33,292,288 or 0
E	P6	<u>33,292,288</u>	33,292,288 or 0


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2.1.35 Proton 1, Proton 2, Proton 3, Proton 4, and Proton 5
33,554,430 pulse data accumulation test

EPS Channel	Threshold	Measured Count	Acceptable Count
A	P1	<u>33,292,288</u>	33,292,288 or 0
B	P2	<u>33,292,288</u>	33,292,288 or 0
C	P3	<u>33,292,288</u>	33,292,288 or 0
D	P4	<u>33,292,288</u>	33,292,288 or 0
E	P5	<u>33,292,288</u>	33,292,288 or 0


Insp. Date 2/23/72

2.1.36 Visual inspection

Insp. Date 2/23/72

Appendix C
Thermal Test Log Sheets

EPS TEST CH. "N"

24 JAN 72

-75°
±5 0°±5

Time	Skin GP1	Cavi- ty GP2	Ch. 17	Ch. 18								
0230	75.1	70.7	71.6	74.8								
Fixed Timer on Computer												
0253	73.7	71.5	71.8	74.4								
0300	73.0	71.6	71.8	74.2								
0315	76.0	71.6	71.9	74.6								
0330	75.8	71.4	71.7	74.0								
0345	77.0	71.5	71.7	74.2								
0400	73.2	71.6	71.8	74.0								
0415	74.3	71.7	71.6	73.6	Going cold wall							
0430	52.3	22.7	-156.0	74.3								
0445	56.9	8.8	-187.3	74.2								
0450	51.2	0.0	-199.7	74.2								
0515	41.7	0.0	-207.3	74.4								
0530	38.9	-0.1	-212.0	74.4								
0545	29.5	1.0	-215.7	74.0								
0600	27.8	-1.1	-218.3	73.6								
0615	22.7	-2.0	-221.1	74.0								
0630	15.8	1.7	-223.3	74.1								
0647	16.7	- .6	-225.3	74.2	Bymo ³ Ch. 7 - Bad data							
0700	-15.7	-2.8	-226.8	74.6								
0715	-20.1	-2.2	-227.9	74.6								
0730	-25.3	-1.6	-229.6	74.7								
0745	-29.8	-0.6	-230.7	74.9								
0800	-33.5	-1.4	-231.7	74.4								
0815	-37.5	-2.6	-232.7	74.8								
0830	-41.2	-4.2	-233.3	74.6								
0845	-44.6	-1.9	-234.3	74.7								
0900	-47.6	+3.3	-235.2	74.4								
0915	-50.9	+1.7	-235.7	74.3								
0930	-53.6	+1.0	-236.4	74.3								
0945	-56.3	+ .5	-237.1	73.9								
1000	-59.0	+ .3	-237.7	74.0								
1015	-61.6	-1.1	-238.4	73.6								
1030	-63.8	-1.7	-238.9	73.0								
1045	-66.0	-1.5	-239.5	72.7								
1100	-68.0	-1.9	-240.4	72.6								
1115	-70.1	-2.5	-240.6	73.4								

EPS TEST CH. "N"

24 JAN 72

-75°
±5 U±5

Time	Skin SP1	Cavi- ty GP2	Ch. 17	Ch. 18									
1130	-72.2	-3.2	-241.1	73.2									
1145	-74.1	-4.1	-241.8	74.1									
1200	-75.8	-4.7	-242.1	74.3									
1215	-77.2	-2.4	-242.2	74.4									
1230	-78.1	-1.6	-242.1	74.4									
1245	-78.7	-1.4	-241.9	74.8									
1300	-78.4	-1.3	-241.8	74.8									
1315	-77.9	-1.2	-241.1	74.9									
1330	-77.3	- .5	-240.4	74.8									
1345	-76.1	-1.3	-240.3	74.3									
1400	-75.9	-1.1	-240.0	74.6									
1415	-75.1	- .9	-239.7	74.9									
1430	-74.5	- .7	-239.7	74.7									
1445	-73.8	- .5	-239.4	74.1									
1500	-73.2	-0.4	-239.2	74.6									
1515	-72.7	-0.2	-238.9	74.4									
1530	-72.1	0.0	-238.9	74.8									
1545	-71.5	-0.03	-238.7	74.5									
1600	-70.8	+0.6	-238.6	74.4									
1615	-70.2	+0.9	-238.5	74.2									
1630	-69.9	1.2	-238.3	74.4									
1645	-70.1	1.4	-238.6	74.3									
1700	-70.7	1.6	-238.9	74.3									
1715	-71.2	1.8	-239.1	74.7									
1730	-71.9	1.8	-239.5	74.3									
1745	-72.5	1.6	-239.6	74.1									
1800	-73.1	1.4	-239.7	74.3	Start	Cash	2						
1815	-73.7	1.2	-239.9	74.2									
1830	-74.2	1.0	-239.9	74.2									
1845	-74.8	0.8	-240.0	74.5									
1900	-75.3	0.4	-240.0	74.7									
1915	-75.6	0.8	-240.2	75.0									
1930	-75.9	0.5	-240.2	74.6									
1945	-76.0	0.3	-240.2	74.8									
2000	-75.9	0.3	-240.0	74.7									
2015	-75.8	0.3	-239.8	74.4									
2030	-75.6	0.3	-239.7	74.5									

EPS TEST CHAMBER "N"

75°
±5 0°±5

Time	Skin GP1	Cavi- ty GP2	Ch. 17	Ch. 18
2045	-75.5	0.3	-239.6	74.4
2100	-75.5	0.4	-239.6	74.5
2115	-75.5	0.4	-239.6	74.5
2130	-75.6	0.2	-239.6	74.6
2145	-75.7	0.2	-239.5	74.3
2200	-75.5	0.2	-239.6	74.6
2215	-75.5	0.1	-239.6	74.2
2230	-75.4	0.1	-239.5	74.3
2245	-75.3	0.1	-239.5	74.6
2300	-75.1	0.1	-239.3	74.5
2315	-75.1	0.1	-239.0	74.8
2330	-75.1	0.1	-239.3	74.9
2345	-75.0	0.1	-239.1	74.8
2400	-75.0	0.2	-239.1	75.1
0015	-75.0	0.3	-239.2	74.7
0030	-74.9	0.3	-239.1	74.7
0045	-74.9	0.2	-239.1	73.9
0100	-74.9	0.3	-239.1	74.6
0116	-74.8	0.4	-239.0	74.9
0130	-74.8	0.6	-238.9	75.0
0145	-74.8	0.6	-238.9	74.9
0200	-74.9	0.7	-238.9	74.9
0215	-74.8	0.7	-238.9	75.1
0230	-74.8	0.7	-238.9	75.4
0245	-74.8	0.7	-238.9	75.4
0300	-74.9	0.7	-238.9	75.6
0315	-74.8	1.1	-239.1	75.4
0330	-74.9	0.6	-238.9	75.7
0345	-74.9	-1.1	-238.9	75.6
0400	-75.0	-0.4	-239.1	75.7
0415	-75.1	-0.2	-239.0	75.8
0430	-75.0	-0.1	-238.9	75.8
0445	-75.1	-0.1	-239.1	75.7
0500	-75.0	-0.4	-239.2	75.6
0515	-75.1	-0.5	-239.2	75.4
0530	-75.2	-0.4	-238.9	75.5
0545	-75.1	-0.4	-239.3	75.1

EPS TEST CHAMBER "N"

25 JAN 72

-75°
±5 0°±5

Time	Skin GP1	Cavity GP2	Ch. 17	Ch. 18
0600	-75.2	-0.5	-239.1	75.1
0615	-75.2	-0.6	-239.0	75.1
0630	-75.3	-0.6	-239.1	75.3
0645	-75.3	0.3	-239.1	75.6
0700	-75.3	0.6	-239.1	75.6
0715	-75.3	0.4	-239.1	75.6
0730	-75.4	0.4	-239.1	75.6
0745	-75.5	0.2	-239.1	75.8
Lost Power to Bldg. @ 0756				
0830	-79.1	-22.9	-244.3	76.3
0845	-79.6	-3.8	-242.7	76.8
0900	-79.4	-0.5	-240.8	76.3
0915	Starting Case 3			
	-23°	±75°		
	±5	±5		
0915	-79.0	-19.5	-239.6	76.2
0934	-79.9	+61.2	-230.6	75.7
0945	-61.5	+69.5	-224.8	75.8
1000	-42.7	+61.6	-213.2	75.7
1015	-39.4	+63.4	-207.5	75.8
1030	-26.7	72.7	-211.2	75.4
1045	-26.0	66.3	-214.9	75.4
1100	-26.0	74.0	-216.5	75.8
1115	-26.4	73.0	-217.4	75.7
1130	27.0	74.9	-218.2	75.3
1145	27.6	74.4	-218.7	76.0
1200	27.7	75.6	-218.9	75.8
1215	27.5	75.7	-218.7	75.7
1230	27.1	73.3	-218.9	75.7
1245	26.5	77.6	-218.3	75.6
1300	25.4	73.7	-217.8	75.8
1315	23.6	75.7	-217.1	66.0
1330	21.8	77.0	-216.0	75.8
1345	-19.0	77.6	-215.2	76.1
1400	-18.0	77.7	-214.4	75.8
1415	-17.5	74.9	-214.9	75.7
1430	-18.8	74.3	-216.3	75.0

EPS TEST CIRCUIT "N"

5 JAN 72

Time	Skin CP1	Cavity CP2	Ca. 17	Ch. 18									
1445	-29.6	73.7	-217.7	75.8									
1500	-31.4	73.4	-218.2	75.4									
1515	-22.0	73.3	-218.2	75.4									
1530	-22.5	72.7	-218.3	75.4									
1545	-23.0	75.6	-218.4	75.2									
1600	-23.4	75.6	-218.6	74.7									
1615	-23.5	74.9	-218.3	74.7									
1630	-23.5	75.9	-218.2	74.7									
1645	-23.2	74.5	-217.9	74.8									
1700	-22.9	74.6	-217.7	74.2									
1715	-22.6	74.3	-217.7	74.1									
1730	-22.4	74.3	-217.6	73.8									
1745	-22.4	74.5	-217.7	74.0									
1800	-22.4	74.3	-217.6	73.7	Going to Test Case 4								
1815	-19.6	73.9	-216.5	74.1									
1830	- 5.3	75	-206.9	73.7									
1845	-29.7	74.5	-178.1	73.7									
1900	59.5	77.4	-159.2	73.5									
1915	29.4	79.1	-147.9	73.1									
1930	115.4	74.4	-138.3	73.2									
1945	136.7	77.9	-130.6	73.1									
2000	154.8	79.2	-126.3	73.7									
2015	169.8	77.1	-121.3	73.5									
2030	186.2	79.1	-115.8	73.9									
2045	202.5	78.6	-107.3	73.6									
2100	218.6	78.8	-100.2	73.1									
2115	231.3	78.2	- 98.2	73.4									
2130	241.4	77.9	- 95.5	73.3									
2145	244.6	78.0	- 98.1	73.1									
2200	246.4	77.9	- 99.3	73.6	Test Case 4 in spec								
2215	248.0	77.5	- 99.5	74.2									
2230	249.2	77.2	- 99.3	74.2									
2245	250.0	76.7	- 99.3	74.1									
2300	250.2	76.3	- 99.9	74.2									
2315	250.1	76.1	-100.4	73.8									
2330	250.1	76.1	-100.7	73.6									
2345	259.3	76.0	-100.5	73.3									

EDS TEST CHAMBER "N"

26 JAN 72

250°
15 75°±5

Time	Skin CPI	Cavi- ty GP2	Ch. 17	Ch. 18								
0000	250.2	75.6	-100.8	78.4								
0015	250.2	75.5	-101.0	78.8								
0030	250.6	75.6	-101.1	74.1								
0105	250.0	75.8	-101.1	73.8	Computer	off line						
0115	250.2	76.0	-101.1	73.6								
0138	250.2	75.8	-101.7	73.7	Typewriter	hung up						
0152	249.9	75.6	-101.9	73.7								
0200	249.9	75.6	-101.7	73.4								
0215	250.2	75.7	-101.9	73.2								
0230	250.5	75.8	-101.1	73.6								
0245	250.2	75.8	-101.9	73.5								
0300	249.9	75.7	-101.8	73.5								
0315	249.7	75.7	-101.9	73.3								
0330	249.7	75.6	-101.7	73.0								
0345	249.9	75.7	-101.6	72.7	Typewriter	hanging up						
0465	250.1	75.9	-101.6	75.9								
0430	250.2	76.0	-101.7	73.3								
0444	249.9	75.9	-101.9	73.5								
0519	249.2	75.6	-102.0	73.8								
0530	249.0	75.4	-102.9	73.3								
0545	249.1	75.3	-102.2	73.1								
0600	249.2	75.3	-102.6	73.1								
0630	249.5	75.6	-102.0	73.2								
0645	249.5	75.7	-101.9	73.6								
0700	249.6	75.7	-101.9	73.1								
0715	249.7	75.7	-102.0	73.6								
0730	249.8	75.7	-102.0	73.1								
0745	249.9	75.8	-102.2	73.6	9740	Test over.	Testing	back on Variac				
0800	246.0	75.8	-97.6	73.4								
0815	241.7	75.6	-67.6	73.8								
0830	239.7	75.8	-22.6	73.9								
0845	236.4	75.9	+7.6	74.0								
0900	228.7	75.4	44.6	74.0								
0915	210.6	75.2	61.2	74.4								
0930	194.1	75.2	70.4	74.3								
0945	180.0	75.5	74.8	74.1								
1000	167.8	75.0	77.0	74.1								

Appendix D
EMI Test Report

SKYLAB ELECTRON/PROTON SPECTROMETER
(P/N SEC 39106425-301)

ELECTROMAGNETIC INTERFERENCE AND
SUSCEPTIBILITY QUALIFICATION

TEST REPORT

MSC/TCSD DOCUMENT EMC-R-EB8-003

7 FEBRUARY 1972

PREPARED BY
LOCKHEED ELECTRONICS COMPANY
FOR
TELEMETRY AND COMMUNICATIONS SYSTEMS DIVISION

Approved By:

Project Engineer *S. Villarsal*
Section *[Signature]*
Branch *E. L. Chicoine*

NASA MANNED SPACECRAFT CENTER
TELEMETRY AND COMMUNICATIONS SYSTEMS DIVISION
HOUSTON, TEXAS

ABSTRACT

Electromagnetic Interference and Susceptibility Qualification Testing of the Skylab Electron/Proton Spectrometer, Part Number SEC 39106425-301, Serial Number 1001, was completed on 2 February 1972. The tests were performed in accordance with NR Specification MH04-02057-234 and Interface Revision Notice (IRN) 9395 delineated in MSC/TCSO Document EMC-P-EB8-003.

The test data indicates that the Spectrometer meets all requirements of MH04-02057-234 and IRN 9395.

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SKYLAB ELECTRON/PROTON SPECTROMETER
(P/N SEC 39106425-301)
ELECTROMAGNETIC INTERFERENCE AND
SUSCEPTIBILITY QUALIFICATION
TEST REPORT
MSC/TCSD DOCUMENT EMC-R-EB8-003

1.0 GENERAL

This document reports the results of Electromagnetic Interference and Susceptibility Qualification Tests performed on the Skylab Electron/Proton Spectrometer, Serial Number 1001. Testing was begun on 31 January, 1972 and completed on 2 February, 1972. Tests were performed in the MSC Building 14 Electromagnetic Interference Test Laboratory under the direction of the Electromagnetic Systems Branch of the Telemetry and Communications Systems Division. The tests were performed in accordance with the requirements of NR Specification MH04-02057-234 and Interface Revision Notice 9395 as delineated in MSC/TCSD Document EMC-P-EB8-003.

2.0 TEST EQUIPMENT

A list of the test equipment used in the performance of these tests is contained in Appendix A. Receiver noise level data for each RIFI meter used in these tests are presented in Appendix C.

3.0 TEST PROCEDURE DEVIATIONS

One deviation to the procedures of EMC-P-EB8-003 (Appendix D) was required in the performance of this test. Skylab telemetry transmitters operating in the frequency range 230 to 250 MHz generate fields in excess of the 1V/M radiated susceptibility field required by NR Specification MH04-02057-234 and IRN9395 in this frequency range. In order to insure the compatibility of the Spectrometer with these transmitters, the test signal amplitude was increased to 7V/M. An approved Test Procedure Deviation Sheet is contained in Appendix D.

4.0 TEST RESULTS

A photograph of the test setup is shown in Figure 1. The duct work shown in the photograph is a part of the cooling scheme contrived to divert cool air from the shielded enclosure air conditioning system directly to the Spectrometer to prevent over heating. The test cables shown protruding from the top of the spectrometer were used during pre and post-test checkout of the spectrometer and were removed during Electromagnetic Interference and Susceptibility Testing. Completed data sheets are contained in Appendix B. The test results are summarized in Table I. Power supply impedance data is contained in Appendix E.

5.0 EMC EVALUATION OF THE SPECTROMETER

The test data indicates that the Electron/Proton Spectrometer met all requirements of NR Specification MH04-02057-234 and IRN 9395.

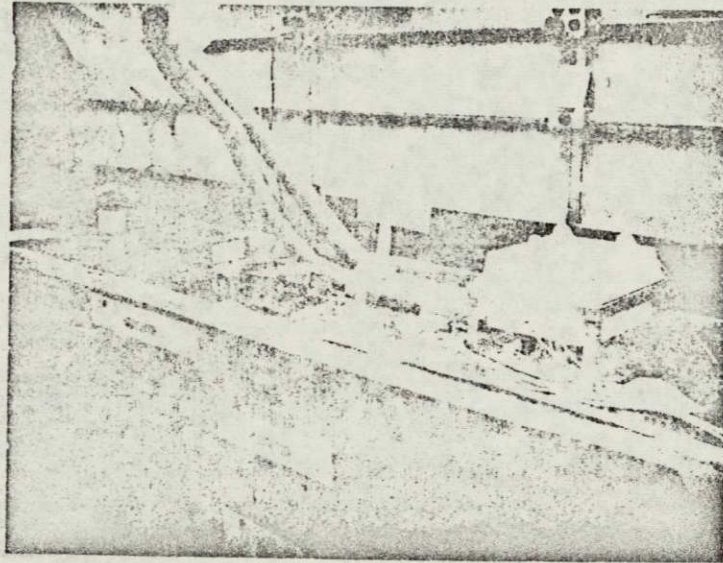



Figure 1, Basic Test Setup

APPENDIX A
TEST EQUIPMENT LIST

Component <i>Electron/Photon Spectrometer</i>	DOCUMENT NO. <i>E128-402</i>
NASA Type No. <i>SEC 39106425-301</i>	Tested By <i>Dolson/Fournet</i>
NASA Serial No. <i>1001</i>	Date Tested <i>131-7A thru 2-02-72</i>
Test Run Time	Inspection Stamp 

TEST EQUIPMENT LIST

NOMENCLATURE	MANUFACTURER AND MODEL	IDENTIFICATION NUMBER	CALIBRATION DUE DATE
REFE Meter	Stoddart NM-40A	33010	3-11-72
REFE Meter	Empire NF-105	31484	2-23-72
REFE METER	Stoddart NM-62B	49127	2-17-72
Oscilloscope	Tektronix 591A	63743	8-30-72
Plug In	Tektronix Type 82	64549	8-30-72
REFE Meter	Stoddart NM-30A	62380	2-03-72
Audio Oscillator	Hewlett Packard 200D	59729	4-28-72
Signal Gen	Hewlett Packard 606A	35505	6-1A-72
Sig. Gen.	HP-608D	31195	5-08-72
Sig. Gen.	HP-612A	35506	4-1-72
Sig. Gen.	HP-614A	30519	5-15-72
Sig. Gen.	HP-616B	35507	5-15-72
Sig. Gen.	HP-618B	30521	5-15-72
Sig. Gen.	HP-620A	30522	5-15-72
Transient Gen	Solar 6471-1	61254	N/A
Oscilloscope	Tektronix Type 321	30949	8-11-72
VTVM	Hewlett Packard 416B	001709	5-26-72
Power Meter	HP-431B	54604	2-29-72
Dc Power Supply	HP 6226A	52869	N/A
Directional Coupler	NARDA 3020A	87913	10-22-72
" "	NARDA 3042B-20	75235	4-02-72
" "	NARDA 3003-20	P26842	6-19-72
" "	NARDA 3004-30	P20688	6-19-72
EPS Test Set	NASA SEC 39106424	N/A	N/A
Biconical Ant.(2)	Honeywell 7825	87084, 84602	N/A
Spiral Ant.	Stoddart 93490-1	84601	N/A
Spiral Ant.	" "	87085	N/A
Spiral Ant.	" "	84600	N/A
Spiral Ant	Singer 93491-2	87086	N/A
Audio Amplifier	McIntosh 200AB	45908	N/A
Current Probe	Stoddart 91550-1	N/A	N/A

Component <i>Electron/Proton Spectrometer</i>	Document No. <i>ERS-003</i>	Rev.
NASA Type No. <i>SEC 2900 6925-301</i>	Tested By <i>Dolson/Fawcett</i>	
NASA Serial No. <i>1001</i>	Date Tested <i>1-31-72</i> 1-31-72 <i>2-02-72</i>	
Test Run Time	Inspection Stamp <i>1-31-72</i>	

TEST EQUIPMENT LIST

NOMENCLATURE	MANUFACTURER AND MODEL	IDENTIFICATION NUMBER	CALIBRATION DUE DATE
<i>Amplifier, RF</i>	<i>AEI wideband</i>	<i>70119</i>	<i>N/A</i>
<i>Amplifier, RF</i>	<i>FAM Engineering Q100M</i>	<i>72303</i>	<i>N/A</i>
<i>Amplifier, RF</i>	<i>FAM Engineering P100M</i>	<i>72300</i>	<i>N/A</i>
<i>Amplifier, RF</i>	<i>FAM Engineering L100M</i>	<i>72299</i>	<i>N/A</i>
<i>Amplifier, RF</i>	<i>FAM Engineering S-100M</i>	<i>72302</i>	<i>N/A</i>
<i>Amplifier, RF</i>	<i>FAM Engineering C100M</i>	<i>72298</i>	<i>N/A</i>
<i>Amplifier, RF</i>	<i>FAM Engineering X100M</i>	<i>72301</i>	<i>N/A</i>

APPENDIX B
TEST DATA SHEETS

COMPONENT: <u>Electron/Proton Spectrometer</u>	DOCUMENT NO: <u>EBR-003</u>	REV:
NASA TYPE NO: <u>SEC 39106425-501</u>	TESTED BY: <u>Dolson/Fournet</u>	
NASA SERIAL NO.: <u>1001</u>	DATE TESTED: <u>1-31-72</u>	
TEST RUN TIME:	INSPECTION STAMP:	

TYPE OF TEST: Conducted Interference

RIF: METER: MODEL NIA 40A PICKUP DEVICE: TYPE Current Probe
S/N 33010 MODEL 91550-1
DETECTOR Carrier S/N N/A

TEST SAMPLE LINE VOLTAGE: 28VDC LEAD TESTED: +28VDC

FREQ	METER READIN, <u>dBµV</u>		CORRECTION FACTORS dB					INTERFERENCE LEVELS <u>dBµA</u>			REMARKS
	SI.	AMB	INPUT ATTEN	EXT NET LOSS	MTR CAL	BW	PICKUP DEVICE	TOTAL	SPEC	AMBIENT	
<u>0.030</u>	<u>22</u>	<u>RVR</u>	<u>20</u>	<u>0</u>	<u>-20</u>	<u>N/A</u>	<u>37</u>	<u>59</u>	<u>N/A</u>	<u>RVR</u>	<u>NOISE</u>
<u>0.060</u>	<u>24</u>	<u>NOISE</u>	<u>0</u>				<u>31</u>	<u>35</u>			
<u>0.180</u>	<u>30</u>		<u>20</u>				<u>22</u>	<u>52</u>			
<u>0.330</u>	<u>25</u>		<u>20</u>				<u>16</u>	<u>41</u>			
<u>0.760</u>	<u>35</u>		<u>20</u>				<u>10</u>	<u>45</u>			
<u>0.900</u>	<u>36</u>		<u>20</u>				<u>8</u>	<u>44</u>			
<u>1.2</u>	<u>20</u>		<u>40</u>				<u>5</u>	<u>45</u>			
<u>1.42</u>	<u>18</u>		<u>40</u>				<u>4</u>	<u>42</u>			
<u>1.6</u>	<u>18</u>		<u>40</u>				<u>3</u>	<u>41</u>			
<u>1.95</u>	<u>23</u>		<u>40</u>				<u>1</u>	<u>44</u>			
<u>2.2</u>	<u>22</u>		<u>40</u>				<u>0</u>	<u>42</u>			
<u>3.1</u>	<u>20</u>		<u>20</u>				<u>-3</u>	<u>17</u>			
<u>4.2</u>	<u>38</u>		<u>20</u>				<u>-5</u>	<u>33</u>			
<u>4.4</u>	<u>34</u>		<u>40</u>				<u>-6</u>	<u>48</u>			
<u>5.4</u>	<u>20</u>		<u>20</u>				<u>-8</u>	<u>12</u>			
<u>7.0</u>	<u>20</u>		<u>20</u>				<u>-10</u>	<u>10</u>			
<u>8.8</u>	<u>22</u>		<u>20</u>				<u>-12</u>	<u>10</u>			
<u>11.2</u>	<u>30</u>		<u>0</u>				<u>-14</u>	<u>-4</u>			
<u>13.2</u>	<u>20</u>		<u>20</u>				<u>-15</u>	<u>5</u>			
<u>13.8</u>	<u>19</u>		<u>20</u>				<u>-16</u>	<u>3</u>			
<u>15.2</u>	<u>28</u>		<u>0</u>				<u>-17</u>	<u>-9</u>			

COMPONENT: Electron/Proton Spectrometer DOCUMENT NO: EB8-003 REV: .

NASA TYPE NO: SEC 39106 425-301 TESTED BY: Dolson/Faurst

NASA SERIAL NO.: 1001 DATE TESTED: 1-31-72

TEST RUN TIME: INSPECTION STAMP:

TYPE OF TEST: Conducted Interference

RFLI METER: MODEL NF-105 PICKUP DEVICE: TYPE Current Probe
 S/N 31484 MODEL 91550-1
 DETECTOR Carrier S/N N/A

TEST SAMPLE LINE VOLTAGE: 28VDC LEAD TESTED: +28VDC

FREQ MHz	METER READING dBu		CORRECTION FACTORS dB					INTERFERENCE LEVELS dBuA			REMARKS
	SIG	AMB	INPUT ATTEN	EXT NET LOSS	MTR CAL	BW	PICKUP DEVICE	SIGNAL	SPEC	AMBIENT	
.014	NO MEAS SIG	REVR NOISE	0	0	N/A	N/A	15	NO MEAS SIG	114	REVR NOISE	
.025	7		0				11	13	106		
.033	14						8	22	98		
.050	11						4	15	84		
.060	10						2	12	80		
.080	12						-1	11	78		
.095	7						-2	5	72		
.105	10						-3	7	70		
.120	16						-3	13	69		
.150	20		-20				-6	-6	64		
.200	13		0				-8	5	58		
.400	2						-12	-10	44		
	NO MEAS SIG							NO MEAS SIG			
25											

COMPONENT: <u>Electron/Proton Spectrometer</u>	DOCUMENT NO: <u>EPR-003</u>	REV:
NASA TYPE NO: <u>SEC 39106425-301</u>	TESTED BY: <u>Dolson/Fournet</u>	
NASA SERIAL NO.: <u>1001</u>	DATE TESTED: <u>1-31-72</u>	
TEST RUN TIME:	INSPECTION STAMP:	

TYPE OF TEST: Conducted Interference

RIFI METER: MODEL NM40A PICKUP DEVICE: TYPE Current Probe
 S/N 33010 MODEL 91550-1
 DETECTOR Carrier S/N N/A

TEST SAMPLE LINE VOLTAGE: 28VDC LEAD TESTED: 28V Return

FREQ KHz	METER READING dB μ V		CORRECTION FACTOR dB					INTERFERENCE LEVELS dB μ A			REMARKS
	SI	AMB	INPUT ATTEN	EXT NET LOSS	MTR CAL	BW	PICKUP DEVICE	FINAL	SPEC	AMBIENT	
100	23	Revr Noise	20	0	-20	N/A	37	60	N/A	Revr Noise	
100	25		0		-20		31	56			
150	20		0				22	22			
130	32		0				16	28			
130	16		40				16	60			
170	32		20				10	42			
190	35		20				8	45			
112	22		40				5	47			
142	22		40				4	46			
116	20		40				3	43			
195	24		40				1	45			
22	22		40				0	42			
31	24		20				-3	21			
42	40		20				-5	35			
44	35		40				-6	49			
54	29		20				-8	21			
90	21		20				-10	11			
88	28		20				-12	16			
112	17		20				-14	3			
132	24		20				-15	9			
138	25		20				-16	9			
152	28	Y	0	Y	Y	Y	-17	-9	Y	Y	

COMPONENT: Electron/Proton Spectrometer DOCUMENT NO: ERS-003 REV:

NASA TYPE NO: SEC-39106425-301 TESTED BY: Dolson/Fournet

NASA SERIAL NO.: 1001 DATE TESTED: 1-31-72

TEST RUN TIME: INSPECTION STAMP: 

TYPE OF TEST: Conducted Interference

RIFI METER: MODEL NF-105 PICKUP DEVICE: TYPE Current Probe
 S/N 31484 MODEL 91550-1
 DETECTOR Carrier S/N N/A

TEST SAMPLE LINE VOLTAGE: 29VDC LEAD TESTED: 28VDC Ret.

FREQ	METER READING <i>dB-μV</i>		CORRECTION FACTORS dB				INTERFERENCE LEVELS <i>dB-μA</i>			REMARKS	
	SIG	AMB	INPUT ATTN.	EXT NET LOSS	MTR CAL	BW	PICKUP DEVICE	SIGNAL	SPEC		AMBIENT
<i>MHz</i>											
.014	<i>NO MEAS SIG</i>	<i>REUR noise</i>	0	0	<i>N/A</i>	<i>HIGH</i>		<i>NO MEAS SIG</i>		<i>REUR noise</i>	
↓	↓							↓			
.023	17						11	28	106		
.033	13						8	21	98		
.050	2		↓				4	6	84		
.060	20		-20				2	2	80		
.080	10		0				-1	9	78		
.095	20		-20				-2	-2	72		
.105	6		0				-3	3	70		
.120	14		0				-3	11	69		
.150	15		-20				-6	-11	64		
.200	3		0				-8	-5	58		
↓	<i>NO MEAS SIG</i>							<i>NO MEAS SIG</i>			
↓	↓							↓			
25	↓	↓	↓	↓	↓	↓	↓	↓		↓	

COMPONENT: Electron/Proton Spectrometer | DOCUMENT NO: EB8-003 | REV: _____

NASA TYPE NO: SFC 39106925-301 | TESTED BY: Dolson/Fournet
 NAS: SERIAL NO.: 1001 | DATE TESTED: 1-31-72
 TEST RUN TIME: _____ | INSPECTION STAMP: _____

TYPE OF TEST: Conducted Interference

RF METER: MODEL NF-105 | PICKUP DEVICE: TYPE Current Probe
 S/N 31484 | MODEL 91550-1
 DETECTOR Peak | S/N N/A

TEST SAMPLE LINE VOLTAGE: 28VDC | LEAD TESTED: +28VDC

FREQ MHz	METER READING dBμV/MHz		CORRECTION FACTORS dB					INTERFERENCE LEVELS dBμA/MHz			REMARKS
	SIG	AMB	INPUT ATTEN	EXT NET LOSS	MTR CAL	BW	PICKUP DEVICE	SIGNAL	SPEC	AMBIENT	
.014	90	Reur Noise	N/A	0	N/A	N/A	15	105	136	Reur Noise	
.020	69						12	81	130		
.024	70						10	80	126		
.030	71						9	80	122		
.040	72						6	78	118		
.06	58						1	59	108		
		NO MEAS SIG									
.160	63						-6	57	92		
.240	60						-9	51	84		
.320	56						-10	46	78		
.355	55						-11	44	76		
.600	43						-13	30	66		
.800	63						-14	49	62		
1.0	42						-14	28	58		
		NO MEAS SIG									
25	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	


COMPONENT: <u>Electron/Proton Spectrometer</u>	DOCUMENT NO: <u>ER8-003</u>	REV:
NASA TYPE NO: <u>SEC-39106425-301</u>	TESTED BY: <u>Dolson/Fournet</u>	
NASA SERIAL NO.: <u>1001</u>	DATE TESTED: <u>1-31-72</u>	
TEST RUN TIME:	INSPECTION STAMP:	

TYPE OF TEST: Conducted Interference

RIFI METER: MODEL NE-105 PICKUP DEVICE: TYPE Current Probe
 S/N 31484 MODEL 91550-1
 DETECTOR Peak S/N N/A

TEST SAMPLE LINE VOLTAGE: 28VDC LEAD TESTED: 28V Ret.

FREQ MHz	METER READING dBµV/MHz		CORRECTION FACTORS dB					INTERFERENCE LEVELS dBµV/MHz			REMARKS
	SIG	AMB	INPUT ATTEN	EXT NET LOSS	MTR CAL	BW	PICKUP DEVICE	SIGNAL	SPEC	AMBIENT	
0.02	92	RUR NOISE	N/A	0	N/A	N/A	15	107	136	RUR NOISE	
0.024	67						12	79	130		
0.028	65						10	75	126		
0.030	65						9	74	122		
0.036	62						6	68	118		
0.045	55						1	56	108		
0.054	NO SIG							NO SIG			
0.063	59							59			
0.072	61						-6	55	92		
0.081	55						-9	46	84		
0.090	50						-10	40	78		
0.108	45						-11	34	76		
0.126	40						-13	27	66		
0.150	53						-14	39	62		
0.180	37						-14	23	58		
0.216	NO SIG							NO SIG			
0.252	59							59			
0.300											
0.360											
0.432											
0.516											
0.615											
0.738											
0.885											
1.062											
1.274											
1.528											
1.833											
2.199											
2.637											
3.164											
3.796											
4.554											
5.464											
6.556											
7.867											
9.440											
11.328											
13.653											
16.583											
20.100											
24.324											
29.388											
35.500											
42.876											
51.852											
62.832											
75.504											
90.000											
108.000											
130.000											
157.000											
189.000											
227.000											
272.000											
325.000											
387.000											
459.000											
543.000											
641.000											
756.000											
891.000											
1050.000											
1236.000											
1452.000											
1701.000											
2000.000											
2360.000											
2790.000											
3300.000											
3890.000											
4570.000											
5350.000											
6250.000											
7280.000											
8460.000											
9810.000											
11350.000											
13100.000											
15080.000											
17310.000											
19810.000											
22600.000											
25700.000											
29100.000											
32900.000											
37100.000											
41700.000											
46800.000											
52400.000											
58600.000											
65400.000											
72800.000											
80900.000											
89700.000											
99300.000											
110000.000											

KIPPron X-ray Spectrometer		Document No. <u>FB8-003</u>	Rev.
NASA Type No. <u>SEC-39106425-301</u>	Tested By <u>Dalton Leurnet</u>		
NASA Serial No. <u>1001</u>	Date Tested <u>2-02-72</u>		
Test Run Time	Inspection Stamp 		

Type of Test: Conducted Susceptibility - Audio

SIGNAL GEN: Model HP-200 C.D INJECTION DEVICE: Type Isolation Transformer
 S/N 38729 Model 6220-1

Modulation N/A S/N N/A
 TEST SAMPLE LINE VOLTAGE: 78VDC LEAD TESTED: 729426

FREQ. MHz	INJECTED TEST SIGNAL		REMARKS	ENGINEERING INFORMATION	
	MEASURED LEVEL (1)	SPECIFICATION REQUIRED LEVEL (2)		INJECTED SIGNAL LEVEL	TEST SAMPLE RESPONSE
30	<u>NO susceptibility</u>	<u>1V P.P</u>	<u>Electron 4 Data output fluctuated intermittently throughout this test. This was not due to Test Signal. REF. DRB EPS-0072</u>	<u>1V P.P</u>	<u>NO suscept.</u>
15K		<u>Logarithmic Decat From 1V P.P. to .1V RMS</u>			
50K		<u>.1V RMS</u>			

Component <u>Electron/Proton Spectrometer</u>	Document No. <u>EB8-003</u>	Rev.
NASA Type No. <u>SEC 3910425-301</u>	Tested By <u>Dolson/Evans</u>	
NASA Serial No. <u>1001</u>	Date Tested <u>2-02-72</u>	
Test Run Time	Inspection Stamp	

Type of Test: Conducted Susceptibility - Transient

SIGNAL GEN: Model Solar 6471-1 INJECTION DEVICE: Type N/A
 S/N 61254 Model N/A

Modulation N/A S/N N/A
 TEST SAMPLE LINE VOLTAGE: 28VDC LEAD TESTED: Parallel Injection

FREQ. KPS	INJECTED TEST SIGNAL		REMARKS	ENGINEERING INFORMATION	
	MEASURED LEVEL (1)	SPECIFICATION REQUIRED LEVEL (2)		INJECTED SIGNAL LEVEL	TEST SAMPLE RESPONSE
11	<u>no susceptibility</u>	<u>+50</u>	<u>Power leads</u>	<u>+50</u>	<u>no susceptibility</u>
10	↓	<u>+0.5</u>	<u>Power gnd to Chassis</u>	<u>+0.5</u>	↓
10	↓	<u>-0.5</u>	↓	<u>-0.5</u>	↓
10	↓	<u>+0.5</u>	<u>sig Gnd to Chassis</u>	<u>+0.5</u>	↓
10	↓	<u>-0.5</u>	↓	<u>-0.5</u>	↓
			<u>Electron A Data</u>		
			<u>Output Fluctuated</u>		
			<u>Throughout this</u>		
			<u>TEST - Not due</u>		
			<u>to Test Signal -</u>		
			<u>Res - DR# EPS-0072</u>		

Component <u>Electron/Proton Spectrometer</u>	Document No. <u>EPS-003</u>	Rev.
NASA Type No. <u>SEC-39106A25-301</u>	Tested By <u>Dalson/Fournet</u>	
NASA Serial No. <u>1001</u>	Date Tested <u>2-01-72</u>	
Test Run Time	Inspection Stamp	

Type of Test: Radiated Susceptibility

SIGNAL GEN: Model HP 606, 608, 612, 614, 616, 618, 620 INJECTION DEVICE: Type Broadband Antennas

S/N see Equipment List Model see Equipment List

Modulation 30% AM 400Hz, 100% AM 1000Hz S/N N/A

TEST SAMPLE LINE VOLTAGE: 28VDC LEAD TESTED: N/A

REQ. FREQ. MHz	INJECTED TEST SIGNAL		REMARKS	ENGINEERING INFORMATION	
	MEASURED LEVEL (1)	SPECIFICATION REQUIRED LEVEL (2)		INJECTED SIGNAL LEVEL	TEST SAMPLE RESPONSE
140	<u>NO Suscept.</u>	<u>1V/M</u>	<u>Electron 4 Data output fluctuated in an intermittent manner throughout this test. This was not due to the susceptibility Test signal. Ref. DR # EPS-0072</u>	<u>2V/M</u>	<u>NO Suscept.</u>
↓					
20					
↓					
200					
↓					
230				<u>7V/M</u>	
250		<u>2V/M</u>			
300					
320		<u>1V/M</u>		<u>2V/M</u>	
↓					
2000		<u>15V/M</u>		<u>15V/M</u>	
2300					
2400		<u>1V/M</u>		<u>2V/M</u>	
↓					
8000		<u>7V/M</u>		<u>7V/M</u>	
↓					
10,000					

Component <u>Electron/Proton Spectrometer</u>	Document No. <u>EP8-003</u>	Rev.
NASA Type No. <u>SFC 39106425-301</u>	Tested By <u>Dalson/Fournet</u>	
NASA Serial No. <u>1001</u>	Date Tested <u>2-02-72</u>	
Test Run Time	Inspection Stamp	

Type of Test: Induced Field Susceptibility

SIGNAL GEN: Model 400Hz Facility Power INJECTION DEVICE: Type 15' length of #14 AWG
 S/N N/A Model Solid Copper Wire
 Modulation N/A S/N N/A
 TEST SAMPLE LINE VOLTAGE: 28VDC LEAD TESTED: N/A

FREQ. <u>Hz</u>	INJECTED TEST SIGNAL		REMARKS NOTE: A measured level in column (1) lower than the required level in column (2) is a failure.	ENGINEERING INFORMATION	
	MEASURED LEVEL (1)	SPECIFICATION REQUIRED LEVEL (2)		INJECTED SIGNAL LEVEL	TEST SAMPLE RESPONSE
<u>700</u>	<u>No Susceptibility</u>	<u>10A</u>	<u>Equipment</u>	<u>11.5A</u>	<u>No susceptibility</u>
<u>430</u>	<u>↓</u>	<u>40 Amp-Ft.</u>	<u>Cables</u>	<u>69 Amp Ft.</u>	<u>↓</u>
			<u>Electron 4 Data</u>		
			<u>Fluctuated throughout</u>		
			<u>this Test-</u>		
			<u>NOT due to</u>		
			<u>Test Signal.</u>		
			<u>Ref DR# EPS-0072</u>		

APPENDIX C
RECEIVER NOISE LEVEL MEASUREMENTS

RIFI METER: NM-40A	TESTED BY: L. DOLSON
NASA CONTROL NO: 33010	DATE TESTED: 21 Dec 71
CAL DUE DATE: 11 MAR 72	ENGINEER: J. CHRISTIAN

TYPE OF TEST: Receiver Noise Level Measurements

TUNING UNIT OR BAND	FREQ kHz	MEASURED NOISE LEVELS			PICKUP DEVICE CORRECTIONS - dB			TEST CAPABILITY						
		NB		BB	CHECK	CP	ANT	LISN	CP		ANT		LISN	
		dBμV	dBμV/MHz					dBμA	dBμA/MHz	dBμV	dBμV/MHz	dBμV	dBμV/MHz	dBμV
	.030	15	N/A		37	N/A	N/A	52	N/A	N/A	N/A	N/A	N/A	N/A
	.045	6			34			40						
	.060	7			31			38						
	.090	-7			28			21						
	.12	12			25			37						
	.18	8			22			30						
	.24	-7			19			12						
	.36	-15			16			1						
	.48	-20			13			-7						
	.72	-11			10			-1						
	.96	-13			7			-6						
	1.5	-14			3			-11						
	1.8	-15			2			-13						
	3.0	-15			-3			-18						
	3.6	-16			-4			-20						
	6.0	-16			-9			-25						
	7.2	-15			-10			-25						
	12	-16			-15			-31						
	15	-15	↓		-16	↓	↓	-31	↓	↓	↓	↓	↓	↓

RIFI METER: <i>NF-105</i>	TESTED BY: <i>L. DOLSON</i>
NASA CONTROL NO: <i>31484</i>	DATE TESTED: <i>21 Dec 71</i>
CAL DUE DATE: <i>23 Feb 72</i>	ENGINEER: <i>J. CHRISTIAN</i>

TYPE OF TEST: Receiver Noise Level Measurements

TUNING UNIT OR BAND	FREQ MHz	MEASURED NOISE LEVELS			PICKUP DEVICE CORRECTIONS - dB			TEST CAPABILITY					
		NB dB μ V	BB dB μ V/MHz	CHECK	CP	ANT	LISN	CP		ANT		LISN	
					STODDART 91550-1	EMPIRE ROD	STODDART 91221-1	NB dB μ A	BB dB μ A/MHz	NB dB μ V	BB dB μ V/MHz	NB dB μ V	BB dB μ V/MHz
TX	.014	-25	36		14	52	N/A	-11	50	27	88	N/A	N/A
	.021	-27	37		12	49		-15	49	22	86		
	.030	-29	31		8	47		-21	39	18	78		
	.045	-33	30		4	46		-29	34	13	76		
	.060	-31	28		2	46		-29	30	15	74		
	.090	-30	28		-2	46		-32	26	16	74		
	.120	-31	26		-4	46		-35	22	15	72		
V	.150	-30	28		-6	46	V	-36	22	16	74	V	V
TA	.150	-18	36		-6	37	0	-24	30	19	73	-18	35
	.240	-15	35		-9	37		-24	26	22	72	-15	35
	.300	-15	35		-10	37		-25	25	22	72	-15	35
	.480	-18	28		-13	30		-31	15	12	58	-18	28
	.600	-18	29		-13	31		-31	16	13	60	-18	29
	.960	-15	31		-14	30		-29	17	15	61	-15	31
	1.2	-15	33		-15	27		-30	18	12	60	-15	33
	1.8	-15	32		-15	28		-30	17	13	60	-15	32
	2.4	-13	32		-15	25		-28	17	12	57	-13	32
	3.6	-13	30		-15	21		-28	15	8	51	-13	30
	4.8	-13	31		-15	24		-28	16	11	55	-13	31
	7.2	-13	32		-15	19		-28	17	6	51	-13	32
	9.6	-11	33		-15	18		-26	18	7	51	-11	33
	15	-10	36		-16	17		-26	20	7	53	-10	36
	20	-9	39		-16	15		-25	23	6	54	-9	39
V	30	-10	35		-16	17	V	-26	19	7	52	-10	35

RIFI METER: <i>NF-105</i>	TESTED BY: <i>L. DOLSON</i>
NASA CONTROL NO: <i>31484</i>	DATE TESTED: <i>21 Dec 71</i>
CAL DUE DATE: <i>23 Feb 72</i>	ENGINEER: <i>J. CHRISTIAN</i>

TYPE OF TEST: Receiver Noise Level Measurements

TUNING UNIT OR BAND	FREQ MHz	MEASURED NOISE LEVELS			PICKUP DEVICE CORRECTIONS - dB			TEST CAPABILITY					
		NB	BB	CHECK	CP	ANT	LISN	CP		ANT		LISN	
		dB μ V	dB μ V/MHz					dB μ A	dB μ A/MHz	dB μ V	dB μ V/MHz	dB μ V	dB μ V/MHz
T-1	60	-1	34		N/A	8	N/A	N/A	N/A	7	42	N/A	N/A
	80	-1	31							7	39		
	120	-5	31							7.5	39		
	160	+3	31							11	39		
	✓ 200	5	35							13	43		
T-2	180												
	220			REJECT									
	360												
✓ 400													
T-3	400	9	24							17	32		
	600	12	25							20	33		
	800	17	30							25	38		
	✓ 1000	12	29		✓	✓	✓	✓	✓	20	37	✓	✓

APPENDIX D
TEST PROCEDURE

SKYLAB ELECTRON/PROTON SPECTROMETER

QUALIFICATION PROCEDURE FOR
ELECTROMAGNETIC INTERFERENCE AND
SUSCEPTIBILITY TESTS

MSC/TCSD DOCUMENT EMC-P-EB8-003

6 OCTOBER 1971

PREPARED BY
LOCKHEED ELECTRONICS COMPANY
FOR
TELEMETRY AND COMMUNICATIONS SYSTEMS DIVISION

Approved By:

Project Engineer Salvador Villaseca

Section James W. Clark

Branch E. L. Chicom

ND-5 J. P. Velt

NASA MANNED SPACECRAFT CENTER
TELEMETRY AND COMMUNICATIONS SYSTEMS DIVISION
HOUSTON, TEXAS

Date: 6 October 1971

NASA/MSC
Houston, Texas

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ABSTRACT

This document establishes the procedures for the conduct of electromagnetic interference and susceptibility qualification testing of the Skylab Electron/Proton Spectrometer to North American Rockwell (NR) Interface Control Document (ICD) MH04-02057-234A as revised by Interface Revision Notice (IRN) 9395.

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REVISIONS

REV.	PAGE
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NASA - Manned Spacecraft Center
TEST PROCEDURE DEVIATION SHEET

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DOCUMENT NUMBER (Test Procedure No. and/or TPS No.)
EMC-P-EB8-003

PART NUMBER
SEC 39106425-301

HARDWARE NOMENCLATURE
Skylab Electron/Proton Spectrometer


DATE OF TEST
2-01-72

HARDWARE SERIAL NUMBER
1001

MSC DIVISION
TCSD

DATE OF DEV.
25 January, 1972

DEV. NO.	PAGE, SECTION, PARAGRAPH AND SEQUENCE NO.	DEVIATION	REASON	PERMANENT (P) OR TEMPORARY (T)	QC (Status and Date)
1	Page 10 Table I	Perform radiated susceptibility test with conical log spiral antenna over the frequency range 230 to 250 MHz at a field intensity of 7V/M instead of 1V/M. Specification limit remains 1 V/M.	Skylab workshop telemetry transmitters operating in the frequency range 230 to 250 MHz generate fields in excess of 1 V/M. The increase in test signal amplitude is required to assure compatibility with these transmitters.	P	

PREPARED BY (Test Engineer) <i>Don Fournet</i>	DATE 26 January 1972	FINAL ACCEPTANCE QC STAMP 
APPROVED BY (Project Engineer - NASA) <i>S. Villarsel</i>	DATE 26 Jan. 1972	
APPROVED BY (Quality Engineer - NASA) <i>T. V. [Signature]</i>	DATE 1/26/72	DATE 2-1-72

SKYLAB ELECTRON/PROTON SPECTROMETER

QUALIFICATION PROCEDURE FOR
ELECTROMAGNETIC INTERFERENCE AND
SUSCEPTIBILITY TESTS

1.0 GENERAL

This document establishes the procedures for electromagnetic interference and susceptibility qualification testing of the Skylab Electron/Proton Spectrometer, hereinafter referred to as the Spectrometer.

The purpose of these tests is to determine if the levels of interference emanating from the Spectrometer and the response of the Spectrometer to externally generated electromagnetic interference are within established limits.

The tests will be performed in the electromagnetic compatibility (EMC) test facilities located in Building 14 at the Manned Spacecraft Center under the direction of the Electromagnetic Systems Branch (ESB) of the Telemetry and Communications Systems Division (TCSD).

2.0 QUALITY ASSURANCE REQUIREMENTS

It is important that each step in the procedure be followed as shown to permit satisfactory evaluation of the test results. Where RECORD is indicated in the text, insert the values obtained for that measurement on the indicated data sheet. Read each step in its entirety prior to starting the test. Conduct all tests under the test conditions delineated in ICD MH04-02057-234A as revised by IRN 9395.

In the event of a failure during any portion of the EMC test program, report the failure to the Component Project Engineer in accord with MSCM 5312, Quality Operating Procedures, Part IV. The Project Engineer will determine the disposition of the reported failure.

A Quality Assurance Representative shall monitor the testing and recording of test data in accordance with the requirements of this test procedure. As a minimum, the inspector shall affix the applicable quality status stamp at the required inspection points. Other inspection points will be established at the discretion of the Quality Assurance Representative.

All devices utilized for measuring test parameters shall be calibrated in accordance with the applicable provisions of MSCM 8070, MSC Metrology Requirements Manual, prior to beginning the test.

Whenever a question of conformance with requirements arises, the inspector shall continue to witness testing and data recording. In such cases he shall prepare either a discrepancy report (DR) or a squawk, noting the questionable condition, that will be submitted for material review action if necessary. In addition, he shall sign and date the data sheet to indicate the inspection coverage and, upon resolution of the discrepancy, shall affix the applicable quality status stamp.

All deviations from this test procedure shall be at the discretion of the Project Engineer with the concurrence of the Cognizant Quality Assurance Representative. Each deviation shall be recorded on a test procedure deviation sheet with inspection verification of recorded data.

The inspector shall post information to the System and Component Historical Record Card, MSC Form 772, in accord with MSCM 5312, Quality Operating Procedures, Part IV.

3.0 APPLICABLE DOCUMENTS

ICD MH04-02057-234A	Electromagnetic Compatibility Design Criteria, CSM/GFE, NR/MSC
IRN 9395	Interface Revision Notice to ICD MH04-02057-234A
MSCM 5312	MSC Reliability and Quality Assurance Manual
Division Internal Note MSC 00168	Test Methods for Spacecraft Electromagnetic Interference (EMI) Control Requirements
MSCM 8070	MSC Metrology Requirements Manual

4.0 TEST EQUIPMENT

The items of test equipment listed in Table I, or equivalents approved by the test engineer, are required. During the test, RECORD the manufacturer, model number, identification number, and calibration due-date of the equipment used on a Data Sheet similar to that shown in Figure A-1.

5.0 SUSCEPTIBILITY DEFINITION

The Spectrometer shall be deemed to be susceptible when; 1) the output of any of the 6 proton detectors and 5 electron detectors, as displayed on the BME Cathode Ray Tube, is equal to or exceeds a count of 10, or 2) a loss of the sync word occurs as a result of the presence of the susceptibility test signal. Loss of the sync word is characterized by a complete loss of output data.

6.0 TEST PROCEDURE

6.1 General Requirements

All interference tests shall be performed within the shielded enclosures located in the Building 14 EMC test facility. The peak detector function of the interference measuring equipment shall be used when scanning in search of frequencies of maximum interference. Broadband and pulsed cw interference shall be measured by using the equipment's peak detector function; narrowband (CW) interferences shall be measured using the equipment's average detector function. Transient interference shall be measured using the peak detector and the aural slideback technique of measurement.

All interference measuring test equipment and general test support equipment shall be operated in accordance with the manufacturer's instruction manuals. Operating instructions for the Electron/Proton Spectrometer Bench Test Equipment (BTE) shall be included in the Test Preparation Sheet (TPS) authorizing the test.

The procedure for determining measurement frequencies prescribed in paragraph 2 of MSC-00168, Appendix A, will be utilized.

6.2 TEST SETUP

The spectrometer shall be mounted on and bonded to the EMI test fixture, which, in turn, shall be mounted on and bonded to the shielded enclosure ground plane. The basic test setup for the spectrometer is shown in Figure A-2. The Spectrometer pin functions and loading requirements for interference testing are shown in Figure A-3. During susceptibility testing, the Spectrometer BTE will replace the load box shown in Figures A-2 and A-3. The BTE shall be located outside the shielded enclosure. The basic test setup of Figure A-2 shall be modified as prescribed by the various test methods of MSC-00168 or Appendix B of this document. In those cases where MSC-00168 requires use of Line Impedance Stabilization Networks (LISN), use Solar type 6512-106R 10-ufd RF Capacitors instead of the LISN's. During all testing, except radiated interference testing, use the HP-6226A power supply. Locate it on the test bench with 24 ± 1 " leads between the power supply and the Spectrometer. For radiated interference testing, the power supply shall be located external to the shielded enclosure.

6.3 TEST REQUIREMENTS

Tables II and III list the interference and susceptibility tests, respectively, to be performed on the Spectrometer. The tables also reference detailed test procedures contained in Division Internal Note MSC 00168 or Appendix B of this document. Each referenced test method contains a sample data sheet which will be used to record the results of the test.

At the conclusion of the test, the test technician will list all items of test equipment used in the test on the test equipment data sheet shown in Figure A-1. In addition, the test technician will prepare photographs of the Spectrometer test setup for inclusion in the test report.

TABLE I TEST EQUIPMENT LIST

NOMENCLATURE	MANUFACTURER AND MODEL
RIFI Meter	Empire Model NF-105
hIFI Meter	Fairchild Model EMC-10
hIFI Meter	Stoddart Model NM-62A
Current Probe*	Fairchild Model PCL-10
Current Probe*	Stoddart Model 91550-1
Directive Antenna*	Stoddart Model 91889-1
Directive Antenna*	Stoddart Model 91888-1
Directive Antenna*	Stoddart Model 91892-1
Biconical Antenna*	Honeywell Model 7825
Biconical Antenna*	Honeywell Model 7825
Log Spiral Antenna*	Stoddart Model 93490-1
Log Spiral Antenna*	Stoddart Model 93491-2
Rod Antenna*	Stoddart Model 92198-3
Rod Antenna*	Empire Model VA-105
Rod Antenna*	Empire Model VR-105
Dipole Antenna*	Empire Model T-1
Dipole Antenna*	Empire Model T-2
Dipole Antenna*	Empire Model T-3
Directional Coupler	Narda Model 3042B-20
Directional Coupler	Narda Model 3003-20
Directional Coupler	Narda Model 3000-10
Directional Coupler	Narda Model 3041-20
Directional Coupler	Narda Model 3004-20
Attenuator	Hewlett-Packard Model 354A
Attenuator	Narda Model 768-10
Power Supply*	Kepeco Model SM-36-10M
Power Supply*	Harrison Lab Model 6226A

*This equipment does not require calibration

TABLE I TEST EQUIPMENT LIST (Continued)

NOMENCLATURE	MANUFACTURER AND MODEL
Audio Amplifier**	McIntosh Model 200AB
Transient Generator	Solar Model 6471-1
Oscilloscope	Tektronix Type 321
Oscilloscope	Tektronix Type 581A
Power Meter	Hewlett-Packard Model 431B
RF Amplifier	Boonton Radio Model 230A
Amplifier**	FAM Model L100N
Amplifier**	FAM Model S100N
Amplifier**	FAM Model C100N
Amplifier**	FAM Model X100N
Signal Generator	Hewlett-Packard Model 606
Signal Generator	Hewlett-Packard Model 608
Signal Generator	Hewlett-Packard Model 612
Signal Generator	Hewlett-Packard Model 614A
Signal Generator	Hewlett-Packard Model 616B
Signal Generator	Hewlett-Packard Model 618B
Signal Generator	Hewlett-Packard Model 620A
Electron/Proton Spectrometer	Lockheed Electronics
Bench Test Equipment**	
Input/Output Unit**	Hazeltine 2000

**The critical performance parameters of this equipment are verified during the tests described herein. Therefore for the purposes of these tests, this equipment does not require current calibration stickers from the MSC Calibration Laboratory

TABLE II. INTERFERENCE TEST REQUIREMENTS

TYPE OF TEST	PARAGRAPH REFERENCES		FREQUENCY RANGE	SPECIFICATION LIMITS	REMARKS
	MHO4-02057-234	MSC 00168			
Conducted Interference Using Oscilloscope	3.6.1.1	N/A Appendix B Test Method 1	0 Hz-15 kHz	0.8 V P-P	Line Stabilization Capacitors (LSC) removed for this test
Conducted Interference Using Current Probe	3.6.1.1	Paragraph 4.4.b Test Method CI-02	BB 0 Hz-25 MHz CW 30 Hz-25 MHz	Figure 5 of MHO4-02057-234	LSC in circuit for these tests
Radiated Interference Rod Antenna	3.6.1.2	4.5a Method RI-01	BB 15kHz-25MHz CW 15kHz-25MHz	Figures 3 & 4 of MHO4-02057-234	LSC in circuit for these tests
Radiated Interference Dipole Antenna	3.6.1.2	4.5.b Test Method PI-02	BB 25MHz-400MHz CW 25MHz-1000MHz	Figures 6 & 8 of MHO4-02057-234	LSC in circuit for these tests
Radiated Interference Directive Antenna	3.6.1.2	4.5.c Test Method RI-03	CW 1000MHz-10,000MHz	Figure 7 of MHO4-02057-234	LSC in circuit for these tests

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TABLE III. SUSCEPTIBILITY TEST REQUIREMENTS

TYPE OF TEST	PARAGRAPH REFERENCES		FREQUENCY RANGE	SPECIFICATION LIMITS	REMARKS
	MHO4-02057-234	MSC 00168			
Conducted Susceptibility RF	3.6.1.3.1	N/A Appendix B Test Method 2	50kHz-400MHz	100,000 μ V	LSC removed for this test
Audio	3.6.1.3.1	4.6.a Test Method CS-01	20Hz-50kHz	Paragraph 3.6.1.3.1.2 MHO4-02057-234	LSC removed for this test
50 V Transient	3.6.1.3.1	4.6.c Test Method CS-03	10PPS-2 min.	+50 V peak	LSC removed for this test
0.5 V Transient	3.6.1.3	4.6.c Test Method CS-03	10PPS-2 min.	\pm 0.5 V peak	LSC removed for this test. Transient injected between each return and chassis ground. Each return grounded to chassis ground through a 1 ohm resistor.
Radiated Susceptibility Rod Antenna	3.6.1.4	4.7.c Test Method RS-03	0.14 to 20MHz	1.0 V/M	LSC in circuit for these tests. Antenna 1 meter from test sample. Measuring antenna 1 meter from transmitting antenna
Biconical Antenna	3.6.1.4	4.7.e Test Method RS-05	20 to 200 MHz	1.0 V/M	
Conical Log-Spiral Antenna	3.6.1.4	N/A Appendix B Test Method 3	200 to 10,000 MHz	1.0 V/M except as follows: 250-300MHz-2V/M 2270-2290-15V/M 9800-10850-7V/M	

Note: Amplitude modulate test signal 30 percent with a 400 Hz sine wave from 50 kHz to 1000 MHz. Use no modulation from 1000-10000 MHz.

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TABLE III. SUSCEPTIBILITY TEST REQUIREMENTS (Cont.)

TYPE OF TEST	PARAGRAPH REFERENCES		FREQUENCY RANGE	SPECIFICATION LIMITS	REMARKS
	MHO4-02057-234	MSC 00168			
Induced Field Susceptibility Equipment	3.6.1.5.1	N/A Appendix B Test Method 4	400 Hz	10 amperes through 5 feet of wire (50 ampere feet)	LSC in circuit for these tests
Cabling	3.6.1.5.2	N/A Appendix B Test Method 5	400 Hz	40 ampere feet	

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APPENDIX A
TEST EQUIPMENT DATA SHEET
AND TEST SETUP FIGURES

Component	Document No.	Rev.
NASA Type No.	Tested By	
NASA Serial No.	Date Tested	
Test Run Time	Inspection Stamp	

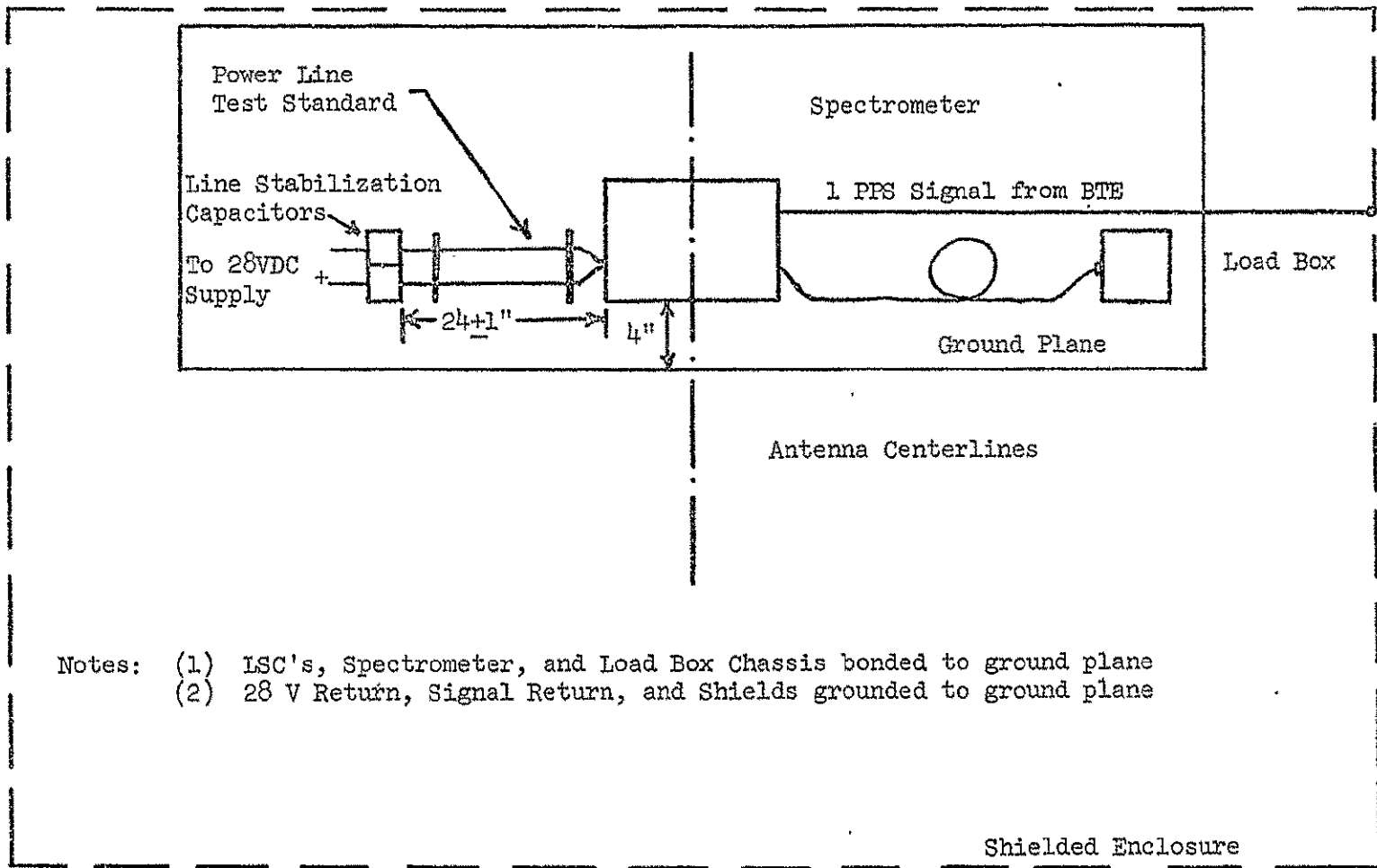
TEST EQUIPMENT LIST

NOMENCLATURE	MANUFACTURER AND MODEL	IDENTIFICATION NUMBER	CALIBRATION DUE DATE

Figure 1. Test Equipment Data Sheet

C-7

A-2



- Notes: (1) LSC's, Spectrometer, and Load Box Chassis bonded to ground plane
(2) 28 V Return, Signal Return, and Shields grounded to ground plane

Figure 2. Basic Test Setup

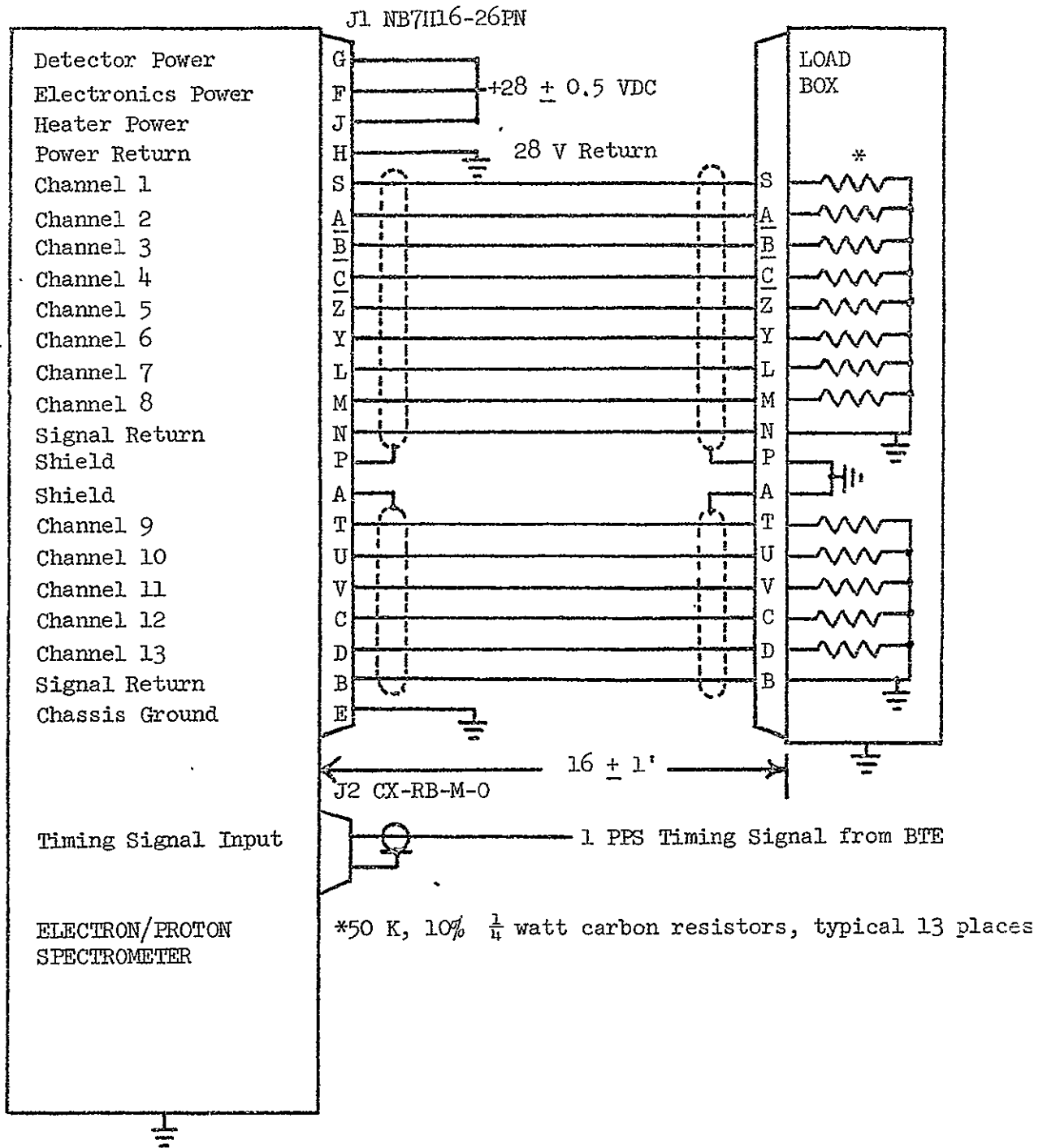


Figure 3. Spectrometer Cabling and Loading Requirements

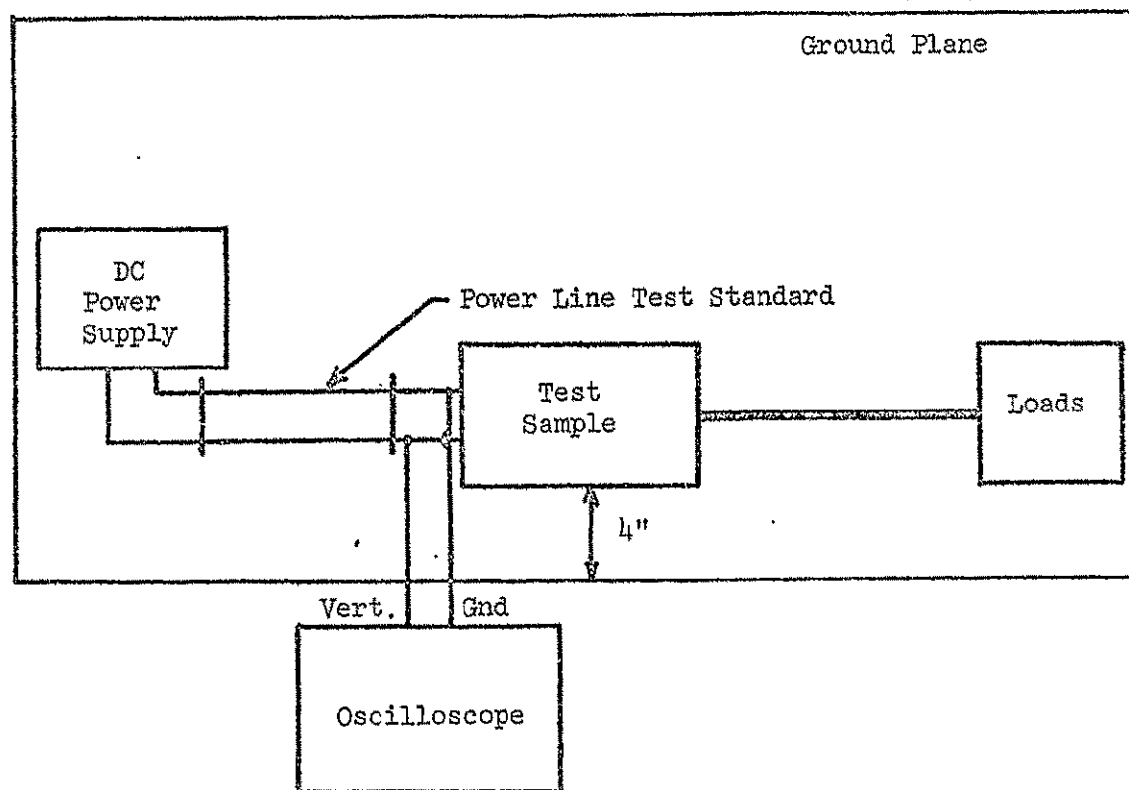
APPENDIX B
SUPPLEMENTARY TEST METHODS

SUPPLEMENTARY TEST METHODS

Test Method 1: Conducted Interference Using an Oscilloscope on DC Input Power Leads

This test method is used to measure conducted interference voltages appearing on input power leads in the frequency range 0 to the Oscilloscope bandwidth.

- a. Test Setup: Figure B-1 shows a typical test setup for use with this test method. The power supply shall be located inside the shielded enclosure for this test. The lead length between the test sample and the power supply, including the length of the power line test standard, shall be as specified in the test procedure. If flight cables are available, they will be used instead of the power line test standard. Bonding or grounding of the test sample and/or shields to the ground plane will be as specified in the test procedure. The third pin on the oscilloscope power cord will be isolated from ground.
- b. Test Equipment: The following items of test equipment (or equivalents) are required to perform this test method.
 - (1) Power supply meeting the impedance requirements of the governing EMI specification and capable of supplying the power requirements of the test sample.
 - (2) Power line test standard conforming to the requirements of the governing EMI specification.
 - (3) Oscilloscope with the bandwidth and sensitivity required by the governing EMI specification.



B-2

- Notes: (1) Bond or ground test sample chassis, shields, and signal return as required in the test procedure.
 (2) Third pin on oscilloscope power cord is not grounded.

Figure B-1. Conducted Interference Using Oscilloscope on DC Power Lines

c. Measurement Procedure

- (1) Set up the equipment as shown in Figure B-1. The oscilloscope probe is connected to the power leads as close to the test sample power connector as is possible.
- (2) Energize the test sample and test equipment and allow time for warmup. Adjust the oscilloscope vertical sensitivity and time base as required to measure the peak-to-peak voltage of the displayed composite signal without regard to frequency. The oscilloscope AC-DC switch shall be in the AC position. RECORD the peak-to-peak voltage of the composite signal.

- d. Data Sheet: Figure A-17 of MSC-00168 is a sample of a data sheet which is suitable for use with this test method.

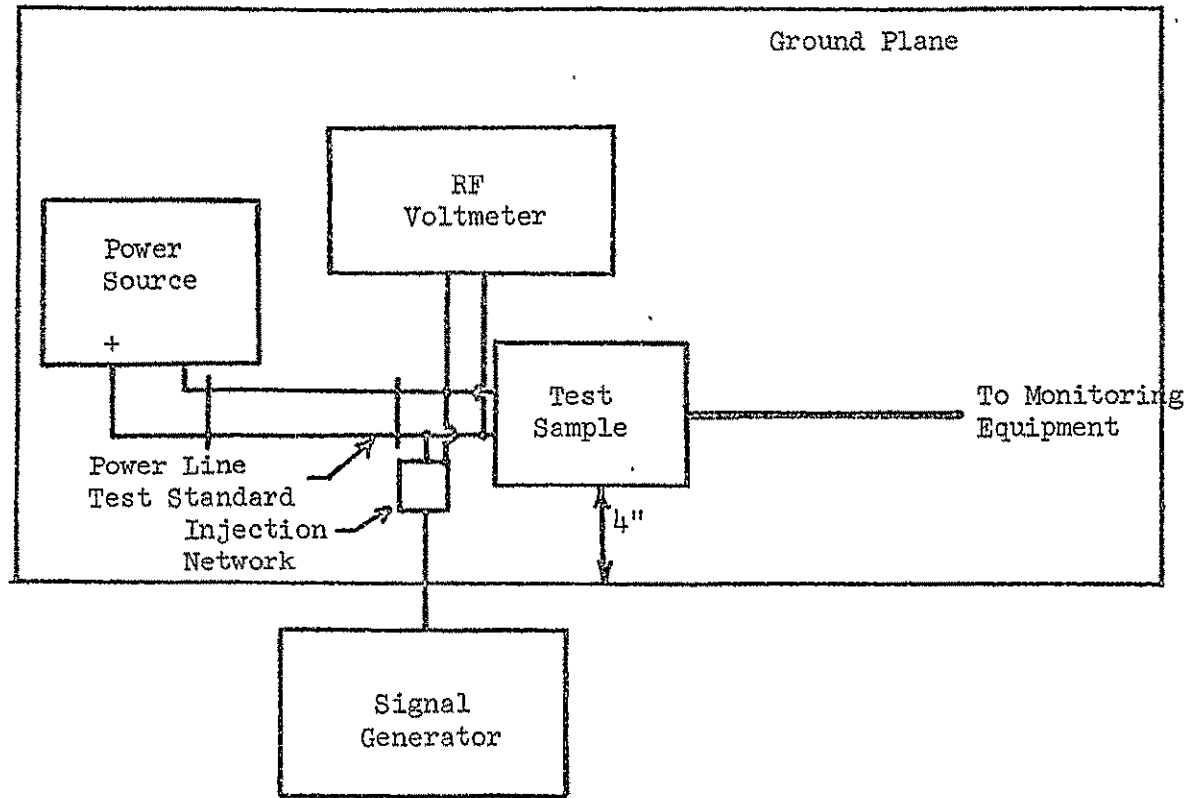
2.0

Test Method 2: RF Conducted Susceptibility Using Injection Capacitors

This test method is intended to verify that the test sample is not susceptible to radio-frequency interference on its power leads.

- a. Test Setup: Figure B-2 shows the typical test setup for use with this method. The line stabilization capacitors are removed for this test.

The bonding and grounding of the test sample and/or cable shields shall be as delineated in the test procedure. The power line test standard is inserted in the circuit between



- Notes: (1) Bond or ground test sample chassis, power return, signal return, and shields as required by test procedure.
- (2) Third pin on signal generator shall not be grounded.

Figure B-2. RF Conducted Susceptibility Using Injection Capacitors

the test sample and the power supply interface. The test sample input simulation and monitoring equipment shall be as shown in the test procedure.

The lead length between the point of connection of the voltmeter probe and the test sample input connector shall be 2" or less.

b. Test Equipment

- (1) Power line test standard.
- (2) Six-foot length of double shielded coaxial cable.
- (3) Signal generators capable of covering the frequency range and delivering the power levels required by the test procedure.
- (4) Vacuum tube voltmeter capable of measuring to the requirements of the governing specification.
- (5) Test sample input simulation and monitoring equipment as required by the test procedure.

c. Test Procedure

- (1) Connect the equipment as shown in Figure B-2. Energize the test equipment and the test sample and allow time for warmup.
- (2) Tune the signal generator to the lowest frequency required by the test procedure. Set the output

attenuator of the signal generator to provide the signal level required by the test procedure (as measured on the VTVM). Unless otherwise specified in the test procedure, the test signal shall be amplitude modulated 30 percent with either a 400 MHz or 1000 Hz sine wave as specified in the test procedure.

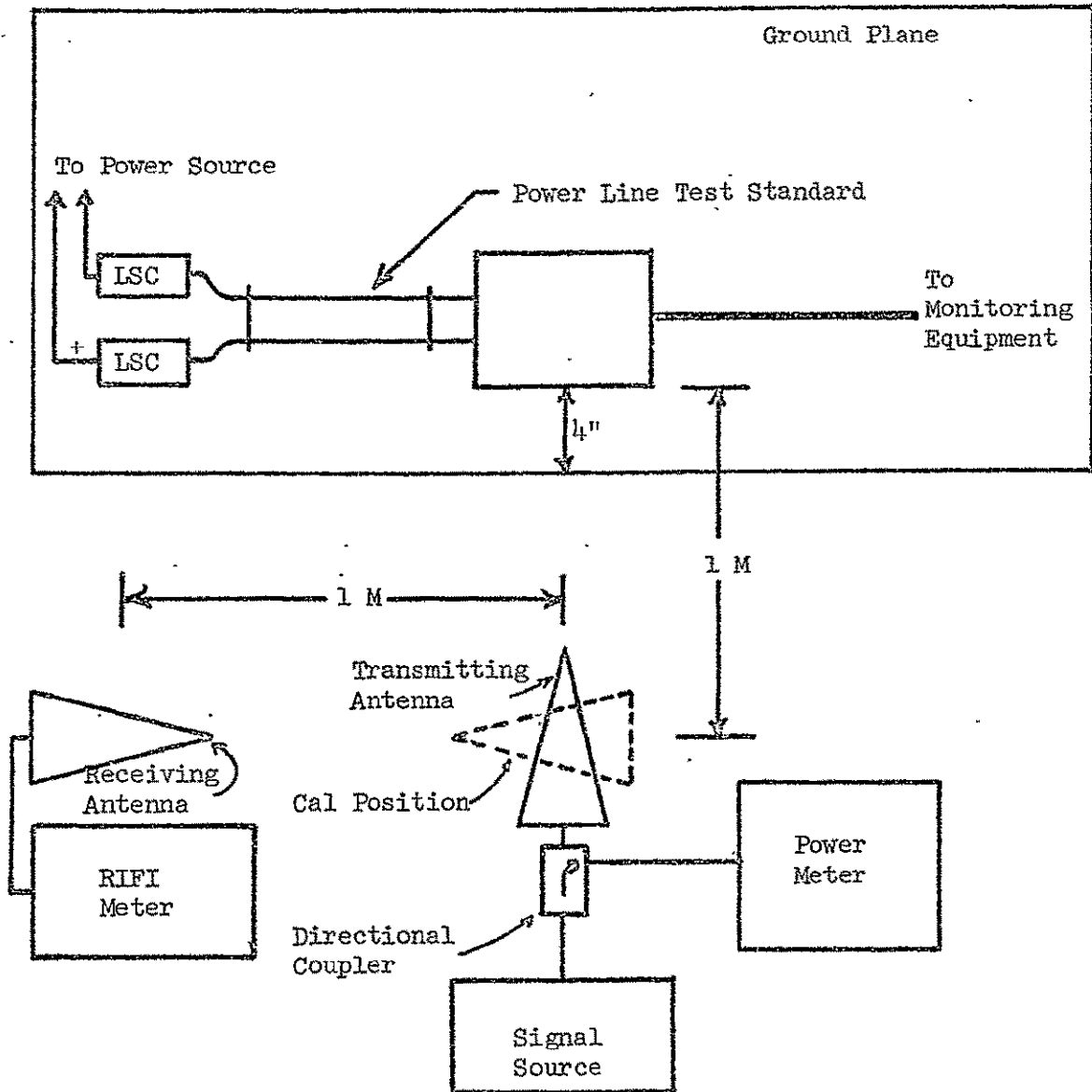
- (3) Scan the frequency range required by the test procedure while maintaining the required output signal level. During the scan, monitor the test sample output for evidence of susceptibility. If such evidence is observed, RECORD the test sample response and decrease the output level of the signal generator until the evidence of susceptibility is just removed. RECORD the frequency and threshold level on the applicable data sheet.

d. Data Sheet: Figure A-18 of MSC-00168 is a sample of a data sheet which is suitable for use with this test method.

3.0

Test Method 3: Radiated Susceptibility - Conical Log-Spiral Antenna - Calibrated Field

- a. Test Setup: The typical test setup for this test method is shown in Figure B-3. The LSC's are used with this method and are mounted on and bonded to the ground plane. The power line test standard is inserted in the circuit between the LSC's and the test sample. The bonding and grounding of the test sample and/or cable shields shall be as delineated in the test procedure. The transmitting antenna is located 1 meter away from the front surface of the test sample. The separation from the test sample is measured from the mid-point



Note: Bonding or grounding of test sample chassis, power return, signal return, and shields per the requirements of the test procedure

Figure B-3. Radiated Susceptibility - Conical Log-Spiral Antenna

of the conical log spiral antenna. The antenna shall be positioned 12 inches above the ground plane. The receiving antenna shall be placed so that the angle formed by the line between the two antennas and the line between the test sample and the transmitting antenna is at least 90 degrees and, when the transmitting antenna is rotated through this angle about its vertical axis, the longitudinal center lines and planes of polarization of the antennas coincide (cal position). The distance between the antennas will be the same as the distance between the transmitting antenna and the test sample. The connection between the receiving antenna and receiver is made with a length of double-shielded coaxial cable. The cable loss shall be considered when calculating field intensity. The test sample input simulation and monitoring equipment shall be set up as delineated in the test procedure.

b. Test Equipment

- (1) LSC per the requirements of the governing specification.
- (2) Power line test standard per the requirements of the governing specification.
- (3) Antennas per the requirements of the governing specification.
- (4) RIFI meter capable of covering the frequency range in question.
- (5) Signal source with an output impedance of 50 ohms and capable of producing the signal levels required by the governing specification.

- (6) RF power meter.
- (7) Directional couplers designed to operate over the frequency range of the test.
- (8) Test sample input simulation and monitoring equipment per the requirements of the governing specification.

c. Test Procedure

- (1) Set up the test equipment as shown in Figure B-3. Set the output attenuator of the signal generator and the gain of the amplifier for minimum output. Energize the test equipment and test sample and allow time for warmup.
- (2) Tune the signal generator to the lowest frequency required by the test procedure for this test. Turn the transmitting antenna to the cal. position. Adjust the power level delivered to the transmitting antenna until the field intensity measured at the receiving antenna is 1 V/M unless otherwise specified by the test procedure. Note the power level indicated on the power meter. (This calibration of the field will be performed once per octave over the frequency range of the test and each time the signal generator, power amplifier, test antenna, or directional coupler is changed as the scan is made over the required frequency range.)
- (3) Turn the transmitting antenna back to the test position. Increase the power level to the transmitting antenna by 3 dB as indicated on the power meter. Scan the frequency

range required by the test procedure while maintaining this power level into the transmitting antenna. Test antennas, signal generators, directional couplers, and power amplifiers will be changed as required during the scan so that the test frequencies remain within their design bandwidths. During the scan, monitor the output of the test sample for an undesired response.

- (4) At each frequency to which the test sample exhibits susceptibility, RECORD the test frequency and test sample response. Decrease the power delivered to the test antenna until the power meter reads the same level noted in step (2) and again RECORD the test sample response. Decrease the power level delivered to the test antenna until the test sample no longer exhibits the undesired response. Turn the transmitting antenna to the CAL position and measure the field intensity at the receiving antenna. RECORD this field intensity as the threshold of susceptibility.

- d. Data Sheet: Figure A-18 of MSC-00168 is an example of a data sheet which is acceptable for use with this test method.

4.0

Test Method 4: Induced Field Susceptibility - Equipment

- a. Test Setup: The typical test setup for this method is shown in Figure B-4. The LSC's are used with this test method and are mounted on and bonded to the ground plane. The power line test standard is inserted in the circuit between the LSC's and the test sample. The bonding and grounding of the test sample and/or cable shields shall be as delineated in the test procedure. The wire segment is located 1 foot from the

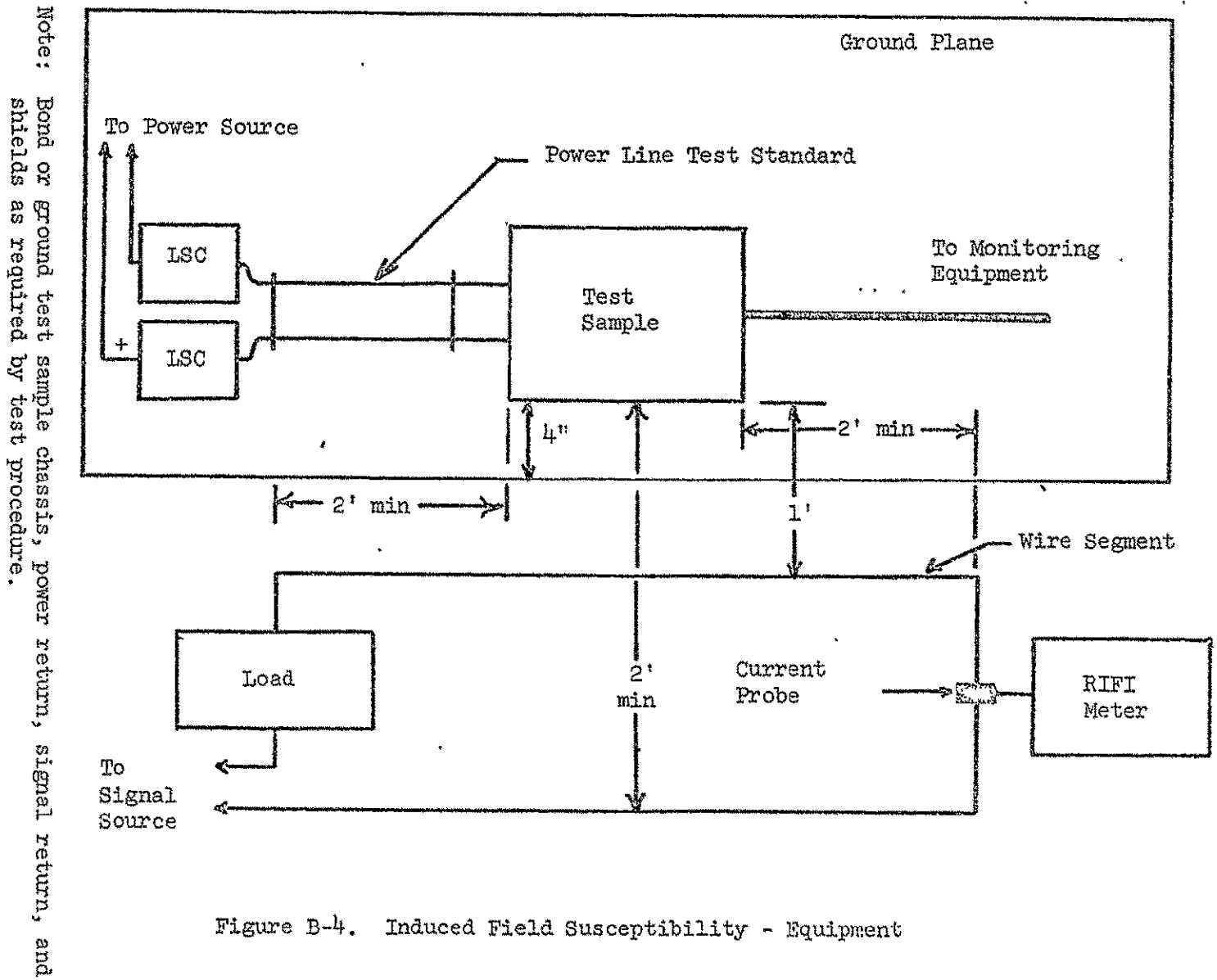


Figure B-4. Induced Field Susceptibility - Equipment

test sample and interconnecting cables parallel to the horizontal centerline of the test sample. The length of the wire segment shall be such that it extends 2 feet past the unit under test at each end. The leads supplying current to the segment shall be routed at least 2 feet from the test sample and its interconnecting cables. The test sample input simulation and monitoring equipment shall be set up as delineated in the test procedure.

b. Test Equipment

- (1) LSC's per the requirement of the governing specification.
- (2) Power line test standard per the requirements of the governing specification.
- (3) A segment of test wire of sufficient length and current carrying capacity to meet the requirements of the governing specification.
- (4) A signal source capable of producing the frequency and amplitude of test signal required by the governing specification.
- (5) A load capable of dissipating the power generated in the course of this test.
- (6) RIFI meter and current probe capable of measuring the current generated in the wire segment at the test frequency.
- (7) Test sample input simulation and monitoring equipment per the requirements of the test procedure.

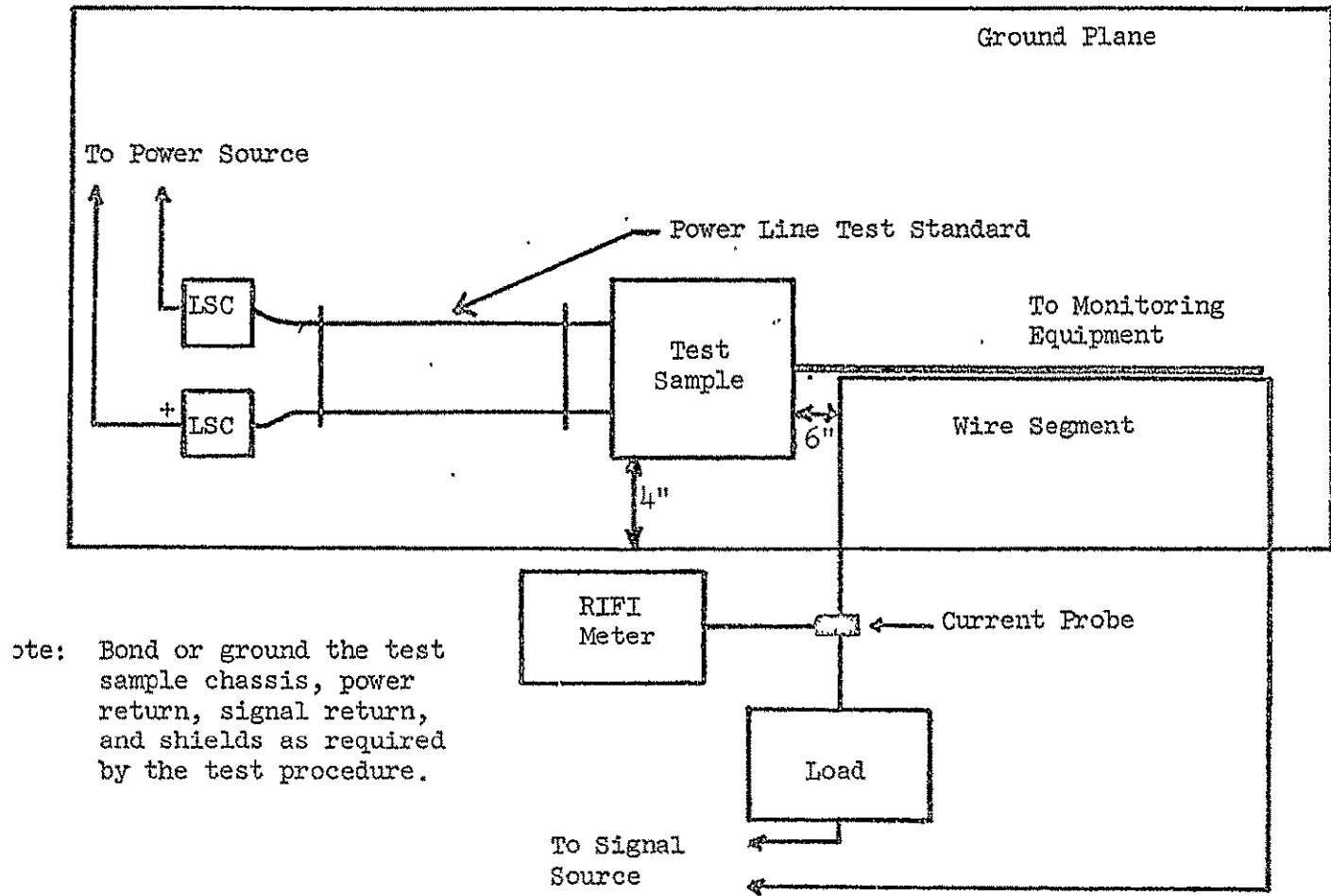
c. Test Procedure

- (1) Set up the equipment as shown in Figure B-4. Energize the test sample and test equipment and allow time for warmup.
- (2) Tune the signal source to the (lowest) test frequency required by the test procedure for this test. Adjust the gain of the signal source and/or the resistance of the load as required so that the current flow in the wire segment, as measured with the RIFI meter, equals the current requirement of the test procedure.
- (3) If a fixed frequency test is specified, allow the current to flow in the segment as long as is required to determine if the test sample is susceptible. If the test is to be performed in a scanning mode, slowly scan the frequency range of interest while monitoring the output of the test sample for evidence of susceptibility.
- (4) When an undesired response is noted, RECORD the test frequency and response of the test sample. Reduce the amplitude of the current flowing in the wire segment until the undesired response is no longer present. Measure the current flow in the wire segment and RECORD the level as threshold of susceptibility.

d. Data Sheet: Figure A-18 of MSC-00168 is an example of a data sheet which is acceptable for use with this test method.

Test Method 5: Induced Field Susceptibility - Cables

- a. Test Setup: The typical test setup for this method is shown in Figure B-5. The LSC's are used with this test method and are mounted on and bonded to the ground plane. The power line test standard is inserted in the circuit between the LSC's and the test sample. The bonding and grounding of the test sample and/or cable shields shall be as delineated in the test procedure. The wire segment is located adjacent to the test sample interconnecting cables. The wire segment shall break away from the test sample cabling at least 6 inches from the cable connectors. The cabling under test shall be routed 2 inches off the ground plane. The test sample input simulation and monitoring equipment shall be set up as delineated in the test procedure.
- b. Test Equipment
- (1) LSC's per the requirements of the governing specification.
 - (2) Power line test standard per the requirements of the governing specification.
 - (3) A segment of test wire of sufficient length and current carrying capacity to meet the requirements of the governing specification.
 - (4) A signal source capable of producing the frequency and amplitude of test signal required by the governing specification.
 - (5) A load capable of dissipating the power generated in the course of this test.



Note: Bond or ground the test sample chassis, power return, signal return, and shields as required by the test procedure.

Figure B-5. Induced Field Susceptibility - Cables

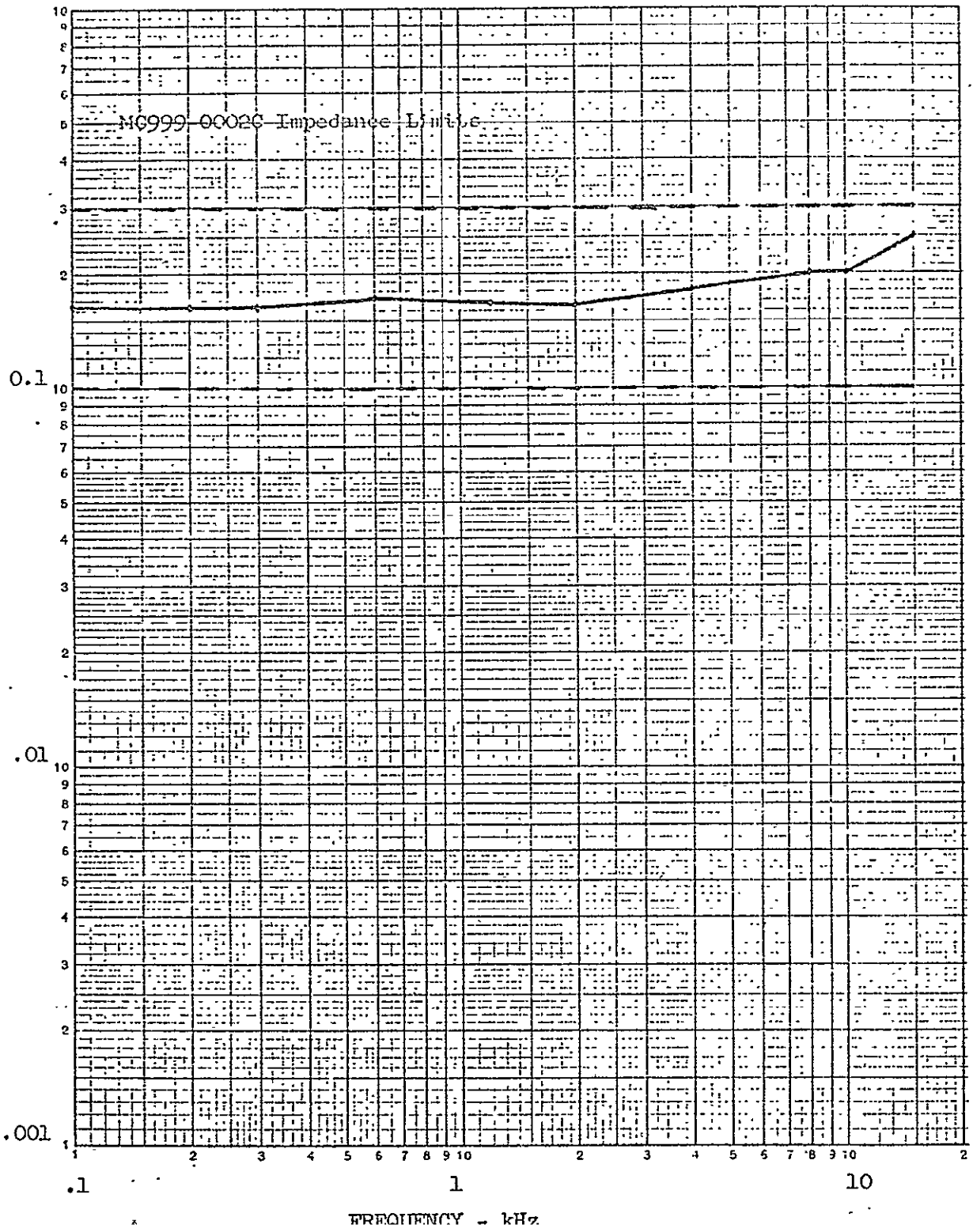
- (6) RIFI meter and current probe capable of measuring the current generated in the wire segment at the test frequency.
- (7) Test sample input simulation and monitoring equipment per the requirements of the test procedure.

3. Test Procedure

- (1) Set up the equipment as shown in Figure B-5. Energize the test sample and test equipment and allow time for warmup.
- (2) Tune the signal source to the (lowest) test frequency required by the test procedure for this test. Adjust the gain of the signal source and/or the resistance of the load as required so that the current flow in the wire segment, as measured with the RIFI meter, equals the current requirement of the test procedure.
- (3) If a fixed frequency test is specified, allow the current to flow in the segment as long as is required to determine if the test sample is susceptible. If the test is to be performed in a scanning mode, slowly scan the frequency range of interest while monitoring the output of the test sample for evidence of susceptibility.
- (4) When an undesired response is noted, RECORD the test frequency and response of the test sample. Reduce the amplitude of the current in the wire segment until the undesired response is no longer present. Measure the current flow in the wire segment and RECORD the level as threshold of susceptibility.

- d. Data Sheet: Figure A-18 of MSC-00168 is an example of a data sheet which is acceptable for use with this test method.

APPENDIX E
POWER SUPPLY IMPEDANCE DATA



OUTPUT IMPEDANCE
HP-6226 POWER WITH 24" LEADS

Appendix E
DR's and FIAR's

2. Article Name ELECTRON PROTON SPECTROMETER		3. Drawing Number SEC 3910C-125-301		4. Serial/Lot Number 1001		5. RECORD NUMBER	
6. Contractor's Name L E C		7. Contractor's Drawing Number N/A		8. Contractor's Serial Number N/A		IDR	
9. Supplier's Name L E C		10. Supplier's Drawing Number N/A		11. Supplier's Serial No N/A		DR/MRR EPS-0071	
13. REF. Document No. EPS-489		14. Spacecraft N/A	15. Fault EC1	16. Funct. N/A	17. Cause/Origin N/A	18. System N/A	19. Disposition N/A

DISCREPANCY

PAGE 24, -15.0 ± 1.0 VDC CHECKS -16.016
 PAGE 27, -15.0 ± 1.0 VDC CHECKS -16.029
 PAGE 40, -15.0 ± 1.0 VDC CHECKS -16.023
 Page 50 EST⁵² -15.0 ± 1.0 VDC CHECKS -16.029
 Page 66 -15.0 ± 1.0 VDC checks -16.023

20. Initiator's Signature S. Harding		21. Stamp Number 12M	22. Organization and Location of Initiator MSC-QA		23. Date 1/19/72	
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DISPOSITION

24. MR Action Required? <input checked="" type="checkbox"/> YES <input type="checkbox"/> No	25. Replacement Part Number N/A	26. Retest Required <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No	27. Retest Accept Date N/A	28. FIAR Number N/A	
--	------------------------------------	--	-------------------------------	------------------------	--

29. MRB Decision <input checked="" type="checkbox"/> USE "AS IS" <input type="checkbox"/> REPAIR <input type="checkbox"/> REWORK <input type="checkbox"/> TAP	INSTRUCTIONS Lo Value for -15 V output as specified by EPS-489 (-15.0V) is in error. Value should be -15.5 V. This was corrected in Procedure EPS-437 (Acceptance Test for the EPS Low Voltage Power Supply). The readings obtained and listed above (-16 V) is the correct output for the LVPS -15 V output. 2. Procedure EPS-489 will be revised to correct this error.				QC STAMP CONT NASA CHECKED WITH OK JH STP 2 PER TELECOM W/ JHB 1/21/72	
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30. DATE 4/26/72		FINAL ACCEPTANCE	
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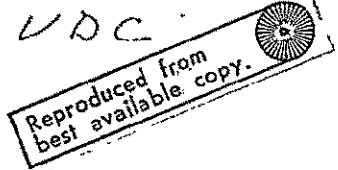
MRB APPROVAL SIGNATURES

31. System Engineer (Contractor) B. E. Williams	DATE 1-21-72	32. System Engineer (NASA) Gordon Jacobs	DATE 1-21-72
33. Quality Control Rep (Contractor) P. Blanton	DATE 4/25/72	34. Quality Control Rep. (NASA)	DATE
35. Program Office Rep. (Office Code)	DATE	36. Quality Engineer (NASA) M. [Signature]	DATE 1/21/72

FAILURE INVESTIGATION ACTION REPORT **REVISION 03** NO. 613-0001

1. PROJECT SKM LAB		2. WHEN REQUESTED 127 SC		3. REPORT NO. DIT		4. FCS CLASSIF. <input type="checkbox"/> FAILURE <input checked="" type="checkbox"/> CASUAL COND.		5. DATE REPORTED 1/19/72	
6. FACILITY 1001 HED		7. ORGANIZATION PHOTON		8. LOCATION P-TH BLD		9. REPORT NO. EPS-0071		10. REPORT ITEM EPS	
11. THIS NUMBER N/A		73. FT MODEL NO. SEC 39106425-301		74. CONTR. PART NO. N/A		75. CONTR. PART NO. N/A		76. CONTR. PART NO. N/A	
12. POINTING YR N/A		77. BT SERIAL NO. 1001		78. SUPPLIER PART NO. N/A		79. SUPPLIER PART NO. N/A		80. SUPPLIER PART NO. N/A	
13. SPEC/PROCESS NO. EPS-489		81. SERIAL NO. N/A		82. SERIAL NO. N/A		83. SERIAL NO. N/A		84. SERIAL NO. N/A	
14. COND.		15. CAUSE		16. SYMPT		17. FAIL TYP		18. DETECTED DURING E.P.S.	

21. DESCRIPTION OF FAILURE/CONDITION
-15.0 VDC ± 1.0 VDC CHECKS. -16.029 VDC



22. CRITICALITY
III

23. REFERENCE CONTACT S. Steadman	ORG. MSC-CA	DATE 2/11/72	24. RIE	ORG.	DATE
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25. PARALLEL ANALYSIS REQUESTED/INSTRUCTIONS
Determine cause of out of limit condition.

26. ASSIGNED TO	ORG.	DATE	27. REQUESTER	ORG.	DATE
-----------------	------	------	---------------	------	------

28. CAUSE OF FAILURE/ANALYSIS RESULTS
The value for the -15V output as specified by Procedure EPS-489 is in error. Correct value is -16.0.

29. SYSTEM ENGINEER	ORG.	DATE	30. RIE	ORG.	DATE
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31. CORRECTIVE ACTION REQUESTED
None, required since this is a procedural error.

32. ACTION ASSIGNED TO	ORG.	DATE	33. REQUESTER	ORG.	DATE
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34. CORRECTIVE ACTION TAKEN
**Revise Procedure EPS-489 to show the correct value.
 REVISION 3/21/72**

35. ACTION BY [Signature]	DATE 4/11/72	36. RIE [Signature]	DATE 4-7-72	37. EIC [Signature]	DATE 4/7/72
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1. Article Name ELECTRON PROTON SPECTROMETER		3. Drawing Number - 301		4. Serial Lot Number 1001		5. RECORD NUMBER	
6. Contractor's Name LEC		7. Contractor's Drawing Number SEC 39106425		8. Contractor's Serial Number N/A		IDR	
9. Supplier's Name LEC		10. Supplier's Drawing Number N/A		11. Supplier's Serial No. N/A		DR/MRR EPS-0072	
13. REF. Document No EPS-489		14. Spacecraft N/A	15. Fault EC1	16. Funct. N/A	17. Cause/Origin N/A	18. System N/A	19. Disposition N/A

DISCREPANCY

PAGE 32 OF PROCEDURE PARA 3G EPS CHANNEL ACCEPTABLE
COUNT ON CHANNEL D. 33,292,288 OR "0" CHECKS 38 COUNTS

PAGE 45 CHANNEL B 33,292,288 OR "0" CHECKS 118 COUNTS
3. Page 68 Channel D. 14 or 16 reads 22,784
4. Page 69 Channel D. 14 or 16 reads 172 and 18688

20. Initiator's Signature <i>E. D. Darling</i>		21. Stamp Number 12M	22. Organization and Location of Initiator MSC - QA		23. Date 1/19/72	
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DISPOSITION

24. MR Action Required? <input checked="" type="checkbox"/> YES <input type="checkbox"/> No	25. Replacement Part Number N/A	26. Retest Required <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No	27. Retest Accept Date N/A	28. FIAR Number N/A	
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29. MRB Decision <input checked="" type="checkbox"/> USE "AS IS" <input type="checkbox"/> REPAIR <input type="checkbox"/> REWORK <input checked="" type="checkbox"/> CAP	INSTRUCTIONS				QC STAMP CONT. NASA	
<p>1. Only Electron Channels (Disc settings of 300 KeV) gave problems. The Proton channels (with Disc settings 1 MeV or higher) gave no problems.</p> <p>2. Problem did not occur when Det Plate Temp was below 0°C.</p> <p>3. Based upon (1) & (2) above, it is concluded that the spurious counts are due to noise caused by the Detectors. Therefore, the EPS is operating properly. The Detectors will be removed during refurbishment of the Qual Unit.</p> <p>4. The unit is OK for Qual Testing.</p>						
					30. DATE 1/21/72 FINAL ACCEPTANCE	

MRB APPROVAL SIGNATURES

31. System Engineer (Contractor) <i>B. E. Cartwright</i>	DATE 1-21-72	32. System Engineer (NASA) <i>Paul W. Forbes</i>	DATE 1-21-72
33. Quality Control Rep. (Contractor)	DATE	34. Quality Control Rep (NASA)	DATE
35. Office Rep. (Office Code)	DATE	36. Quality Engineer (NASA) <i>E. D. Darling</i>	DATE 1/21/72

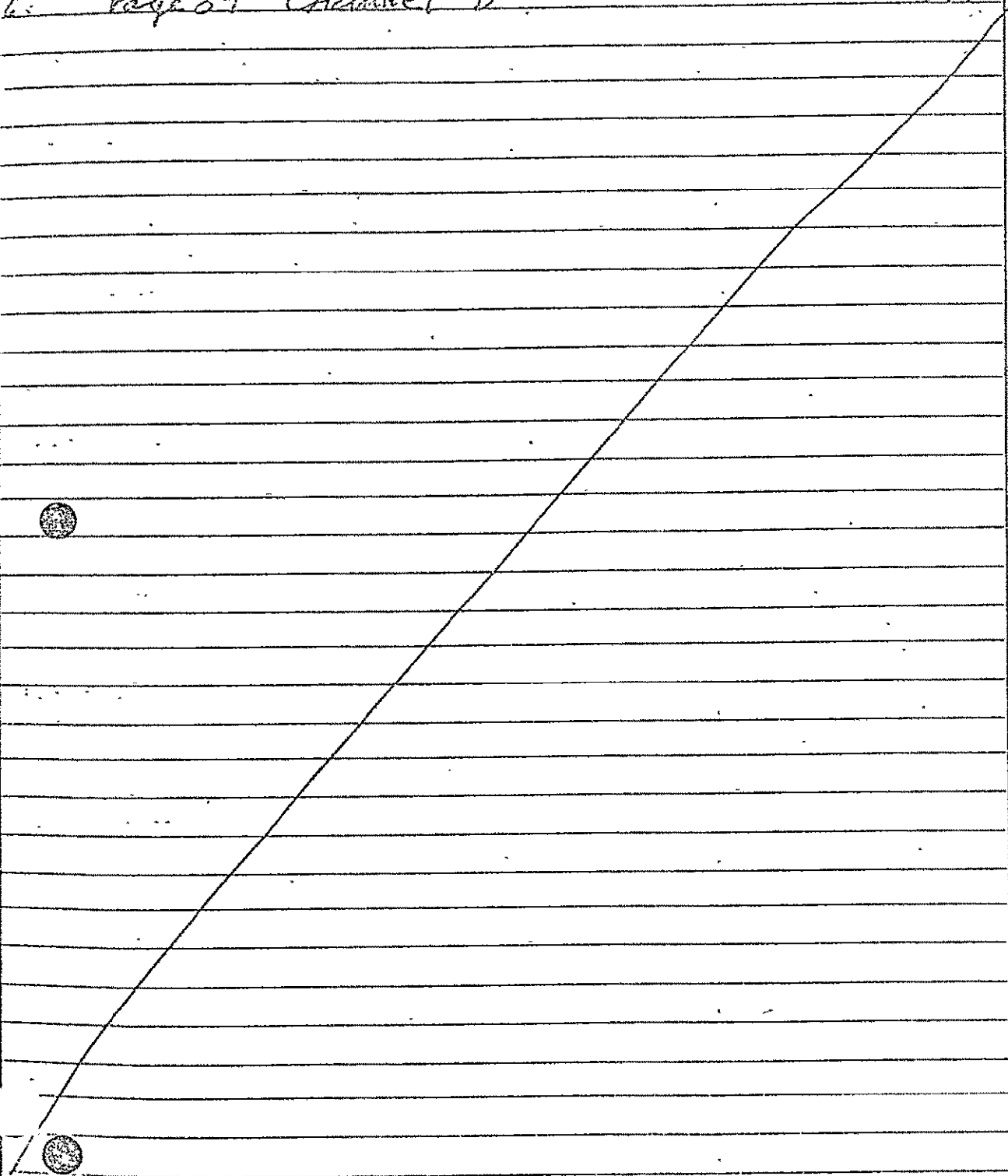
EL3

NASA NATIONAL SPACE CENTER

3. RECORD NUMBER
IDR
DR/MRR <i>EL5-0072</i>

QC STAMP
CONT. NASA

5: Page 71 Channel D 33,292,258 or 0 reads 880
 6: Page 84 Channel D " " " 344



DATE: *1/21/71* FINAL ACCEPTANCE



NASA - MANNED SPACECRAFT CENTER
 FAILURE INVESTIGATION ACTION REPORT NO. EPS-0004

1. WHERE DETECTED FACILITY: <u>MSC</u> ORGANIZATION: <u>LOCKHEED</u> LOCATION: <u>BETA BLD 1</u>	2. PART IDENT. NO. <u>EPS-0022</u>	3. DATE REPORTED <u>1/18/72</u>
4. FAILURE CLASSIF. NO. FAILURE 1. 1. SUB. COND.	5. PART ASSY. NAME <u>EPS</u>	6. REFERENCE ITEM <u>EPS</u>
7. LNS IDENT NAME <u>E.P.S.</u>	8. TEST EVIDENCE TEST <u>EPS</u>	9. PART PART NO. <u>N/A</u>
10. SUPPLIER PART NO. <u>N/A</u>	11. SUPPLIER PART NO. <u>N/A</u>	12. SUPPLIER PART NO. <u>N/A</u>
13. SERIAL NO. <u>1001</u>	14. SERIAL NO. <u>N/A</u>	15. SERIAL NO. <u>N/A</u>
16. SERIAL NO. <u>N/A</u>	17. SERIAL NO. <u>N/A</u>	18. SERIAL NO. <u>N/A</u>
19. SERIAL NO. <u>N/A</u>	20. SYSTEM NAME <u>EPS</u>	21. TIME CODE (24 HR) <u>N/A</u>

DESCRIPTION OF FAILURE CONDITION
 CHANNELS B, & D ARE GETTING SPURIOUS COUNTS, CHANNEL B
 23, 242, 288 OR "0" READS 118, CHANNEL D. 14, OR 16 COUNTS
 READS 172, & 18688 COUNTS

CRITICALITY <u>III</u>					
INITIAL CONTACT <u>J. P. ...</u>	ORG. <u>MSC-RA</u>	DATE <u>2/11/72</u>	25. RIE	ORG.	DATE

HARDWARE ANALYSIS REQUESTED/INSTRUCTIONS
 Conduct special test without detectors to determine if noise is from electronics or detectors.

CAUSE OF FAILURE, ANALYSIS RESULTS Spurious counts are caused by the detectors installed in channels B and D. This was verified by additional testing performed on TPS #EPS-1214.					
26. SYSTEM ENGINEER	ORG.	DATE	27. REQUESTER	ORG.	DATE

28. CORRECTIVE ACTION REQUESTED
 Detectors installed were suspect prior to installation. These detectors will be replaced prior to flight.

29. ACTION ASSIGNED TO	ORG.	DATE	30. REQUESTER	ORG.	DATE
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31. CORRECTIVE ACTION TAKEN
 During refurbishment of the Qual Test Unit, the detectors presently installed will be removed.
 Detectors will be installed in the unit prior to flight.
 Data obtained during special testing (see 25 above) is attached.
 J. O. ... 4/27/72 Re-copy R&E 1106 4-17-72
 ACTION BY: J. O. ... DATE: 4/27/72 32. P.E. DATE: 4-17-72 33. CRO. E.C. DATE: 4/17/72

Configuration Change
 Configuration Change
 Job Number

TEST-PREPARATION SHEET
 NASA - MANNED SPACECRAFT CENTER

2. IIS No. EPS-1214
 3. S.C. Cat. No.
 5. Page 1 of 2
 9. Need Date

6. Job No.
 7. Date 2-28-72
 8. Time

Drawings, Documents, Specs. & Part Numbers(s)
 EC 39106425

11. Contract Number
 N459-11373

12. Serial Number
 1001

Item
 EPS

14. Ref. E. O. Number

5. Short Title
 Testing of Qual Test Unit.

16. Wt Req

Reason for Work: To perform necessary testing as required by Mr. Distin, W. J. & Mr. Lopez of Boeing to verify disposition of R EPS-0072.

18 DESCRIPTION (Print or Type)	21 Insp.	
	Tech.	ASA

Remove EPS P/N 5EC39106425-301, S/N 1001 from the Beta Bldg Bonded Storage.	2/28/72	
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Remove Detectors from Channels B and D.	2/28/72	
---	---------	--

Perform Steps 2.1.23 thru 2.1.35 of Procedure EPS-503 on Channels B and D. Record Data below.	2/28/72	
---	---------	--

EPS Channel	Through-hole	Measured Count	Permissible Count
B	E2	14	14 or 16
D	E4	14	↑
B	P2	14	↓
D	P4	14	14 or 16
B	E2	2032	2032 or 2048
D	E4	2048	↑
B	P2	2032	↓
D	P4	2032	2032 or 2048

Prepared By:

20. Final Acceptance Date: 2/28/72

REFER TO PROCEDURES FOR REQUIRED SIGNATURES

REFER TO PROCEDURES FOR REQUIRED SIGNATURES

Signature: Date: 2-28-72

Signature: Date: 2-28-72
 Signature: Date: 2/28/72

TEST PREPARATION SHEET

CONTINUATION SHEET

NASA - MARSH SPACECRAFT CENTER

Title: EP3 - 1/1/77
 S.C.: _____ Cor: _____ No: _____
 Page: 2 of 2

DESCRIPTION (Part or Type)	Tech	Insp	
		Cont	REASA
EP3			
Channel			
B	E7	260,096	260,096 CR
D	E9	260,096	262,144
B	P2	260,096	
D	P4	260,096	260,096 CR
B	E7	33,292,288	33,292,288 CR
D	E4	0	
B	P2	33,292,288	
D	P4	33,292,288	33,292,288 CR
Return the EP3 Gwal Unit to the Bldg 2/23/77			
Bldg Bundled Storage			

2. Article Name FLECTRON PROTON SPECTROMETER		3. Drawing Number -301 SEC 39106425		4. Serial/Lot Number K101		5. RECORD NUMBER IDR		
6. Contractor's Name PCKHEED ELECTRONICS		7. Contractor's Drawing Number N/A		8. Contractor's Serial Number N/A		DR/MRR EPS-0087		
9. Supplier's Name PCKHEED ELECTRONICS		10. Supplier's Drawing Number N/A		11. Supplier's Serial No N/A		12. Next Higher Assy. N/A		
13. I.I.F. Document No. EPS-503		14. Spacecraft N/A		15. Fault T57	16. Funct N/A	17. Cause/Origin N/A	18. System N/A	19. Disposition N/A

DISCREPANCY

SEAL P/N ZX5176 IS LOOSE IN NUMEROUS PLACES ON MOUNT BASE OF EPS.

20. Initiator's Signature <i>[Signature]</i>		21. Stamp Number 12 M	22. Organization and Location of Initiator MSC-QA		23. Date 2/11/72	
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DISPOSITION

24. MR Action Required? <input checked="" type="checkbox"/> YES <input type="checkbox"/> No	25. Replacement Part Number N/A	26. Retest Required <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No	27. Retest Accept Date N/A	28. FIAR Number EPS-0005	
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29. MRB Decision	INSTRUCTIONS				QC STAMP?	
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- USE "ASIS"
- REPAIR
- REWORK
- SCRAP

Seal was probably knocked loose during all the moving & handling of the EPS Qual Unit during qualification testing.

~~Substituted~~ Rebond seal to flange as per Drawing SEC 39106425 prior to next Qual Test.

CONT.	NASA

30. DATE **2/11/72** FINAL ACCEPTANCE

MRB APPROVAL SIGNATURES

31. System Engineer (Contractor) <i>[Signature]</i>	DATE 2-11-72	32. System Engineer (NASA) <i>[Signature]</i>	DATE 2-11-72
33. Quality Control Rep. (Contractor)	DATE	34. Quality Control Rep. (NASA)	DATE
35. Program Office Rep. (Office Code)	DATE	36. Quality Engineer (NASA) <i>[Signature]</i>	DATE 2/16/72

NASA - MANNED SPACECRAFT CENTER
 FAILURE INVESTIGATION ACTION REPORT **FORM 0001** **EPS-0005**

1. PT. OF ORG. LAB		2. WHERE DETECTED FACILITY MISC		3. ORG. REPORT NO. DRN EPS-0087	4. PRGM. CLASSIF. <input type="checkbox"/> FAILURE <input type="checkbox"/> UNSAT. COND.	5. DATE REPORTED 2/11/72
6. CONTRACTOR LOCKHEED		7. END ITEM NAME E.P.S.	8. ITEM UNDER TEST E.P.S.	9. NEXT ASSY. NAME E.P.S.	10. REPORTED ITEM E.P.S.	
11. ITC NUMBER N/A		75. EI MODEL NO. -301	85. CONTR. PART NO. N/A	95. CONTR. PART NO. N/A	105. CONTR. PART NO. N/A	
12. ROUTING VIA N/A		76. EI SERIAL NO. 1001	86. SUPPLIER PART NO. N/A	96. SUPPLIER PART NO. N/A	106. SUPPLIER PART NO. N/A	
13. SPEC/PROCESS NO. ERS-503		88. SERIAL NO. N/A	98. SERIAL NO. N/A	108. SERIAL NO. N/A		
14. CORD.	15. CAUSE	16. SYMPT	17. FAIL TYP	18. DETECTED DURING QUAL	19.	22. SYSTEM NAME EPS

21. DESCRIPTION OF FAILURE/CONDITION:
SEAL P/N ZX 5176 IS LOOSE IN NUMEROUS PLACES ON MOUNT BASE OF EPS.

22. CRITICALITY
III

23. INITIATOR/CONTACT W. D. ...	ORG. MISC-OA	DATE 2/11/72	24. RIE	ORG.	DATE
---	------------------------	------------------------	---------	------	------

25. HARDWARE ANALYSIS REQUESTED/INSTRUCTIONS
Determine cause of problem.

26. SIGNED TO	ORG.	DATE	27. REQUESTER	ORG.	DATE
---------------	------	------	---------------	------	------

29. CAUSE OF FAILURE/ANALYSIS RESULTS
Seal P/N ZX5176 was grossly abused during Qual Testing and became loose. This unit was subjected to abnormal handling during Qual Testing and moving from place to place. THERE IS NO DESIGN PROBLEM WITH SEAL. LOSS OF SEAL INTEGRITY WILL HAVE NO EFFECT ON EPS PERFORMANCE.

29. SYSTEM ENGINEER	ORG.	DATE	30. RIE	ORG.	DATE
---------------------	------	------	---------	------	------

31. CORRECTIVE ACTION REQUESTED
**Due to fact that problem was caused by mishandling, seal will be repaired and used for remainder of test.
 REBONDED**

32. ACTION ASSIGNED TO	ORG.	DATE	33. REQUESTER	ORG.	DATE
------------------------	------	------	---------------	------	------

34. CORRECTIVE ACTION TAKEN
Rebonded seal to flange per drawing SEC39106425 prior to next testing series. Flight units will not be abused during installation.

35. ACTION BY W. D. ...	ORG.	DATE 4/11/72	36. BY R. E. ...	ORG.	DATE 4-7-72	37. BY ...	ORG.	DATE ...
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NASA - MANNED SPACECRAFT CENTER
 FAILURE INVESTIGATION ACTION REPORT *0095* *EPS-0005*

1. P. CBT <i>YLAB</i>		2. WHERE DETECTED FACILITY: <i>MSC</i> ORGANIZATION: <i>LOCATED</i> LOCATION: <i>BF7A BLS</i>			3. O.S. REPORT NO. <i>DEF</i> <i>EPS-5037</i>	4. PROB. CLASSIF. <input checked="" type="checkbox"/> FAILURE <input type="checkbox"/> UNSAT COND.	5. DATE REPORTED <i>2/11/72</i>
6. SUBSTITUTOR <i>LOCATED</i>	7. ESD ITEM NAME <i>E.P.S.</i>	8. ITEM UNDER TEST <i>E.P.S.</i>		9. NEXT ASSY. NAME <i>E.P.S.</i>		10. REPORTED ITEM <i>E.P.S.</i>	
11. TPE NO/HELP <i>N/A</i>	7a. EI MODEL NO. <i>-301</i>	9a. CONTR. PART NO. <i>N/A</i>		9b. CONTR. PART NO. <i>N/A</i>		10a. CONTR. PART NO. <i>N/A</i>	
12. ROUTING VIA <i>N/A</i>	7c. EI SERIAL NO. <i>1001</i>	9c. SUPPLIER PART NO. <i>N/A</i>		9d. SUPPLIER PART NO. <i>N/A</i>		10c. SUPPLIER PART NO. <i>N/A</i>	
13. SPEC/PROCESS I.O. <i>EPS-503</i>		8c. SERIAL NO. <i>N/A</i>		9e. SERIAL NO. <i>N/A</i>		10c. SERIAL NO. <i>N/A</i>	
14. COND.	15. CAUSE	16. SYMPT	17. FAIL TYP	18. DETECTED DURING <i>QUAL</i>	19.	20. SYSTEM DATE <i>EPS</i>	103. Time/Date/Sec/72 <i>N/A</i>
21. DESCRIPTION OF FAILURE/CONDITION <i>SEAL P/N ZX5176 IS LOOSE IN NUMEROUS PLACES ON MOUNT BASE OF EPS,</i>							
22. CRITICALITY <i>TLL</i>							
23. INITIATOR/CONTACT <i>X/Deering</i>		ORG. <i>MSC-OA</i>	DATE <i>2/11/72</i>	24. RIE		ORG.	DATE
25. HARDWARE ANALYSIS REQUESTED/INSTRUCTIONS <i>Determine cause of problem.</i>							
26. DESIGNED TO		ORG.	DATE	27. REQUESTER		ORG.	DATE
28. CAUSE OF FAILURE-ANALYSIS RESULTS <i>Seal P/N ZX5176 was grossly abused during Qual Testing and became loose. This unit was subjected to abnormal handling during Qual Testing and moving from place to place. THERE IS NO DESIGN PROBLEM WITH SEAL. LOSS OF SEAL INTEGRITY WILL HAVE NO EFFECT ON EPS PERFORMANCE.</i>							
29. SYSTEM ENGINEER		ORG.	DATE	30. RIE		ORG.	DATE
31. CORRECTIVE ACTION REQUESTED <i>Due to fact that problem was caused by mishandling, seal will be repaired and used for remainder of test.</i> <i>REBONDED</i>							
32. ACTION ASSIGNED TO		ORG.	DATE	33. REQUESTER		ORG.	DATE
34. CORRECTIVE ACTION TAKEN <i>Rebonded seal to flange per drawing SEC39106425 prior to next testing series. Flight units will not be abused during installation.</i>							
35. ACTION BY <i>Carson</i>		ORG.	DATE <i>4/11/72</i>	36. RIE <i>R.E. Lopez</i>		ORG. <i>R.E. Lopez</i>	DATE <i>4-7-72</i>
35. ACTION BY <i>R. J. Gordon</i>		ORG.	DATE <i>6/25/70</i>	36. RIE <i>R. J. Gordon</i>		ORG. <i>R. J. Gordon</i>	DATE <i>8/7/70</i>
35. ACTION BY <i>[Signature]</i>		ORG.	DATE <i>2/11/72</i>	36. RIE <i>[Signature]</i>		ORG. <i>[Signature]</i>	DATE <i>2/11/72</i>

2. Article Name Electron/Proton Spectrometer		3. Drawing Number SEC 39106425	4. Serial/Lot Number 1001	5. RECORD NUMBER	
Contractor's Name LOCKHEED Elect.		7. Contractor's Drawing Number N/A	8. Contractor's Serial Number N/A	IDR	
9. Supplier's Name N/A		10. Supplier's Drawing Number N/A	11. Supplier's Serial No. N/A	DR/MRR EPS0089	
13. REF. Document No PARA EPS 503 2.12	14. Spacecraft N/A	15. Fault T13	16. Fund. N/A	17. Cause Origin N/A	12. Next Higher Assy. N/A
				18. System N/A	19. Disposition N/A

DISCREPANCY

1. Signs of Rusting on top of EPS near Detector "C" also on 1 washer same location.

2. Paint Blisters on side of Isolator Housing & Central Test Point Cover plate.

20. Initiator's Signature <i>[Signature]</i>	21. Stamp Number 108M	22. Organization and Location of Initiator MSC QC Bldg 15	23. Date 2/23/72
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DISPOSITION

24. MR Action Required? <input checked="" type="checkbox"/> YES <input type="checkbox"/> No	25. Replacement Part Number N/A	26. Retest Required <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No	27. Retest Accept Date N/A	28. FIAR Number EPS-0006
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29. MRB Decision <input checked="" type="checkbox"/> USE "AS IS" <input type="checkbox"/> REPAIR <input type="checkbox"/> REWORK <input type="checkbox"/> SCRAP	INSTRUCTIONS		QC STAMP	
	<p>This EPS Instrument (S/N 1001) had been thru several Qualification tests (EMT, Thermal-Vacuum, Vibration, Shock etc) prior to the Humidity tests. During these tests and transferring the EPS to the test location the thermal paint on the instrument has been marred and scratched. This would allow moisture to penetrate the painted surfaces and possibly cause blistering.</p> <p>The signs of rusting itemized in (1) above were caused by the the humidity chamber rusting and dripping water (discolored water) onto the EPS during testing. This unit is OK for further testing.</p>		CONT.	NASA

30. DATE **4/21/72** FINAL ACCEPTANCE

MRB APPROVAL SIGNATURES

31. System Engineer (Contractor) <i>[Signature]</i>	DATE 2/24/72	32. System Engineer (NASA) <i>[Signature]</i>	DATE 4/25/72
33. Quality Control Rep. (Contractor)	DATE	34. Quality Control Rep (NASA)	DATE
35. Program Office Rep. (Office Code)	DATE	36. Quality Engineer (NASA) <i>[Signature]</i>	DATE 4/21/72

NASA - MANNED SPACECRAFT CENTER
FAILURE INVESTIGATION ACTION REPORT **STATION COPY** EPS-0089

1. PROJECT SkyLab		2. WHERE DETECTED FACILITY: MSC		3. ORGANIZATION LOCHEED		4. LOCATION BETA BLD		5. U.S. REPORT NO. DR# EPS-0089		6. PROB. CLASSIF. <input type="checkbox"/> FAILURE <input checked="" type="checkbox"/> UNSAT. COND.		7. DATE REPORTED 2/23/72	
8. PART NAME LOCHEED		9. END ITEM NAME F.P.S.		10. ITEM COLLECTED EPS		11. PART ASSY. NAME N/A		12. PART NO. F.P.S.		13. PART NO. N/A		14. PART NO. N/A	
15. SPEC. PROCESS NO. EPS-503		16. DATE 2.12		17. SERIAL NO. N/A		18. SERIAL NO. N/A		19. SERIAL NO. N/A		20. SERIAL NO. N/A		21. SERIAL NO. N/A	
22. CAUSE		23. SYMPT		24. FAIL TYP		25. DETECTED		26. SYSTEM		27. TIME		28. TIME	

21. DESCRIPTION OF FAILURE CONDITION: **QUAL TEST**
POST HUMIDITY VISUAL INSPECTION DISCLOSED THE FOLLOWING.
 1. SIGNS OF RUSTING ON TOP OF EPS NEAR DETECTOR "C" ALSO ON WASHER SAME LOCATION
 2. PAINT BLISTERS ON SIDE OF ISOLATOR HOUSING & CENTRAL TEST PCH.

22. CRITICALITY 004		23. COVER PLATES	
24. INITIATOR CONTACT J. Harding		25. DATE 2/23/72	

25. HARDWARE ANALYSIS REQUESTED/INSTRUCTIONS
Determine cause of rust and paint blisters.



26. SIGNED TO		27. REQUESTER	
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26. CAUSE OF FAILURE ANALYSIS RESULTS: This unit had been subjected to EMI, thermal-vacuum, vibration, shock, etc. Qualification Testing prior to the humidity test. During these tests and while transferring the EPS to the test location, the thermal paint was marked and scratched. This allowed moisture to penetrate the painted surfaces and cause the blistering.
 The detector 'C' dome is made of aluminum and the washer is made of 18/8 CRES, both items being fabricated by NASA/MSC TSD with full QA coverage. They could not be the cause of the apparent rust-marks on the EPS. The signs of rusting were caused by rust colored water dripping off of the NASA/MSC humidity chamber onto the EPS.

29. SYSTEM ENGINEER		30. DATE	
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31. CORRECTIVE ACTION REQUESTED
Refinish unit during refurbishment to become back-up spare.

32. ACTION ASSIGNED TO		33. REQUESTER	
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34. CORRECTIVE ACTION TAKEN: EPS Flight Units will not receive the rough handling and treatment that the Qual Unit received and will not be placed in the NASA/MSC humidity chamber, therefore, these problems will not occur on these units.

The EPS Qual Unit is scheduled to be refurbished into the Flight Spare (Backup) unit and will be repainted.

35. ACTION BY J. A. Gill		36. DATE 4/27/72		37. CLOSURE 4-18-72		38. DATE 4/27/72	
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1. Category		DISCREPANCY REPORT/MATERIAL REVIEW RECORD					NASA - MANNED SPACECRAFT CENTER		PAGE 1 OF 2	
EB		2. Article Name		3. Drawing Number -301		4. Serial-Lot Number		5. RECORD NUMBER		
ELECTRON PROTON SPECTROMETER SEC 34106425		6. Contractor's Name		7. Contractor's Drawing Number		8. Contractor's Serial Number		IDR		
LEC		LEC		N/A		N/A		DR/MRR FPS-0090		
9. Supplier's Name		10. Supplier's Drawing Number		11. Supplier's Serial No.		12. Next Higher Assy.				
LEC		N/A		N/A		N/A				
13. REF. Document No.		14. Spacecraft		15. Fault		16. Func.		17. Cause/Origin		
EPS-503 PAGE 269		N/A		EC1		N/A		N/A		
18. System		19. Disposition		DISCREPANCY						
EPS		N/A		POST HUMIDITY FUNCTIONAL TEST DISCLOSED THE FOLLOWING						
1. MEDIUM VOLTAGE ADC CHECKOUT 1.0, 2.0, 3.0, 4.0, & 4.9 VDC INPUT VOLTAGE. OUT PUT VOLTAGE CHECKS LOW. PAGE 269.										
2. PAGE. 270, 271, & 273. DISC REF MON. CHECKS 2.965 VDC SHOULD BE 3.0 ± .02 VDC.										
20. Initiator's Signature			21. Stamp Number		22. Organization and Location of Initiator			23. Date		
G. D. Harding			12 M		MSC - QA			2/23/72		
24. MR Action Required?			25. Replacement Part Number		26. Retest Required		27. Retest Accept Date		28. FIAR Number	
<input checked="" type="checkbox"/> YES <input type="checkbox"/> No			N/A		<input checked="" type="checkbox"/> Yes <input type="checkbox"/> No		2/24/72		EPS-0007	
29. MRB Decision		INSTRUCTIONS							QC STAMP	
<input checked="" type="checkbox"/> USE "AS IS"									CONT. NASA	
<input type="checkbox"/> REPAIR		1. Release the EPS S/N 1001 from the Beta Bldg Bonded Storage.							2/23/72	
<input type="checkbox"/> REWORK		2. Connect the EPS to the BTE and apply power to the EPS. Allow power to Remain on the EPS for 3 hours.							2/23/72	
<input type="checkbox"/> -SCRAP		3. Repeat the medium ADC checkout test.							2/23/72	
		a) .025 = .019 b) .050 = .043 c) .100 = .092 d) 1.0 = .987								
		e) 2.0 = 1.989 f) 3.0 = 2.986 g) 4.0 = 3.983 h) 4.9 = 4.882								
		Readings d) thru h) are still out of spec.								
		4. Allow power to remain on EPS for an additional 24 hours then repeat step 3. above.							2/23/72	
		5. a) .025 = .019 b) .050 = .043 c) .100 = .092 d) 1.0 = .992							2/23/72	
		e) 2.0 = 1.989 f) 3.0 = 2.991 g) 4.0 = 3.988 h) 4.9 = 4.887								
		Reading e) only is out of spec.								
		30. DATE		4/22/72		FINAL ACCEPTANCE				
MRB APPROVAL SIGNATURES										
31. System Engineer (Contractor)			DATE		32. System Engineer (NASA)			DATE		
George E. Cunningham			2/24/72		Andrew J. Farkas			2/24/72		
33. Quality Control Rep. (Contractor)			DATE		34. Quality Control Rep. (NASA)			DATE		
35. Program Office Rep. (Office Code)			DATE		36. Quality Engineer (NASA)			DATE		
					C. Little			2/27/72		

EB

3. RECORD NUMBER

IDR

DR/MRR EPS-0040

QC STAMP
CONT. NASA

6. Transport the EPS P/N SEC39106425-301, S/N 1001 to the MSC Bldg 265 Van de Graaff Lab.

2/23/72

7. Install the EPS in a vacuum chamber and pump the system down (using only a roughing pump) for 1 1/2 hours.

2/23/72

8. Return the EPS Unit S/N 1001 to the Beta Bldg and repeat Step 3. above.

2/23/72

a) .025 = .019 b) .050 = .043

c) .100 = .092 d) 1.0 = .992

e) 2.0 = 1.989 f) 3.0 = 2.986

g) 4.0 = 3.988 h) 4.9 = 4.887

QV Taylor 4/24/72

2/24/72

9. Repeat Steps 6 thru 8, except leave unit in vacuum chamber overnight.

2/24/72

a) .025 = 0.019 b) .050 = .044 c) .100 = .093

d) 1.0 = .992 e) 2.0 = 1.989 f) 3.0 = 2.991

g) 4.0 = 3.988 h) 4.9 = 4.887

10. Repeat Step 3, using maximum tolerance allowed by Procedure (i.e., +.001 VDC to each input voltage).

2/24/72

a) .026 = .019 b) .051 = .044 c) .101 = .093

d) 1.001 = .992 e) 2.001 = 1.994 f) 3.001 = 2.991

g) 4.001 = 3.993 h) 4.901 = 4.892

All readings are in specification

DATE:

4/27/72

FINAL ACCEPTANCE

NASA - MANNED SPACECRAFT CENTER
FAILURE INVESTIGATION ACTION REPORT **ACTION COPY** ERS-0001

1. PROJECT SKYLAB		2. WHERE DETECTED FACILITY: M.S.C.		3. ORG. REPORT NO. DR# EPS-0090		4. PROB. CLASSIF. OF FAILURE UNSAT. COND.		5. DATE REPORTED 2/23/72	
6. ITEM IDENTIFICATION LOCK HEED		7. END ITEM PART NO. ELCATION PROTON		8. ITEM IDENTIFIER SPECTROMETER		9. NEXT ASSY. NAME		10. REPORTED ITEM	
11. TPS NUMBER EPS-1210		7a. EI MODEL NO. SEC 39106425		8a. CONTR. PART NO. N/A		9a. CONTR. PART NO. N/A		10a. CONTR. PART NO. N/A	
12. FOOTING VIA N/A		7b. EI SERIAL NO. 1001		8b. SUPPLIER PART NO. N/A		9b. SUPPLIER PART NO. N/A		10b. SUPPLIER PART NO. N/A	
13. SPEC/PROCESS NO. EPS-503		DATE:		14. CORR. 336		15. CAUSE		16. SYMPT ZVS	
17. TAIL TYP		18. DETECTED DURING QUAL.		19.		20. SYSTEM NAME EPS		10c. SERIAL NO. N/A	

21. DESCRIPTION OF FAILURE/CONDITION **POST HUMIDITY FUNCTIONAL TEST DISCLOSED THE FOLLOWING:**
 1. MEDIUM VOLTAGE ADC CHECKOUT PAGE 269 OF SPEC, 1.0, 2.0, 3.0, 4.0, & 4.4 VDC INPUT VOLTAGE. OUT PUT VOLTAGE IS LOW
 2. PAGE 220, 221, & 223 DISC, REF, MON. CHECKS 2.965 V.D.C.

22. CRITICALITY **004** **SHOULD BE 3.0 ± 102 VDC**

23. INITIATOR/CONTACT **J. Harding** ORG. **MSC-QA** DATE **2/23/72**

25. HARDWARE ANALYSIS REQUEST/INSTRUCTIONS
 Conduct analysis to determine cause and determine method for meeting specification.

27. REQUESTER ORG. DATE

28. CAUSE OF FAILURE/ANALYSIS RESULTS **Moisture condensed upon a very high impedance circuit mode causing excessive current leakage and therefore, the out of specification reading. Also, during initial calibration of the ADC, the circuit was adjusted such that it was on the low end of the spec. and therefore, could not vary over the allowable tolerances without being out-of-spec. Instrument warmup and vacuum soak brought the voltage within limits. During calibration of all EPS Flight Units (including the refurbished Qual Unit) the ADC will be calibrated to the middle of the allowable tolerance range.**

29. SYSTEM ENGINEER ORG. DATE

31. CORRECTIVE ACTION REQUESTED
Determine action to be taken to insure that problem will not exist on flight units.

32. ACTION ASSIGNED TO ORG. DATE

34. CORRECTIVE ACTION TAKEN
During calibration of all EPS Flight Units (including the refurbished Qual Unit) the ADC will be calibrated to the middle of the allowable tolerance range: J.A. Zell 5/15/72
Data obtained during additional testing is attached. Procedures for calibrating and testing the ADC are: EPS-401, 403A, 449, 505 and 506.
4/19/72 **4/24/72**

DISCREPANCY REPORT/MATERIAL REVIEW RECORD
NASA - MANNED SPACECRAFT CENTER

EB

PAGE 1 OF 1

2. Article Name ELECTRON PROTON SPECTROMETER SEC 391064R5		3. Drawing Number -301		4. Serial/Lot Number 1001		5. RECORD NUMBER	
6. Contractor's Name LEC		7. Contractor's Drawing Number N/A		8. Contractor's Serial Number N/A		IDR	
9. Supplier's Name LEC		10. Supplier's Drawing Number N/A		11. Supplier's Serial No. N/A		DRIMRR EPS-0091	
13. REF. Document No. EPS-1216 TPS.		14. Spacecraft N/A		15. Fault T13		16. Funct. N/A	
		17. Cause/Origin N/A		18. System N/A		19. Disposition N/A	

DISCREPANCY

1. UNPLATED AREAS WHERE SHOCK MOUNT STRAPS ATTACH TO SLICE ASSYS IS CORRODED. FOUND AFTER QUAL TESTING

2. NUMEROUS BLISTERS AND EVIDENCE OF CORROSION ON GOLD PLATED AREAS ON SLICE ASSYS.

20. Initiator's Signature S.D. Harding		21. Stamp Number 12 M		22. Organization and Location of Initiator MSC - QA		23. Date 2/29/72	
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DISPOSITION

24. MR Action Required? <input checked="" type="checkbox"/> YES <input type="checkbox"/> No		25. Replacement Part Number N/A		26. Retest Required <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No		27. Retest Accept Date N/A		28. FIAR Number EPS-0008	
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29. MRB Decision <input checked="" type="checkbox"/> USE "AS IS" <input type="checkbox"/> REPAIR <input type="checkbox"/> REWORK <input type="checkbox"/> SCRAP		INSTRUCTIONS						QC STAFF CONT. NASA	
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1. To prevent corrosion from occurring on the EPS Flight Units, the slices will ~~be~~ have a brushed-on alodine coating applied in the unplated areas. CHEMICAL FILM PER MIL-C-5541, TYPE I OR II, GRADE B, CLASS 1.

2. The small areas of corrosion and/or blisters do not affect the structural design of the EPS. Since the percentage of gold-plated surface area that showed evidence of corrosion is very small (much less than 1% of the total area) the thermal design of the EPS will not be affected.

30. DATE **3/20/72** FINAL ACCEPTANCE

MRB APPROVAL SIGNATURES

31. System Engineer (Contractor) George E. [Signature]		DATE 3/2/72		32. System Engineer (NASA) [Signature]		DATE 3/7/72	
33. Quality Control Rep. (Contractor)		DATE		34. Quality Control Rep. (NASA)		DATE	
35. Program Office Rep. (Office Code)		DATE		36. Quality Engineer (NASA) [Signature]		DATE 3/7/72	

NASA - MANNED SPACECRAFT CENTER
FAILURE INVESTIGATION ACTION REPORT UNION UNO:EPS-0008

1. PROJECT SKYLAB		2. FAILURE DETECTED FACILITY: MSC ORGANIZATION: LOCKHEED LOCATION: BFA BLD		3. CIRC. REPORT NO. DR 4	4. PROB. CLASSIF. <input type="checkbox"/> FAILURE <input checked="" type="checkbox"/> UNSAT. COND.	5. DATE REPORTED 2/29/72
6. CONTRACTOR LOCKHEED		7. ITEM NAME ELECTRON PROTON SPECTROMETER		8. ITEM NUMBER ←		10. REPORTED ITEM →
11. IFS NUMBER EPS-1216		7a. ET MODEL NO. -301		6a. CONTR. PART NO. N/A		10a. CONTR. PART NO. N/A
12. ROUTING VIA N/A		7b. ET SERIAL NO. 1001		6b. SUPPLIER PART NO. N/A		10b. SUPPLIER PART NO. N/A
13. SPEC./PROCESS NO. DATE: N/A		6c. SERIAL NO. N/A		9c. SERIAL NO. N/A		10c. SERIAL NO. N/A
14. COND.	15. CAUSE	16. SYMPT	17. FAIL TYP	18. DETECTED DURING QUAL	19.	20. SYSTEM NAME E.P.S.

21. DESCRIPTION OF FAILURE/CONDITION

- UNPLATED AREAS WHERE SHOCK MOUNT STRAPS ATTACH TO SLICE ASSYS. IS CORRODED. FOUND AFTER QUAL TESTING
- NUMEROUS BLISTERS AND EVIDENCE OF CORROSION ON GOLD PLATED

22. CRITICALITY
004 AREAS ON SLICE ASSYS.

23. INITIATOR/CONTACT
L. D. Harding MSC-QA. 2/29/72

25. HARDWARE ANALYSIS REQUESTED/INSTRUCTIONS
Perform analysis to determine cause of problem.



SIGNED TO: _____ ORG.: _____ DATE: _____ 27. REQUESTER: _____ ORG.: _____ DATE: _____

23. CAUSE OF FAILURE/ANALYSIS RESULTS

1. The corrosion and/or deposits on the bare aluminum areas (match-machined for vibration isolator mounting straps) were caused by chemical or electrochemical attack in the presence of moisture containing enough contamination to make it conductive and therefore corrosive, in the presence of a dissimilar metal junction. (Aluminum and gold-plating of strap.) Recommend use of chemical conversion coating to convert the surface of the active metal (aluminum) to a less chemically active or inert surface.

(Continued on attached sheet)

27. SYSTEM ENGINEER: _____ ORG.: _____ DATE: _____ 30. RIE: _____ ORG.: _____

29. CORRECTIVE ACTION REQUESTED
Indicate corrective action to be taken on flight units to insure corrosion does not occur.

32. ACTION ASSIGNED TO: _____ ORG.: _____ DATE: _____ 33. REQUESTER: _____ ORG.: _____ DATE: _____

34. CORRECTIVE ACTION TAKEN

- Applied chemical film to exposed metal surfaces of the slices individually per MIL-C-5541, Type I or II, Grade B, Class 1.
- The area per side contains more than 50 square inches of surface area whereas the total blistered area is certainly less than 1/2 square inch or less than 1%. The extremely small percentage of area that blistered will not affect the thermal control quality of the gold plating. Surface regarded as satisfactory with up to 2% loss of area.

Handwritten notes: 3/3/72 R. J. Lopez Col/SPC 4-22-72

35. ACTION BY: _____ ORG.: _____ DATE: _____ 36. RIE: _____ ORG.: _____ DATE: _____ 37. CIRC. OUT: _____

28. Cause of Failure/Analysis Results (Continued)

2. The small "blisters and evidence of corrosion" on slice assemblies resulted from either (1) moisture behind the gold plating (entering either thru a pinhole or other flaw in the plating) or (2) where the gold plating was missing when the unit was received from NASA/MSC TSD. The finish of the slices is (1) zincate immersion coating followed by (2) copper flash, (3) bright nickel using sulfamate process (.0002" thk.), and (4) a bright gold plate using Sel-Rex BDT-200 process type 1, Grade C, .00008" to .0001 thk. per MIL-G-45204. This finish is required on the outside surfaces of the slices for thermal control. Since the plating is a composite of four separate layers, it is difficult to establish any reason for the blistering other than the extremely thin gold coating did have flaws which allowed moisture to enter.

18508		DATE 3/6/72	DRAWING CHANGE NOTICE		SHEET 1
DRAWING NO SEC39107463		REV. B	REASON FOR CHANGE		RELEASE
TITLE SPECIFICATION CONTROL DRAWINGS, INNER ELECTRONICS		FINISHING SPECIFICATION ADDITION		ORIGINATOR R.P. Dumm	DATE 3/6/72
PROJECT EPS	DRAWING TO BE CHANGED <input checked="" type="checkbox"/> YES <input type="checkbox"/> NO			APPROVED R.P. Dumm	DATE 3/6/72
DISPOSITION OF EXISTING MATL/PARTS		EFFECTIVITY		APPROVED P. E. [Signature]	DATE 3/6/72
USE AS IS RETURN TO STOCK	<input type="checkbox"/> N/A	REWORK <input checked="" type="checkbox"/>	MODEL N/A	SERIAL NO. ALL 1001 →	AUTH.

DESCRIPTION OF CHANGE

ADD NOTE 9 :

"

NOTE 9 : AFTER MACHINING THE SLICES (ITEMS 1,2,3, & 4) FOR MATCH-FIT WITH MOUNTING STRAPS, APPLY CHEMICAL FILM TO EXPOSED SURFACES OF THE SLICES INDIVIDUALLY PER MIL-C-5541, TYPE I OR II, GRADE B, CLASS 1.
CAUTION! : ANY CLEANING, FINISHING, OR APPLICATION MUST NOT AFFECT THE GOLD-PLATED OR THERMAL-COATED SURFACES.

NOTE : SLICES MAT'L - 6061-T651 AL "

PART NUMBER	DESCRIPTION	MATERIAL	SPECIFICATION	CHANGE
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